DL151/D Rev. 4, Jan-2003

# **Rectifier Device Data**

**ON Semiconductor**<sup>®</sup>



# **Rectifier Device Data**

DL151/D Rev. 4, Jan-2003



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For tape and reel packaging options, please refer to ON Semiconductor document BRD8011/D.

# CHAPTER 1 Numeric Data Sheet Listing

## NUMERIC DATA SHEET LISTING

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MBR2515L         25 Amp, 15 Volt SWITCHMODE Power Rectifier         276           MBR2535CTL         25 Amp, 35 Volt SWITCHMODE Power Rectifier         256           MBR2545CTP         30 Amp, 45 Volt SWITCHMODE Power Rectifier         290           MBR3045PT         30 Amp, 45 Volt SWITCHMODE Power Rectifier         297           MBR3060         3 Amp, 60 Volt Axial Lead Rectifier         216           MBR3060         3 Amp, 40 Volt Axial Lead Rectifier         216           MBR3060         3 Amp, 40 Volt Axial Lead Rectifier         222           MBR360         3 Amp, 50 Volt Axial Lead Rectifier         229           MBR360         3 Amp, 60 Volt Axial Lead Rectifier         229           MBR360         3 Amp, 60 Volt Axial Lead Rectifier         229           MBR4051LWT         40 Amp, 15 Volt SWITCHMODE Schottky Power Rectifier         300           MBR4045WT         40 Amp, 45 Volt SWITCHMODE Power Rectifier         293           MBR6045WT         60 Amp, 45 Volt SWITCHMODE Power Rectifier         306           MBR735         7.5 Amp, 35 Volt SWITCHMODE Power Rectifier         262           MBR745         7.5 Amp, 35 Volt SWITCHMODE Power Rectifier         306           MBR4045WT         60 Amp, 45 Volt SWITCHMODE Power Rectifier         262           MBR4120ET3         1 Amp, 20 Vol		-	
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MBRD620CT	6 Amp, 20 Volt SWITCHMODE Power Rectifier	
MBRD630CT	6 Amp, 30 Volt SWITCHMODE Power Rectifier	
MBRD640CT	6 Amp, 40 Volt SWITCHMODE Power Rectifier	
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MBRD660CT	6 Amp, 60 Volt SWITCHMODE Power Rectifier	
MBRD835L MBRF20100CT	8 Amp, 35 Volt SWITCHMODE Power Rectifier	
	20 Amp, 100 Volt SWITCHMODE Schottky Power Rectifier	
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MBRM110ET1 MBRM110ET3	1 Amp, 10 Volt Surface Mount Schottky Power Rectifier	
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MBRM110LT3	1 Amp, 10 Volt Surface Mount Schottky Power Rectifier	
MBRM120ET1	1 Amp, 20 Volt Surface Mount Schottky Power Rectifier	
MBRM120ET3	1 Amp, 20 Volt Surface Mount Schottky Power Rectifier	
MBRM120LT1	1 Amp, 20 Volt Surface Mount Schottky Power Rectifier	
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MBRM140T1	1 Amp, 40 Volt Surface Mount Schottky Power Rectifier	
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MBRP40030CTL	400 Amp, 30 Volt POWERTAP II SWITCHMODE Power Rectifier	
MBRP40045CTL	400 Amp, 45 Volt POWERTAP II SWITCHMODE Power Rectifier	
MBRP60035CTL	600 Amp, 35 Volt POWERTAP II SWITCHMODE Power Rectifier	
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MBRS410LT3	4 Amp, 10 Volt Surface Mount Schottky Power Rectifier	
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MR2504	25 Amp, 400 Volt Medium-Current Silicon Rectifier	
MR2510	25 Amp, 1000 Volt Medium-Current Silicon Rectifier	
MR2520L	Overvoltage Transient Suppressor	
MR2535L	Medium Current Overvoltage Transient Suppressor	
MR2835S	Overvoltage Transient Suppressor	
MR2835SK	Overvoltage Transient Suppressor	
MR3025 MR750	25 Amp, 250 Volt Medium-Current Silicon Rectifier         50 Volt High Current Lead Mounted Rectifier	
MR751	100 Volt High Current Lead Mounted Rectifier	
MR752	200 Volt High Current Lead Mounted Rectifier	
MR754	400 Volt High Current Lead Mounted Rectifier	
MR756	600 Volt High Current Lead Mounted Rectifier	
MR760	1000 Volt High Current Lead Mounted Rectifier	
MR850	3.0 Amp, 50 Volt Axial Lead Fast Recovery Rectifier	
MR851	3.0 Amp, 100 Volt Axial Lead Fast Recovery Rectifier	
MR852	3.0 Amp, 200 Volt Axial Lead Fast Recovery Rectifier	
MR854	3.0 Amp, 400 Volt Axial Lead Fast Recovery Rectifier	
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MRA4005T3	1 Amp, 600 Volt Surface Mount Standard Recovery Power Rectifier	509
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MRA4007T3	1 Amp, 1000 Volt Surface Mount Standard Recovery Power Rectifier	509
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MUR2020R	20 Amp, 200 Volt Ultrafast SWITCHMODE Power Rectifier	474
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MUR3040PT	30 Amp, 400 Volt Ultrafast SWITCHMODE Power Rectifier	495
MUR3060PT	30 Amp, 600 Volt Ultrafast SWITCHMODE Power Rectifier	495
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MUR405	4 Amp, 50 Volt Ultrafast SWITCHMODE Power Rectifier	434
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MUR440	4 Amp, 400 Volt Ultrafast SWITCHMODE Power Rectifier	
MUR460	4 Amp, 600 Volt Ultrafast SWITCHMODE Power Rectifier	
MUR480E	4 Amp, 800 Volt Ultrafast "E" Series SWITCHMODE Power Rectifier	
MUR620CT	6 Amp, 200 Volt Ultrafast SWITCHMODE Power Rectifier	
MUR805	8 Amp, 50 Volt Ultrafast SWITCHMODE Power Rectifier	
MUR810	8 Amp, 100 Volt Ultrafast SWITCHMODE Power Rectifier	
MUR8100E	8 Amp, 1000 Volt Ultrafast "E" Series SWITCHMODE Power Rectifier	
MUR815	8 Amp, 150 Volt Ultrafast SWITCHMODE Power Rectifier	
MUR820	8 Amp, 200 Volt Ultrafast SWITCHMODE Power Rectifier	
MUR840	8 Amp, 400 Volt Ultrafast SWITCHMODE Power Rectifier	
MUR860	8 Amp, 600 Volt Ultrafast SWITCHMODE Power Rectifier	
MUR880E	8 Amp, 800 Volt Ultrafast "E" Series SWITCHMODE Power Rectifier	
MURA105T3	1 Amp, 50-100 Volt Surface Mount Ultrafast Power Rectifier	
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MURS260T3 2 Amp, 600 Volt Surface Mount Ultrafast Power Rectifier	384
MURS320T3 3 Amp, 200 Volt Surface Mount Ultrafast Power Rectifier	387
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# CHAPTER 2 Selector Guide

Continuing investment in research and development for discrete products has created a rectifier manufacturing facility that matches the precision and versatility of the most advanced integrated circuits. As a result, ON Semiconductor's silicon rectifiers span all high tech applications with quality levels capable of passing the most stringent environmental tests . . . including those for automotive under-hood applications.

#### Product Highlights:

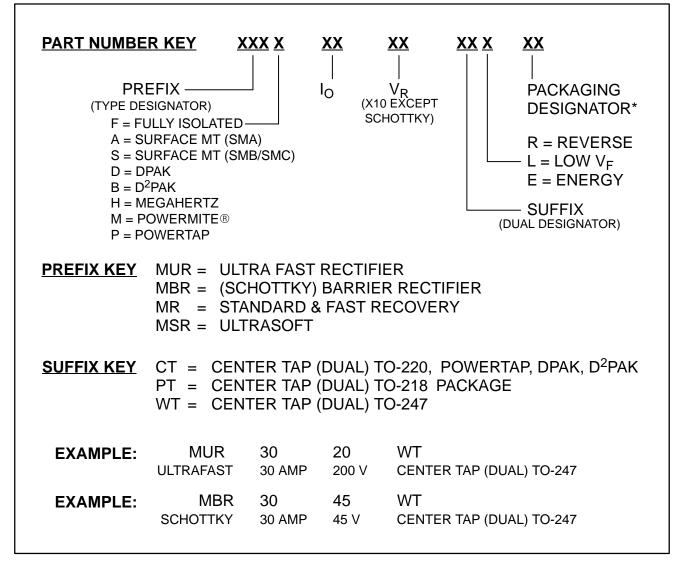
- Surface Mount Devices A major thrust has been the development and introduction of a broad range of power rectifiers, Schottky and Ultrafast, 1/2 amp to 25 amp, 15 to 600 volts.
- Application Specific Rectifiers -
  - Schottky rectifiers having lower forward voltage drop (0.3 to 0.6 volts) for use in low voltage SMPS outputs and as "OR"ing diodes.
  - MEGAHERTZ<sup>™</sup> series for high frequency power supplies and power factor correction.
  - Ultrasoft rectifiers for high speed rectification.
  - Energy rated rectifiers with guaranteed energy handling capability.
  - Automotive transient suppressors.
- Ultrafast rectifiers having reverse recovery times as low as 25 ns to complement the Schottky devices for higher voltage requirements in high frequency applications.
- A wide variety of package options to match virtually any potential requirement.

The rectifier selector section that follows has generally been arranged by package and technology. The individual tables have been sorted by voltage and current with the package types for the devices listed shown above each table. The Application Specific Rectifiers are also included in their respective tables.

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# **RECTIFIER NUMBERING SYSTEM**



\*For available packaging options consult Sales Office or see Data Sheet.

### **Application Specific Rectifiers**

#### Table 1. Low V<sub>F</sub> Schottky Rectifiers

Device	l <sub>O</sub> (Amps)	V <sub>RRM</sub> (Volts)	V <sub>F</sub> @ Rated I <sub>O</sub> and T <sub>C</sub> = 25°C Volts (Max)	I <sub>R</sub> @ Rated V <sub>RRM</sub> mAmps (Max)	Package
MBR0520LT1, T3	0.5	20	0.33	0.25	SOD-123
MBR120LSFT1, T3	1	20	0.45	0.4	SOD-123 Flat Lead
MBRM110LT1, T3	1	10	0.365	0.5	PowerMite <sup>®</sup>
MBRA210LT3	2	10	0.35	0.7	SMA
MBRS130LT3	1	30	0.395	1	SMB
MBRS410LT3	4	10	0.33	5.0	SMC
MBRD835L	8	35	0.41	1.4	DPAK
MBRD1035CTL	10	35	0.41	6	DPAK
MBR2030CTL	20	30	0.48	5	TO-220
MBRB2535CTL	25	35	0.41	10	D <sup>2</sup> PAK
MBR2535CTL	25	35	0.41	5	TO-220
MBRB2515L	25	15	0.42	15	D <sup>2</sup> PAK
MBR2515L	25	15	0.42	15	TO-220
MBRB3030CTL	30	30	0.51	5	D <sup>2</sup> PAK
MBR4015LWT	40	15	0.42	5	TO-247
MBRP20030CTL	200	30	0.52	5	POWERTAP II
MBRP40045CTL	400	45	0.57	10	POWERTAP II
MBRP400100CTL	400	100	0.83	6	POWERTAP II
MBRP60035CTL	600	35	0.57	10	POWERTAP II

#### Table 2. MEGAHERTZ<sup>™</sup> Rectifiers

			Maxim		
Device	l <sub>O</sub> (Amps)	V <sub>RRM</sub> (Volts)	$V_F @ I_F = 4.0 A and T_C = 25^{\circ}C$ (Volts)	I <sub>R</sub> @ Rated V <sub>RRM</sub> (mAmps)	t <sub>rr</sub> (Nanosecond)
MURH840CT/MURHB840CT	8	400	2.2	0.01	28
MURH860CT	8	600	2.8	0.01	35
MURHB860CT	8	600	2.8	0.01	35
MURHF860CT	8	600	2.8	0.01	35

#### Table 3. UltraSoft Rectifiers (For High Speed Rectification)

Device	I <sub>O</sub> (Amps)	V <sub>RRM</sub> (Volts)	Max V <sub>F</sub> @ I <sub>F</sub> (Volts)	Max t <sub>rr</sub> (ղSec)	T <sub>J</sub> Max (°C)
MSRD620CT	6	200	1.35 @ 6.0 A	55	175
MSR860	8	600	1.7 @ 8.0 A	120	150
MSR1560	15	600	1.8 @ 15 A	45	150

#### Table 4. Energy Rated Rectifiers

Device	l <sub>O</sub> (Amps)	V <sub>RRM</sub> (Volts)	Max V <sub>F</sub> @ Rated unless Noted (Volts)	I <sub>R</sub> @ V <sub>RRM</sub> (μAmps)	Waval (M <sub>J</sub> )
MUR180E	1.0	800	1.75	10	10
MUR1100E	1.0	1000	1.75	10	10
MUR480E	4.0	800	1.75 @ 3.0 A	25	20
MUR4100E	4.0	1000	1.75 @ 3.0 A	25	20
MUR880E	8.0	800	1.8	25	20
MUR8100E	8.0	1000	1.8	25	20

#### Table 5. Automotive Transient Suppressors

Device	I <sub>O</sub> (Amps) V <sub>RRM</sub> (Volts) Max V <sub>F</sub> @ I <sub>F</sub> (Volts)		Max V <sub>F</sub> @ I <sub>F</sub> (Volts)	I <sub>RSM (</sub> Amps)	T <sub>J</sub> Max (°C)
MR2535L	6.0	20	1.1 @ 100 A	62 @ 10 mS	175
MR2835SK	32	23	1.1 @ 100 A	62 @ 10 mS	175
MR2520L	6.0	23	1.25 @ 100 A	58 @ 10 mS	175
TRA2532	32	23	1.18 @ 100 A	80 @ 10 mS	175

### **SCHOTTKY Rectifiers**

#### Table 6. Surface Mount Schottky Rectifiers

V <sub>RRM</sub> (Volts)	I <sub>O</sub> <sup>(1)</sup> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> <sup>(2)</sup> T <sub>J</sub> = 25°C (mA)	Max I <sub>R</sub> <sup>(3)</sup> (mA)	Package
20	0.5	T <sub>L</sub> = 90°C	MBR0520LT1 MBR0520LT3	0.310 @ 0.1 A 0.385 @ 0.5 A	5	125	.075 @ 10 V .250 @ 20 V	5 @ 10 V 8 @ 20 V	
30	0.5	T <sub>L</sub> = 100°C	MBR0530T1 MBR0530T3	0.375 @ 0.1 A 0.430 @ 0.5 A	5	125	.020 @ 15 V .130 @ 30 V	-	CASE 425-04 (SOD-123) Cathode = Band
40	0.5	T <sub>L</sub> = 110°C	MBR0540T1 MBR0540T3	0.53 @ 0.5 A	5	150	.010 @ 20 V .020 @ 40 V	-	
20	1	T <sub>L</sub> = 140°C	MBR120ESFT1 ★ MBR120ESFT3 ★	0.53 @ 1.0 A	40	150	.010	1.6 @ 100°C	
20	1	T <sub>L</sub> = 115°C	MBR120LSFT1 ★ MBR120LSFT3 ★	0.45 @ 1.0 A	50	125	0.4	25 @ 85°C	CASE 498-01 (SOD-123FL)
40	1	T <sub>L</sub> = 112°C	MBR140SFT1 ★ MBR140SFT3 ★	0.55 @ 1.0 A	30	125	0.5	25 @ 85°C	
10	1	T <sub>C</sub> = 100°C	MBRM110ET1 ★ MBRM110ET3 ★	0.53 @ 1.0 A	50	150	0.001	0.5 @ 100°C	
10	1	T <sub>C</sub> = 115°C	MBRM110LT1 ★ MBRM110LT3 ★	0.365 @ 1.0 A	50	125	0.5	60 @ 100°C	
20	1	T <sub>C</sub> = 130°C	MBRM120ET3	0.455 @ 0.1 A 0.530 @ 1.0 A	50	150	0.010 @ 20 V	1.6 @ 20 V	CASE 457-04 (POWERMITE®)
20	1	$T_{tab} \leq 100^\circ C$	MBRM120LT3	0.36 @ 0.1 A 0.45 @ 1.0 A	50	125	0.4 @ 20 V	N/A	
30	1	T <sub>C</sub> = 135°C	MBRM130LT3*	0.45 @ 1.0 A	50	125	1	N/A	
40	1	$T_{tab} \leq 100^\circ C$	MBRM140T3	0.39 @ 0.1 A 0.55 @ 1.0 A	50	125	0.5 @ 40 V	N/A	
20	1	T <sub>L</sub> = 125°C	MBRA120ET3	0.530 @ 1.0 A	40	150	0.010	1.6 @ 100°C	
20	1	T <sub>L</sub> = 110°C	MBRA120LT3	0.395 @ 1.0 A	40	125	0.200	6.0 @ 100°C	
30	1	$T_C \le 105^{\circ}C$	MBRA130LT3	0.41 @ 1.0 A 0.47 @ 2.0 A	25	125	1.0 @ 30 V 0.4 @ 15 V	25 @ 30 V	CASE 403D-02
40	1	$T_C \le 100^{\circ}C$	MBRA140T3	0.60 @ 1.0 A 0.73 @ 2.0 A	25	125	0.5 @ 40 V 0.1 @ 20 V	10 @ 40 V	(SMA) Cathode = Notch
60	1	T <sub>L</sub> = 105°C	MBRA160T3 ★	0.51 @ 1.0 A	30	125	0.2	10 @ 125°C	or Polarity Band
60	1	T <sub>L</sub> = 105°C	SS16*	0.51 @ 1.0 A	30	125	0.2	10 @ 125°C	
10	2	$T_L = 125^{\circ}C$	MBRA210ET3 *	0.50 @ 2.0 A	150	150	0.050	0.5 @ 100°C	
10	2	T <sub>L</sub> = 110°C	MBRA210LT3 ★	0.35 @ 2.0 A	230	125	0.70	60 @ 100°C	
20	1	T <sub>L</sub> = 115°C	MBRS120T3	0.55 @ 1.0 A	40	125	1	10	
30	1	$T_L = 120^{\circ}C$	MBRS130LT3	0.395 @ 1.0 A	40	125	1	10	_
30	1	T <sub>L</sub> = 115°C	MBRS130T3	0.55 @ 1.0 A	40	125	1	10	
40	1	T <sub>L</sub> = 115°C	MBRS140T3	0.6 @ 1.0 A	40	125	1	10	
40	1	T <sub>C</sub> = 110°C	MBRS140LT3	0.5 @ 1.0 A	40	125	0.4	10	
90	1	T <sub>L</sub> = 120°C	MBRS190T3	0.75 @ 1.0 A	50	125	0.5	5	CASE 403A-03
100	1	T <sub>L</sub> = 120°C	MBRS1100T3	0.75 @ 1.0 A	40	150	0.5	5	(SMB) Cathode = Notch
40	1.5	T <sub>C</sub> = 100°C	MBRS1540T3	0.46 @ 1.5 A	40	125	0.8	5.7	or Polarity Band
40	2	T <sub>C</sub> ≤ 95°C	MBRS240LT3	0.43 @ 2.0 A 0.53 @ 4.0 A	25	125	2.0 @ 40 V 0.5 @ 20 V	60 @ 40 V 40 @ 20 V	
40	2	T <sub>C</sub> = 103°C	MBRS2040LT3	0.43 @ 2.0 A 0.50 @ 4.0 A	70	125	0.80 @ 40 V 0.10 @ 20 V	20 @ 40 V 6.0 @ 20 V	-
60	2	T <sub>L</sub> = 95°C	MBRS260T3 <del>×</del>	0.63 @ 2.0 A	40	125	0.2	10 @ 125°C	
60	2	T <sub>L</sub> = 95°C	SS26 *	0.63 @ 2.0 A	40	125	0.2	10 @ 125°C	

All devices listed are ON Semiconductor preferred devices

### **SCHOTTKY Rectifiers**

#### Table 6. Surface Mount Schottky Rectifiers (continued)

V <sub>RRM</sub> (Volts)	I <sub>O</sub> <sup>(1)</sup> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> <sup>(2)</sup> T <sub>J</sub> = 25°C (mA)	Max I <sub>R</sub> <sup>(3)</sup> (mA)	Packag	je
20	3	T <sub>L</sub> = 100°C	MBRS320T3	0.50 @ 3.0 A	80	125	2	20		
30	3	T <sub>L</sub> = 100°C	MBRS330T3	0.50 @ 3.0 A	80	125	2	20		
40	3	T <sub>L</sub> = 100°C	MBRS340T3	0.525 @ 3.0 A	80	125	2	20	CASE 403-03	•
60	3	T <sub>L</sub> = 100°C	MBRS360T3	0.74 @ 3.0 A	80	125	0.5	20	(SMC)	
100	3	$T_L = 100^{\circ}C$	MBRS3100T3 *	0.79 @ 3.0 A	130	150	0.05	5.0 @ 125°C	Cathode = Notch	h US
10	4	T <sub>L</sub> = 130°C	MBRS410ET3 *	0.50 @ 4.0 A	250	150	0.15	4.0 @ 100°C		
10	4	T <sub>L</sub> = 110°C	MBRS410LT3 *	0.33 @ 4.0 A	150	125	5.0	200 @ 100°C	-	
20	3	T <sub>C</sub> = 125°C	MBRD320T4	0.60 @ 3.0 A	75	150	0.2	20 @ 125°C		
30	3	T <sub>C</sub> = 125°C	MBRD330T4	0.60 @ 3.0 A	75	150	0.2	20 @ 125°C		
40	3	T <sub>C</sub> = 125°C	MBRD340T4	0.60 @ 3.0 A	75	150	0.2	20 @ 125°C		
50	3	T <sub>C</sub> = 125°C	MBRD350T4	0.60 @ 3.0 A	75	150	0.2	20 @ 125°C		¹⁰₱ๅ–₀
60	3	T <sub>C</sub> = 125°C	MBRD360T4	0.60 @ 3.0 A	75	150	0.2	20 @ 125°C	CASE 369A-13	3 <b>0 🛃 -</b>
20	6	T <sub>C</sub> = 130°C	MBRD620CTT4	0.70 @ 3.0 A	75	150	0.1	15 @ 125°C	(DPAK)	"CT" Suffix
30	6	T <sub>C</sub> = 130°C	MBRD630CTT4	0.70 @ 3.0 A	75	150	0.1	15 @ 125°C	4	
40	6	T <sub>C</sub> = 130°C	MBRD640CTT4	0.70 @ 3.0 A	75	150	0.1	15 @ 125°C	169	¦ <b>_}</b> ≁∘
50	6	$T_C = 130^{\circ}C$	MBRD650CTT4	0.70 @ 3.0 A	75	150	0.1	15 @ 125°C	3	Non-"CT
60	6	T <sub>C</sub> = 130°C	MBRD660CTT4	0.70 @ 3.0 A	75	150	0.1	15 @ 125°C		Suffix
35	8	T <sub>C</sub> = 100°C	MBRD835L	0.40 @ 3.0 A 0.51 @ 8.0 A	100	125	1.4	35		
35	10	T <sub>C</sub> = 90°C	MBRD1035CTL	0.49 @ 10 A	100	125	2	130 @ 125°C		
10	45	T <sub>C</sub> = 135°C	MBRB1045*	0.84 @ 20 A	150	150	0.1	15 @ 125°C		
45	15	T <sub>C</sub> = 105°C	MBRB1545CT	0.84 @ 15 A	150	150	0.1	15 @ 125°C		
60	20	T <sub>C</sub> = 110°C	MBRB2060CT	0.95 @ 20 A	150	150	0.15	150 @ 125°C		
100	20	T <sub>C</sub> = 110°C	MBRB20100CT	0.85 @ 10 A 0.95 @ 20 A	150	150	0.1	6 @ 125°C		
200	20	T <sub>C</sub> = 125°C	MBRB20200CT	1.0 @ 20 A	150	150	1	50 @ 125°C	CASE 418B-04	
15	25	$T_C = 90^{\circ}C$	MBRB2515L	0.45 @ 25 A	150	100	15	200 @ 70°C	(D <sup>2</sup> PAK)	3 <b>0-₽⊢</b> "CT" Suff
35	25	T <sub>C</sub> = 110°C	MBRB2535CTL	0.47 @ 12.5 A 0.55 @ 25 A	150	125	10	500 @ 125°C	4	UT SUT
45	25	T <sub>C</sub> = 130°C	MBRB2545CT	0.82 @ 30 A	150	150	0.2	40 @ 125°C		<sup>1</sup> ° <b>→</b>
30	30	T <sub>C</sub> = 115°C	MBRB3030CT	0.54 @ 15 A 0.67 @ 30 A	300	150	1.2	145 @ 150°C 46 @ 10 V, 150°C	1 3	30-J Non-"C Suffix
30	30	T <sub>C</sub> = 95°C	MBRB3030CTL	0.45 @ 15 A 0.51 @ 30 A	150	125	2	195 @ 125°C 75 @ 10 V, 125°C		
30	40	T <sub>C</sub> = 110°C	MBRB4030	0.46 @ 20 A 0.55 @ 40 A	300	150	1	150 @ 125°C		

All devices listed are ON Semiconductor preferred devices

#### Table 7. Axial Lead Schottky Rectifiers

V <sub>RRM</sub> (Volts)	l <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> <sup>(2)</sup> T <sub>L</sub> = 25°C (mA)	Max I <sub>R</sub> <sup>(3)</sup> T <sub>L</sub> (mA)	Package
20	1	T <sub>A</sub> = 55°C R <sub>θJA</sub> = 80°C/W	1N5817	0.45 @ 1.0 A	25	125	1	10	CASE 59-10
30	1	$T_A = 55^{\circ}C$ $R_{\Theta JA} = 80^{\circ}C/W$	1N5818	0.55 @ 1.0 A	25	125	1	10	(DO-41) Plastic
40	1	T <sub>A</sub> = 55°C R <sub>θJA</sub> = 80°C/W	1N5819	0.60 @ 1.0 A	25	125	1	10	/
50	1	T <sub>A</sub> = 55°C	MBR150	0.75 @ 1.0 A	25	150	0.5	5	j
60	1	T <sub>A</sub> = 55°C R <sub>θJA</sub> = 80°C/W	MBR160	0.75 @ 1.0 A	25	150	0.5	5	
100	1	T <sub>A</sub> = 120°C R <sub>θJA</sub> = 50°C/W	MBR1100	0.79 @ 1.0 A	50	150	0.5	5	Cathode = Polarity Band
60	3	T∟ = 125°C	MBR3060 *	0.62 @ 3.0 A	125	150	0.15	10 @ 100°C	CASE 59-09 (DO-15) Plastic Cathode = Polarity Band
20	3	T <sub>A</sub> = 76°C R <sub>θJA</sub> = 28°C/W	1N5820	0.457 @ 3.0 A	80	125	2	20	
30	3	$T_A = 71^{\circ}C$ $R_{\theta JA} = 28^{\circ}C/W$	1N5821	0.500 @ 3.0 A	80	125	2	20	CASE 267-05 (DO-201AD)
40	3	$T_A = 61^{\circ}C$ $R_{\Theta JA} = 28^{\circ}C/W$	1N5822	0.525 @ 3.0 A	80	125	2	20	Plastic
40	3	T <sub>A</sub> = 65°C R <sub>θJA</sub> = 28°C/W	MBR340	0.600 @ 3.0 A	80	150	0.6	20	
50	3	T <sub>A</sub> = 65°C	MBR350RL	0.600 @ 3.0 A	80	150	0.6	20	
60	3	T <sub>A</sub> = 65°C R <sub>θJA</sub> = 28°C/W	MBR360RL	0.740 @ 3.0 A	80	150	0.6	20	Cathode = Polarity Band
100	3	T <sub>A</sub> = 100°C R <sub>θJA</sub> = 28°C/W	MBR3100	0.79 @ 3.0 A	150	150	0.6	20	

All devices listed are ON Semiconductor preferred devices

#### Table 8. TO-220 Thru-Hole Schottky Rectifiers

V <sub>RRM</sub> (Volts)	l <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> <sup>(2)</sup> T <sub>C</sub> = 25°C (mA)	Max I <sub>R</sub> <sup>(3)</sup> (mA)	Package
35	15	T <sub>C</sub> = 105°C	MBR1535CT	0.84 @ 15 A	150	150	0.1	15 @ 125°C	
45	15	T <sub>C</sub> = 105°C	MBR1545CT	0.84 @ 15 A	150	150	0.1	15 @ 125°C	
100	16	T <sub>C</sub> = 133°C	MBR16100CT	0.84 @ 16 A	150	175	0.1	5 @ 125°C	]
30	20	T <sub>C</sub> = 137°C	MBR2030CTL	0.52 @ 10 A 0.58 @ 20 A	150	150	5	40	CASE 221A-09
45	20	T <sub>C</sub> = 135°C	MBR2045CT	0.84 @ 20 A	150	150	0.1	15 @ 125°C	(TO-220AB)
60	20	T <sub>C</sub> = 133°C	MBR2060CT	0.85 @ 10 A 0.95 @ 20 A	150	150	0.1	6 @ 125°C	
80	20	T <sub>C</sub> = 133°C	MBR2080CT	0.95 @ 20 A	150	150	0.1	6 @ 125°C	30
90	20	T <sub>C</sub> = 133°C	MBR2090CT	0.95 @ 20 A	150	150	0.1	6 @ 125°C	1.2
100	20	T <sub>C</sub> = 133°C	MBR20100CT	0.85 @ 10 A 0.95 @ 20 A	150	150	0.1	6 @ 125°C	3
200	20	T <sub>C</sub> = 125°C	MBR20200CT	1.0 @ 20 A	150	150	1	50 @ 125°C	
35	25	T <sub>C</sub> = 95°C	MBR2535CTL	0.55 @ 25 A	150	125	5	500 @ 125°C	
45	25	T <sub>C</sub> = 130°C	MBR2545CT	0.82 @ 30 A	150	150	0.2	40 @ 125°C	
35	7.5	T <sub>C</sub> = 105°C	MBR735	0.84 @ 15 A	150	150	0.1	15 @ 125°C	
45	7.5	T <sub>C</sub> = 105°C	MBR745	0.84 @ 15 A	150	150	0.1	15 @ 125°C	
35	10	T <sub>C</sub> = 135°C	MBR1035	0.84 @ 20 A	150	150	0.1	15 @ 125°C	
45	10	T <sub>C</sub> = 135°C	MBR1045	0.84 @ 20 A	150	150	0.1	15 @ 125°C	CASE 221B-04 (TO-220AC)
60	10	T <sub>C</sub> = 133°C	MBR1060	0.80 @ 10 A	150	150	0.1	6 @ 125°C	
90	10	T <sub>C</sub> = 133°C	MBR1090	0.70 @ 10 A	150	150	0.1	6 @ 125°C	
100	10	T <sub>C</sub> = 133°C	MBR10100	0.80 @ 10 A	150	150	0.1	6 @ 125°C	30- <b>P</b>
35	16	T <sub>C</sub> = 125°C	MBR1635	0.63 @ 16 A	150	150	0.2	40 @ 125°C	3
45	16	T <sub>C</sub> = 125°C	MBR1645	0.63 @ 16 A	150	150	0.2	40 @ 125°C	1
15	25	T <sub>C</sub> = 90°C	MBR2515L	0.45 @ 25 A	150	100	15	200 @ 70°C	
60	20	T <sub>C</sub> = 133°C	NBRF2060CT	0.95 @ 20 A	150	150	0.15	15 @ 125°C	
100	20	T <sub>C</sub> = 133°C	<b>% MBRF20100CT</b>	0.95 @ 20 A	150	150	0.15	15 @ 125°C	221D-03 FULL PAK
200	20	T <sub>C</sub> = 125°C	<b>%)</b> MBRF20200CT	1.0 @ 20 A	150	150	1	50 @ 125°C	
45	25	T <sub>C</sub> = 125°C	SU MBRF2545CT	0.82 @ 25 A	150	150	0.2	40 @ 125°C	3

 $^{(2)}V_{RRM}$  unless noted  $^{(3)}V_{RRM},\,T_J$  = 100°C unless noted  $\radsim M$  Indicates UL Recognized - File #E69369

### Table 9. TO-218 and TO-247 Schottky Rectifiers

V <sub>RRM</sub> (Volts)	l <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> <sup>(2)</sup> T <sub>C</sub> = 25°C (mA)	Max I <sub>R</sub> <sup>(3)</sup> (mA)	Package
45	30	T <sub>C</sub> = 105°C	MBR3045PT	0.76 @ 30 A	200	150	1	100 @ 125°C	
45	40	T <sub>C</sub> = 125°C	MBR4045PT	0.70 @ 20 A 0.80 @ 40 A	400	150	1	50	340D-02 (TO-218AC)
45	60	T <sub>C</sub> = 125°C	MBR6045PT	0.62 @ 30 A 0.75 @ 60 A	500	150	1	50	
45	30	T <sub>C</sub> = 105°C	MBR3045WT	0.76 @ 30 A	200	150	1	100 @ 125°C	
15	40	T <sub>C</sub> = 125°C	MBR4015LWT	0.42 @ 20 A 0.50 @ 40 A	400	100	5	150 @ 75°C	CASE 340L-02 (TO-247)
45	40	T <sub>C</sub> = 125°C	MBR4045WT	0.70 @ 20 A 0.80 @ 40 A	400	150	1	50	
45	60	T <sub>C</sub> = 125°C	MBR6045WT	0.62 @ 30 A 0.75 @ 60 A	500	150	1	50	3 <b>0-⊅ -</b> ]

 $^{(2)}V_{RRM}$  unless noted  $^{(3)}V_{RRM}$ , T<sub>J</sub> = 100°C unless noted

#### Table 10. POWERTAP II Schottky Rectifiers

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V <sub>RRM</sub> (Volts)	I <sub>O</sub> <sup>(1)</sup> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> (2) T <sub>C</sub> = 25°C (mA)	Max I <sub>R</sub> <sup>(3)</sup> (mA)	Package
30	200	T <sub>C</sub> = 125°C	MBRP20030CTL	0.52 @ 100 A 0.60 @ 200 A	1500	150	5	-	
30	400	T <sub>C</sub> = 100°C	MBRP40030CTL*	0.50 @ 200 A	1500	150	20	1000 @ 100°C	CASE 357C-03 POWERTAP™
35	600	T <sub>C</sub> = 100°C	MBRP60035CTL	0.57 @ 300 A	4000	150	10	250	FOWLKIAF
45	200	T <sub>C</sub> = 125°C	MBRP20045CT	0.78 @ 100 A	1500	150	0.5	50 @ 125°C	
45	300	T <sub>C</sub> = 120°C	MBRP30045CT	0.70 @ 150 A 0.82 @ 300 A	2500	150	0.8	75 @ 125°C	
45	400	T <sub>C</sub> = 100°C	MBRP40045CTL	0.57 @ 200 A	2500	150	10	-	
60	200	T <sub>C</sub> = 125°C	MBRP20060CT	0.800 @ 100 A	1500	150	0.5	50 @ 125°C	20₩ 3
60	300	T <sub>C</sub> = 120°C	MBRP30060CT	0.79 @ 150 A 0.89 @ 300 A	2500	150	0.8	75 @ 125°C	Cathode = Mounting Plate Anode = Terminal
100	400	T <sub>C</sub> = 100°C	MBRP400100CTL	0.83 @ 200 A	2500	150	6	-	

★ New Product

### **NEW UltraSoft Rectifiers**

#### Table 11. UltraSoft Rectifiers (For High Speed Rectification)

V <sub>RRM</sub> (Volts)	I <sub>O</sub> <sup>(1)</sup> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 29°C (Volts)	t <sub>rr</sub> (ηSec)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> (2) T <sub>C</sub> = 25°C (μΑ)	Max I <sub>R</sub> <sup>(3)</sup> (μΑ) T <sub>J</sub> = 150°C	Package
200	6	T <sub>C</sub> = 145°C	MSRD620CT ★	1.2 @ 6.0 A	55	150	5	200	CASE 369A-13 (DPAK) 30 - 0 4 104 30 - 104 30 30 - 104 30 30 - 104 30 30 30 30 - 104 30 30 30 30 30 30
600	8	T <sub>C</sub> = 125°C	MSR860	1.7 @ 8.0 A	120	150	10 µA	1000	CASE 221B-04 Style 1
600	15	T <sub>C</sub> = 125°C	MSR1560	1.8 @ 15 A	45	150	15	5000	

★ New Product

### **Ultrafast Rectifiers**

Table 12. Surface Mount Ultrafast Rectifiers

V <sub>RRM</sub> (Volts)	I <sub>O</sub> <sup>(1)</sup> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max t <sub>rr</sub> (ns)	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> <sup>(2)</sup> T <sub>J</sub> = 25°C (μΑ)	Max I <sub>R</sub> <sup>(4)</sup> (µA) Package	Packa	ge
50	1	T <sub>L</sub> = 155°C	MURA105T3	30	0.875 @ 1.0 A	50	175	2	50		
100	1	T <sub>L</sub> = 155°C	MURA110T3	30	0.875 @ 1.0 A	50	175	2	50		
150	1	T <sub>L</sub> = 155°C	MURA115T3	35	0.875 @ 1.0 A	40	175	2	50		
200	1	T <sub>L</sub> = 155°C	MURA120T3	35	0.875 @ 1.0 A	40	175	2	50		
300	1	T <sub>L</sub> = 150°C	MURA130T3	35	1.1 @ 1.0 A	35	175	5	150		
400	1	T <sub>L</sub> = 150°C	MURA140T3	35	1.1 @ 1.0 A	35	175	5	150	CASE 40	
600	1	T <sub>L</sub> = 145°C	MURA160T3	75	1.25 @ 1.0 A	30	175	5	150	5101	A
50	2	T <sub>L</sub> = 135°C	MURA205T3	30	0.94 @ 2.0 A	50	175	2	50		
100	2	T <sub>L</sub> = 135°C	MURA210T3	30	0.94 @ 2.0 A	50	175	2	50		
150	2	T <sub>L</sub> = 135°C	MURA215T3	35	0.95 @ 2.0 A	40	175	2	50	Cathode = Po	larity Band
200	2	T <sub>L</sub> = 135°C	MURA220T3	35	0.95 @ 2.0 A	40	175	2	50		
300	2	T <sub>L</sub> = 125°C	MURA230T3	65	1.3 @ 2.0 A	35	175	5	150		
400	2	T <sub>L</sub> = 125°C	MURA240T3	65	1.3 @ 2.0 A	35	175	5	150		
600	2	T <sub>L</sub> = 110°C	MURA260T3	75	1.45 @ 2.0 A	30	175	5	150		
50	1	T <sub>L</sub> = 155°C	MURS105T3	35	0.875 @ 1.0 A	40	175	2	50		
100	1	T <sub>L</sub> = 155°C	MURS110T3	35	0.875 @ 1.0 A	40	175	2	50		
150	1	T <sub>L</sub> = 155°C	MURS115T3	35	0.875 @ 1.0 A	40	175	2	50	CASE 40	34-03
200	1	T <sub>L</sub> = 155°C	MURS120T3	35	0.875 @ 1.0 A	40	175	2	50	SM	
400	1	T <sub>L</sub> = 150°C	MURS140T3	75	1.25 @ 1.0 A	35	175	5	150		
600	1	T <sub>L</sub> = 150°C	MURS160T3	75	1.25 @ 1.0 A	35	175	5	150		
200	2	T <sub>L</sub> = 145°C	MURS220T3	35	0.95 @ 2.0 A	40	175	2	50	~	*
300	2	T <sub>L</sub> = 125°C	MURS230T3	65	1.3 @ 2.0 A	35	175	5	150	Cathode = P	olarity Band
400	2	T <sub>L</sub> = 125°C	MURS240T3	65	1.3 @ 2.0 A	35	175	5	150		
600	2	T <sub>L</sub> = 125°C	MURS260T3	75	1.45 @ 2.0 A	35	175	5	150		
200	3	$T_L = 140^{\circ}C$	MURS320T3	35	0.875 @ 3.0 A	75	175	5	150	CASE 403-0	3
400	3	T <sub>L</sub> = 130°C	MURS340T3	75	1.25 @ 3.0 A	75	175	10	250	SMC	b _
600	3	T <sub>L</sub> = 130°C	MURS360T3	75	1.25 @ 3.0 A	75	175	10	250	Cathode = Not	ich 🔍
200	6	T <sub>C</sub> = 140°C	MURD620CT	35	1.0 @ 3.0 A	50	175	5	250 @ 125°C		1 <b>0-▶</b>
200	3	T <sub>C</sub> = 158°C	MURD320	35	.95 @ 3.0 A	75	175	5	500 @ 125°C		30-₽ <sup>C</sup> "CT" Suffi
400	8	T <sub>C</sub> = 120°C	MURHB840CT	28	2.2 @ 4.0 A	100	175	10	500	D <sup>2</sup> PAK CASE	
600	8	T <sub>C</sub> = 120°C	MURHB860CT	35	2.8 @ 4.0 A	100	175	10	500	418B-04	<sup>1</sup> 0 30 ► 0
200	16	T <sub>C</sub> = 150°C	MURB1620CT	35	0.975 @ 8.0 A	100	175	5	250		Non-"CT" Suffix
600	16	T <sub>C</sub> = 150°C	MURB1660CT	60	1.5 @ 8.0 A	100	175	10	500	1 3	

#### Table 13. Axial Lead Ultrafast Rectifiers

V <sub>RRM</sub> (Volts)	l <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max t <sub>rr</sub> (ns)	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> <sup>(2)</sup> T <sub>J</sub> = 25°C (μΑ)	Max I <sub>R</sub> <sup>(4)</sup> (μΑ)	Package
50	1	T <sub>A</sub> = 130°C	MUR105	35	0.875 @ 1.0 A	35	175	2	50	
100	1	T <sub>A</sub> = 130°C	MUR110	35	0.875 @ 1.0 A	35	175	2	50	
150	1	T <sub>A</sub> = 130°C	MUR115	35	0.875 @ 1.0 A	35	175	2	50	
200	1	T <sub>A</sub> = 130°C R <sub>θJA</sub> = 50°C/W	MUR120	25	0.875 @ 1.0 A	35	175	2	50	
300	1	T <sub>A</sub> = 120°C	MUR130	75	1.25 @ 1.0 A	35	175	5	150	
400	1	T <sub>A</sub> = 120°C	MUR140	75	1.25 @ 1.0 A	35	175	5	150	CASE 59-10
600	1	T <sub>A</sub> = 120°C R <sub>θJA</sub> = 50°C/W	MUR160	50	1.25 @ 1.0 A	35	175	5	150	(DO-41) Plastic
800	1	$T_A = 95^{\circ}C$	MUR180E	75	1.75 @ 1.0 A	35	175	10	600 @ 100°C	Cathode = Polarity Band
1000	1	$T_A = 95^{\circ}C$ $R_{\Theta JA} = 50^{\circ}C/W$	MUR1100E	75	1.75 @ 1.0 A	35	175	10	600 @ 100°C	
200	2	$T_A = 90^{\circ}C$	MUR220	35	0.95 @ 2.0 A	35	175	2	50	
400	2	$T_A = 85^{\circ}C$	MUR240	65	1.15 @ 2.0 A	35	175	5	150	
600	2	$T_A=60^{\circ}C$	MUR260	75	1.35 @ 2.0 A	35	175	5	150	
1000	2	$T_A = 35^{\circ}C$	MUR2100E	100	2.2 @ 2.0 A	35	175	10	600	
50	4	$T_A=80^\circ C$	MUR405	35	0.89 @ 2.0 A	125	175	5	150	
100	4	$T_A = 80^{\circ}C$	MUR410	35	0.89 @ 2.0 A	125	175	5	150	
150	4	$T_A = 80^{\circ}C$	MUR415	35	0.89 @ 2.0 A	125	175	5	150	_
200	4	T <sub>A</sub> = 80°C R <sub>θJA</sub> = 28°C/W	MUR420	25	0.875 @ 3.0 A	125	175	5	150	CASE 267-05
400	4	T <sub>A</sub> = 40°C	MUR440	75		75	175	10	250	(DO-201AD)
600	4	T <sub>A</sub> = 40°C R <sub>θJA</sub> = 28°C/W	MUR460	50	1.25 @ 3.0 A	70	175	10	250	Plastic Cathode = Polarity Band
800	4	$T_A = 35^{\circ}C$	MUR480E	75	1.75 @ 3.0 A	70	175	25	900	
1000	4	$T_A = 35^{\circ}C$ $R_{\theta JA} = 28^{\circ}C/W$	MUR4100E	75	1.75 @ 3.0 A	70	175	25	900	

 $^{(2)}V_{RRM}$  unless noted (4) $V_{RRM}$ , T<sub>J</sub> = 150°C unless noted

#### Table 14. TO-220 Ultrafast and MEGAHERTZ<sup>™</sup> Rectifiers

V <sub>RRM</sub> (Volts)	I <sub>O</sub> <sup>(1)</sup> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max t <sub>rr</sub> (ns)	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> <sup>(2)</sup> T <sub>C</sub> = 25°C (μΑ)	Max I <sub>R</sub> <sup>(4)</sup> (μΑ)	Package
200	6	$T_C = 130^{\circ}C$	MUR620CT	35	0.975 @ 3.0 A	75	175	5	250	CASE 221A-09
400	8	T <sub>C</sub> = 120°C	MURH840CT	28	2.2 @ 4.0 A	100	175	10	500	(TO-220AB)
600	8	$T_C = 120^{\circ}C$	MURH860CT	35	2.8 @ 4.0 A	100	175	10	500	10-▶
100	16	T <sub>C</sub> = 150°C	MUR1610CT	35	0.975 @ 8.0 A	100	175	5	250	30→
150	16	$T_C = 150^{\circ}C$	MUR1615CT	35	0.975 @ 8.0 A	100	175	5	250	1
200	16	T <sub>C</sub> = 150°C	MUR1620CT	35	0.975 @ 8.0 A	100	175	5	250	
200	16	$T_C = 160^{\circ}C$	MUR1620CTR	85	1.2 @ 8.0 A	100	175	5	500	
400	16	T <sub>C</sub> = 150°C	MUR1640CT	60	1.30 @ 8.0 A	100	175	10	250	MUR1620CTR Only
600	16	T <sub>C</sub> = 150°C	MUR1660CT	60	1.5 @ 8.0 A	100	175	10	500	only
50	8	T <sub>C</sub> = 150°C	MUR805	35	0.975 @ 8.0 A	100	175	5	250	
100	8	T <sub>C</sub> = 150°C	MUR810	35	0.975 @ 8.0 A	100	175	5	250	
150	8	$T_C = 150^{\circ}C$	MUR815	35	0.975 @ 8.0 A	100	175	5	250	
200	8	$T_C = 150^{\circ}C$	MUR820	35	0.975 @ 8.0 A	100	175	5	250	
400	8	T <sub>C</sub> = 150°C	MUR840	50	1.30 @ 8.0 A	100	175	10	500	CASE 221B-04
600	8	T <sub>C</sub> = 150°C	MUR860	50	1.50 @ 8.0 A	100	175	10	500	(TO-220AC)
800	8	T <sub>C</sub> = 150°C	MUR880E	75	1.80 @ 8.0 A	100	175	25	500 @ 100°C	
100	15	$T_C = 150^{\circ}C$	MUR1510	35	1.05 @ 15 A	200	175	10	500	3 <b>0-₩</b> <sup>1</sup>
150	15	T <sub>C</sub> = 150°C	MUR1515	35	1.05 @ 15 A	200	175	10	500	
200	15	T <sub>C</sub> = 150°C	MUR1520	35	1.05 @ 15 A	200	175	10	500	3
400	15	T <sub>C</sub> = 150°C	MUR1540	60	1.25 @ 15 A	150	175	10	500	
600	15	T <sub>C</sub> = 145°C	MUR1560	60	1.50 @ 15 A	150	175	10	1000	
200	20	T <sub>C</sub> = 125°C	MUR2020R	95	1.10 @ 20 A	250	175	50	1000	
1000	8	$T_C = 150^{\circ}C$	MUR8100E	75	1.80 @ 8.0 A	100	175	25	500 @ 100°C	
200	16	T <sub>C</sub> = 150°C	NURF1620CT	35	0.975 @ 8.0 A	100	150	5	250	CASE 221D-03
600	16	T <sub>C</sub> = 150°C	MURF1660CT	60	1.5 @ 8.0 A	100	175	10	500	0[9]
600	8	$T_C \le 120^{\circ}C$	MURHF860CT ★	35	2.8 @ 4.0 A	100	150	10	500	olo

**N** Indicates UL Recognized - File #E69369 \* New Product

#### Table 15. TO-218 and TO-247 Ultrafast Rectifiers

V <sub>RRM</sub> (Volts)	l <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max t <sub>rr</sub> (ns)	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> <sup>(2)</sup> T <sub>J</sub> = 25°C (μΑ)	Max I <sub>R</sub> <sup>(4)</sup> (mA)	Package
200	30	T <sub>C</sub> = 145°C	MUR3020WT	35	1.05 @ 15 A	200	175	10	0.5	CASE 340L-02 (TO-247)
600	30	T <sub>C</sub> = 145°C	MUR3060WT	60	1.70 @ 15 A	150	175	10	1	
200	30	$T_C = 150^{\circ}C$	MUR3020PT	35	1.05 @ 15 A	200	175	10	0.5	CASE 340D-02 (TO-218AC)
400	30	$T_{C} = 150^{\circ}C$	MUR3040PT	60	1.25 @ 15 A	150	175	10	0.5	
600	30	$T_C = 145^{\circ}C$	MUR3060PT	60	1.50 @ 15 A	150	175	10	1	

 $^{(2)}V_{RRM}$  unless noted (4) $V_{RRM},\,T_{J}$  = 150°C unless noted

#### Table 16. POWERTAP II Ultrafast Rectifiers

V <sub>RRM</sub> (Volts)	l <sub>O</sub> <sup>(1)</sup> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max t <sub>rr</sub> (ns)	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>C</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> <sup>(2)</sup> T <sub>J</sub> = 25°C (μΑ)	Max I <sub>R</sub> <sup>(4)</sup> (mA)	Package
200	200	T <sub>C</sub> = 130°C	MURP20020CT	50	1.00 @ 100 A	800	175	150	1 @ 125°C	CASE 357C-03 POWERTAP™
400	200	T <sub>C</sub> = 100°C	MURP20040CT	50	1.30 @ 100 A	800	175	50	0.5 @ 125°C	3 Cathode = Mounting Plate Anode = Terminal

 $^{(1)}$  is total device current capability.  $^{(2)}$  V<sub>RRM</sub> unless noted  $^{(4)}$  V<sub>RRM</sub>, T<sub>J</sub> = 150°C unless noted

V <sub>RRM</sub> (Volts)	l <sub>O</sub> (Amperes)	I <sub>O</sub> Rating Condition	Device	Max V <sub>F</sub> @ i <sub>F</sub> T <sub>J</sub> = 25°C (Volts)	Max t <sub>rr</sub> (ns)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	Max I <sub>R</sub> <sup>(2)</sup> T <sub>J</sub> = 25°C (μΑ)	Max I <sub>R</sub> <sup>(3)</sup> (µA)	Package
400	1.5	T <sub>L</sub> = 118°C	MRS1504T3	1.04 @ 1.5 A	-	50	150	1	340	CASE 403A-03 SMB
300	1	T <sub>L</sub> = 150°C	MRA4003T3 *	1.1 @ 1.0 A	-	30	175	10	50	CASE 403B-02
400	1	T <sub>L</sub> = 150°C	MRA4004T3 *	1.1 @ 1.0 A	-	30	175	10	50	SMA
600	1	T <sub>L</sub> = 150°C	MRA4005T3 *	1.1 @ 1.0 A	-	30	175	10	50	
800	1	T <sub>L</sub> = 150°C	MRA4006T3 *	1.1 @ 1.0 A	-	30	175	10	50	Cathode = Notch
1000	1	T <sub>L</sub> = 150°C	MRA4007T3 *	1.1 @ 1.0 A	-	30	175	10	50	
50	1	T <sub>A</sub> = 75°C	1N4001RL	1.1 @ 1.0 A	-	30	150	10	50	
100	1	T <sub>A</sub> = 75°C	1N4002RL	1.1 @ 1.0 A	-	30	150	10	50	
200	1	T <sub>A</sub> = 75°C	1N4003RL	1.1 @ 1.0 A	-	30	150	10	50	
400	1	T <sub>A</sub> = 75°C	1N4004RL	1.1 @ 1.0 A	-	30	150	10	50	
600	1	T <sub>A</sub> = 75°C	1N4005RL	1.1 @ 1.0 A	-	30	150	10	50	CASE 59-10 <sup>(7)</sup> (DO-41)
800	1	T <sub>A</sub> = 75°C	1N4006RL	1.1 @ 1.0 A	-	30	150	10	50	Plastic
1000	1	T <sub>A</sub> = 75°C	1N4007RL	1.1 @ 1.0 A	-	30	150	10	50	(a)
50	1	T <sub>A</sub> = 75°C	1N4933RL	1.2 @ 1.0 A	200	30	150	5	100	Cathode = Polarity Band
100	1	T <sub>A</sub> = 75°C	1N4934RL	1.2 @ 1.0 A	200	30	150	5	100	
200	1	T <sub>A</sub> = 75°C	1N4935RL	1.2 @ 1.0 A	200	30	150	5	100	
400	1	T <sub>A</sub> = 75°C	1N4936RL	1.2 @ 1.0 A	200	30	150	5	100	
600	1	$T_A = 75^{\circ}C$	1N4937RL	1.2 @ 1.0 A	200	30	150	5	100	
50	3	$T_L = 105^{\circ}C$	1N5400RL	1.2 @ 9.4 A	-	200	150	10	500 @ 150°C	
100	3	T <sub>L</sub> = 105°C	1N5401RL	1.2 @ 9.4 A	-	200	150	10	500 @ 150°C	
200	3	$T_L = 105^{\circ}C$	1N5402RL	1.2 @ 9.4 A	-	200	150	10	500 @ 150°C	
400	3	T <sub>L</sub> = 105°C	1N5404RL	1.2 @ 9.4 A	-	200	150	10	500 @ 150°C	CASE 267-05 (DO-201AD)
600	3	$T_L = 105^{\circ}C$	1N5406RL	1.2 @ 9.4 A	-	200	150	10	500 @ 150°C	Plastic
800	3	$T_L = 105^{\circ}C$	1N5407RL	1.2 @ 9.4 A	-	200	150	10	500 @ 150°C	
1000	3	T <sub>L</sub> = 105°C	1N5408RL	1.2 @ 9.4 A	-	200	150	10	500 @ 150°C	Cathodo Dalarity Dana
200	3	$T_A = 80^{\circ}C^{(8)}$	MR852RL	1.25 @ 3.0 A	200	100	150	10	150	Cathode = Polarity Band
400	3	$T_{A} = 80^{\circ}C^{(8)}$	MR854RL	1.25 @ 3.0 A	200	100	150	10	150	
600	3	$T_{A} = 80^{\circ}C^{(8)}$	MR856RL	1.25 @ 3.0 A	200	100	150	10	150	
50	6	T <sub>A</sub> = 60°C R <sub>θJA</sub> = 25°C/W	MR750RL	1.25 @ 100 A	-	400	175	25	1000	
100	6	T <sub>A</sub> = 60°C R <sub>θJA</sub> = 25°C/W	MR751RL	1.25 @ 100 A	-	400	175	25	1000	CASE 194-04
200	6	T <sub>A</sub> = 60°C R <sub>θJA</sub> = 25°C/W	MR752RL	1.25 @ 100 A	-	400	175	25	1000	Plastic
400	6	T <sub>A</sub> = 60°C R <sub>θJA</sub> = 25°C/W	MR754RL	1.25 @ 100 A	-	400	175	25	1000	Cathode indicated by diode symbol
600	6	$T_A = 60^{\circ}C$ $R_{\Theta JA} = 25^{\circ}C/W$	MR756RL	1.25 @ 100 A	-	400	175	25	1000	
1000	6	$T_A = 60^{\circ}C$ $R_{\Theta JA} = 25^{\circ}C/W$	MR760RL	1.25 @ 100 A	-	400	175	25	1000	
200	25	T <sub>C</sub> = 150°C	MR2502	1.18 @ 78.5 A	-	400	175	100	500	CASE 193-04
400	25	T <sub>C</sub> = 150°C	MR2504	1.18 @ 78.5 A	-	400	175	100	500	Plastic
1000	25	T <sub>C</sub> = 150°C	MR2510	1.18 @ 78.5 A	-	400	175	100	500	Ø
250	32	T <sub>C</sub> = 150°C	TRA3225	1.15 @ 100 A	-	500	175	10	250	Cathode = Polarity Band
250	25	T <sub>C</sub> = 150°C	TRA2525	1.18 @ 100 A	-	400	175	10	250	

#### Fast Recovery Rectifiers/General-Purpose Rectifiers Table 17. Fast Recovery Rectifiers/General Purpose Rectifiers

 $^{(2)}V_{RRM}$  unless noted  $^{(3)}V_{RRM},\,T_J$  = 100°C unless noted  $^{(7)}Package$  Size: 0.120" max diameter by 0.260" length.

<sup>(8)</sup>Must be derated for reverse power dissipation. See data sheet. <sup>(9)</sup>Overvoltage Transient Suppressor: 24-32 volts avalanche voltage.

\* New Product

#### Table 18. Overvoltage Transient Suppressors

V <sub>RRM</sub> (Volts)	V <sub>BR</sub> <sup>(1)</sup> (Volts)	V <sub>BR</sub> (Volts)	l <sub>O</sub> (Amperes)	Device	Max V <sub>F</sub> T <sub>J</sub> = 25°C (Volts)	I <sub>FSM</sub> (Amperes)	T <sub>J</sub> Max (°C)	I <sub>RSM</sub> (Amperes)	Max I <sub>R</sub> <sup>(6)</sup> (μΑ)	Package
23	24-32	40(4)	6 T <sub>L</sub> = 125°C	MR2520L	1.25 I <sub>F</sub> = 100A	400	175	58(5)	10	CASE 194-04 Plastic
20	24-32	40 <sup>(2)</sup>	6 T <sub>C</sub> = 125°C	MR2535L	1.1 I <sub>F</sub> = 100A	400	175	62 <sup>(5)</sup>	0.2	Cathode = Diode Symbol
20	24-32	40 <sup>(3)</sup>	32 T <sub>C</sub> = 150°C	TRA2532	1.18 I <sub>F</sub> = 100A	500	175	80 <sup>(5)</sup>	10	CASE 193-04 Plastic Solution Cathode = Polarity Band
23	24-32	40 <sup>(3)</sup>	32 T <sub>C</sub> = 150°C	MR2835SK	1.1 I <sub>F</sub> = 100A	400	175	62 <sup>(5)</sup>	5 @ 20 V	CASE 460-02 Top Can Cathode = Terminal

 $^{(5)} Time \ Constant$  = 10 mS, 25°C  $^{(6)} At \ V_{RRM}, \ T_j$  = 25°C unless noted

# CHAPTER 3 Schottky Data Sheets

# MBR0520LT1, MBR0520LT3

**Preferred Devices** 

# Surface Mount Schottky Power Rectifier

## Plastic SOD-123 Package

The Schottky Power Rectifier employs the Schottky Barrier principle with a barrier metal that produces optimal forward voltage drop-reverse current tradeoff. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package provides an alternative to the leadless 34 MELF style package. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Very Low Forward Voltage (0.38 V Max @ 0.5 A, 25°C)
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Package Designed for Optimal Automated Board Assembly

#### Mechanical Characteristics

- Reel Options: MBR0520LT1 = 3,000 per 7" reel/8 mm tape. MBR0520LT3 = 10,000 per 13" reel/8 mm tape.
- Device Marking: B2
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	V
Average Rectified Forward Current (Rated $V_R$ , $T_L$ = 90°C)	I <sub>F(AV)</sub>	0.5	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	5.5	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +125	°C
Operating Junction Temperature	TJ	-65 to +125	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	1000	V/μs



### ON Semiconductor<sup>™</sup>

http://onsemi.com

### SCHOTTKY BARRIER RECTIFIER 0.5 AMPERES 20 VOLTS



SOD-123 CASE 425 STYLE 1

#### MARKING DIAGRAM



B2 = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBR0520LT1	SOD-123	3000/Tape & Reel
MBR0520LT3	SOD-123	10,000/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

Semiconductor Components Industries, LLC, 2000 October, 2000 - Rev. 3

## MBR0520LT1, MBR0520LT3

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance — Junction to Ambient (Note 1.)	$R_{\thetaJA}$	206	°C/W
Thermal Resistance — Junction to Lead	$R_{ extsf{ heta}JL}$	150	°C/W

#### **ELECTRICAL CHARACTERISTICS**

		-		
Maximum Instantaneous Forward Voltage (Note 2.)	٧ <sub>F</sub>	$T_J = 25^{\circ}C$	$T_J = 100^{\circ}C$	Volts
(i <sub>F</sub> = 0.1 Amps) (i <sub>F</sub> = 0.5 Amps)		0.300 0.385	0.220 0.330	
Maximum Instantaneous Reverse Current (Note 2.)	I <sub>R</sub>	$T_J = 25^{\circ}C$	$T_J = 100^{\circ}C$	mA
(V <sub>R</sub> = 10 V) (Rated dc Voltage = 20 V)		75 μΑ 250 μΑ	5 mA 8 mA	

1. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2%.

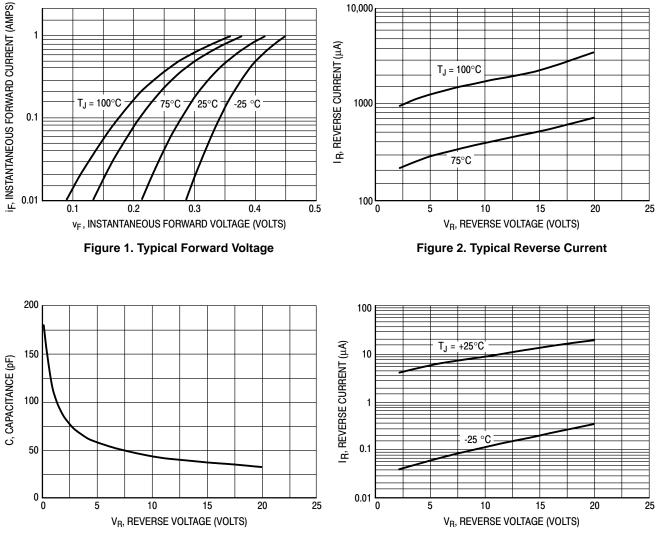


Figure 3. Typical Capacitance

Figure 4. Typical Reverse Current

## MBR0520LT1, MBR0520LT3

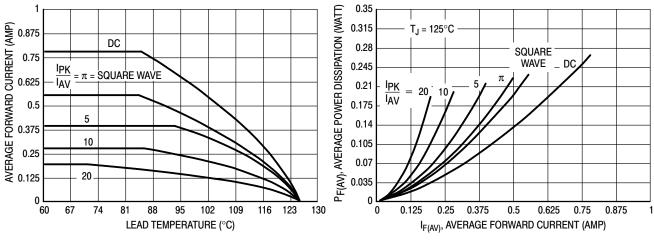


Figure 5. Current Derating (Lead)

Figure 6. Power Dissipation

# MBR0530T1, MBR0530T3

**Preferred Devices** 

# Surface Mount Schottky Power Rectifier

Plastic SOD-123 Package

... using the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Package Designed for Optimal Automated Board Assembly

#### Mechanical Characteristics

- Reel Options: MBR0530T1 = 3,000 per 7" reel/8 mm tape MBR0530T3 = 10,000 per 13" reel/8 mm tape
- Device Marking: B3
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Average Rectified Forward Current (Rated V <sub>R</sub> , T <sub>L</sub> = 100°C)	I <sub>F(AV)</sub>	0.5	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	5.5	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +125	°C
Operating Junction Temperature	TJ	-65 to +125	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	1000	V/μs



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### SCHOTTKY BARRIER RECTIFIER 0.5 AMPERES 30 VOLTS



SOD-123 CASE 425 STYLE 1

#### MARKING DIAGRAM



B3 = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBR0530T1	SOD-123	3000/Tape & Reel
MBR0530T3	SOD-123	10,000/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

Semiconductor Components Industries, LLC, 2000 October, 2000 - Rev. 2

## MBR0530T1, MBR0530T3

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance — Junction to Ambient (Note 1.)	$R_{\thetaJA}$	206	°C/W
Thermal Resistance — Junction to Lead	$R_{ extsf{ heta}JL}$	150	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 2.) ( $i_F = 0.1 \text{ Amps}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 0.5 \text{ Amps}, T_J = 25^{\circ}\text{C}$ )	۷F	0.375 0.43	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_C = 25^{\circ}C$ ) ( $V_R = 15 V, T_C = 25^{\circ}C$ )	I <sub>R</sub>	130 20	μΑ

1. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq 2\%$ .

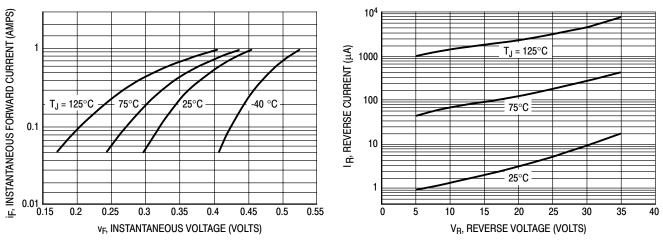


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

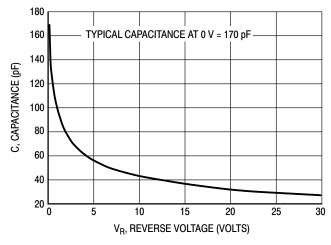


Figure 3. Typical Capacitance

## MBR0530T1, MBR0530T3

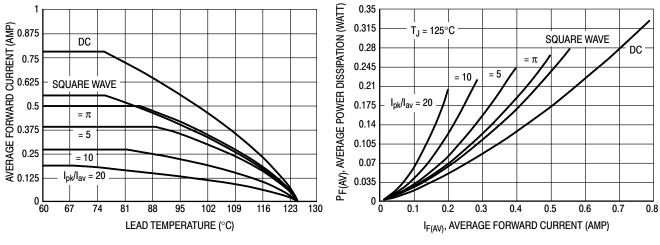


Figure 4. Current Derating (Lead)

Figure 5. Power Dissipation

# MBR0540T1, MBR0540T3

# Surface Mount Schottky Power Rectifier

## SOD-123 Power Surface Mount Package

The Schottky Power Rectifier employs the Schottky Barrier principle with a barrier metal that produces optimal forward voltage drop-reverse current tradeoff. Ideally suited for low voltage, high frequency rectification, or as a free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package provides an alternative to the leadless 34 MELF style package. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Very Low Forward Voltage
- Epoxy Meets UL94, VO at 1/8"
- Package Designed for Optimal Automated Board Assembly

#### **Mechanical Characteristics:**

- Reel Options: 3,000 per 7 inch reel/8 mm tape
- Reel Options: 10,000 per 13 inch reel/8 mm tape
- Device Marking: B4
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C max. for 10 Seconds

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 115°C)	Ι <sub>Ο</sub>	0.5	A
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 115°C)	I <sub>FRM</sub>	1.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	5.5	A
Storage/Operating Case Temperature Range	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +150	°C
Voltage Rate of Change (Rated $V_R$ , $T_J$ = 25°C)	dv/dt	1000	V/µs



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## SCHOTTKY BARRIER RECTIFIER 0.5 AMPERES 40 VOLTS



SOD-123 CASE 425 STYLE 1

#### MARKING DIAGRAM



B4 = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping	
MBR0540T1	SOD-123	3000/Tape & Reel	
MBR0540T3	SOD-123	10,000/Tape & Reel	

### MBR0540T1, MBR0540T3

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance - Junction-to-Lead (Note 1.)	R <sub>tjl</sub>	118	°C/W
Thermal Resistance - Junction-to-Ambient (Note 2.)	R <sub>tja</sub>	206	

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3.)	VF	T <sub>J</sub> = 25°C	$T_J = 100^{\circ}C$	V
(i <sub>F</sub> = 0.5 A) (i <sub>F</sub> = 1 A)		0.51 0.62	0.46 0.61	
Maximum Instantaneous Reverse Current (Note 3.)	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	μΑ
(V <sub>R</sub> = 40 V) (V <sub>R</sub> = 20 V)		20 10	13,000 5,000	

1. Mounted with minimum recommended pad size, PC Board FR4.

2. 1 inch square pad size (1 X 0.5 inch for each lead) on FR4 board.

3. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2.0%.

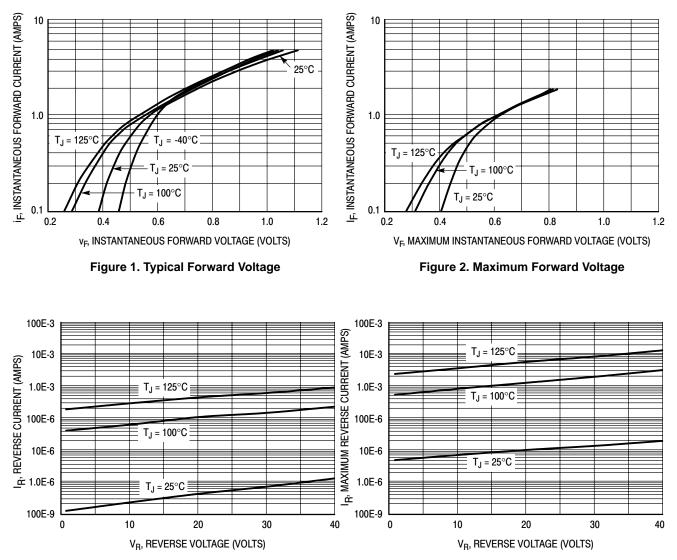
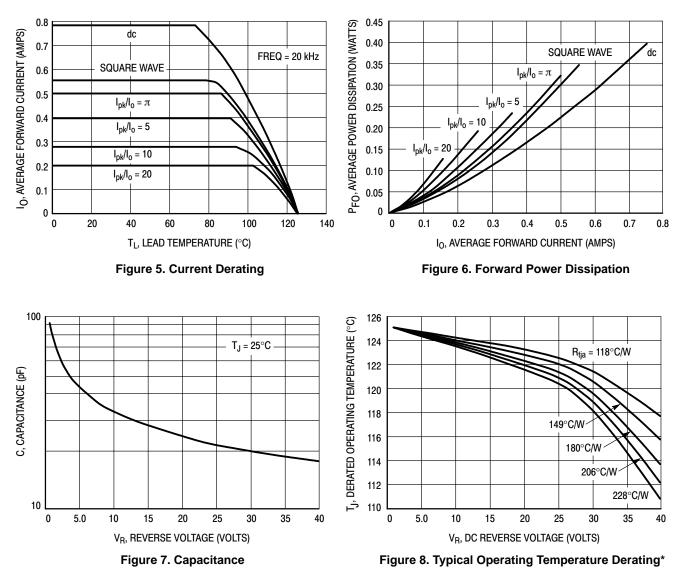


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

# MBR0540T1, MBR0540T3

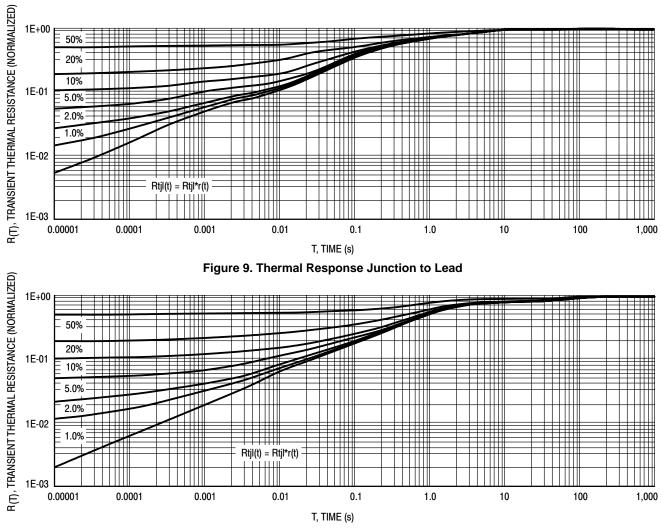


\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of  $T_J$  therefore must include forward and reverse power effects. The allowable operating  $T_J$  may be calculated from the equation:  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

- r(t) = thermal impedance under given conditions,
- Pf = forward power dissipation, and
- Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.

# MBR0540T1, MBR0540T3





# Surface Mount Schottky Power Rectifier

# Plastic SOD-123 Package

... using the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Leakage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, V0 at 1/8"
- Package Designed for Optimal Automated Board Assembly
- ESD Ratings: Machine Model, C
  - Human Body Model, 3B

#### **Mechanical Characteristics**

- Reel Options: MBR120ESFT1 = 3,000 per 7" reel/8 mm tape MBR120ESFT3 = 10,000 per 13" reel/8 mm tape
- Device Marking: L2E
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds



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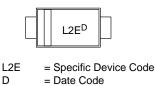
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# SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 20 VOLTS



SOD-123FL CASE 498 PLASTIC

#### **DEVICE MARKING**



#### **ORDERING INFORMATION**

Device	Package	Shipping
MBR120ESFT1	SOD-123FL	3000/Tape & Reel
MBR120ESFT3	SOD-123FL	10,000/Tape & Reel

#### MAXIMUM RATINGS

Symbol	Value	Unit
V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	V
IO	1.0	А
I <sub>FRM</sub>	2.0	A
I <sub>FSM</sub>	40	A
T <sub>stg</sub>	-65 to 150	°C
TJ	-65 to 150	°C
dv/dt	10,000	V/μs
	VRRM       VRWM       VR       IO       IFRM       IFSM       Tstg       TJ	$\begin{array}{c c} V_{RRM} & 20 \\ V_{RWM} & V_{R} \\ \hline I_{O} & 1.0 \\ I_{FRM} & 2.0 \\ \hline I_{FRM} & 2.0 \\ \hline I_{FSM} & 40 \\ \hline T_{stg} & -65 \text{ to } 150 \\ \hline T_{J} & -65 \text{ to } 150 \\ \hline \end{array}$

#### THERMAL CHARACTERISTICS

Thermal Resistance - Junction-to-Lead (Note 1)	R <sub>til</sub>	26	°C/W
Thermal Resistance - Junction-to-Lead (Note 2)	R <sub>til</sub>	21	
Thermal Resistance - Junction-to-Ambient (Note 1)	R <sub>tia</sub>	325	
Thermal Resistance - Junction-to-Ambient (Note 2)	R <sub>tja</sub>	82	

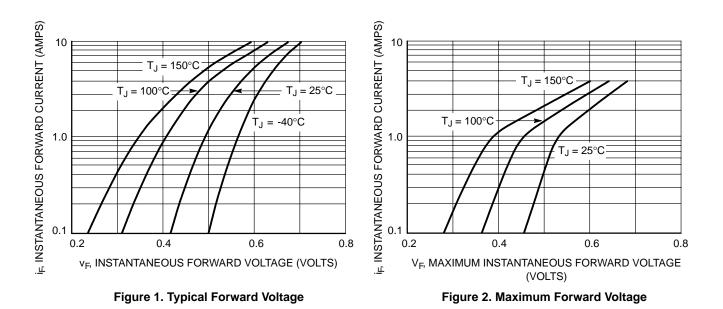
1. Mounted with minimum recommended pad size, PC Board FR4.

2. Mounted with 1 in. copper pad (Cu area 700 mm<sup>2</sup>).

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3), See Figure 2	V <sub>F</sub>	$T_J = 25^{\circ}C$	$T_J = 100^{\circ}C$	V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$ $(I_F = 2.0 \text{ A})$		0.455 0.530 0.595	0.360 0.455 0.540	
Maximum Instantaneous Reverse Current (Note 3), See Figure 4	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	μΑ
$(V_R = 20 V)$ $(V_R = 10 V)$ $(V_R = 5.0 V)$		10 1.0 0.5	1600 500 300	

3. Pulse Test: Pulse Width  $\leq 250~\mu s,$  Duty Cycle  $\leq 2\%.$ 



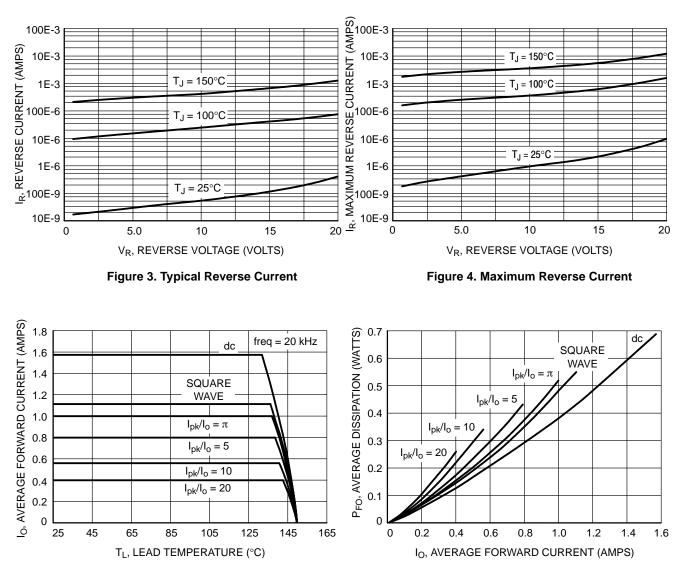
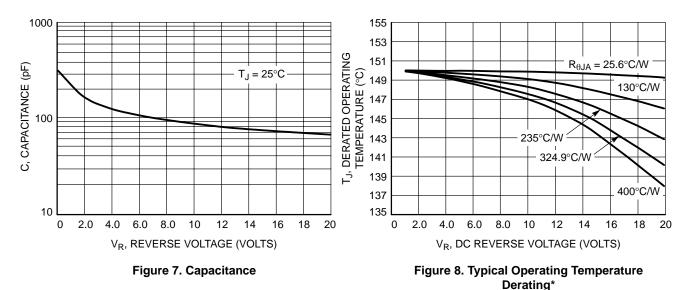


Figure 5. Current Derating

Figure 6. Forward Power Dissipation



\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of  $T_J$  therefore must include forward and reverse power effects. The allowable operating  $T_J$  may be calculated from the equation:  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.

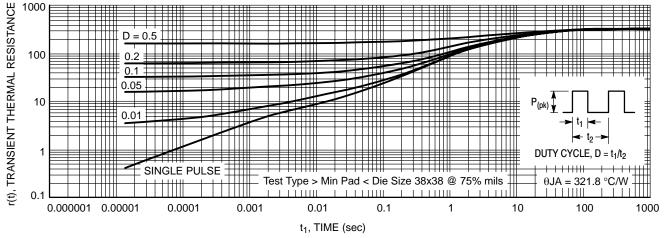


Figure 9. Thermal Response

# Surface Mount Schottky Power Rectifier

# Plastic SOD-123 Package

... using the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, V0 at 1/8"
- Package Designed for Optimal Automated Board Assembly
- ESD Ratings: Machine Model, C

Human Body Model, 3B

#### **Mechanical Characteristics**

- Reel Options: MBR120LSFT1 = 3,000 per 7" reel/8 mm tape MBR120LSFT3 = 10,000 per 13" reel/8 mm tape
- Device Marking: L2L
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds



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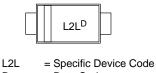
http://onsemi.com

# SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 20 VOLTS



SOD-123FL CASE 498 PLASTIC

#### **DEVICE MARKING**



= Date Code

### ORDERING INFORMATION

D

Device	Package	Shipping
MBR120LSFT1	SOD-123FL	3000/Tape & Reel
MBR120LSFT3	SOD-123FL	10,000/Tape & Reel

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	V
Average Rectified Forward Current (At Rated $V_R$ , $T_L = 115^{\circ}C$ )	IO	1.0	А
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 100 kHz, T <sub>L</sub> = 110°C)	I <sub>FRM</sub>	2.0	A
Non-Repetitive Peak Surge Current (Non-Repetitive peak surge current, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	50	A
Storage Temperature	T <sub>stg</sub>	-55 to 150	°C
Operating Junction Temperature	TJ	-55 to 125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J = 25^{\circ}C$ )	dv/dt	10,000	V/μs

#### THERMAL CHARACTERISTICS

Thermal Resistance - Junction-to-Lead (Note 1)	R <sub>til</sub>	26	°C/W
Thermal Resistance - Junction-to-Lead (Note 2)	R <sub>til</sub>	21	
Thermal Resistance - Junction-to-Ambient (Note 1)	R <sub>tja</sub>	325	
Thermal Resistance - Junction-to-Ambient (Note 2)	R <sub>tja</sub>	82	

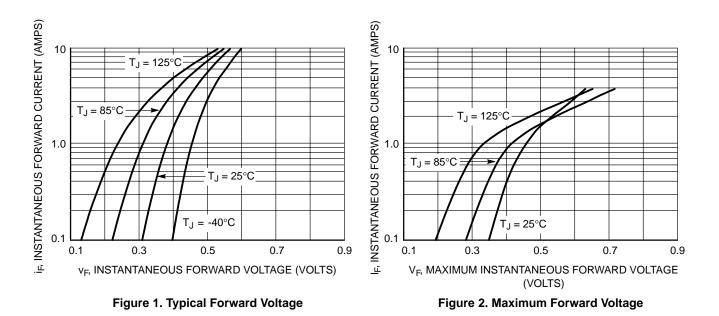
1. Mounted with minimum recommended pad size, PC Board FR4.

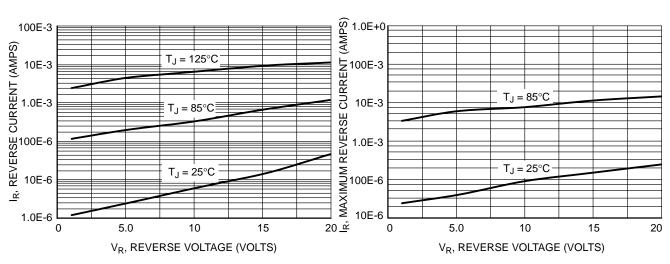
2. Mounted with 1 in. copper pad (Cu area 700 mm<sup>2</sup>).

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3), See Figure 2	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 85°C	V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$ $(I_F = 3.0 \text{ A})$		0.34 0.45 0.65	0.26 0.415 0.67	
Maximum Instantaneous Reverse Current (Note 3), See Figure 4	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 85°C	mA
(V <sub>R</sub> = 20 V) (V <sub>R</sub> = 10 V)		0.40 0.10	25 18	

3. Pulse Test: Pulse Width  $\leq$  250  $\mu s,$  Duty Cycle  $\leq$  2%.









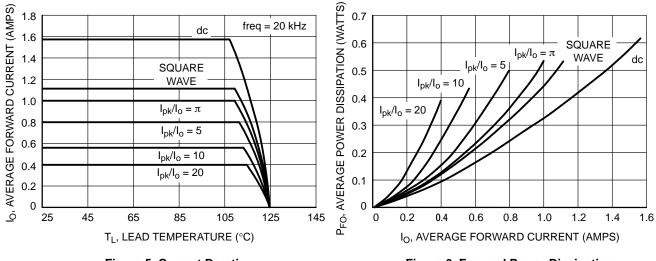
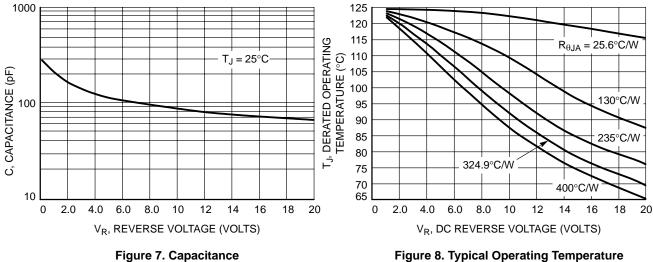


Figure 5. Current Derating

Figure 6. Forward Power Dissipation



. Derating\*

\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of  $T_J$  therefore must include forward and reverse power effects. The allowable operating  $T_J$  may be calculated from the equation:  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.

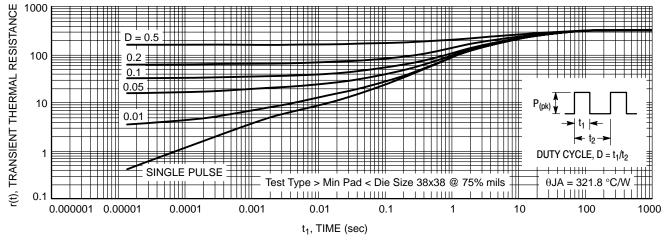


Figure 9. Thermal Response

# Surface Mount Schottky Power Rectifier

# Plastic SOD-123 Package

... using the Schottky Barrier principle with a large area metal-to-silicon power diode. Ideally suited for low voltage, high frequency rectification or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system. This package also provides an easy to work with alternative to leadless 34 package style. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, V0 at 1/8"
- Package Designed for Optimal Automated Board Assembly
- ESD Ratings: Machine Model, C
  - Human Body Model, 3B

#### Mechanical Characteristics

- Reel Options: MBR140SFT1 = 3,000 per 7" reel/8 mm tape MBR140SFT3 = 10,000 per 13" reel/8 mm tape
- Device Marking: L4F
- Polarity Designator: Cathode Band
- Weight: 11.7 mg (approximately)
- Case: Epoxy, Molded
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds



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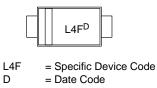
http://onsemi.com

# SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 40 VOLTS



SOD-123FL CASE 498 PLASTIC

#### **DEVICE MARKING**



### ORDERING INFORMATION

Device	Package	Shipping
MBR140SFT1	SOD-123FL	3000/Tape & Reel
MBR140SFT3	SOD-123FL	10,000/Tape & Reel

#### MAXIMUM RATINGS

Symbol	Value	Unit
V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
Io	1.0	А
I <sub>FRM</sub>	2.0	A
I <sub>FSM</sub>	30	A
T <sub>stg</sub>	-55 to 150	°C
TJ	-55 to 125	°C
dv/dt	10,000	V/µs
	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub> I <sub>O</sub> IFRM IFSM T <sub>stg</sub> T <sub>J</sub>	$ \begin{array}{c c} V_{RRM} & 40 \\ V_{RWM} & 40 \\ V_{RWM} & V_{R} & 40 \\ \hline I_{O} & 1.0 \\ I_{FRM} & 2.0 \\ \hline I_{FSM} & 30 \\ \hline T_{stg} & -55 \text{ to } 150 \\ \hline T_{J} & -55 \text{ to } 125 \\ \hline \end{array} $

#### THERMAL CHARACTERISTICS

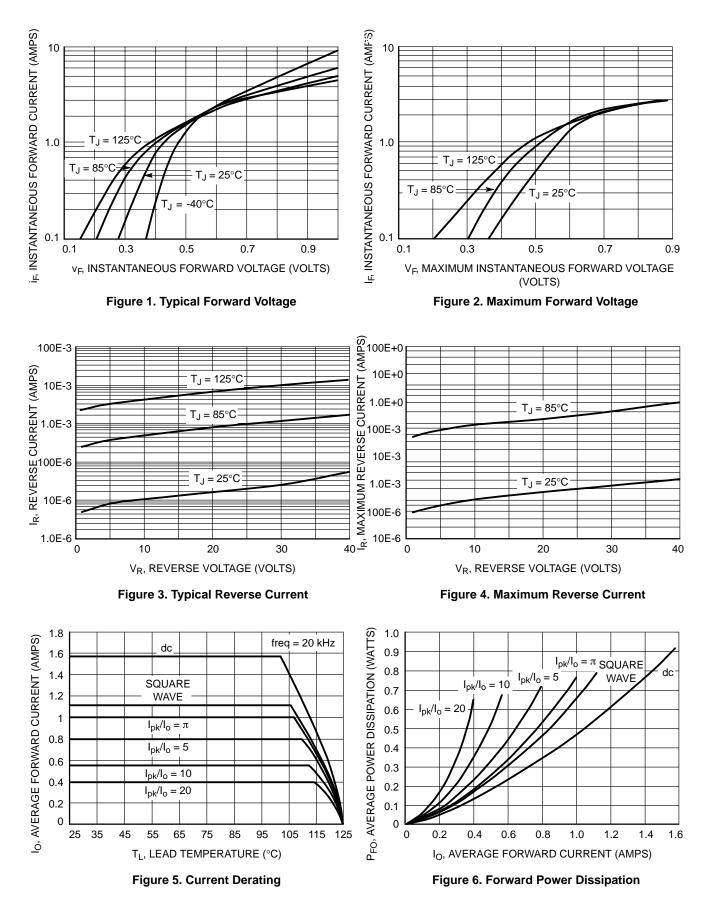
Thermal Resistance - Junction-to-Lead (Note 1)	R <sub>til</sub>	26	°C/W
Thermal Resistance - Junction-to-Lead (Note 2)	, R <sub>til</sub>	21	
Thermal Resistance - Junction-to-Ambient (Note 1)	R <sub>tia</sub>	325	
Thermal Resistance - Junction-to-Ambient (Note 2)	R <sub>tja</sub>	82	

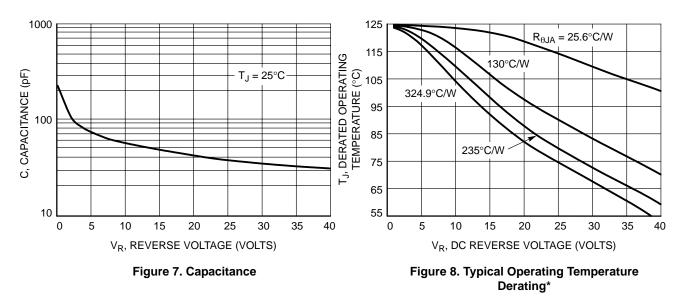
Mounted with minimum recommended pad size, PC Board FR4.
 Mounted with 1 in. copper pad (Cu area 700 mm<sup>2</sup>).

### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3), See Figure 2	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 85°C	V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$ $(I_F = 3.0 \text{ A})$		0.36 0.55 0.85	0.30 0.515 0.88	
Maximum Instantaneous Reverse Current (Note 3), See Figure 4	Ι <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 85°C	mA
(V <sub>R</sub> = 40 V) (V <sub>R</sub> = 20 V)		0.5 0.15	25 18	

3. Pulse Test: Pulse Width  $\leq$  250  $\mu s,$  Duty Cycle  $\leq$  2%.





\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of T<sub>J</sub> therefore must include forward and reverse power effects. The allowable operating  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where T<sub>J</sub> may be calculated from the equation:

r(t) = thermal impedance under given conditions, Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable T<sub>J</sub> due to reverse bias under DC conditions only and is calculated as T<sub>J</sub> = T<sub>Jmax</sub> - r(t)Pr, where r(t) = Rthia. For other power applications further calculations must be performed.

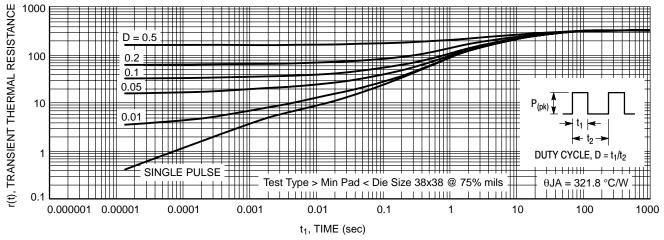


Figure 9. Thermal Response

# Surface Mount Schottky Power Rectifier

# POWERMITE<sup>®</sup> Power Surface Mount Package

The Schottky Powermite employs the Schottky Barrier principle with a barrier metal and epitaxial construction that produces optimal forward voltage drop-reverse current tradeoff. The advanced packaging techniques provide for a highly efficient micro miniature, space saving surface mount Rectifier. With its unique heatsink design, the Powermite has the same thermal performance as the SMA while being 50% smaller in footprint area, and delivering one of the lowest height profiles, < 1.1 mm in the industry. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

#### Features:

- Low I<sub>R</sub> Extends Battery Life
- Low Profile Maximum Height of 1.1 mm
- Small Footprint Footprint Area of 8.45 mm2
- 150°C Operating Junction Temperature
- Low Thermal Resistance with Direct Thermal Path of Die on Exposed Cathode Heat Sink

#### **Mechanical Characteristics:**

- Powermite is JEDEC Registered as D0-216AA
- Case: Molded Epoxy
- Epoxy Meets UL 94V-O at 1/8"
- Weight: 62 mg (approximately)
- Lead and Mounting Surface Temperature for Soldering Purposes. 260°C Maximum for 10 Seconds

### MAXIMUM RATINGS

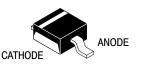
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# ON Semiconductor<sup>™</sup>

http://onsemi.com

# SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 10 VOLTS



POWERMITE CASE 457 PLASTIC

### MARKING DIAGRAM



1E1 = Device Code M = Date Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBRM110ET1	POWERMITE	3,000/Tape & Reel
MBRM110ET3	POWERMITE	12,000/Tape & Reel

#### MAXIMUM RATINGS

Rating	Symbol	Va	Value		
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	1	V		
Average Rectified Forward Current ( $T_L = 100^{\circ}C$ )	Ι <sub>Ο</sub>	1	.0	А	
Non-Repetitive Peak Surge Current (Non-Repetitive peak surge current, halfwave, single phase, 60 Hz)	IFSM	5	50		
Storage Temperature	T <sub>stg</sub>	-55 to	o +150	°C	
Operating Junction Temperature	TJ	-55 to	°C		
Voltage Rate of Change (Rated $V_R$ , $T_J = 25^{\circ}C$ )	dv/dt	10,000		V/μs	
HERMAL CHARACTERISTICS		•			
Thermal Resistance - Junction-to-Lead (Anode) (Note 1) Thermal Resistance - Junction-to-Tab (Cathode) (Note 1) Thermal Resistance - Junction-to-Ambient (Note 1)	R <sub>tjl</sub> R <sub>tjtab</sub> R <sub>tja</sub>	35 23 277		°C/W	
ELECTRICAL CHARACTERISTICS					
Maximum Instantaneous Forward Voltage (Note 2)	VF	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	V	
$(I_{F} = 0.1 \text{ A})$ $(I_{F} = 1.0 \text{ A})$ $(I_{F} = 2.0 \text{ A})$		0.455 0.530 0.595	0.360 0.455 0.540		
Maximum Instantaneous Reverse Current (Note 2)	Ι <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	μΑ	

300

500

0.5

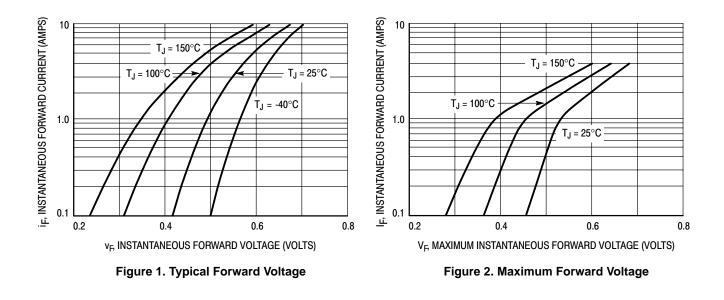
1.0

(V<sub>R</sub> = 5.0 V)

(V<sub>R</sub> = 10 V)

1. Mounted with minimum recommended pad size, PC Board FR4, See Figures 8 and 9. 2. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2%.

# MBRM110E



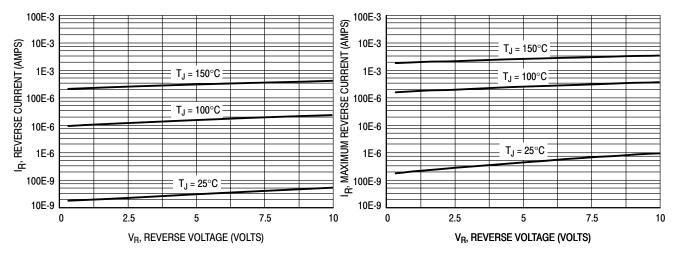
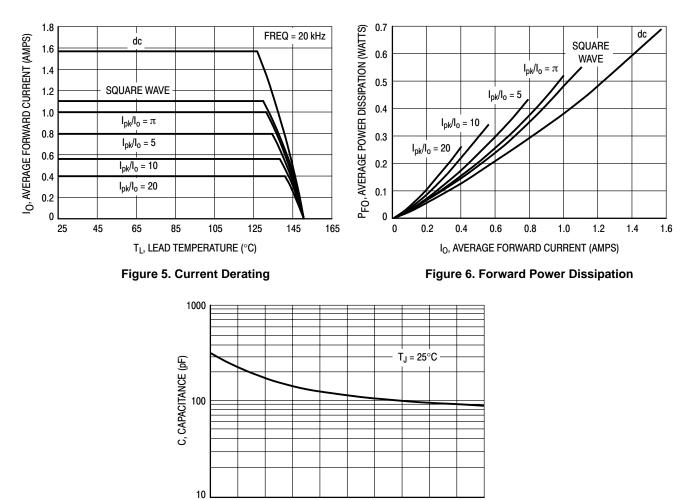


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

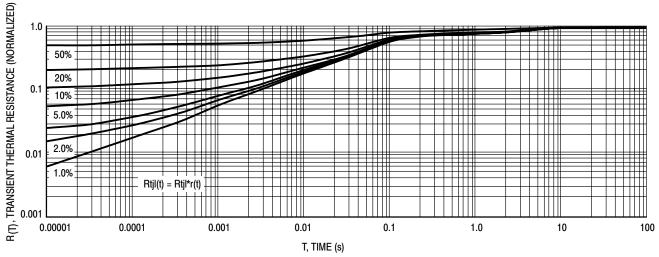
# MBRM110E



V<sub>R</sub>, REVERSE VOLTAGE (VOLTS)

Figure 7. Capacitance

# MBRM110E





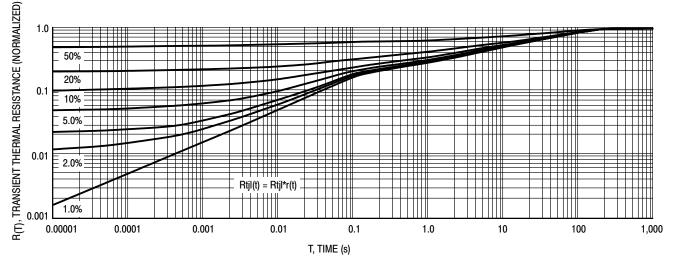


Figure 9. Thermal Response Junction to Ambient

# Surface Mount Schottky Power Rectifier

# POWERMITE<sup>®</sup> Power Surface Mount Package

The Schottky Powermite employs the Schottky Barrier principle with a barrier metal and epitaxial construction that produces optimal forward voltage drop-reverse current tradeoff. The advanced packaging techniques provide for a highly efficient micro miniature, space saving surface mount Rectifier. With its unique heatsink design, the Powermite has the same thermal performance as the SMA while being 50% smaller in footprint area, and delivering one of the lowest height profiles, < 1.1 mm in the industry. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

#### Features:

- Ultra Low V<sub>F</sub>
- 1st in Marketplace with a 10 V<sub>R</sub> Schottky Rectifier
- Low Profile Maximum Height of 1.1 mm
- Small Footprint Footprint Area of 8.45 mm2
- Low Thermal Resistance with Direct Thermal Path of Die on Exposed Cathode Heat Sink
- ESD Protection: Human Body Model >4000 V (Class 3) Machine Model >400 V (Class C)

#### **Mechanical Characteristics:**

- Powermite is JEDEC Registered as D0-216AA
- Case: Molded Epoxy
- Epoxy Meets UL 94V-O at 1/8"
- Weight: 62 mg (approximately)
- Lead and Mounting Surface Temperature for Soldering Purposes. 260°C Maximum for 10 Seconds

#### MAXIMUM RATINGS

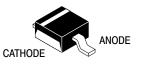
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http://onsemi.com

# SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 10 VOLTS



POWERMITE CASE 457 PLASTIC

### MARKING DIAGRAM



1L1 = Device Code M = Date Code

### ORDERING INFORMATION

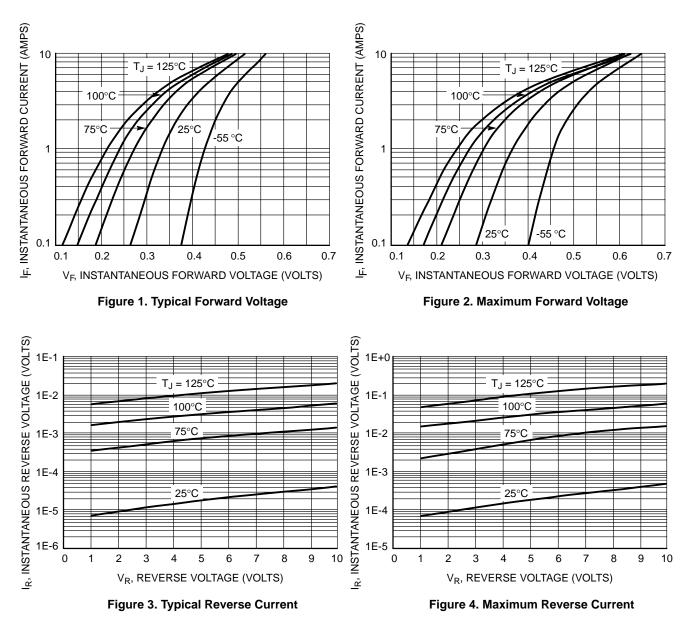
Device	Package	Shipping
MBRM110LT1	POWERMITE	3,000/Tape & Reel
MBRM110LT3	POWERMITE	12,000/Tape & Reel

### MAXIMUM RATINGS

Rating	Symbol	Va	lue	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	1	0	V
Average Rectified Forward Current (T <sub>L</sub> = 115°C, $R_{\theta JL}$ = 35°C/W)	Ι <sub>Ο</sub>	1	.0	А
Non-Repetitive Peak Surge Current (Non-Repetitive peak surge current, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	5	50	
Storage Temperature	T <sub>stg</sub>	-55 to 125		°C
Operating Junction Temperature	TJ	-55 to 125		°C
Voltage Rate of Change (Rated $V_R$ , $T_J = 25^{\circ}C$ )	dv/dt	10,000		V/µs
THERMAL CHARACTERISTICS		·		
Thermal Resistance - Junction-to-Lead (Anode) (Note 1) Thermal Resistance - Junction-to-Tab (Cathode) (Note 1) Thermal Resistance - Junction-to-Ambient (Note 1)	R <sub>tjl</sub> R <sub>tjtab</sub> R <sub>tja</sub>	2	85 23 77	°C/W
ELECTRICAL CHARACTERISTICS				
Maximum Instantaneous Forward Voltage (Note 2)	V <sub>F</sub>	T <sub>J</sub> = 25°C	$T_J = 100^{\circ}C$	V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$		0.280 0.365	0.175 0.275	

$(I_F = 1.0 \text{ A})$ $(I_F = 2.0 \text{ A})$		0.365 0.415	0.275 0.325	
Maximum Instantaneous Reverse Current (Note 2)	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
(V <sub>R</sub> = 5.0 V) (V <sub>R</sub> = 10 V)		0.2 0.5	30 60	

1. Mounted with minimum recommended pad size, PC Board FR4, See Figures 8 and 9.2. Pulse Test: Pulse Width  $\leq 250 \ \mu$ s, Duty Cycle  $\leq 2\%$ .



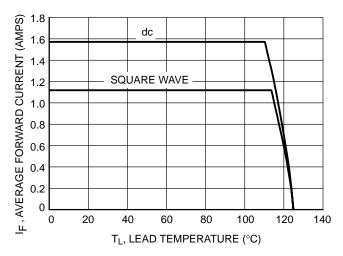
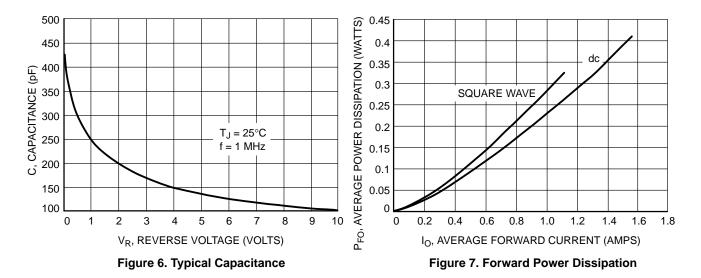
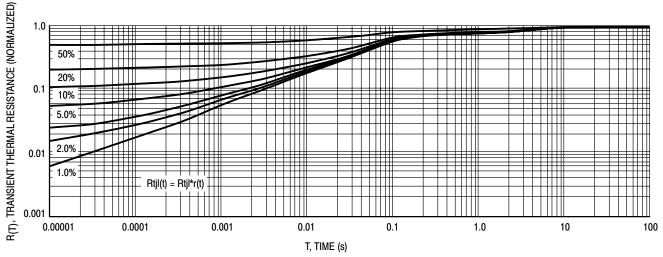


Figure 5. Current Derating - Junction to Lead







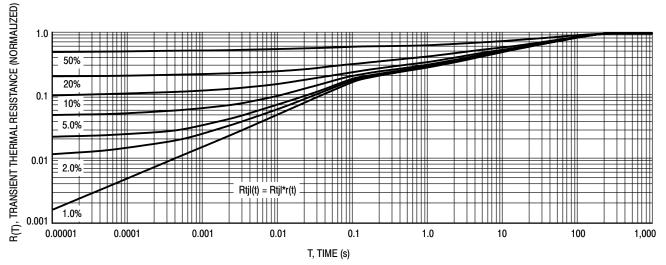


Figure 9. Thermal Response Junction to Ambient

# Surface Mount Schottky Power Rectifier

# POWERMITE<sup>®</sup> Power Surface Mount Package

The Schottky Powermite employs the Schottky Barrier principle with a barrier metal and epitaxial construction that produces optimal forward voltage drop-reverse current tradeoff. The advanced packaging techniques provide for a highly efficient micro miniature, space saving surface mount Rectifier. With its unique heatsink design, the Powermite has the same thermal performance as the SMA while being 50% smaller in footprint area, and delivering one of the lowest height profiles, < 1.1 mm in the industry. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

#### Features:

- Low Profile Maximum Height of 1.1 mm
- Small Footprint Footprint Area of 8.45 mm2
- Low V<sub>F</sub> Provides Higher Efficiency and Extends Battery Life
- Supplied in 12 mm Tape and Reel
- Low Thermal Resistance with Direct Thermal Path of Die on Exposed Cathode Heat Sink

#### **Mechanical Characteristics:**

- Powermite is JEDEC Registered as DO-216AA
- Case: Molded Epoxy
- Epoxy Meets UL94V-0 at 1/8"
- Weight: 62 mg (approximately)
- Device Marking: BCV
- Lead and Mounting Surface Temperature for Soldering Purposes. 260°C Maximum for 10 Seconds

### MAXIMUM RATINGS

Please See the Table on the Following Page



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# SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 20 VOLTS



POWERMITE CASE 457 PLASTIC

### MARKING DIAGRAM



BCV = Device Code M = Date Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBRM120ET1	POWERMITE	3000/Tape & Reel
MBRM120ET3	POWERMITE	12,000/Tape & Reel

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C$ = 130°C)	IO	1.0	А
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz, $T_C = 135^{\circ}C$ )	I <sub>FRM</sub>	2.0	A
Non-Repetitive Peak Surge Current (Non-Repetitive peak surge current, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	50	A
Storage Temperature	T <sub>stg</sub>	-65 to 150	°C
Operating Junction Temperature	TJ	-65 to 150	°C
Voltage Rate of Change (Rated V <sub>R</sub> , T <sub>J</sub> = 25°C)	dv/dt	10,000	V/μs

#### THERMAL CHARACTERISTICS

Thermal Resistance - Junction-to-Lead (Anode) (Note 1)	R <sub>til</sub>	35	°C/W
Thermal Resistance - Junction-to-Tab (Cathode) (Note 1)	R <sub>titab</sub>	23	
Thermal Resistance - Junction-to-Ambient (Note 1)	Ŕ <sub>tja</sub>	277	

1. Mounted with minimum recommended pad size, PC Board FR4, See Figures 9 and 10.

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 2), See Figure 2	V <sub>F</sub>	T <sub>J</sub> = 25°C	$T_J = 100^{\circ}C$	V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$ $(I_F = 2.0 \text{ A})$		0.455 0.530 0.595	0.360 0.455 0.540	
Maximum Instantaneous Reverse Current (Note 2), See Figure 4	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	μΑ
$(V_R = 20 V)$ $(V_R = 10 V)$ $(V_R = 5.0 V)$		10 1.0 0.5	1600 500 300	

2. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2%.

# MBRM120E

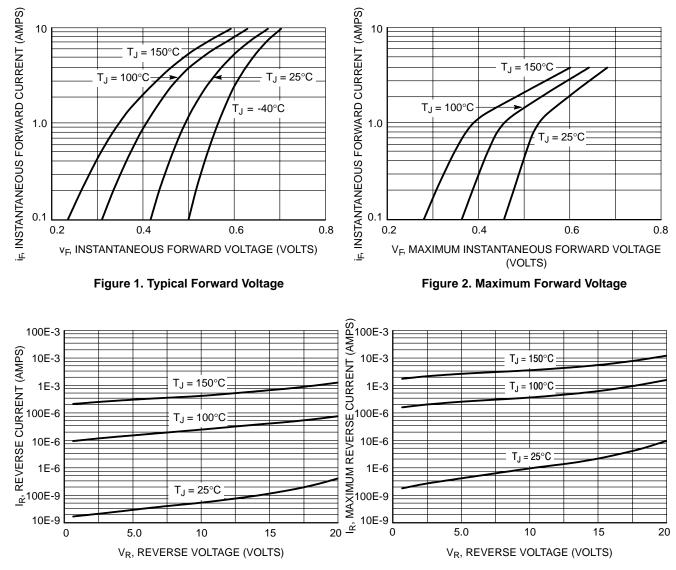
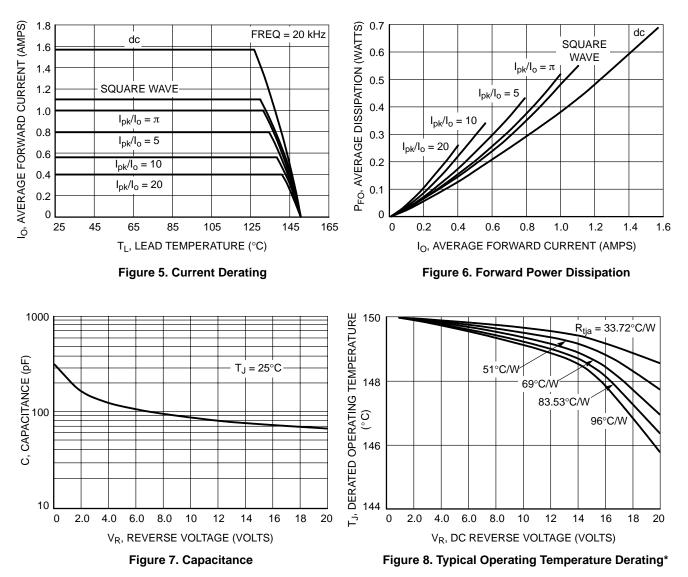


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

### MBRM120E



\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of  $T_J$  therefore must include forward and reverse power effects. The allowable operating  $T_J$  may be calculated from the equation:  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

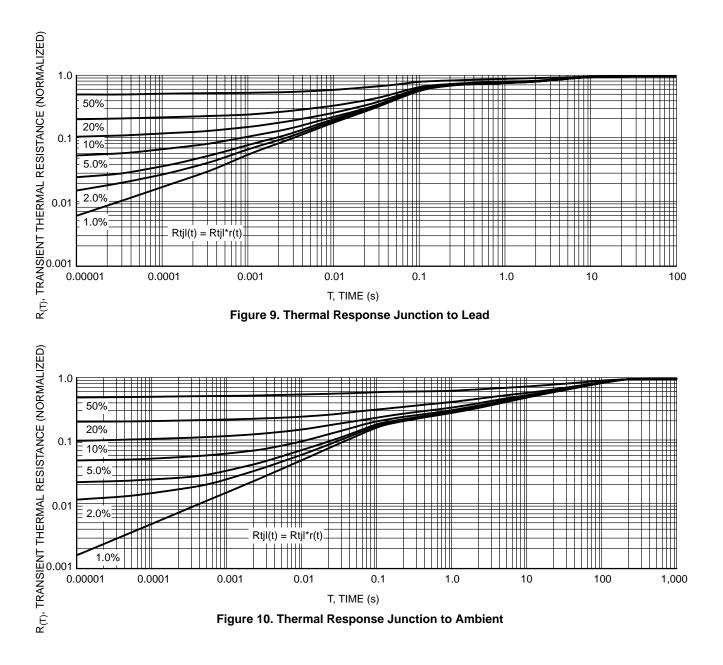
r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.

# MBRM120E



# Surface Mount Schottky Power Rectifier

# POWERMITE<sup>®</sup> Power Surface Mount Package

The Schottky Powermite employs the Schottky Barrier principle with a barrier metal and epitaxial construction that produces optimal forward voltage drop-reverse current tradeoff. The advanced packaging techniques provide for a highly efficient micro miniature, space saving surface mount Rectifier. With its unique heatsink design, the Powermite has the same thermal performance as the SMA while being 50% smaller in footprint area, and delivering one of the lowest height profiles, < 1.1 mm in the industry. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

### Features:

- Low Profile Maximum Height of 1.1 mm
- Small Footprint Footprint Area of 8.45 mm2
- Low V<sub>F</sub> Provides Higher Efficiency and Extends Battery Life
- Supplied in 12 mm Tape and Reel
- Low Thermal Resistance with Direct Thermal Path of Die on Exposed Cathode Heat Sink

#### **Mechanical Characteristics:**

- Powermite is JEDEC Registered as DO-216AA
- Case: Molded Epoxy
- Epoxy Meets UL94V-0 at 1/8"
- Weight: 62 mg (approximately)
- Device Marking: BCF
- Lead and Mounting Surface Temperature for Soldering Purposes. 260°C Maximum for 10 Seconds

#### MAXIMUM RATINGS

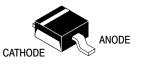
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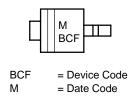
http://onsemi.com

# SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 20 VOLTS



POWERMITE CASE 457 PLASTIC

### MARKING DIAGRAM



### ORDERING INFORMATION

Device	Package	Shipping
MBRM120LT1	POWERMITE	3000/Tape & Reel
MBRM120LT3	POWERMITE	12,000/Tape & Reel

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C$ = 135°C)	IO	1.0	А
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 100 kHz, $T_C = 135^{\circ}C$ )	I <sub>FRM</sub>	2.0	A
Non-Repetitive Peak Surge Current (Non-Repetitive peak surge current, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	50	A
Storage Temperature	T <sub>stg</sub>	-55 to 150	°C
Operating Junction Temperature	TJ	-55 to 125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J = 25^{\circ}C$ )	dv/dt	10,000	V/μs

#### THERMAL CHARACTERISTICS

Thermal Resistance - Junction-to-Lead (Anode) (Note 1)	R <sub>til</sub>	35	°C/W
Thermal Resistance - Junction-to-Tab (Cathode) (Note 1)	R <sub>titab</sub>	23	
Thermal Resistance - Junction-to-Ambient (Note 1)	R <sub>tja</sub>	277	

1. Mounted with minimum recommended pad size, PC Board FR4, See Figures 9 & 10.

#### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 2), See Figure 2	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 85°C	V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$ $(I_F = 3.0 \text{ A})$		0.34 0.45 0.65	0.26 0.415 0.67	
Maximum Instantaneous Reverse Current (Note 2), See Figure 4	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 85°C	mA
(V <sub>R</sub> = 20 V) (V <sub>R</sub> = 10 V)		0.40 0.10	25 18	

2. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2%.

# MBRM120L

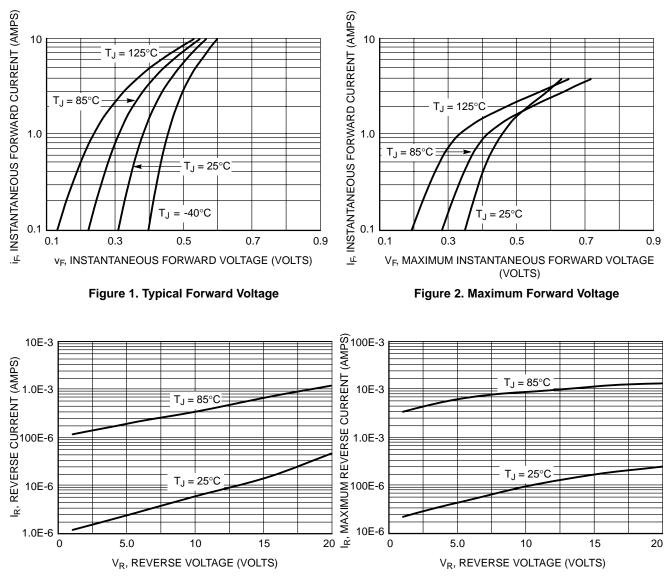
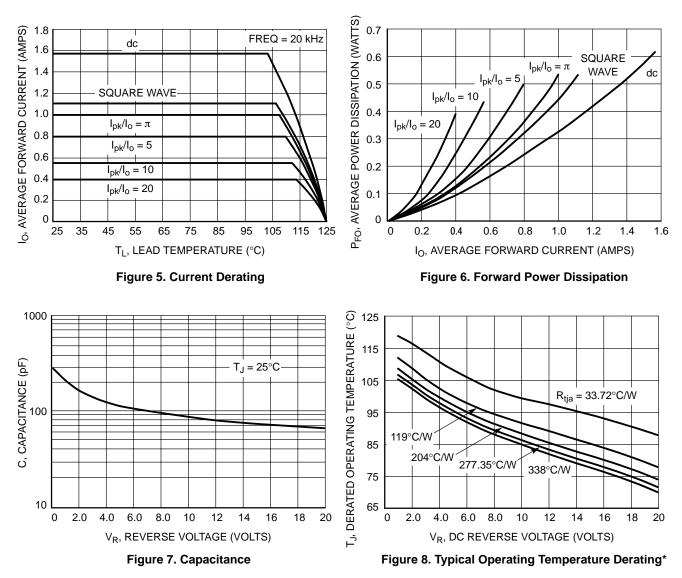


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

### MBRM120L



\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of  $T_J$  therefore must include forward and reverse power effects. The allowable operating  $T_J$  may be calculated from the equation:  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

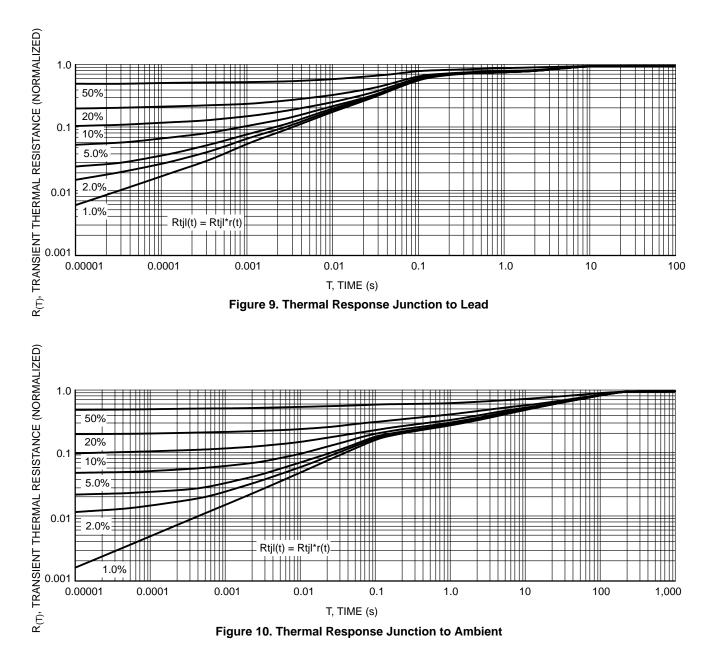
r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.

# MBRM120L



# Surface Mount Schottky Power Rectifier

# POWERMITE<sup>®</sup> Power Surface Mount Package

The Schottky Powermite employs the Schottky Barrier principle with a barrier metal and epitaxial construction that produces optimal forward voltage drop-reverse current tradeoff. The advanced packaging techniques provide for a highly efficient micro miniature, space saving surface mount Rectifier. With its unique heatsink design, the Powermite has the same thermal performance as the SMA while being 50% smaller in footprint area, and delivering one of the lowest height profiles, < 1.1 mm in the industry. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

#### Features:

- Low Profile Maximum Height of 1.1 mm
- Small Footprint Footprint Area of 8.45 mm2
- Low V<sub>F</sub> Provides Higher Efficiency and Extends Battery Life
- Supplied in 12 mm Tape and Reel
- Low Thermal Resistance with Direct Thermal Path of Die on Exposed Cathode Heat Sink

#### **Mechanical Characteristics:**

- Powermite is JEDEC Registered as DO-216AA
- Case: Molded Epoxy
- Epoxy Meets UL94V-0 at 1/8"
- Weight: 62 mg (approximately)
- Device Marking: BCG
- Lead and Mounting Surface Temperature for Soldering Purposes. 260°C Maximum for 10 Seconds

#### MAXIMUM RATINGS

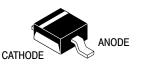
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# SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 30 VOLTS



POWERMITE CASE 457 PLASTIC

### MARKING DIAGRAM



BCG = Device Code M = Date Code

### **ORDERING INFORMATION**

Device	Package	Shipping
MBRM130LT1	POWERMITE	3000/Tape & Reel
MBRM130LT3	POWERMITE	12,000/Tape & Reel

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V	
Average Rectified Forward Current (At Rated $V_R$ , $T_C$ = 135°C)	IO	1.0	А	
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 100 kHz, $T_C = 135^{\circ}C$ )	I <sub>FRM</sub>	2.0	A	
Non-Repetitive Peak Surge Current (Non-Repetitive peak surge current, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	50	A	
Storage Temperature	T <sub>stg</sub>	-55 to 150	°C	
Operating Junction Temperature	TJ	-55 to 125	°C	
Voltage Rate of Change (Rated $V_R$ , $T_J = 25^{\circ}C$ )	dv/dt	10,000	V/μs	

#### THERMAL CHARACTERISTICS

Thermal Resistance - Junction-to-Lead (Anode) (Note 1)	R <sub>tjl</sub>	35	°C/W
Thermal Resistance - Junction-to-Tab (Cathode) (Note 1)	R <sub>tjtab</sub>	23	
Thermal Resistance - Junction-to-Ambient (Note 1)	Ŕ <sub>tja</sub>	277	

1. Mounted with minimum recommended pad size, PC Board FR4, See Figures 9 & 10.

#### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 2), See Figure 2	VF	T <sub>J</sub> = 25°C	T <sub>J</sub> = 85°C	V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$ $(I_F = 3.0 \text{ A})$		0.30 0.38 0.52	0.20 0.33 0.50	
Maximum Instantaneous Reverse Current (Note 2), See Figure 4	Ι <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 85°C	mA
$(V_R = 30 V)$ $(V_R = 20 V)$ $(V_R = 10 V)$		0.41 0.13 0.05	11 5.3 3.2	

2. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2%.

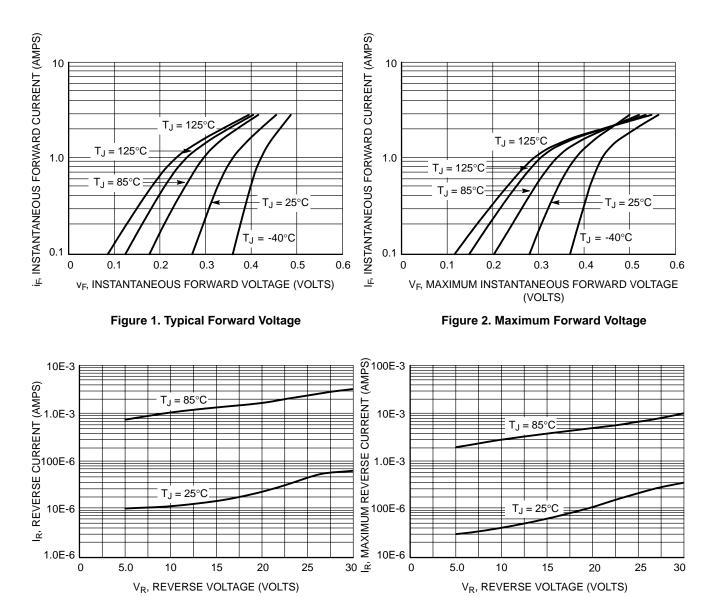
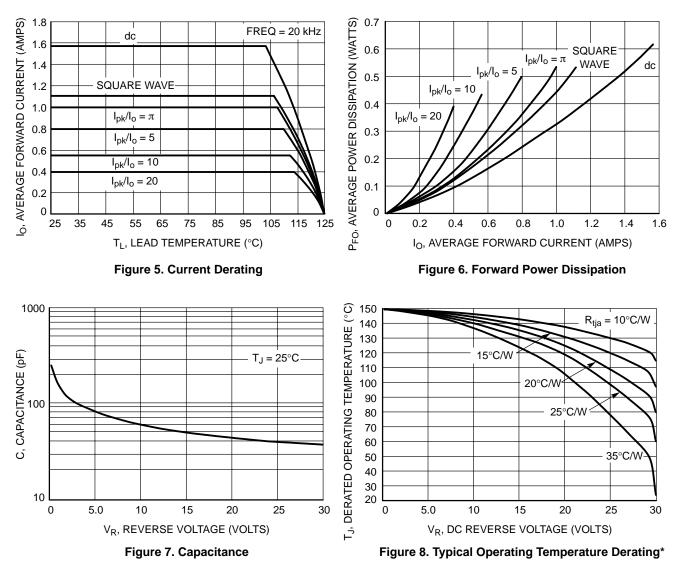


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

### MBRM130L



\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of  $T_J$  therefore must include forward and reverse power effects. The allowable operating  $T_J$  may be calculated from the equation:  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

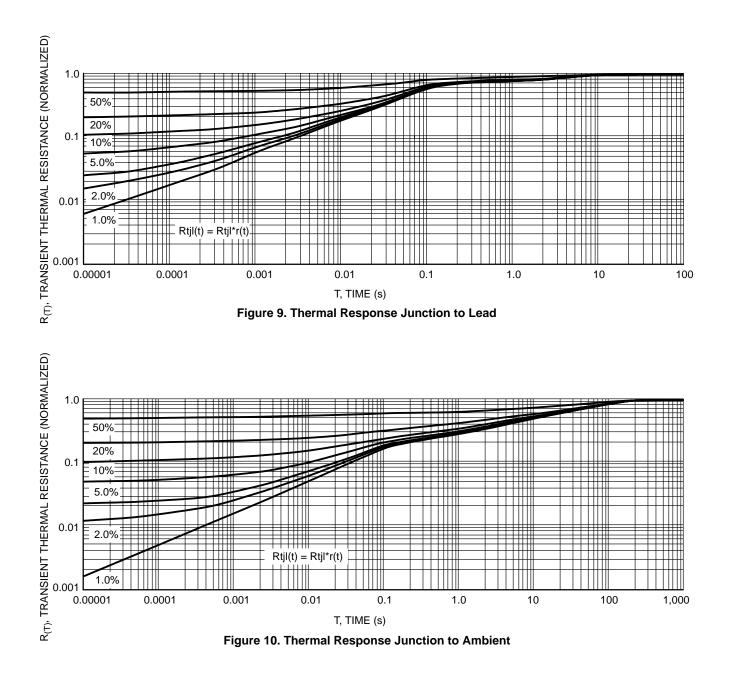
r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.

## MBRM130L



# Surface Mount Schottky Power Rectifier

# POWERMITE<sup>®</sup> Power Surface Mount Package

The Schottky Powermite employs the Schottky Barrier principle with a barrier metal and epitaxial construction that produces optimal forward voltage drop-reverse current tradeoff. The advanced packaging techniques provide for a highly efficient micro miniature, space saving surface mount Rectifier. With its unique heatsink design, the Powermite has the same thermal performance as the SMA while being 50% smaller in footprint area, and delivering one of the lowest height profiles, < 1.1 mm in the industry. Because of its small size, it is ideal for use in portable and battery powered products such as cellular and cordless phones, chargers, notebook computers, printers, PDAs and PCMCIA cards. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

#### Features:

- Low Profile Maximum Height of 1.1 mm
- Small Footprint Footprint Area of 8.45 mm2
- Low V<sub>F</sub> Provides Higher Efficiency and Extends Battery Life
- Supplied in 12 mm Tape and Reel
- Low Thermal Resistance with Direct Thermal Path of Die on Exposed Cathode Heat Sink

#### **Mechanical Characteristics:**

- Powermite is JEDEC Registered as DO-216AA
- Case: Molded Epoxy
- Epoxy Meets UL94V-0 at 1/8"
- Weight: 62 mg (approximately)
- Device Marking: BCJ
- Lead and Mounting Surface Temperature for Soldering Purposes. 260°C Maximum for 10 Seconds

#### MAXIMUM RATINGS

Please See the Table on the Following Page



## **ON Semiconductor®**

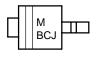
http://onsemi.com

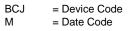
# SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 40 VOLTS



POWERMITE CASE 457 PLASTIC

#### MARKING DIAGRAM





Device	Package	Shipping
MBRM140T1	POWERMITE	3000/Tape & Reel
MBRM140T3	POWERMITE	12,000/Tape & Reel

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C$ = 110°C)	Ι <sub>Ο</sub>	1.0	А
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 100 kHz, $T_C = 110^{\circ}C$ )	I <sub>FRM</sub>	2.0	A
Non-Repetitive Peak Surge Current (Non-Repetitive peak surge current, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	50	A
Storage Temperature	T <sub>stg</sub>	-55 to 150	°C
Operating Junction Temperature	TJ	-55 to 125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J = 25^{\circ}C$ )	dv/dt	10,000	V/μs

#### THERMAL CHARACTERISTICS

Thermal Resistance - Junction-to-Lead (Anode) (Note 1)	R <sub>til</sub>	35	°C/W
Thermal Resistance - Junction-to-Tab (Cathode) (Note 1)	R <sub>titab</sub>	23	
Thermal Resistance - Junction-to-Ambient (Note 1)	R <sub>tja</sub>	277	

1. Mounted with minimum recommended pad size, PC Board FR4, See Figures 9 & 10.

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 2), See Figure 2	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 85°C	V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$ $(I_F = 3.0 \text{ A})$		0.36 0.55 0.85	0.30 0.515 0.88	
Maximum Instantaneous Reverse Current (Note 2), See Figure 4	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 85°C	mA
(V <sub>R</sub> = 40 V) (V <sub>R</sub> = 20 V)		0.5 0.15	25 18	

2. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2%.

## MBRM140

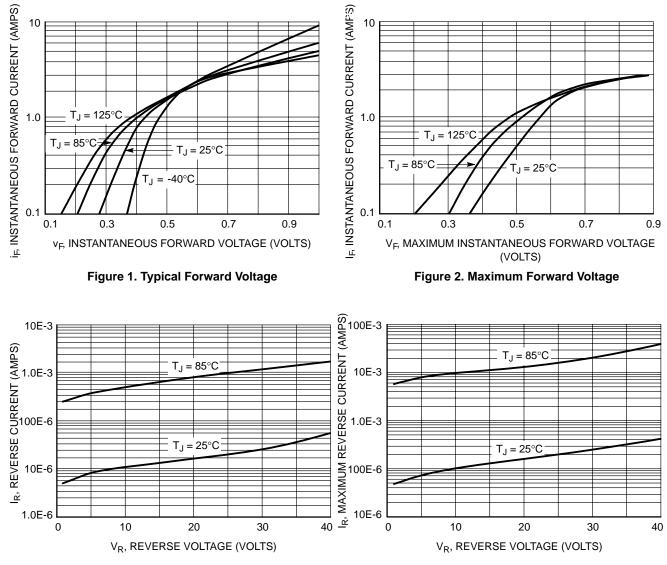
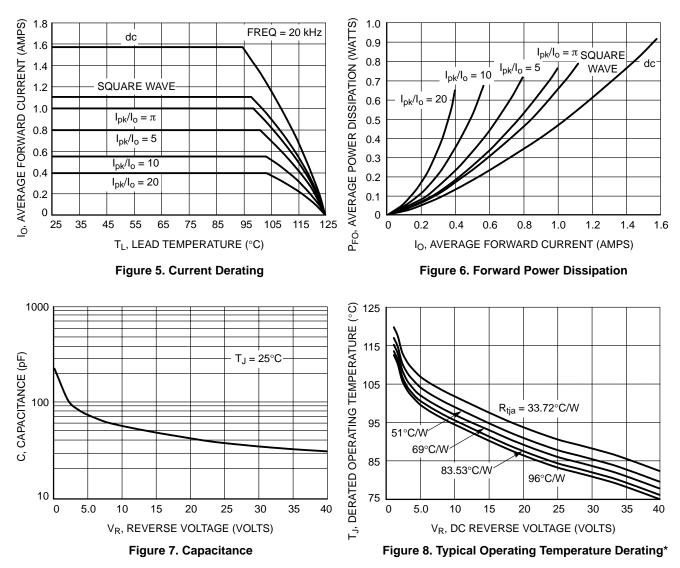


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

### **MBRM140**

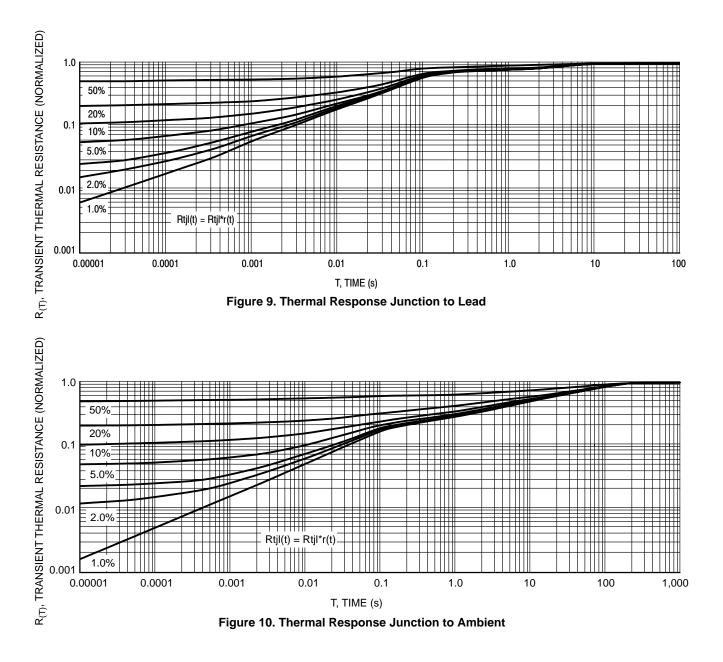


\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of  $T_J$  therefore must include forward and reverse power effects. The allowable operating  $T_J$  may be calculated from the equation:  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

- r(t) = thermal impedance under given conditions,
- Pf = forward power dissipation, and
- Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.

### MBRM140



# MBRA120ET3

# Surface Mount Schottky Power Rectifier

# **SMA Power Surface Mount Package**

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Optimized for Low Leakage Current

#### **Mechanical Characteristics:**

- Case: Molded Epoxy
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- Available in 12 mm Tape, 5000 Units per 13 inch Reel
- Marking: B1E2

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 125°C)	Ι <sub>Ο</sub>	1.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +150	°C
Voltage Rate of Change (Rated $V_R$ , $T_J$ = 25°C)	dv/dt	10,000	V/μs



### **ON Semiconductor®**

http://onsemi.com

### SCHOTTKY BARRIER RECTIFIER 1 AMPERE 20 VOLTS



SMA CASE 403D PLASTIC

B1E2

MARKING DIAGRAM

B1E2 = Device Code

Device	Package	Shipping
MBRA120ET3	SMA	5000/Tape & Reel

## MBRA120ET3

#### THERMAL CHARACTERISTICS

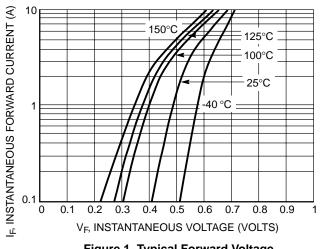
Characteristic	Symbol	5 mm x 5 mm (Note 2)	<b>1 Inch x 1/2 inch</b> (Note 3)	Unit
Thermal Resistance - Junction-to-Lead	R <sub>θJL</sub>	34	20	°C/W
Thermal Resistance - Junction-to-Ambient	R <sub>θJA</sub>	138	77	

#### **ELECTRICAL CHARACTERISTICS**

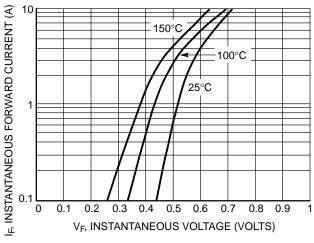
Maximum Instantaneous Forward Voltage (Note 1), See Figure 2	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$ $(I_F = 2.0 \text{ A})$		0.455 0.530 0.595	0.360 0.455 0.540	
Maximum Instantaneous Reverse Current, See Figure 4	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	μΑ
$(V_R = 20 V)$ $(V_R = 10 V)$ $(V_R = 5.0 V)$		10 1.0 0.5	1600 500 300	

Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2%. 1.

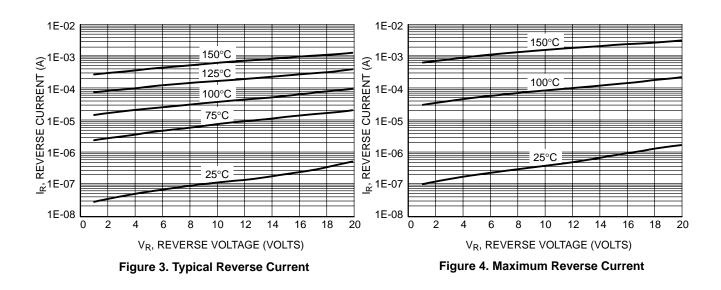
Mounted on a Pad Size of 5 mm x 5 mm, PC Board FR4 (2 pads).
 Mounted on a Pad Size of 1 inch x 1/2 inch, PC Board FR4 (2 pads).



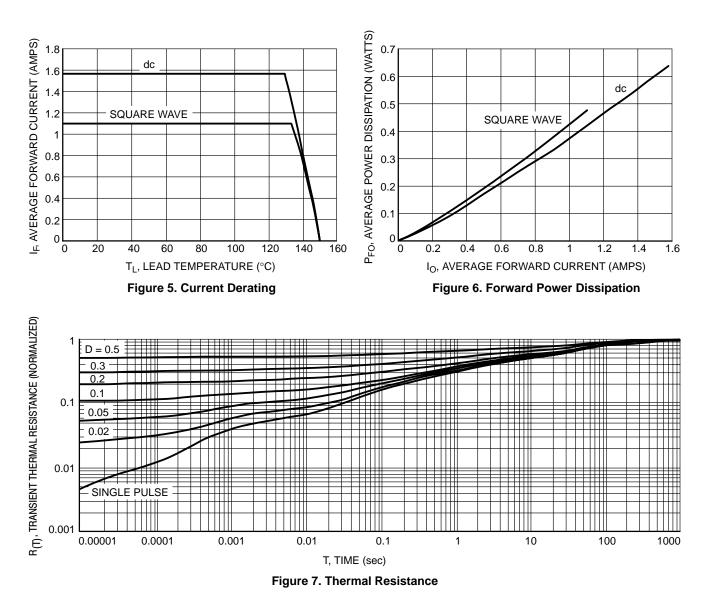




#### Figure 2. Maximum Forward Voltage



## MBRA120ET3



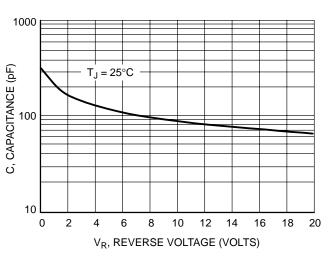


Figure 8. Typical Junction Capacitance

# MBRA120LT3

# Surface Mount Schottky Power Rectifier

# **SMA Power Surface Mount Package**

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Optimized for Low Leakage Current

#### **Mechanical Characteristics:**

- Case: Molded Epoxy
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- Available in 12 mm Tape, 5000 Units per 13 inch Reel
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C)
- Marking: B1L2

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>L</sub> = 110°C)	Ι <sub>Ο</sub>	1.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Storage/Operating Case Temperature Operating Junction Temperature	T <sub>stg</sub> , T <sub>C</sub> T <sub>J</sub>	-55 to +125	°C
Voltage Rate of Change (Rated V <sub>R</sub> , T <sub>J</sub> = 25°C)	dv/dt	10,000	V/µs



## **ON Semiconductor®**

http://onsemi.com

### SCHOTTKY BARRIER RECTIFIER 1 AMPERE 20 VOLTS





SMA CASE 403D PLASTIC

B1L2 = Device Code

Device	Package	Shipping
MBRA120LT3	SMA	5000/Tape & Reel

Semiconductor Components Industries, LLC, 2002 April, 2002 - Rev. 1

# MBRA120LT3

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	5 mm x 5 mm (Note 2)	<b>1 Inch x 1/2 inch</b> (Note 3)	Unit
Thermal Resistance - Junction-to-Lead	Psi <sub>JL</sub> (Note 4)	34	20	°C/W
Thermal Resistance - Junction-to-Ambient	$R_{\theta JA}$	138	77	

#### **ELECTRICAL CHARACTERISTICS**

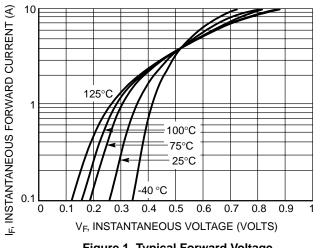
Maximum Instantaneous Forward Voltage (Note 1), See Figure 2	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$ $(I_F = 2.0 \text{ A})$		0.300 0.395 0.445	0.15 0.30 0.40	
Maximum Instantaneous Reverse Current, See Figure 4	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
(V <sub>R</sub> = 20 V) (V <sub>R</sub> = 10 V)		0.2 0.1	6.0 4.0	

1. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2%.

2. Mounted on a Pad Size of 5 mm x 5 mm, PC Board FR4 (2 pads).

3. Mounted on a Pad Size of 1 inch x 1/2 inch, PC Board FR4 (2 pads).

4. In compliance with JEDEC 51, these values (historically represented by  $R_{\theta JL}$ ) are now referenced as  $Psi_{JL}$ .





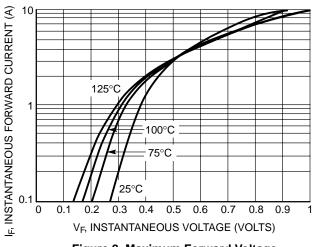
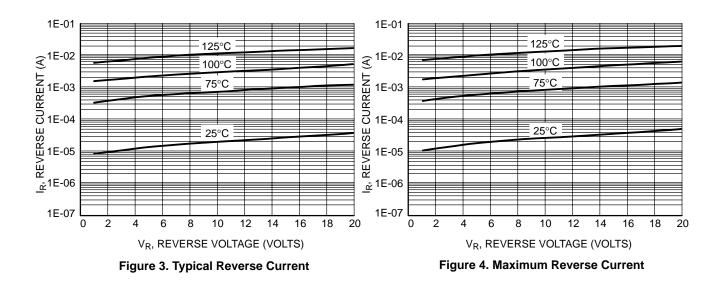
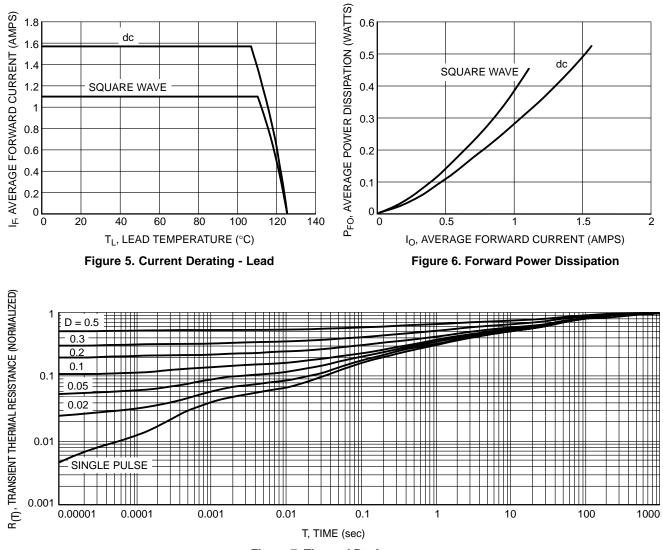


Figure 2. Maximum Forward Voltage



## MBRA120LT3





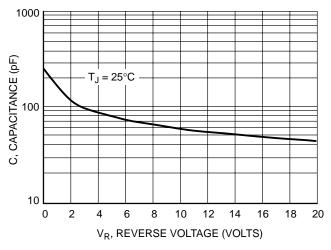


Figure 8. Typical Junction Capacitance

# MBRA130LT3

# Surface Mount Schottky Power Rectifier

# SMA Power Surface Mount Package

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop

#### Mechanical Characteristics:

- Case: Molded Epoxy
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode Lead Indicated by Either Notch in Plastic Body or Polarity Band
- Available in 12 mm Tape, 5000 Units per 13 inch Reel, Add "T3" Suffix to Part Number
- Marking: B1L3

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 105°C)	Ι <sub>Ο</sub>	1.0	А
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 100 kHz, T <sub>C</sub> = 105°C)	I <sub>FRM</sub>	2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	25	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	ТJ	-55 to +125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J = 25^{\circ}C$ )	dv/dt	10,000	V/μs



### **ON Semiconductor®**

http://onsemi.com

#### SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 30 VOLTS



SMA CASE 403D PLASTIC

#### MARKING DIAGRAM



B1L3 = Device Code

Device	Package	Shipping
MBRA130LT3	SMA	5000/Tape & Reel

# MBRA130LT3

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction-to-Lead (Note 1.)	R <sub>θJL</sub>	35	°C/W
Thermal Resistance — Junction-to-Ambient (Note 1.)	R <sub>θJA</sub>	86	

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 2.)		V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	Volts
see Figure 2	(I <sub>F</sub> = 1.0 A) (I <sub>F</sub> = 2.0 A)		0.41 0.47	0.35 0.43	
Maximum Instantaneous Reverse Current		I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
see Figure 4	(V <sub>R</sub> = 30 V) (V <sub>R</sub> = 15 V)		1.0 0.4	25 12	

1. Mounted on 2" Square PC Board with 1" Square Total Pad Size, PC Board FR4. 2. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2.0%.

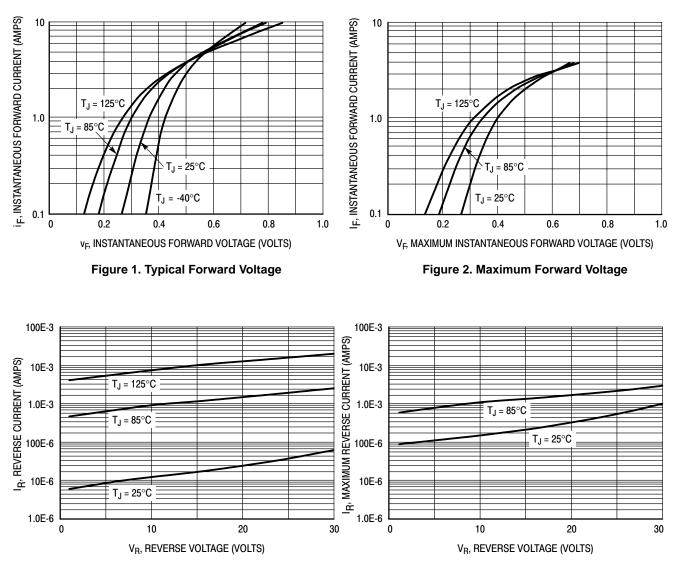


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

## MBRA130LT3

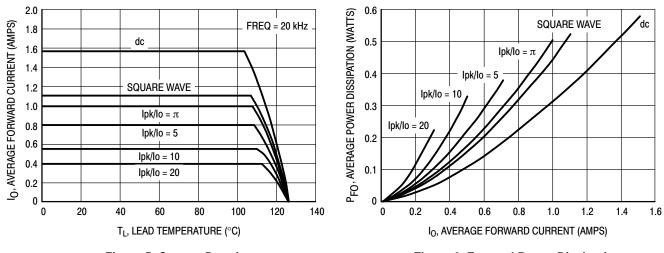
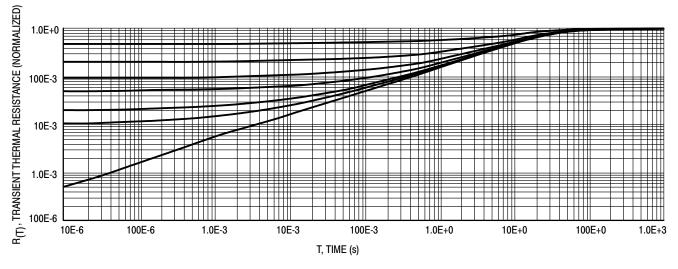




Figure 6. Forward Power Dissipation





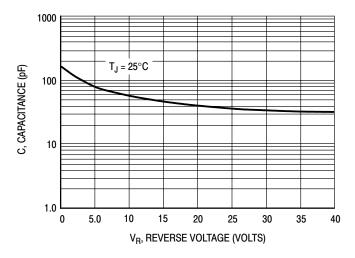


Figure 8. Capacitance

# MBRA140T3

# Surface Mount Schottky Power Rectifier

# **SMA Power Surface Mount Package**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State of the art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bent Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Guardring for Stress Protection

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm tape, 5000 units per 13 inch reel
- Polarity: Cathode Lead Indicated by Either Notch in Plastic Body or Polarity Band
- Marking: B14

#### MAXIMUM RATINGS

Symbol	Value	Unit
V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
Ι <sub>Ο</sub>	1.0	A
I <sub>FRM</sub>	2.0	A
I <sub>FSM</sub>	30	A
T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
TJ	-55 to +125	°C
dv/dt	10,000	V/μs
	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub> I <sub>O</sub> I <sub>FRM</sub> I <sub>FSM</sub> T <sub>stg</sub> , T <sub>C</sub> T <sub>J</sub>	V <sub>RRM</sub> 40           V <sub>RWM</sub> 40           V <sub>RWM</sub> 40           Io         1.0           I <sub>FRM</sub> 2.0           I <sub>FSM</sub> 30           T <sub>stg</sub> , T <sub>C</sub> -55 to +150           T <sub>J</sub> -55 to +125



### **ON Semiconductor®**

http://onsemi.com

#### SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 40 VOLTS



SMA CASE 403D PLASTIC

#### MARKING DIAGRAM



B14 = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBRA140T3	SMA	5000/Tape & Reel

Semiconductor Components Industries, LLC, 2002 April, 2002 - Rev. 5

# **MBRA140T3**

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction-to-Lead (Note 1.)	R <sub>θJL</sub>	35	°C/W
Thermal Resistance — Junction-to-Ambient (Note 1.)	R <sub>θJA</sub>	86	

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 2.)		V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	Volts
see Figure 2 for other Values	(I <sub>F</sub> = 1.0 A) (I <sub>F</sub> = 2.0 A)		0.55 0.71	0.505 0.74	
Maximum Instantaneous Reverse Current		I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
see Figure 4 for other Values	(V <sub>R</sub> = 40 V) (V <sub>R</sub> = 20 V)		0.5 0.1	10 4.0	

1. Mounted on 2" Square PC Board with 1" Square Total Pad Size, PC Board FR4.2. Pulse Test: Pulse Width  $\leq 250 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .

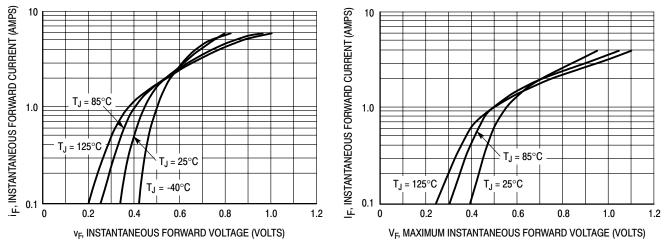
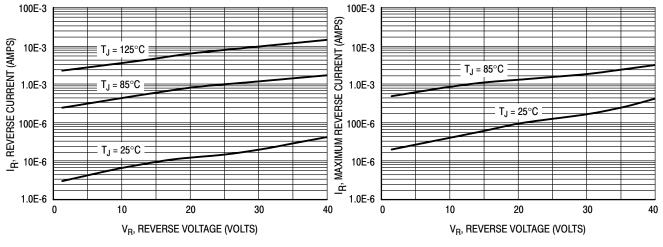


Figure 1. Typical Forward Voltage

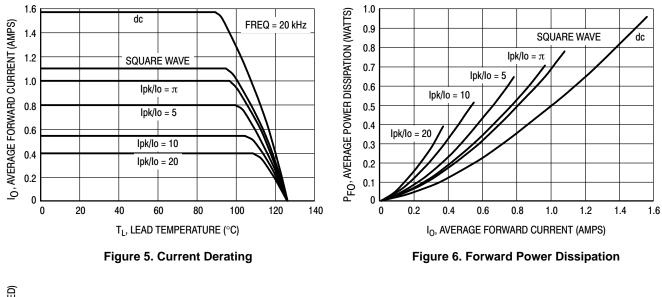
Figure 2. Maximum Forward Voltage

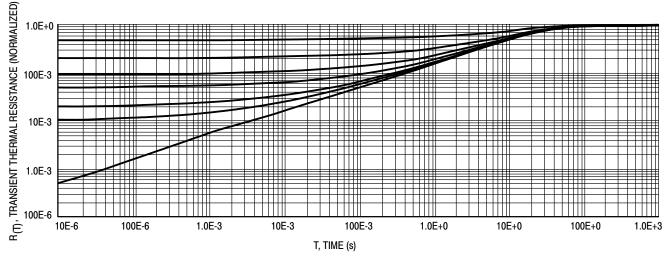


**Figure 3. Typical Reverse Current** 

Figure 4. Maximum Reverse Current

### **MBRA140T3**







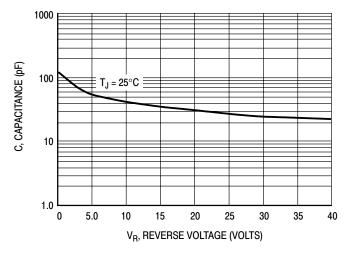


Figure 8. Capacitance

# MBRA160T3

# Surface Mount Schottky Power Rectifier

# **SMA Power Surface Mount Package**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State of the art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bent Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Guardring for Stress Protection

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm tape, 5000 units per 13 inch reel
- Polarity: Cathode Lead Indicated by Polarity Band
- ESD Ratings: Machine Model = C
  - Human Body Model = 3B
- Marking: B16

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 105°C)	۱ <sub>0</sub>	1.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +125	°C
Voltage Rate of Change (Rated V <sub>R</sub> , T <sub>J</sub> = 25°C)	dv/dt	10,000	V/μs



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#### SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 60 VOLTS



SMA CASE 403D PLASTIC

#### MARKING DIAGRAM



B16 = Device Code

Device	Package	Shipping
MBRA160T3	SMA	5000/Tape & Reel

# **MBRA160T3**

#### THERMAL CHARACTERISTICS

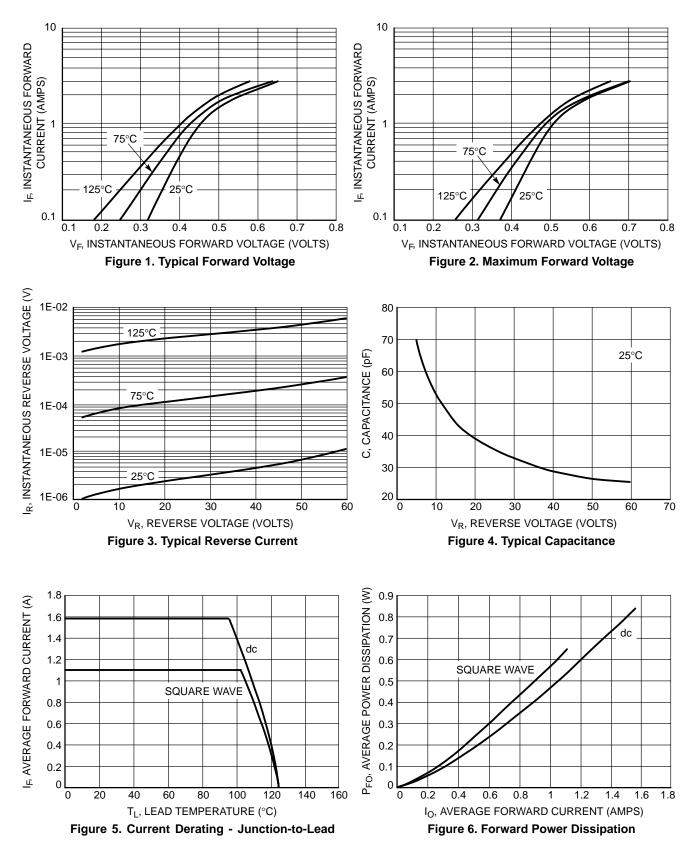
Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction-to-Lead (Note 1)	R <sub>θJL</sub>	35	°C/W
Thermal Resistance - Junction-to-Ambient (Note 1)	R <sub>θJA</sub>	86	

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 2)		V <sub>F</sub>	$T_J = 25^{\circ}C$	T <sub>J</sub> = 125°C	Volts
······································	(I <sub>F</sub> = 1.0 A)		0.510	0.475	
Maximum Instantaneous Reverse Current		I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	mA
	(V <sub>R</sub> = 60 V)		0.2	10	

1. Mounted on 2" Square PC Board with 1" Square Total Pad Size, PC Board FR4.2. Pulse Test: Pulse Width  $\leq 250 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .

## MBRA160T3



# Surface Mount Schottky Power Rectifier

# **SMA Power Surface Mount Package**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State of the art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bent Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Guardring for Stress Protection

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm tape, 5000 units per 13 inch reel
- Polarity: Cathode Lead Indicated by Polarity Band
- ESD Ratings: Machine Model = C
  - Human Body Model = 3B
- Marking: SS16

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 105°C)	۱ <sub>0</sub>	1.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +125	°C
Voltage Rate of Change (Rated V <sub>R</sub> , T <sub>J</sub> = 25°C)	dv/dt	10,000	V/μs



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http://onsemi.com

#### SCHOTTKY BARRIER RECTIFIER 1.0 AMPERES 60 VOLTS



SMA CASE 403D PLASTIC

#### MARKING DIAGRAM



SS16 = Device Code

Device	Package	Shipping
SS16	SMA	5000/Tape & Reel

#### THERMAL CHARACTERISTICS

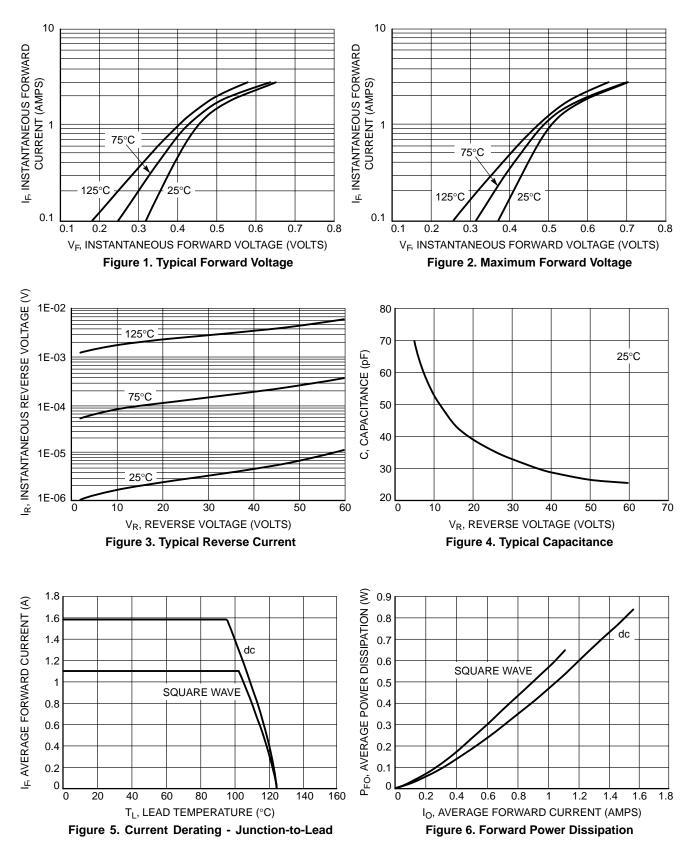
Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction-to-Lead (Note 1)	R <sub>θJL</sub>	35	°C/W
Thermal Resistance - Junction-to-Ambient (Note 1)	R <sub>θJA</sub>	86	

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 2)		V <sub>F</sub>	$T_J = 25^{\circ}C$	T <sub>J</sub> = 125°C	Volts
······································	(I <sub>F</sub> = 1.0 A)		0.510	0.475	
Maximum Instantaneous Reverse Current		I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	mA
	(V <sub>R</sub> = 60 V)		0.2	10	

Mounted on 2" Square PC Board with 1" Square Total Pad Size, PC Board FR4.
 Pulse Test: Pulse Width ≤ 250 μs, Duty Cycle ≤ 2.0%.

**SS16** 



# MBRA210ET3

# Surface Mount Schottky Power Rectifier

**SMA Power Surface Mount Package** 

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

- Low I<sub>R</sub>, Extends Battery Life
- 1st in the Market Place with a 10 V<sub>R</sub> Schottky Rectifier
- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Optimized for Low Leakage Current

#### **Mechanical Characteristics:**

- Case: Molded Epoxy
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Ratings: Machine Model = C
  - Human Body Model = 3B
- Available in 12 mm Tape, 5000 Units per 13 inch Reel

#### MAXIMUM RATINGS

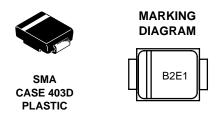
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	10	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C$ = 125°C)	Ι <sub>Ο</sub>	2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	100	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-65 to +150	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Voltage Rate of Change (Rated $V_R$ , $T_J$ = 25°C)	dv/dt	10,000	V/μs



### **ON Semiconductor®**

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### SCHOTTKY BARRIER RECTIFIER 2 AMPERES 10 VOLTS



B2E1 = Device Code

Device	Package	Shipping
MBRA210ET3	SMA	5000/Tape & Reel

Semiconductor Components Industries, LLC, 2002
 December, 2002 - Rev. 3

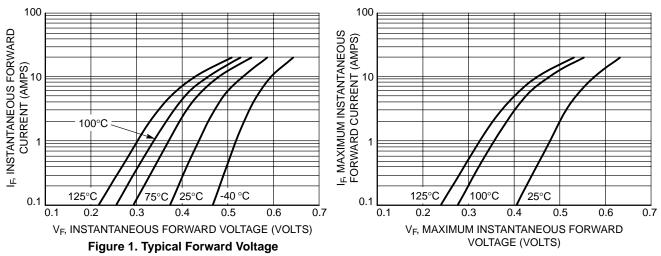
#### THERMAL CHARACTERISTICS

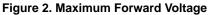
Characteristic	Symbol	Min Pad	1 Inch Pad	Unit
Thermal Resistance - Junction-to-Lead (Note 1)	R <sub>θJL</sub>	22	15	°C/W
Thermal Resistance - Junction-to-Ambient (Note 1)	R <sub>θJA</sub>	150	81	

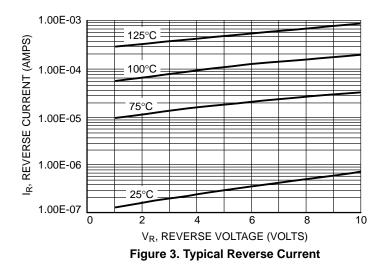
#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 2)	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	V
(I <sub>F</sub> = 0.1 A) (I <sub>F</sub> = 1.0 A) (I <sub>F</sub> = 2.0 A)		0.405 0.480 0.500	0.275 0.355 0.385	
Maximum Instantaneous Reverse Current	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	μΑ
(V <sub>R</sub> = 10 V) (V <sub>R</sub> = 5.0 V)		15 50	200 500	

Mounted on a 3" square FR4 PC Board with min. pads or 1" square copper heat spreader.
 Pulse Test: Pulse Width ≤ 250 µs, Duty Cycle ≤ 2%.







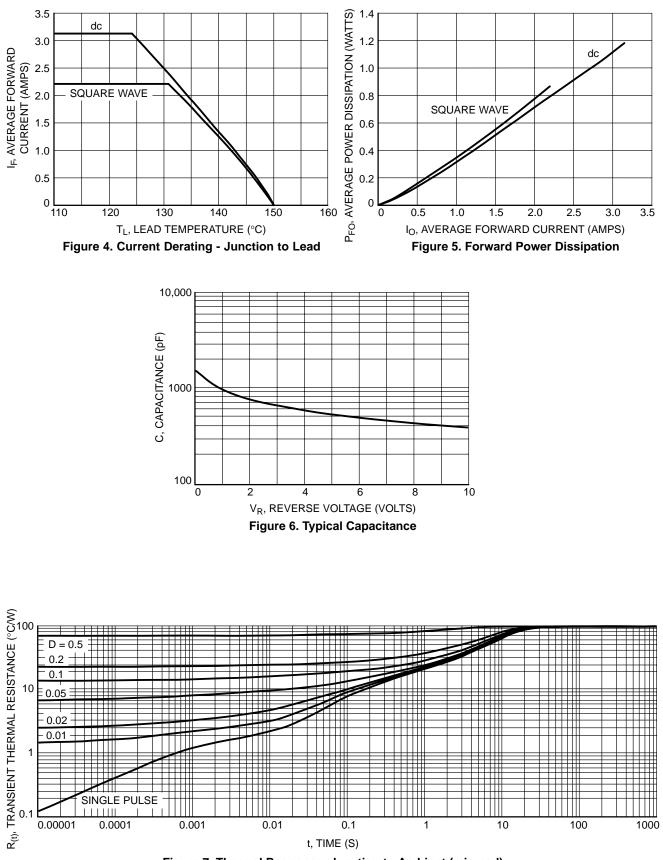


Figure 7. Thermal Response, Junction to Ambient (min pad)

## MBRA210ET3

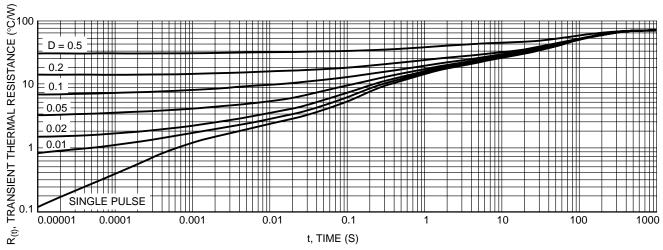


Figure 8. Thermal Response, Junction to Ambient (1 inch pad)

# MBRA210LT3

# Surface Mount Schottky Power Rectifier

SMA Power Surface Mount Package

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

- Ultra Low V<sub>F</sub>
- 1st in the Market Place with a 10 V<sub>R</sub> Schottky Rectifier
- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Optimized for Low Forward Voltage

#### **Mechanical Characteristics:**

- Case: Molded Epoxy
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Ratings: Machine Model = C
  - Human Body Model = 3A
- Available in 12 mm Tape, 5000 Units per 13 inch Reel
- Marking: B2L1

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	10	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>L</sub> = 110°C)	Ι <sub>Ο</sub>	2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	160	A
Storage/Operating Case Temperature Operating Junction Temperature	T <sub>stg</sub> , T <sub>C</sub> T <sub>J</sub>	-55 to +125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J$ = 25°C)	dv/dt	10,000	V/µs



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### SCHOTTKY BARRIER RECTIFIER 2 AMPERES 10 VOLTS



B2L1

MARKING

DIAGRAM

B2L1 = Device Code

Device	Package	Shipping
MBRA210LT3	SMA	5000/Tape & Reel

<sup>©</sup> Semiconductor Components Industries, LLC, 2002 December, 2002 - Rev. 3

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Min Pad	1 Inch Pad	Unit
Thermal Resistance - Junction-to-Lead	R <sub>θJL</sub>	22	15	°C/W
Thermal Resistance - Junction-to-Ambient	R <sub>θJA</sub>	150	81	

#### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 1)	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	V
$(I_F = 0.1 \text{ A})$ $(I_F = 1.0 \text{ A})$ $(I_F = 2.0 \text{ A})$		0.260 0.325 0.350	0.15 0.23 0.26	
Maximum Instantaneous Reverse Current	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
(V <sub>R</sub> = 5.0 V) (V <sub>R</sub> = 10 V)		0.25 0.70	40 60	

1. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2%.

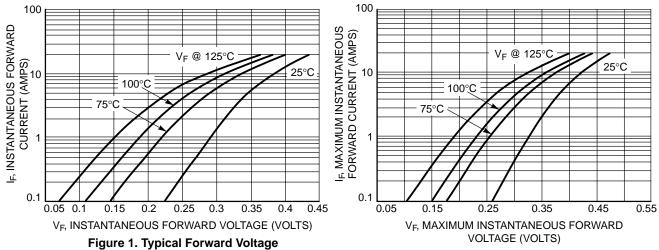
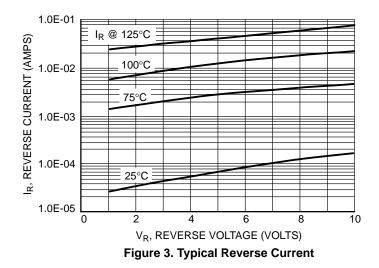


Figure 2. Maximum Forward Voltage



# MBRA210LT3

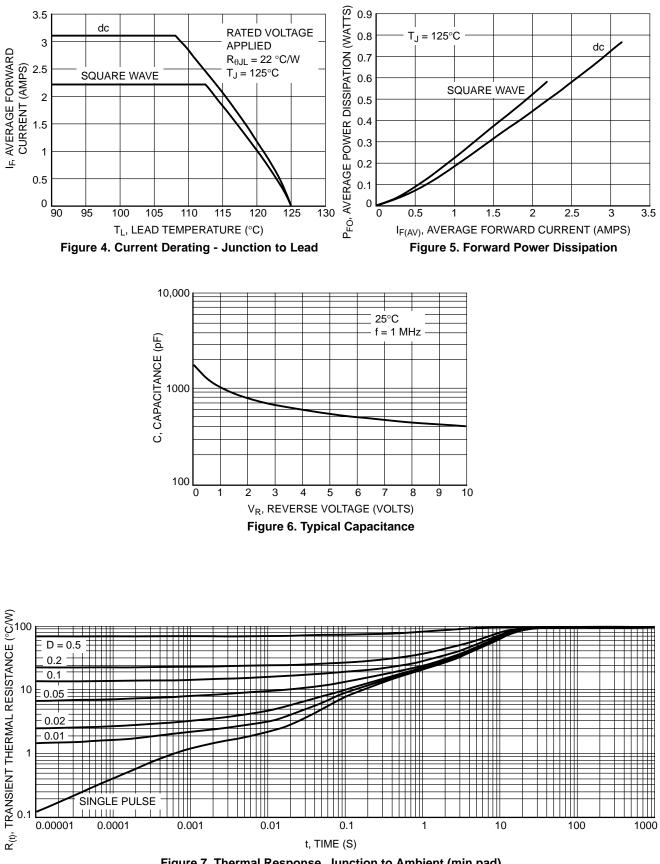


Figure 7. Thermal Response, Junction to Ambient (min pad)

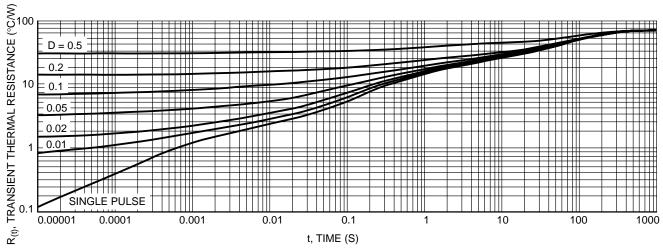


Figure 8. Thermal Response, Junction to Ambient (1 inch pad)

# MBRS120T3

Preferred Device

# Surface Mount Schottky Power Rectifier

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop (0.55 Volts Max @ 1.0 A, T<sub>J</sub> = 25°C)
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Cathode Polarity Band
- Marking: B12

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	V
Average Rectified Forward Current (T <sub>L</sub> = 115°C)	I <sub>F(AV)</sub>	1.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Operating Junction Temperature	TJ	-65 to +125	°C



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#### SCHOTTKY BARRIER RECTIFIER 1.0 AMPERE 20 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



B12 = Device Code

#### ORDERING INFORMATION

Device	Package	Package Shipping	
MBRS120T3	SMB	2500/Tape & Reel	

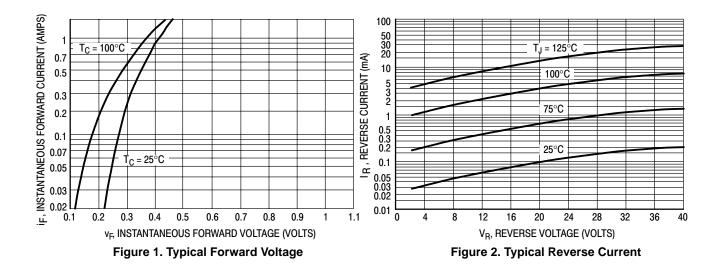
**Preferred** devices are recommended choices for future use and best overall value.

## **MBRS120T3**

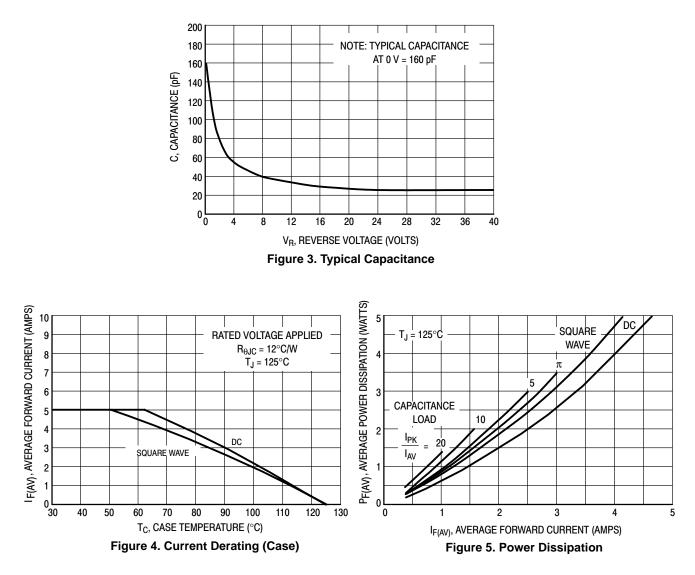
#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Lead $(T_L = 25^{\circ}C)$	R <sub>θJL</sub>	12	°C/W
ELECTRICAL CHARACTERISTICS			
Maximum Instantaneous Forward Voltage (Note 1.) $(i_F = 1.0 \text{ A}, \text{ T}_J = 25^{\circ}\text{C})$	V <sub>F</sub>	0.6	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 100^{\circ}C$ )	İR	1.0 10	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



# MBRS120T3



# MBRS130LT3

Preferred Device

# **Schottky Power Rectifier**

# **Surface Mount Power Package**

... Employs the Schottky Barrier principle in a large area metal- to- silicon power diode. State- of- the- art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system.

- Very Low Forward Voltage Drop (0.395 Volts Max @  $1.0 \text{ A}, \text{T}_{J} = 25^{\circ}\text{C}$ )
- Small Compact Surface Mountable Package with J-Bend Leads
- Highly Stable Oxide Passivated Junction
- Guardring for Stress Protection

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Cathode Polarity Band
- Marking: 1BL3

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Average Rectified Forward Current $T_L = 120^{\circ}C$ $T_L = 110^{\circ}C$	I <sub>F(AV)</sub>	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Operating Junction Temperature	TJ	-65 to +125	°C



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### SCHOTTKY BARRIER RECTIFIER 1.0 AMPERE 30 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



1BL3 = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRS130LT3	SMB	2500/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

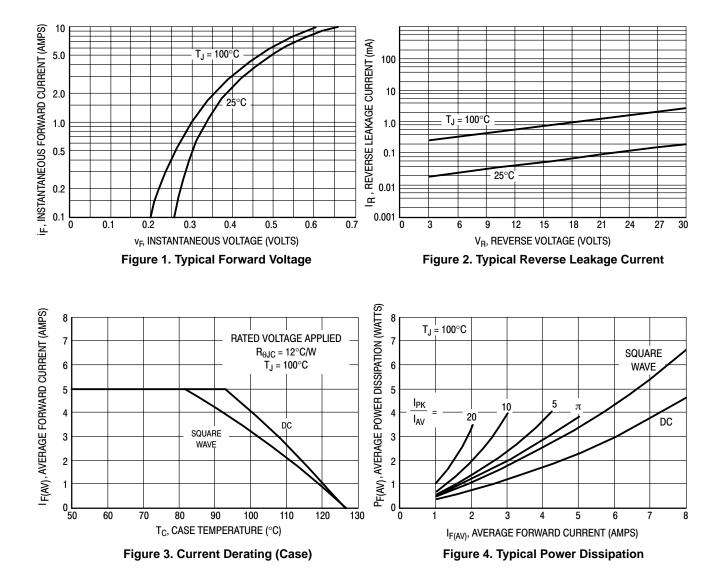
# MBRS130LT3

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance — Junction to Lead $(T_L = 25^{\circ}C)$	$R_{ extsf{ heta}JL}$	12	°C/W
ELECTRICAL CHARACTERISTICS			

Maximum Instantaneous Forward Voltage (Note 1.) ( $i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 2.0 \text{ A}, T_J = 25^{\circ}\text{C}$ )	V <sub>F</sub>	0.395 0.445	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 100^{\circ}C$ )	I <sub>R</sub>	1.0 10	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2%.



# MBRS130LT3

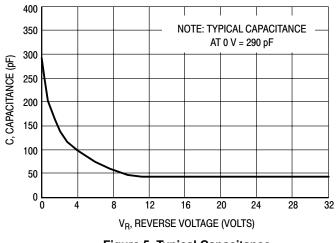


Figure 5. Typical Capacitance

# MBRS130T3

Preferred Device

# Surface Mount Schottky Power Rectifier

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop (0.55 Volts Max @ 1.0 A, T<sub>J</sub> = 25°C)
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Cathode Polarity Band
- Marking: B13

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Average Rectified Forward Current (T <sub>L</sub> = 115°C)	I <sub>F(AV)</sub>	1.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Operating Junction Temperature	TJ	-65 to +125	°C



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### SCHOTTKY BARRIER RECTIFIER 1.0 AMPERE 30 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



B13 = Device Code

## ORDERING INFORMATION

Device	Package	Shipping
MBRS130T3	SMB	2500/Tape & Reel

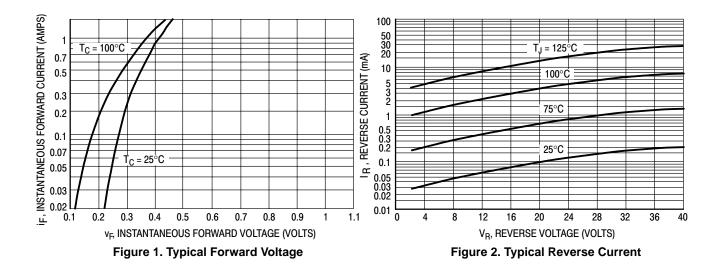
**Preferred** devices are recommended choices for future use and best overall value.

# MBRS130T3

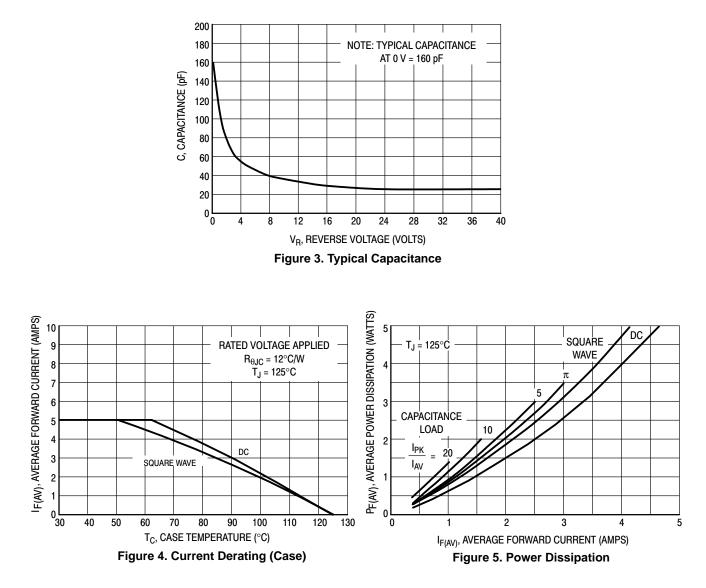
#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Lead $(T_L = 25^{\circ}C)$	R <sub>θJL</sub>	12	°C/W
ELECTRICAL CHARACTERISTICS			
Maximum Instantaneous Forward Voltage (Note 1.) $(i_F = 1.0 \text{ A}, \text{ T}_J = 25^{\circ}\text{C})$	V <sub>F</sub>	0.6	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 100^{\circ}C$ )	İR	1.0 10	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



# **MBRS130T3**



Preferred Device

# Surface Mount Schottky Power Rectifier

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop (0.55 Volts Max @ 1.0 A, T<sub>J</sub> = 25°C)
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Cathode Polarity Band
- Marking: B14

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
Average Rectified Forward Current (T <sub>L</sub> = 115°C)	I <sub>F(AV)</sub>	1.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Operating Junction Temperature	TJ	-65 to +125	°C



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### SCHOTTKY BARRIER RECTIFIER 1.0 AMPERE 40 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



B14 = Device Code

### ORDERING INFORMATION

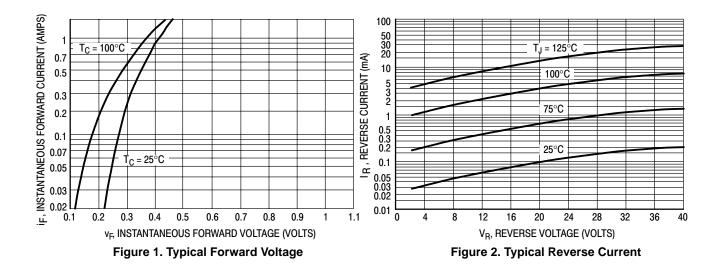
Device	Package	Shipping
MBRS140T3	SMB	2500/Tape & Reel

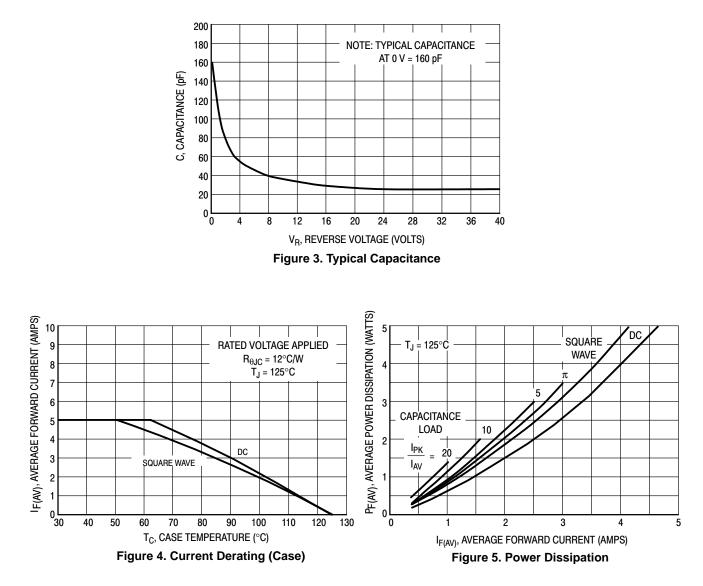
**Preferred** devices are recommended choices for future use and best overall value.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Lead $(T_L = 25^{\circ}C)$	R <sub>θJL</sub>	12	°C/W
ELECTRICAL CHARACTERISTICS			
Maximum Instantaneous Forward Voltage (Note 1.) $(i_F = 1.0 \text{ A}, \text{ T}_J = 25^{\circ}\text{C})$	V <sub>F</sub>	0.6	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 100^{\circ}C$ )	İR	1.0 10	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.





# Surface Mount Schottky Power Rectifier

# SMB Power Surface Mount Package

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop
- Mechanical Characteristics:
- Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 95 mg (approximately)
- Cathode Polarity Band
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Available in 12 mm Tape, 2500 Units per 13" Reel, Add "T3" Suffix to Part Number
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Marking: B14L

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 110°C)	Ι <sub>Ο</sub>	1.0	A
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 100 kHz, T <sub>C</sub> = 110°C)	I <sub>FRM</sub>	2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J$ = 25°C)	dv/dt	10,000	V/μs



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### SCHOTTKY BARRIER RECTIFIER 1.0 AMPERE 40 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



B14L = Device Code

### **ORDERING INFORMATION**

Device	Package	Shipping
MBRS140LT3	SMB	2500/Tape & Reel

#### THERMAL CHARACTERISTICS

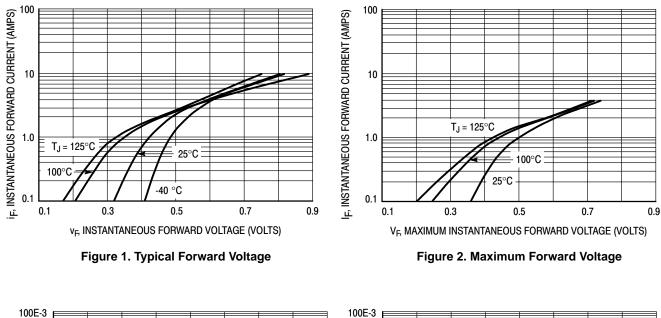
Characteristic	Symbol	Мах	Unit
Thermal Resistance — Junction-to-Lead (Note 1.) Thermal Resistance — Junction-to-Ambient (Note 2.)	$R_{ heta JL}$ $R_{ heta JA}$	24 80	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3.)		VF	T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	Volts
see Figure 2	(i <sub>F</sub> = 1.0 A) (i <sub>F</sub> = 2.0 A)		0.5 0.6	0.425 0.58	
Maximum Instantaneous Reverse Current (Note 3.)		I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
see Figure 4	(V <sub>R</sub> = 40 V) (V <sub>R</sub> = 20 V)		0.4 0.02	10 5.0	

1. Mounted with minimum recommended pad size, PC Board FR4.

2. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board. 3. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2.0%.



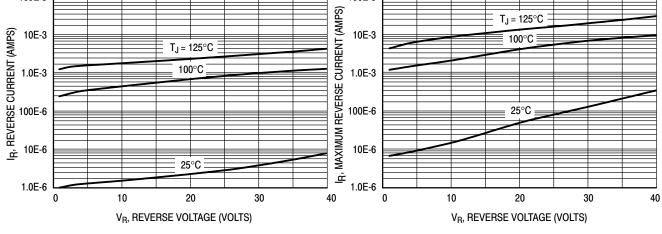
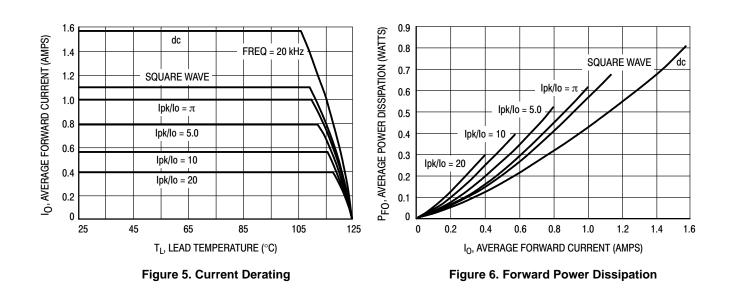
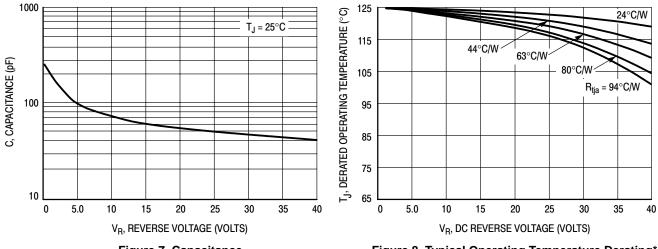


Figure 3. Typical Reverse Current











\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of  $T_J$  therefore must include forward and reverse power effects. The allowable operating  $T_J$  may be calculated from the equation:  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where r(t) = thermal impedance under given conditions,

r(t) = thermal impedance under given conditions, Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.

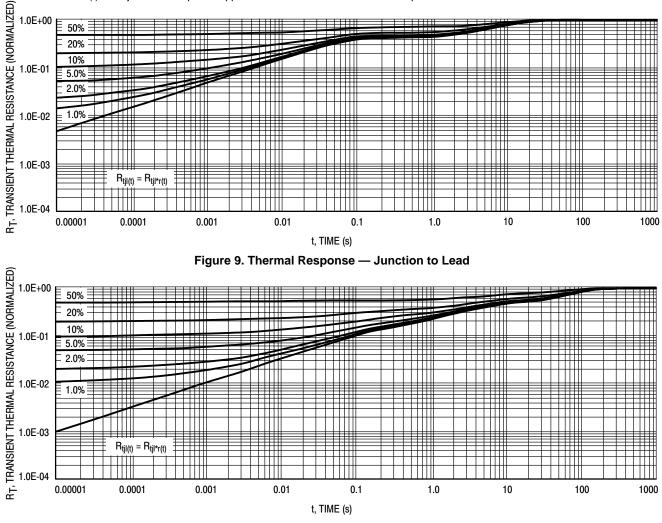


Figure 10. Thermal Response — Junction to Ambient

# MBRS1100T3, MBRS190T3

**Preferred Devices** 

# **Schottky Power Rectifier**

# Surface Mount Power Package

Schottky Power Rectifiers employ the use of the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system. These state-of-the-art devices have the following features:

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- High Blocking Voltage 100 Volts
- 150°C Operating Junction Temperature
- Guardring for Stress Protection

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Cathode Polarity Band
- Markings; MBRS190T3: B19 MBRS1100T3: B1C

## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MBRS190T3 MBRS1100T3	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	90 100	V
Average Rectified Forward Current $T_L = 120^{\circ}C$ $T_L = 100^{\circ}C$	I <sub>F(AV)</sub>	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	50	A
Operating Junction Temperature	TJ	-65 to +150	°C
Voltage Rate of Change	dv/dt	10	V/ns



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## SCHOTTKY BARRIER RECTIFIER 1.0 AMPERE 90, 100 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



B1x = Device Code x = 9 or C

### ORDERING INFORMATION

Device	Package	Shipping
MBRS1100T3	SMB	2500/Tape & Reel
MBRS190T3	SMB	2500/Tape & Reel

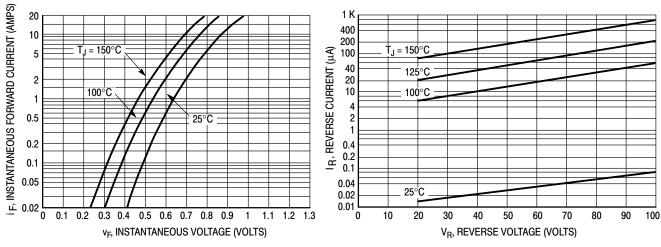
Preferred devices are recommended choices for future use and best overall value.

# MBRS1100T3, MBRS190T3

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance — Junction to Lead ( $T_L = 25^{\circ}C$ )	R <sub>θJL</sub>	22	°C/W
ELECTRICAL CHARACTERISTICS			
Maximum Instantaneous Forward Voltage (Note 1.) ( $i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$ )	V <sub>F</sub>	0.75	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, TJ = 25°C) (Rated dc Voltage, T <sub>J</sub> = 100°C)	I <sub>R</sub>	0.5 5.0	mA

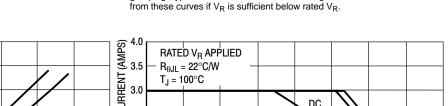
1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

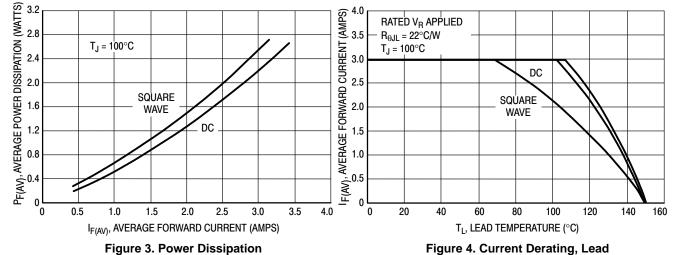


## **TYPICAL ELECTRICAL CHARACTERISTICS**

Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current\* \*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated





# **MBRS1100T3, MBRS190T3**

## **TYPICAL ELECTRICAL CHARACTERISTICS**

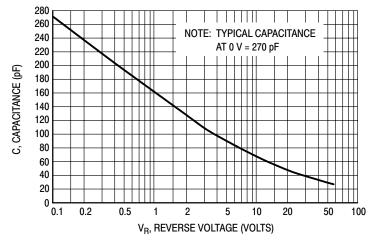


Figure 5. Typical Capacitance

# Surface Mount Schottky Power Rectifier

# SMB Power Surface Mount Package

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop
- Mechanical Characteristics:
- Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 95 mg (approximately)
- Cathode Polarity Band
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Available in 12 mm Tape, 2500 Units per 13" Reel, Add "T3" Suffix to Part Number
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Marking: BGJ

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 100^{\circ}C$ )	Ι <sub>Ο</sub>	1.5	A
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 100 kHz, $T_C = 105^{\circ}C$ )	I <sub>FRM</sub>	3.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J$ = 25°C)	dv/dt	10,000	V/μs



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### SCHOTTKY BARRIER RECTIFIER 1.5 AMPERES 40 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



BGJ = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRS1540T3	SMB	2500/Tape & Reel

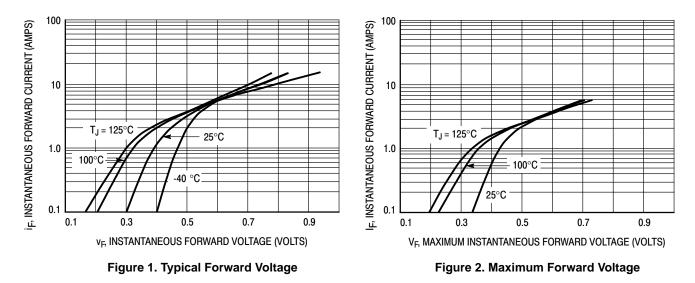
#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction-to-Lead (Note 1.)	R <sub>θJL</sub>	24	°C/W
Thermal Resistance — Junction-to-Ambient (Note 2.)	R <sub>θJA</sub>	80	

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3.)		٧F	$T_J = 25^{\circ}C$	T <sub>J</sub> = 125°C	Volts
see Figure 2	(i <sub>F</sub> = 1.5 A) (i <sub>F</sub> = 3.0 A)		0.46 0.54	0.39 0.54	
Maximum Instantaneous Reverse Current (Note 3.)		I <sub>R</sub>	$T_J = 25^{\circ}C$	T <sub>J</sub> = 100°C	mA
see Figure 4	(V <sub>R</sub> = 40 V) (V <sub>R</sub> = 20 V)		0.8 0.1	5.7 1.6	

1. Mounted with minimum recommended pad size, PC Board FR4.2. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.3. Pulse Test: Pulse Width  $\leq 250 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .



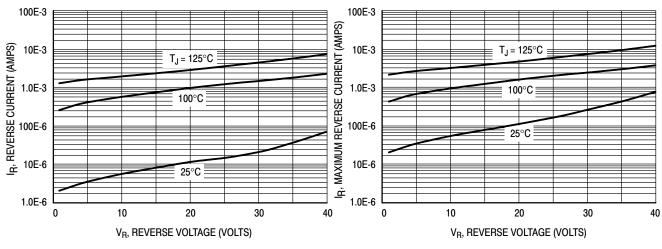
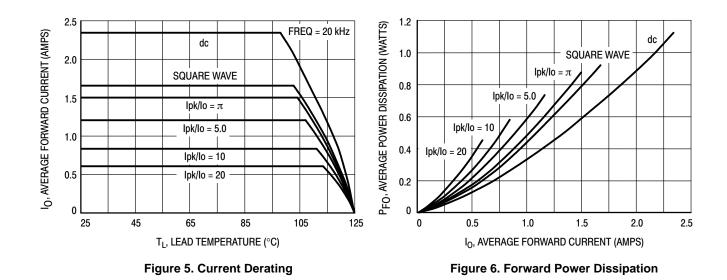
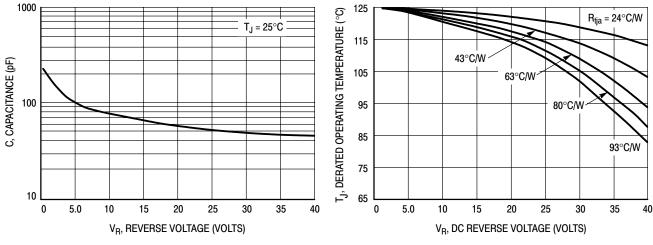


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current









\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of  $T_J$  therefore must include forward and reverse power effects. The allowable operating  $T_J$  may be calculated from the equation:  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.

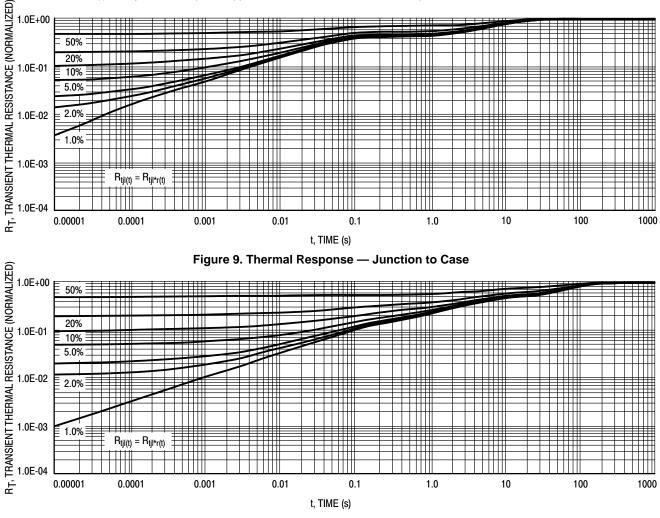


Figure 10. Thermal Response — Junction to Ambient

# Surface Mount Schottky Power Rectifier

# SMB Power Surface Mount Package

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop
- Mechanical Characteristics:
- Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 95 mg (approximately)
- Cathode Polarity Band
- Maximum Temperature of 260°C/10 Seconds for Soldering
- Available in 12 mm Tape, 2500 Units per 13" Reel, Add "T3" Suffix to Part Number
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Marking: 2BL4

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 100°C)	Ι <sub>Ο</sub>	2.0	A
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 105°C)	I <sub>FRM</sub>	4.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	25	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J$ = 25°C)	dv/dt	10,000	V/μs



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### SCHOTTKY BARRIER RECTIFIER 2.0 AMPERES 40 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



2BL4 = Device Code

### ORDERING INFORMATION

Device	Package	Shipping
MBRS240LT3	SMB	2500/Tape & Reel

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction-to-Lead (Note 1.)	R <sub>θJL</sub>	18	°C/W
Thermal Resistance — Junction-to-Ambient (Note 3.)	R <sub>θJA</sub>	78	

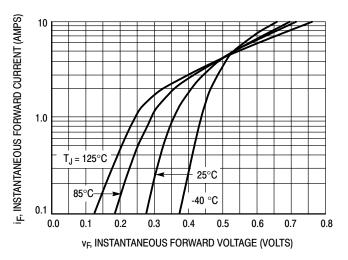
#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 2.)		VF	T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	Volts
see Figure 2	(I <sub>F</sub> = 2.0 A) (I <sub>F</sub> = 4.0 A)		0.43 0.54	0.375 0.55	
Maximum Instantaneous Reverse Current (Note 2.)		I <sub>R</sub>	T <sub>J</sub> = 25°C	$T_J = 100^{\circ}C$	mA
	(V <sub>R</sub> = 40 V)		2.0	60	
see Figure 4	$(V_R = 20 V)$		0.5	40	

1. Mounted with minimum recommended pad size, PC Board FR4.

2. Pulse Test: Pulse Width  $\leq 250 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .

3. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.





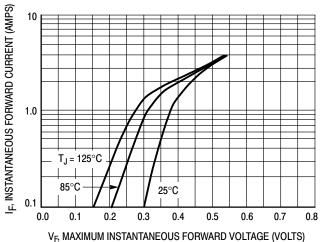


Figure 2. Maximum Forward Voltage

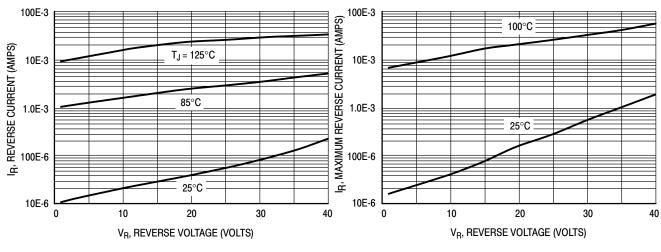


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

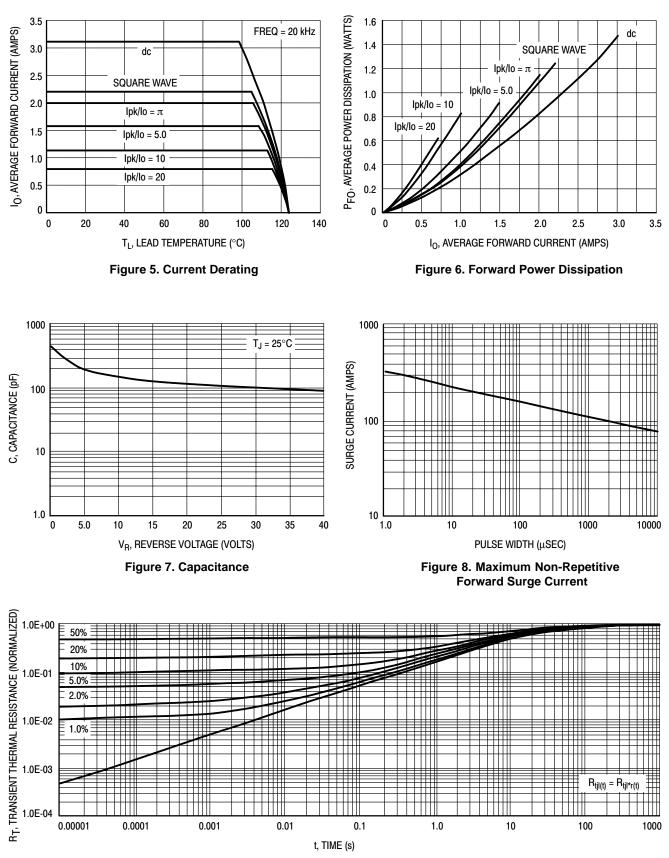


Figure 9. Thermal Response

# Surface Mount Schottky Power Rectifier

# **SMB Power Surface Mount Package**

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop
- Mechanical Characteristics:
- Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 95 mg (approximately)
- Maximum Temperature of 260°C / 10 Seconds for Soldering
- Cathode Polarity Band
- Available in 12 mm Tape, 2500 Units per 13 inch Reel, Add "T3" Suffix to Part Number
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Marking: BKJL

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 103°C)	Ι <sub>Ο</sub>	2.0	A
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 104°C)	I <sub>FRM</sub>	4.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	70	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J$ = 25°C)	dv/dt	10,000	V/μs



## ON Semiconductor<sup>™</sup>

http://onsemi.com

### SCHOTTKY BARRIER RECTIFIER 2.0 AMPERES 40 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



BKJL = Device Code

### ORDERING INFORMATION

Device	Package	Shipping
MBRS2040LT3	SMB	2500/Tape & Reel

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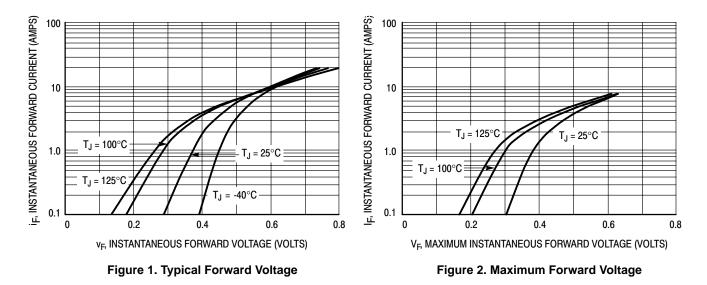
#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction-to-Lead (Note 1.) Thermal Resistance — Junction-to-Ambient (Note 2.)	$R_{ extsf{ heta}JL}$ $R_{ hetaJA}$	22.5 78	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3.)		V <sub>F</sub>	$T_J = 25^{\circ}C$	T <sub>J</sub> = 125°C	Volts
see Figure 2	(I <sub>F</sub> = 2.0 A) (I <sub>F</sub> = 4.0 A)		0.43 0.50	0.34 0.45	
Maximum Instantaneous Reverse Current (Note 3.)		I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
see Figure 4	(V <sub>R</sub> = 40 V) (V <sub>R</sub> = 20 V)		0.8 0.1	20 6.0	

1. Minimum pad size (0.108 X 0.085 inch) for each lead on FR4 board.2. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.3. Pulse Test: Pulse Width  $\leq 250 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .



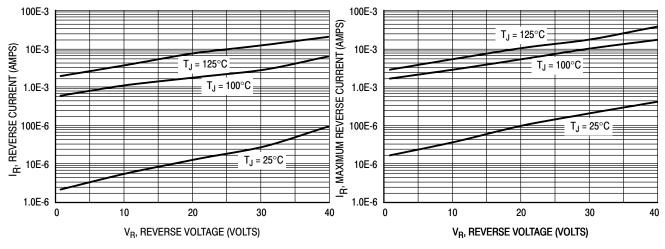
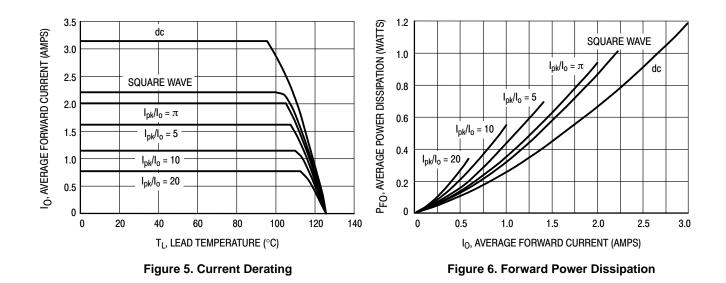
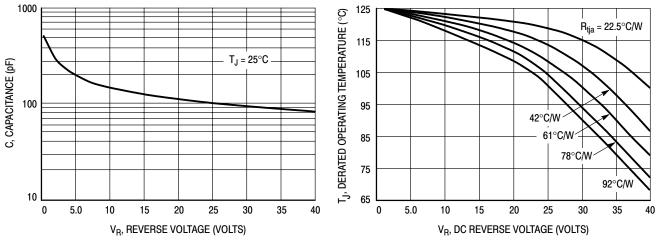


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current









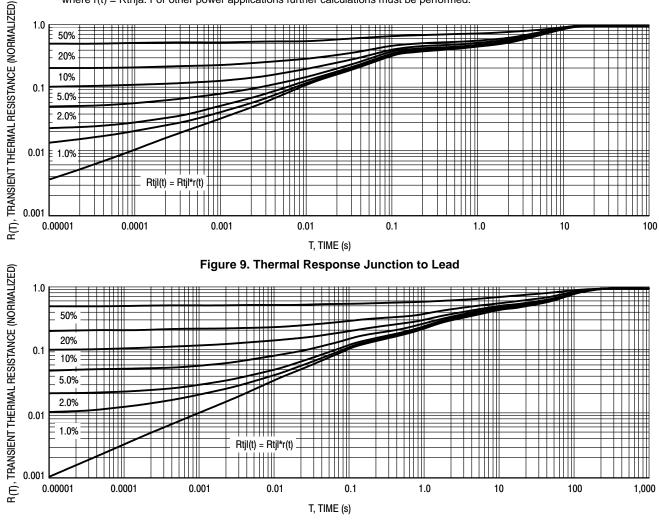
\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of  $T_J$  therefore must include forward and reverse power effects. The allowable operating  $T_J$  may be calculated from the equation:  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = R thia. For other power applications further calculations must be performed.





# MBRS260T3

# Surface Mount Schottky Power Rectifier

# **SMB Power Surface Mount Package**

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop
- Mechanical Characteristics:
- Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 95 mg (approximately)
- Cathode Polarity Band
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Available in 12 mm Tape, 2500 Units per 13" Reel, Add "T3" Suffix to Part Number
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- ESD Ratings: Machine Model = C
  - Human Body Model = 3B
- Marking: B26

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>L</sub> = 95°C)	Ι <sub>Ο</sub>	2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +125	°C
Voltage Rate of Change (Rated V <sub>R</sub> , T <sub>J</sub> = 25°C)	dv/dt	10,000	V/μs



## ON Semiconductor<sup>™</sup>

http://onsemi.com

### SCHOTTKY BARRIER RECTIFIER 2.0 AMPERES 60 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



B26 = Device Code

### ORDERING INFORMATION

Device	Package	Shipping
MBRS260T3	SMB	2500/Tape & Reel

# MBRS260T3

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction-to-Lead (Note 1.) Thermal Resistance - Junction-to-Ambient (Note 2.)	$R_{ extsf{ heta}JL}$ $R_{ hetaJA}$	24 80	°C/W

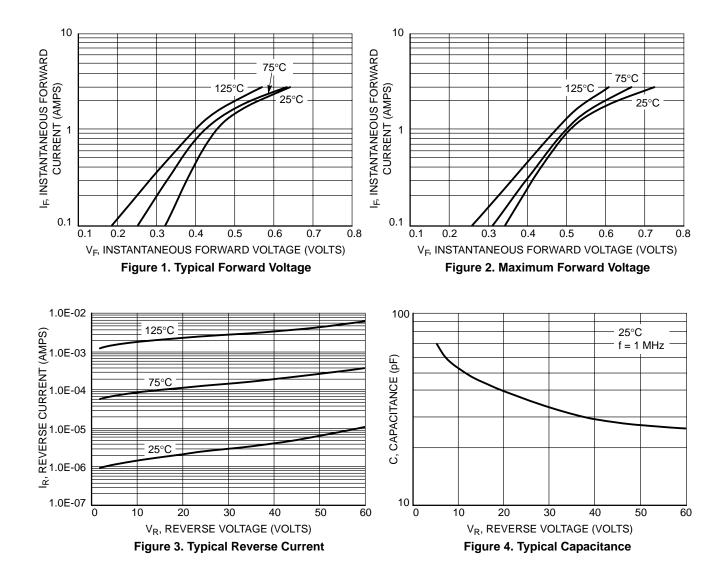
#### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 3.)	٧F	T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	Volts
$(i_{F} = 1.0 \text{ A})$ $(i_{F} = 2.0 \text{ A})$		0.51 0.63	0.475 0.55	
Maximum Instantaneous Reverse Current (Note 3.)	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	mA
$(V_R = 60 \text{ V})$		0.2	10	

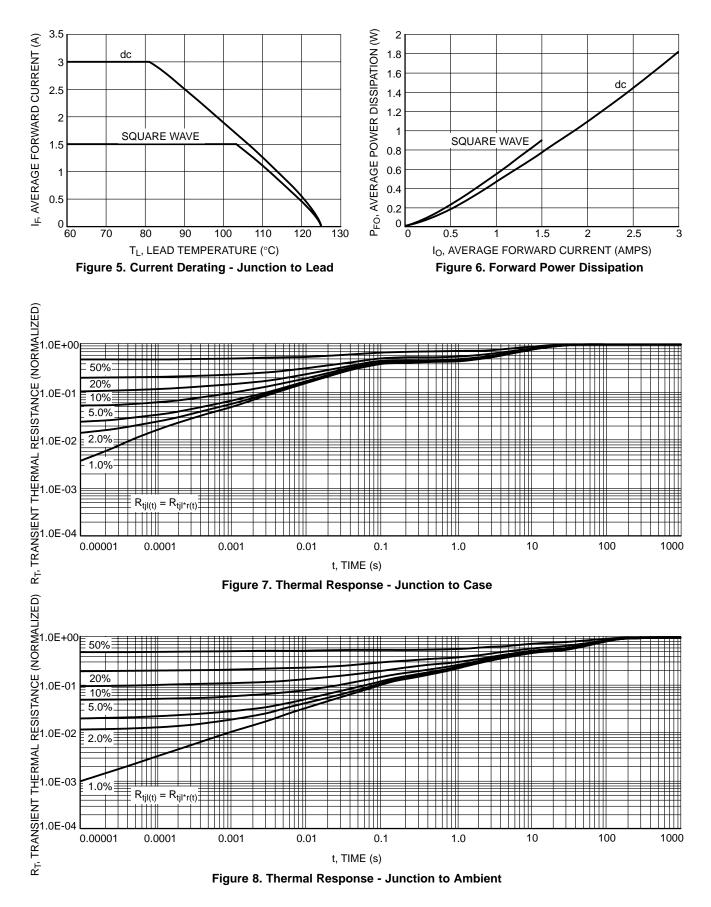
1. Mounted with minimum recommended pad size, PC Board FR4.

2. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.

3. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2.0%.



## **MBRS260T3**



# Surface Mount Schottky Power Rectifier

# SMB Power Surface Mount Package

... employing the Schottky Barrier principle in a metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop
- Mechanical Characteristics:
- Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 95 mg (approximately)
- Cathode Polarity Band
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Available in 12 mm Tape, 2500 Units per 13" Reel, Add "T3" Suffix to Part Number
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- ESD Ratings: Machine Model = C Human Body Model = 3B
- Marking: SS26

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>L</sub> = 95°C)	Ι <sub>Ο</sub>	2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +125	°C
Voltage Rate of Change (Rated V <sub>R</sub> , T <sub>J</sub> = 25°C)	dv/dt	10,000	V/μs



## ON Semiconductor<sup>™</sup>

http://onsemi.com

### SCHOTTKY BARRIER RECTIFIER 2.0 AMPERES 60 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



SS26 = Device Code

### ORDERING INFORMATION

Device	Package	Shipping
SS26	SMB	2500/Tape & Reel

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction-to-Lead (Note 1.) Thermal Resistance - Junction-to-Ambient (Note 2.)	$R_{ extsf{ heta}JL}$ $R_{ hetaJA}$	24 80	°C/W

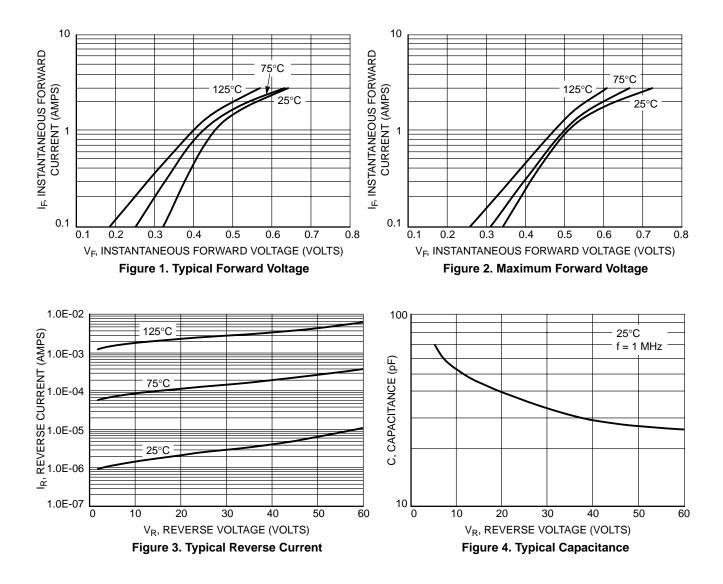
#### ELECTRICAL CHARACTERISTICS

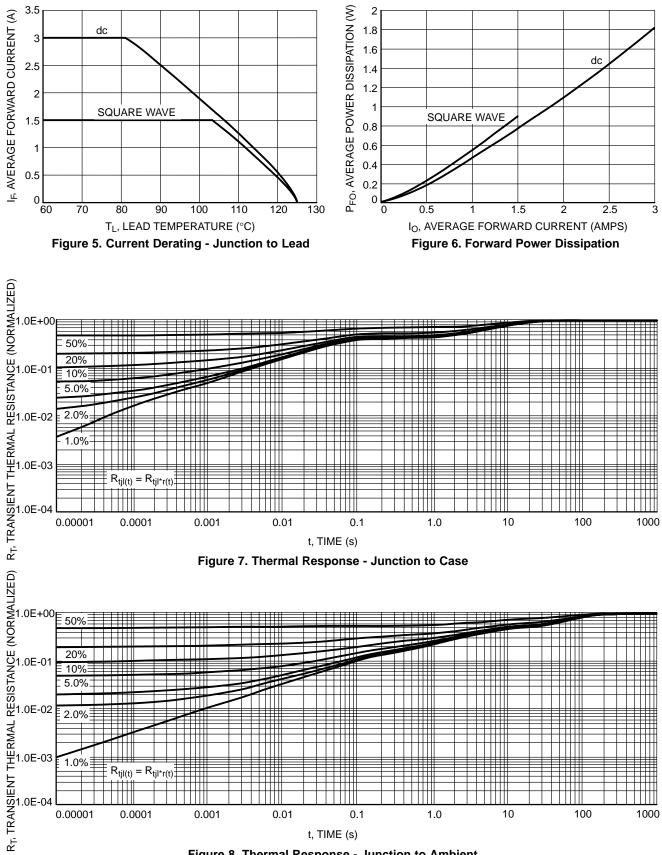
Maximum Instantaneous Forward Voltage (Note 3.) $\begin{array}{l} (i_{F}=1.0 \text{ A}) \\ (i_{F}=2.0 \text{ A}) \end{array}$		T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	Volts
		0.51 0.63	0.475 0.55	
Maximum Instantaneous Reverse Current (Note 3.)	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	mA
$(V_R = 60 \text{ V})$		0.2	10	

1. Mounted with minimum recommended pad size, PC Board FR4.

2. 1 inch square pad size (1 x 0.5 inch for each lead) on FR4 board.

3. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2.0%.







# MBRS320T3, MBRS330T3, MBRS340T3, MBRS360T3

**Preferred Devices** 

# Surface Mount Schottky Power Rectifier

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop (0.5 Volts Max @ 3.0 A, T<sub>J</sub> = 25°C)
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 217 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 16 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: B32, B33, B34, B36

#### MAXIMUM RATINGS

Please See the Table on the Following Page



## ON Semiconductor<sup>™</sup>

http://onsemi.com

## SCHOTTKY BARRIER RECTIFIERS 3.0 AMPERES 20, 30, 40, 60 VOLTS



SMC CASE 403 PLASTIC

#### MARKING DIAGRAM



B3x = Device Codex = 2, 3, 4 or 6 Y = Year

W = Work Week

#### **ORDERING INFORMATION**

Device	Package	Shipping		
MBRS320T3	SMC	2500/Tape & Reel		
MBRS330T3	SMC	2500/Tape & Reel		
MBRS340T3	SMC	2500/Tape & Reel		
MBRS360T3	SMC	2500/Tape & Reel		

**Preferred** devices are recommended choices for future use and best overall value.

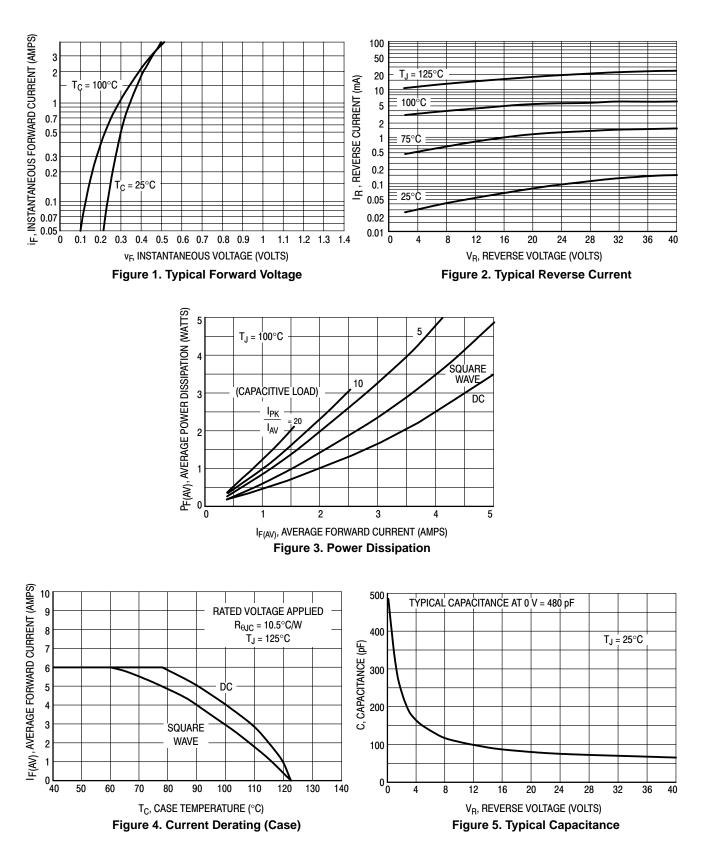
# MBRS320T3, MBRS330T3, MBRS340T3, MBRS360T3

#### MAXIMUM RATINGS

Rating	Symbol	MBRS320T3	MBRS330T3	MBRS340T3	MBRS360T3	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	30	40	60	Volts
Average Rectified Forward Current	I <sub>F(AV)</sub>	3.0 @ T <sub>L</sub> = 100°C 4.0 @ T <sub>L</sub> = 90°C				
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	80	80	80	80	Amps
Operating Junction Temperature	TJ	- 65 to +125	- 65 to +125 - 65 to +125			°C
THERMAL CHARACTERISTICS						
Thermal Resistance — Junction to Lead	$R_{ extsf{ heta}JL}$	11	11	11	11	°C/W
ELECTRICAL CHARACTERISTICS						•
Maximum Instantaneous Forward Voltage (Note 1.) ( $i_F = 3.0 \text{ A}, \text{ T}_J = 25^{\circ}\text{C}$ )	V <sub>F</sub>	0.50	0.50	0.525	0.740	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 100^{\circ}C$ )	i <sub>R</sub>	2.0 20	2.0 20	2.0 20	0.5 20	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

### MBRS320T3, MBRS330T3, MBRS340T3, MBRS360T3



# **MBRS3100T3**

Preferred Device

## Surface Mount Schottky Power Rectifier

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 217 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 16 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- ESD Ratings: Machine Model = C
  - Human Body Model = 3B
- Marking: B310

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	Volts
Average Rectified Forward Current (At Rated V <sub>R</sub> , $T_L$ = 100°C)	I <sub>F(AV)</sub>	3.0	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load condi- tions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	130	Amps
Operating Junction Temperature Range	TJ	- 65 to +150	°C
THERMAL CHARACTERISTICS			
Thermal Resistance - Junction to Lead	R <sub>0.II</sub>	11	°C/W



### ON Semiconductor<sup>™</sup>

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#### SCHOTTKY BARRIER RECTIFIERS 3.0 AMPERES 100 VOLTS



SMC CASE 403 PLASTIC

#### MARKING DIAGRAM



Y = Year WW = Work Week B310 = Device Code

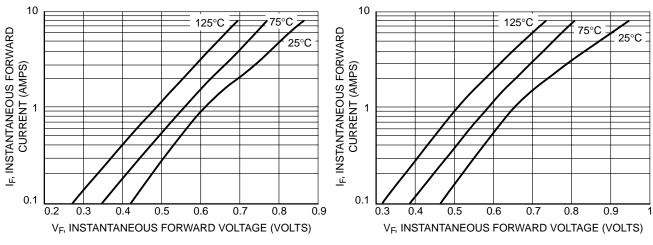
#### ORDERING INFORMATION

Device	Package	Shipping
MBRS3100T3	SMC	2500/Tape & Reel

#### **ELECTRICAL CHARACTERISTICS**

	VF	0.79 0.90 0.62 0.70	Volts
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 125^{\circ}C$ )	İR	0.05 5.0	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.





1E-03

1E-04

1E-05

1E-06

1E-07

1E-08

0

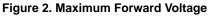
IR, REVERSE CURRENT (AMPS)

125°C

≡ 75°C

25°C

20



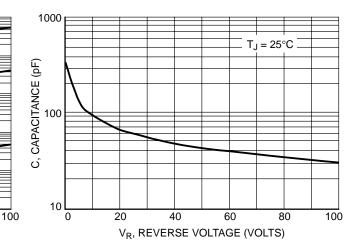


Figure 3. Typical Reverse Current

V<sub>R</sub>, REVERSE VOLTAGE (VOLTS)

60

80

40

Figure 4. Typical Capacitance

## **MBRS3100T3**

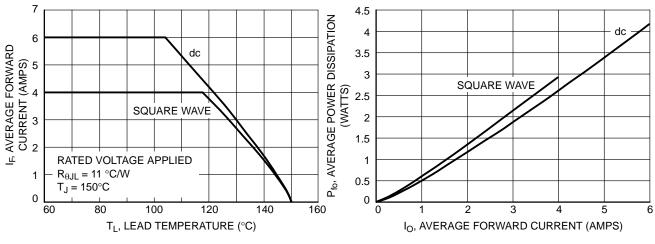


Figure 5. Current Derating - Lead

Figure 6. Forward Power Dissipation

# MBRS410ET3

Preferred Device

## Surface Mount Schottky Power Rectifier

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

- Very Low V<sub>F</sub> Accompanied by Low I<sub>R</sub>
- 1st in the Market Place with a 10 V<sub>R</sub> Schottky Rectifier
- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Designed for Low Leakage
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 217 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 16 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- ESD Ratings: Machine Model = C
  - Human Body Model = 3B
- Marking: B4E1

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	10	V
Average Rectified Forward Current (@ T <sub>L</sub> = 130°C)	Ι <sub>Ο</sub>	4.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	250	A
Operating Junction Temperature	TJ	-65 to +150	°C



### ON Semiconductor<sup>™</sup>

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#### SCHOTTKY BARRIER RECTIFIERS 4.0 AMPERES 10 VOLTS



SMC CASE 403 PLASTIC

#### MARKING DIAGRAM



Y = Year WW = Work Week B4E1= Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRS410ET3	SMC	2500/Tape & Reel

## MBRS410ET3

#### THERMAL CHARACTERISTICS

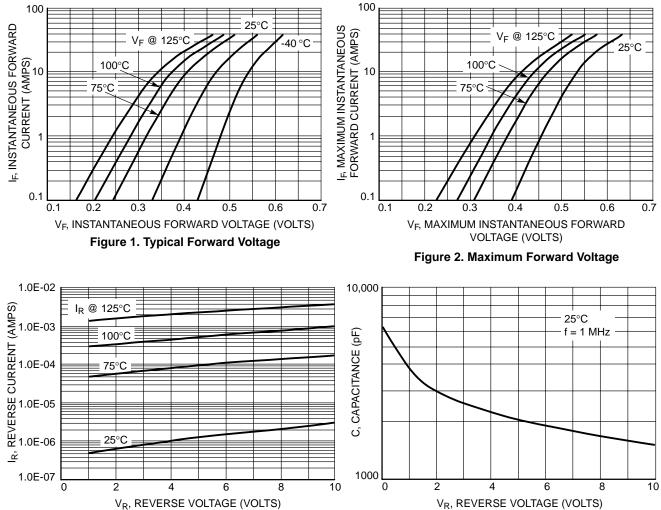
Characteristic	Symbol	5 mm x 5 mm (Note 2)	1 Inch x 1/2 inch	Unit
Thermal Resistance - Junction-to-Lead	R <sub>θJL</sub>	12	7.0	°C/W
Thermal Resistance - Junction-to-Ambient	R <sub>θJA</sub>	109	59	

#### **ELECTRICAL CHARACTERISTICS**

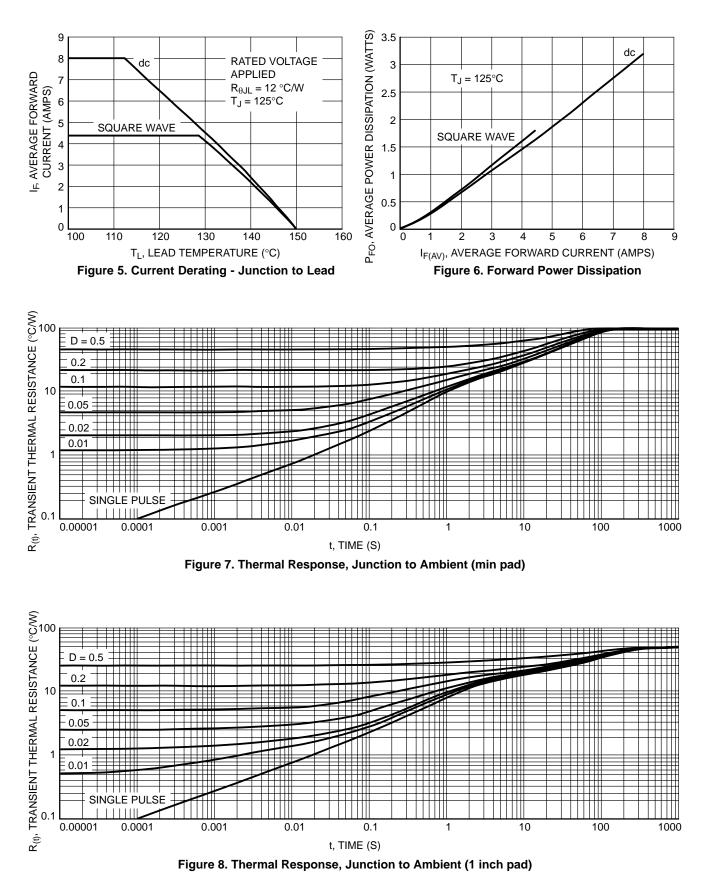
Maximum Instantaneous Forward Voltage (Note 1)	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	V
$(I_F = 2.0 \text{ A})$ $(I_F = 4.0 \text{ A})$ $(I_F = 8.0 \text{ A})$		0.475 0.500 0.525	0.370 0.395 0.430	
Maximum Instantaneous Reverse Current (Note 1)	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	μΑ
(Rated dc Voltage, $V_R = 5.0 \text{ V}$ ) (Rated dc Voltage, $V_R = 10 \text{ V}$ )		50 150	2000 4000	

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 Mounted with Minimum Recommended Pad Size, PC Board FR4.

Figure 3. Typical Reverse Current



## MBRS410ET3



# MBRS410LT3

Preferred Device

## Surface Mount Schottky Power Rectifier

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency rectification, or as free wheeling and polarity protection diodes, in surface mount applications where compact size and weight are critical to the system. Typical applications are ac/dc and dc-dc converters, reverse battery protection, and "Oring" of multiple supply voltages and any other application where performance and size are critical.

- Ultra Low V<sub>F</sub>
- 1st in the Market Place with a 10 V<sub>R</sub> Schottky Rectifier
- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guarding for Stress Protection

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 217 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 16 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- ESD Ratings: Machine Model = C
  - Human Body Model = 3B
- Marking: B4L1

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	10	V
Average Rectified Forward Current (@ T <sub>L</sub> = 110°C)	Ι <sub>Ο</sub>	4.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Operating Junction Temperature	TJ	-65 to +125	°C



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#### SCHOTTKY BARRIER RECTIFIERS 4.0 AMPERES 10 VOLTS



SMC CASE 403 PLASTIC

#### MARKING DIAGRAM



Y = Year WW = Work Week B4L1 = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBRS410LT3	SMC	2500/Tape & Reel

## MBRS410LT3

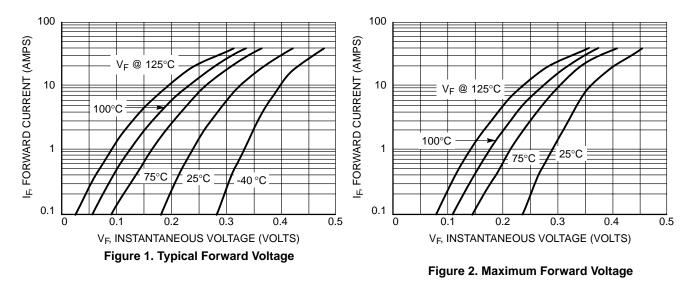
#### THERMAL CHARACTERISTICS

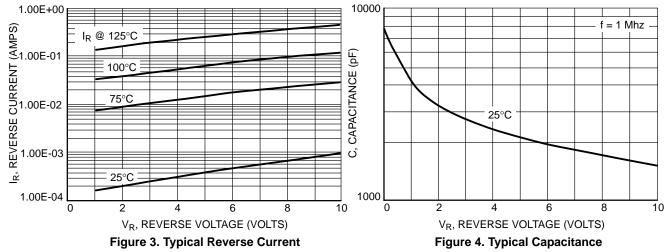
Characteristic	Symbol	Min Pad (Note 2)	1 Inch Pad	Unit
Thermal Resistance - Junction-to-Lead	R <sub>θJL</sub>	12	7.0	°C/W
Thermal Resistance - Junction-to-Ambient	R <sub>θJA</sub>	109	59	

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 1)	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	V
$(I_F = 2.0 \text{ A})$ $(I_F = 4.0 \text{ A})$ $(I_F = 8.0 \text{ A})$		0.31 0.33 0.35	0.200 0.225 0.250	
Maximum Instantaneous Reverse Current (Note 1)	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
(Rated dc Voltage, $V_R = 5.0 \text{ V}$ ) (Rated dc Voltage, $V_R = 10 \text{ V}$ )		2.0 5.0	100 200	

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
 Mounted with Minimum Recommended Pad Size, PC Board FR4.





## MBRS410LT3

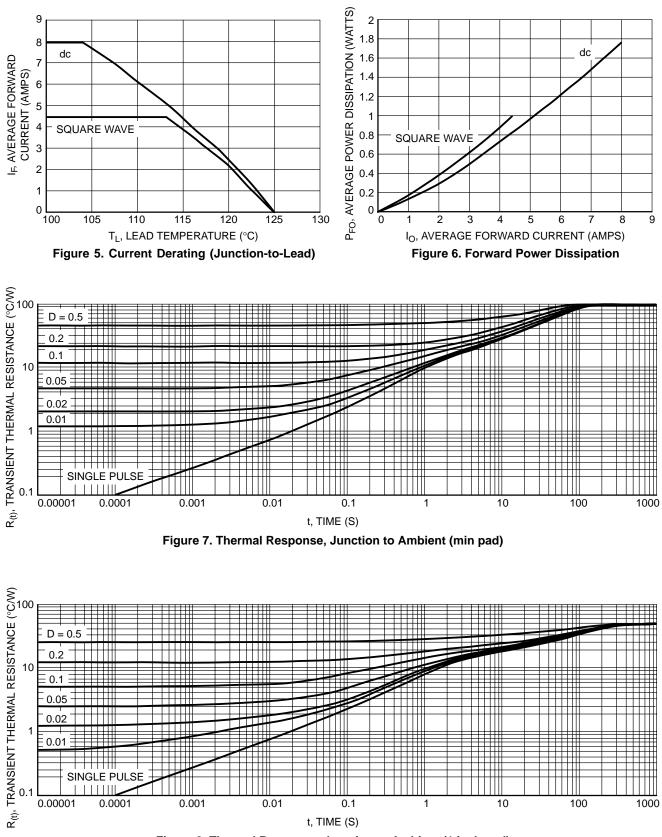


Figure 8. Thermal Response, Junction to Ambient (1 inch pad)

# MBRD320, MBRD330, MBRD340, MBRD350, MBRD360

MBRD320, MBRD340 and MBRD360 are Preferred Devices

## SWITCHMODE™ Power Rectifiers

## **DPAK Surface Mount Package**

... designed for use as output rectifiers, free wheeling, protection and steering diodes in switching power supplies, inverters and other inductive switching circuits. These state-of-the-art devices have the following features:

- Extremely Fast Switching
- Extremely Low Forward Drop
- Platinum Barrier with Avalanche Guardrings

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: B320, B330, B340, B350, B360

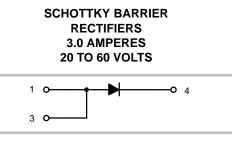
#### MAXIMUM RATINGS

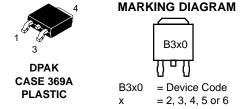
Please See the Table on the Following Page



### ON Semiconductor<sup>™</sup>

http://onsemi.com





#### **ORDERING INFORMATION**

Device	Package	Shipping
MBRD320	DPAK	75 Units/Rail
MBRD320RL	DPAK	1800/Tape & Reel
MBRD320T4	DPAK	2500/Tape & Reel
MBRD330	DPAK	75 Units/Rail
MBRD330RL	DPAK	1800/Tape & Reel
MBRD330T4	DPAK	2500/Tape & Reel
MBRD340	DPAK	75 Units/Rail
MBRD340RL	DPAK	1800/Tape & Reel
MBRD340T4	DPAK	2500/Tape & Reel
MBRD350	DPAK	75 Units/Rail
MBRD350RL	DPAK	1800/Tape & Reel
MBRD350T4	DPAK	2500/Tape & Reel
MBRD360	DPAK	75 Units/Rail
MBRD360RL	DPAK	1800/Tape & Reel
MBRD360T4	DPAK	2500/Tape & Reel

## MBRD320, MBRD330, MBRD340, MBRD350, MBRD360

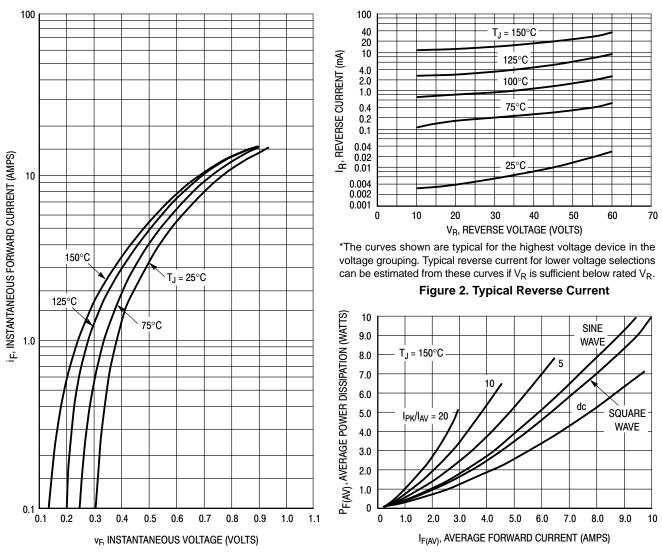
#### MAXIMUM RATINGS

- 4	Symbol		MBRD				
Rating	Symbol	320	330	340	350	360	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	30	40	50	60	Volts
Average Rectified Forward Current (T <sub>C</sub> = +125°C, Rated V <sub>R</sub> )	I <sub>F(AV)</sub>		•	3	•	•	Amps
Peak Repetitive Forward Current, $T_C = +125^{\circ}C$ (Rated V <sub>R</sub> , Square Wave, 20 kHz)	I <sub>FRM</sub>			6			Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>			75			Amps
ak Repetitive Reverse Surge Current (2 µs, 1 kHz) I <sub>RRM</sub> 1		Amp					
Operating Junction Temperature Range	TJ	-65 to +150			°C		
Storage Temperature Range	T <sub>stg</sub>	-65 to +175			°C		
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	/dt 10,000			V/µs		
THERMAL CHARACTERISTICS							
Maximum Thermal Resistance, Junction to Case	R <sub>θJC</sub> 6			°C/W			
Maximum Thermal Resistance, Junction to Ambient (Note 1.)	$R_{\theta JA}$			80			°C/W
ELECTRICAL CHARACTERISTICS	·						
Maximum Instantaneous Forward Voltage (Note 2.) $i_F = 3 \text{ Amps}, T_C = +25^{\circ}\text{C}$ $i_F = 3 \text{ Amps}, T_C = +125^{\circ}\text{C}$ $i_F = 6 \text{ Amps}, T_C = +25^{\circ}\text{C}$ $i_F = 6 \text{ Amps}, T_C = +125^{\circ}\text{C}$	V <sub>F</sub>			0.6 0.45 0.7 0.625			Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_C = +25^{\circ}C$ ) (Rated dc Voltage, $T_C = +125^{\circ}C$ )	i <sub>R</sub>			mA			

1. Rating applies when surface mounted on the minimum pad size recommended.

2. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

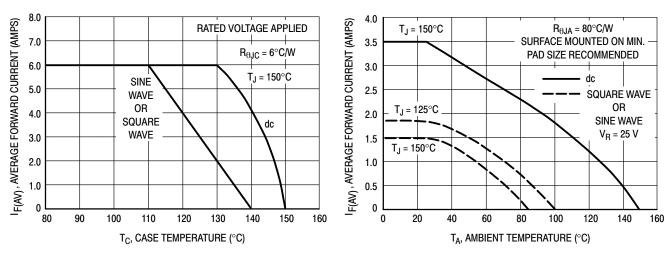
### MBRD320, MBRD330, MBRD340, MBRD350, MBRD360



#### **TYPICAL CHARACTERISTICS**

Figure 1. Typical Forward Voltage

Figure 3. Average Power Dissipation



### MBRD320, MBRD330, MBRD340, MBRD350, MBRD360



Figure 5. Current Derating, Ambient

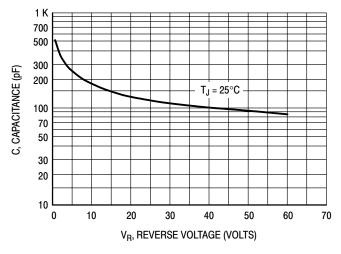


Figure 6. Typical Capacitance

# MBRD620CT, MBRD630CT, MBRD640CT, MBRD650CT, MBRD660CT

MBRD620CT, MBRD640CT and MBRD660CT are Preferred Devices

## SWITCHMODE™ Power Rectifiers

## **DPAK Surface Mount Package**

... in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Extremely Fast Switching
- Extremely Low Forward Drop
- Platinum Barrier with Avalanche Guardrings

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: B620T, B630T, B640T, B650T, B660T

#### MAXIMUM RATINGS

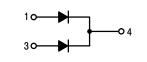
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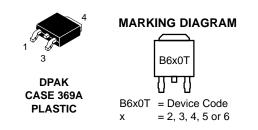


### ON Semiconductor<sup>™</sup>

http://onsemi.com

SCHOTTKY BARRIER RECTIFIERS 6.0 AMPERES 20 TO 60 VOLTS





#### **ORDERING INFORMATION**

Device	Package	Shipping
MBRD620CTT4	DPAK	2500/Tape & Reel
MBRD630CTT4	DPAK	2500/Tape & Reel
MBRD640CTT4	DPAK	2500/Tape & Reel
MBRD650CT	DPAK	75 Units/Rail
MBRD650CTT4	DPAK	2500/Tape & Reel
MBRD660CT	DPAK	75 Units/Rail
MBRD660CTRL	DPAK	1800/Tape & Reel
MBRD660CTT4	DPAK	2500/Tape & Reel

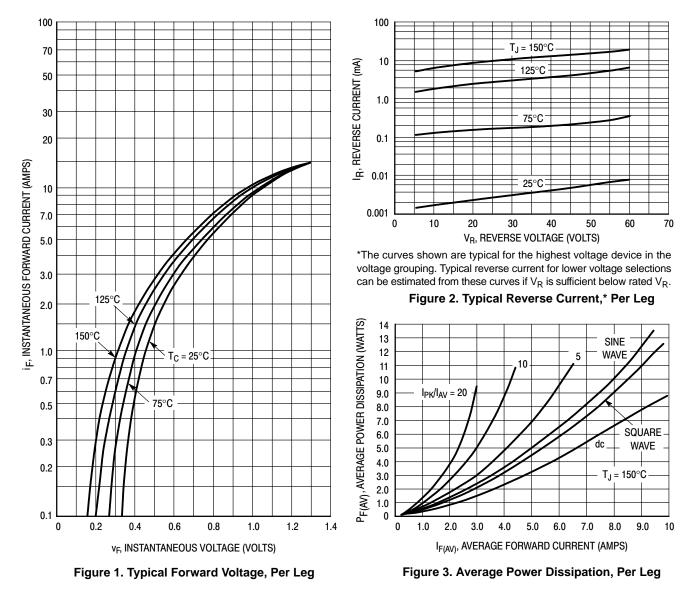
## MBRD620CT, MBRD630CT, MBRD640CT, MBRD650CT, MBRD660CT

#### MAXIMUM RATINGS

- 4		MBRD					
Rating	Symbol	620CT	630CT	640CT	650CT	660CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	30	40	50	60	Volts
Average Rectified Forward CurrentPer Diode $T_C = 130^{\circ}C$ (Rated $V_R$ )Per Device	I <sub>F(AV)</sub>			3 6			Amps
Peak Repetitive Forward Current, T <sub>C</sub> = 130°C (Rated V <sub>R</sub> , Square Wave, 20 kHz) Per Diode		6					Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)		75				Amps	
Peak Repetitive Reverse Surge Current (2 µs, 1 kHz)		1				Amp	
Operating Junction Temperature		-65 to +150					°C
Storage Temperature		-65 to +175					°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000				V/µs	
THERMAL CHARACTERISTICS PER DIODE							
Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	6				°C/W	
Maximum Thermal Resistance, Junction to Ambient (Note 1.)	$R_{\theta JA}$	80				°C/W	
ELECTRICAL CHARACTERISTICS PER DIODE							
Maximum Instantaneous Forward Voltage (Note 2.) $i_F = 3 \text{ Amps}, T_C = 25^{\circ}\text{C}$ $i_F = 3 \text{ Amps}, T_C = 125^{\circ}\text{C}$ $i_F = 6 \text{ Amps}, T_C = 25^{\circ}\text{C}$ $i_F = 6 \text{ Amps}, T_C = 125^{\circ}\text{C}$				0.7 0.65 0.9 0.85			Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_C = 25^{\circ}C$ ) (Rated dc Voltage, $T_C = 125^{\circ}C$ )				0.1 15			mA

1. Rating applies when surface mounted on the minimum pad size recommended. 2. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\le 2.0\%$ .

## MBRD620CT, MBRD630CT, MBRD640CT, MBRD650CT, MBRD660CT



### **TYPICAL CHARACTERISTICS**

## MBRD620CT, MBRD630CT, MBRD640CT, MBRD650CT, MBRD660CT

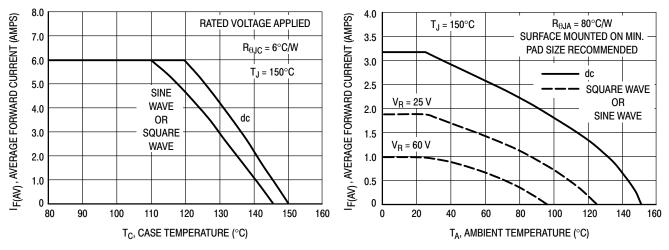




Figure 5. Current Derating, Ambient, Per Leg

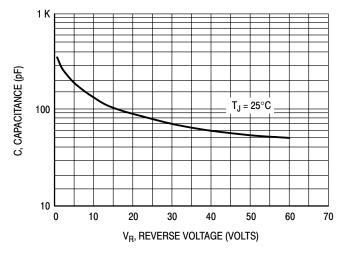


Figure 6. Typical Capacitance, Per Leg

# MBRD835L

Preferred Device

## SWITCHMODE™ Power Rectifier

## **DPAK Surface Mount Package**

This SWITCHMODE power rectifier which uses the Schottky Barrier principle with a proprietary barrier metal, is designed for use as output rectifiers, free wheeling, protection and steering diodes in switching power supplies, inverters and other inductive switching circuits. This state of the art device has the following features:

- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Compact Size
- Lead Formed for Surface Mount
- **Mechanical Characteristics**

#### • Case: Epoxy, Molded

- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per 13" reel, by adding a "T4" suffix to the part number
- Marking: B835L

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 88°C)	I <sub>F(AV)</sub>	8.0	A
Peak Repetitive Forward Current (At Rated $V_R$ , Square Wave, 20 kHz, $T_C = 80^{\circ}C$ )	I <sub>FRM</sub>	16	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	75	A
Repetitive Avalanche Current (Current Decaying Linearly to Zero in 1 µs, Frequency Limited by T <sub>Jmax</sub> )	I <sub>AR</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Operating Junction Temperature	TJ	-65 to +125	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs



### ON Semiconductor<sup>™</sup>

http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 8.0 AMPERES 35 VOLTS





CASE 369A STYLE 3

#### MARKING DIAGRAM



B835L = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBRD835L	DPAK	75 Units/Rail
MBRD835LT4	DPAK	2500/Tape & Reel

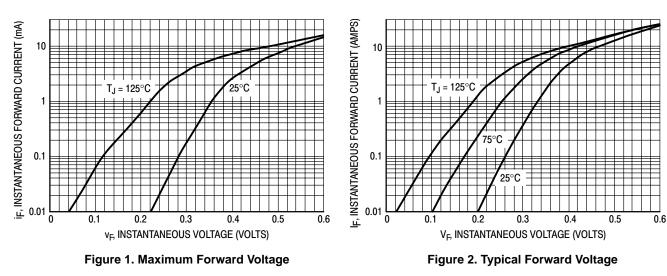
## MBRD835L

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance — Junction to Case	$R_{\theta JC}$	6	°C/W
Thermal Resistance — Junction to Ambient (Note 1.)	$R_{\thetaJA}$	80	°C/W
ELECTRICAL CHARACTERISTICS	·		
Maximum Instantaneous Forward Voltage (Note 2) $(i_{-} = 8 \text{ Amps} T_{-} = 1.25^{\circ}\text{C})$	V_	0.51	Volte

Maximum Instantaneous Forward Voltage (Note 2.) ( $i_F = 8 \text{ Amps}, T_C = +25^{\circ}C$ ) ( $i_F = 8 \text{ Amps}, T_C = +125^{\circ}C$ )	V <sub>F</sub>	0.51 0.41	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_C = +25^{\circ}C$ ) (Rated dc Voltage, $T_C = +100^{\circ}C$ )	I <sub>R</sub>	1.4 35	mA

1. Rating applies when surface mounted on the minimum pad size recommended. 2. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\le 2\%$ .



#### **TYPICAL CHARACTERISTICS**

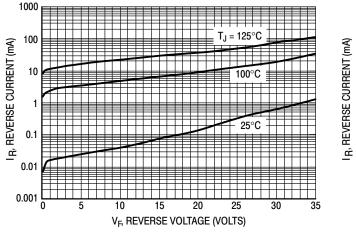


Figure 3. Maximum Reverse Current

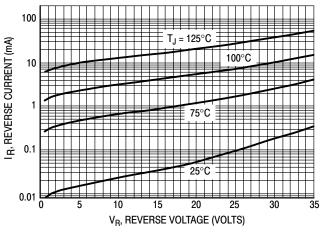
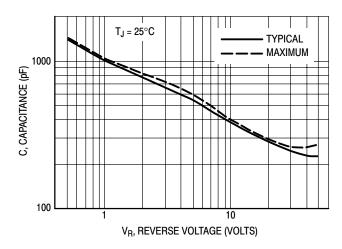
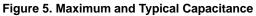


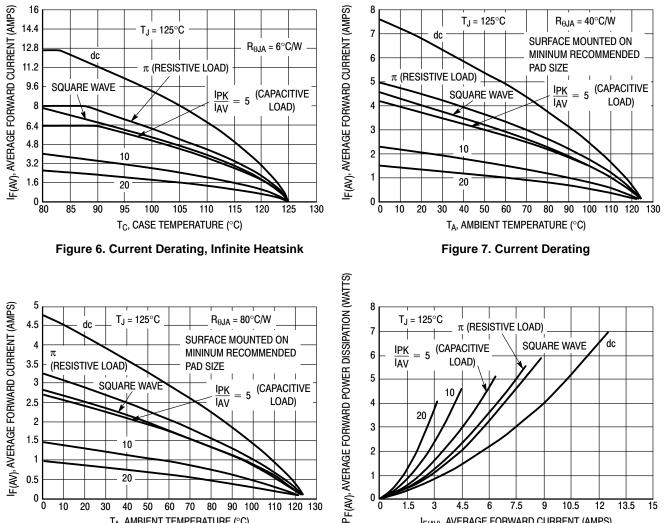
Figure 4. Typical Reverse Current

## MBRD835L

#### **TYPICAL CHARACTERISTICS**







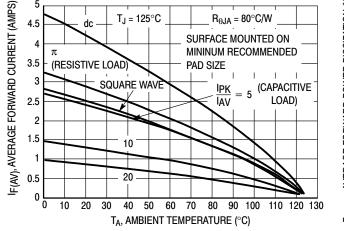


Figure 8. Current Derating, Free Air

http://onsemi.com 164

4

3

2

0

0

1.5 3 4.5

6 7.5

IF(AV), AVERAGE FORWARD CURRENT (AMPS)

**Figure 9. Forward Power Dissipation** 

9 10.5 12 13.5 15

20

## SWITCHMODE<sup>™</sup> Schottky Power Rectifier

## **DPAK Power Surface Mount Package**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State of the art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies, free wheeling diode and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Guardring for Stress Protection
- Matched Dual Die Construction -May be Paralleled for High Current Output
- High dv/dt Capability
- Short Heat Sink Tap Manufactured Not Sheared
- Very Low Forward Voltage Drop
- Epoxy Meets UL94, VO at 1/8"

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per Reel, Add "T4" to Suffix part #
- Marking: B1035CL

#### MAXIMUM RATINGS

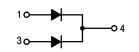
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### ON Semiconductor<sup>™</sup>

http://onsemi.com

SCHOTTKY BARRIER RECTIFIER 10 AMPERES 35 VOLTS





CASE 369A PLASTIC

#### MARKING DIAGRAM



B1035CL = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRD1035CTL	DPAK	75 Units/Rail
MBRD1035CTLT4	DPAK	2500/Tape & Reel

#### MAXIMUM RATINGS

Rating		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35	Volts
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 115^{\circ}C$ )	Per Leg Per Package	IO	5.0 10	Amps
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz, $T_C$ = 115°C)	Per Leg	I <sub>FRM</sub>	10	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, sing	Per Package gle phase, 60 Hz)	I <sub>FSM</sub>	50	Amps
Storage / Operating Case Temperature		T <sub>stg,</sub> T <sub>c</sub>	-55 to +125	°C
Operating Junction Temperature		ТJ	-55 to +125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J = 25^{\circ}C$ )		dv/dt	10,000	V/µs
HERMAL CHARACTERISTICS				
Thermal Resistance - Junction to Case	Per Leg	$R_{\theta JC}$	2.43	°C/W
Thermal Resistance - Junction to Ambient (Note 1.)	Per Leg	R <sub>θJA</sub>	68	°C/W
ELECTRICAL CHARACTERISTICS				-
	Per Leg	VF	0.47 0.41 0.56 0.55	Volts
Maximum Instantaneous Reverse Current (Note 2.) see Figure 4 $(V_R = 35 V, T_J = 25^{\circ}C)$ $(V_R = 35 V, T_J = 100^{\circ}C)$ $(V_R = 17.5 V, T_J = 25^{\circ}C)$	Per Leg	I <sub>R</sub>	2.0 30 0.20	mA

5.0

 $(V_R = 17.5 V, T_J = 25^{\circ}C)$  $(V_R = 17.5 V, T_J = 100^{\circ}C)$ 

1. Rating applies when using minimum pad size, FR4 PC Board 2. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2.0%.

### **TYPICAL CHARACTERISTICS**

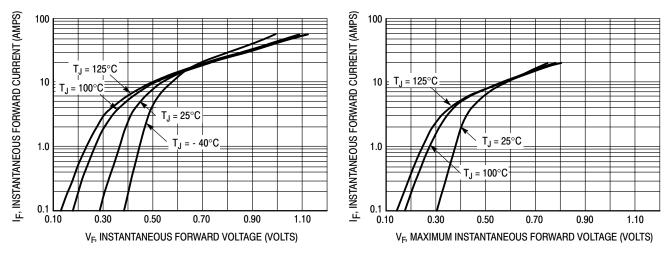


Figure 1. Typical Forward Voltage Per Leg



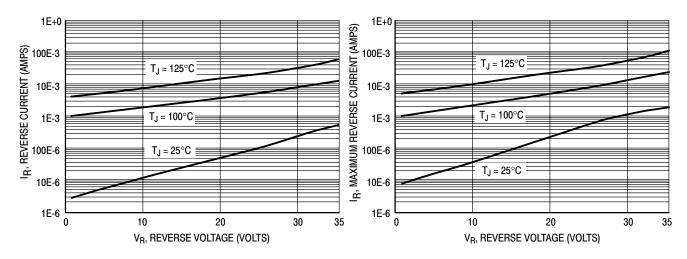
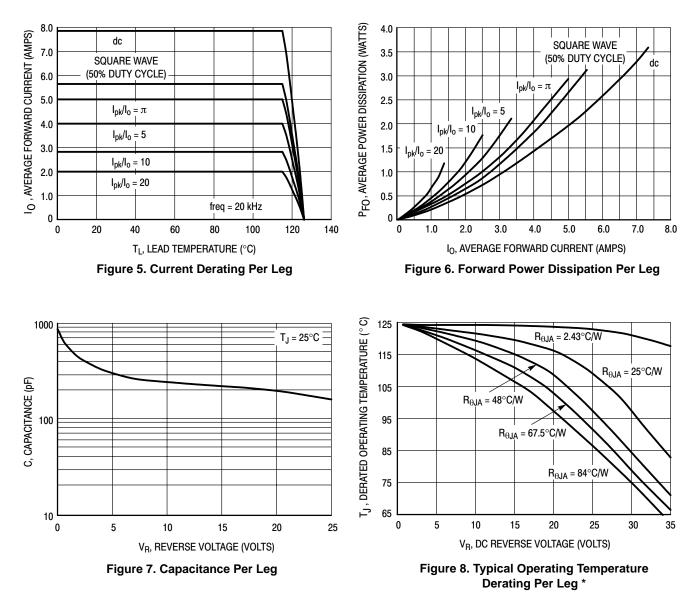


Figure 3. Typical Reverse Current Per Leg

Figure 4. Maximum Reverse Current Per Leg



\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of  $T_J$  therefore must include forward and reverse power effects. The allowable operating  $T_J$  may be calculated from the equation:  $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and

Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.

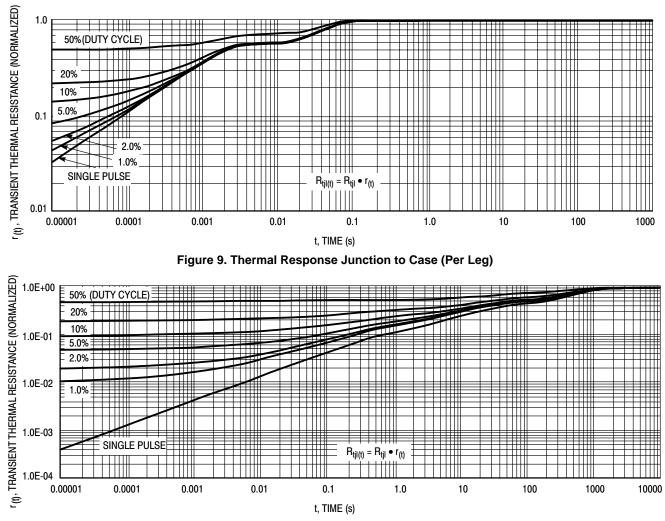


Figure 10. Thermal Response Junction to Ambient (Per Leg)

# **MBRB1045**

Preferred Device

## SWITCHMODE™ Power Rectifier

## D<sup>2</sup>PAK Surface Mount Power Package

The D<sup>2</sup>PAK Power Rectifier employs the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, free wheeling diodes, and polarity protection diodes. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Short Heat Sink Tab Manufactured Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: MBRB1045

#### MAXIMUM RATINGS

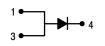
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	Volts
Average Rectified Forward Current (Rated V <sub>R</sub> ) T <sub>C</sub> = 135°C	I <sub>F(AV)</sub>	10	Amps
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz) T <sub>C</sub> = 135°C	I <sub>FRM</sub>	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load condi- tions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	150	Amps
Operating Junction and Storage Tem- perature Range	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10000	V/µs



### **ON Semiconductor®**

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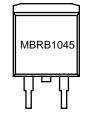
#### SCHOTTKY BARRIER RECTIFIER 10 AMPERES 45 VOLTS





D<sup>2</sup>PAK CASE 418B PLASTIC

#### MARKING DIAGRAM



MBRB1045 = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRB1045	D <sup>2</sup> PAK	50 Units/Tube
MBRB1045T4	D <sup>2</sup> PAK	800/Tape & Reel

Semiconductor Components Industries, LLC, 2002 April, 2002 - Rev. 2

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Case (Note 1.)	R <sub>θJC</sub>	1.0	°C/W
— Junction to Ambient (Note 1.)	R <sub>θJA</sub>	34	

#### **ELECTRICAL CHARACTERISTICS**

	V <sub>F</sub>	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $TJ = 125^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	I <sub>R</sub>	15 0.1	mA

1. When mounted using minimum recommended pad size on FR-4 board. 2. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ 

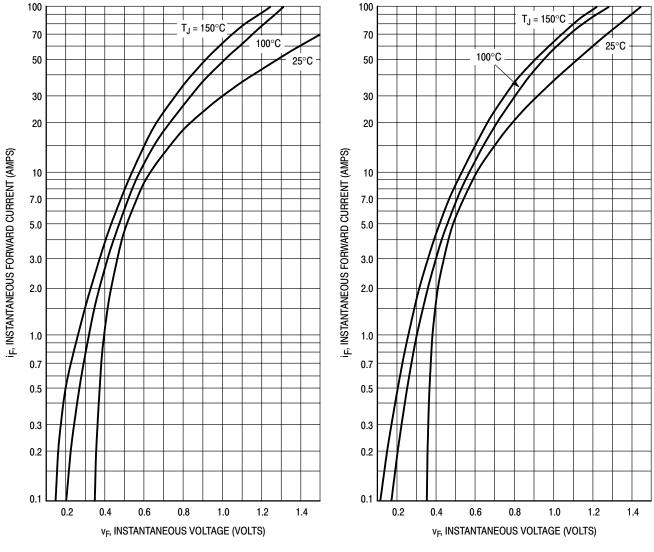
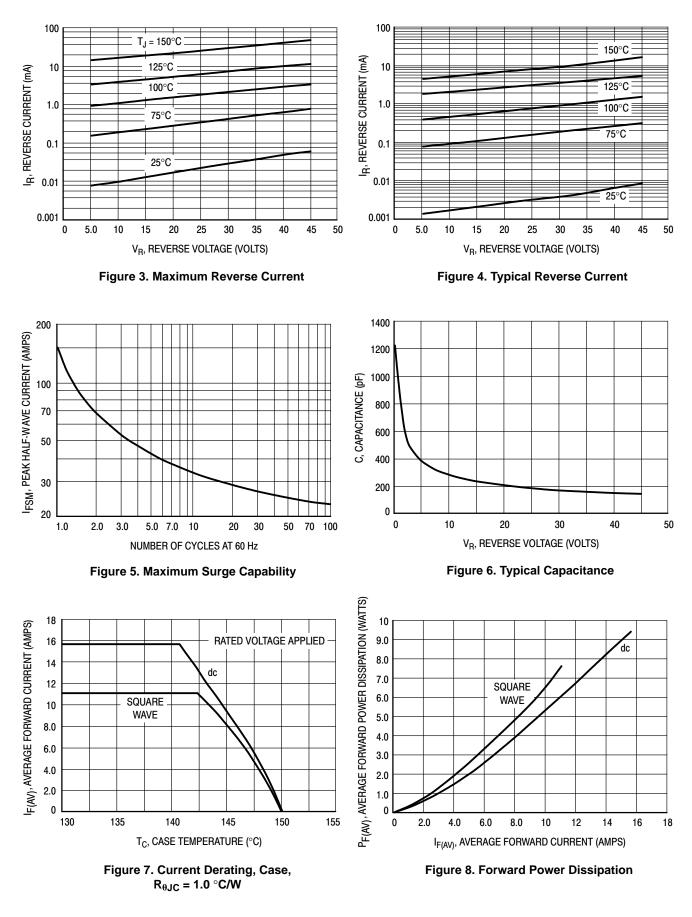


Figure 1. Maximum Forward Voltage

Figure 2. Typical Forward Voltage

### **MBRB1045**



# MBRB1545CT

Preferred Device

## SWITCHMODE™ Power Rectifier

## D<sup>2</sup>PAK Surface Mount Power Package

The D<sup>2</sup>PAK Power Rectifier employs the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Short Heat Sink Tab Manufactured Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B1545T

#### MAXIMUM RATINGS (Per Leg)

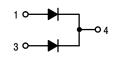
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 105°C) Total Device	I <sub>F(AV)</sub>	7.5 15	A
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 105°C)	I <sub>FRM</sub>	15	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/μs

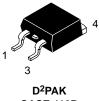


### **ON Semiconductor®**

http://onsemi.com







CASE 418B STYLE 3

#### MARKING DIAGRAM



B1545 = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRB1545CT	D <sup>2</sup> PAK	50/Rail
MBRB1545CTT4	D <sup>2</sup> PAK	800/Tape & Reel

## MBRB1545CT

#### THERMAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Case	R <sub>θJC</sub>	2.0	°C/W
— Junction to Ambient (Note 3)	R <sub>θJA</sub>	50	

#### ELECTRICAL CHARACTERISTICS (Per Leg)

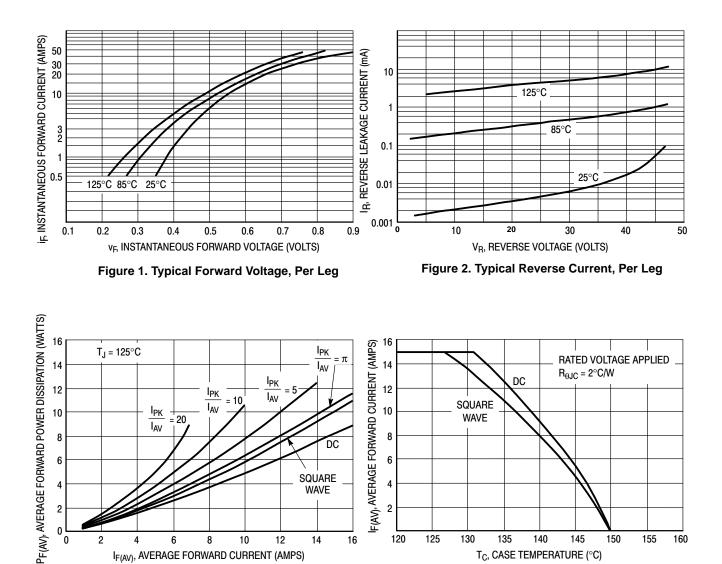
V <sub>F</sub>		Volts
	0.57	
	0.72	
	0.84	
i <sub>R</sub>		mA
	15	
	0.1	
-		i <sub>R</sub> 0.57 0.72 0.84 15

When mounted using minimum recommended pad size on FR-4 board. 3.

4. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

IF(AV), AVERAGE FORWARD CURRENT (AMPS)

**Figure 3. Typical Forward Power Dissipation** 



T<sub>C</sub>, CASE TEMPERATURE (°C)

Figure 4. Current Derating, Case

# MBRB2060CT

Preferred Device

## SWITCHMODE™ Power Rectifier

## D<sup>2</sup>PAK Surface Mount Power Package

Employs the use of the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, Vo at 1/8"
- Short Heat Sink Tab Manufactured Not Sheared!
- Similar in Size to Industry Standard TO-220 Package

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B2060T

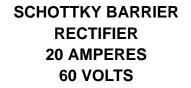
#### MAXIMUM RATINGS (Per Leg)

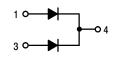
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
Average Rectified Forward Current (Rated V <sub>R</sub> , T <sub>C</sub> = 110°C) Total Device	I <sub>F(AV)</sub>	10 20	A
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 100^{\circ}C$ )	I <sub>FRM</sub>	20	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	0.5	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs

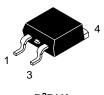


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D<sup>2</sup>PAK CASE 418B STYLE 3

#### MARKING DIAGRAM



B2060T = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRB2060CT	D <sup>2</sup> PAK	50/Rail
MBRB2060CTT4	D <sup>2</sup> PAK	800/Tape & Reel

## MBRB2060CT

#### THERMAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Case — Junction to Ambient (Note 1.)	$R_{ heta JC}$ $R_{ heta JA}$	2.0 50	°C/W

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Maximum Instantaneous Forward Voltage (Note 2.) ( $i_F = 20 \text{ Amps}, T_J = 125^{\circ}\text{C}$ ) ( $i_F = 20 \text{ Amps}, T_J = 25^{\circ}\text{C}$ )	۷F	0.85 0.95	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_J = 125^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	150 0.15	mA

1. When mounted using minimum recommended pad size on FR-4 board.

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

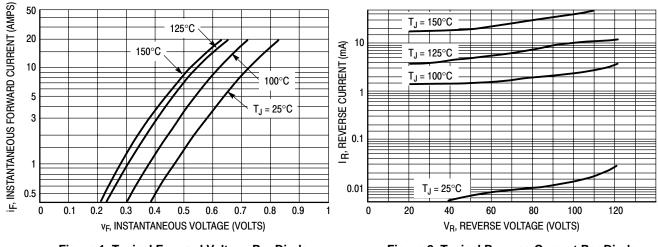
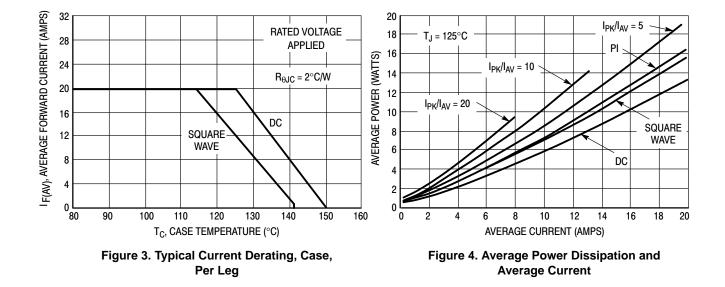


Figure 1. Typical Forward Voltage Per Diode

Figure 2. Typical Reverse Current Per Diode



# MBRB20100CT

Preferred Device

## SWITCHMODE™ Power Rectifier

## D<sup>2</sup>PAK Surface Mount Power Package

The D<sup>2</sup>PAK Power Rectifier employs the use of the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, Vo at 1/8"
- Short Heat Sink Tab Manufactured Not Sheared!
- Similar in Size to Industry Standard TO-220 Package

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B20100

#### MAXIMUM RATINGS (Per Leg)

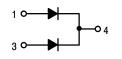
Bating Symbol Value II				
Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	V	
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 110°C) Total Device	I <sub>F(AV)</sub>	10 20	A	
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 100°C)	I <sub>FRM</sub>	20	A	
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A	
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	0.5	A	
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C	
Operating Junction Temperature	TJ	-65 to +150	°C	
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/μs	

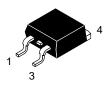


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D<sup>2</sup>PAK CASE 418B STYLE 3

#### MARKING DIAGRAM



B20100 = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRB20100CT	D <sup>2</sup> PAK	50/Rail
MBRB20100CTT4	D <sup>2</sup> PAK	800/Tape & Reel

## MBRB20100CT

#### THERMAL CHARACTERISTICS (Per Leg)

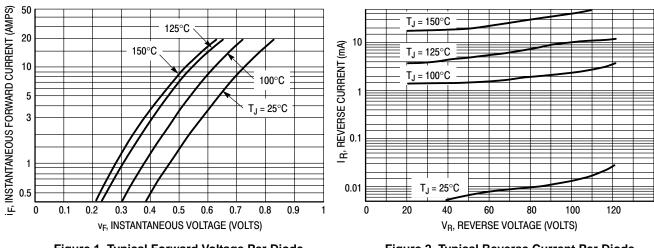
Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Case — Junction to Ambient (Note 1.)	$R_{ heta JC}$ $R_{ heta JA}$	2.0 50	°C/W

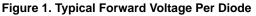
#### ELECTRICAL CHARACTERISTICS (Per Leg)

Maximum Instantaneous Forward Voltage (Note 2.)	VF		Volts
$(i_F = 10 \text{ Amp}, T_C = 125^{\circ}C)$ $(i_F = 10 \text{ Amp}, T_C = 25^{\circ}C)$ $(i_F = 20 \text{ Amp}, T_C = 125^{\circ}C)$ $(i_F = 20 \text{ Amp}, T_C = 25^{\circ}C)$		0.75 0.85 0.85 0.95	
$\label{eq:maximum lnstantaneous Reverse Current (Note 2.) \\ (Rated dc Voltage, T_J = 125^{\circ}C) \\ (Rated dc Voltage, T_J = 25^{\circ}C) \\ \end{array}$	i <sub>R</sub>	6.0 0.1	mA

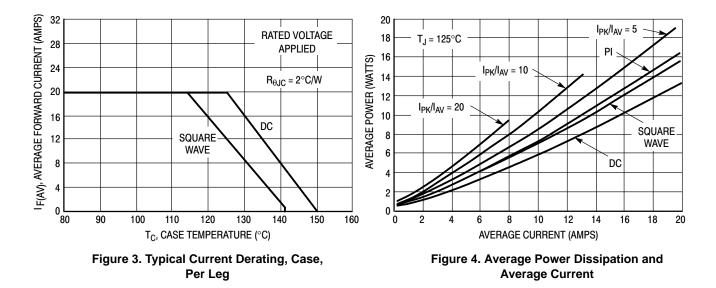
1. When mounted using minimum recommended pad size on FR-4 board.

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.









# MBRB20200CT

Preferred Device

## SWITCHMODE™ Power Rectifier

## **Dual Schottky Rectifier**

... using Schottky Barrier technology with a platinum barrier metal. This state-of-the-art device is designed for use in high frequency switching power supplies and converters with up to 48 volt outputs. They block up to 200 volts and offer improved Schottky performance at frequencies from 250 kHz to 5.0 MHz.

#### • 200 Volt Blocking Voltage

- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (10,000 V/µs)
- Dual Diode Construction Terminals 1 and 3 Must be Connected for Parallel Operation at Full Rating

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B20200

#### MAXIMUM RATINGS (Per Leg)

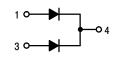
Rating	Symbol	Value	Unit		
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	V		
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 134°C) Per Device Per Leg	I <sub>F(AV)</sub>	10 20	A		
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = +137°C) Per Leg	I <sub>FRM</sub>	20	A		
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A		
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	A		
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C		
Operating Junction Temperature	Т <sub>Ј</sub>	-65 to +150	°C		
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/μs		

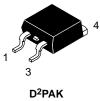


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CASE 418B STYLE 3

#### MARKING DIAGRAM



B20200 = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRB20200CT	D <sup>2</sup> PAK	50/Rail
MBRB20200CTT4	D <sup>2</sup> PAK	800/Tape & Reel

## MBRB20200CT

#### THERMAL CHARACTERISTICS (Per Leg)

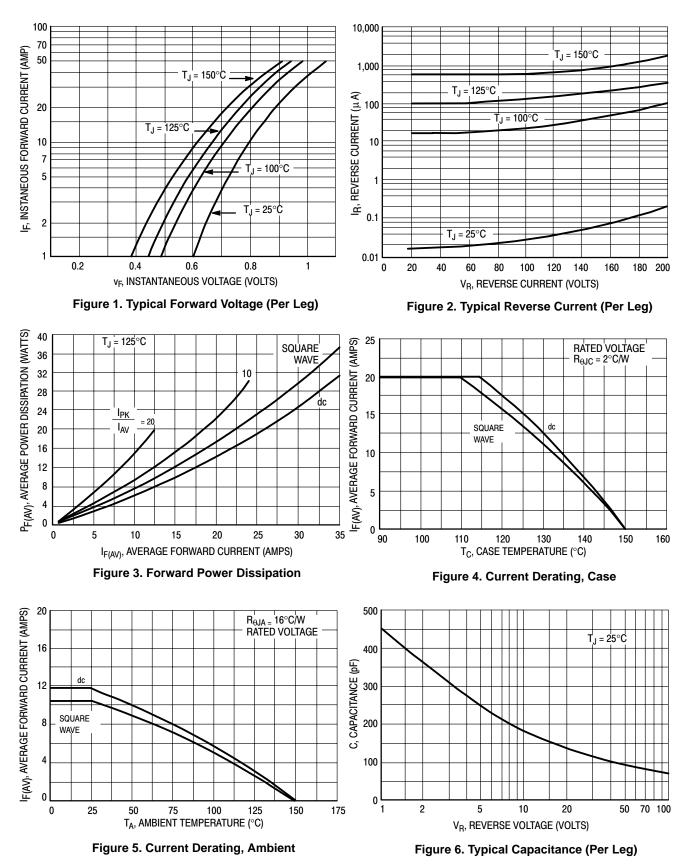
Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Case	$R_{\thetaJC}$	2.0	°C/W

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Maximum Instantaneous Forward Voltage (Note 1.)	V <sub>F</sub>		Volts
(I <sub>F</sub> = 10 Amps, T <sub>C</sub> = 25°C)		0.9	
(I <sub>F</sub> = 10 Amps, T <sub>C</sub> = 125°C)		0.8	
$(I_F = 20 \text{ Amps}, T_C = 25^{\circ}C)$		1.0	
$(I_F = 20 \text{ Amps}, T_C = 125^{\circ}C)$		0.9	
Maximum Instantaneous Reverse Current (Note 1.)	I <sub>R</sub>		mA
(Rated dc Voltage, $T_C = 25^{\circ}C$ )		1.0	
(Rated dc Voltage, $T_C = 125^{\circ}C$ )		50	
DYNAMIC CHARACTERISTICS (Per Leg)			
Capacitance ( $V_R$ = -5.0 V, $T_C$ = 25°C, Frequency = 1.0 MHz)	CT	500	pF

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

## MBRB20200CT



# MBRB2515L

Preferred Device

## SWITCHMODE™ Power Rectifier OR'ing Function Diode

## D<sup>2</sup>PAK Surface Mount Power Package

The D<sup>2</sup>PAK Power Rectifier employs the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, free wheeling diodes, and polarity protection diodes. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 100°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Short Heat Sink Tab Manufactured Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package
- **Mechanical Characteristics**
- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B2515L

#### MAXIMUM RATINGS

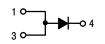
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	15	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 90°C)	I <sub>F(AV)</sub>	25	A
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 100°C)	I <sub>FRM</sub>	30	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Operating Junction Temperature	TJ	100	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs

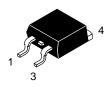


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SCHOTTKY BARRIER RECTIFIER 25 AMPERES 15 VOLTS





D<sup>2</sup>PAK CASE 418B STYLE 3

#### MARKING DIAGRAM



B2515L = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRB2515L	D <sup>2</sup> PAK	50/Rail
MBRB2515LT4	D <sup>2</sup> PAK	800/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

#### THERMAL CHARACTERISTICS

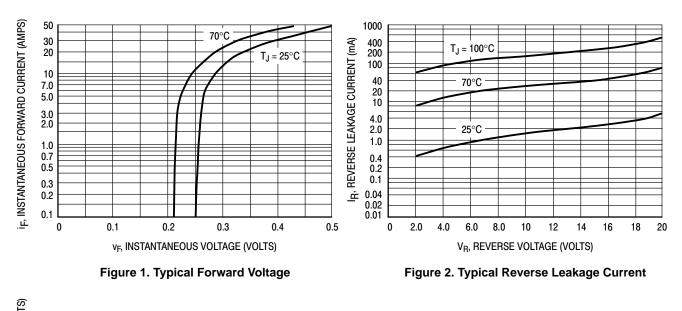
Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Case	$R_{ heta JC}$	1.0	°C/W
— Junction to Ambient (Note 1.)	$R_{ heta JA}$	50	

#### **ELECTRICAL CHARACTERISTICS**

	v <sub>F</sub>	0.28 0.42 0.45	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_J = 70^{\circ}$ C) (Rated dc Voltage, $T_J = 25^{\circ}$ C)	۱ <sub>R</sub>	200 15	mA

1. When mounted using minimum recommended pad size on FR-4 board.

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



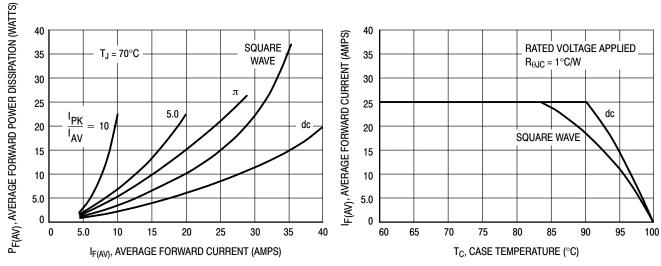


Figure 3. Typical Forward Power Dissipation



# MBRB2535CTL

Preferred Device

## SWITCHMODE™ Power Rectifier

D<sup>2</sup>PAK Surface Mount Power Package

The D<sup>2</sup>PAK Power Rectifier employs the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, free wheeling diodes, and polarity protection diodes. These state-of-the-art devices have the following features:

- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 125°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Short Heat Sink Tab Manufactured Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B2535L

#### MAXIMUM RATINGS

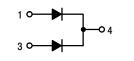
Please See the Table on the Following Page

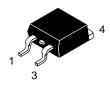


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D<sup>2</sup>PAK CASE 418B STYLE 3

#### MARKING DIAGRAM



B2535L = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRB2535CTL	D <sup>2</sup> PAK	50/Rail
MBRB2535CTLT4	D <sup>2</sup> PAK	800/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

## MBRB2535CTL

#### MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 110°C)	I <sub>F(AV)</sub>	12.5	A
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 90^{\circ}C$ )	I <sub>FRM</sub>	25	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	IFSM	150	A
Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz)	I <sub>RRM</sub>	1.0	А
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Operating Junction Temperature	TJ	-65 to +125	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs

#### THERMAL CHARACTERISTICS (Per Leg)

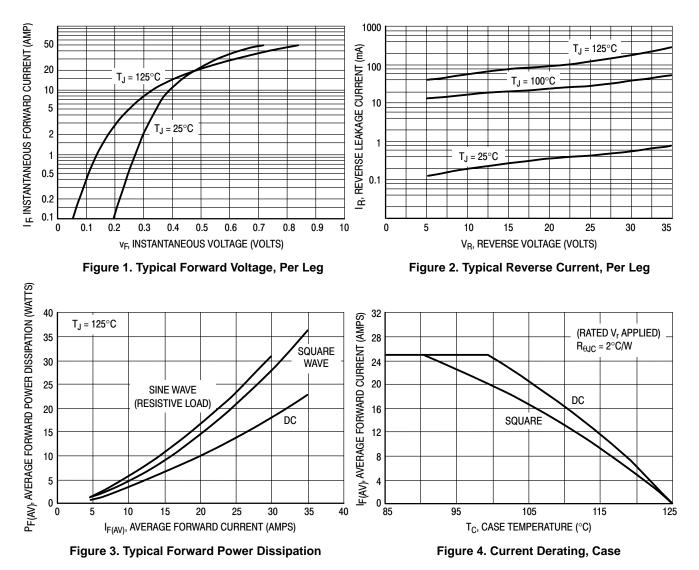
Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Case	R <sub>θJC</sub>	2.0	°C/W
— Junction to Ambient (Note 1.)	R <sub>θJA</sub>	50	

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Maximum Instantaneous Forward Voltage (Note 2.)	V <sub>F</sub>		Volts
(i <sub>F</sub> = 25 Amps, T <sub>J</sub> = 25°C)		0.55	
(i <sub>F</sub> = 12.5 Amps, T <sub>J</sub> = 125°C)		0.41	
$(i_F = 12.5 \text{ Amps}, T_J = 25^{\circ}\text{C})$		0.47	
Maximum Instantaneous Reverse Current (Note 2.)	I <sub>R</sub>		mA
(Rated dc Voltage, $T_J = 125^{\circ}C$ )		500	
(Rated dc Voltage, $T_J = 25^{\circ}C$ )		10	

1. When mounted using minimum recommended pad size on FR-4 board. 2. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .

## MBRB2535CTL



# MBRB2545CT

Preferred Device

## SWITCHMODE™ Power Rectifier

## D<sup>2</sup>PAK Surface Mount Power Package

The D<sup>2</sup>PAK Power Rectifier employs the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Short Heat Sink Tab Manufactured Not Sheared!
- Similar in Size to the Industry Standard TO-220 Package

#### Mechanical Characteristics

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per 13" reel by adding a "T4" suffix to the part number
- Marking: B2545T

### MAXIMUM RATINGS (Per Leg)

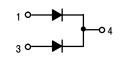
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 130°C) Total Device	I <sub>F(AV)</sub>	15 30	A
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 130°C)	I <sub>FRM</sub>	30	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs

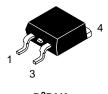


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D<sup>2</sup>PAK CASE 418B STYLE 3

#### MARKING DIAGRAM



B2545T = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRB2545CT	D <sup>2</sup> PAK	50/Rail
MBRB2545CTT4	D <sup>2</sup> PAK	800/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

## MBRB2545CT

#### THERMAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Case — Junction to Ambient (Note 1.)	$R_{ extsf{ heta}JC}$ $R_{ hetaJA}$	1.5 50	°C/W

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Maximum Instantaneous Forward Voltage (Note 2.) ( $i_F = 30 \text{ Amps}, T_J = 125^{\circ}C$ ) ( $i_F = 30 \text{ Amps}, T_J = 25^{\circ}C$ )	۷F	0.73 0.82	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_J = 125^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )		40 0.2	mA

1. When mounted using minimum recommended pad size on FR-4 board.

2. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .

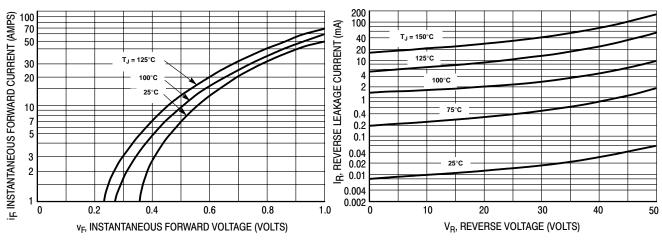


Figure 1. Typical Forward Voltage, Per Leg

Figure 2. Typical Reverse Current, Per Leg

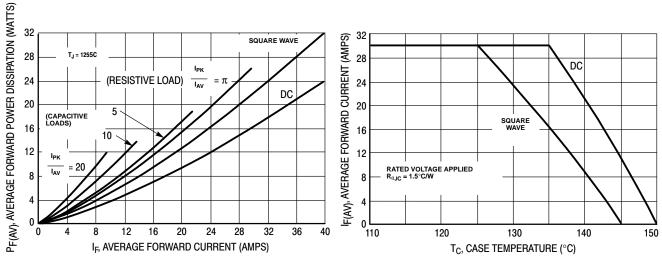




Figure 4. Current Derating, Case

Preferred Device

## SWITCHMODE™ Power Rectifier

Using the Schottky Barrier principle with a proprietary barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Maximum Die Size
- 150°C Operating Junction Temperature
- Short Heat Sink Tab Manufactured Not Sheared

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units per Plastic Tube
- Available in 24 mm Tape and Reel, 800 Units per 13" Reel by Adding a "T4" Suffix to the Part Number
- Marking: B3030

#### MAXIMUM RATINGS

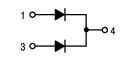
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V <sub>RRM</sub>	30	V
Working Peak Reverse Voltage	VRRM V <sub>RWM</sub>	30	v
DC Blocking Voltage	VR		
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 134°C)	I <sub>F(AV)</sub>		A
Per Device		30	
Per Leg		15	
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = +137°C) Per Leg	I <sub>FRM</sub>	30	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions, Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	200	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs
Reverse Energy (Unclamped Inductive Surge) (Inductance = 3 mH, T <sub>C</sub> = 25°C)	W	100	mJ

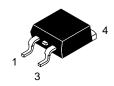


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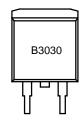






D<sup>2</sup>PAK CASE 418B STYLE 3

#### MARKING DIAGRAM



B3030 = Device Code

### ORDERING INFORMATION

Device	Package	Shipping
MBRB3030CT	D <sup>2</sup> PAK	50/Rail
MBRB3030CTT4	D <sup>2</sup> PAK	800/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

#### THERMAL CHARACTERISTICS (Per Leg)

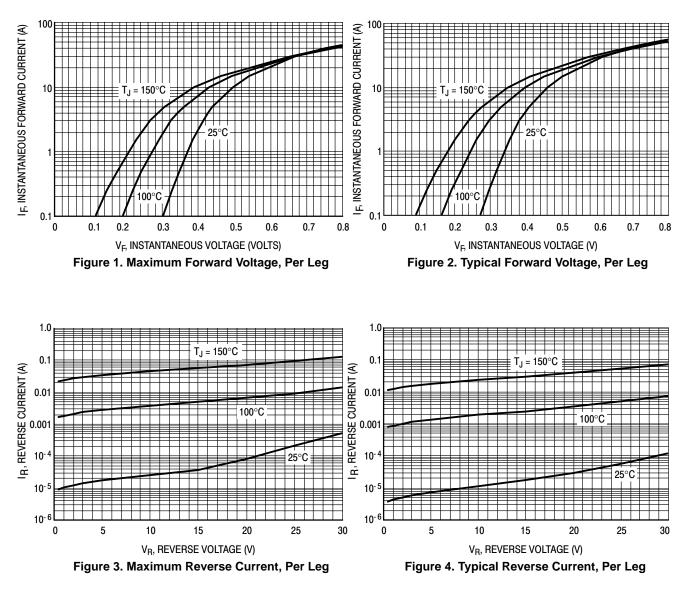
Characteristic	Symbol	Value	Unit
Thermal Resistance — Junction to Case — Junction to Ambient (Note 1.)	$R_{ heta JC} \ R_{ heta JA}$	1.0 50	°C/W

#### ELECTRICAL CHARACTERISTICS (Per Leg)

· _ • •			
Maximum Instantaneous Forward Voltage (Note 2.), Per Leg	V <sub>F</sub>		Volts
(I <sub>F</sub> = 15 Amps, T <sub>C</sub> = +25°C)		0.54	
(I <sub>F</sub> = 15 Amps, T <sub>C</sub> = +150°C)		0.47	
$(I_{F} = 30 \text{ Amps}, T_{C} = +25^{\circ}\text{C})$		0.67	
(I <sub>F</sub> = 30 Amps, T <sub>C</sub> = +150°C)		0.66	
Maximum Instantaneous Reverse Current (Note 2.), Per Leg	I <sub>R</sub>		mA
(Rated dc Voltage, $T_C = +25^{\circ}C$ )		0.6	
(Reverse Voltage = 10 V, T <sub>C</sub> = +150°C)		46	
(Rated dc Voltage, $T_C = +150^{\circ}C$ )		145	

1. When mounted using minimum recommended pad size on FR-4 board. 2. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .

#### **ELECTRICAL CHARACTERISTICS**



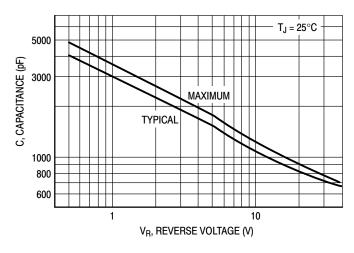
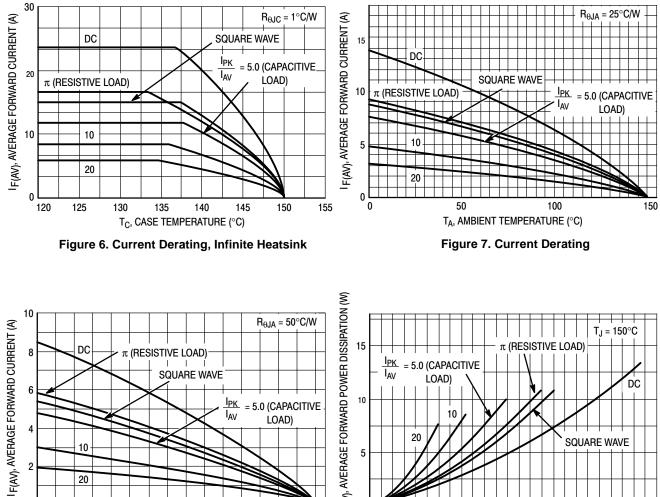
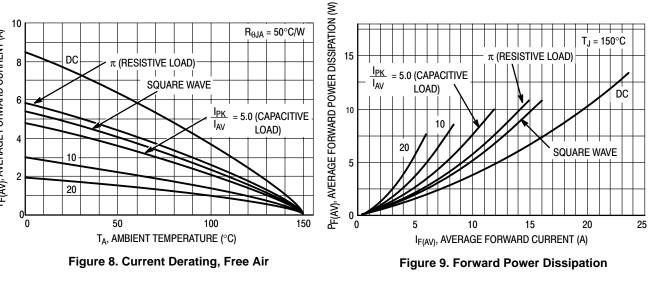


Figure 5. Capacitance

#### **TYPICAL CHARACTERISTICS**





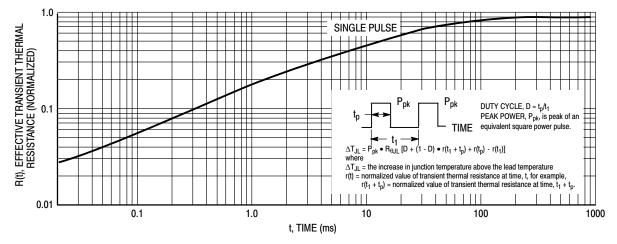


Figure 10. Thermal Response

## SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a proprietary barrier metal. These state-of-the-art devices have the following features:

#### Features:

- Dual Diode Construction -May be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 125°C Operating Junction Temperature
- Maximum Die Size
- Short Heat Sink Tab Manufactured Not Sheared!

#### MAXIMUM RATINGS

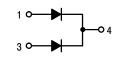
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C$ = 115°C) Per Device	Ι <sub>Ο</sub>	15 30	A
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 115°C)	I <sub>FRM</sub>	30	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	300	A
Peak Repetitive Reverse Surge Current (1.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Operating Junction Temperature Range	TJ	-55 to +125	°C
Voltage Rate of Change (Rated $V_R$ , $T_J = 25^{\circ}C$ )	dV/dt	10,000	V/µs
Reverse Energy, Unclamped Inductive Surge $(T_J = 25^{\circ}C, L = 3.0 \text{ mH})$	E <sub>AS</sub>	224.5	mJ

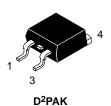


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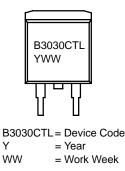
SCHOTTKY BARRIER RECTIFIER 30 AMPERES 30 VOLTS





CASE 418B PLASTIC

#### MARKING DIAGRAM



#### ORDERING INFORMATION

Device	Package	Shipping
MBRB3030CTL	D <sup>2</sup> PAK	50/Rail

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Ambient (Note 1.)	$R_{\thetaJA}$	50	°C/W
Thermal Resistance, Junction to Case	$R_{ ext{ heta}JC}$	1.0	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 2.) $(I_F = 15 \text{ A}, T_J = 25^{\circ}\text{C})$ $(I_F = 30 \text{ A}, T_J = 25^{\circ}\text{C})$	V <sub>F</sub>	0.44 0.51	V
Maximum Instantaneous Reverse Current (Note 2.)	I <sub>R</sub>		mA
(Rated $V_R$ , $T_J = 25^{\circ}C$ )		2.0	
(Rated V <sub>R</sub> , T <sub>J</sub> = 125°C)		195	

1. Mounted using minimum recommended pad size on FR-4 board.

2. Pulse Test: Pulse Width = 250  $\mu$ s, Duty Cycle  $\leq$  2.0%.

All device data is "Per Leg" except where noted.

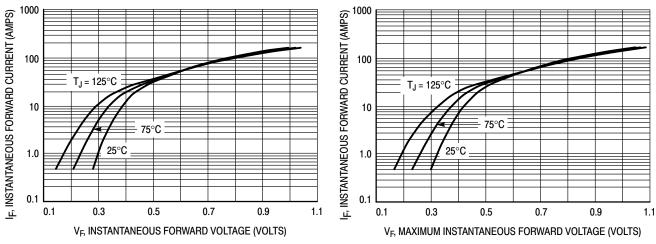


Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage

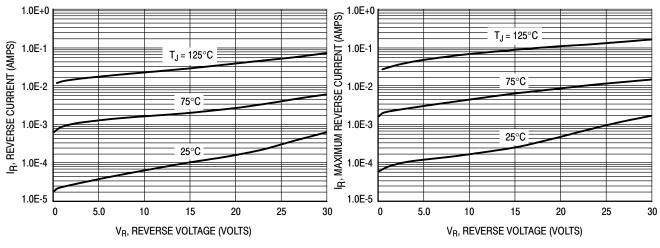


Figure 3. Typical Reverse Current

Figure 4. Maximum Reverse Current

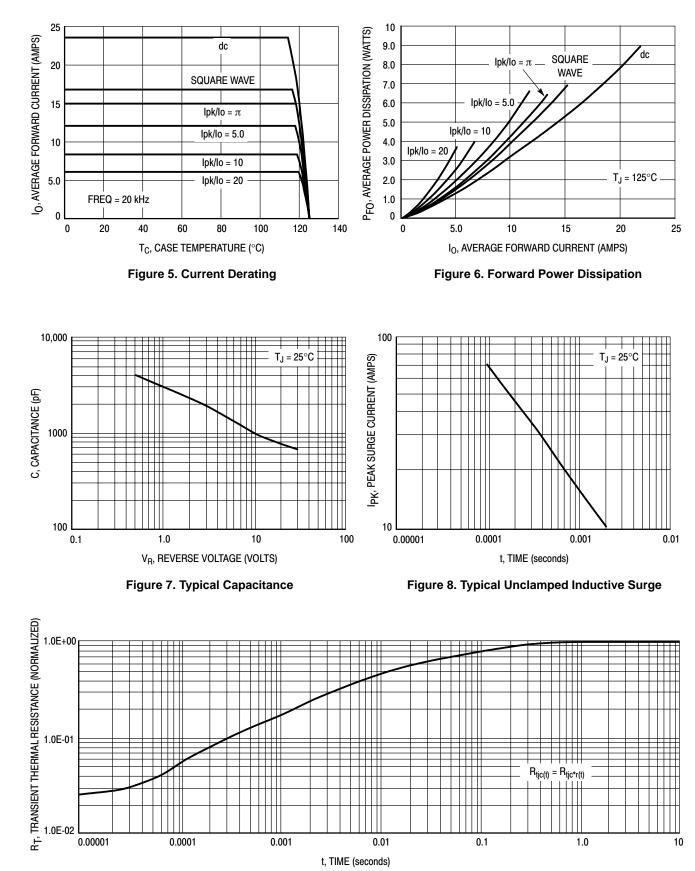


Figure 9. Typical Thermal Response

## Modeling Reverse Energy Characteristics of Power Rectifiers

Prepared by: David Shumate & Larry Walker ON Semiconductor Products Sector

#### ABSTRACT

Power semiconductor rectifiers are used in a variety of applications where the reverse energy requirements often vary dramatically based on the operating conditions of the application circuit. A characterization method was devised using the Unclamped Inductive Surge (UIS) test technique. By testing at only a few different operating conditions (i.e. different inductor sizes) a safe operating range can be established for a device. A relationship between peak avalanche current and inductor discharge time was established. Using this relationship and circuit parameters, the part applicability can be determined. This technique offers a power supply designer the total operating conditions for a device as opposed to the present single-data-point approach.

#### INTRODUCTION

In today's modern power supplies, converters and other switching circuitry, large voltage spikes due to parasitic inductance can propagate throughout the circuit, resulting in catastrophic device failures. Concurrent with this, in an effort to provide low-loss power rectifiers, i.e., devices with lower forward voltage drops, Schottky technology is being applied to devices used in this switching power circuitry. This technology lends itself to lower reverse breakdown voltages. This combination of high voltage spikes and low reverse breakdown voltage devices can lead to reverse energy destruction of power rectifiers in their applications. This phenomena, however, is not limited to just Schottky technology.

In order to meet the challenges of these situations, power semiconductor manufacturers attempt to characterize their devices with respect to reverse energy robustness. The typical reverse energy specification, if provided at all, is usually given as energy-to-failure (mJ) with a particular inductor specified for the UIS test circuit. Sometimes the peak reverse test current is also specified. Practically all reverse energy characterizations are performed using the UIS test circuit shown in Figure 10. Typical UIS voltage and current waveforms are shown in Figure 11.

In order to provide the designer with a more extensive characterization than the above mentioned one-point approach, a more comprehensive method for characterizing these devices was developed. A designer can use the given information to determine the appropriateness and safe operating area (SOA) of the selected device.

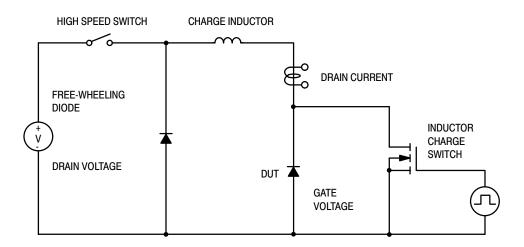
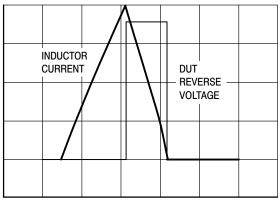


Figure 10. Simplified UIS Test Circuit

#### Suggested Method of Characterization



TIME (s)

#### Figure 11. Typical Voltage and Current UIS Waveforms

Utilizing the UIS test circuit in Figure 10, devices are tested to failure using inductors ranging in value from 0.01 to 159 mH. The reverse voltage and current waveforms are acquired to determine the exact energy seen by the device and the inductive current decay time. At least 4 distinct inductors and 5 to 10 devices per inductor are used to generate the characteristic current versus time relationship. This relationship when coupled with the application circuit conditions, defines the SOA of the device uniquely for this application.

#### **Example Application**

The device used for this example was an MBR3035CT, which is a 30 A (15 A per side) forward current, 35 V reverse breakdown voltage rectifier. All parts were tested to destruction at 25°C. The inductors used for the characterization were 10, 3.0, 1.0 and 0.3 mH. The data recorded from the testing were peak reverse current (Ip), peak reverse breakdown voltage (BVR), maximum withstand energy, inductance and inductor discharge time (see Table 1). A plot of the Peak Reverse Current versus Time at device destruction, as shown in Figure 12, was generated. The area under the curve is the region of lower reverse energy or lower stress on the device. This area is known as the safe operating area or SOA.

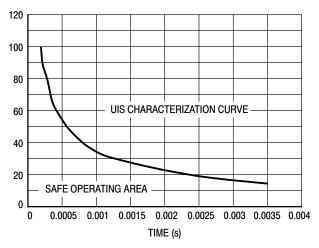


Figure 12. Peak Reverse Current versus Time for DUT

PART NO.	I <sub>P</sub> (A)	B <sub>VR</sub> (V)	ENERGY (mJ)	L (mH)	TIME (μs)
1	46.6	65.2	998.3	1	715
2	41.7	63.4	870.2	1	657
3	46.0	66.0	1038.9	1	697
4	42.7	64.8	904.2	1	659
5	44.9	64.8	997.3	1	693
6	44.1	64.1	865.0	1	687
7	26.5	63.1	1022.6	3	1261
8	26.4	62.8	1024.9	3	1262
9	24.4	62.2	872.0	3	1178
10	27.6	62.9	1091.0	3	1316
11	27.7	63.2	1102.4	3	1314
12	17.9	62.6	1428.6	10	2851
13	18.9	62.1	1547.4	10	3038
14	18.8	60.7	1521.1	10	3092
15	19.0	62.6	1566.2	10	3037
16	74.2	69.1	768.4	0.3	322
17	77.3	69.6	815.4	0.3	333
18	75.2	68.9	791.7	0.3	328
19	77.3	69.6	842.6	0.3	333
20	73.8	69.1	752.4	0.3	321
21	75.6	69.2	823.2	0.3	328
22	74.7	68.6	747.5	0.3	327
23	78.4	70.3	834.0	0.3	335
24	70.5	66.6	678.4	0.3	317
25	78.3	69.4	817.3	0.3	339

Table 1. UIS Test Data

The procedure to determine if a rectifier is appropriate, from a reverse energy standpoint, to be used in the application circuit is as follows:

- a. Obtain "Peak Reverse Current versus Time" curve from data book.
- b. Determine steady state operating voltage (OV) of circuit.
- c. Determine parasitic inductance (L) of circuit section of interest.
- d. Obtain rated breakdown voltage (BVR) of rectifier from data book.
- e. From the following relationships,

$$V = L \cdot \frac{d}{dt}i(t) \qquad \qquad I = \frac{(BVR - OV) \cdot t}{L}$$

a "designer" l versus t curve is plotted alongside the device characteristic plot.

f. The point where the two curves intersect is the current level where the devices will start to fail. A peak inductor current below this intersection should be chosen for safe operating. As an example, the values were chosen as  $L = 200 \,\mu\text{H}$ ,  $OV = 12 \, V$  and  $BVR = 35 \, V$ .

Figure 13 illustrates the example. Note the UIS characterization curve, the parasitic inductor current curve and the safe operating region as indicated.

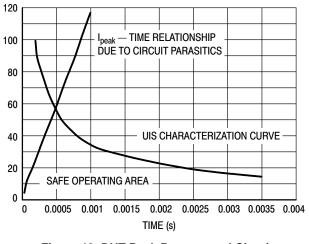


Figure 13. DUT Peak Reverse and Circuit Parasitic Inductance Current versus Time

#### SUMMARY

Traditionally, power rectifier users have been supplied with single-data-point reverse-energy characteristics by the supplier's device data sheet; however, as has been shown here and in previous work, the reverse withstand energy can vary significantly depending on the application. What was done in this work was to create a characterization scheme by which the designer can overlay or map their particular requirements onto the part capability and determine quite accurately if the chosen device is applicable. This characterization technique is very robust due to its statistical approach, and with proper guardbanding ( $6\sigma$ ) can be used to give worst-case device performance for the entire product line. A "typical" characteristic curve is probably the most applicable for designers allowing them to design in their own margins.

#### References

- Borras, R., Aliosi, P., Shumate, D., 1993, "Avalanche Capability of Today's Power Semiconductors, "Proceedings, European Power Electronic Conference," 1993, Brighton, England
- Pshaenich, A., 1985, "Characterizing Overvoltage Transient Suppressors," <u>Powerconversion</u> <u>International, June/July</u>

Preferred Device

## SWITCHMODE™ Power Rectifier

Using the Schottky Barrier principle with a proprietary barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Maximum Die Size
- 150°C Operating Junction Temperature
- Short Heat Sink Tab Manufactured Not Sheared

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 Grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads Readily Solderable
- Shipped 50 Units per Plastic Tube
- Available in 24 mm Tape and Reel, 800 Units per 13" Reel by Adding a "T4" Suffix to the Part Number
- Marking: B4030

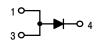
		1	1
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Average Rectified Forward Current (At Rated $V_R$ ) $T_C$ = +115°C (Note 1.)	I <sub>F(AV)</sub>	40	A
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz) T <sub>C</sub> = +112°C	I <sub>FRM</sub>	80	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	300	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Operating Junction Temperature Range	ТJ	-65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/µs
Reverse Energy (Unclamped Inductive Surge) $(T_C = 25^{\circ}C, L = 3.0 \text{ mH})$	W	600	mJ



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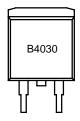
## SCHOTTKY BARRIER RECTIFIER 40 AMPERES 30 VOLTS





## STYLE 3

#### MARKING DIAGRAM



B4030 = Device Code

#### ORDERING INFORMATION

Device	Package	Shipping
MBRB4030	D <sup>2</sup> PAK	50/Rail
MBRB4030T4	D <sup>2</sup> PAK	800/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

1. Rating applies when pins 1 and 3 are connected.

#### THERMAL CHARACTERISTICS

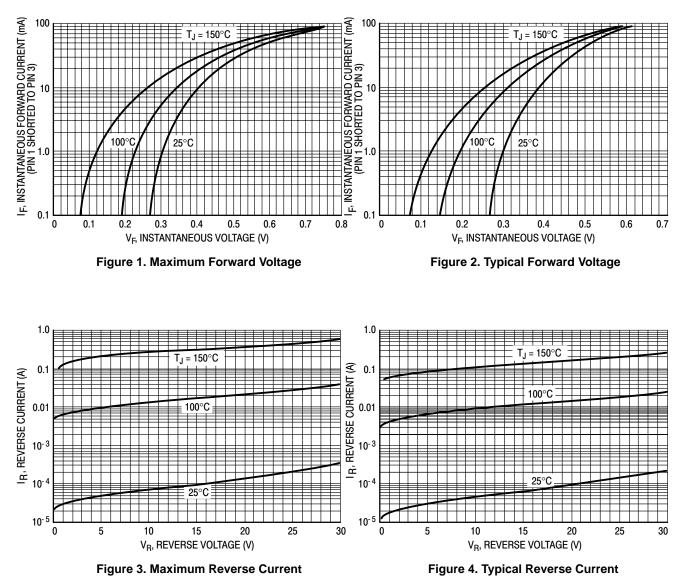
Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction to Case	$R_{ extsf{ heta}JC}$	1.0	°C/W
Thermal Resistance - Junction to Ambient (Note 3.)	$R_{ hetaJA}$	50	°C/W

#### ELECTRICAL CHARACTERISTICS

	VF	0.46 0.34 0.55 0.45	V
Maximum Instantaneous Reverse Current (Note 4.), per Device (Rated DC Voltage, $T_C = +25^{\circ}C$ ) (Rated DC Voltage, $T_C = +125^{\circ}C$ )	۱ <sub>R</sub>	0.35 150	mA

Rating applies when pins 1 and 3 are connected.
 Rating applies when surface mounted on the miniumum pad size recommended.
 Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤ 2.0%

#### **ELECTRICAL CHARACTERISTICS**



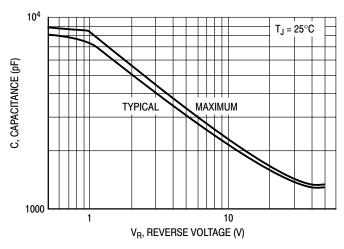


Figure 5. Maximum and Typical Capacitance

#### **ELECTRICAL CHARACTERISTICS**

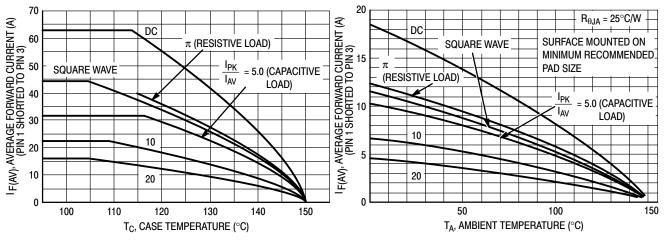
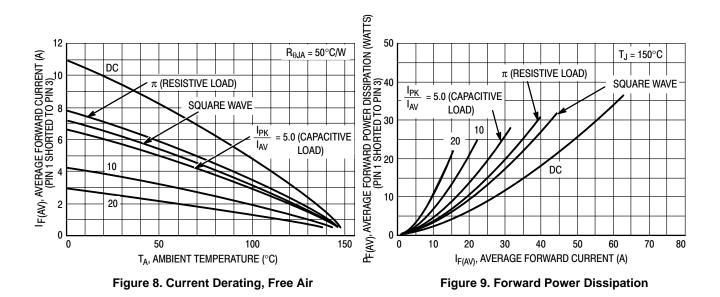


Figure 6. Current Derating, Infinite Heatsink





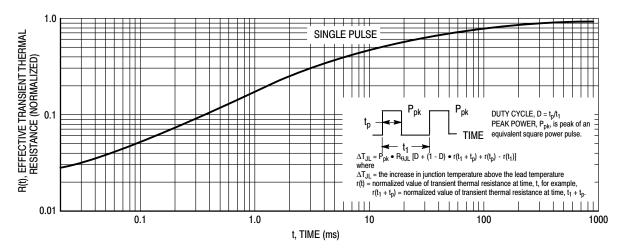


Figure 10. Thermal Response

# 1N5817, 1N5818, 1N5819

1N5817 and 1N5819 are Preferred Devices

# **Axial Lead Rectifiers**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low V<sub>F</sub>
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N5817, 1N5818, 1N5819

### MAXIMUM RATINGS

Please See the Table on the Following Page



## **ON Semiconductor®**

http://onsemi.com

## SCHOTTKY BARRIER RECTIFIERS 1.0 AMPERE 20, 30 and 40 VOLTS



#### 1N581x = Device Codex = 7, 8 or 9

#### **ORDERING INFORMATION**

Device	Package	Shipping
1N5817	Axial Lead	1000 Units/Bag
1N5817RL	Axial Lead	5000/Tape & Reel
1N5818	Axial Lead	1000 Units/Bag
1N5818RL	Axial Lead	5000/Tape & Reel
1N5819	Axial Lead	1000 Units/Bag
1N5819RL	Axial Lead	5000/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

## 1N5817, 1N5818, 1N5819

#### MAXIMUM RATINGS

Rating	Symbol	1N5817	1N5818	1N5819	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	30	40	V
Non-Repetitive Peak Reverse Voltage	V <sub>RSM</sub>	24	36	48	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	14	21	28	V
Average Rectified Forward Current (Note 1.) $(V_{R(equiv)} \le 0.2 V_{R}(dc), T_{L} = 90^{\circ}C,$ $R_{\theta JA} = 80^{\circ}C/W, P.C.$ Board Mounting, see Note 4., $T_{A} = 55^{\circ}C$ )	Ι <sub>Ο</sub>		1.0		A
Ambient Temperature (Rated V <sub>R</sub> (dc), P <sub>F(AV)</sub> = 0, R <sub><math>\theta</math>JA</sub> = 80°C/W)	T <sub>A</sub>	85	80	75	°C
Non-Repetitive Peak Surge Current $I_F$ (Surge applied at rated load conditions, half-wave, single phase 60 Hz, $T_L = 70^{\circ}$ C)		25	(for one cy	cle)	A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T <sub>J</sub> , T <sub>stg</sub>	-	-65 to +12	5	°C
Peak Operating Junction Temperature (Forward Current applied)	T <sub>J(pk)</sub>		150		°C

#### THERMAL CHARACTERISTICS (Note 1.)

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Ambient	$R_{ extsf{ heta}JA}$	80	°C/W

**ELECTRICAL CHARACTERISTICS** ( $T_L = 25^{\circ}C$  unless otherwise noted) (Note 1.)

Characteristic		Symbol	1N5817	1N5818	1N5819	Unit
Maximum Instantaneous Forward Voltage (Note 2.)	(i <sub>F</sub> = 0.1 A) (i <sub>F</sub> = 1.0 A) (i <sub>F</sub> = 3.0 A)	۷F	0.32 0.45 0.75	0.33 0.55 0.875	0.34 0.6 0.9	~
Maximum Instantaneous Reverse Current @ Rated dc Volta	age (Note 2.) (T <sub>L</sub> = 25°C) (T <sub>L</sub> = 100°C)	I <sub>R</sub>	1.0 10	1.0 10	1.0 10	mA

1. Lead Temperature reference is cathode lead 1/32" from case.

2. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle = 2.0%.

#### NOTE 3. — DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.1  $V_{RWM}$ . Proper derating may be accomplished by use of equation (1).

$$\begin{array}{l} T_{A(max)} = T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)} \qquad (1) \\ \mbox{where } T_{A(max)} = \mbox{Maximum allowable ambient temperature} \\ T_{J(max)} = \mbox{Maximum allowable junction temperature} \\ (125^{\circ}C \mbox{ or the temperature at which thermal} \\ runaway occurs, whichever is lowest) \\ P_{F(AV)} = \mbox{Average forward power dissipation} \\ P_{R(AV)} = \mbox{Average reverse power dissipation} \\ R_{\theta,JA} = \mbox{Junction-to-ambient thermal resistance} \end{array}$$

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2).

$$T_{R} = T_{J(max)} - R_{\theta JA} P_{R(AV)}$$
(2)

Substituting equation (2) into equation (1) yields:

T,

$$M_{(max)} = T_R - R_{\theta JA} P_{F(AV)}$$
(3)

Inspection of equations (2) and (3) reveals that  $T_R$  is the ambient temperature at which thermal runaway occurs or where  $T_J = 125^{\circ}$ C, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a difference in the rate of change of the slope in the vicinity of 115°C. The data of Figures 1, 2, and 3 is based upon dc conditions. For use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, that is:

$$V_{R(equiv)} = V_{in(PK)} \times F$$
 (4)

The factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

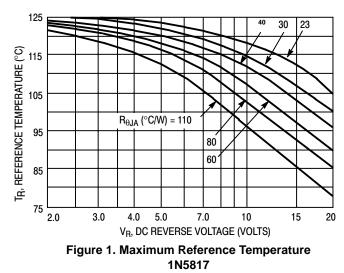
EXAMPLE: Find  $T_{A(max)}$  for 1N5818 operated in a 12-volt dc supply using a bridge circuit with capacitive filter such that  $I_{DC} = 0.4 \text{ A} (I_{F(AV)} = 0.5 \text{ A}), I_{(FM)}/I_{(AV)} = 10$ , Input Voltage = 10 V<sub>(rms)</sub>, R<sub>0JA</sub> = 80°C/W.

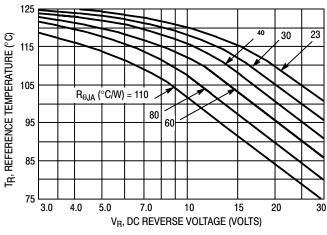
Step 3. Find  $P_{F(AV)}$  from Figure 4. \*\*Read  $P_{F(AV)} = 0.5$  W

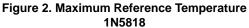
$$\mathbb{D} \frac{I_{(FM)}}{I_{(AV)}} = 10 \text{ and } IF(AV) = 0.5 \text{ A.}$$

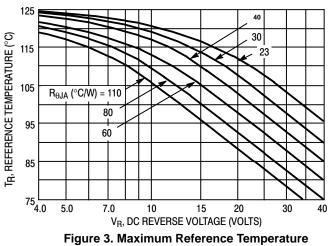
Step 4. Find  $T_{A(max)}$  from equation (3).  $T_{A(max)} = 109 - (80) (0.5) = 69^{\circ}C.$ 

\*\*Values given are for the 1N5818. Power is slightly lower for the 1N5817 because of its lower forward voltage, and higher for the 1N5819.









1N5819

Circuit	Half Wave		Full Wave, Bridge		Full Wave, Ce	nter Tapped*†
Load	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

Table 1. Values for Factor F

\*Note that  $V_{R(PK)} \approx 2.0 V_{in(PK)}$ . † Use line to center tap voltage for  $V_{in}$ 

http://onsemi.com 205

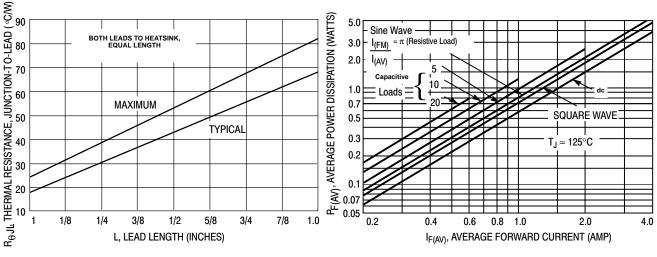
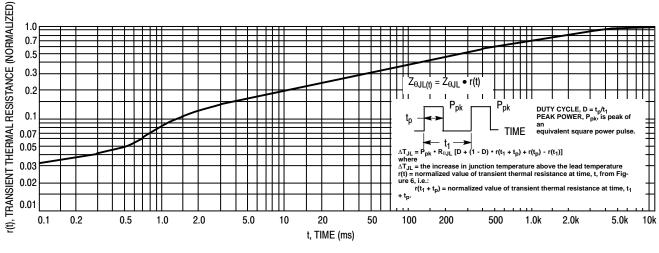
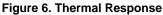




Figure 5. Forward Power Dissipation 1N5817-19





#### NOTE 4. — MOUNTING DATA

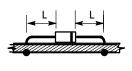
Data shown for thermal resistance junction-to-ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR  $R_{\theta JA}$  IN STILL AIR

Mounting					
Method	1/8	1/4	1/2	3/4	R <sub>θJA</sub>
1	52	65	72	85	°C/W
2	67	80	87	100	°C/W
3		50			

Mounting Method 1 P.C. Board with

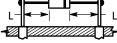
P.C. Board with 1-1/2 " x 1-1/2" copper surface.





BOARD GROUND PLANE





VECTOR PIN MOUNTING

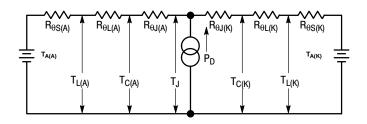
Mounting Method 2

P.C. Board with 1-1/2 " x 1-1/2" copper surface.

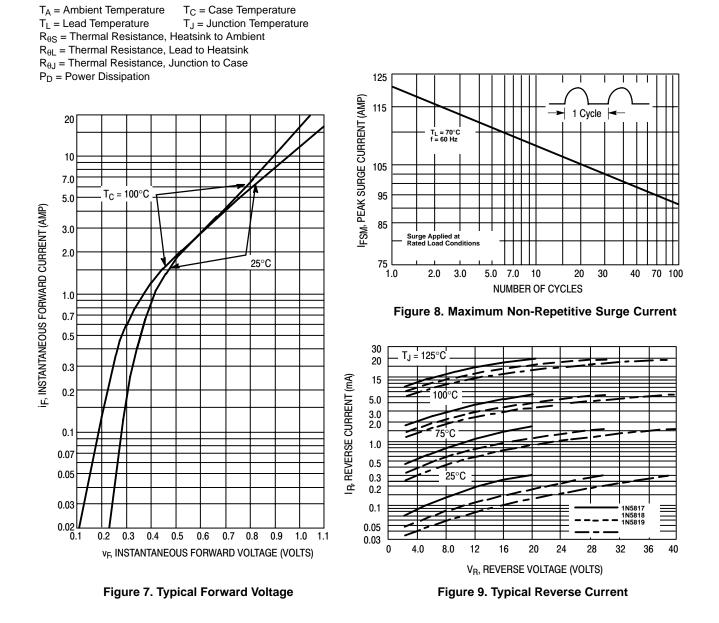
Mounting Method 3

### 1N5817, 1N5818, 1N5819

#### NOTE 5. — THERMAL CIRCUIT MODEL (For heat conduction through the leads)



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heatsink. Terms in the model signify: (Subscripts A and K refer to anode and cathode sides, respectively.) Values for thermal resistance components are:  $R_{\theta L} = 100^{\circ}$ C/W/in typically and 120°C/W/in maximum  $R_{\theta J} = 36^{\circ}$ C/W typically and 46°C/W maximum.



#### NOTE 6. — HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss: it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

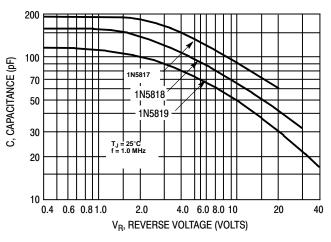


Figure 10. Typical Capacitance

# MBR150, MBR160

MBR160 is a Preferred Device

# **Axial Lead Rectifiers**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Low Reverse Current
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Mechanical Characteristics:
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: B150, B160

#### MAXIMUM RATINGS

Please See the Table on the Following Page



## **ON Semiconductor®**

http://onsemi.com

## SCHOTTKY BARRIER RECTIFIERS 1.0 AMPERE 50, 60 VOLTS





= 5 or 6

х

## ORDERING INFORMATION

Device	Package Shipping	
MBR150	Axial Lead	1000 Units/Bag
MBR150RL	Axial Lead	5000/Tape & Reel
MBR160	Axial Lead	1000 Units/Bag
MBR160RL	Axial Lead	5000/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

## MBR150, MBR160

#### MAXIMUM RATINGS

Rating	Symbol	MBR150	MBR160	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	60	Volts	
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	42	Volts	
Average Rectified Forward Current (Note 1.) $(V_{R(equiv)} \le 0.2 V_{R}(dc), T_{L} = 90^{\circ}C, R_{\theta JA} = 80^{\circ}C/W, P.C.$ Board Mounting, see Note 3., $T_{A} = 55^{\circ}C$ )	IO	1	1.0		
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz, $T_L = 70^{\circ}C$ )	I <sub>FSM</sub>	I <sub>FSM</sub> 25 (for one cycle)			
Operating and Storage Junction Temperature Range (Reverse Voltage Applied)	T <sub>J</sub> , T <sub>stg</sub>	- 65 te	o +150	°C	
Peak Operating Junction Temperature (Forward Current Applied)	T <sub>J(pk)</sub>	1:	50	°C	

#### THERMAL CHARACTERISTICS (Notes 3. and 4.)

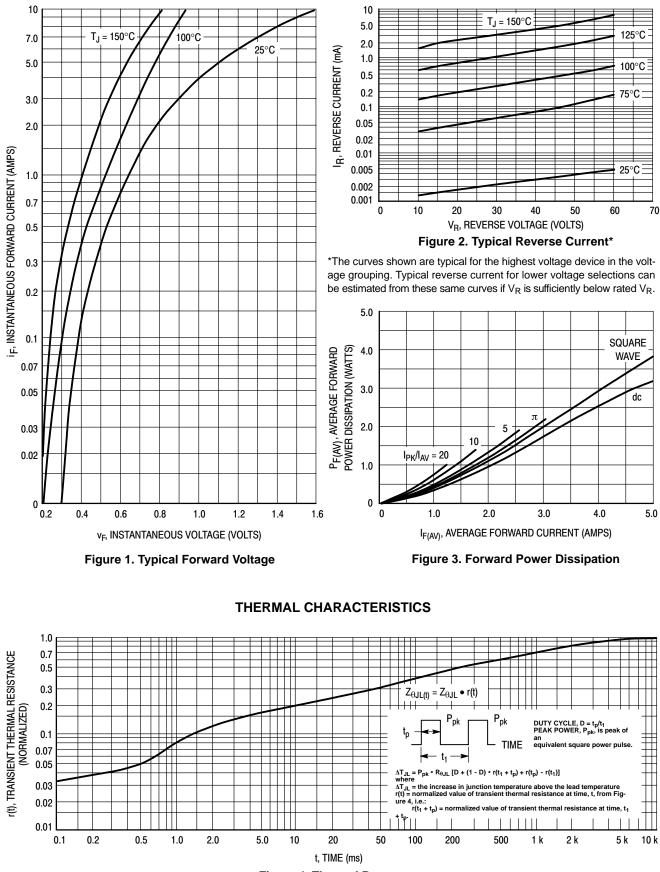
Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Ambient	$R_{\thetaJA}$	80	°C/W

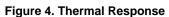
#### **ELECTRICAL CHARACTERISTICS** ( $T_L = 25^{\circ}C$ unless otherwise noted) (Note 1.)

Characteristic	Symbol	Мах	Unit
$\label{eq:constant} \begin{array}{l} \mbox{Maximum Instantaneous Forward Voltage (Note 2.)} \\ (i_F = 0.1 \mbox{ A}) \\ (i_F = 1.0 \mbox{ A}) \\ (i_F = 3.0 \mbox{ A}) \end{array}$	VF	0.550 0.750 1.000	Volt
Maximum Instantaneous Reverse Current @ Rated dc Voltage (Note 2.) $(T_L = 25^{\circ}C)$ $(T_L = 100^{\circ}C)$	i <sub>R</sub>	0.5 5.0	mA

1. Lead Temperature reference is cathode lead 1/32'' from case.2. Pulse Test: Pulse Width = 300 µs, Duty Cycle  $\leq 2.0\%$ .

## MBR150, MBR160





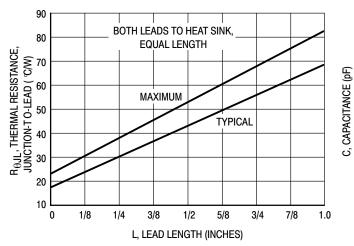


Figure 5. Steady-State Thermal Resistance

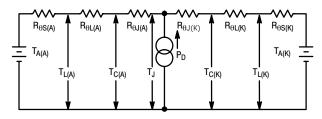
#### NOTE 3. — MOUNTING DATA:

Data shown for thermal resistance junction-to-ambient  $(R_{\theta JA})$  for the mounting shown is to be used as a typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

Typical Values for  $R_{\theta JA}$  in Still Air

Mounting	Lead Length, L (in)				в
Method	1/8	1/4	1/2	3/4	$R_{\theta JA}$
1	52	65	72	85	°C/W
2	67	80	87	100	°C/W
3	—		50		°C/W

**NOTE 4.** — **THERMAL CIRCUIT MODEL:** (For heat conduction through the leads)



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heat sink. Terms in the model signify:

 $\begin{array}{ll} T_A = Ambient \mbox{ Temperature } & T_C = Case \mbox{ Temperature } \\ T_L = Lead \mbox{ Temperature } & T_J = \mbox{ Junction Temperature } \\ R_{\theta S} = \mbox{ Thermal Resistance, Heat Sink to Ambient } \\ R_{\theta L} = \mbox{ Thermal Resistance, Lead to Heat Sink } \\ R_{\theta J} = \mbox{ Thermal Resistance, Junction to Case } \\ P_D = \mbox{ Power Dissipation } \end{array}$ 

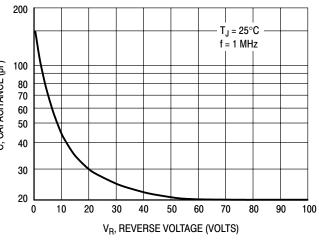
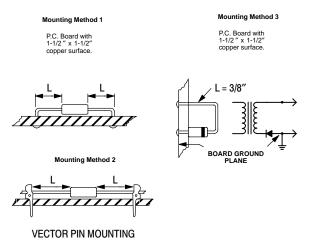


Figure 6. Typical Capacitance



(Subscripts A and K refer to anode and cathode sides, respectively.) Values for thermal resistance components are:  $R_{\theta L} = 100^{\circ}C/W/in$  typically and  $120^{\circ}C/W/in$  maximum.  $R_{\theta J} = 36^{\circ}C/W$  typically and  $46^{\circ}C/W$  maximum.

#### NOTE 5. — HIGH FREQUENCY OPERATION:

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 6.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss: it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

## **MBR1100**

Preferred Device

# **Axial Lead Rectifier**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Low Reverse Current
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Guard-Ring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- High Surge Capacity

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16" from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: B1100

#### MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	V
$ \begin{array}{l} \mbox{Average Rectified Forward Current} \\ (V_{R(equiv)} \leq 0.2 \ V_{R}(dc), \ R_{\theta JA} = \\ 50^{\circ}C/W, \ P.C. \ Board Mounting, \ see \\ Note \ 1., \ T_{A} = 120^{\circ}C) \end{array} $	lo	1.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	50	A
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10	V/ns



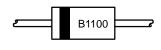
### **ON Semiconductor**<sup>®</sup>

http://onsemi.com

## SCHOTTKY BARRIER RECTIFIER 1.0 AMPERE 100 VOLTS



#### MARKING DIAGRAM



B1100 = Device Code

#### ORDERING INFORMATION

Device	Packa	age Shipping
MBR1100	Axial L	ead 1000 Units/Bag
MBR1100F	RL Axial L	ead 5000/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

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### **MBR1100**

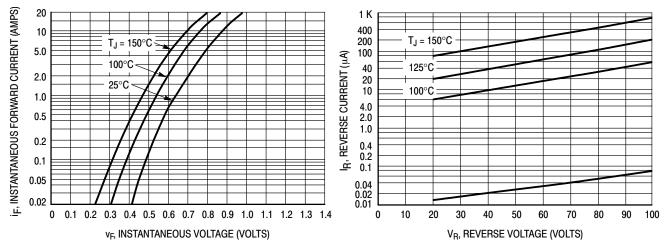
#### THERMAL CHARACTERISTICS (See Note 2.)

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Ambient	$R_{\thetaJA}$	See Note 1.	°C/W

**ELECTRICAL CHARACTERISTICS** ( $T_L = 25^{\circ}C$  unless otherwise noted)

Characteristic	Symbol	Мах	Unit
Maximum Instantaneous Forward Voltage * ( $i_F = 1 \text{ A}, T_L = 25^{\circ}\text{C}$ ) ( $i_F = 1 \text{ A}, T_L = 100^{\circ}\text{C}$ )	V <sub>F</sub>	0.79 0.69	Volt
Maximum Instantaneous Reverse Current @ Rated dc Voltage * $(T_L = 25^{\circ}C)$ $(T_L = 100^{\circ}C)$	i <sub>R</sub>	0.5 5.0	mA

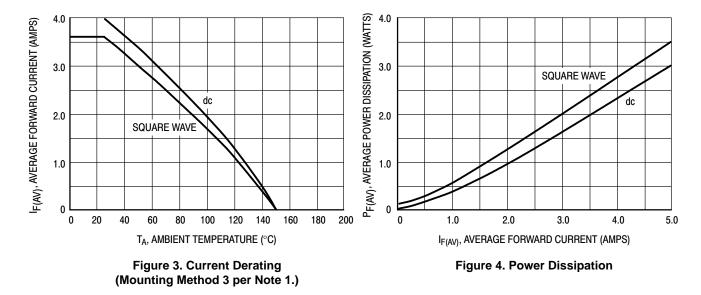
\* Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.







<sup>†</sup> The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if  $V_R$  is sufficiently below rated  $V_R$ .



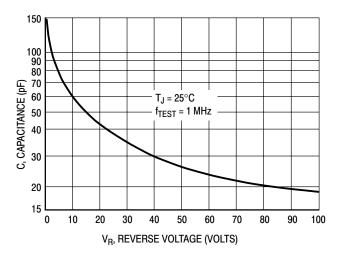


Figure 5. Typical Capacitance

#### NOTE 1. — MOUNTING DATA:

Data shown for thermal resistance junction-to-ambient  $(R_{\theta JA})$  for the mounting shown is to be used as a typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

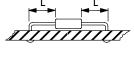
Typical Values for  $\textbf{R}_{\theta \textbf{J}\textbf{A}}$  in Still Air

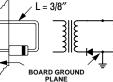
Mounting	Lead Length, L (in)				Р
Method	1/8	1/4	1/2	3/4	$R_{\theta JA}$
1	52	65	72	85	°C/W
2	67	80	87	100	°C/W
3	_		50		°C/W

Mounting Method 1

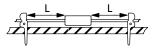
P.C. Board with 1-1/2 " x 1-1/2" copper surface.





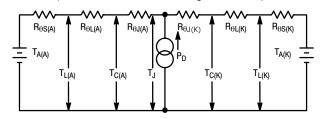


Mounting Method 2



VECTOR PIN MOUNTING

NOTE 2. — THERMAL CIRCUIT MODEL: (For heat conduction through the leads)



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heat sink. Terms in the model signify:

 $\begin{array}{ll} T_A = Ambient \mbox{ Temperature } & T_C = Case \mbox{ Temperature } \\ T_L = Lead \mbox{ Temperature } & T_J = Junction \mbox{ Temperature } \\ R_{\theta S} = Thermal \mbox{ Resistance, Heat Sink to Ambient } \\ R_{\theta L} = Thermal \mbox{ Resistance, Lead to Heat Sink } \\ R_{\theta J} = Thermal \mbox{ Resistance, Junction to Case } \\ P_D = Power \mbox{ Dissipation } \end{array}$ 

(Subscripts A and K refer to anode and cathode sides, respectively.) Values for thermal resistance components are:  $R_{\theta L} = 100^{\circ}C/W/in$  typically and 120°C/W/in maximum.  $R_{\theta J} = 36^{\circ}C/W$  typically and 46°C/W maximum.

#### NOTE 3. — HIGH FREQUENCY OPERATION:

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 5)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss: it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

# **Axial Lead Rectifier**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low V<sub>f</sub>
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Low Stored Charge, Majority Carrier Conduction
- Mechanical Characteristics:
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- ESD Ratings: Machine Model = A

Human Body Model = 2

• Marking: MBR3060

## MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>r</sub>	60	V
Average Rectified Forward Current $T_L = 125^{\circ}C (R_{\theta,JL} = 13^{\circ}C/W,$ P.C. Board Mounting)	Ι <sub>ο</sub>	3.0	A
Non-Repetitive Peak Surge Current	I <sub>FSM</sub>	125	A
Operating and Storage Junction Temperature Range (Reverse Voltage Applied)	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C
Peak Operating Junction Temperature (Forward Current Applied)	T <sub>J(pk)</sub>	150	°C



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# SCHOTTKY BARRIER RECTIFIER 3.0 AMPERES 60 VOLTS



#### MARKING DIAGRAM



MBR3060 = Device Code

#### ORDERING INFORMATION

Device	)	Package	Shipping
MBR3060	R3060 Axial Lead		1000 Units/Bag
MBR3060	٦L	Axial Lead	5000/Tape & Reel

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#### THERMAL CHARACTERISTICS

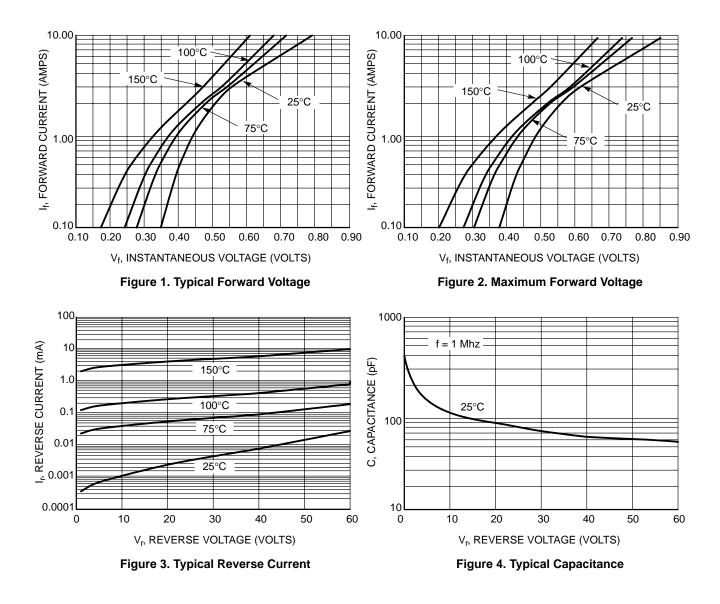
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction-to-Lead (Note 1, see Note 3, Mounting Method 3)	$R_{\theta JL}$	13	°C/W
Thermal Resistance, Junction-to-Ambient (see Note 3, Mounting Method 3)	$R_{\thetaJA}$	50	°C/W

#### **ELECTRICAL CHARACTERISTICS** ( $T_L = 25^{\circ}C$ unless otherwise noted) (Note 1)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 2) ( $I_f = 3.0 \text{ Amp}$ ), $T_L = 25^{\circ}\text{C}$ ( $I_f = 3.0 \text{ Amp}$ ), $T_L = 100^{\circ}\text{C}$	V <sub>f</sub>	0.62 0.59	V
Maximum Instantaneous Reverse Current (Note 2) $(V_r = 60 \text{ V}), T_L = 25^{\circ}\text{C}$ $(V_r = 60 \text{ V}), T_L = 100^{\circ}\text{C}$	l <sub>r</sub>	150 10	μA mA

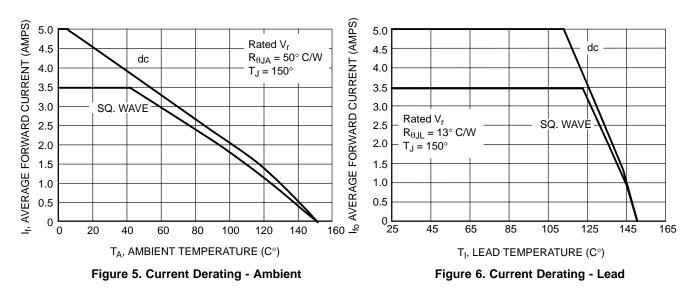
1. Lead Temperature reference is cathode lead at printed wiring board.

2. Pulse Test: Pulse Width =  $300 \mu s$ , Duty Cycle = 2.0%.



## **TYPICAL CHARACTERISTICS**

## **TYPICAL CHARACTERISTICS**



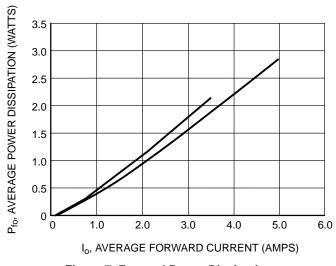


Figure 7. Forward Power Dissipation

## NOTE 3 — MOUNTING DATA

Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) and thermal resistance junction-to-lead ( $R_{\theta JL}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

#### TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

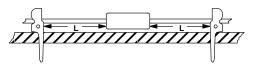
Mounting	ounting Lead Length, L (in)						
Method	1/8	1/4	1/2	3/4	$R_{\theta JA}$		
1	52	65	72	85	°C/W		
2	67	80	87	100	°C/W		
3		50					

#### TYPICAL VALUES FOR $\textbf{R}_{\theta \textbf{JL}}$ IN STILL AIR

Mounting	Lead			
Method	1/8	1/4	1/2	$R_{\theta JA}$
1	15	23	37	°C/W
2	30	38	52	°C/W
3		13		°C/W

#### **Mounting Method 2**

Vector Push-In Terminals T-28

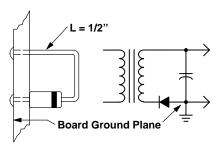


#### **Mounting Method 1**

P.C. Board with 1-1/2  $^{\prime\prime}$  X 1-1/2  $^{\prime\prime}$  copper surface.

### **Mounting Method 3**

P.C. Board with 1-1/2 " X 1-1/2" copper surface.



# 1N5820, 1N5821, 1N5822

1N5820 and 1N5822 are Preferred Devices

# **Axial Lead Rectifiers**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features chrome barrier metal, epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low V<sub>F</sub>
- Low Power Loss/High Efficiency
- Low Stored Charge, Majority Carrier Conduction

### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 500 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- Marking: 1N5820, 1N5821, 1N5822

## MAXIMUM RATINGS

Please See the Table on the Following Page



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# SCHOTTKY BARRIER RECTIFIERS 3.0 AMPERES 20, 30, 40 VOLTS



### MARKING DIAGRAM



1N582x = Device Codex = 0, 1 or 2

## ORDERING INFORMATION

Device	Package	Shipping
1N5820	Axial Lead	500 Units/Bag
1N5820RL	Axial Lead	1500/Tape & Reel
1N5821	Axial Lead	500 Units/Bag
1N5821RL	Axial Lead	1500/Tape & Reel
1N5822	Axial Lead	500 Units/Bag
1N5822RL	Axial Lead	1500/Tape & Reel

# 1N5820, 1N5821, 1N5822

#### MAXIMUM RATINGS

Rating	Symbol	1N5820	1N5821	1N5822	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	30	40	V
Non-Repetitive Peak Reverse Voltage	V <sub>RSM</sub>	24	36	48	V
RMS Reverse Voltage	V <sub>R(RMS)</sub>	14	21	28	V
Average Rectified Forward Current (Note 1) $V_{R(equiv)} \le 0.2 V_{R(dc)}, T_{L} = 95^{\circ}C$ $(R_{\theta JA} = 28^{\circ}C/W, P.C.$ Board Mounting, see Note 5)	lo		3.0		A
$ \begin{array}{l} \mbox{Ambient Temperature} \\ \mbox{Rated } V_{R(dc)}, \mbox{P}_{F(AV)} = 0 \\ \mbox{R}_{\theta JA} = 28^{\circ} \mbox{C/W} \end{array} $	T <sub>A</sub>	90	85	80	°C
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, half wave, single phase 60 Hz, $T_L = 75^{\circ}C$ )	I <sub>FSM</sub>	<b></b> 80	) (for one cyc	le) <b>──</b> ►	A
Operating and Storage Junction Temperature Range (Reverse Voltage applied)	T <sub>J</sub> , T <sub>stg</sub>		65 to +12	5>	°C
Peak Operating Junction Temperature (Forward Current applied)	T <sub>J(pk)</sub>	<	<u> </u>		°C

#### \*THERMAL CHARACTERISTICS (Note 5)

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{\thetaJA}$	28	°C/W

\*ELECTRICAL CHARACTERISTICS (T<sub>L</sub> =  $25^{\circ}$ C unless otherwise noted) (Note 1)

Characteristic	Symbol	1N5820	1N5821	1N5822	Unit
	VF	0.370 0.475 0.850	0.380 0.500 0.900	0.390 0.525 0.950	V
Maximum Instantaneous Reverse Current @ Rated dc Voltage (Note 2) $T_L = 25^{\circ}C$ $T_L = 100^{\circ}C$	i <sub>R</sub>	2.0 20	2.0 20	2.0 20	mA

1. Lead Temperature reference is cathode lead 1/32'' from case. 2. Pulse Test: Pulse Width = 300 µs, Duty Cycle = 2.0%. \*Indicates JEDEC Registered Data for 1N5820-22.

## NOTE 3 — DETERMINING MAXIMUM RATINGS

Reverse power dissipation and the possibility of thermal runaway must be considered when operating this rectifier at reverse voltages above 0.1  $V_{RWM}$ . Proper derating may be accomplished by use of equation (1).

$$\begin{split} T_{A(max)} &= T_{J(max)} - R_{\theta JA} P_{F(AV)} - R_{\theta JA} P_{R(AV)}(1) \\ \text{where } T_{A(max)} &= \text{Maximum allowable ambient temperature} \\ T_{J(max)} &= \text{Maximum allowable junction temperature} \\ & (125^{\circ}\text{C or the temperature at which thermal} \\ & \text{runaway occurs, whichever is lowest}) \\ P_{F(AV)} &= \text{Average forward power dissipation} \\ P_{R(AV)} &= \text{Average reverse power dissipation} \\ R_{\theta JA} &= \text{Junction-to-ambient thermal resistance} \end{split}$$

Figures 1, 2, and 3 permit easier use of equation (1) by taking reverse power dissipation and thermal runaway into consideration. The figures solve for a reference temperature as determined by equation (2).

 $T_{R} = T_{J(max)} - R_{\theta JA} P_{R(AV)}$ (2)

Substituting equation (2) into equation (1) yields:

$$T_{A(max)} = T_{R} - R_{\theta JA} P_{F(AV)}$$
(3)

Inspection of equations (2) and (3) reveals that  $T_R$  is the ambient temperature at which thermal runaway occurs or where  $T_J = 125^{\circ}$ C, when forward power is zero. The transition from one boundary condition to the other is evident on the curves of Figures 1, 2, and 3 as a difference in the rate of change of the slope in the vicinity of 115°C. The data of Figures 1, 2, and 3 is based upon dc conditions. For

Table	1.	Values	for	Factor	F
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use in common rectifier circuits, Table 1 indicates suggested factors for an equivalent dc voltage to use for conservative design, that is:

$$V_{R(equiv)} = V_{(FM)} \times F \tag{4}$$

The factor F is derived by considering the properties of the various rectifier circuits and the reverse characteristics of Schottky diodes.

EXAMPLE: Find  $T_{A(max)}$  for 1N5821 operated in a 12-volt dc supply using a bridge circuit with capacitive filter such that  $I_{DC} = 2.0 \text{ A} (I_{F(AV)} = 1.0 \text{ A}), I_{(FM)}/I_{(AV)} = 10$ , Input Voltage = 10 V<sub>(rms)</sub>,  $R_{\theta JA} = 40^{\circ}$ C/W.

Step 1. Find  $V_{R(equiv)}$ . Read F = 0.65 from Table 1,

 $\therefore$  V<sub>R(equiv)</sub> = (1.41) (10) (0.65) = 9.2 V.

Step 2. Find  $T_R$  from Figure 2. Read  $T_R = 108^{\circ}C$ 

@  $V_R = 9.2$  V and  $R_{\theta JA} = 40^{\circ}$ C/W.

Step 3. Find  $P_{F(AV)}$  from Figure 6. \*\*Read  $P_{F(AV)} = 0.85$  W

$$@\frac{I(FM)}{I(AV)} = 10 \text{ and } I_{F(AV)} = 1.0 \text{ A.}$$

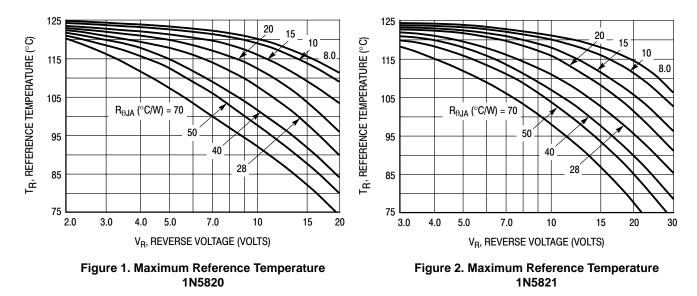
Step 4. Find  $T_{A(max)}$  from equation (3).

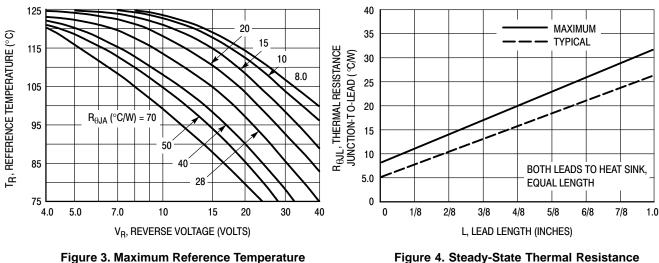
 $T_{A(max)} = 108 - (0.85) (40) = 74^{\circ}C.$ 

\*\*Values given are for the 1N5821. Power is slightly lower for the 1N5820 because of its lower forward voltage, and higher for the 1N5822. Variations will be similar for the MBR-prefix devices, using  $P_{F(AV)}$  from Figure 6.

Circuit	Half Wave		Full Wave, Bridge		Full V Center T	,
Load	Resistive	Capacitive*	Resistive	Capacitive	Resistive	Capacitive
Sine Wave	0.5	1.3	0.5	0.65	1.0	1.3
Square Wave	0.75	1.5	0.75	0.75	1.5	1.5

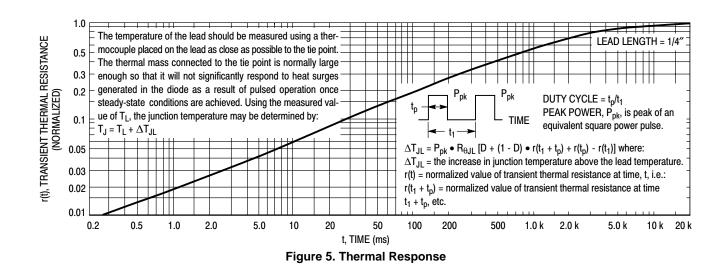
\*Note that  $V_{R(PK)}\approx$  2.0  $V_{in(PK)}.$  †Use line to center tap voltage for  $V_{in}.$ 





1N5822





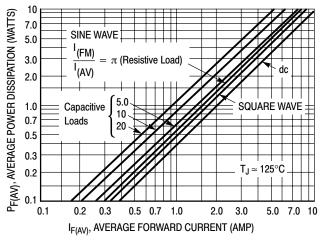
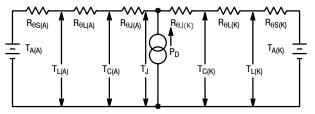


Figure 6. Forward Power Dissipation 1N5820-22

#### **NOTE 4 - APPROXIMATE THERMAL CIRCUIT MODEL**



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. For a given total lead length, lowest values occur when one side of the rectifier is brought as close as possible to the heat sink. Terms in the model signify:

 $T_A$  = Ambient Temperature  $T_C$  = Case Temperature

 $T_L$  = Lead Temperature  $T_J$  = Junction Temperature

- $R_{\theta S}$  = Thermal Resistance, Heat Sink to Ambient
- $R_{\theta L}$  = Thermal Resistance, Lead to Heat Sink

 $R_{\theta J}=$  Thermal Resistance, Junction to Case

 $P_D$  = Total Power Dissipation =  $P_F + P_R$ 

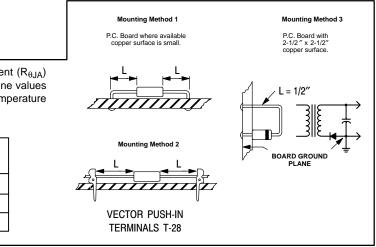
P<sub>F</sub> = Forward Power Dissipation

 $P_R$  = Reverse Power Dissipation

(Subscripts (A) and (K) refer to anode and cathode sides, respectively.) Values for thermal resistance components are:

$$\begin{split} R_{\theta L} &= 42^{\circ}C/W/\text{in typically and } 48^{\circ}C/W/\text{in maximum} \\ R_{\theta J} &= 10^{\circ}C/W \text{ typically and } 16^{\circ}C/W \text{ maximum} \\ \text{The maximum lead temperature may be found as follows:} \\ T_L &= T_{J(max)} - \Delta T_{JL} \end{split}$$

where  $\Delta T_{JL} \approx R_{\theta JL} \cdot P_D$ 



#### NOTE 5 — MOUNTING DATA

Data shown for thermal resistance junction-to-ambient ( $R_{\theta,JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR  $R_{\theta JA}$  IN STILL AIR

Mounting	Lead Length, L (in)				
Method	1/8	1/4	1/2	3/4	$R_{\theta JA}$
1	50	51	53	55	°C/W
2	58	59	61	63	°C/W
3	28			°C/W	

## 1N5820, 1N5821, 1N5822

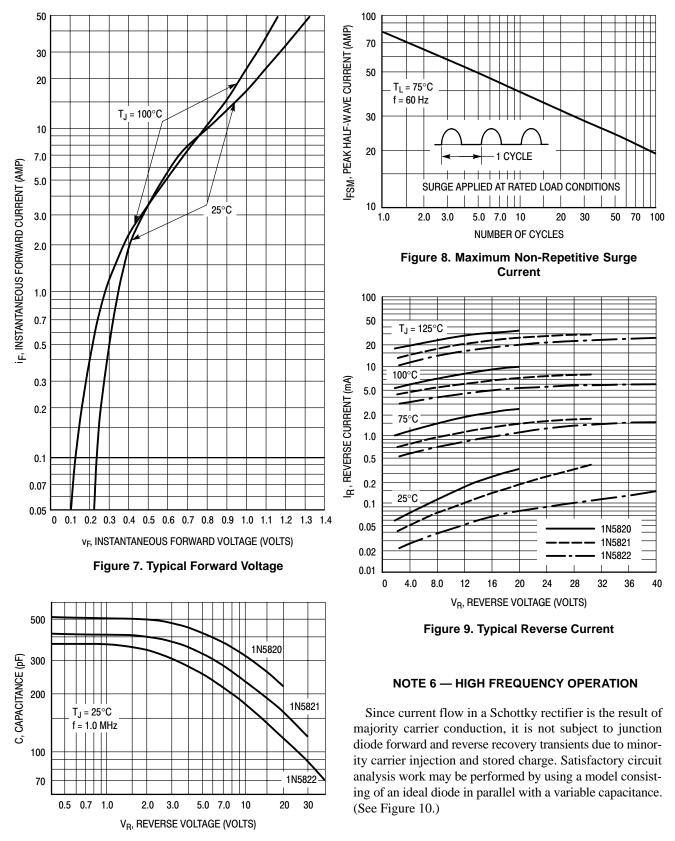


Figure 10. Typical Capacitance

Preferred Device

# **Axial Lead Rectifier**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low V<sub>F</sub>
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Low Stored Charge, Majority Carrier Conduction

## **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 500 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- Marking: B340

## MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	40	V
Average Rectified Forward Current $T_A = 65^{\circ}C (R_{\theta,JA} = 28^{\circ}C/W,$ P.C. Board Mounting)	Ι <sub>Ο</sub>	3.0	A
Non-Repetitive Peak Surge Current (Note 1) (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz, T <sub>L</sub> = 75°C)	I <sub>FSM</sub>	80	A
Operating and Storage Junction Temperature Range (Reverse Voltage Applied)	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C
Peak Operating Junction Temperature (Forward Current Applied)	T <sub>J(pk)</sub>	150	°C

1. Lead Temperature reference is cathode lead 1/32" from case.



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# SCHOTTKY BARRIER RECTIFIER 3.0 AMPERES 40 VOLTS



#### MARKING DIAGRAM



B340 = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBR340	Axial Lead	500 Units/Bag
MBR340RL	Axial Lead	1500/Tape & Reel

#### THERMAL CHARACTERISTICS

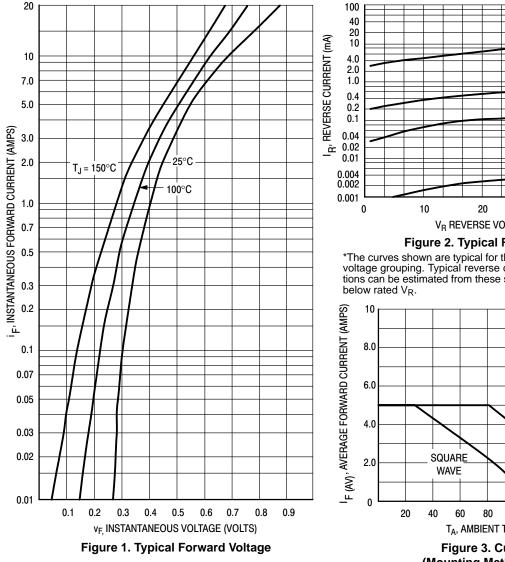
Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Ambient (see Note 4, Mounting Method 3)	$R_{\thetaJA}$	28	°C/W

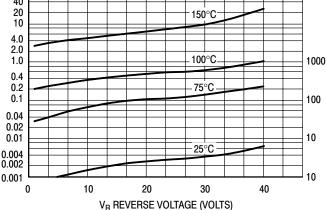
ELECTRICAL CHARACTERISTICS (T<sub>L</sub> = 25°C unless otherwise noted) (Note 2)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 3) ( $i_F = 1.0 \text{ Amp}$ ) ( $i_F = 3.0 \text{ Amp}$ ) ( $i_F = 9.4 \text{ Amp}$ )	VF	0.500 0.600 0.850	V
Maximum Instantaneous Reverse Current @ Rated dc Voltage (Note 3) $T_L = 25^{\circ}C$ $T_L = 100^{\circ}C$	İR	0.60 20	mA

2. Lead Temperature reference is cathode lead 1/32" from case.

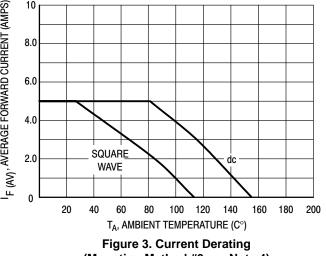
3. Pulse Test: Pulse Width = 300 µs, Duty Cycle = 2.0%.

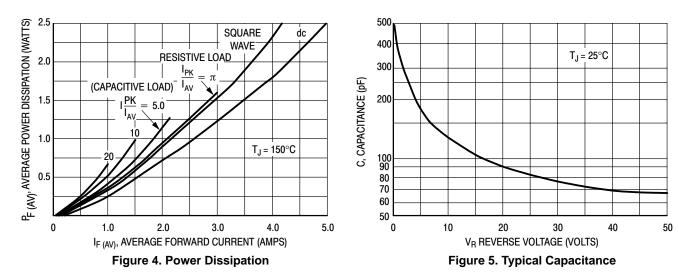






\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if  $V_R$  is sufficiently





#### NOTE 4 — MOUNTING DATA

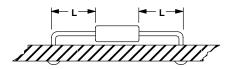
Data shown for thermal resistance junction-to-ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL	VALUES FOR	Rous IN	STILL AIR
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Mounting	Le				
Method	1/8	1/4	1/2	3/4	$R_{\theta JA}$
1	50	51	53	55	°C/W
2	58	59	61	63	°C/W
3	28			°C/W	

#### **Mounting Method 1**

P.C. Board where available copper surface is small.

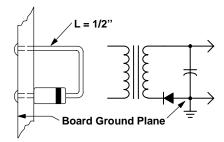


#### **Mounting Method 2**

Vector Push-In Terminals T-28

#### **Mounting Method 3**

P.C. Board with 2-1/2 " X 2-1/2" copper surface.



# MBR350, MBR360

MBR360 is a Preferred Device

# **Axial Lead Rectifiers**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Extremely Low v<sub>F</sub>
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Low Stored Charge, Majority Carrier Conduction
- Mechanical Characteristics:
- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 500 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- Marking: B350, B360

## MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MBR350 MBR360	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50 60	V
Average Rectified Forward Current $T_A = 65^{\circ}C (R_{\theta,JA} = 28^{\circ}C/W,$ P.C. Board Mounting)	Ι <sub>Ο</sub>	3.0	A
Non-Repetitive Peak Surge Current (Note 1) (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz, T <sub>L</sub> = 75°C)	I <sub>FSM</sub>	80	A
Operating and Storage Junction Temperature Range (Reverse Voltage Applied)	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C
Peak Operating Junction Temperature (Forward Current Applied)	T <sub>J(pk)</sub>	150	°C

1. Lead Temperature reference is cathode lead 1/32" from case.



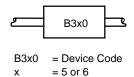
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# SCHOTTKY BARRIER RECTIFIERS 3.0 AMPERES 50, 60 VOLTS



## MARKING DIAGRAM



## ORDERING INFORMATION

Device	Package	Shipping
MBR350	Axial Lead	500 Units/Bag
MBR350RL	Axial Lead	1500/Tape & Reel
MBR360	Axial Lead	500 Units/Bag
MBR360RL	Axial Lead	1500/Tape & Reel

# MBR350, MBR360

#### THERMAL CHARACTERISTICS

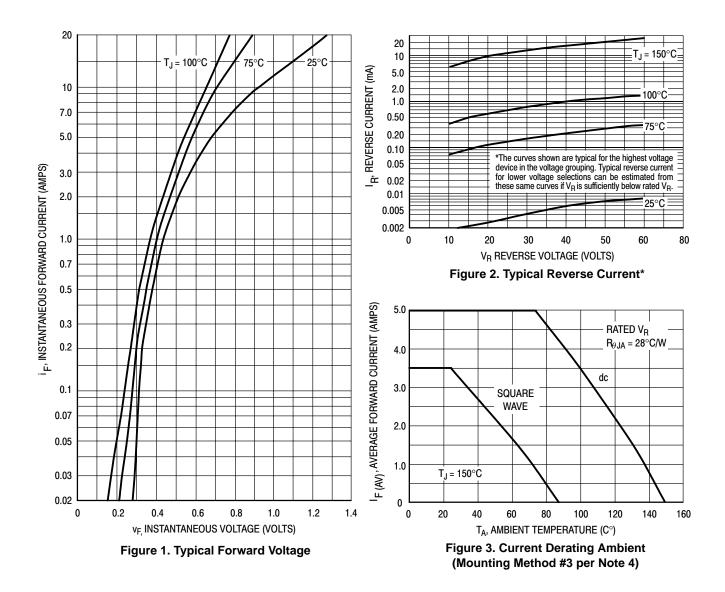
Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Ambient (see Note 4, Mounting Method 3)	$R_{\thetaJA}$	28	°C/W

ELECTRICAL CHARACTERISTICS (T<sub>L</sub> = 25°C unless otherwise noted) (Note 2)

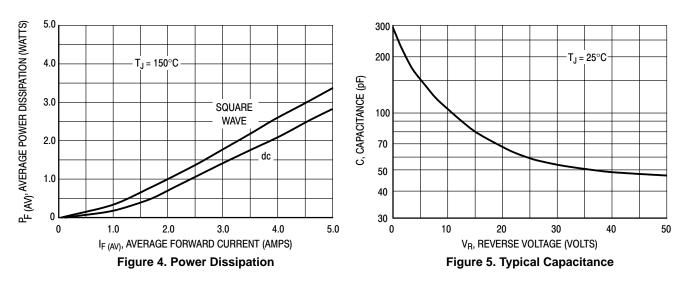
Characteristic	Symbol	Max	Unit
$\label{eq:maximum lnstantaneous Forward Voltage (Note 3)} \\ (i_F = 1.0 \mbox{ Amp}) \\ (i_F = 3.0 \mbox{ Amp}) \\ (i_F = 9.4 \mbox{ Amp}) \end{aligned}$	VF	0.600 0.740 1.080	V
Maximum Instantaneous Reverse Current @ Rated dc Voltage (Note 3) $T_L = 25^{\circ}C$ $T_L = 100^{\circ}C$	İR	0.60 20	mA

2. Lead Temperature reference is cathode lead 1/32" from case.

3. Pulse Test: Pulse Width = 300 μs, Duty Cycle = 2.0%.



## MBR350, MBR360



#### NOTE 4 — MOUNTING DATA

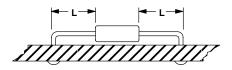
Data shown for thermal resistance junction-to-ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL	VALUES FOR	Rous IN	STILL AIR
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Mounting Lead Length, L (in)					
Method	1/8	1/4	1/2	3/4	$R_{\theta JA}$
1	50	51	53	55	°C/W
2	58	59	61	63	°C/W
3	28				°C/W

#### **Mounting Method 1**

P.C. Board where available copper surface is small.

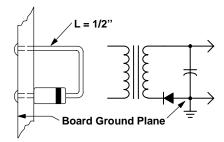


#### **Mounting Method 2**

Vector Push-In Terminals T-28

#### **Mounting Method 3**

P.C. Board with 2-1/2 " X 2-1/2" copper surface.



Preferred Device

# **Axial Lead Rectifier**

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlap contact. Ideally suited for use as rectifiers in low-voltage, high-frequency inverters, free wheeling diodes, and polarity protection diodes.

- Low Reverse Current
- Low Stored Charge, Majority Carrier Conduction
- Low Power Loss/High Efficiency
- Highly Stable Oxide Passivated Junction
- Guard-Ring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- High Surge Capacity

### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 500 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- Marking: B3100

#### MAXIMUM RATINGS

Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	V
Average Rectified Forward Current $T_A = 100^{\circ}C (R_{\theta,JA} = 28^{\circ}C/W,$ P.C. Board Mounting, see Note 2)	lo	3.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Operating and Storage Junction Temperature Range (Reverse Voltage Applied)	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10	V/ns



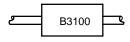
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# SCHOTTKY BARRIER RECTIFIER 3.0 AMPERES 100 VOLTS



### MARKING DIAGRAM



B3100 = Device Code

#### **ORDERING INFORMATION**

Device	vice Package Shipping	
MBR3100	Axial Lead	500 Units/Bag
MBR3100RL	Axial Lead	1500/Tape & Reel

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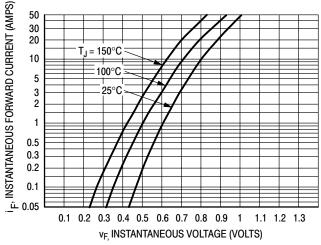
#### THERMAL CHARACTERISTICS

Characteristic		Max	Unit
Thermal Resistance, Junction to Ambient (see Note 2, Mounting Method 3)	$R_{\thetaJA}$	28	°C/W

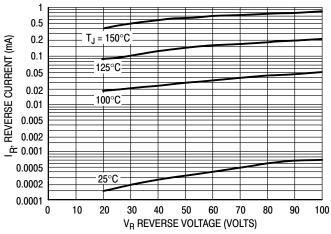
ELECTRICAL CHARACTERISTICS (T<sub>L</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 1) ( $i_F = 3.0 \text{ Amps}, T_L = 25^{\circ}\text{C}$ ) ( $i_F = 3.0 \text{ Amps}, T_L = 100^{\circ}\text{C}$ )	VF	0.79 0.69	V
Maximum Instantaneous Reverse Current @ Rated dc Voltage (Note 1) $T_L = 25^{\circ}C$ $T_L = 100^{\circ}C$	i <sub>R</sub>	0.6 20	mA

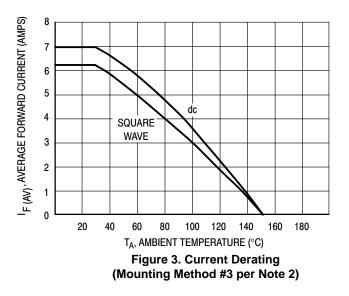
1. Pulse Test: Pulse Width = 300 µs, Duty Cycle = 2.0%.



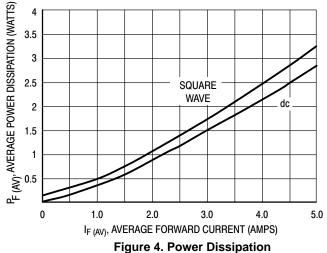


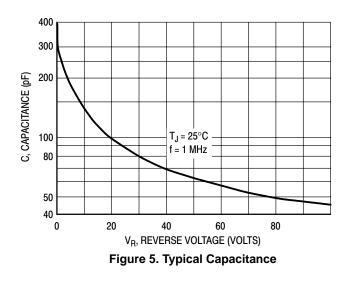






\*The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these curves if  $V_R$  is sufficient below rated  $V_R$ .





NOTE 2 — MOUNTING DATA

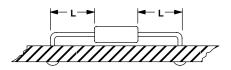
Data shown for thermal resistance junction-to-ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering, or in case the tie point temperature cannot be measured.

TYPICAL VALUES FOR  $\textbf{R}_{\theta \textbf{J}\textbf{A}}$  IN STILL AIR

Mounting Lead Length, L (in)					
Method	1/8	1/4	1/2	3/4	$R_{\theta JA}$
1	50	51	53	55	°C/W
2	58	59	61	63	°C/W
3	28				°C/W

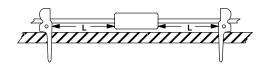
### **Mounting Method 1**

P.C. Board where available copper surface is small.



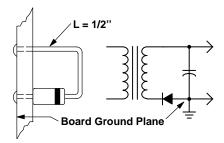
#### **Mounting Method 2**

Vector Push-In Terminals T-28



#### **Mounting Method 3**

P.C. Board with 2-1/2 " X 2-1/2" copper surface.



# MBR1535CT, MBR1545CT

MBR1545CT is a Preferred Device

# SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Center-Tap Configuration
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Mechanical Characteristics:
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1535, B1545

### MAXIMUM RATINGS

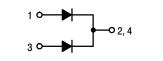
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Volta MBR1535CT MBR1545CT	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35 45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 105^{\circ}C$ ) Per Diode Per Device	I <sub>F(AV)</sub>	7.5 15	A
$\begin{array}{l} \mbox{Peak Repetitive Forward Current} \\ (Rated V_R, Square Wave, \\ 20 \mbox{ kHz}, T_C = 105^{\circ} C) & \mbox{Per Diode} \end{array}$	I <sub>FRM</sub>	15	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	1000	V/μs

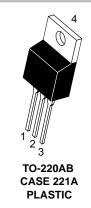


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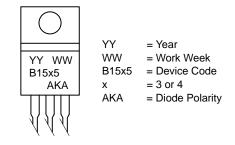
http://onsemi.com

SCHOTTKY BARRIER RECTIFIERS 15 AMPERES 35 and 45 VOLTS





#### MARKING DIAGRAM



## ORDERING INFORMATION

Device	Package	Shipping
MBR1535CT	TO-220	50 Units/Rail
MBR1545CT	TO-220	50 Units/Rail

# MBR1535CT, MBR1545CT

## THERMAL CHARACTERISTICS PER DIODE

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	$R_{\thetaJC}$	3.0	°C/W
Maximum Thermal Resistance, Junction to Ambient	$R_{\thetaJA}$	60	°C/W

## ELECTRICAL CHARACTERISTICS PER DIODE

	V <sub>F</sub>	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 125^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	15 0.1	mA

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq 2.0\%$ 

# MBR1535CT, MBR1545CT

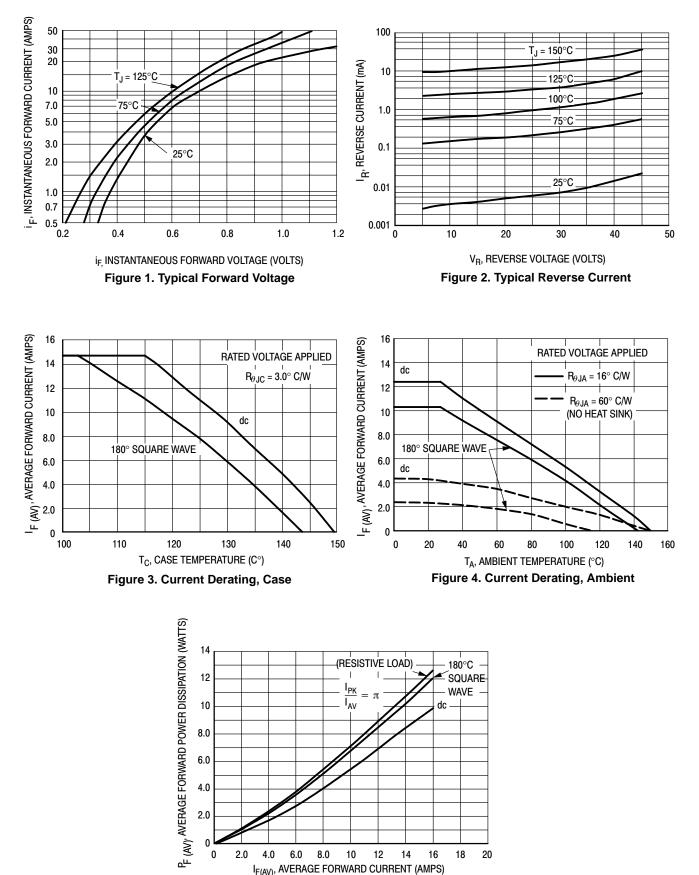


Figure 5. Power Dissipation

# **MBR16100CT**

# SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- 16 Amps Total (8.0 Amps Per Diode Leg)
- Guard-Ring for Stress Protection
- Low Forward Voltage
- 175°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Low Power Loss/High Efficiency
- High Surge Capacity
- Low Stored Charge Majority Carrier Conduction

### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B16100

#### MAXIMUM RATINGS (Per Diode Leg)

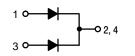
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	V
Average Rectified Forward Current (Rated V <sub>R</sub> ) T <sub>C</sub> = 133°C	I <sub>F(AV)</sub>	8.0	A
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz) T <sub>C</sub> = 133°C	I <sub>FRM</sub>	16	A
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	0.5	A
Operating Junction Temperature	TJ	- 65 to +175	°C
Storage Temperature	T <sub>stg</sub>	- 65 to +175	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs



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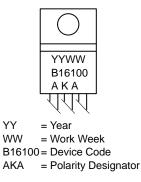
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## MARKING DIAGRAM



#### **ORDERING INFORMATION**

	Device Package		Shipping	
MB	R16100CT	TO-220	50 Units/Rail	

# **MBR16100CT**

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance - Junction to Case - Junction to Ambient	R <sub>θJC</sub> R <sub>θJA</sub>	2.0 60	°C/W
ELECTRICAL CHARACTERISTICS (Per Diode Leg)			
$\label{eq:maximum lnstantaneous Forward Voltage (Note 1) \\ (i_F = 8.0 \text{ Amps}, T_C = 125^\circ\text{C}) \\ (i_F = 8.0 \text{ Amps}, T_C = 25^\circ\text{C}) \\ (i_F = 16 \text{ Amps}, T_C = 125^\circ\text{C}) \\ (i_F = 16 \text{ Amps}, T_C = 25^\circ\text{C}) \\ (i_F = 16 \text{ Amps}, T_C = 25^\circ\text{C}) \\ \end{array}$	VF	0.6 0.74 0.69 0.84	Volts
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_C = 125^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	5.0 0.1	mA

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2%.

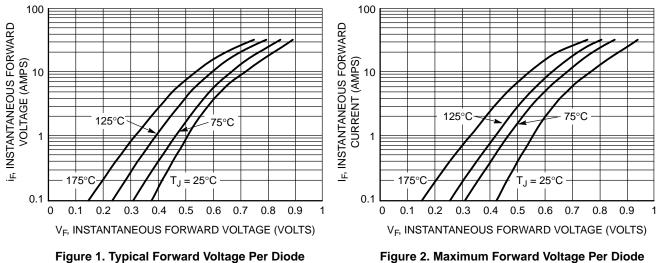


Figure 1. Typical Forward Voltage Per Diode

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# **MBR16100CT**

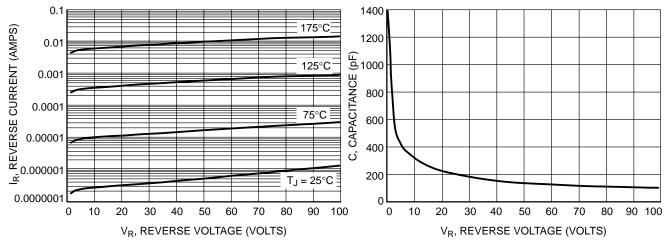
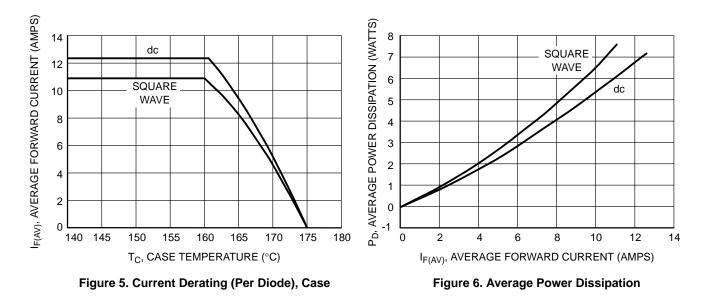




Figure 4. Typical Capacitance Per Diode



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# MBR2030CTL

Preferred Device

# SWITCHMODE<sup>™</sup> Dual Schottky Power Rectifier

... employing the Schottky Barrier principle in a large area metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop (0.4 Max @ 10 A,  $T_C = 150^{\circ}C$ )
- 150°C Operating Junction Temperature
- Matched Dual Die Construction (10 A per Leg or 20 A per Package)
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, VO at 1/8"

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2030

## MAXIMUM RATINGS

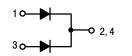
Please See the Table on the Following Page



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TO-220AB CASE 221A PLASTIC

#### MARKING DIAGRAM



B2030 = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBR2030CTL	TO-220	50 Units/Tube

# MBR2030CTL

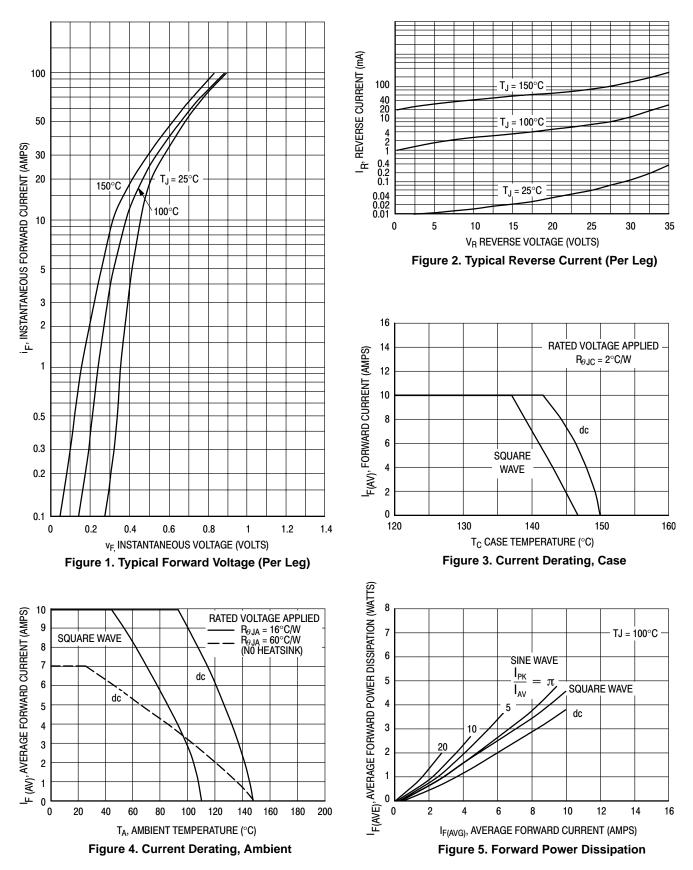
#### MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	Volts
Average Rectified Forward Current	I <sub>F(AV)</sub>	10	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	150	Amps
Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz)	I <sub>RRM</sub>	1.0	Amp
Operating Junction Temperature	TJ	-65 to +150	°C
Storage Temperature	T <sub>stg</sub>	-65 to +175	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	1000	V/µs
THERMAL CHARACTERISTICS (Per Leg)			
Thermal Resistance, Junction to Case	$R_{\theta JC}$	2.0	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)	· · · · ·		
Maximum Instantaneous Forward Voltage (Note 1.) (in = 10 Amps, To = 25°C)	V <sub>F</sub>	0.52	Volts

		0.52 0.40 0.58 0.48	
Maximum Instantaneous Reverse Current (Note 1.) (Rated DC Voltage, $T_C = 25^{\circ}C$ ) (Rated DC Voltage, $T_C = 100^{\circ}C$ ) (Rated DC Voltage, $T_C = 125^{\circ}C$ )	i <sub>R</sub>	5.0 40 75	mA

1. Pulse Test: Pulse Width = 5.0 ms, Duty Cycle  $\leq$  10%.

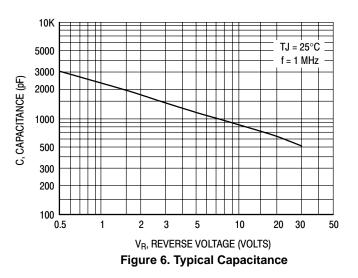
# MBR2030CTL



#### HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 6.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.



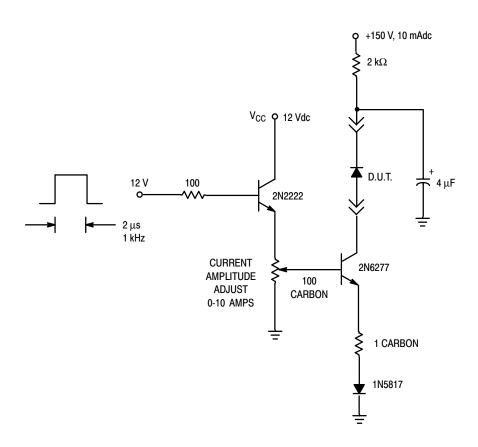


Figure 7. Test Circuit for dv/dt and Reverse Surge Current

Preferred Device

# SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2045

### MAXIMUM RATINGS

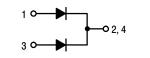
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 135°C)	I <sub>F(AV)</sub>	20	A
Peak Repetitive Forward Current per Diode Leg (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 135^{\circ}C$ )	I <sub>FRM</sub>	20	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz) See Figure 11	I <sub>RRM</sub>	1.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	1000	V/μs

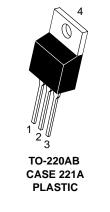


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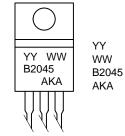
http://onsemi.com







### MARKING DIAGRAM



= Year

- = Work Week
- = Device Code = Diode Polarity

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBR2045CT	TO-220	50 Units/Rail

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Maximum Thermal Resistance, Junction to Case	$R_{ extsf{ heta}JC}$	2.0	°C/W

ELECTRICAL CHARACTERISTICS			
	VF	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 125^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	İR	15 0.1	mA

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

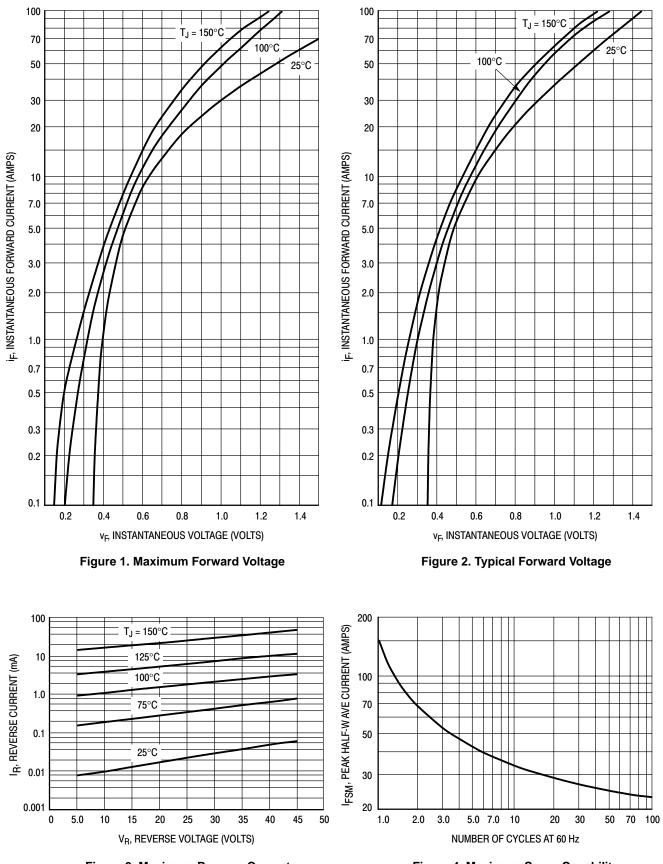
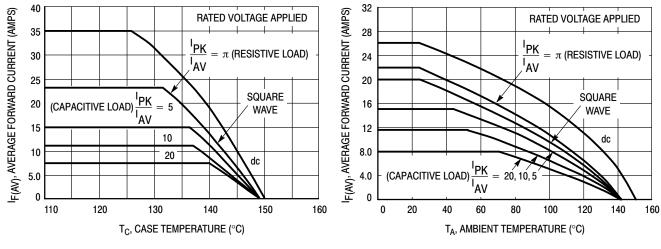


Figure 3. Maximum Reverse Current

Figure 4. Maximum Surge Capability







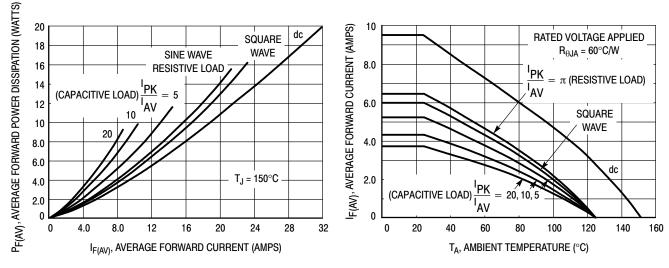


Figure 7. Forward Power Dissipation



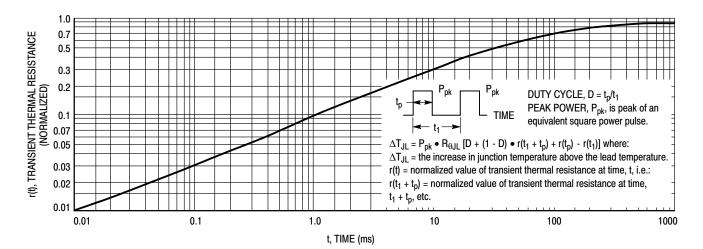


Figure 9. Thermal Response

#### HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10.)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.

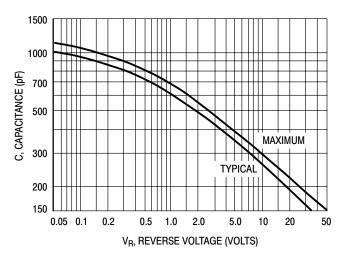


Figure 10. Capacitance

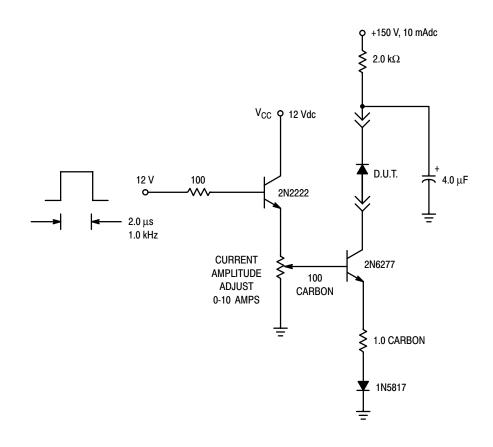


Figure 11. Test Circuit for dv/dt and Reverse Surge Current

# MBR2060CT, MBR2080CT, MBR2090CT, MBR20100CT

MBR2060CT and MBR20100CT are Preferred Devices

# SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- 20 Amps Total (10 Amps Per Diode Leg)
- Guard-Ring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Low Power Loss/High Efficiency
- High Surge Capacity
- Low Stored Charge Majority Carrier Conduction

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2060, B2080, B2090, B20100

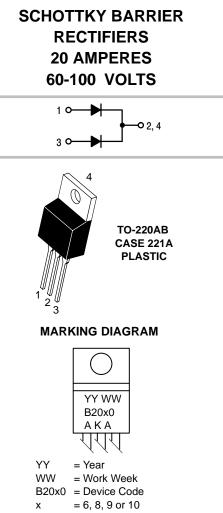
## MAXIMUM RATINGS

Please See the Table on the Following Page



## **ON Semiconductor**<sup>™</sup>

http://onsemi.com



AKA = Polarity Designator

#### **ORDERING INFORMATION**

Device	Package Shipping	
MBR2060CT	TO-220	50 Units/Rail
MBR2080CT	TO-220	50 Units/Rail
MBR2090CT	TO-220	50 Units/Rail
MBR20100CT	TO-220	50 Units/Rail

# MBR2060CT, MBR2080CT, MBR2090CT, MBR20100CT

		MBR				
Rating	Symbol	2060CT	2080CT	2090CT	20100CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	80	90	100	Volts
Average Rectified Forward Current (Rated $V_R$ ) T <sub>C</sub> = 133°C	I <sub>F(AV)</sub>	10				Amps
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz) $T_C = 133^{\circ}C$	I <sub>FRM</sub>	20				Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	150			Amps	
Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz)	I <sub>RRM</sub>	0.5			Amp	
Operating Junction Temperature	TJ	-65 to +150			°C	
Storage Temperature	T <sub>stg</sub>	-65 to +175			°C	
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000				V/µs
THERMAL CHARACTERISTICS						
Maximum Thermal Resistance — Junction to Case — Junction to Ambient	$R_{ extsf{ heta}JC} \ R_{ hetaJA}$	2.0 60			°C/W	
ELECTRICAL CHARACTERISTICS (Per Diode Leg)						
	VF	0.75 0.85 0.85 0.95			Volts	
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 125^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	6.0 0.1			mA	

MAXIMUM RATINGS (Per Diode Leg)

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

### MBR2060CT, MBR2080CT, MBR2090CT, MBR20100CT

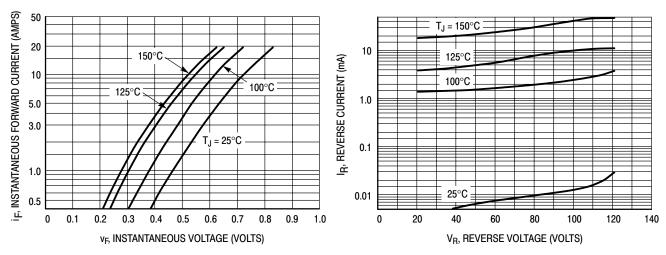


Figure 1. Typical Forward Voltage Per Diode

Figure 2. Typical Reverse Current Per Diode

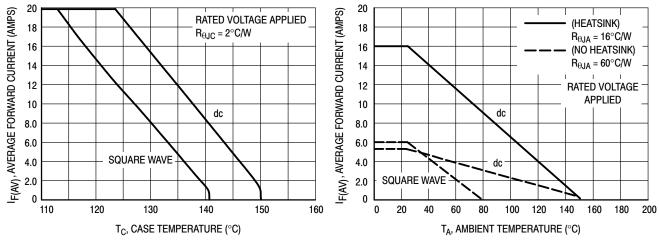
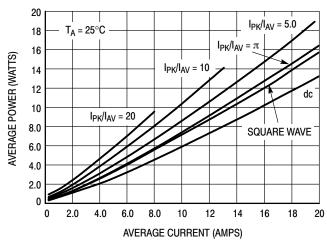
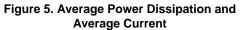


Figure 3. Current Derating, Case

Figure 4. Current Derating, Ambient





# **MBR20200CT**

## SWITCHMODE<sup>™</sup> Power

## **Dual Schottky Rectifier**

... using Schottky Barrier technology with a platinum barrier metal. This state-of-the-art device is designed for use in high frequency switching power supplies and converters with up to 48 volt outputs. They block up to 200 volts and offer improved Schottky performance at frequencies from 250 kHz to 5.0 MHz.

#### • 200 Volt Blocking Voltage

- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (10,000 V/µs)
- Dual Diode Construction Terminals 1 and 3 Must be Connected for Parallel Operation at Full Rating

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B20200

#### MAXIMUM RATINGS (Per Leg)

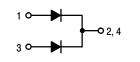
RatingSymtPeak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking VoltageVR VRW VRAverage Rectified Forward Current (Rated VR, TC = 125°C)IF(AN Per Leg Per PackagePeak Repetitive Forward CurrentIF(AN) PER	M 200 M 10 20	Unit V A
Working Peak Reverse Voltage $V_{RW}$ DC Blocking Voltage $V_R$ Average Rectified Forward Current (Rated $V_R$ , $T_C = 125^{\circ}C$ ) $Per Leg$ Per Package	/) 10 20	
(Rated $V_R$ , $T_C = 125^{\circ}C$ ) Per Leg Per Package	10 20	A
Peak Repetitive Forward Current		
per Leg (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 90°C)	M 20	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	M 150	A
Peak Repetitive Reverse Surge I <sub>RRI</sub> Current (2.0 μs, 1.0 kHz)	M 1.0	A
Storage Temperature Range T <sub>stg</sub>	-65 to +1	75 °C
Operating Junction Temperature T <sub>J</sub>	-65 to +1	50 °C
Voltage Rate of Change (Rated V <sub>R</sub> ) dv/c	it 10,000	V/μs



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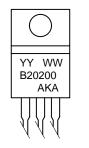




CASE 221A PLASTIC

#### MARKING DIAGRAM

YY



= Year WW = Work Week B20200 = Device Code = Diode Polarity AKA

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBR20200CT	TO-220	50 Units/Rail

## MBR20200CT

#### THERMAL CHARACTERISTICS (Per Leg)

Characteristic		Value	Unit
Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)			
$ \begin{array}{ll} \mbox{Maximum Instantaneous Forward Voltage (Note 1.)} & (I_F = 10 \mbox{ Amps}, \ T_C = 25^\circ C) \\ & (I_F = 10 \ \mbox{Amps}, \ T_C = 125^\circ C) \\ & (I_F = 20 \ \mbox{Amps}, \ T_C = 25^\circ C) \\ & (I_F = 20 \ \mbox{Amps}, \ T_C = 125^\circ C) \end{array} $	V <sub>F</sub>	0.9 0.8 1.0 0.9	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 25^{\circ}C$ ) (Rated dc Voltage, $T_C = 125^{\circ}C$ )	۱ <sub>R</sub>	1.0 50	mA
DYNAMIC CHARACTERISTICS (Per Leg)	·		
Capacitance ( $V_R$ = -5.0 V, $T_C$ = 25°C, Frequency = 1.0 MHz)	CT	500	pF

1. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .

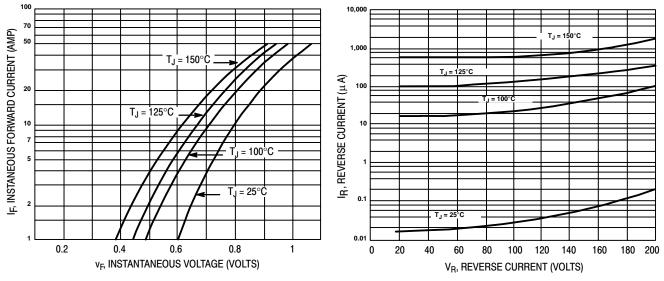


Figure 1. Typical Forward Voltage (Per Leg)

Figure 2. Typical Reverse Current (Per Leg)

## MBR20200CT

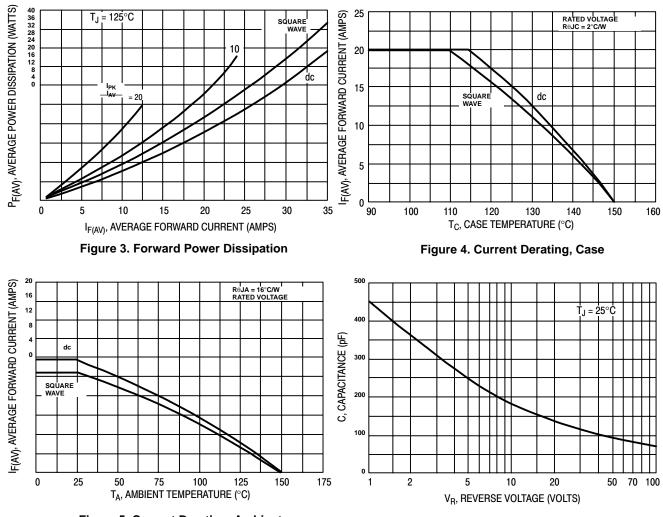


Figure 5. Current Derating, Ambient

Figure 6. Typical Capacitance (Per Leg)

# MBR2535CTL

# SWITCHMODE™ Power Rectifier

... employing the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, free wheeling diodes, and polarity protection diodes.

- Very Low Forward Voltage (0.55 V Maximum @ 25 Amps)
- Matched Dual Die Construction (12.5 A per Leg or 25 A per Package)
- Guardring for Stress Protection
- Highly Stable Oxide Passivated Junction (125°C Operating Junction Temperature)
- Epoxy Meets UL94, VO at 1/8"

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2535L

#### MAXIMUM RATINGS (Per Leg)

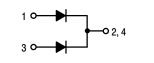
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35	V
Average Rectified Forward Current (Rated V <sub>R</sub> , T <sub>C</sub> = 110°C)	I <sub>F(AV)</sub>	12.5	A
Peak Repetitive Forward Current, per Leg (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 95°C)	I <sub>FRM</sub>	25	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions, Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Operating Junction Temperature	TJ	-65 to +125	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/μs
Controlled Avalanche Energy	Waval	20	mJ



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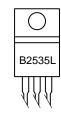






CASE 221A PLASTIC

#### MARKING DIAGRAM



B2535L = Device Code

#### ORDERING INFORMATION

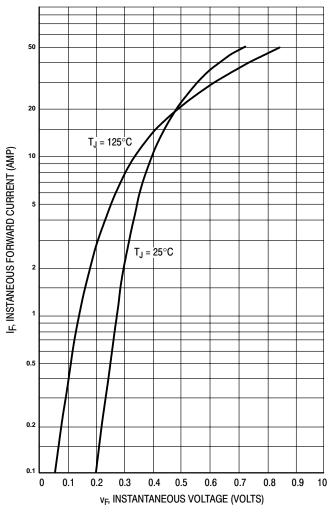
Device	Package	Shipping
MBR2535CTL	TO-220	50 Units/Rail

## MBR2535CTL

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance — Junction to Case	$R_{ extsf{ heta}JC}$	2.0	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)			
	V <sub>F</sub>	0.55 0.47 0.41	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 125^{\circ}C$ )	I <sub>R</sub>	5.0 500	mA

1. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .





## MBR2535CTL

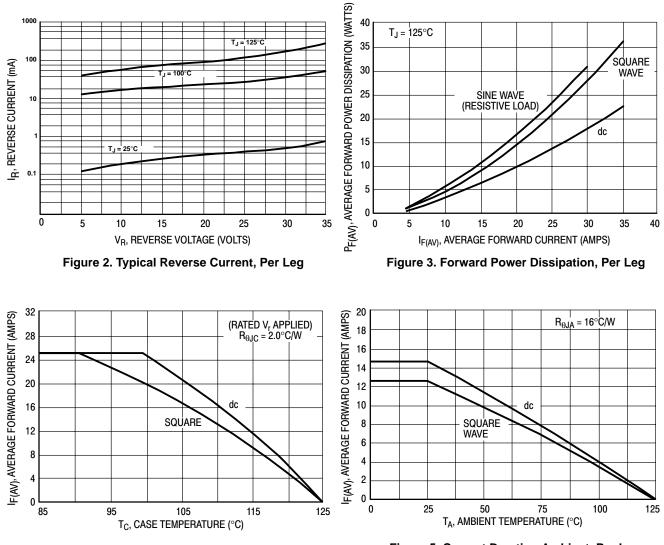


Figure 4. Current Derating

Figure 5. Current Derating Ambient, Per Leg

# MBR2545CTP

# SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2545P

#### MAXIMUM RATINGS

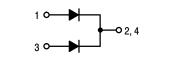
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
Average Rectified Forward Current (Rated V <sub>R</sub> , T <sub>C</sub> = 130°C)	I <sub>F(AV)</sub>	30	A
$\label{eq:result} \begin{array}{l} \mbox{Peak Repetitive Forward Current} \\ \mbox{(Rated V}_R, \mbox{Square Wave, 20 kHz,} \\ \mbox{T}_C = 130^\circ\mbox{C} \\ \end{array} \\ \begin{array}{l} \mbox{Per Diode Leg} \end{array}$	I <sub>FRM</sub>	30	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) Per Diode Leg	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/μs

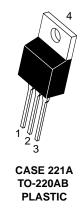


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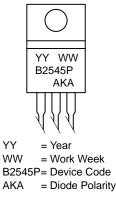
http://onsemi.com







#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

Device	Package	Shipping
MBR2545CTP	TO-220	50 Units/Rail

### MBR2545CTP

#### THERMAL CHARACTERISTICS (Per Diode Leg)

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	$R_{ extsf{ heta}JC}$	2.0	°C/W
FLECTRICAL CHARACTERISTICS (Per Diode Leg)			

ELECTRICAL CHARACTERISTICS (Per Diode Leg)			
	VF	0.73 0.82	Volts
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_C = 125^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	40 0.2	mA

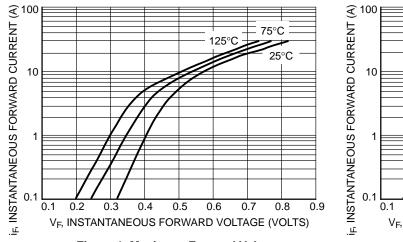
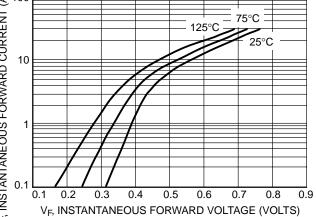


Figure 1. Maximum Forward Voltage



#### Figure 2. Typical Forward Voltage

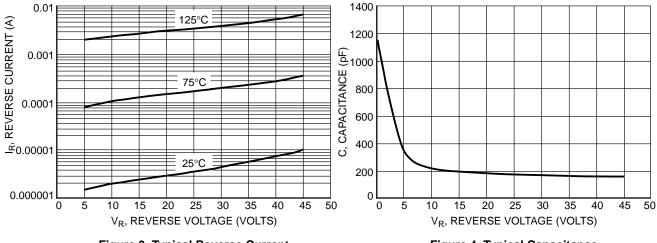
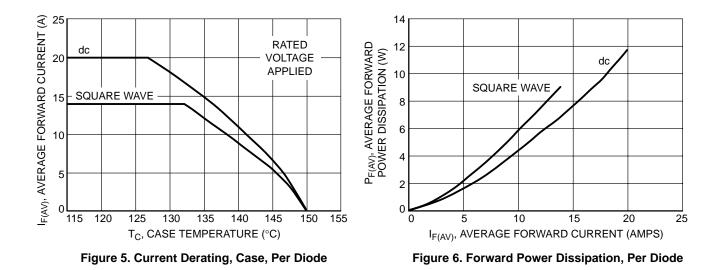


Figure 3. Typical Reverse Current

Figure 4. Typical Capacitance



# **MBR735, MBR745**

MBR745 is a Preferred Device

# SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B735, B745

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MBR735 MBR745	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35 45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 105°C)	I <sub>F(AV)</sub>	7.5	A
Peak Repetitive Forward Current, (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 105°C)	I <sub>FRM</sub>	15	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs



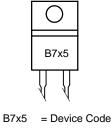
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http://onsemi.com

## SCHOTTKY BARRIER RECTIFIERS 7.5 AMPERES 35 and 45 VOLTS







# x = 3 or 4

### ORDERING INFORMATION

Device	Package	Shipping
MBR735	TO-220	50 Units/Rail
MBR745	TO-220	50 Units/Rail

## MBR735, MBR745

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	°C/W
Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	60	°C/W
ELECTRICAL CHARACTERISTICS			

	VF	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 125^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	15 0.1	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

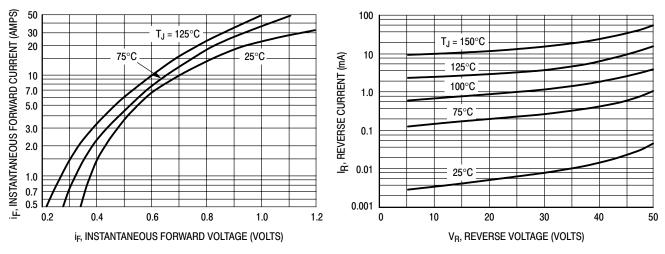


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

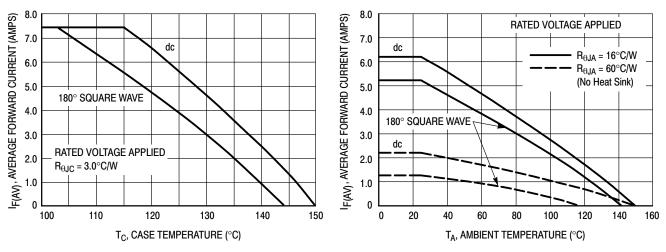




Figure 4. Current Derating, Ambient

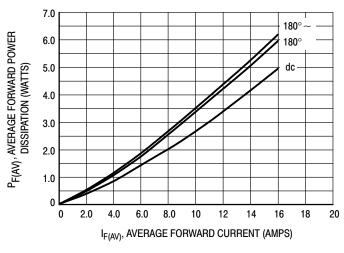


Figure 5. Power Dissipation

MBR1045 is a Preferred Device

# SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1035, B1045

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MBR1035 MBR1045	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35 45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 135°C)	I <sub>F(AV)</sub>	10	A
Peak Repetitive Forward Current, (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 135^{\circ}C$ )	I <sub>FRM</sub>	20	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz) See Figure 12	I <sub>RRM</sub>	1.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs



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## SCHOTTKY BARRIER RECTIFIERS 10 AMPERES 35 to 45 VOLTS







B10x5 = Device Code x = 3 or 4

### ORDERING INFORMATION

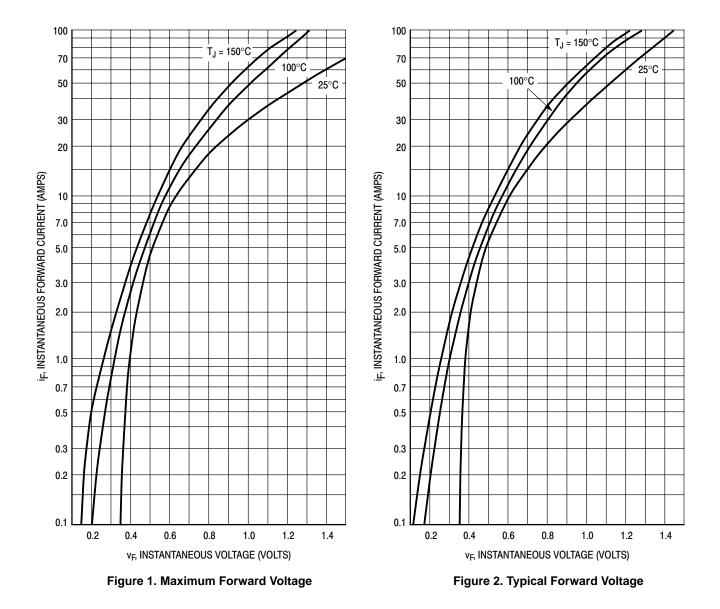
Device	Package	Shipping
MBR1035	TO-220	50 Units/Rail
MBR1045	TO-220	50 Units/Rail

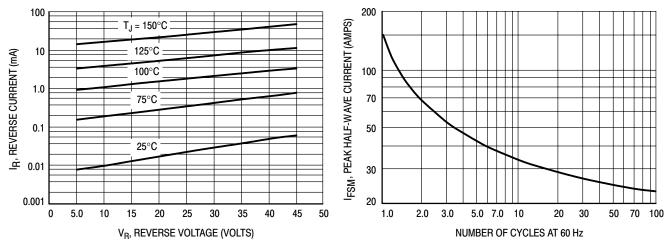
#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	$R_{ extsf{ heta}JC}$	2.0	°C/W
FLECTRICAL CHARACTERISTICS			

ELECTRICAL CHARACTERISTICS			
Maximum Instantaneous Forward Voltage (Note 1.) ( $i_F = 10 \text{ Amps}, \text{TC} = 125^{\circ}\text{C}$ ) ( $i_F = 20 \text{ Amps}, \text{T}_C = 125^{\circ}\text{C}$ ) ( $i_F = 20 \text{ Amps}, \text{T}_C = 25^{\circ}\text{C}$ )	VF	0.57 0.72 0.84	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 125^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	15 0.1	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.









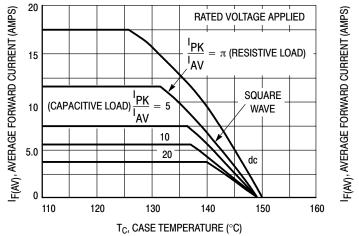
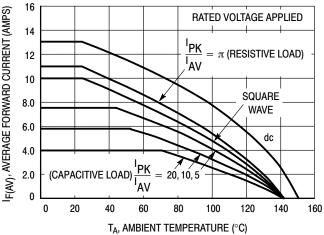


Figure 5. Current Derating, Infinite Heatsink





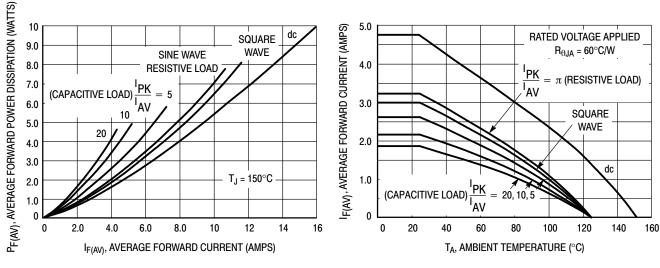


Figure 7. Forward Power Dissipation



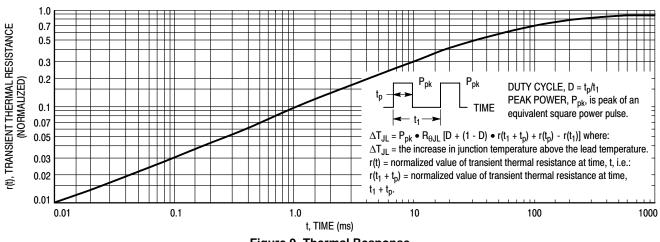
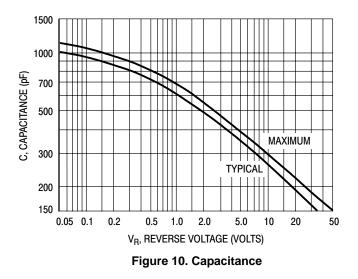


Figure 9. Thermal Response

#### HIGH FREQUENCY OPERATION

Since current flow in a Schottky rectifier is the result of majority carrier conduction, it is not subject to junction diode forward and reverse recovery transients due to minority carrier injection and stored charge. Satisfactory circuit analysis work may be performed by using a model consisting of an ideal diode in parallel with a variable capacitance. (See Figure 10)

Rectification efficiency measurements show that operation will be satisfactory up to several megahertz. For example, relative waveform rectification efficiency is approximately 70 percent at 2.0 MHz, e.g., the ratio of dc power to RMS power in the load is 0.28 at this frequency, whereas perfect rectification would yield 0.406 for sine wave inputs. However, in contrast to ordinary junction diodes, the loss in waveform efficiency is not indicative of power loss; it is simply a result of reverse current flow through the diode capacitance, which lowers the dc output voltage.



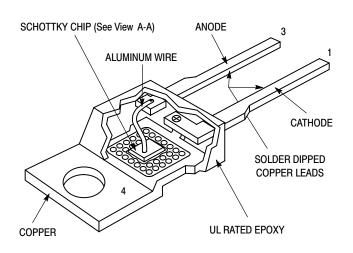
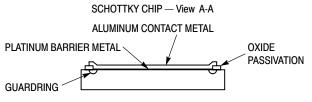


Figure 11. Schottky Rectifier



Motorola builds quality and reliability into its Schottky Rectifiers.

First is the chip, which has an interface metal between the barrier metal and aluminum-contact metal to eliminate any possible interaction between the two. The indicated guardring prevents dv/dt problems, so snubbers are not mandatory. The guardring also operates like a zener to absorb over-voltage transients.

Second is the package. The Schottky chip is bonded to the copper heat sink using a specially formulated solder. This gives the unit the capability of passing 10,000 operating thermal-fatigue cycles having a  $\Delta T_J$  of 100°C. The epoxy molding compound is rated per UL 94, V0 @ 1/8". Wire bonds are 100% tested in assembly as they are made.

Third is the electrical testing, which includes 100% dv/dt at 1600 V/ $\mu s$  and reverse avalanche as part of device characterization.

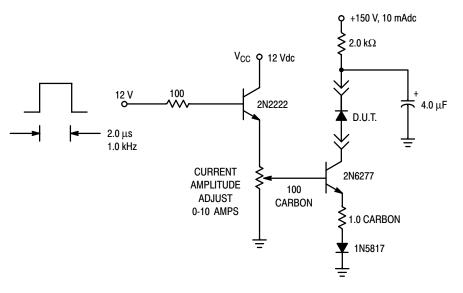


Figure 12. Test Circuit for dv/dt and Reverse Surge Current

# MBR1060, MBR1080, MBR1090, MBR10100

MBR1060 and MBR10100 are Preferred Devices

## SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guard-Ring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, VO at 1/8"
- Low Power Loss/High Efficiency
- High Surge Capacity
- Low Stored Charge Majority Carrier Conduction
- Mechanical Characteristics:
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1060, B1080, B1090, B10100

#### MAXIMUM RATINGS

Please See the Table on the Following Page



### ON Semiconductor<sup>™</sup>

http://onsemi.com

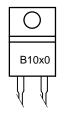
## SCHOTTKY BARRIER RECTIFIERS 10 AMPERES 60 to 100 VOLTS

3 0 0 1, 4



TO-220AC CASE 221B PLASTIC

#### MARKING DIAGRAM



B10x0 = Device Code x = 6, 8, 9 or 10

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBR1060	TO-220	50 Units/Rail
MBR1080	TO-220	50 Units/Rail
MBR1090	TO-220	50 Units/Rail
MBR10100	TO-220	50 Units/Rail

## MBR1060, MBR1080, MBR1090, MBR10100

#### MAXIMUM RATINGS

Define	0	MBR				
Rating	Symbol -	1060	1080	1090	10100	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	80	90	100	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C$ = 133°C	I <sub>F(AV)</sub>			10		Amps
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz) T <sub>C</sub> = 133°C	I <sub>FRM</sub>		2	20		Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>		1	50		Amps
Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz)	I <sub>RRM</sub>		C	).5		Amp
Operating Junction Temperature	TJ	- 65 to +150			°C	
Storage Temperature	T <sub>stg</sub> - 65 to +175			°C		
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000			V/µs	
THERMAL CHARACTERISTICS						
Maximum Thermal Resistance — Junction to Case — Junction to Ambient	R <sub>θJC</sub> R <sub>θJA</sub>	2.0 60			°C/W	
ELECTRICAL CHARACTERISTICS						
	VF	0.7 0.8 0.85 0.95		Volts		
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 125^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	6.0 0.10		mA		

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

### MBR1060, MBR1080, MBR1090, MBR10100

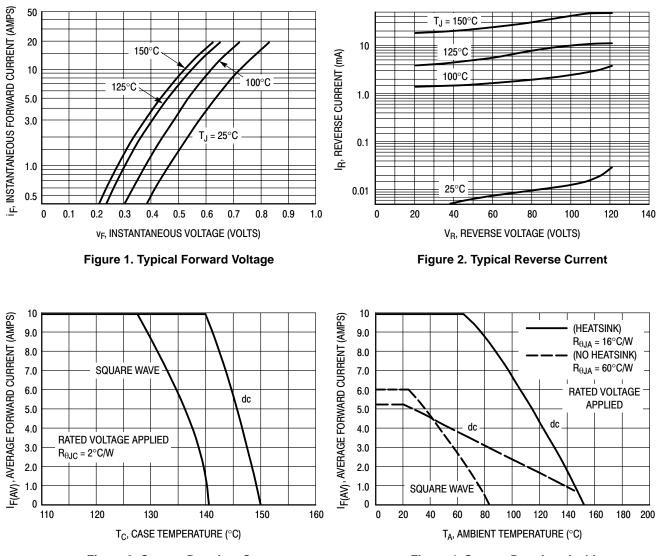


Figure 3. Current Derating, Case

Figure 4. Current Derating, Ambient

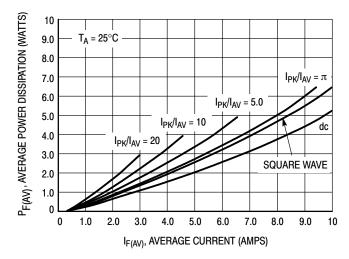


Figure 5. Forward Power Dissipation

MBR1645 is a Preferred Device

# SWITCHMODE™ Power Rectifiers

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B1635, B1645

#### MAXIMUM RATINGS

	1		
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MBR1635 MBR1645	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35 45	V
Average Rectified Forward Current (Rated V <sub>R</sub> , T <sub>C</sub> = 125°C)	I <sub>F(AV)</sub>	16	A
Peak Repetitive Forward Current, (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 125°C)	I <sub>FRM</sub>	32	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz)	I <sub>RRM</sub>	1.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )	dv/dt	10,000	V/μs

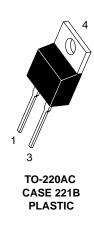


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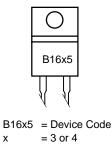
http://onsemi.com

## SCHOTTKY BARRIER RECTIFIERS 16 AMPERES 35 and 45 VOLTS





#### MARKING DIAGRAM



#### ORDERING INFORMATION

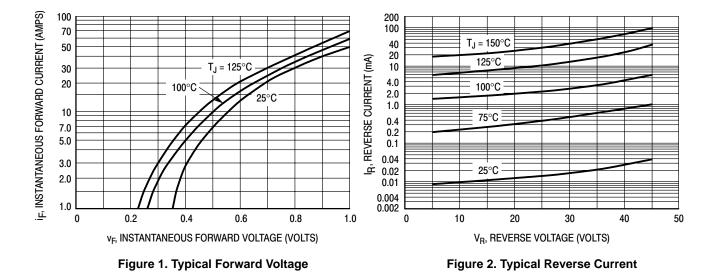
Device	Package	Shipping
MBR1635	TO-220	50 Units/Rail
MBR1645	TO-220	50 Units/Rail

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	$R_{ extsf{ heta}JC}$	1.5	°C/W

ELECTRICAL CHARACTERISTICS			
	VF	0.57 0.63	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 125^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	40 0.2	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



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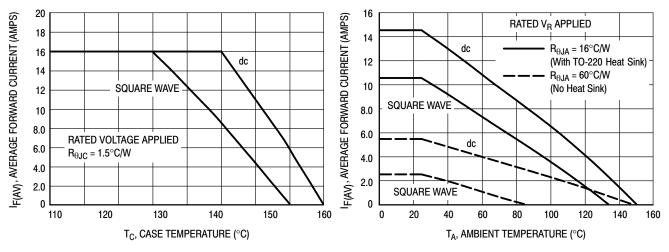




Figure 4. Current Derating, Ambient

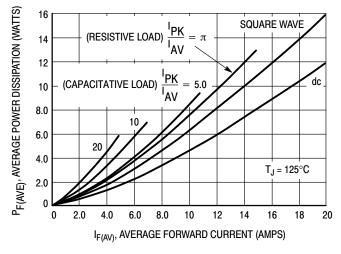


Figure 5. Forward Power Dissipation

# **MBR2515L**

# SWITCHMODE™ Power Rectifier

... employing the Schottky Barrier principle in a large metal-to-silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use in low voltage, high frequency switching power supplies, low voltage converters, OR'ing diodes, and polarity protection devices.

- Very Low Forward Voltage (0.28 V Maximum @ 19 Amps, 70°C)
- Guardring for Stress Protection
- Highly Stable Oxide Passivated Junction (100°C Operating Junction Temperature)
- Epoxy Meets UL94, VO at 1/8"

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 Units Per Plastic Tube
- Marking: B2515L

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	15	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 90^{\circ}C$ )	I <sub>F(AV)</sub>	25	A
Peak Repetitive Forward Current, per Leg (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 90°C)	I <sub>FRM</sub>	30	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	150	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	1.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +125	°C
Operating Junction Temperature	TJ	-65 to +100	°C

#### THERMAL CHARACTERISTICS

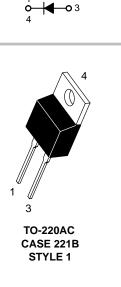
Thermal Resistance —	$R_{\theta JC}$	2.0	°C/W
Junction to Case			



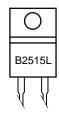
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## SCHOTTKY BARRIER RECTIFIER 25 AMPERES 15 VOLTS



#### MARKING DIAGRAM



B2515L = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBR2515L	TO-220	50 Units/Rail

## MBR2515L

### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 1) ( $i_F = 25 \text{ Amps}, T_J = 25^{\circ}C$ ) ( $i_F = 25 \text{ Amps}, T_J = 70^{\circ}C$ ) ( $i_F = 19 \text{ Amps}, T_J = 70^{\circ}C$ )	VF	0.45 0.42 0.38	Volts
Maximum Instantaneous Reverse Current (Note 1) (Rated DC Voltage, $T_J = 25^{\circ}C$ ) (Rated DC Voltage, $T_J = 70^{\circ}C$ )	۱ <sub>R</sub>	15 200	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

# MBRF2060CT

Preferred Device

# SWITCHMODE™ Schottky Power Rectifier

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal- to- silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369 (Note 1.)

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2060

#### MAXIMUM RATINGS

Please See the Table on the Following Page

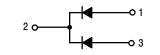
1. UL Recognized mounting method is per Figure 4



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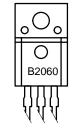






ISOLATED TO-220 CASE 221D STYLE 3

#### MARKING DIAGRAM



B2060 = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBRF2060CT	TO-220	50 Units/Rail

## MBRF2060CT

#### MAXIMUM RATINGS (Per Leg)

Rating		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	Volts
Average Rectified Forward Current (Rated $V_R$ ), $T_C$ = 133°C	Total Device	I <sub>F(AV)</sub>	10 20	Amps
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 133°C		I <sub>FRM</sub>	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)		I <sub>FSM</sub>	150	Amps
Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz)		I <sub>RRM</sub>	0.5	Amp
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )		dv/dt	10000	V/µs
RMS Isolation Voltage (t = 1.0 second, R.H. $\leq$ 30%, T_A = 25°C) (Note 2.) Per	Per Figure 3 Figure 4 (Note 1.) Per Figure 5	V <sub>iso1</sub> V <sub>iso2</sub> V <sub>iso3</sub>	4500 3500 1500	Volts

#### THERMAL CHARACTERISTICS (Per Leg)

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.0	°C/W
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	ΤL	260	°C

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Max	Unit
	VF	0.85 0.75 0.95 0.85	Volts
Maximum Instantaneous Reverse Current (Note 3.) (Rated DC Voltage, $T_C = 25^{\circ}C$ ) (Rated DC Voltage, $T_C = 125^{\circ}C$ )	i <sub>R</sub>	0.15 150	mA

1. UL Recognized mounting method is per Figure 42. Proper strike and creepage distance must be provided.3. Pulse Test: Pulse Width =  $300 \ \mu s$ , Duty Cycle  $\leq 2.0\%$ 

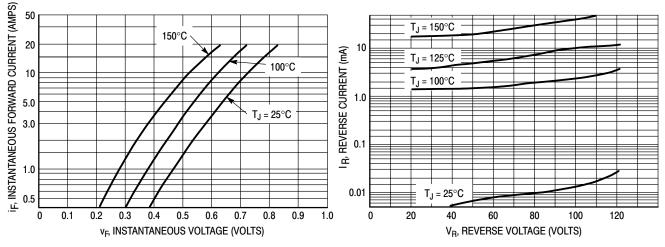


Figure 1. Typical Forward Voltage Per Diode



### MBRF2060CT

#### **TEST CONDITIONS FOR ISOLATION TESTS\***

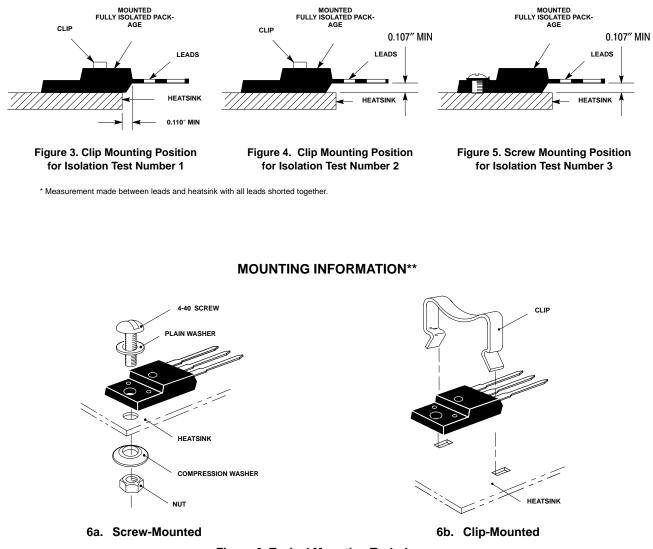


Figure 6. Typical Mounting Techniques

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of 20 in  $\cdot$  lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in  $\cdot$  lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, ON Semiconductor does not recommend exceeding 10 in  $\cdot$  lbs of mounting torque under any mounting conditions.

\*\*For more information about mounting power semiconductors see Application Note AN1040.

# MBRF20100CT

Preferred Device

# SWITCHMODE™ Schottky Power Rectifier

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal- to- silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369 (Note 1.)

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B20100

#### MAXIMUM RATINGS

Please See the Table on the Following Page

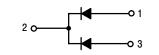
1. UL Recognized mounting method is per Figure 4



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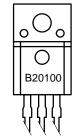






ISOLATED TO-220 CASE 221D STYLE 3

#### MARKING DIAGRAM



B20100 = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBRF20100CT	TO-220	50 Units/Rail

## **MBRF20100CT**

#### MAXIMUM RATINGS (Per Leg)

Rating		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	Volts
Average Rectified Forward Current (Rated $V_R$ ), $T_C$ = 133°C	Total Device	I <sub>F(AV)</sub>	10 20	Amps
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 133°C		I <sub>FRM</sub>	20	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)		I <sub>FSM</sub>	150	Amps
Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz)		I <sub>RRM</sub>	0.5	Amp
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )		dv/dt	10000	V/µs
RMS Isolation Voltage (t = 1.0 second, R.H. $\leq$ 30%, T_A = 25°C) (Note 2.) Per	Per Figure 3 Figure 4 (Note 1.) Per Figure 5	V <sub>iso1</sub> V <sub>iso2</sub> V <sub>iso3</sub>	4500 3500 1500	Volts

#### THERMAL CHARACTERISTICS (Per Leg)

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.5	°C/W
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds		260	°C

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 3.)	VF		Volts
(i <sub>F</sub> = 10 Amp, T <sub>C</sub> = 25°C)		0.85	
(i <sub>F</sub> = 10 Amp, T <sub>C</sub> = 125°C)		0.75	
$(i_F = 20 \text{ Amp}, T_C = 25^{\circ}C)$		0.95	
(i <sub>F</sub> = 20 Amp, T <sub>C</sub> = 125°C)		0.85	
Maximum Instantaneous Reverse Current (Note 3.)	i <sub>R</sub>		mA
(Rated DC Voltage, $T_C = 25^{\circ}C$ )		0.15	
(Rated DC Voltage, $T_C = 125^{\circ}C$ )		150	

1. UL Recognized mounting method is per Figure 42. Proper strike and creepage distance must be provided.3. Pulse Test: Pulse Width =  $300 \ \mu s$ , Duty Cycle  $\leq 2.0\%$ 

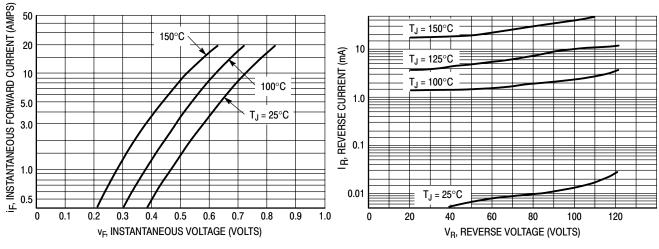


Figure 1. Typical Forward Voltage Per Diode

Figure 2. Typical Reverse Current Per Diode

### **MBRF20100CT**

#### **TEST CONDITIONS FOR ISOLATION TESTS\***

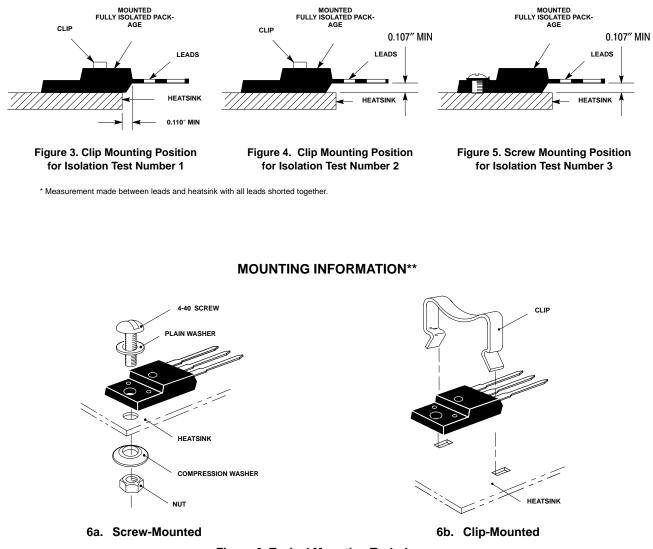


Figure 6. Typical Mounting Techniques

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of 20 in  $\cdot$  lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in  $\cdot$  lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, ON Semiconductor does not recommend exceeding 10 in  $\cdot$  lbs of mounting torque under any mounting conditions.

\*\*For more information about mounting power semiconductors see Application Note AN1040.

# MBRF20200CT

Preferred Device

# SWITCHMODE™ Schottky Power Rectifier

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal- to- silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B20200

#### MAXIMUM RATINGS

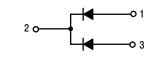
Please See the Table on the Following Page



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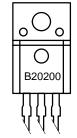






ISOLATED TO-220 CASE 221D STYLE 3

#### MARKING DIAGRAM



B20200 = Device Code

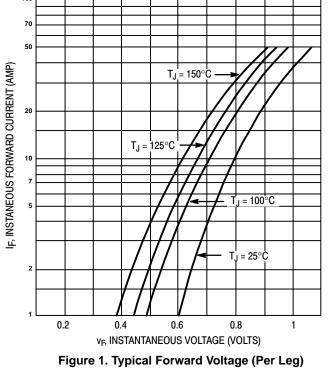
#### **ORDERING INFORMATION**

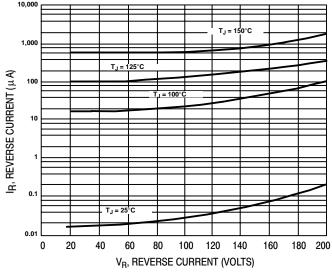
Device	Package	Shipping
MBRF20200CT	TO-220	50 Units/Rail

## MBRF20200CT

### MAXIMUM RATINGS (Per Leg)

Rating		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	Volts
Average Rectified Forward Current (Rated $V_R$ ) $T_C$ = 125°C	Per Leg Per Package	I <sub>F(AV)</sub>	10 20	Amps
Peak Repetitive Forward Current, Per Leg (Rated $V_R$ , Square Wave, 20 kHz) $T_C$ = 90°C		I <sub>FRM</sub>	20	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)		I <sub>FSM</sub>	150	Amps
Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz)		I <sub>RRM</sub>	1.0	Amp
Operating Junction Temperature and Storage Temperature		T <sub>J</sub> , T <sub>stg</sub>	- 65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )		dv/dt	10,000	V/µs
THERMAL CHARACTERISTICS (Per Leg)				
Thermal Resistance — Junction to Case		$R_{ extsf{ heta}JC}$	3.5	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg	)			
Rating		Symbol	Max	Unit
$\label{eq:maximum lnstantaneous Forward Voltage (Note (i_F = 10 Amp, T_C = 25^{\circ}C) (i_F = 10 Amp, T_C = 125^{\circ}C) (i_F = 20 Amp, T_C = 25^{\circ}C) (i_F = 20 Amp, T_C = 125^{\circ}C) \\ \end{tabular}$	1.)	VF	0.9 0.8 1.0 0.9	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 25^{\circ}C$ ) (Rated dc Voltage, $T_C = 125^{\circ}C$ )		İR	1.0 50	mA
DYNAMIC CHARACTERISTICS (Per Leg)		· ·		•
Capacitance (V <sub>R</sub> = -5.0 V, T <sub>C</sub> = 25°C, Freq. = 1.0 MHz)		CT	500	pF
1. Pulse Test: Pulse Width = 300 $\mu$ s, Duty Cycle $\leq$	2.0%	· ·		·
	10,000			
70			T 150°C	







### **MBRF20200CT**

#### **TEST CONDITIONS FOR ISOLATION TESTS\***

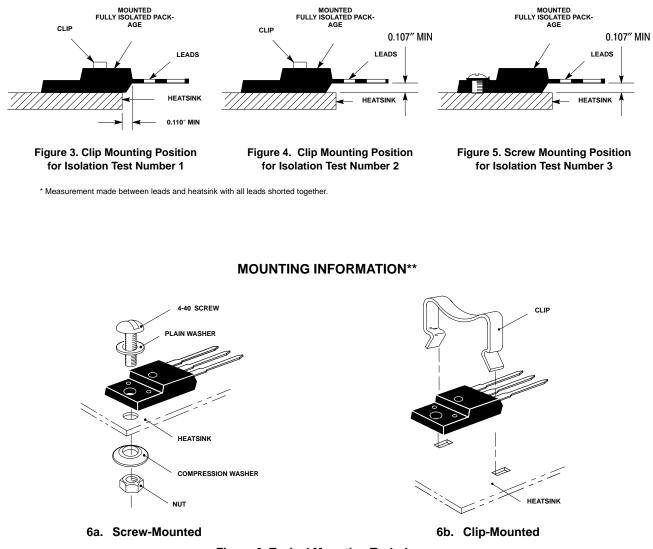


Figure 6. Typical Mounting Techniques

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of 20 in  $\cdot$  lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in  $\cdot$  lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, ON Semiconductor does not recommend exceeding 10 in  $\cdot$  lbs of mounting torque under any mounting conditions.

\*\*For more information about mounting power semiconductors see Application Note AN1040.

# MBRF2545CT

Preferred Device

# SWITCHMODE™ Schottky Power Rectifier

The SWITCHMODE Power Rectifier employs the Schottky Barrier principle in a large area metal- to- silicon power diode. State-of-the-art geometry features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for use as rectifiers in very low-voltage, high-frequency switching power supplies, free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Very Low Forward Voltage Drop
- Matched Dual Die Construction
- High Junction Temperature Capability
- High dv/dt Capability
- Excellent Ability to Withstand Reverse Avalanche Energy Transients
- Guardring for Stress Protection
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369 (Note 1.)

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: B2545

#### MAXIMUM RATINGS

Please See the Table on the Following Page

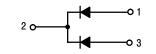
1. UL Recognized mounting method is per Figure 4



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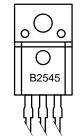






ISOLATED TO-220 CASE 221D STYLE 3

#### MARKING DIAGRAM



B2545 = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBRF2545CT	TO-220	50 Units/Rail

## MBRF2545CT

#### MAXIMUM RATINGS (Per Leg)

Rating		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	Volts
Average Rectified Forward Current (Rated $V_R$ ), $T_C$ = 125°CTo	otal Device	I <sub>F(AV)</sub>	12.5 25	Amps
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 125°C		I <sub>FRM</sub>	25	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)		I <sub>FSM</sub>	150	Amps
Peak Repetitive Reverse Surge Current (2.0 µs, 1.0 kHz)		I <sub>RRM</sub>	1.0	Amp
Operating Junction and Storage Temperature		T <sub>J</sub> , T <sub>stg</sub>	- 65 to +150	°C
Voltage Rate of Change (Rated V <sub>R</sub> )		dv/dt	10000	V/µs
RMS Isolation Voltage (t = 1.0 second, R.H. $\leq$ 30%, T <sub>A</sub> = 25°C) (Note 2.) Per Figu	Per Figure 3 re 4 (Note 1.) Per Figure 5	V <sub>iso1</sub> V <sub>iso2</sub> V <sub>iso3</sub>	4500 3500 1500	Volts

#### THERMAL CHARACTERISTICS (Per Leg)

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.5	°C/W
Maximum Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	ΤL	260	°C

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 3.)	٧ <sub>F</sub>		Volts
$(i_{F} = 12.5 \text{ Amps}, T_{C} = 25^{\circ}C)$		0.7	
(i <sub>F</sub> = 12.5 Amps, T <sub>C</sub> = 125°C)		0.62	
Maximum Instantaneous Reverse Current (Note 3.)	i <sub>R</sub>		mA
(Rated DC Voltage, $T_{C} = 25^{\circ}C$ )		0.2	
(Rated DC Voltage, $T_C = 125^{\circ}C$ )		40	

1. UL Recognized mounting method is per Figure 4

2. Proper strike and creepage distance must be provided.

3. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%

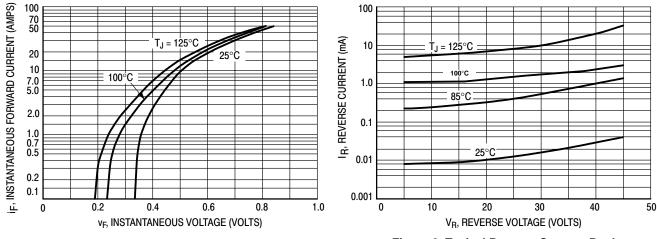


Figure 1. Typical Forward Voltage, Per Leg

Figure 2. Typical Reverse Current, Per Leg

## MBRF2545CT

#### **TEST CONDITIONS FOR ISOLATION TESTS\***

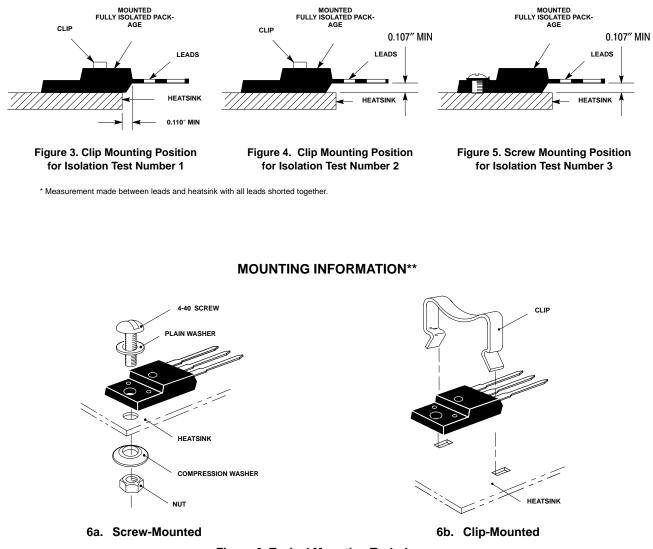


Figure 6. Typical Mounting Techniques

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of 20 in  $\cdot$  lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in  $\cdot$  lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, ON Semiconductor does not recommend exceeding 10 in  $\cdot$  lbs of mounting torque under any mounting conditions.

\*\*For more information about mounting power semiconductors see Application Note AN1040.

# **MBR3045PT**

Preferred Device

# SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction Terminals 1 and 3 may be Connected for Parallel Operation at Full Rating
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature

### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: B3045

## MAXIMUM RATINGS

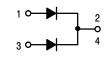
Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 105^{\circ}C$ ) Per Device Per Diode	I <sub>F(AV)</sub>	30 15	A
Peak Repetitive Forward Current, (Rated V <sub>R</sub> , Square Wave, 20 kHz) Per Diode	I <sub>FRM</sub>	30	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	200	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz) Per Diode See Figure 6	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Peak Surge Junction Temperature (Forward Current Applied)	T <sub>J(pk)</sub>	175	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs

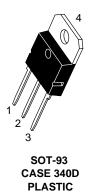


# ON Semiconductor\*\*

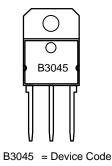
http://onsemi.com







### MARKING DIAGRAM



### ORDERING INFORMATION

Device	Package	Shipping
MBR3045PT	SOT-93	30 Units/Rail

**Preferred** devices are recommended choices for future use and best overall value.

## MBR3045PT

#### THERMAL CHARACTERISTICS PER DIODE

Rating	Symbol	Max	Unit
Thermal Resistance, Junction to Case	$R_{ extsf{ heta}JC}$	1.4	°C/W
Thermal Resistance, Junction to Ambient	$R_{ extsf{ heta}JA}$	40	°C/W

#### ELECTRICAL CHARACTERISTICS PER DIODE

Instantaneous Forward Voltage (Note 1.) ( $i_F = 20 \text{ Amps}, T_C = 125^{\circ}C$ ) ( $i_F = 30 \text{ Amps}, T_C = 125^{\circ}C$ ) ( $i_F = 30 \text{ Amps}, T_C = 25^{\circ}C$ )	VF	0.60 0.72 0.76	Volts
Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 125$ °C) (Rated dc Voltage, $T_C = 25$ °C)	i <sub>R</sub>	100 1.0	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

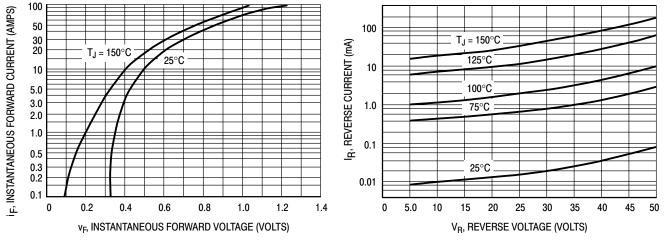
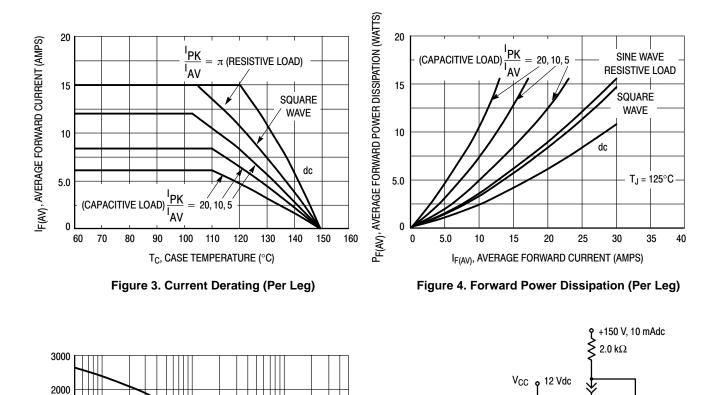


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

## MBR3045PT



12 V

2.0 µs

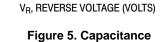
1.0 kHz

100

CURRENT

AMPLITUDE

ADJUST 0-10 AMPS



5.0

10

20

50

1.0 2.0

0.5

C, CAPACITANCE (pF)

600

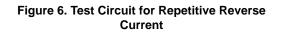
500

400

300

0.05 0.1

0.2



2N2222

 $100 \Omega$ 

CARBON

D.U.T.

2N6277

2

1.0 CARBON

1N5817

市 4.0 μF

# SWITCHMODE™ Power Rectifier

The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 45 Volt Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (> 10 V/ns)
- 150°C Operating Junction Temperature

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: B4045

### MAXIMUM RATINGS

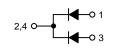
Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 125^{\circ}C$ ) Per Diode Per Device	I <sub>F(AV)</sub>	20 40	A
Peak Repetitive Forward Current, (Rated $V_R$ , Square Wave, 20 kHz @ T <sub>C</sub> = 90°C) Per Diode	I <sub>FRM</sub>	40	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	400	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Peak Surge Junction Temperature (Forward Current Applied)	T <sub>J(pk)</sub>	175	°C
Voltage Rate of Change	dv/dt	10,000	V/μs

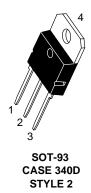


## ON Semiconductor<sup>™</sup>

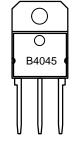
http://onsemi.com







#### MARKING DIAGRAM



B4045 = Device Code

## ORDERING INFORMATION

Device	Package	Shipping
MBR4045PT	SOT-93	30 Units/Rail

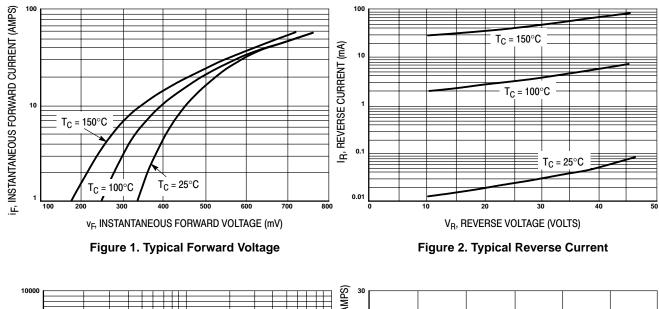
Semiconductor Components Industries, LLC, 2000 October, 2000 - Rev. 4

# MBR4045PT

#### THERMAL CHARACTERISTICS

Rating	Symbol	Мах	Unit
Thermal Resistance — Junction to Case	R <sub>θJC</sub>	1.4	°C/W
ELECTRICAL CHARACTERISTICS			
Instantaneous Forward Voltage (Note 1.) @ $I_F = 20 \text{ Amps}, T_C = 25^{\circ}C$ @ $I_F = 20 \text{ Amps}, T_C = 125^{\circ}C$ @ $I_F = 40 \text{ Amps}, T_C = 25^{\circ}C$ @ $I_F = 40 \text{ Amps}, T_C = 125^{\circ}C$	VF	0.70 0.60 0.80 0.75	Volts
Instantaneous Reverse Current (Note 1.) @ Rated DC Voltage, $T_C = 25^{\circ}C$ @ Rated DC Voltage, $T_C = 100^{\circ}C$	۱ <sub>R</sub>	1.0 50	mA

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq 2.0\%$ 



## **TYPICAL ELECTRICAL CHARACTERISTICS**

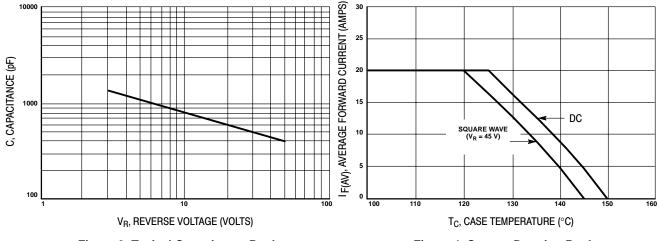




Figure 4. Current Derating Per Leg

# MBR6045PT

# SWITCHMODE™ Power Rectifier

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- Dual Diode Construction Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 45 Volt Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (> 10 V/ns)
- 150°C Operating Junction Temperature

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: MBR6045PT

### MAXIMUM RATINGS

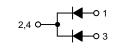
Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 125^{\circ}C$ ) Per Diode Per Device	I <sub>F(AV)</sub>	30 60	A
Peak Repetitive Forward Current, (Rated $V_R$ , Square Wave, 20 kHz @ T <sub>C</sub> = 90°C) Per Diode	I <sub>FRM</sub>	60	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	500	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Peak Surge Junction Temperature (Forward Current Applied)	T <sub>J(pk)</sub>	175	°C
Voltage Rate of Change	dv/dt	10,000	V/μs

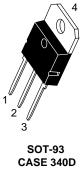


## ON Semiconductor<sup>™</sup>

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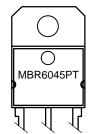
SCHOTTKY BARRIER RECTIFIER 60 AMPERES 45 VOLTS





STYLE 2

### MARKING DIAGRAM



MBR6045PT = Device Code

### ORDERING INFORMATION

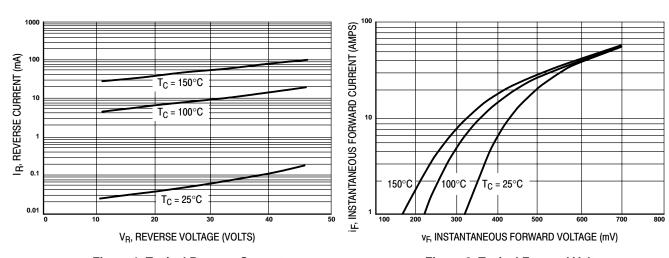
Device	Package	Shipping
MBR6045PT	SOT-93	30 Units/Rail

# MBR6045PT

#### THERMAL CHARACTERISTICS

Rating	Symbol	Мах	Unit
Thermal Resistance - Junction to Case	$R_{ extsf{ heta}JC}$	1.0	°C/W
ELECTRICAL CHARACTERISTICS			
Instantaneous Forward Voltage (Note 1.) @ $I_F = 30 \text{ Amps}, T_C = 25^{\circ}C$ @ $I_F = 30 \text{ Amps}, T_C = 125^{\circ}C$ @ $I_F = 60 \text{ Amps}, T_C = 25^{\circ}C$	V <sub>F</sub>	0.62 0.55 0.75	Volts
Instantaneous Reverse Current (Note 1.) @ Rated DC Voltage, T <sub>C</sub> = 25°C @ Rated DC Voltage, T <sub>C</sub> = 100°C	IR	1.0 50	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%



## **TYPICAL ELECTRICAL CHARACTERISTICS**

Figure 1. Typical Reverse Current

Figure 2. Typical Forward Voltage

# **MBR3045WT**

Preferred Device

# SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction Terminals 1 and 3 may be Connected for Parallel Operation at Full Rating
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Popular TO-247 Package

### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: B3045

## MAXIMUM RATINGS

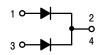
$\begin{tabular}{ c c c c } \hline Rating & Symbol & Max \\ \hline Peak Repetitive Reverse Voltage & V_{RRM} & V_{RVVM} & V_R & V_$	Unit
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	
(Rated $V_R$ , $T_C = 105^{\circ}C$ )Per Device Per Diode30 15Peak Repetitive Forward Current, (Rated $V_R$ , Square Wave, 20 kHz) Per DiodeIFRM30Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)IFSM200Peak Repetitive Reverse Current (2.0 $\mu$ s, 1.0 kHz) Per DiodeIRRM2.0	V
(Rated V <sub>R</sub> , Square Wave, 20 kHz) Per Diode       Item         Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)       IFSM       200         Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz) Per Diode See Figure 6       I <sub>RRM</sub> 2.0	A
(Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)       Image: Condition of the second	A
(2.0 μs, 1.0 kHz) Per Diode See Figure 6	A
	A
Storage Temperature Range T <sub>stg</sub> -65 to +	175 °C
Operating Junction Temperature T <sub>J</sub> -65 to +	150 °C
Peak Surge Junction Temperature (Forward Current Applied)         T <sub>J(pk)</sub> 175	°C
Voltage Rate of Change (Rated V <sub>R</sub> ) dv/dt 10,00	0 V/μs

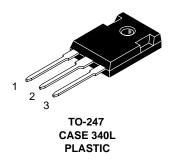


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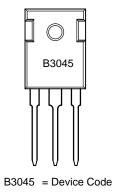
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## MARKING DIAGRAM



## ORDERING INFORMATION

Device	Package	Shipping
MBR3045WT	TO-247	30 Units/Rail

Preferred devices are recommended choices for future use and best overall value.

## **MBR3045WT**

#### THERMAL CHARACTERISTICS (Per Diode)

Rating	Symbol	Мах	Unit
Thermal Resistance — Junction to Case — Junction to Ambient	R <sub>θJC</sub> R <sub>θJA</sub>	1.4 40	°C/W
ELECTRICAL CHARACTERISTICS (Per Diode)	· · · · · ·		
Instantaneous Forward Voltage (Note 1.) ( $i_F = 20 \text{ Amps}, T_C = 125^{\circ}C$ ) ( $i_F = 30 \text{ Amps}, T_C = 125^{\circ}C$ ) ( $i_F = 30 \text{ Amps}, T_C = 25^{\circ}C$ )	VF	0.6 0.72 0.76	Volts
Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 125^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	İR	100 1.0	mA

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

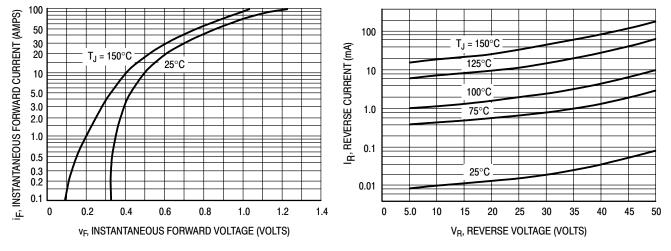


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

## **MBR3045WT**

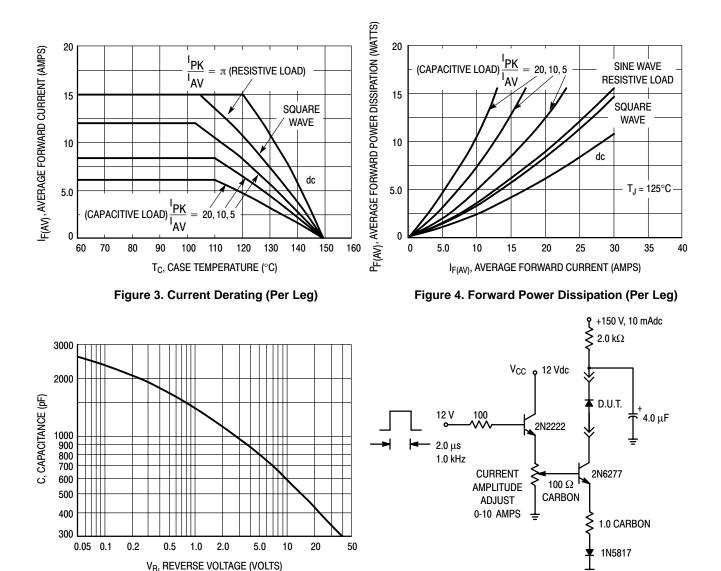


Figure 5. Capacitance

Figure 6. Test Circuit for Repetitive Reverse Current

# SWITCHMODE™ Schottky Power Rectifier

# **TO247 Power Package**

... employing the Schottky Barrier principle in a large area metal-to-silicon power rectifier. Features epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Highly Stable Oxide Passivated Junction
- Guardring for Over-Voltage Protection
- Low Forward Voltage Drop
- Monolithic Dual Die Construction. May Be Paralleled for High Current Output.
- Full Electrical Isolation without Additional Hardware

#### **Mechanical Characteristics:**

- Case: Molded Epoxy
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 30 Units Per Plastic Tube
- Marking: B4015L

### MAXIMUM RATINGS

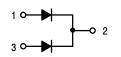
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	15	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 95^{\circ}C$ ) Per Leg Per Package	Ι <sub>Ο</sub>	20 40	A
$\begin{array}{l} \mbox{Peak Repetitive Forward Current,} \\ \mbox{(At Rated V}_{R}, \mbox{Square Wave,} \\ \mbox{20 kHz}, \mbox{T}_{C} = 95^{\circ}\mbox{C}) & \mbox{Per Leg} \end{array}$	I <sub>FRM</sub>	40	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) Per Package	I <sub>FSM</sub>	120	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to +100	°C
Operating Junction Temperature	TJ	-55 to +100	°C
Voltage Rate of Change (Rated $V_R$ , $T_J$ = 25°C)	dv/dt	10,000	V/µs

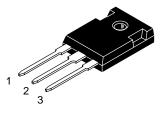


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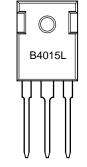






TO-247 CASE 340L STYLE 2

#### MARKING DIAGRAM



B4015L = Device Code

### ORDERING INFORMATION

Device	Package	Shipping
MBR4015LWT	TO-247	30 Units/Rail

#### THERMAL CHARACTERISTICS

Rating		Symbol	Va	lue	Unit
Thermal Resistance — Junction-to-Case — Junction-to-Ambient	Per Leg Per Leg	R <sub>θJC</sub> R <sub>θJA</sub>	-	57 i5	°C/W
ELECTRICAL CHARACTERISTICS					
Maximum Instantaneous Forward Voltage (Note 1.), See Figure 2	Per Leg	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	V
(I <sub>F</sub> = 20 A) (I <sub>F</sub> = 40 A)			0.42 0.50	0.36 0.48	
Maximum Instantaneous Reverse Current (Note 1.), See Figure 4	Per Leg	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	mA
(V <sub>R</sub> = 15 V) (V <sub>R</sub> = 7.5 V)			5.0 2.7	530 370	

1. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2%.

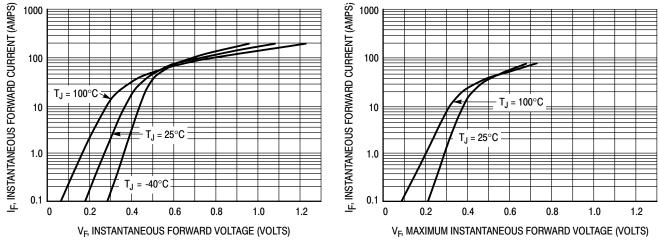


Figure 1. Typical Forward Voltage Per Leg

Figure 2. Maximum Forward Voltage Per Leg

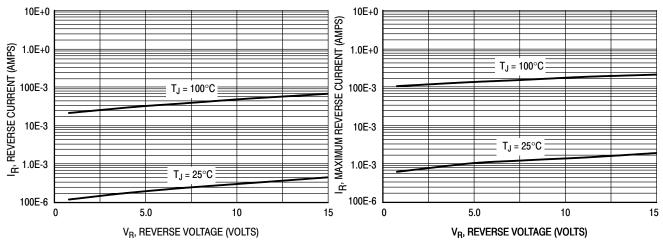
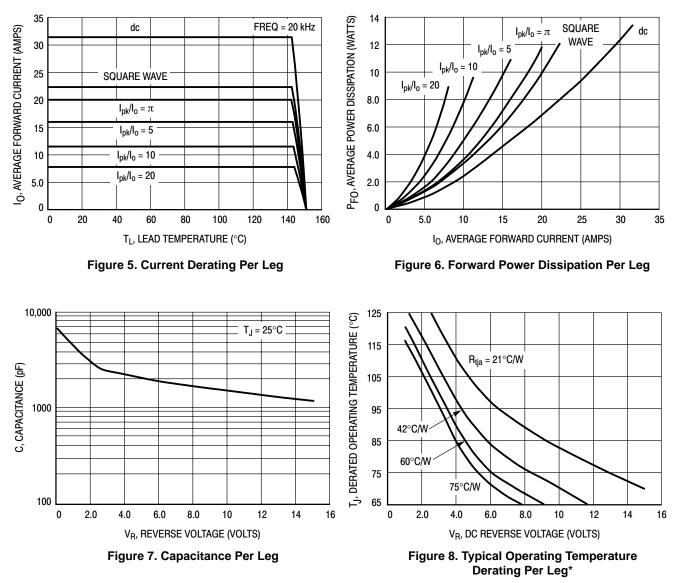


Figure 3. Typical Reverse Current Per Leg

Figure 4. Maximum Reverse Current Per Leg



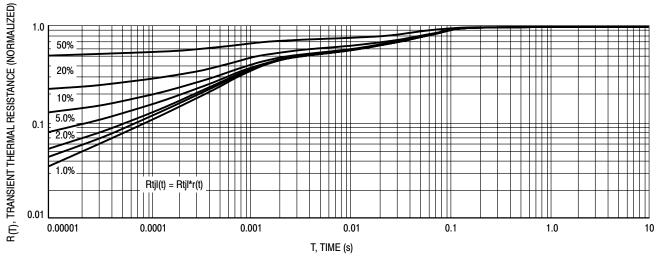
\* Reverse power dissipation and the possibility of thermal runaway must be considered when operating this device under any reverse voltage conditions. Calculations of TJ therefore must include forward and reverse power effects. The allowable operating T<sub>.</sub> may be calculated from the equation:

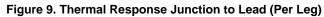
 $T_J = T_{Jmax} - r(t)(Pf + Pr)$  where

r(t) = thermal impedance under given conditions,

Pf = forward power dissipation, and Pr = reverse power dissipation

This graph displays the derated allowable  $T_J$  due to reverse bias under DC conditions only and is calculated as  $T_J = T_{Jmax} - r(t)Pr$ , where r(t) = Rthja. For other power applications further calculations must be performed.





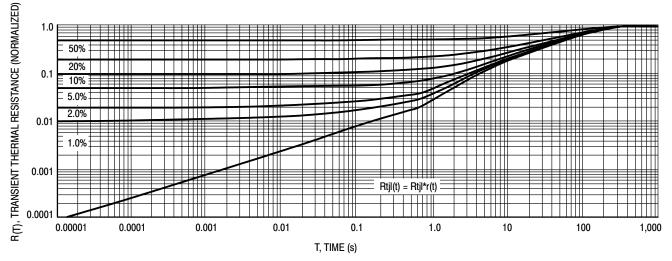


Figure 10. Thermal Response Junction to Ambient (Per Leg)

# **MBR4045WT**

# SWITCHMODE™ Power Rectifier

The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 45 Volt Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (> 10 V/ns)
- 150°C Operating Junction Temperature

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: B4045

### MAXIMUM RATINGS

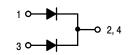
Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 125^{\circ}C$ ) Per Diode Per Device	I <sub>F(AV)</sub>	20 40	A
$\begin{array}{l} \mbox{Peak Repetitive Forward Current,} \\ (Rated V_R, Square Wave, \\ 20 \mbox{ kHz}, T_C = 90 \mbox{°C}) & \mbox{Per Diode} \end{array}$	I <sub>FRM</sub>	40	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	400	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Peak Surge Junction Temperature (Forward Current Applied)	T <sub>J(pk)</sub>	175	°C
Voltage Rate of Change	dv/dt	10,000	V/μs

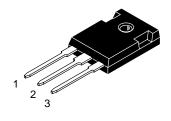


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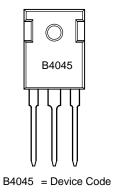






TO-247AC CASE 340L STYLE 2

#### MARKING DIAGRAM



### ORDERING INFORMATION

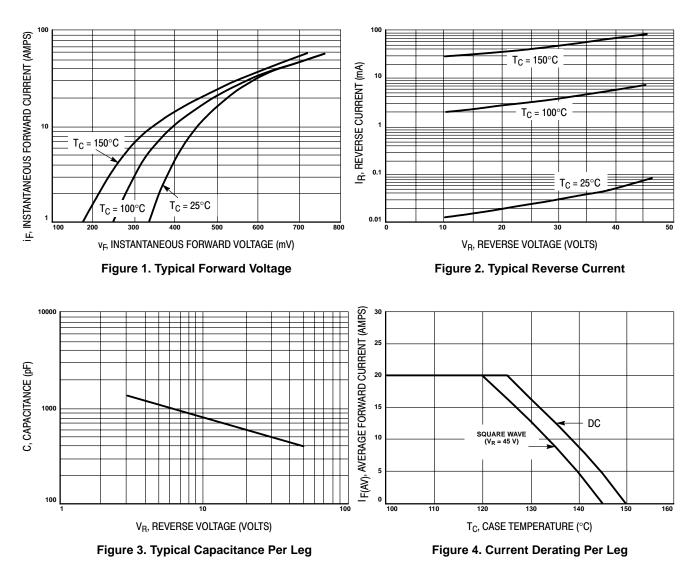
Device	Package	Shipping
MBR4045WT	TO-247	30 Units/Rail

## **MBR4045WT**

#### THERMAL CHARACTERISTICS (Per Diode)

Rating	Symbol	Max	Unit
Thermal Resistance — Junction to Case	R <sub>θJC</sub>	1.4	°C/W
ELECTRICAL CHARACTERISTICS (Per Diode)			
Instantaneous Forward Voltage (Note 1.) @ $I_F = 20 \text{ Amps}, T_C = 25^{\circ}C$ @ $I_F = 20 \text{ Amps}, T_C = 125^{\circ}C$ @ $I_F = 40 \text{ Amps}, T_C = 25^{\circ}C$ @ $I_F = 40 \text{ Amps}, T_C = 125^{\circ}C$	V <sub>F</sub>	0.70 0.60 0.80 0.75	Volts
Instantaneous Reverse Current (Note 1.) @ Rated DC Voltage, T <sub>C</sub> = 25°C @ Rated DC Voltage, T <sub>C</sub> = 100°C	I <sub>R</sub>	1.0 50	mA

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle < 2.0%



## **TYPICAL ELECTRICAL CHARACTERISTICS**

# MBR6045WT

# SWITCHMODE™ Power Rectifier

The SWITCHMODE power rectifier employs the use of the Schottky Barrier principle with a Platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction Terminals 1 and 3 May Be Connected for Parallel Operation at Full Rating
- 45 Volt Blocking Voltage
- Low Forward Voltage Drop
- Guardring for Stress Protection and High dv/dt Capability (> 10 V/ns)
- 150°C Operating Junction Temperature

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 Units Per Plastic Tube
- Marking: MBR6045WT

### MAXIMUM RATINGS

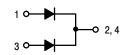
Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 125^{\circ}C$ ) Per Diode Per Device	I <sub>F(AV)</sub>	30 60	A
$\begin{array}{l} \mbox{Peak Repetitive Forward Current,} \\ (Rated V_R, Square Wave, \\ 20 \mbox{ kHz}, T_C = 90 \mbox{°C}) & \mbox{Per Diode} \end{array}$	I <sub>FRM</sub>	60	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	500	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C
Operating Junction Temperature	TJ	-65 to +150	°C
Peak Surge Junction Temperature (Forward Current Applied)	T <sub>J(pk)</sub>	175	°C
Voltage Rate of Change	dv/dt	10,000	V/µs

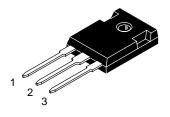


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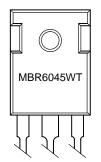






TO-247AC CASE 340L STYLE 2

### MARKING DIAGRAM



MBR6045WT = Device Code

#### ORDERING INFORMATION

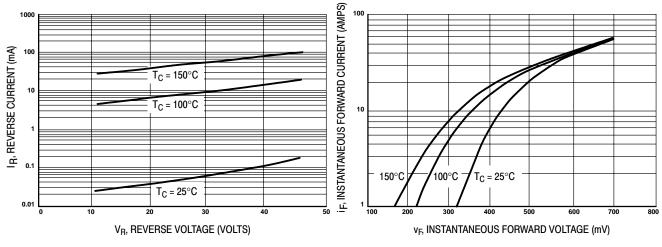
Device	Package	Shipping
MBR6045WT	TO-247	30 Units/Rail

# **MBR6045WT**

### THERMAL CHARACTERISTICS (Per Diode)

Rating	Symbol	Мах	Unit
Thermal Resistance - Junction to Case	$R_{ extsf{ heta}JC}$	1.0	°C/W
ELECTRICAL CHARACTERISTICS (Per Diode)			
Instantaneous Forward Voltage (Note 1.) @ $I_F = 30 \text{ Amps}, T_C = 25^{\circ}C$ @ $I_F = 30 \text{ Amps}, T_C = 125^{\circ}C$ @ $I_F = 60 \text{ Amps}, T_C = 25^{\circ}C$	V <sub>F</sub>	0.62 0.55 0.75	Volts
Instantaneous Reverse Current (Note 1.) @ Rated DC Voltage, T <sub>C</sub> = 25°C @ Rated DC Voltage, T <sub>C</sub> = 100°C	۱ <sub>R</sub>	1.0 50	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle < 2.0%



## **TYPICAL ELECTRICAL CHARACTERISTICS**

Figure 1. Typical Reverse Current

Figure 2. Typical Forward Voltage

Preferred Device

# POWERTAP™ II SWITCHMODE™ Power Rectifier

The SWITCHMODE Power Rectifier uses the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 150°C Operating Junction Temperature
- Recyclable Epoxy
- Guaranteed Reverse Avalanche Energy Capability
- Improved Mechanical Ratings

#### **Mechanical Characteristics**

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25 40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B20030L

#### MAXIMUM RATINGS

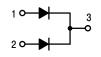
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 125$ °C) Per Leg Per Device	I <sub>F(AV)</sub>	100 200	A
Peak Repetitive Forward Current, (At Rated $V_R$ , Square Wave, 20 kHz, $T_C = 100^{\circ}C$ )	I <sub>FRM</sub>	200	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	1500	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Operating Junction Temperature	Т <sub>Ј</sub>	-55 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs



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# LOW V<sub>F</sub> SCHOTTKY BARRIER RECTIFIER 200 AMPERES 30 VOLTS





### MARKING DIAGRAM



B20030L = Device Code YY = Year WW = Work Week

### ORDERING INFORMATION

Device	Package	Shipping
MBRP20030CTL	POWERTAP II	25 Units/Tray

**Preferred** devices are recommended choices for future use and best overall value.

#### THERMAL CHARACTERISTICS

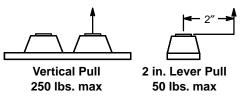
Rating	Symbol	Value	Unit
Thermal Resistance — Junction to Case	$R_{ extsf{ heta}JC}$	0.45	°C/W
ELECTRICAL CHARACTERISTICS			
$\label{eq:linear} \begin{array}{l} \mbox{Maximum Instantaneous Forward Voltage (Note 1.)} \\ (I_F = 200 \mbox{ Amps, } T_C = +125^\circ C) \\ (I_F = 200 \mbox{ Amps, } T_C = +25^\circ C) \end{array}$	V <sub>F</sub>	0.52 0.60	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, T <sub>C</sub> = +25°C)	۱ <sub>R</sub>	5.0	mA

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2%.

#### MAXIMUM MECHANICAL RATINGS

Terminal Penetration:	0.235 max
Terminal Torque:	25-40 in-lb max
Mounting Torque — Outside Holes:	30-40 in-lb max
Mounting Torque — Center Hole:	8-10 in-lb max
Seating Plane Flatness	1 mil per in. (between mounting holes)

#### POWERTAP MECHANICAL DATA APPLIES OVER OPERATING TEMPERATURE



Note: While the POWERTAP is capable of sustaining these vertical and levered tensions, the intimate contact between POWERTAP and heat sink may be lost. This could lead to thermal runaway. The use of very flexible leads is recommended for the anode connections. Use of thermal grease is highly recommended.

## MOUNTING PROCEDURE

The POWERTAP package requires special mounting considerations because of the long longitudinal axis of the copper heat sink. It is important to follow the proper tightening sequence to avoid warping the heat sink, which can reduce thermal contact between the POWERTAP and heat sink.

### STEP 1:

Locate the POWERTAP on the heat sink and start mounting bolts into the threads by hand (2 or 3 turns).

## **STEP 2:**

Finger tighten the center bolt. The bolt may catch on the threads of the heat sink so it is important to make sure the face of the bolt or washer is in contact with the surface of the POWERTAP.

### **STEP 3:**

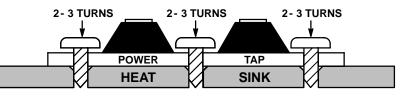
Tighten each of the end bolts between 5 to 10 in-lb.

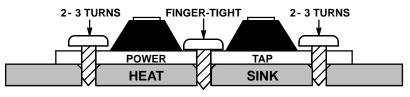
### **STEP 4:**

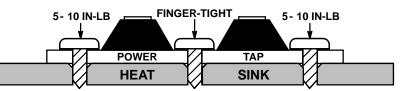
Tighten the center bolt between 8 to 10 in-lb.

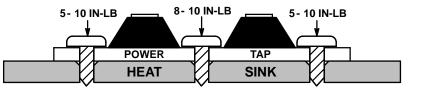
### **STEP 5:**

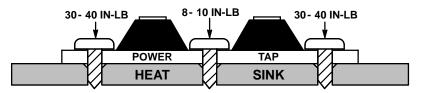
Finally, tighten the end bolts between 30 to 40 in-lb.











Preferred Device

# POWERTAP™ II SWITCHMODE™ Power Rectifier

The SWITCHMODE Power Rectifier uses the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction -May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 150°C Operating Junction Temperature
- Recyclable Epoxy
- Improved Mechanical Ratings

#### **Mechanical Characteristics**

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25 40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B40030L

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	30	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 100^{\circ}C$ ) Per Leg Per Device	I <sub>F(AV)</sub>	200 400	A
Peak Repetitive Forward Current, (At Rated $V_R$ , Square Wave, 20 kHz, $T_C = 100^{\circ}C$ )	I <sub>FRM</sub>	200	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	1500	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Operating Junction Temperature	Τ <sub>J</sub>	-55 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs

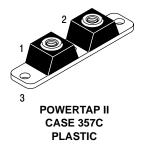


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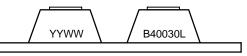
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# LOW V<sub>F</sub> SCHOTTKY BARRIER RECTIFIER 400 AMPERES 30 VOLTS





#### MARKING DIAGRAM



B40030L = Device Code YY = Year WW = Work Week

## ORDERING INFORMATION

Device	Package	Shipping
MBRP40030CTL	POWERTAP II	25 Units/Tray

Preferred devices are recommended choices for future use and best overall value.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction to Case (Note 1.)	$R_{ extsf{ heta}JC}$	0.4	°C/W
ELECTRICAL CHARACTERISTICS			
$\label{eq:constant} \begin{array}{l} \mbox{Maximum Instantaneous Forward Voltage (Note 2.)} \\ (i_F = 200 \mbox{ Amps}, \ T_C = +25^{\circ}C) \\ (i_F = 200 \mbox{ Amps}, \ T_C = +100^{\circ}C) \end{array}$	V <sub>F</sub>	0.5 0.41	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_C = +25^{\circ}C$ ) (Rated dc Voltage, $T_C = +100^{\circ}C$ )	I <sub>R</sub>	20 1000	mA

1. Rating applies when surface mounted on the minimum pad size recommended.

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2%.

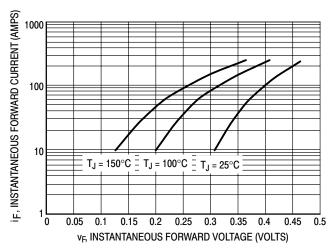


Figure 1. Typical Instantaneous Forward Voltage

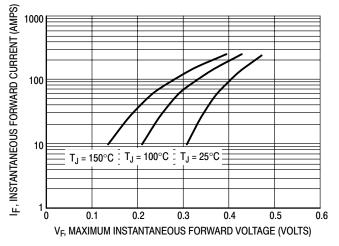


Figure 2. Maximum Instantaneous Forward Voltage

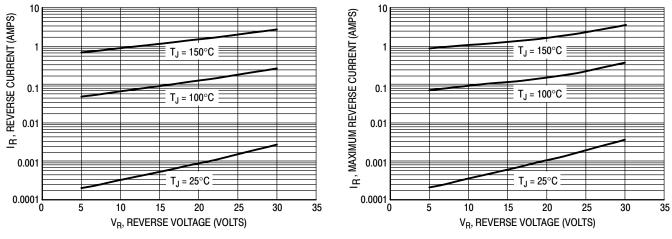




Figure 4. Maximum Reverse Current

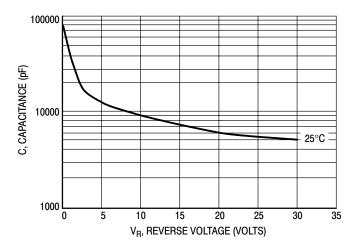
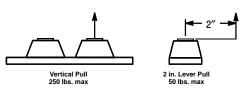


Figure 5. Typical Capacitance

#### MAXIMUM MECHANICAL RATINGS

Terminal Penetration:	0.235 max
Terminal Torque:	25-40 in-lb max
Mounting Torque - Outside Holes:	30-40 in-lb max
Mounting Torque - Center Hole:	8-10 in-lb max
Seating Plane Flatness	1 mil per in. (between mounting holes)

POWERTAP MECHANICAL DATA APPLIES OVER OPERATING TEMPERATURE



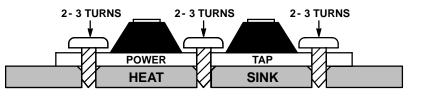
Note: While the POWERTAP is capable of sustaining these vertical and levered tensions, the intimate contact between POWERTAP and heat sink may be lost. This could lead to thermal runaway. The use of very flexible leads is recommended for the anode connections. Use of thermal grease is highly recommended.

### **MOUNTING PROCEDURE**

The POWERTAP package requires special mounting considerations because of the long longitudinal axis of the copper heat sink. It is important to follow the proper tightening sequence to avoid warping the heat sink, which can reduce thermal contact between the POWERTAP and heat sink.

#### **STEP 1:**

Locate the POWERTAP on the heat sink and start mounting bolts into the threads by hand (2 or 3 turns).



#### **STEP 2:**

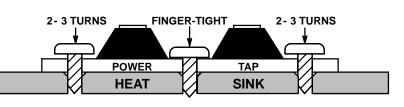
Finger tighten the center bolt. The bolt may catch on the threads of the heat sink so it is important to make sure the face of the bolt or washer is in contact with the surface of the POWERTAP.

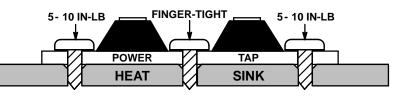
#### **STEP 3:**

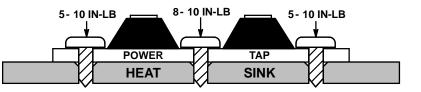
Tighten each of the end bolts between 5 to 10 in-lb.

#### **STEP 4:**

Tighten the center bolt between 8 to 10 in-lb.

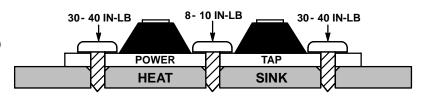








Finally, tighten the end bolts between 30 to 40 in-lb.



# MBRP60035CTL

Preferred Device

# POWERTAP™ II SWITCHMODE™ Power Rectifier

The SWITCHMODE Power Rectifier uses the Schottky Barrier principle with a platinum barrier metal. This state-of-the-art device has the following features:

- Dual Diode Construction May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 150°C Operating Junction Temperature
- Recyclable Epoxy
- Guaranteed Reverse Avalanche Energy Capability
- Improved Mechanical Ratings

#### **Mechanical Characteristics**

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25 40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B60035L

### MAXIMUM RATINGS

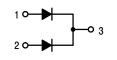
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	35	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 100^{\circ}C$ ) Per Leg Per Device	I <sub>F(AV)</sub>	300 600	A
Peak Repetitive Forward Current, (At Rated $V_R$ , Square Wave, 20 kHz, T <sub>C</sub> = 100°C)	I <sub>FRM</sub>	300	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	4000	A
Peak Repetitive Reverse Surge Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs



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# LOW V<sub>F</sub> SCHOTTKY BARRIER RECTIFIER 600 AMPERES 35 VOLTS





### MARKING DIAGRAM



B60035L = Device Code YY = Year WW = Work Week

### **ORDERING INFORMATION**

Device	Package	Shipping
MBRP60035CTL	POWERTAP II	25 Units/Tray

**Preferred** devices are recommended choices for future use and best overall value.

# MBRP60035CTL

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance — Junction to Case	$R_{ extsf{ heta}JC}$	0.4	°C/W
ELECTRICAL CHARACTERISTICS			
$\label{eq:maximum lnstantaneous Forward Voltage (Note 1.)} \\ (i_F = 300 \text{ Amps, } T_C = +25^\circ\text{C}) \\ (i_F = 300 \text{ Amps, } T_C = +100^\circ\text{C}) \\ \end{aligned}$	V <sub>F</sub>	0.57 0.50	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = +25^{\circ}C$ ) (Rated dc Voltage, $T_C = +100^{\circ}C$ )	I <sub>R</sub>	3.0 250	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2%.

#### MAXIMUM MECHANICAL RATINGS

Terminal Penetration:	0.235 max
Terminal Torque:	25-40 in-lb max
Mounting Torque — Outside Holes:	30-40 in-lb max
Mounting Torque — Center Hole:	8-10 in-lb max
Seating Plane Flatness	1 mil per in. (between mounting holes)

#### POWERTAP MECHANICAL DATA APPLIES OVER OPERATING TEMPERATURE

Vertical Pull 250 lbs. max



50 lbs. max

Note: While the POWERTAP is capable of sustaining these vertical and levered tensions, the intimate contact between POWERTAP and heat sink may be lost. This could lead to thermal runaway. The use of very flexible leads is recommended for the anode connections. Use of thermal grease is highly recommended.

# MBRP60035CTL

## MOUNTING PROCEDURE

The POWERTAP package requires special mounting considerations because of the long longitudinal axis of the copper heat sink. It is important to follow the proper tightening sequence to avoid warping the heat sink, which can reduce thermal contact between the POWERTAP and heat sink.

### STEP 1:

Locate the POWERTAP on the heat sink and start mounting bolts into the threads by hand (2 or 3 turns).

## **STEP 2:**

Finger tighten the center bolt. The bolt may catch on the threads of the heat sink so it is important to make sure the face of the bolt or washer is in contact with the surface of the POWERTAP.

### **STEP 3:**

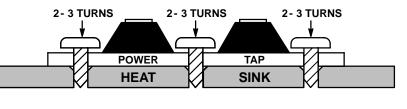
Tighten each of the end bolts between 5 to 10 in-lb.

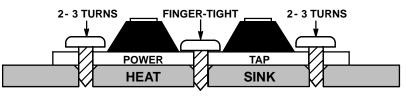
### **STEP 4:**

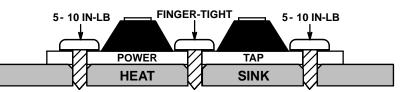
Tighten the center bolt between 8 to 10 in-lb.

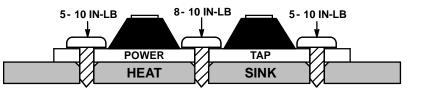
### **STEP 5:**

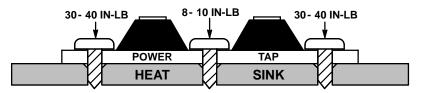
Finally, tighten the end bolts between 30 to 40 in-lb.











# MBRP20045CT

Preferred Device

# POWERTAP™ II SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25-40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B20045T

### MAXIMUM RATINGS

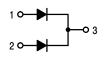
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 140°C) Per Leg Per Device	I <sub>F(AV)</sub>	100 200	A
$\label{eq:rescaled} \begin{array}{l} \mbox{Peak Repetitive Forward Current,} \\ (Rated V_R, Square Wave, \\ 20 \mbox{ kHz}, T_C = 140^{\circ} \mbox{C}) \qquad \mbox{Per Leg} \end{array}$	I <sub>FRM</sub>	200	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	1500	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz) Per Leg	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/μs



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SCHOTTKY BARRIER RECTIFIER 200 AMPERES 45 VOLTS





#### MARKING DIAGRAM



B20045T = Device Code YY = Year WW = Work Week

### **ORDERING INFORMATION**

Device	Package	Shipping
MBRP20045CT	POWERTAP II	25 Units/Tray

**Preferred** devices are recommended choices for future use and best overall value.

# **MBRP20045CT**

#### THERMAL CHARACTERISTICS (Per Leg)

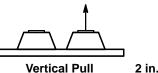
Rating	Symbol	Value	Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	0.6	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)			
Instantaneous Forward Voltage (Note 1) ( $i_F = 200 \text{ Amps}, T_J = 25^{\circ}C$ ) ( $i_F = 200 \text{ Amps}, T_J = 125^{\circ}C$ )	VF	0.89 0.78	Volts
Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 125^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	50 0.5	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

#### MAXIMUM MECHANICAL RATINGS

Terminal Penetration:	0.235 max
Terminal Torque:	25-40 in-lb max
Mounting Torque — Outside Holes:	30-40 in-lb max
Mounting Torque — Center Hole:	8-10 in-lb max
Seating Plane Flatness	1 mil per in. (between mounting holes)

#### POWERTAP MECHANICAL DATA **APPLIES OVER OPERATING TEMPERATURE**



250 lbs. max



Note: While the POWERTAP is capable of sustaining these vertical and levered tensions, the intimate contact between POWERTAP and heat sink may be lost. This could lead to thermal runaway. The use of very flexible leads is recommended for the anode connections. Use of thermal grease is highly recommended.

# MBRP20045CT

## MOUNTING PROCEDURE

The POWERTAP package requires special mounting considerations because of the long longitudinal axis of the copper heat sink. It is important to follow the proper tightening sequence to avoid warping the heat sink, which can reduce thermal contact between the POWERTAP and heat sink.

## STEP 1:

Locate the POWERTAP on the heat sink and start mounting bolts into the threads by hand (2 or 3 turns).

## **STEP 2:**

Finger tighten the center bolt. The bolt may catch on the threads of the heat sink so it is important to make sure the face of the bolt or washer is in contact with the surface of the POWERTAP.

### **STEP 3:**

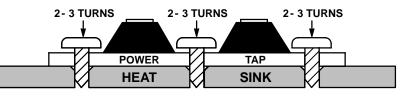
Tighten each of the end bolts between 5 to 10 in-lb.

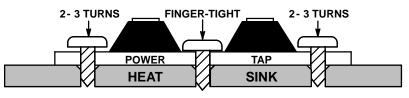
## STEP 4:

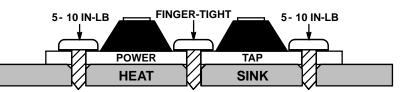
Tighten the center bolt between 8 to 10 in-lb.

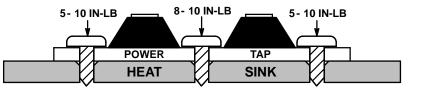
### **STEP 5:**

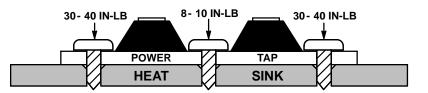
Finally, tighten the end bolts between 30 to 40 in-lb.











# MBRP30045CT

Preferred Device

# POWERTAP™ II SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature
- Guaranteed Reverse Avalanche

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25-40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B30045T

### MAXIMUM RATINGS

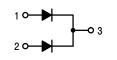
Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
$\begin{array}{llllllllllllllllllllllllllllllllllll$	I <sub>F(AV)</sub>	150 300	A
$\label{eq:rescaled} \begin{array}{l} \mbox{Peak Repetitive Forward Current,} \\ (Rated V_R, Square Wave, \\ 20 \mbox{ kHz}, T_C = 140^{\circ} \mbox{C}) \qquad \mbox{Per Leg} \end{array}$	I <sub>FRM</sub>	300	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) Per Leg	I <sub>FSM</sub>	2500	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz) Per Leg	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs



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# SCHOTTKY BARRIER RECTIFIER 300 AMPERES 45 VOLTS





### MARKING DIAGRAM



B30045T = Device Code YY = Year WW = Work Week

### ORDERING INFORMATION

Device	Package	Shipping
MBRP30045CT	POWERTAP II	25 Units/Tray

**Preferred** devices are recommended choices for future use and best overall value.

# **MBRP30045CT**

### THERMAL CHARACTERISTICS (Per Leg)

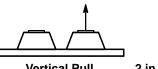
Rating	Symbol	Value	Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	0.45	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)			
Instantaneous Forward Voltage (Note 1) ( $i_F = 150 \text{ Amps}, T_J = 25^{\circ}C$ ) ( $i_F = 300 \text{ Amps}, T_J = 25^{\circ}C$ )	v <sub>F</sub>	0.70 0.82	Volts
Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 125^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	İR	75 0.8	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

### MAXIMUM MECHANICAL RATINGS

Terminal Penetration:	0.235 max
Terminal Torque:	25-40 in-lb max
Mounting Torque — Outside Holes:	30-40 in-lb max
Mounting Torque — Center Hole:	8-10 in-lb max
Seating Plane Flatness	1 mil per in. (between mounting holes)

#### POWERTAP MECHANICAL DATA APPLIES OVER OPERATING TEMPERATURE



Vertical Pull 250 lbs. max



Note: While the POWERTAP is capable of sustaining these vertical and levered tensions, the intimate contact between POWERTAP and heat sink may be lost. This could lead to thermal runaway. The use of very flexible leads is recommended for the anode connections. Use of thermal grease is highly recommended.

# **MBRP30045CT**

## MOUNTING PROCEDURE

The POWERTAP package requires special mounting considerations because of the long longitudinal axis of the copper heat sink. It is important to follow the proper tightening sequence to avoid warping the heat sink, which can reduce thermal contact between the POWERTAP and heat sink.

## STEP 1:

Locate the POWERTAP on the heat sink and start mounting bolts into the threads by hand (2 or 3 turns).

## **STEP 2:**

Finger tighten the center bolt. The bolt may catch on the threads of the heat sink so it is important to make sure the face of the bolt or washer is in contact with the surface of the POWERTAP.

### **STEP 3:**

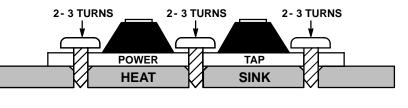
Tighten each of the end bolts between 5 to 10 in-lb.

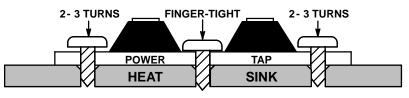
## STEP 4:

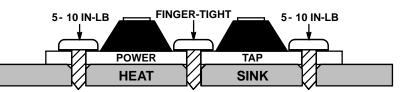
Tighten the center bolt between 8 to 10 in-lb.

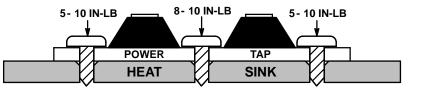
### **STEP 5:**

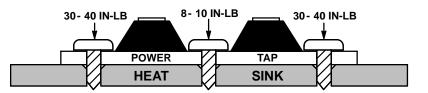
Finally, tighten the end bolts between 30 to 40 in-lb.











# MBRP40045CTL

## POWERTAP™ II SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

#### Features:

- Dual Diode Construction May be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 150°C Operating Junction Temperature
- Recyclable Epoxy
- Guaranteed Reverse Avalanche Energy Capability
- Improved Mechanical Ratings

#### MAXIMUM RATINGS

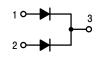
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	45	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 100^{\circ}C$ ) Per Leg Per Device	I <sub>F(AV)</sub>	200 400	A
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 100°C)	I <sub>FRM</sub>	400	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	2500	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage and Operating Case Temperature Range	T <sub>stg</sub> , T <sub>C</sub>	-55 to +150	°C
Operating Junction Temperature	Т <sub>Ј</sub>	-55 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	1000	V/μs

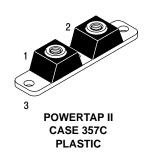


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## SCHOTTKY BARRIER RECTIFIER 400 AMPERES 45 VOLTS





#### MARKING DIAGRAM



B40045L = Device Code YY = Year WW = Work Week

#### ORDERING INFORMATION

Device	Package	Shipping
MBRP40045CTL	POWERTAP II	25 Units/Tray

## MBRP40045CTL

#### THERMAL CHARACTERISTICS

Rating		Symbol	Value	Unit
Thermal Resistance — Junction-to-Case F	Per Leg	$R_{ extsf{ heta}JC}$	0.45	°C/W

#### ELECTRICAL CHARACTERISTICS

Rating		Symbol	Value		Unit
Maximum Instantaneous Forward Voltage (Note 1.)	Per Leg	VF	T <sub>C</sub> = 25°C	T <sub>C</sub> = 125°C	V
(I <sub>F</sub> = 200 A) (I <sub>F</sub> = 400 A)			0.57 0.73	0.52 0.68	
Maximum Instantaneous Reverse Current (Note 1.)	Per Leg	I <sub>R</sub>	T <sub>C</sub> = 25°C	T <sub>C</sub> = 125°C	mA
(Rated DC Voltage)			10	400	

1. Pulse Test: Pulse Width = 380  $\mu s,$  Duty Cycle  $\leq$  2%.

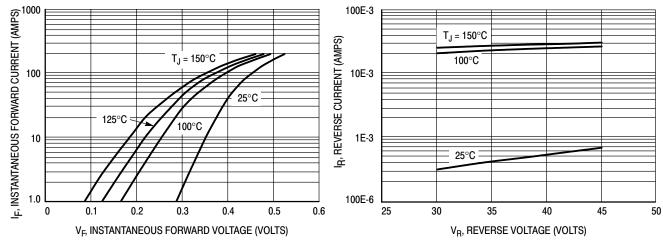


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

Preferred Device

## POWERTAP<sup>™</sup> II SWITCHMODE<sup>™</sup> Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature

#### Mechanical Characteristics:

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25-40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B20060T

#### MAXIMUM RATINGS

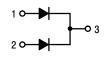
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 140^{\circ}C$ ) Per Leg Per Device	I <sub>F(AV)</sub>	100 200	A
$\begin{array}{l} \mbox{Peak Repetitive Forward Current,} \\ (Rated V_R, Square Wave, \\ 20 \mbox{ kHz, } T_C = 140^\circ \mbox{C}) \qquad \mbox{Per Leg} \end{array}$	I <sub>FRM</sub>	200	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	1500	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz) Per Leg	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/μs

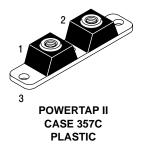


## **ON Semiconductor®**

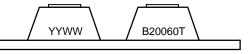
http://onsemi.com

## SCHOTTKY BARRIER RECTIFIER 200 AMPERES 60 VOLTS





#### MARKING DIAGRAM



B20060T = Device Code YY = Year WW = Work Week

#### ORDERING INFORMATION

Device	Package Shipping	
MBRP20060CT	POWERTAP II	25 Units/Tray

**Preferred** devices are recommended choices for future use and best overall value.

#### THERMAL CHARACTERISTICS (Per Leg)

Rating	Symbol	Value	Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	0.6	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)			
Instantaneous Forward Voltage (Note 1)	٧ <sub>F</sub>	0.01	Volts

(i <sub>F</sub> = 200 Amps, T <sub>J</sub> = 25°C) (i <sub>F</sub> = 200 Amps, T <sub>J</sub> = 100°C)		0.91 0.80		
Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 125^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	50 0.5	mA	

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

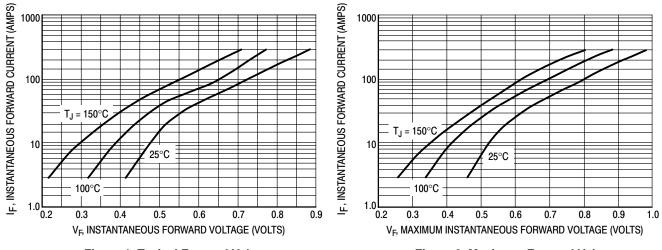
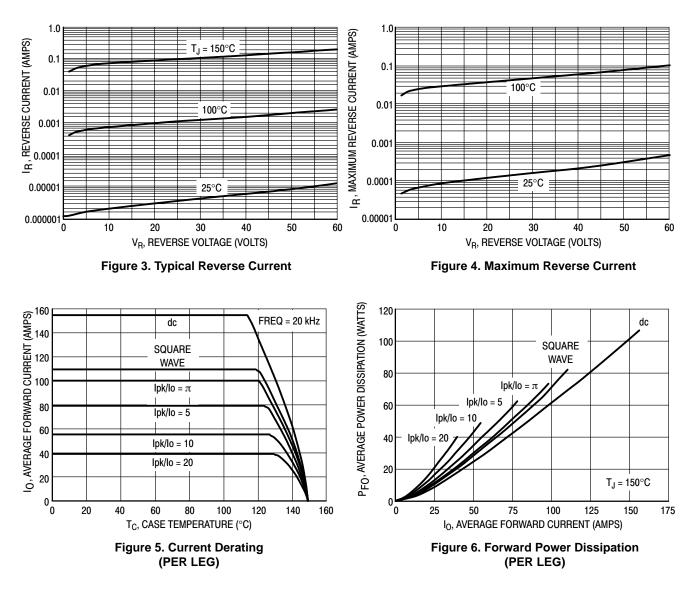
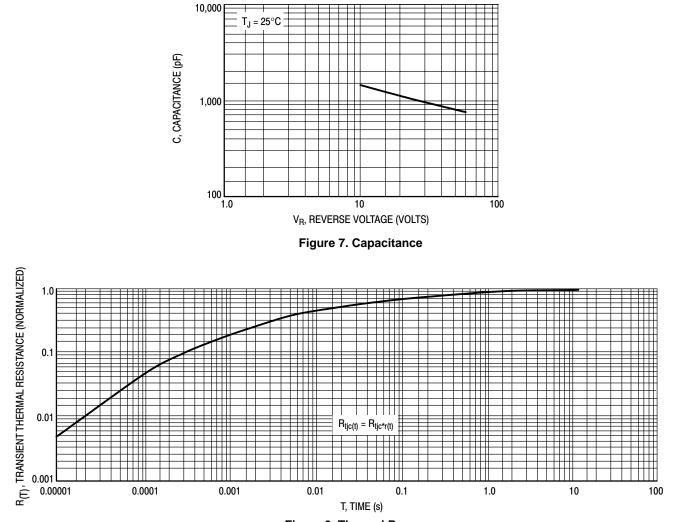


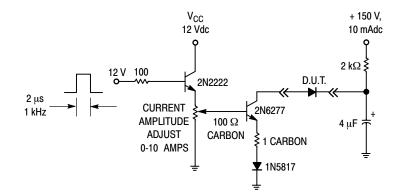
Figure 1. Typical Forward Voltage

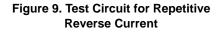
Figure 2. Maximum Forward Voltage







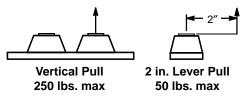




#### MAXIMUM MECHANICAL RATINGS

Terminal Penetration:	0.235 max
Terminal Torque:	25-40 in-lb max
Mounting Torque — Outside Holes:	30-40 in-lb max
Mounting Torque — Center Hole:	8-10 in-lb max
Seating Plane Flatness	1 mil per in. (between mounting holes)

#### POWERTAP MECHANICAL DATA APPLIES OVER OPERATING TEMPERATURE



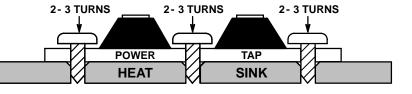
Note: While the POWERTAP is capable of sustaining these vertical and levered tensions, the intimate contact between POWERTAP and heat sink may be lost. This could lead to thermal runaway. The use of very flexible leads is recommended for the anode connections. Use of thermal grease is highly recommended.

#### **MOUNTING PROCEDURE**

The POWERTAP package requires special mounting considerations because of the long longitudinal axis of the copper heat sink. It is important to follow the proper tightening sequence to avoid warping the heat sink, which can reduce thermal contact between the POWERTAP and heat sink.

#### **STEP 1:**

Locate the POWERTAP on the heat sink and start mounting bolts into the threads by hand (2 or 3 turns).



#### **STEP 2:**

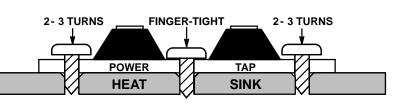
Finger tighten the center bolt. The bolt may catch on the threads of the heat sink so it is important to make sure the face of the bolt or washer is in contact with the surface of the POWERTAP.

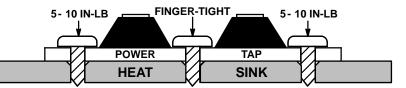
#### **STEP 3:**

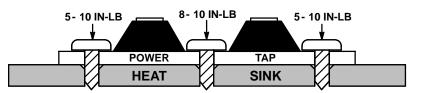
Tighten each of the end bolts between 5 to 10 in-lb.

#### STEP 4:

Tighten the center bolt between 8 to 10 in-lb.

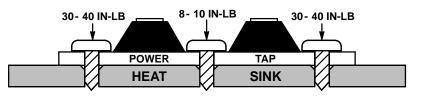






#### **STEP 5:**

Finally, tighten the end bolts between 30 to 40 in-lb.



Preferred Device

## POWERTAP™ II SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

- Dual Diode Construction May Be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage
- 150°C Operating Junction Temperature

#### Mechanical Characteristics:

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25-40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: B30060T

#### MAXIMUM RATINGS

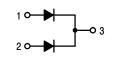
Rating	Symbol	Max	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	60	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 140°C) Per Leg Per Device	I <sub>F(AV)</sub>	150 300	A
$\label{eq:result} \begin{array}{l} \mbox{Peak Repetitive Forward Current,} \\ (Rated V_R, Square Wave, \\ 20 \mbox{ kHz, } T_C = 140^\circ \mbox{C}) \qquad \mbox{Per Leg} \end{array}$	I <sub>FRM</sub>	300	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) Per Leg	I <sub>FSM</sub>	2500	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz) Per Leg	I <sub>RRM</sub>	2.0	A
Storage Temperature Range	T <sub>stg</sub>	-55 to +150	°C
Operating Junction Temperature	TJ	-55 to +150	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	10,000	V/µs



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## SCHOTTKY BARRIER RECTIFIER 300 AMPERES 60 VOLTS





#### MARKING DIAGRAM



B30060T = Device Code YY = Year WW = Work Week

#### ORDERING INFORMATION

Device	e Package Shipping	
MBRP30060CT	POWERTAP II	25 Units/Tray

**Preferred** devices are recommended choices for future use and best overall value.

#### THERMAL CHARACTERISTICS (Per Leg)

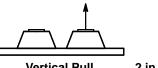
Rating	Symbol	Value	Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	0.45	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)			
Instantaneous Forward Voltage (Note 1) ( $i_F = 150 \text{ Amps}, T_J = 25^{\circ}C$ ) ( $i_F = 300 \text{ Amps}, T_J = 25^{\circ}C$ )	۷F	0.79 0.89	Volts
Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 125^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	İR	75 0.8	mA

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

#### MAXIMUM MECHANICAL RATINGS

Terminal Penetration:	0.235 max
Terminal Torque:	25-40 in-lb max
Mounting Torque — Outside Holes:	30-40 in-lb max
Mounting Torque — Center Hole:	8-10 in-lb max
Seating Plane Flatness	1 mil per in. (between mounting holes)

#### POWERTAP MECHANICAL DATA APPLIES OVER OPERATING TEMPERATURE



Vertical Pull 250 lbs. max



Note: While the POWERTAP is capable of sustaining these vertical and levered tensions, the intimate contact between POWERTAP and heat sink may be lost. This could lead to thermal runaway. The use of very flexible leads is recommended for the anode connections. Use of thermal grease is highly recommended.

### MOUNTING PROCEDURE

The POWERTAP package requires special mounting considerations because of the long longitudinal axis of the copper heat sink. It is important to follow the proper tightening sequence to avoid warping the heat sink, which can reduce thermal contact between the POWERTAP and heat sink.

#### STEP 1:

Locate the POWERTAP on the heat sink and start mounting bolts into the threads by hand (2 or 3 turns).

#### **STEP 2:**

Finger tighten the center bolt. The bolt may catch on the threads of the heat sink so it is important to make sure the face of the bolt or washer is in contact with the surface of the POWERTAP.

#### **STEP 3:**

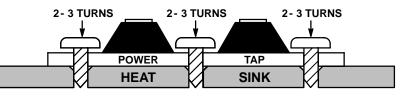
Tighten each of the end bolts between 5 to 10 in-lb.

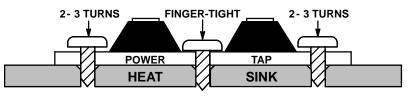
#### STEP 4:

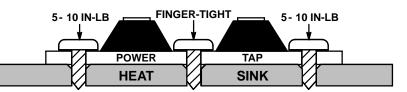
Tighten the center bolt between 8 to 10 in-lb.

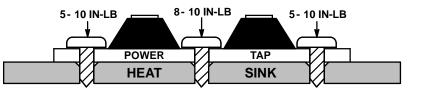
#### **STEP 5:**

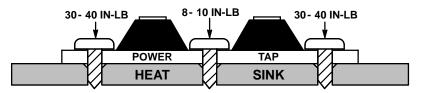
Finally, tighten the end bolts between 30 to 40 in-lb.











# MBRP400100CTL

## POWERTAP™ II SWITCHMODE™ Power Rectifier

... using the Schottky Barrier principle with a platinum barrier metal. These state-of-the-art devices have the following features:

#### Features:

- Dual Diode Construction -May be Paralleled for Higher Current Output
- Guardring for Stress Protection
- Low Forward Voltage Drop
- 175°C Operating Junction Temperature
- Recyclable Epoxy
- Guaranteed Reverse Avalanche Energy Capability
- Improved Mechanical Ratings

#### MAXIMUM RATINGS

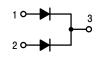
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 100^{\circ}C$ ) Per Leg Per Device	I <sub>F(AV)</sub>	200 400	A
Peak Repetitive Forward Current (At Rated $V_R$ , Square Wave, 20 kHz, $T_C = 100^{\circ}C$ )	I <sub>FRM</sub>	400	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	2500	A
Peak Repetitive Reverse Current (2.0 μs, 1.0 kHz)	I <sub>RRM</sub>	2.0	A
Storage and Operating Case Temperature Range	T <sub>stg</sub> , T <sub>C</sub>	-55 to +175	°C
Operating Junction Temperature	TJ	-55 to +175	°C
Voltage Rate of Change (Rated $V_R$ )	dv/dt	1000	V/µs

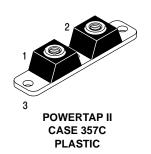


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## SCHOTTKY BARRIER RECTIFIER 400 AMPERES 100 VOLTS





#### MARKING DIAGRAM



B400100L = Device Code YY = Year WW = Work Week

#### **ORDERING INFORMATION**

Device	Package	Shipping
MBRP400100CTL	POWERTAP II	25 Units/Tray

## MBRP400100CTL

#### THERMAL CHARACTERISTICS

Rating	S	Symbol	Value	Unit
Thermal Resistance - Junction-to-Case Per Le	eg	$R_{\theta JC}$	0.45	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Rating		Symbol	Va	lue	Unit
Maximum Instantaneous Forward Voltage (Note 1)	Per Leg	V <sub>F</sub>	T <sub>C</sub> = 25°C	T <sub>C</sub> = 125°C	V
(I <sub>F</sub> = 200 (I <sub>F</sub> = 400			0.83 0.97	0.69 0.82	
Maximum Instantaneous Reverse Current (Note 1)	Per Leg	Ι <sub>R</sub>	T <sub>C</sub> = 25°C	T <sub>C</sub> = 125°C	mA
(Rated D	C Voltage)		6.0	80	

1. Pulse Test: Pulse Width = 380  $\mu$ s, Duty Cycle  $\leq$  2%.

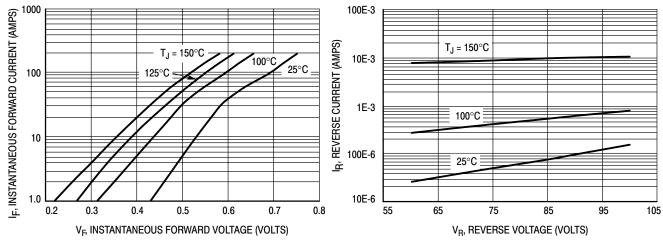


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

## SWITCHMODE™ Soft Ultrafast Recovery Power Rectifier

## **Plastic DPAK Package**

State of the art geometry features epitaxial construction with glass passivation and metal overlay contact. Ideally suited for low voltage, high frequency switching power supplies, free wheeling diode and polarity protection diodes.

- Soft Ultrafast Recovery (35 ns typ.)
- Highly Stable Oxide Passivated Junction
- Matched Dual Die Construction May Be Paralleled for High Current Output
- Short Heat Sink Tab Manufactured Not Sheared
- Epoxy Meets UL94, V<sub>O</sub> at 1/8"

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 0.4 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per Reel, Add "T4" to Suffix part number
- Marking: S620T

#### MAXIMUM RATINGS

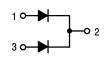
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 137^{\circ}C$ ) Per Leg Per Package	Ι <sub>Ο</sub>	3.0 6.0	A
$\begin{array}{c} \mbox{Peak Repetitive Forward Current} \\ \mbox{(At Rated V}_{R}, \mbox{Square Wave}, \\ \mbox{20 kHz}, \mbox{T}_{C} = 138^{\circ}\mbox{C}) & \mbox{Per Leg} \end{array}$	I <sub>FRM</sub>	6.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz) Per Package	I <sub>FSM</sub>	50	A
Storage/Operating Case Temperature Range	T <sub>stg</sub> , T <sub>C</sub>	-55 to +175	°C
Operating Junction Temperature Range	TJ	-55 to +175	°C



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SOFT ULTRAFAST RECTIFIER 6.0 AMPERES 200 VOLTS





CASE 369A PLASTIC

#### MARKING DIAGRAM



S620T = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MSRD620CT	DPAK	75 Units/Rail
MSRD620CTT4	DPAK	2500/Tape & Reel

#### THERMAL CHARACTERISTICS

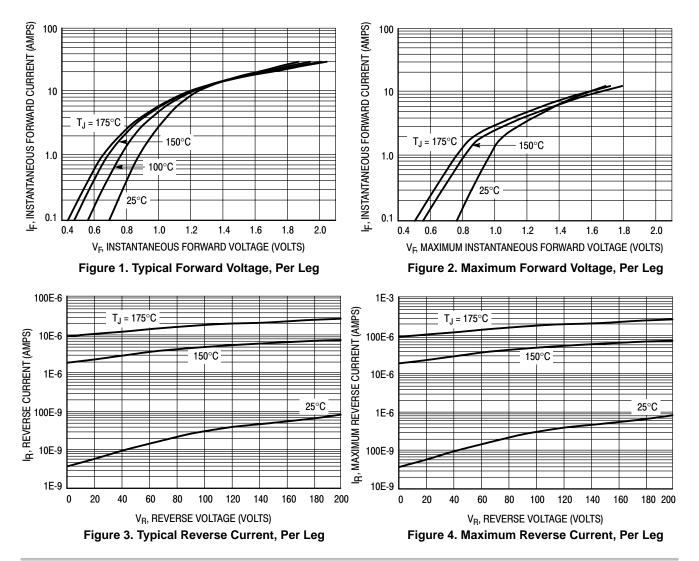
Rating		Symbol	Value	Unit
Thermal Resistance - Junction to Case	Per Leg	R <sub>θJC</sub>	9.0	°C/W
- Junction to Ambient	Per Leg	R <sub>θJA</sub>	80	

#### **ELECTRICAL CHARACTERISTICS**

Rating		Symbol	Va	lue	Unit
Maximum Instantaneous Forward Voltage (Note 1.), see Figure 2	Per Leg	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 150°C	V
(I <sub>F</sub> = 3.0 A) (I <sub>F</sub> = 6.0 A)			1.15 1.35	1.05 1.30	
Maximum Instantaneous Reverse Current, see Figure 4	Per Leg	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 150°C	μA
(V <sub>R</sub> = 200 V) (V <sub>R</sub> = 100 V)			5.0 2.0	200 100	
Maximum Reverse Recovery Time (Note 2.) $(V_R = 30 \text{ V}, I_F = 1.0 \text{ A}, \text{ di/dt} = 50 \text{ A/}\mu\text{s})$ $(V_R = 30 \text{ V}, I_F = 3.0 \text{ A}, \text{ di/dt} = 50 \text{ A/}\mu\text{s})$	Per Leg	t <sub>rr</sub>		15 55	ns
Maximum Peak Reverse Recovery Current $(V_R = 30 \text{ V}, I_F = 1.0 \text{ A}, \text{ di/dt} = 50 \text{ A/}\mu\text{s})$ $(V_R = 30 \text{ V}, I_F = 3.0 \text{ A}, \text{ di/dt} = 50 \text{ A/}\mu\text{s})$	Per Leg	I <sub>RM</sub>		2.0 5.0	A

1. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2%.

2.  $t_{rr}$  measured projecting from 25% of  $I_{RM}$  to ground.



http://onsemi.com 337

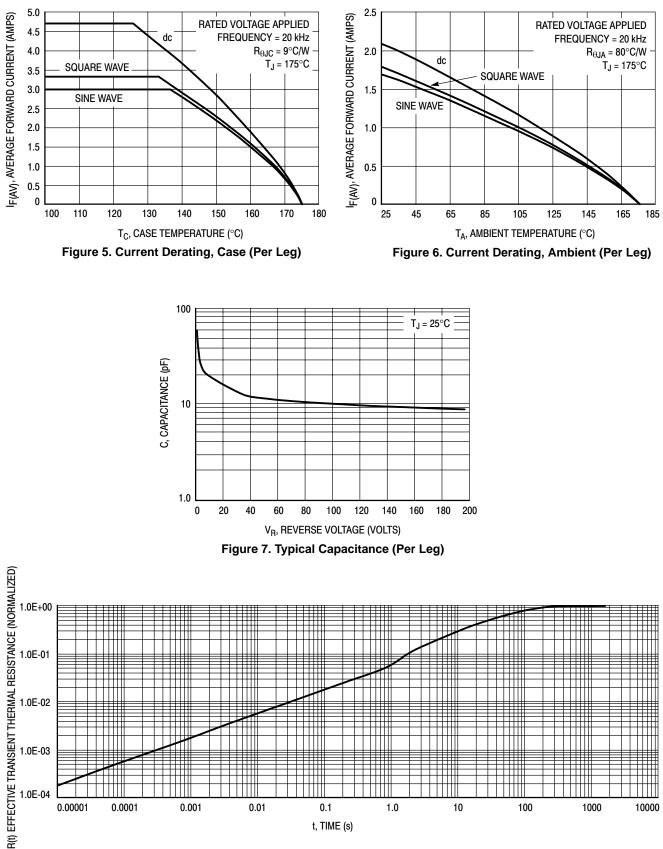


Figure 8. Transient Thermal Response ( $R_{\theta JA}$ )

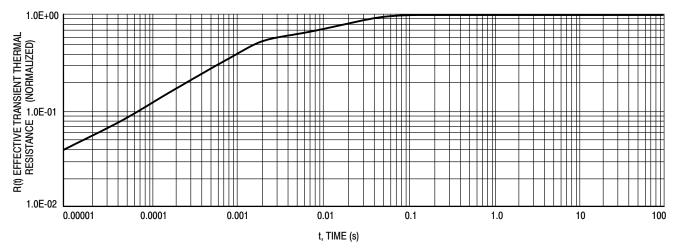


Figure 9. Transient Thermal Response ( $R_{\theta JC}$ )

## SWITCHMODE<sup>™</sup> Soft Recovery Power Rectifier

## Plastic TO-220 Package

Designed for use as free wheeling diodes in variable speed motor control applications and switching power supplies. These state-of-the-art devices have the following features:

- Soft Recovery with Guaranteed Low Reverse Recovery Charge (Q<sub>RR</sub>) and Peak Reverse Recovery Current (I<sub>RRM</sub>)
- 150°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy meets UL94, V<sub>O</sub> @ 1/8"
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction

#### **Mechanical Characteristics:**

- Case: Molded Epoxy
- Weight: 1.9 Grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 50 Units per Plastic Tube
- Marking: MSR860

#### MAXIMUM RATINGS

	-	1	-
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600	V
Average Rectified Forward Current (At Rated $V_R$ , $T_C = 125^{\circ}C$ )	Ι <sub>Ο</sub>	8.0	A
Peak Repetitive Forward Current (At Rated $V_R$ , Square Wave, 20 kHz, $T_C = 125^{\circ}C$ )	I <sub>FRM</sub>	16	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	100	A
Storage/Operating Case Temperature Range	T <sub>stg</sub> , T <sub>C</sub>	-65 to +150	°C
Operating Junction Temperature Range	TJ	-65 to +150	°C
THERMAL CHARACTERISTICS			
TI IDII		1.0	

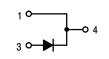
Thermal Resistance -	$R_{\theta JC}$	1.6	°C/W
Junction-to-Case	$R_{\theta JA}$	72.8	
Thermal Resistance -			
Junction-to-Ambient			

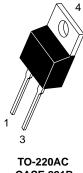


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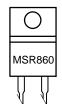
## SOFT RECOVERY POWER RECTIFIER 8.0 AMPERES 600 VOLTS





CASE 221B STYLE 1

#### MARKING DIAGRAM



MSR860 = Device Code

#### ORDERING INFORMATION

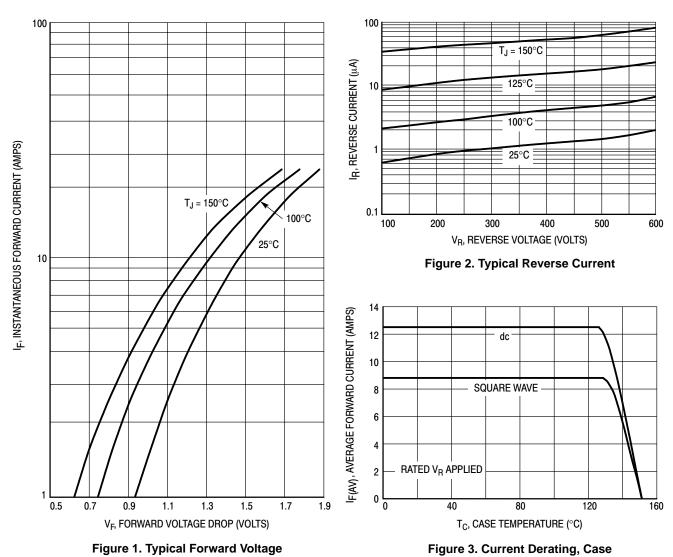
Device	Package	Shipping
MSR860	TO-220	50 Units/Rail

#### **ELECTRICAL CHARACTERISTICS**

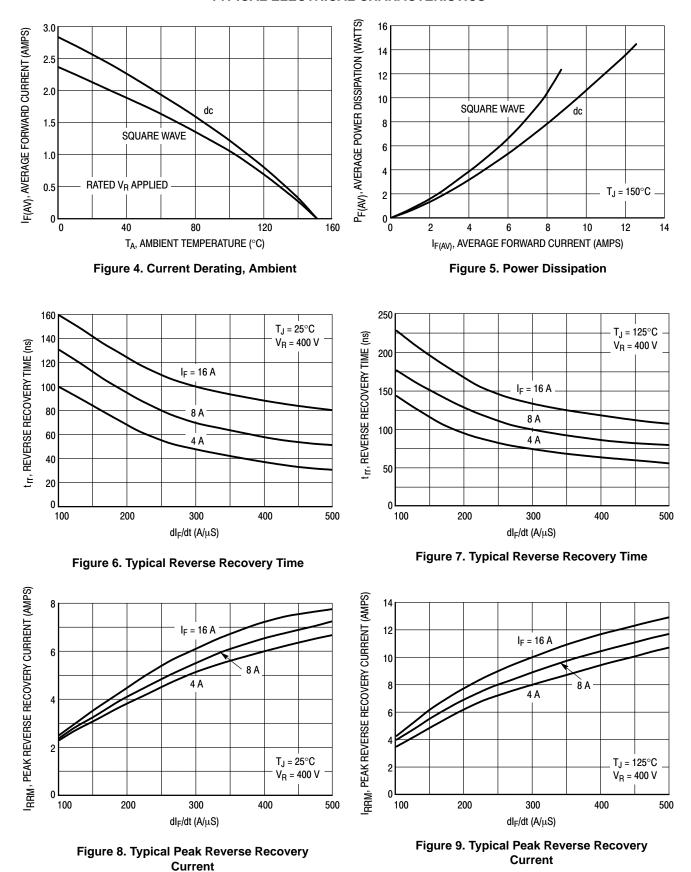
Characteristic	Symbol	Va	lue	Unit
Maximum Instantaneous Forward Voltage (Note 1.) (I <sub>F</sub> = 8.0 A)	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 150°C	V
Typical		1.7 1.4	1.3 <i>1.1</i>	
Maximum Instantaneous Reverse Current	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 150°C	μΑ
(V <sub>R</sub> = 600 V) <i>Typical</i>		10 <i>2.0</i>	1000 <i>80</i>	
Maximum Reverse Recovery Time (Note 2.)	t <sub>rr</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 125°C	ns
(V <sub>R</sub> = 400 V, I <sub>F</sub> = 8.0 A, di/dt = 200 A/µs) <i>Typical</i>		120 <i>95</i>	190 <i>125</i>	
Typical Recovery Softness Factor ( $V_R = 400 \text{ V}, I_F = 8.0 \text{ A}, \text{ di/dt} = 200 \text{ A/}\mu\text{s}$ )	$s = t_b/t_a$	2.5	3.0	
Maximum Peak Reverse Recovery Current ( $V_R = 400 \text{ V}, I_F = 8.0 \text{ A}, \text{ di/dt} = 200 \text{ A/}\mu\text{s}$ )	I <sub>RRM</sub>	5.8	8.3	A
Maximum Reverse Recovery Charge ( $V_R = 400 \text{ V}, I_F = 8.0 \text{ A}, \text{ di/dt} = 200 \text{ A/}\mu\text{s}$ )	Q <sub>RR</sub>	350	700	nC

1. Pulse Test: Pulse Width  $\leq$  380 µs, Duty Cycle  $\leq$  2%

2.  $T_{RR}$  measured projecting from 25% of  $I_{RRM}$  to zero current

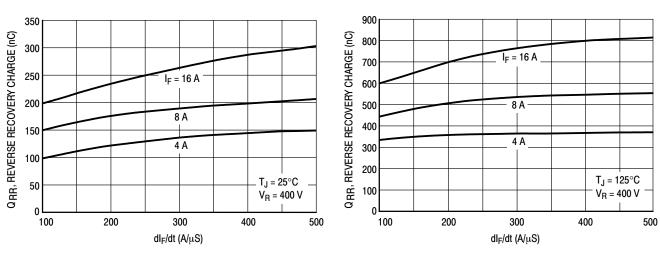


### **TYPICAL ELECTRICAL CHARACTERISTICS**



#### **TYPICAL ELECTRICAL CHARACTERISTICS**

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#### **TYPICAL ELECTRICAL CHARACTERISTICS**





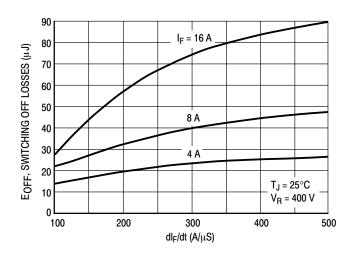


Figure 12. Typical Switching Off Losses

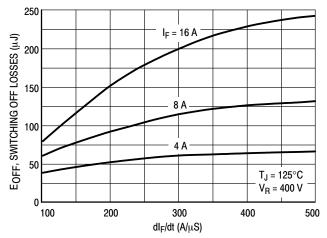


Figure 13. Typical Switching Off Losses

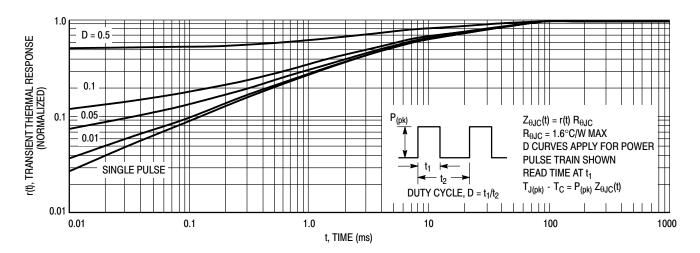


Figure 14. Thermal Response

## SWITCHMODE<sup>™</sup> Soft Recovery Power Rectifier

Designed for boost converter or hard-switched converter applications, especially for Power Factor Correction application. It could also be used as a free wheeling diode in variable speed motor control applications and switching mode power supplies. These state-of-the-art devices have the following features:

- Soft Recovery with Low Reverse Recovery Charge (Q<sub>RR</sub>) and Peak Reverse Recovery Current (I<sub>RRM</sub>)
- 150°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy meets UL94, V<sub>O</sub> @ 1/8"
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- **Mechanical Characteristics:**
- Case: Molded Epoxy
- Weight: 1.9 Grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 50 Units per Plastic Tube
- Marking: MSR1560

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>C</sub> = 125°C)	Ι <sub>Ο</sub>	15	A
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz,T <sub>C</sub> = 125°C)	I <sub>FRM</sub>	30	A
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	100	A
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-65 to +150	°C
Operating Junction Temperature	TJ	-65 to +150	°C

#### THERMAL CHARACTERISTICS

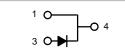
Parameter	Symbol	Value	Unit
Thermal Resistance - Junction-to-Case Thermal Resistance -	$R_{ extsf{ heta}JC}$	1.6	°C/W
Junction-to-Ambient	$R_{\theta JA}$	72.8	



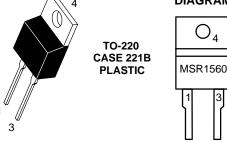
### ON Semiconductor<sup>™</sup>

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## SOFT RECOVERY POWER RECTIFIER 15 AMPERES 600 VOLTS



#### MARKING DIAGRAM



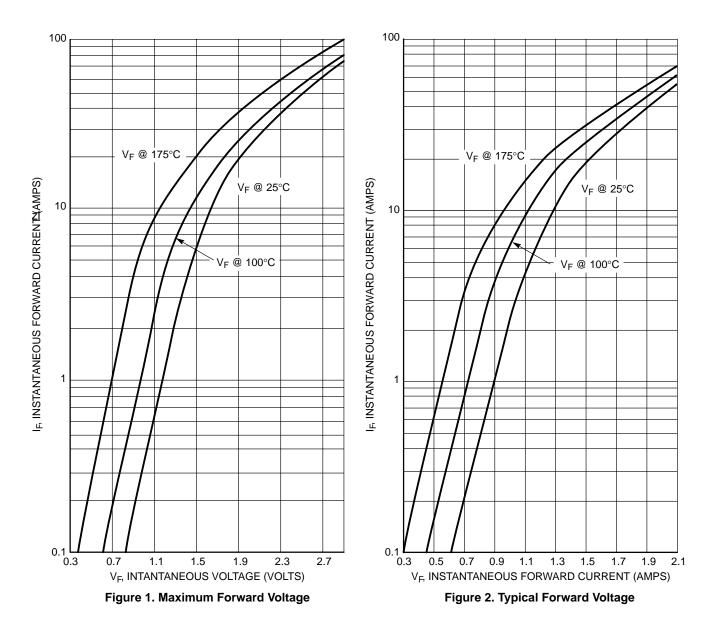
#### ORDERING INFORMATION

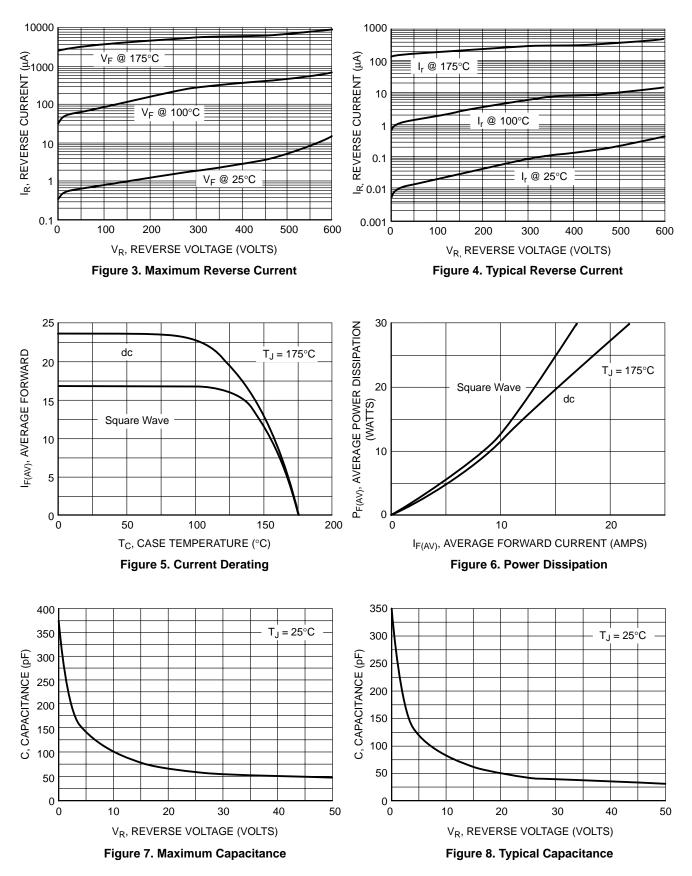
Device	Package	Shipping
MSR1560	TO-220	50 Units/Rail

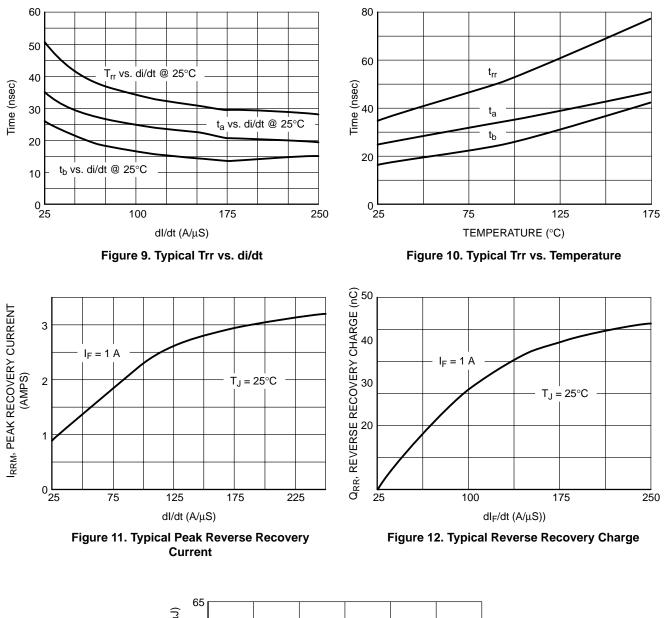
#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 1) ( $I_F = 15 \text{ A}$ )	V <sub>F</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 150°C	V
Typical		1.8 <i>1.5</i>	1.4 <i>1.2</i>	
Maximum Instantaneous Reverse Current (V <sub>R</sub> = 600 V)	I <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 150°C	μΑ
Typical		15 <i>0.4</i>	5000 <i>100</i>	
Maximum Reverse Recovery Time (Note 2) (V <sub>R</sub> = 30 V, I <sub>F</sub> = 1 A, di/dt = 100 A/ $\mu$ s)	t <sub>rr</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	ns
Typical		45 <i>35</i>	65 <i>54</i>	
Typical Recovery Softness Factor (V <sub>R</sub> = 30 V, I <sub>F</sub> = 1 A, di/dt = 100 A/ $\mu$ s)	$s = t_b/t_a$	.67	.74	
Typical Peak Reverse Recovery Current (V <sub>R</sub> = 30 V, I <sub>F</sub> = 1 A, di/dt = 100 A/ $\mu$ s)	I <sub>RRM</sub>	2.3	3.2	А
Typical Reverse Recovery Charge ( $V_R = 30 \text{ V}$ , $I_F = 1 \text{ A}$ , di/dt = 100 A/µs)	Q <sub>RR</sub>	31	78	nC

1. Pulse Test: Pulse Width  $\leq$  380 µs, Duty Cycle  $\leq$  2% 2. T<sub>RR</sub> measured projecting from 25% of I<sub>RRM</sub> to zero current







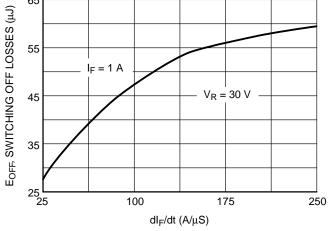


Figure 13. Typical Switching Off Losses

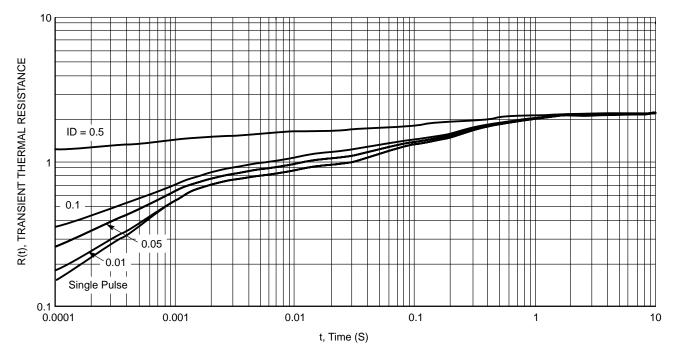


Figure 14. Transient Thermal Response

# CHAPTER 4 Ultrafast Data Sheets

# MURA105T3, MURA110T3

**Preferred Devices** 

## Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.66 Volts Max @  $1.0 \text{ A}, \text{T}_{J} = 150^{\circ}\text{C}$ )

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 5000 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C)
- Marking: U4A, U4B

#### MAXIMUM RATINGS

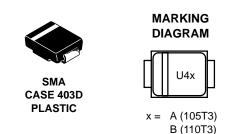
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURA105T3 MURA110T3	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50 100	V
Average Rectified Forward Current @ $T_L = 155^{\circ}C$ @ $T_L = 135^{\circ}C$	I <sub>F(AV)</sub>	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	50	A
Operating Junction Temperature Range	TJ	- 65 to +175	°C



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## ULTRAFAST RECTIFIERS 1 AMPERE 50-100 VOLTS



#### **ORDERING INFORMATION**

Device	Package	Shipping
MURA105T3	SMA	5000/Tape & Reel
MURA110T3	SMA	5000/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

## MURA105T3, MURA110T3

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Lead (Note 1)	Psi <sub>JL</sub> (Note 2)	24	°C/W
Thermal Resistance, Junction to Ambient (Note 1)	$R_{\theta JA}$	216	

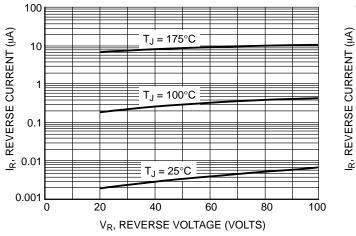
#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3) ( $i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C}$ )	VF	0.875 0.66	Volts
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	2.0 50	μΑ
Maximum Reverse Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 50 A/µs)	t <sub>rr</sub>	30	ns

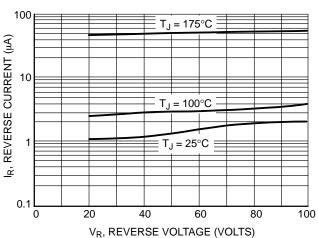
1. Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.

2. In compliance with JEDEC 51, these values (historically represented by  $R_{\theta,L}$ ) are now referenced as  $Psi_{JL}$ .

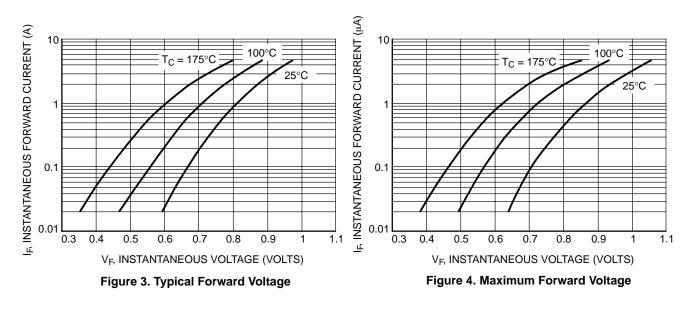
3. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



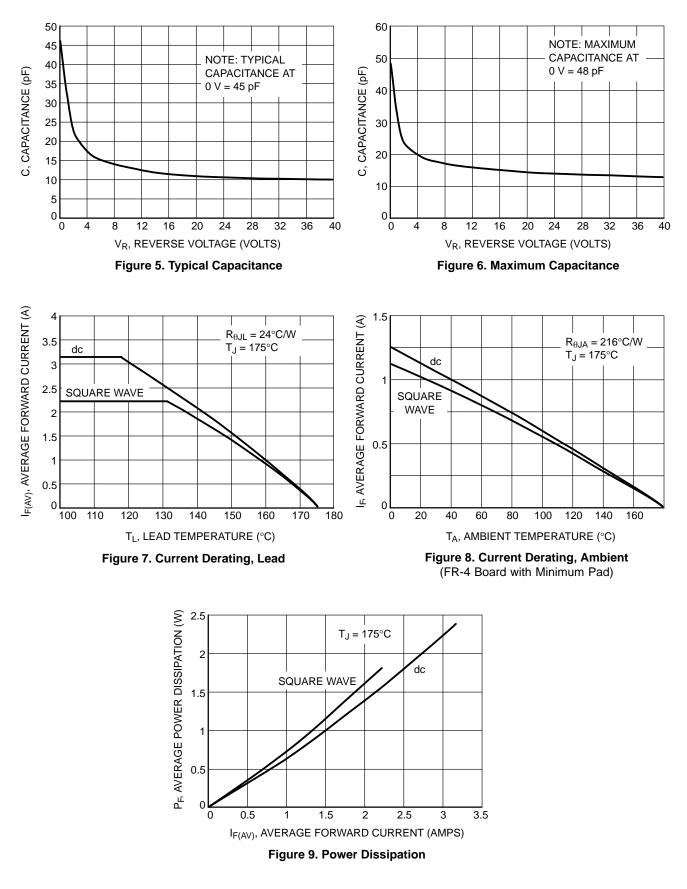




#### Figure 2. Maximum Reverse Current



## **MURA105T3, MURA110T3**



# MURA115T3, MURA120T3

**Preferred Devices** 

## Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.71 Volts Max @  $1.0 \text{ A}, \text{T}_{\text{J}} = 150^{\circ}\text{C}$ )

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 5000 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C)
- Marking: U4C, U4D

#### MAXIMUM RATINGS

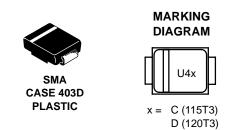
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURA115T3 MURA120T3	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	150 200	V
Average Rectified Forward Current @ $T_L = 155^{\circ}C$ @ $T_L = 135^{\circ}C$	I <sub>F(AV)</sub>	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Operating Junction Temperature Range	TJ	- 65 to +175	°C



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## ULTRAFAST RECTIFIERS 1 AMPERE 100-200 VOLTS



#### **ORDERING INFORMATION**

Device	Package	Shipping
MURA115T3	SMA	5000/Tape & Reel
MURA120T3	SMA	5000/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

## MURA115T3, MURA120T3

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Lead ( $T_L = 25^{\circ}C$ ) (Note 1)	Psi <sub>JL</sub> (Note 2)	24	°C/W
Thermal Resistance, Junction to Ambient (Note 1)	R <sub>0JA</sub>	216	

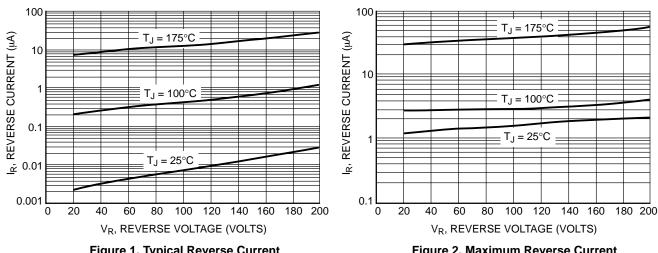
#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3) ( $i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C}$ )	VF	0.875 0.71	Volts
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	2.0 50	μΑ
Maximum Reverse Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 50 A/μs)	t <sub>rr</sub>	35	ns

1. Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.

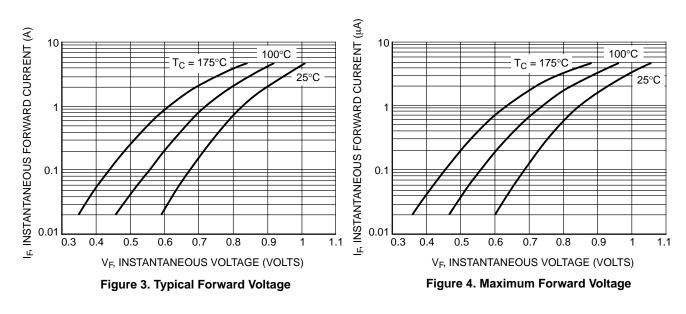
In compliance with JEDEC 51, these values (historically represented by  $R_{\theta,JL}$ ) are now referenced as Psi<sub>JL</sub>. 2.

3. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

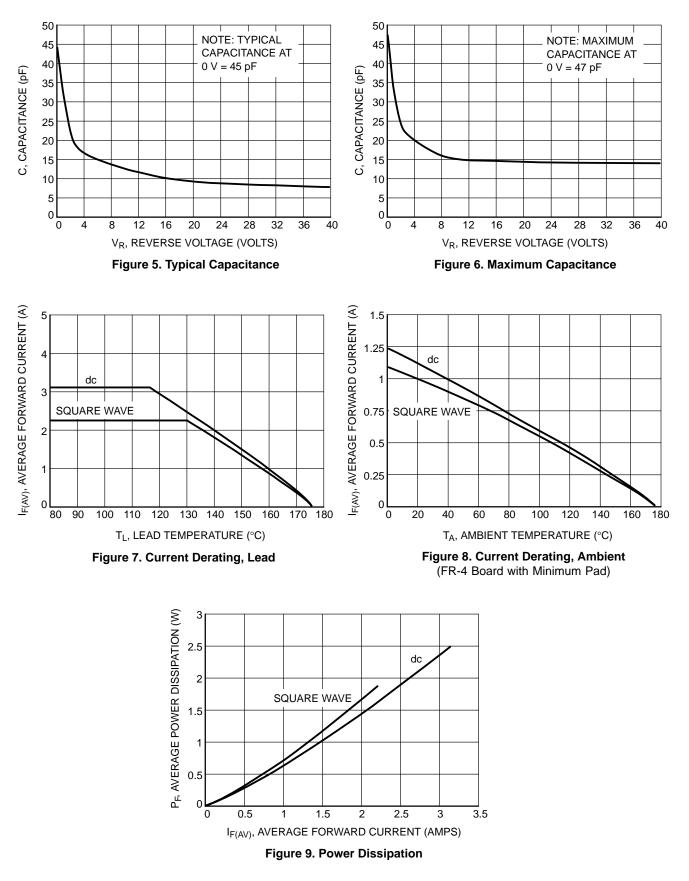








## **MURA115T3, MURA120T3**



# MURA130T3, MURA140T3

**Preferred Devices** 

## Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.8 Volts Max @ 1.0 A,  $T_J = 150^{\circ}C$ )

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 5000 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C)
- Marking: U4F, U4G

#### MAXIMUM RATINGS

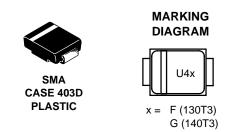
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURA130T3 MURA140T3	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	300 400	V
Average Rectified Forward Current @ $T_L = 150^{\circ}C$ @ $T_L = 125^{\circ}C$	I <sub>F(AV)</sub>	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	35	A
Operating Junction Temperature Range	TJ	- 65 to +175	°C



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## ULTRAFAST RECTIFIERS 1 AMPERE 300-400 VOLTS



#### **ORDERING INFORMATION**

Device	Package	Shipping
MURA130T3	SMA	5000/Tape & Reel
MURA140T3	SMA	5000/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

## **MURA130T3, MURA140T3**

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Lead ( $T_L = 25^{\circ}C$ ) (Note 1)	Psi <sub>JL</sub> (Note 2)	24	°C/W
Thermal Resistance, Junction to Ambient (Note 1)	$R_{\theta JA}$	216	

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3) ( $i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C}$ )	۷F	1.1 0.8	Volts
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	5.0 150	μΑ
Maximum Reverse Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 50 A/µs)	t <sub>rr</sub>	65	ns

1. Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.

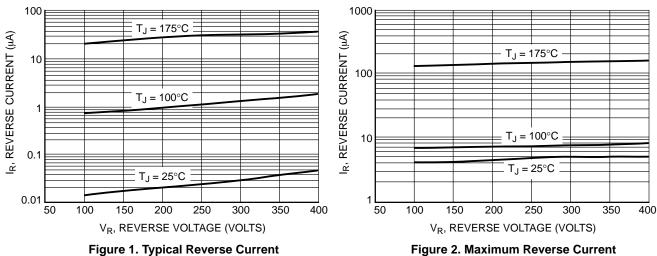
2. In compliance with JEDEC 51, these values (historically represented by  $R_{\theta JL}$ ) are now referenced as  $Psi_{JL}$ . 3. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

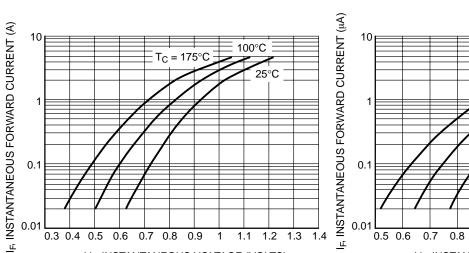
0.1

0.01

0.3 0.4

0.5 0.6





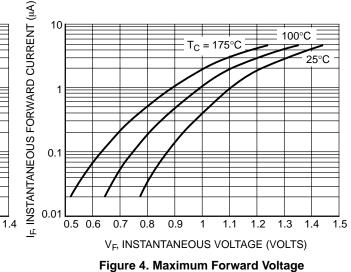
0.7 0.8 0.9

V<sub>F</sub>, INSTANTANEOUS VOLTAGE (VOLTS)

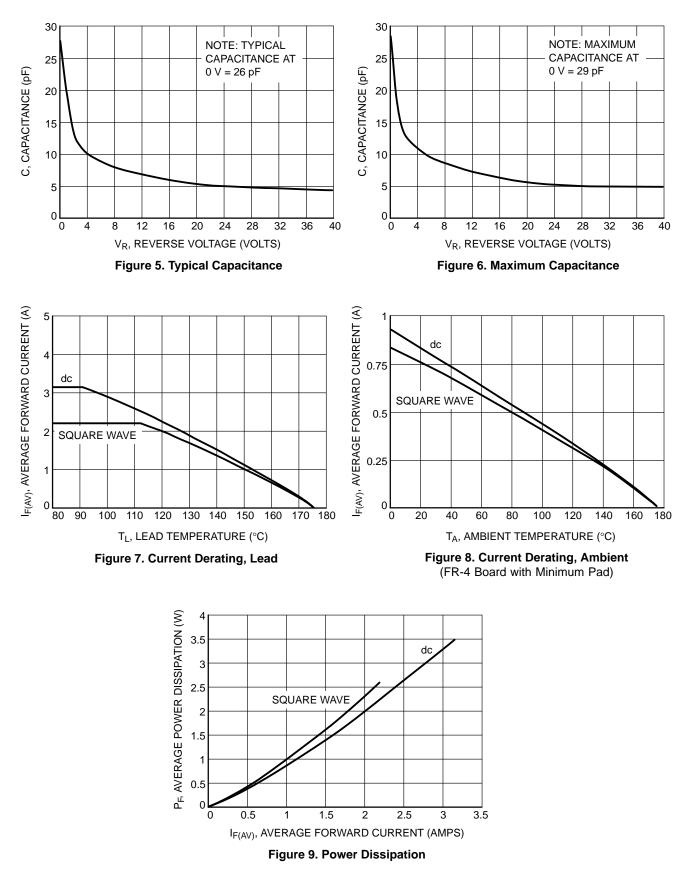
Figure 3. Typical Forward Voltage

1 1.1 1.2 1.3





## **MURA130T3, MURA140T3**



# **MURA160T3**

Preferred Device

## Surface Mount Ultrafast Power Rectifier

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (1.05 Volts Max @  $1.0 \text{ A}, \text{T}_{J} = 150^{\circ}\text{C}$ )

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 5000 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C)
- Marking: U4J

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600	V
Average Rectified Forward Current @ $T_L = 145^{\circ}C$ @ $T_L = 110^{\circ}C$	I <sub>F(AV)</sub>	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	30	A
Operating Junction Temperature Range	Τ <sub>J</sub>	- 65 to +175	°C



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## ULTRAFAST RECTIFIER 1 AMPERE 600 VOLTS







U4J = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MURA160T3	SMA	5000/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

## **MURA160T3**

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Lead ( $T_L = 25^{\circ}C$ ) (Note 1)	Psi <sub>JL</sub> (Note 2)	24	°C/W
Thermal Resistance, Junction to Ambient (Note 1)	`R <sub>θJA</sub> ´	216	

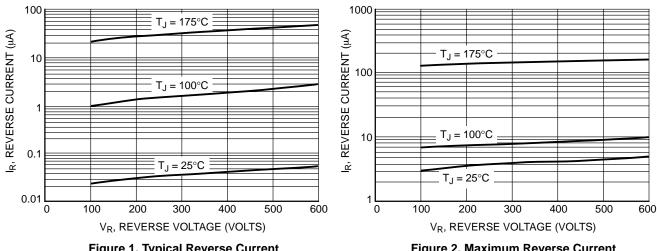
#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3) ( $i_F = 1.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 1.0 \text{ A}, T_J = 150^{\circ}\text{C}$ )	v <sub>F</sub>	1.25 1.05	Volts
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	5.0 150	μΑ
Maximum Reverse Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 50 A/µs)	t <sub>rr</sub>	75	ns

1. Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.

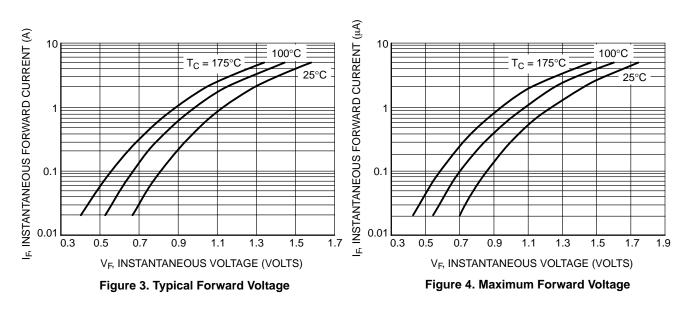
In compliance with JEDEC 51, these values (historically represented by  $R_{\theta,JL}$ ) are now referenced as Psi<sub>JL</sub>. 2.

3. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

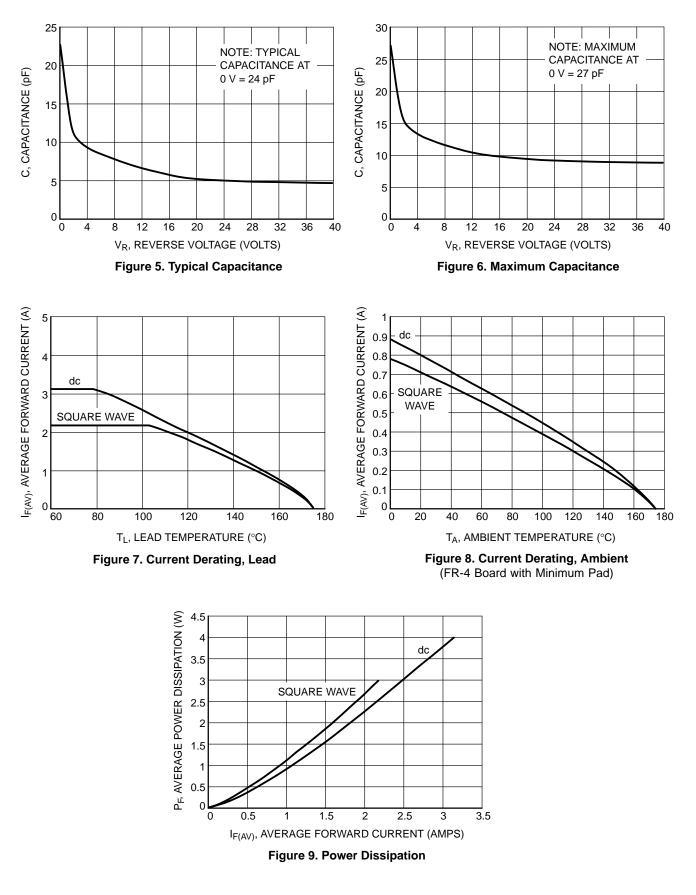








## **MURA160T3**



# MURA205T3, MURA210T3

**Preferred Devices** 

## Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.74 Volts Max @ 2.0 A,  $T_J = 150^{\circ}C$ )

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 5000 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C)
- Marking: U5A, U5B

#### MAXIMUM RATINGS

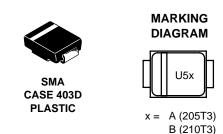
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURA205T3 MURA210T3	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50 100	V
Average Rectified Forward Current @ $T_L = 155^{\circ}C$ @ $T_L = 135^{\circ}C$	I <sub>F(AV)</sub>	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	50	A
Operating Junction Temperature Range	TJ	- 65 to +175	°C



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## ULTRAFAST RECTIFIERS 2 AMPERES 50-100 VOLTS



#### **ORDERING INFORMATION**

Device	Package	Shipping
MURA205T3	SMA	5000/Tape & Reel
MURA210T3	SMA	5000/Tape & Reel

## MURA205T3, MURA210T3

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Lead (Note 1)	Psi <sub>JL</sub> (Note 2)	24	°C/W
Thermal Resistance, Junction to Ambient (Note 1)	$R_{ extsf{ heta}JA}$	216	

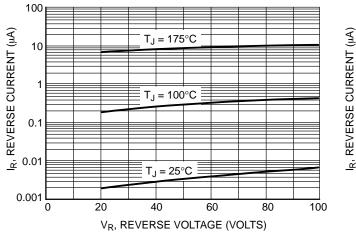
#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3) ( $i_F = 2.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 2.0 \text{ A}, T_J = 150^{\circ}\text{C}$ )	VF	0.94 0.74	Volts
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	2.0 50	μΑ
Maximum Reverse Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 50 A/µs)	t <sub>rr</sub>	30	ns

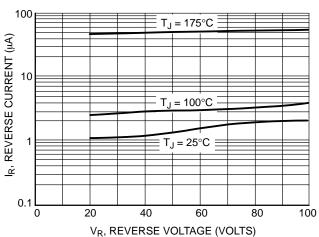
1. Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.

2. In compliance with JEDEC 51, these values (historically represented by  $R_{\theta,L}$ ) are now referenced as  $Psi_{JL}$ .

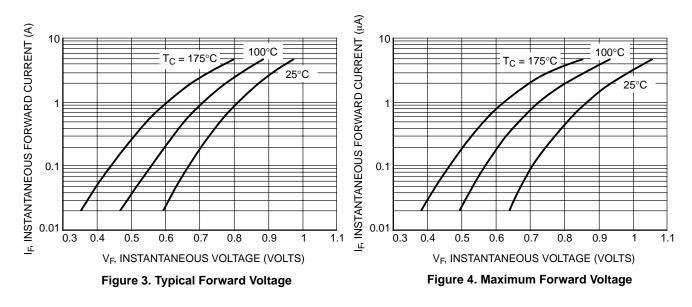
3. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



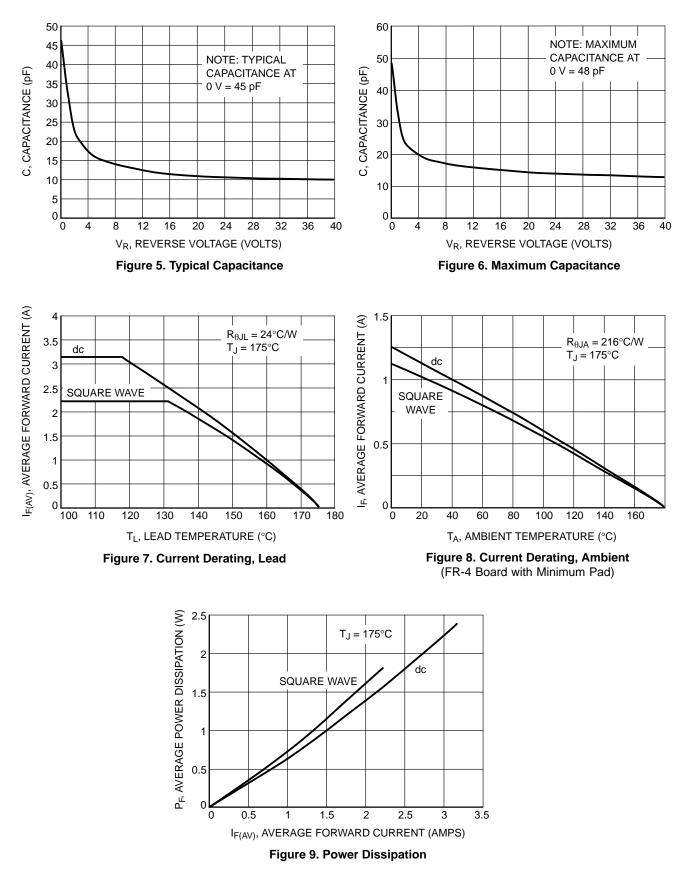




#### Figure 2. Maximum Reverse Current



## MURA205T3, MURA210T3



# **MURA215T3, MURA220T3**

**Preferred Devices** 

## Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.77 Volts Max @ 2.0 A,  $T_J = 150^{\circ}C$ )

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 5000 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C)
- Marking: U5C, U5D

#### MAXIMUM RATINGS

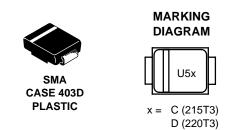
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURA215T3 MURA220T3	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	150 200	V
Average Rectified Forward Current @ $T_L = 155^{\circ}C$ @ $T_L = 135^{\circ}C$	I <sub>F(AV)</sub>	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	40	A
Operating Junction Temperature Range	TJ	- 65 to +175	°C



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## ULTRAFAST RECTIFIERS 2 AMPERES 100-200 VOLTS



#### **ORDERING INFORMATION**

Device	Package	Shipping
MURA215T3	SMA	5000/Tape & Reel
MURA220T3	SMA	5000/Tape & Reel

## **MURA215T3, MURA220T3**

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Lead ( $T_L = 25^{\circ}C$ ) (Note 1)	Psi <sub>JL</sub> (Note 2)	24	°C/W
Thermal Resistance, Junction to Ambient (Note 1)	$R_{\theta JA}$	216	

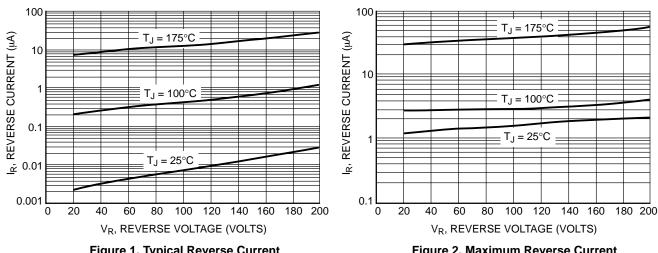
#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3) ( $i_F = 2.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 2.0 \text{ A}, T_J = 150^{\circ}\text{C}$ )	VF	0.95 0.77	Volts
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	2.0 50	μΑ
Maximum Reverse Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 50 A/μs)	t <sub>rr</sub>	35	ns

1. Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.

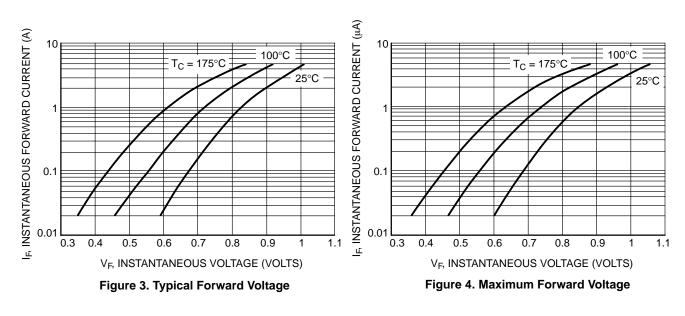
In compliance with JEDEC 51, these values (historically represented by  $R_{\theta,JL}$ ) are now referenced as Psi<sub>JL</sub>. 2.

3. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

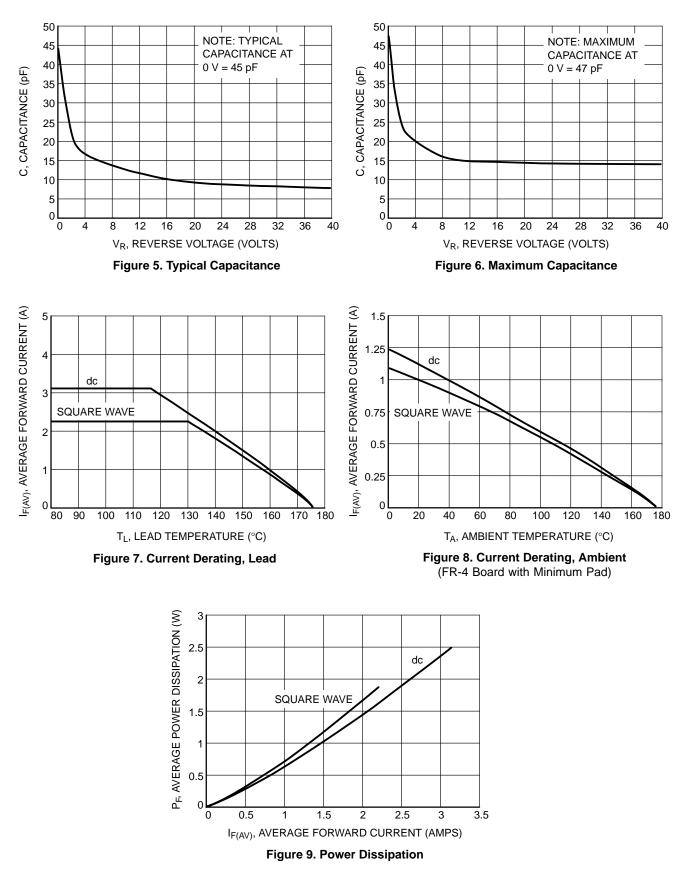








## MURA215T3, MURA220T3



# **MURA230T3, MURA240T3**

**Preferred Devices** 

## Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.95 Volts Max @ 2.0 A,  $T_J = 150^{\circ}C$ )

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 5000 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C)
- Marking: U5F, U5G

#### MAXIMUM RATINGS

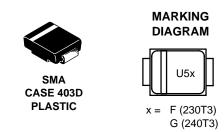
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MURA230T3 MURA240T3	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	300 400	V
Average Rectified Forward Current @ $T_L = 150^{\circ}C$ @ $T_L = 125^{\circ}C$	I <sub>F(AV)</sub>	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	35	A
Operating Junction Temperature Range	TJ	- 65 to +175	°C



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## ULTRAFAST RECTIFIERS 2 AMPERES 300-400 VOLTS



#### **ORDERING INFORMATION**

Device	Package	Shipping
MURA230T3	SMA	5000/Tape & Reel
MURA240T3	SMA	5000/Tape & Reel

## MURA230T3, MURA240T3

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Lead ( $T_L = 25^{\circ}C$ ) (Note 1)	Psi <sub>JL</sub> (Note 2)	24	°C/W
Thermal Resistance, Junction to Ambient (Note 1)	$R_{\theta JA}$	216	

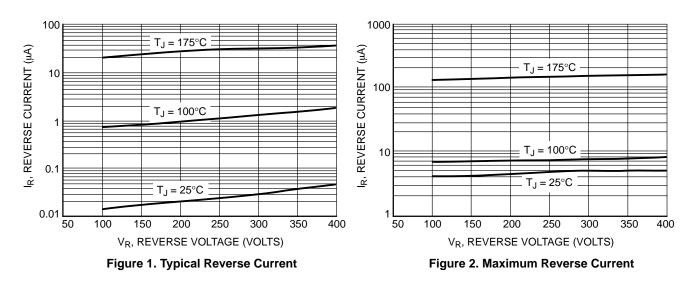
#### **ELECTRICAL CHARACTERISTICS**

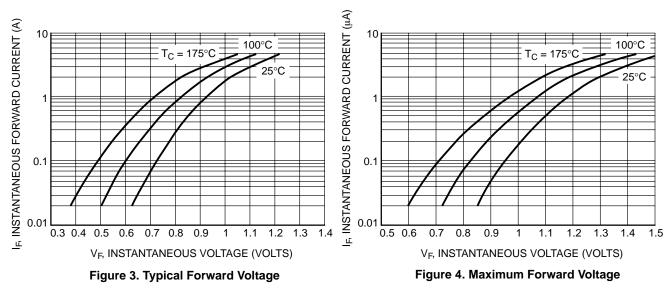
Maximum Instantaneous Forward Voltage (Note 3) ( $i_F = 2.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 2.0 \text{ A}, T_J = 150^{\circ}\text{C}$ )	VF	1.30 1.05	Volts
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	5.0 150	μΑ
Maximum Reverse Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 50 A/µs)	t <sub>rr</sub>	65	ns

1. Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.

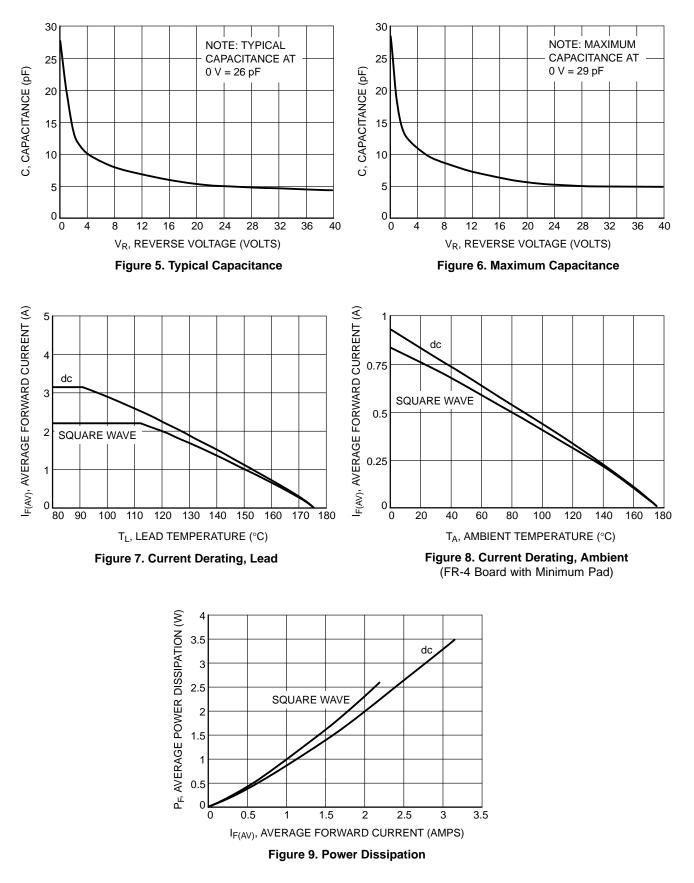
2. In compliance with JEDEC 51, these values (historically represented by  $R_{\theta,L}$ ) are now referenced as  $Psi_{JL}$ .

3. Pulse Test: Pulse Width =  $300 \,\mu$ s, Duty Cycle  $\leq 2.0\%$ .





## MURA230T3, MURA240T3



# **MURA260T3**

Preferred Device

## Surface Mount Ultrafast Power Rectifier

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (1.2 Volts Max @ 2.0 A,  $T_J = 150^{\circ}C$ )

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 70 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 5000 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- ESD Protection: Human Body Model > 4000 V (Class 3) Machine Model > 400 V (Class C)
- Marking: U5J

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600	V
Average Rectified Forward Current @ $T_L = 145^{\circ}C$ @ $T_L = 110^{\circ}C$	I <sub>F(AV)</sub>	1.0 2.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	30	A
Operating Junction Temperature Range	Τ <sub>J</sub>	- 65 to +175	°C



### **ON Semiconductor®**

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### ULTRAFAST RECTIFIER 2 AMPERES 600 VOLTS





U5J = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MURA260T3	SMA	5000/Tape & Reel

## **MURA260T3**

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction to Lead ( $T_L = 25^{\circ}C$ ) (Note 1)	Psi <sub>JL</sub> (Note 2)	24	°C/W
Thermal Resistance, Junction to Ambient (Note 1)	`R <sub>θJA</sub> ´	216	

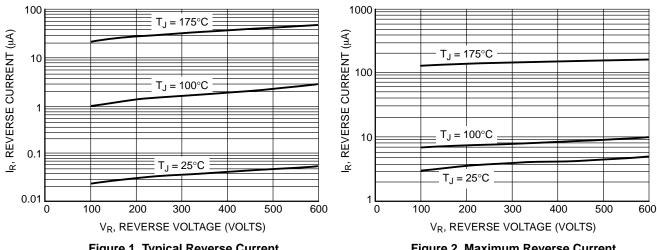
#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 3) ( $i_F = 2.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 2.0 \text{ A}, T_J = 150^{\circ}\text{C}$ )	VF	1.45 1.20	Volts
Maximum Instantaneous Reverse Current (Note 3) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	5.0 150	μΑ
Maximum Reverse Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 50 A/µs)	t <sub>rr</sub>	75	ns

1. Rating applies when surface mounted on the minimum pad size recommended, PC Board FR-4.

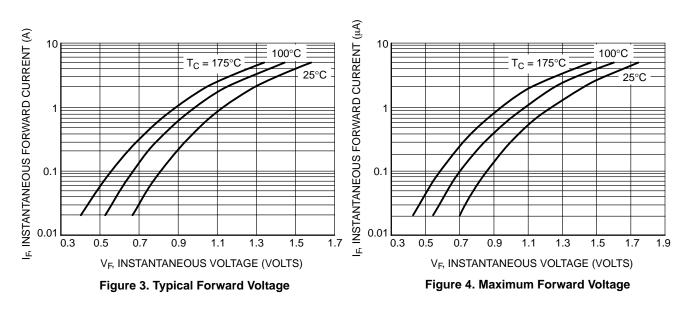
In compliance with JEDEC 51, these values (historically represented by  $R_{\theta,JL}$ ) are now referenced as Psi<sub>JL</sub>. 2.

3. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

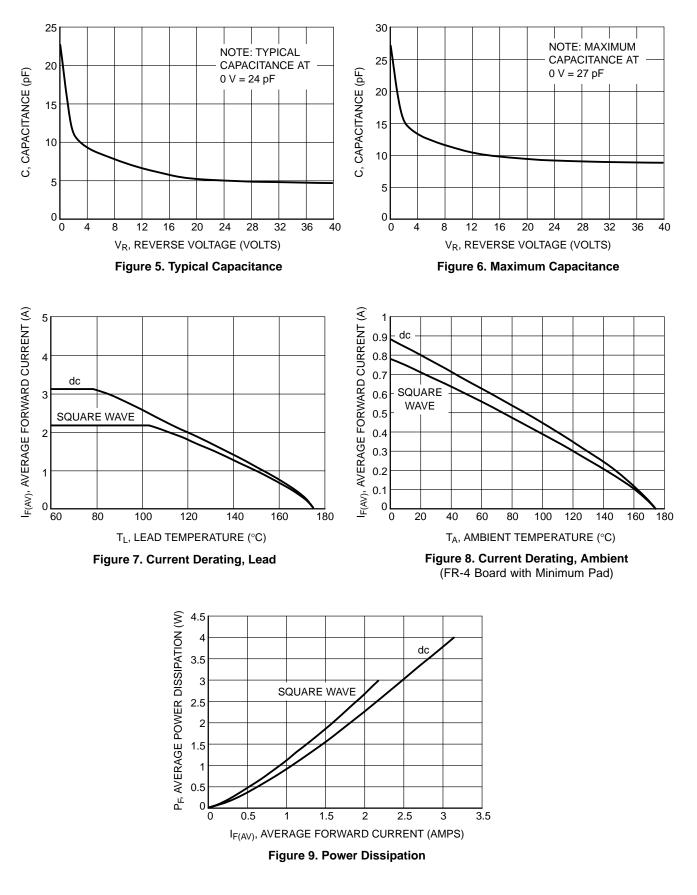








## **MURA260T3**



**Preferred Devices** 

## Surface Mount Ultrafast Power Rectifiers

## MURS105T3, MURS110T3, MURS115T3, MURS120T3, MURS140T3, MURS160T3

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.71 to 1.05 Volts Max @ 1.0 A,  $T_J = 150^{\circ}C$ )

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- Marking: U1A, U1B, U1C, U1D, U1G, U1J

#### MAXIMUM RATINGS

Please See the Table on the Following Page



### ON Semiconductor<sup>™</sup>

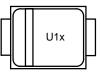
http://onsemi.com

## ULTRAFAST RECTIFIERS 1.0 AMPERE 50-600 VOLTS



SMB CASE 403A

#### MARKING DIAGRAM



U1x= Device Code x = Specific Device Code A, B, C, D, G or J

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the table on page 375 of this data sheet.

#### **DEVICE MARKING INFORMATION**

See general marking information in the device marking table on page 375 of this data sheet.

#### MAXIMUM RATINGS

			MURS					
Rating	Symbol	105T3	110T3	115T3	120T3	140T3	160T3	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	150	200	400	600	Volts
Average Rectified Forward Current	I <sub>F(AV)</sub>		1.0 @ T <sub>L</sub> = 155°C 2.0 @ T <sub>L</sub> = 145°C		1.0 @ T <sub>L</sub> 2.0 @ T <sub>L</sub>		Amps	
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	40		3	5	Amps		
Operating Junction Temperature	Τ <sub>J</sub>			-65 t	o +175	•		°C

#### THERMAL CHARACTERISTICS

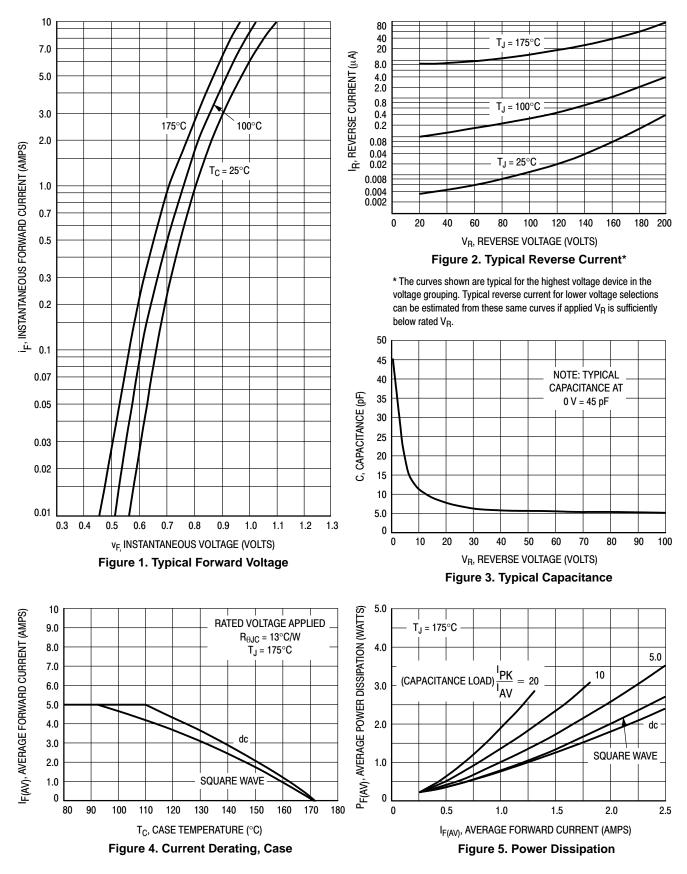
Thermal Resistance, Junction to Lead $(T_L = 25^{\circ}C)$	R <sub>θJL</sub>	13		°C/W				
ELECTRICAL CHARACTERISTICS								
$\label{eq:maximum lnstantaneous Forward Voltage (Note 1)} \begin{array}{l} (i_F = 1.0 \text{ A},  \text{T}_J = 25^\circ\text{C}) \\ (i_F = 1.0 \text{ A},  \text{T}_J = 150^\circ\text{C}) \end{array}$	v <sub>F</sub>	0.875 0.71	1.25 1.05	Volts				
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	2.0 50	5.0 150	μΑ				
$\begin{array}{l} \mbox{Maximum Reverse Recovery Time} \\ (i_F = 1.0 \mbox{ A, di/dt} = 50 \mbox{ A/}\mu s) \\ (i_F = 0.5 \mbox{ A, i}_R = 1.0 \mbox{ A, I}_R \mbox{ to } 0.25 \mbox{ A}) \end{array}$	t <sub>rr</sub>	35 25	75 50	ns				
Maximum Forward Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 100 A/μs, Rec. to 1.0 V)	t <sub>fr</sub>	25	50	ns				

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

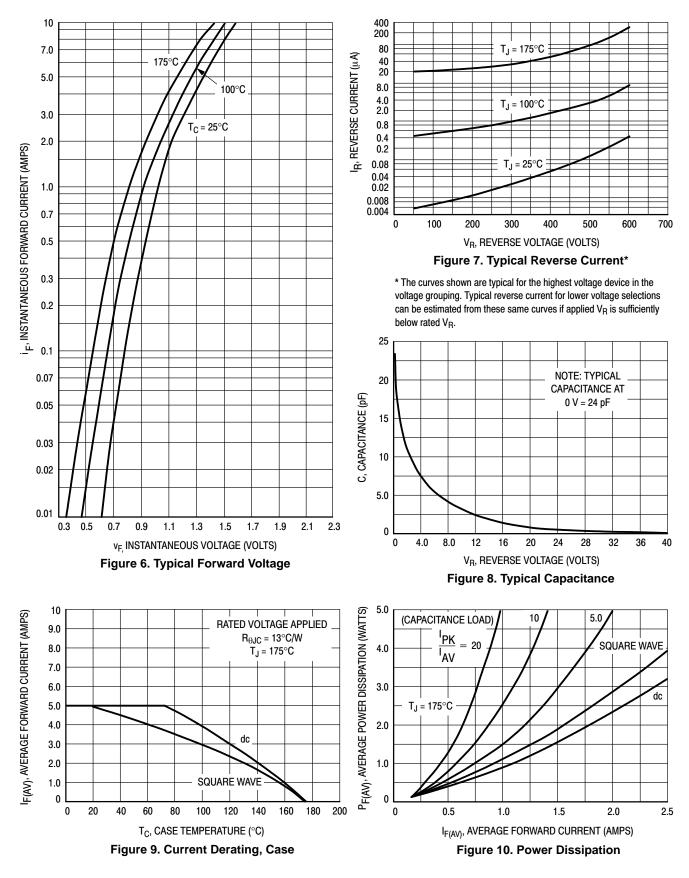
#### **DEVICE MARKING AND ORDERING INFORMATION**

Device	Marking	Package	Shipping
MURS105T3	U1A	SMB	2500 Units/Tape & Reel
MURS110T3	U1B	SMB	2500 Units/Tape & Reel
MURS115T3	U1C	SMB	2500 Units/Tape & Reel
MURS120T3	U1D	SMB	2500 Units/Tape & Reel
MURS140T3	U1G	SMB	2500 Units/Tape & Reel
MURS160T3	U1J	SMB	2500 Units/Tape & Reel

#### MURS105T3, MURS110T3, MURS115T3, MURS120T3



#### **MURS140T3, MURS160T3**



# **MURS220T3**

Preferred Device

## Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.77 Volts Max @ 2.0 A, T<sub>J</sub> = 150°C)

#### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- Marking: U2D

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	V
Average Rectified Forward Current	I <sub>F(AV)</sub>	2.0 @ T <sub>L</sub> = 145°C	A
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	40	A
Operating Junction Temperature Range	TJ	-65 to +175	°C



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## ULTRAFAST RECTIFIERS 2 AMPERES 200 VOLTS





U2D

SMB CASE 403A



U2D = Specific Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MURS220T3	SMB	2500/Tape & Reel

### **MURS220T3**

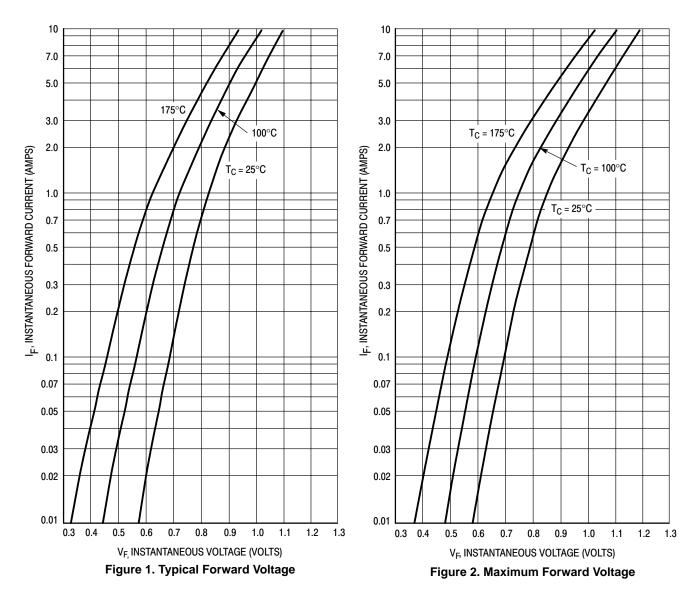
#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Lead $(T_L = 25^{\circ}C)$	$R_{ extsf{ heta}JL}$	13	°C/W

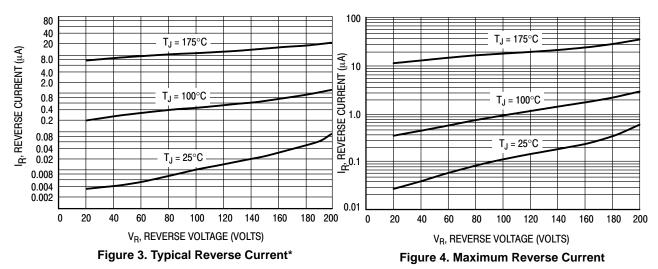
#### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 1.) ( $i_F = 2.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 2.0 \text{ A}, T_J = 150^{\circ}\text{C}$ )	VF	0.95 0.77	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	2.0 50	μΑ
Maximum Reverse Recovery Time ( $i_F = 1.0 \text{ A}, \text{ di/dt} = 50 \text{ A/}\mu\text{s}$ ) ( $i_F = 0.5 \text{ A}, i_R = 1.0 \text{ A}, I_R \text{ to } 0.25 \text{ A}$ )	t <sub>rr</sub>	35 25	ns
Maximum Forward Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 100 A/μs, Rec. to 1.0 V)	t <sub>fr</sub>	25	ns

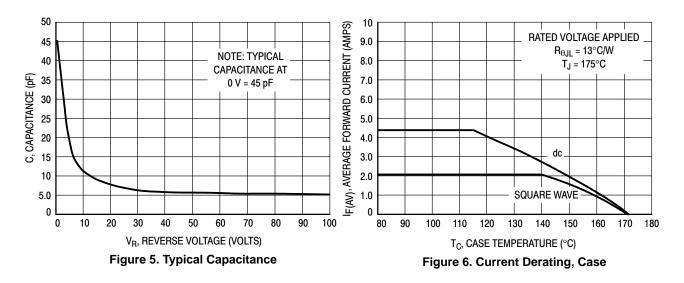
1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

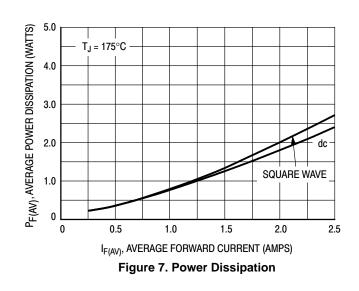


### **MURS220T3**



\* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if applied  $V_R$  is sufficiently below rated  $V_R$ .





# **MURS230T3, MURS240T3**

**Preferred Devices** 

## Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (0.95 Volts Max @ 2.0 A,  $T_J = 150^{\circ}C$ )

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- Marking: U2F, U2G

#### MAXIMUM RATINGS

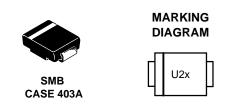
Rating	Symbol	Value	Unit
Peak Repetitive Reverse VoltageWorking Peak Reverse VoltageDC Blocking VoltageMURS230T3MURS240T3	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	300 400	V
Average Rectified Forward Current	I <sub>F(AV)</sub>	1.0 @ T <sub>L</sub> = 150°C 2.0 @ T <sub>L</sub> = 125°C	A
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	35	A
Operating Junction Temperature Range	Τ <sub>J</sub>	-65 to +175	°C



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## ULTRAFAST RECTIFIERS 2 AMPERES 300-400 VOLTS



x = F (230T3) G (240T3)

### ORDERING INFORMATION

Device	Package	Shipping
MURS230T3	SMB	2500/Tape & Reel
MURS240T3	SMB	2500/Tape & Reel

## MURS230T3, MURS240T3

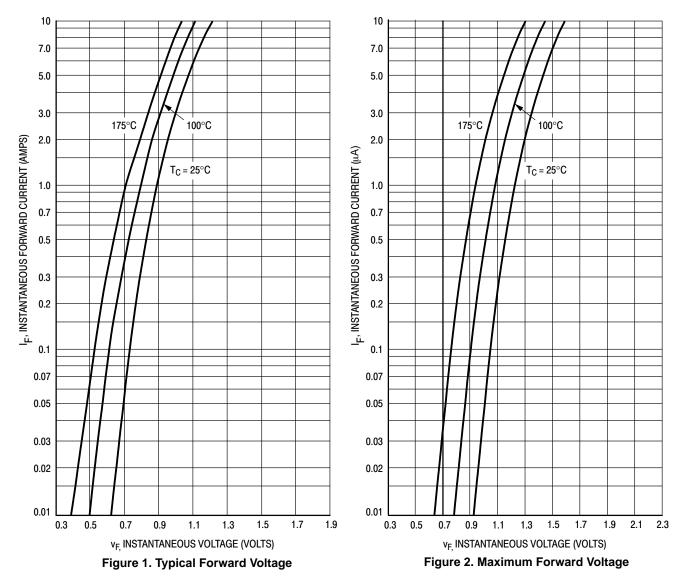
#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance, Junction to Lead $(T_L = 25^{\circ}C)$	$R_{ extsf{ heta}JL}$	13	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 1.)	٧ <sub>F</sub>		Volts
$(i_F = 2.0 \text{ A}, T_J = 25^{\circ}\text{C})$ $(i_F = 2.0 \text{ A}, T_J = 150^{\circ}\text{C})$		1.30 1.05	
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	5.0 150	μΑ
Maximum Reverse Recovery Time ( $i_F = 1.0 \text{ A}, \text{ di/dt} = 50 \text{ A/}\mu\text{s}$ ) ( $i_F = 0.5 \text{ A}, i_R = 1.0 \text{ A}, I_R \text{ to } 0.25 \text{ A}$ )	t <sub>rr</sub>	65 50	ns
Maximum Forward Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 100 A/μs, Rec. to 1.0 V)	t <sub>fr</sub>	50	ns

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



### MURS230T3, MURS240T3

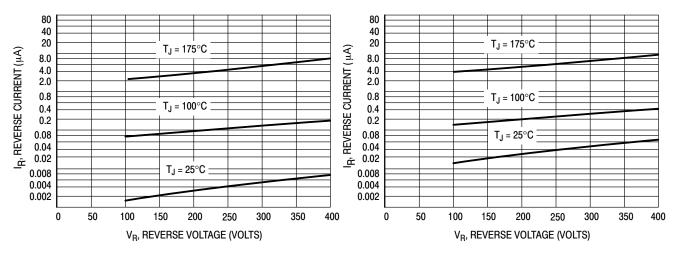
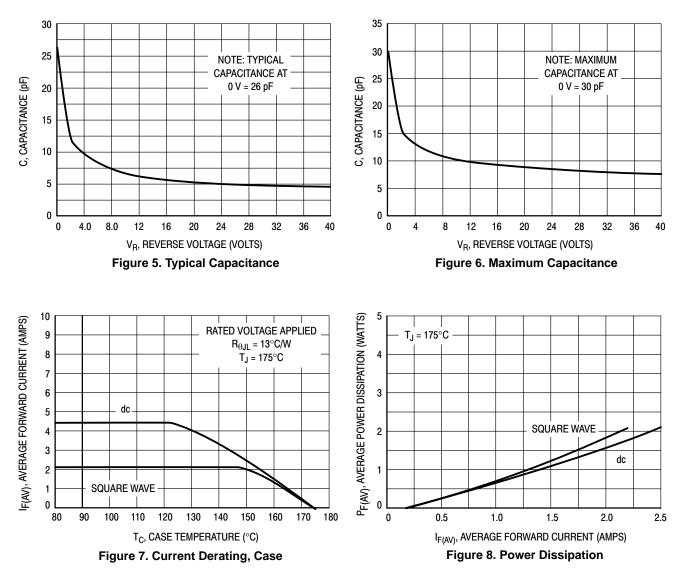




Figure 4. Maximum Reverse Current\*

\* The curves shown are typical for the highest voltage device in the voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if applied  $V_R$  is sufficiently below rated  $V_R$ .



# MURS260T3

Preferred Device

## Surface Mount Ultrafast Power Rectifiers

Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- High Temperature Glass Passivated Junction
- Low Forward Voltage Drop (1.20 Volts Max @ 2.0 A,  $T_J = 150^{\circ}C$ )

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 12 mm Tape and Reel, 2500 units per reel
- Polarity: Polarity Band Indicates Cathode Lead
- Marking: U2J

#### MAXIMUM RATINGS

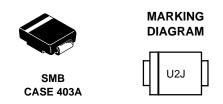
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600	Volts
Average Rectified Forward Current	I <sub>F(AV)</sub>	2.0 @ T <sub>L</sub> = 125°C	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	35	Amps
Operating Junction Temperature	Τ <sub>J</sub>	- 65 to +175	°C



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## ULTRAFAST RECTIFIERS 2 AMPERES 600 VOLTS



U2J = Specific Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MURS260T3	SMB	2500/Tape & Reel

## **MURS260T3**

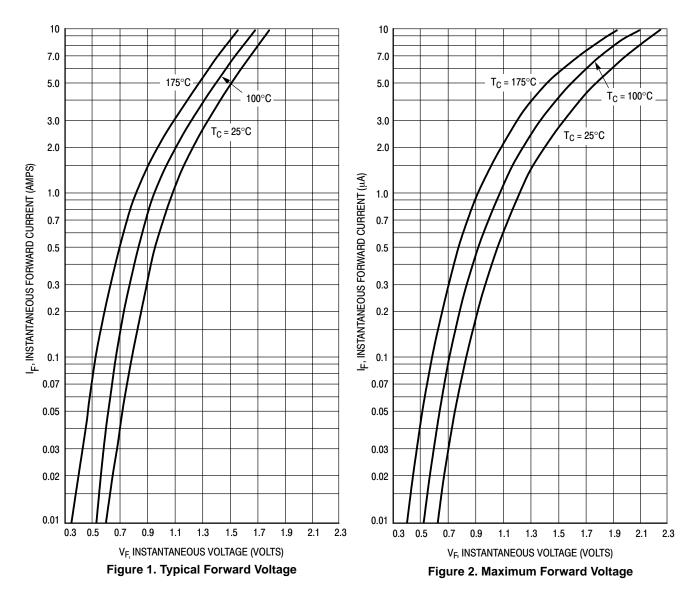
#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Lead $(T_L = 25^{\circ}C)$	$R_{ extsf{ heta}JL}$	13	°C/W

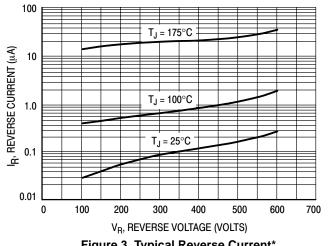
#### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 1.) ( $i_F = 2.0 \text{ A}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 2.0 \text{ A}, T_J = 150^{\circ}\text{C}$ )	VF	1.45 1.20	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	İR	5.0 150	μΑ
Maximum Reverse Recovery Time ( $i_F = 1.0 \text{ A}, \text{ di/dt} = 50 \text{ A/}\mu\text{s}$ ) ( $i_F = 0.5 \text{ A}, i_R = 1.0 \text{ A}, I_R \text{ to } 0.25 \text{ A}$ )	t <sub>rr</sub>	75 50	ns
Maximum Forward Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 100 A/μs, Rec. to 1.0 V)	t <sub>fr</sub>	50	ns

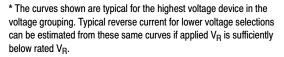
1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



### **MURS260T3**







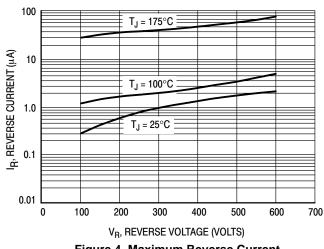
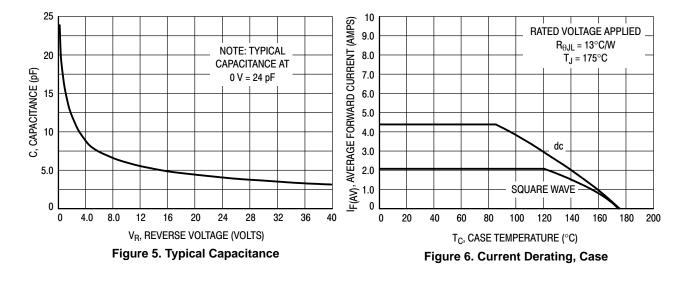
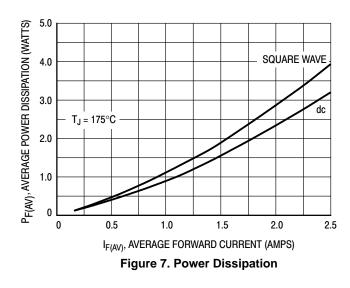


Figure 4. Maximum Reverse Current





## MURS320T3, MURS340T3, MURS360T3

Preferred Devices

## Surface Mount Ultrafast Power Rectifiers

... employing state-of-the-art epitaxial construction with oxide passivation and metal overlay contact. Ideally suited for high voltage, high frequency rectification, or as free wheeling and protection diodes, in surface mount applications where compact size and weight are critical to the system.

- Small Compact Surface Mountable Package with J-Bend Leads
- Rectangular Package for Automated Handling
- Highly Stable Oxide Passivated Junction
- Low Forward Voltage Drop (0.71 to 1.05 Volts Max @ 3.0 A, T<sub>J</sub> = 150°C)

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 217 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in 16 mm Tape and Reel, 2500 units per reel
- Polarity: Notch in Plastic Body Indicates Cathode Lead
- Marking: U3D, U3G, U3J

#### MAXIMUM RATINGS

Please See the Table on the Following Page



## **ON Semiconductor®**

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#### ULTRAFAST RECTIFIERS 3.0 AMPERES 200-600 VOLTS



SMC CASE 403 PLASTIC

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

Device	Package	Shipping
MURS320T3	SMC	2500/Tape & Reel
MURS340T3	SMC	2500/Tape & Reel
MURS360T3	SMC	2500/Tape & Reel

## MURS320T3, MURS340T3, MURS360T3

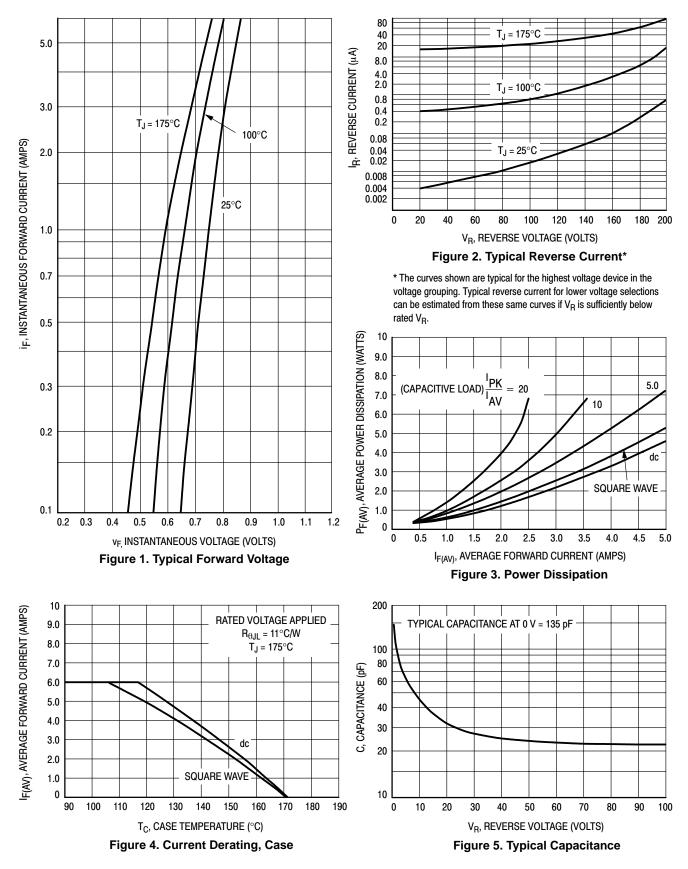
#### MAXIMUM RATINGS

Rating	Symbol	MURS320T3	MURS340T3	MURS360T3	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	400	600	Volts
Average Rectified Forward Current	I <sub>F(AV)</sub>	3.0 @ T <sub>L</sub> = 140°C 4.0 @ T <sub>L</sub> = 130°C	-	3.0 @ T <sub>L</sub> = 130°C 4.0 @ T <sub>L</sub> = 115°C	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>		75		Amps
Operating Junction Temperature	TJ		-65 to +175		°C
THERMAL CHARACTERISTICS		•			
Thermal Resistance, Junction to Lead	$R_{\theta JL}$	11			°C/W
ELECTRICAL CHARACTERISTICS		·			
	VF	0.875 0.89 0.71	1.25 1.28 1.05	1.25 1.28 1.05	Volts
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 25^{\circ}C$ ) (Rated dc Voltage, $T_J = 150^{\circ}C$ )	i <sub>R</sub>	5.0 150	10 250	10 250	μΑ
Maximum Reverse Recovery Time ( $i_F = 1.0 \text{ A}$ , di/dt = 50 A/µs) ( $i_F = 0.5 \text{ A}$ , $i_R = 1.0 \text{ A}$ , $I_{REC}$ to 0.25 A)	t <sub>rr</sub>	35 25	75 50	75 50	ns
Maximum Forward Recovery Time $(i_F = 1.0 \text{ A}, \text{ di/dt} = 100 \text{ A}/\mu\text{s}, \text{ Recovery to } 1.0 \text{ V})$	t <sub>fr</sub>	25	50	50	ns

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

### MURS320T3, MURS340T3, MURS360T3

### **MURS320T3**



### MURS320T3, MURS340T3, MURS360T3

#### 400 200 5.0 T<sub>J</sub> = 175°C 80 I<sub>R</sub>, REVERSE CURRENT (µA) 40 20 3.0 8.0 4.0 2.0 T<sub>J</sub> = 175°C T<sub>J</sub> = 100°C 100°C 2.0 0.8 0.4 0.2 25°C 0.08 T<sub>J</sub> = 25°C 0.04 0.02 1.0 0.008 0.7 0.004 0 100 200 300 400 700 500 600 0.5 V<sub>R</sub>, REVERSE VOLTAGE (VOLTS) Figure 7. Typical Reverse Current\* \* The curves shown are typical for the highest voltage device in the 0.3 voltage grouping. Typical reverse current for lower voltage selections can be estimated from these same curves if V<sub>R</sub> is sufficiently below 0.2 rated V<sub>B</sub>. PF(AV), AVERAGE POWER DISSIPATION (WATTS) 10 9.0 0.1 8.0 7.0 0.07 SQUARE WAVE 6.0 dc (CAPACITIVE LOADS) 5.0 0.05 4.0 <u> PK</u> = 20 10 5.0 3.0 Ά٧ 0.03 2.0 0.02 1.0 0.3 0.5 0.7 0.9 1.1 1.3 1.5 1.7 1.9 2.1 2.3 0 0 0.5 1.0 1.5 2.0 2.5 3.0 3.5 4.0 4.5 5.0 v<sub>E</sub> INSTANTANEOUS VOLTAGE (VOLTS) IF(AV), AVERAGE FORWARD CURRENT (AMPS) Figure 6. Typical Forward Voltage **Figure 8. Power Dissipation** 10 100 9.0 90 8.0 80 TYPICAL CAPACITANCE AT 0 V = 75 pF 7.0 C, CAPACITANCE (pF) 70 60 6.0 5.0 50 4.0 40 dc 3.0 30 SQUARE WAVE 2.0 20 1.0 10 0 0 70 80 90 100 110 120 130 140 150 160 170 0 10 20 30 40 50 60 70 80 90 100

i<sub>F</sub>, INSTANTANEOUS FORWARD CURRENT (AMPS)

I<sub>F(AV)</sub>, AVERAGE FORWARD CURRENT (AMPS)

## MURS340T3, MURS360T3

http://onsemi.com 390 V<sub>R</sub>, REVERSE VOLTAGE (VOLTS)

Figure 10. Typical Capacitance

T<sub>C</sub>, CASE TEMPERATURE (°C)

Figure 9. Current Derating, Case

## MURD620CT

Preferred Device

## SWITCHMODE™ Power Rectifier

## **DPAK Surface Mount Package**

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Time
- Low Forward Voltage Drop
- Low Leakage

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: U620T

#### MAXIMUM RATINGS

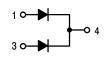
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 140$ °C) Per Diode Per Device	I <sub>F(AV)</sub>	3.0 6.0	A
$\begin{array}{l} \mbox{Peak Repetitive Forward Current} \\ \mbox{(Rated V}_R, \mbox{Square Wave,} \\ \mbox{20 kHz}, \mbox{T}_C = 145^\circ\mbox{C}) & \mbox{Per Diode} \end{array}$	l <sub>F</sub>	6.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, 60 Hz)	I <sub>FSM</sub>	50	A
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C



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ULTRAFAST RECTIFIER 6.0 AMPERES 200 VOLTS





CASE 369A PLASTIC

#### MARKING DIAGRAM



U620T = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping		
MURD620CT	DPAK	75 Units/Rail		
MURD620CTT4	DPAK	2500/Tape & Reel		

## MURD620CT

#### THERMAL CHARACTERISTICS (Per Diode)

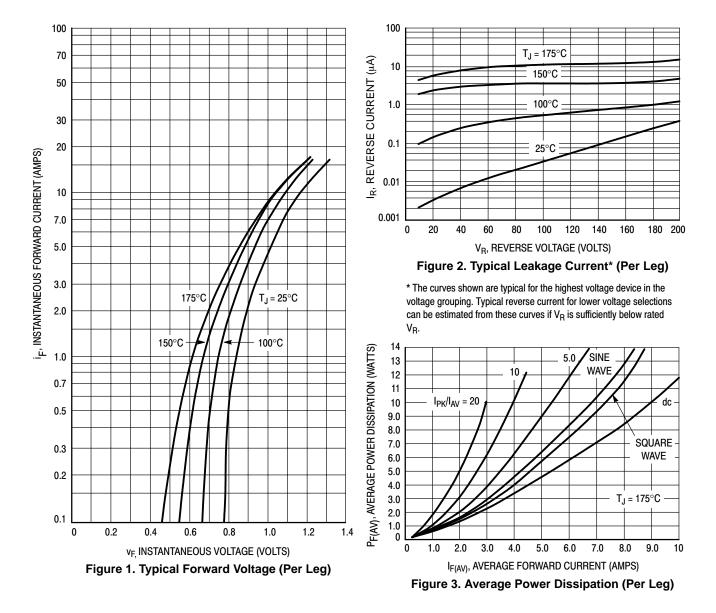
Rating	Symbol	Value	Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	9	°C/W
Junction to Ambient (Note 1)	R <sub>θJA</sub>	80	

#### ELECTRICAL CHARACTERISTICS (Per Diode)

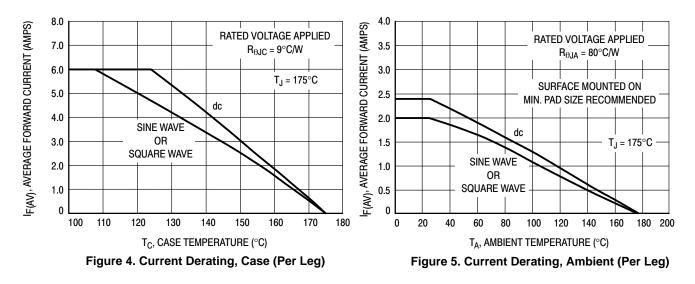
Maximum Instantaneous Forward Voltage Drop (Note 2)	VF		Volts
(i <sub>F</sub> = 3 Amps, T <sub>C</sub> = 25°C)		1	
$(i_F = 3 \text{ Amps}, T_C = 125^{\circ}C)$		0.96	
$(i_F = 6 \text{ Amps}, T_C = 25^{\circ}C)$		1.2	
$(i_F = 6 \text{ Amps}, T_C = 125^{\circ}C)$		1.13	
Maximum Instantaneous Reverse Current (Note 2)	i <sub>R</sub>		μA
$(T_J = 25^{\circ}C, Rated dc Voltage)$		5	
$(T_J = 125^{\circ}C, Rated dc Voltage)$		250	
Maximum Reverse Recovery Time	t <sub>rr</sub>		ns
(I <sub>F</sub> = 1 Amp, di/dt = 50 Amps/µs, V <sub>R</sub> = 30 V, T <sub>J</sub> = 25°C)		35	
(I <sub>F</sub> = 0.5 Amp, i <sub>R</sub> = 1 Amp, I <sub>REC</sub> = 0.25 A, V <sub>R</sub> = 30 V, T <sub>J</sub> = 25°C)		25	

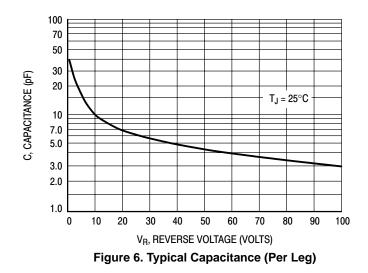
1. Rating applies when surface mounted on the minimum pad sizes recommended.

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



### MURD620CT





## MURD320

Preferred Device

## SWITCHMODE™ Power Rectifier

## **DPAK Surface Mount Package**

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Time
- Low Forward Voltage Drop
- Low Leakage

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 75 units per plastic tube
- Available in 16 mm Tape and Reel, 2500 units per reel, by adding a "T4" suffix to the part number
- Marking: U320

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	V
Average Rectified Forward Current (Rated V <sub>R</sub> , T <sub>C</sub> = 158°C)	I <sub>F(AV)</sub>	3.0	A
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 158°C)	I <sub>FRM</sub>	6.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, 60 Hz)	I <sub>FSM</sub>	75	A
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C



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ULTRAFAST RECTIFIER 3.0 AMPERES 200 VOLTS





DPAK CASE 369A PLASTIC

#### MARKING DIAGRAM



U320 = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping		
MURD320	DPAK	75 Units/Rail		
MURD320T4	DPAK	2500/Tape & Reel		

#### THERMAL CHARACTERISTICS

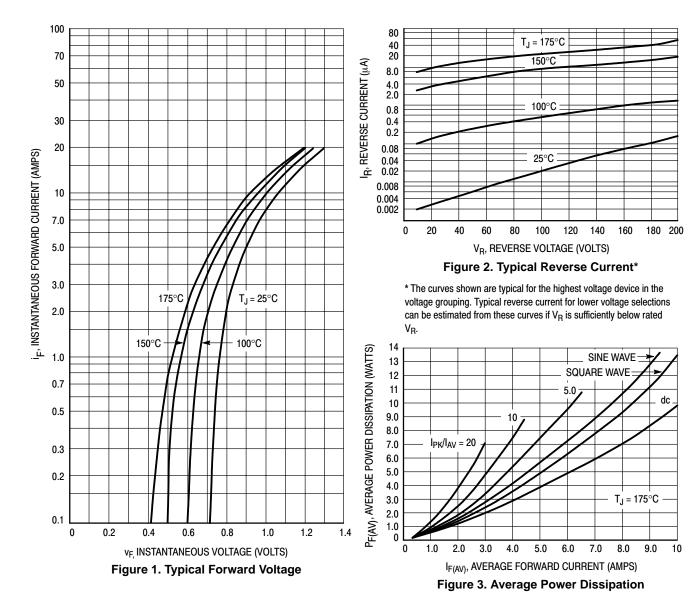
Rating	Symbol	Value	Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	6 80	°C/W
Junction to Ambient (Note 1.)	$R_{ extsf{ heta}JA}$	60	

#### ELECTRICAL CHARACTERISTICS

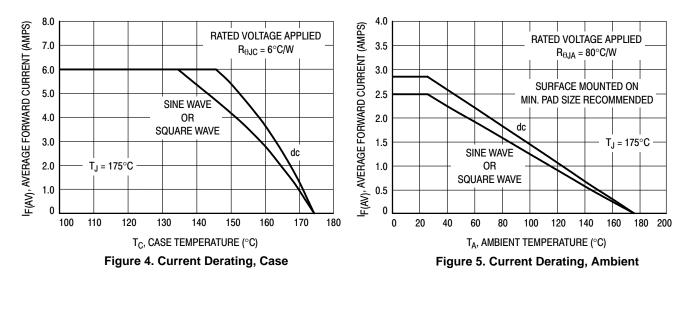
Maximum Instantaneous Forward Voltage Drop (Note 2.) ( $i_F = 3 \text{ Amps}, T_J = 25^{\circ}\text{C}$ ) ( $i_F = 3 \text{ Amps}, T_J = 125^{\circ}\text{C}$ )	VF	0.95 0.75	Volts
Maximum Instantaneous Reverse Current (Note 2.) $(T_J = 25^{\circ}C, Rated dc Voltage)$ $(T_J = 125^{\circ}C, Rated dc Voltage)$	i <sub>R</sub>	5 500	μΑ
Maximum Reverse Recovery Time $(I_F = 1 \text{ Amp, di/dt} = 50 \text{ Amps/}\mu s, V_R = 30 \text{ V, } T_J = 25^{\circ}\text{C})$ $(I_F = 0.5 \text{ Amp, i}_R = 1 \text{ Amp, } I_{REC} = 0.25 \text{ A, } V_R = 30 \text{ V, } T_J = 25^{\circ}\text{C})$	t <sub>rr</sub>	35 25	ns

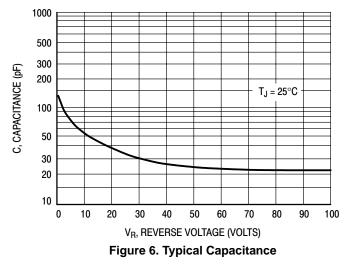
1. Rating applies when surface mounted on the minimum pad sizes recommended.

2. Pulse Test: Pulse Width =  $300 \ \mu$ s, Duty Cycle  $\leq 2.0\%$ .



### **MURD320**





# **MURHB840CT**

Preferred Device

# MEGAHERTZ™ Power Rectifier

# D<sup>2</sup>PAK Power Surface Mount Package

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Ultrafast 28 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Epoxy Meets UL94, V<sub>0</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability
- Low Leakage Specified @ 150°C Case Temperature
- Short Heat Sink Tab Manufactured Not Sheared!
- Similar in Size to Industrial Standard TO-220 Package

### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per reel by adding a "T4" suffix to the part number
- Marking: UH840

### MAXIMUM RATINGS (Per Leg)

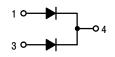
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	400	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 120°C) Total Device	I <sub>F(AV)</sub>	4.0 8.0	A
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 120°C)	I <sub>FM</sub>	8.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	100	A
Controlled Avalanche Energy	W <sub>AVAL</sub>	20	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C



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ULTRAFAST RECTIFIER 8.0 AMPERES 400 VOLTS







### MARKING DIAGRAM



UH840 = Device Code

### ORDERING INFORMATION

Device	Package	Shipping
MURHB840CT	D <sup>2</sup> PAK	50 Units/Rail
MURHB840CTT4	D <sup>2</sup> PAK	800/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

### MURHB840CT

### THERMAL CHARACTERISTICS (Per Leg)

Rating	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	°C/W
Maximum Thermal Resistance, Junction to Ambient (Note 1.)	$R_{\thetaJA}$	50	°C/W

#### ELECTRICAL CHARACTERISTICS (Per Leg)

, <b>-</b>			
Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 2.) $(i_F = 4.0 \text{ Amps}, T_C = 150^{\circ}\text{C})$ $(i_F = 4.0 \text{ Amps}, T_C = 25^{\circ}\text{C})$	۷F	1.9 2.2	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_C = 150^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	500 10	μΑ
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/μs)	t <sub>rr</sub>	28	ns

See Chapter 7 for mounting conditions 1.

2. Pulse Test: Pulse Width = 300 μs, Duty Cycle ≤2.0%

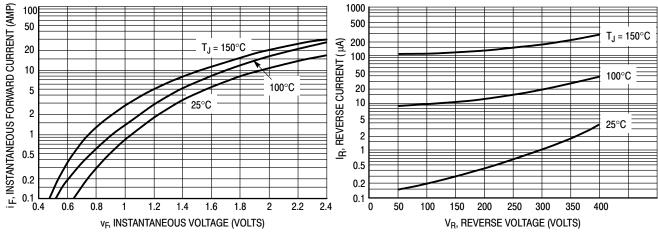
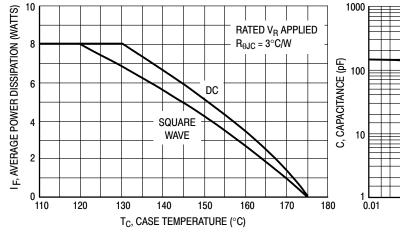
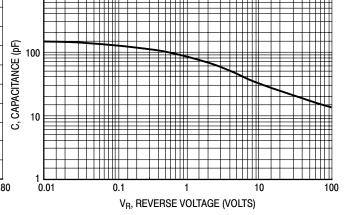




Figure 2. Typical Reverse Current, Per Leg









# MURHB840CT

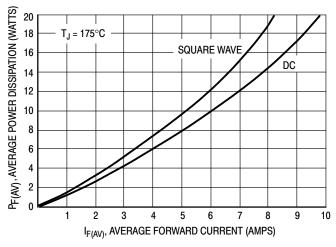


Figure 5. Forward Power Dissipation, Per Leg

# MURHB860CT

Preferred Device

# MEGAHERTZ™ Power Rectifier

# D<sup>2</sup>PAK Power Surface Mount Package

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Ultrafast 35 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 Volts
- Low Leakage Specified @ 150°C Case Temperature
- Short Heat Sink Tab Manufactured Not Sheared!
- Similar in Size to Industry Standard TO-220 Package

### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per reel by adding a "T4" suffix to the part number
- Marking: UH860

### MAXIMUM RATINGS (Per Leg)

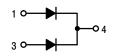
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 120°C) Total Device	I <sub>F(AV)</sub>	4.0 8.0	A
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 120^{\circ}C$ )	I <sub>FM</sub>	8.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	100	A
Operating Junction and Storage Temperature Range	TJ, T <sub>stg</sub>	-65 to +175	°C



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ULTRAFAST RECTIFIER 8.0 AMPERES 600 VOLTS





STYLE 3

### MARKING DIAGRAM



UH860 = Device Code

### ORDERING INFORMATION

Device	Package	Shipping
MURHB860CT	D <sup>2</sup> PAK	50 Units/Rail
MURHB860CTT4	D <sup>2</sup> PAK	800/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

## MURHB860CT

### THERMAL CHARACTERISTICS (Per Leg)

Rating	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	°C/W
Maximum Thermal Resistance, Junction to Ambient	$R_{\thetaJA}$	50	°C/W

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 1.) $(i_F = 4.0 \text{ Amps}, T_C = 150^{\circ}\text{C})$ $(i_F = 4.0 \text{ Amps}, T_C = 25^{\circ}\text{C})$	۷ <sub>F</sub>	2.5 2.8	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 150^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	500 10	μA
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/μs)	t <sub>rr</sub>	35	ns

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  ${\leq}2.0\%$ 

# MURB1620CT

Preferred Device

# SWITCHMODE™ Power Rectifier

# D<sup>2</sup>PAK Power Surface Mount Package

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Ultrafast 35 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Short Heat Sink Tab Manufactured Not Sheared!
- Similar in Size to Industrial Standard TO-220 Package
- Mechanical Characteristics
- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per reel by adding a "T4" suffix to the part number
- Marking: U1620

### MAXIMUM RATINGS (Per Leg)

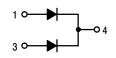
( <b>•</b> ,			
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 150°C) Total Device	I <sub>F(AV)</sub>	8.0 16	A
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 150^{\circ}C$ )	I <sub>FM</sub>	16	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	IFSM	100	A
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C



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ULTRAFAST RECTIFIER 16 AMPERES 200 VOLTS





# STYLE 3

### MARKING DIAGRAM



U1620 = Device Code

### ORDERING INFORMATION

Device	Package	Shipping
MURB1620CT	D <sup>2</sup> PAK	50 Units/Rail
MURB1620CTT4	D <sup>2</sup> PAK	800/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

### MURB1620CT

### THERMAL CHARACTERISTICS (Per Leg)

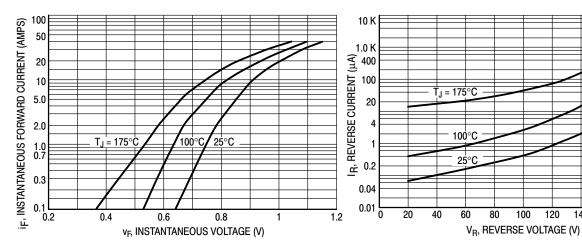
Rating	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	$R_{ extsf{ heta}JC}$	3	°C/W
Maximum Thermal Resistance, Junction to Ambient (Note 1.)	$R_{ extsf{ heta}JA}$	50	°C/W
Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	TL	260	°C

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (Note 2.) ( $i_F = 8 \text{ Amp}, T_C = 150^{\circ}\text{C}$ ) ( $i_F = 8 \text{ Amp}, T_C = 25^{\circ}\text{C}$ )	VF	0.895 0.975	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_C = 150^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	250 5	μΑ
Maximum Reverse Recovery Time (I <sub>F</sub> = 1 Amp, di/dt = 50 Amp/μs) (I <sub>F</sub> = 0.5 Amp, i <sub>R</sub> = 1 Amp, I <sub>REC</sub> = 0.25 Amp)	t <sub>rr</sub>	35 25	ns

1. See Chapter 7 for mounting conditions

2. Pulse Test: Pulse Width =  $300 \mu s$ , Duty Cycle  $\leq 2.0\%$ 







100

120

140

160

180 200

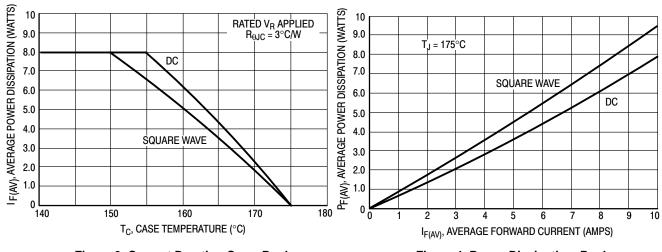
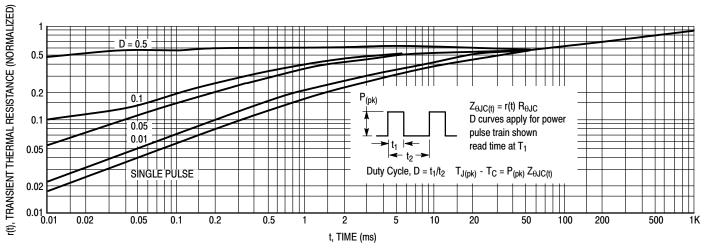


Figure 3. Current Derating Case, Per Leg



### MURB1620CT





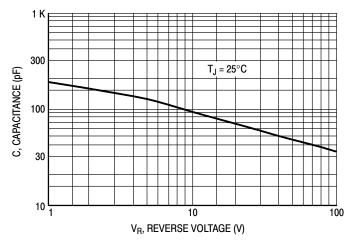


Figure 6. Typical Capacitance, Per Leg

# MURB1660CT

Preferred Device

# SWITCHMODE™ Power Rectifier

# D<sup>2</sup>PAK Power Surface Mount Package

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Package Designed for Power Surface Mount Applications
- Ultrafast 60 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 V
- Low Leakage Specified @ 150°C Case Temperature
- Short Heat Sink Tab Manufactured Not Sheared!
- Similar in Size to Industrial Standard TO-220 Package

### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.7 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Available in 24 mm Tape and Reel, 800 units per reel by adding a "T4" suffix to the part number
- Marking: U1660T

### MAXIMUM RATINGS (Per Leg)

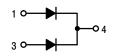
Rating	Symbol	Value	Unit			
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600	V			
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 150°C) Total Device	I <sub>F(AV)</sub>	8.0 16	A			
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 150°C)	I <sub>FM</sub>	16	A			
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	IFSM	100	A			
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C			



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ULTRAFAST RECTIFIER 16 AMPERES 600 VOLTS







### MARKING DIAGRAM



U1660T = Device Code

### ORDERING INFORMATION

Device	Package	Shipping
MURB1660CT	D <sup>2</sup> PAK	50 Units/Rail
MURB1660CTT4	D <sup>2</sup> PAK	800/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

### MURB1660CT

### THERMAL CHARACTERISTICS (Per Leg)

Rating	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	$R_{ extsf{ heta}JC}$	2	°C/W
Maximum Thermal Resistance, Junction to Ambient (Note 1.)	$R_{ extsf{ heta}JA}$	50	°C/W
Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	TL	260	°C

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Мах	Unit
Maximum Instantaneous Forward Voltage (Note 2.) ( $i_F = 8 \text{ Amp}, T_C = 150^{\circ}\text{C}$ )	v <sub>F</sub>	1.20	Volts
(i <sub>F</sub> = 8 Amp, T <sub>C</sub> = 25°C) Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, T <sub>C</sub> = 150°C) (Rated dc Voltage, T <sub>C</sub> = 25°C)	i <sub>R</sub>	1.50 500 10	μΑ
Maximum Reverse Recovery Time (I <sub>F</sub> = 1 Amp, di/dt = 50 Amp/μs) (I <sub>F</sub> = 0.5 Amp, i <sub>R</sub> = 1 Amp, I <sub>REC</sub> = 0.25 Amp)	t <sub>rr</sub>	60 50	ns

1. See Chapter 7 for mounting conditions

2. Pulse Test: Pulse Width =  $300 \,\mu$ s, Duty Cycle  $\leq 2.0\%$ 

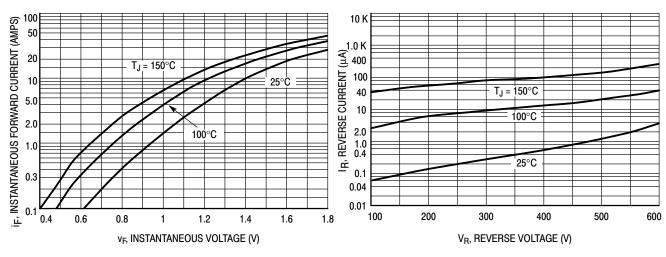




Figure 2. Typical Reverse Current, Per Leg

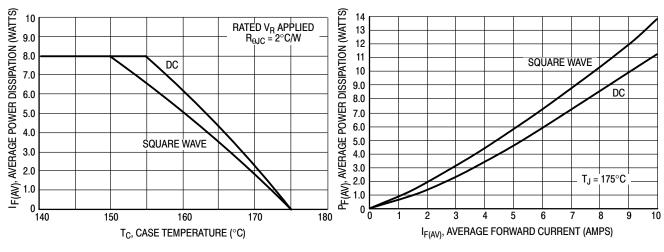
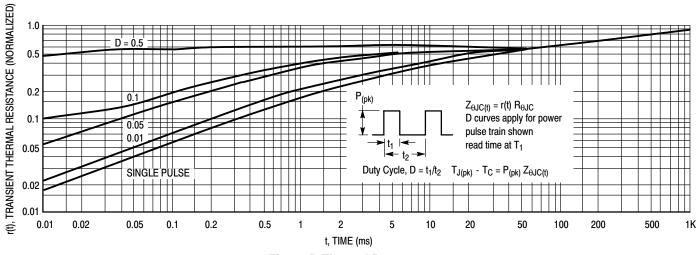


Figure 3. Current Derating, Case, Per Leg



### MURB1660CT





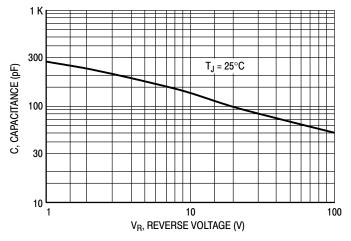


Figure 6. Typical Capacitance, Per Leg

**Preferred Devices** 

# SWITCHMODE<sup>™</sup> Power Rectifiers

# MUR105, MUR110, MUR115, MUR120, MUR130, MUR140, MUR160

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 25, 50 and 75 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 Volts

### **Mechanical Characteristics:**

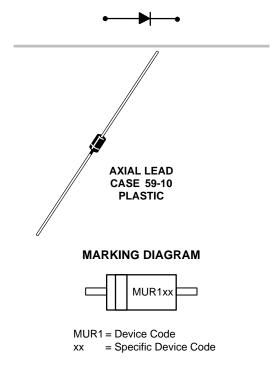
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: MUR105, MUR110, MUR115, MUR120, MUR130, MUR140, MUR160

#### MAXIMUM RATINGS

Please See the Table on the Following Page



# ULTRAFAST RECTIFIERS 1.0 AMPERE 50-600 VOLTS



### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 409 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

### MAXIMUM RATINGS

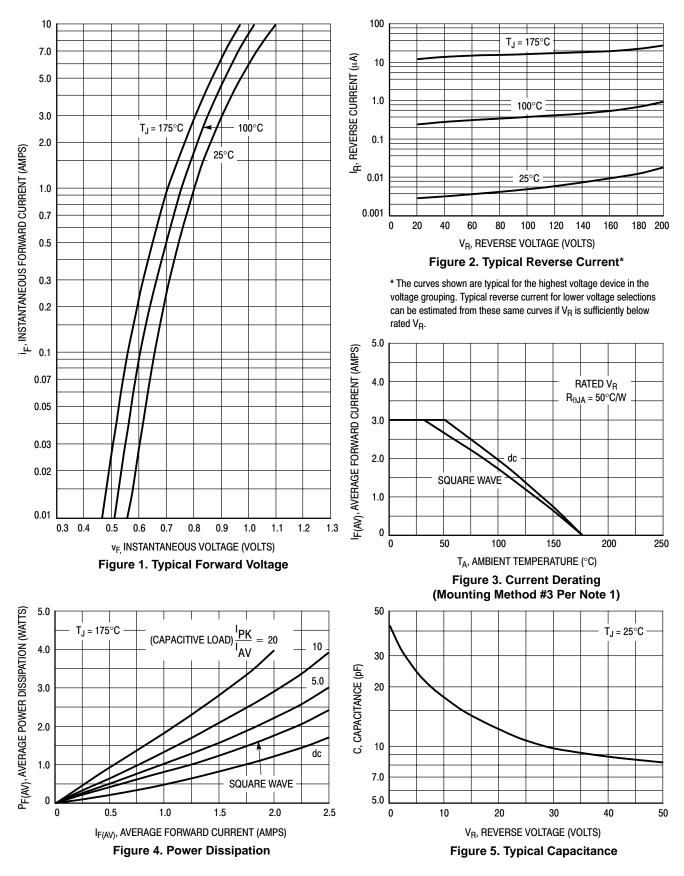
		MUR							
Rating	Symbol	105	110	115	120	130	140	160	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	150	200	300	400	600	Volts
Average Rectified Forward Current (Square Wave Mounting Method #3 Per Note 1.)	I <sub>F(AV)</sub>		1.0 @ T <sub>A</sub>	= 130°C	;	1.0 (	@ T <sub>A</sub> = 1	20°C	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>				35				Amps
Operating Junction Temperature and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>			-	65 to +1	75			°C
THERMAL CHARACTERISTICS									
Maximum Thermal Resistance, Junction to Ambient	$R_{\thetaJA}$			S	ee Note	1.			°C/W
ELECTRICAL CHARACTERISTICS									
Maximum Instantaneous Forward Voltage (Note 1) ( $i_F = 1.0 \text{ Amp}, T_J = 150^{\circ}\text{C}$ ) ( $i_F = 1.0 \text{ Amp}, T_J = 25^{\circ}\text{C}$ )	VF		0.7 0.8	/10 875			1.05 1.25		Volts
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 150^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	50 150 2.0 5.0				μΑ			
	t <sub>rr</sub>	35 75 25 50				ns			
Maximum Forward Recovery Time ( $I_F = 1.0 \text{ A}$ , di/dt = 100 A/µs, $I_{REC}$ to 1.0 V)	t <sub>fr</sub>		2	5			50		ns

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

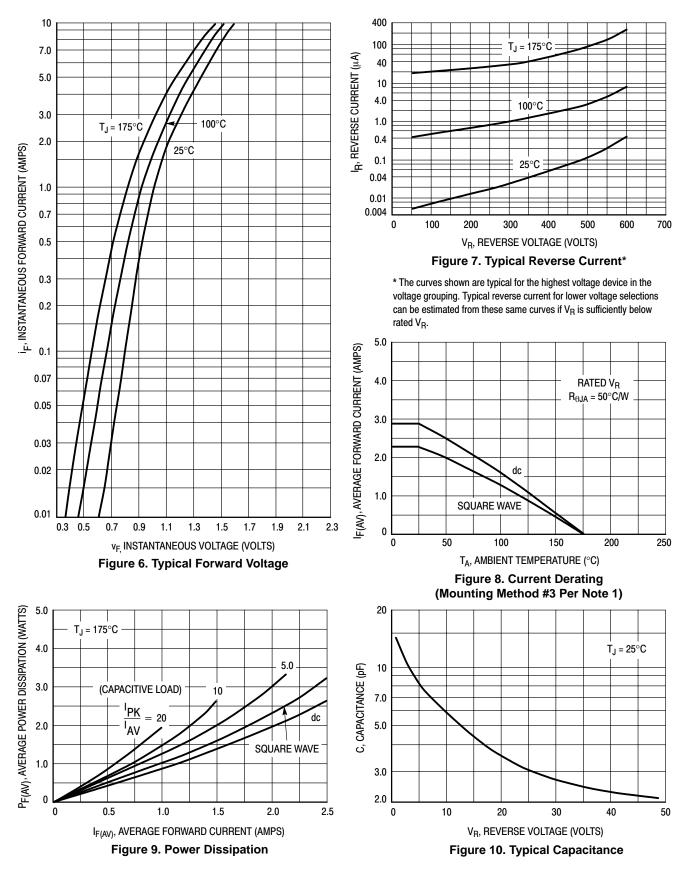
### **ORDERING INFORMATION**

Device	Marking	Package	Shipping
MUR105	MUR105	Axial Lead	1000 Units/Bag
MUR105RL	MUR105	Axial Lead	5000 Units/Tape & Reel
MUR110	MUR110	Axial Lead	1000 Units/Bag
MUR110RL	MUR110	Axial Lead	5000 Units/Tape & Reel
MUR115	MUR115	Axial Lead	1000 Units/Bag
MUR115RL	MUR115	Axial Lead	5000 Units/Tape & Reel
MUR120	MUR120	Axial Lead	1000 Units/Bag
MUR120RL	MUR120	Axial Lead	5000 Units/Tape & Reel
MUR130	MUR130	Axial Lead	1000 Units/Bag
MUR130RL	MUR130	Axial Lead	5000 Units/Tape & Reel
MUR140	MUR140	Axial Lead	1000 Units/Bag
MUR140RL	MUR140	Axial Lead	5000 Units/Tape & Reel
MUR160	MUR160	Axial Lead	1000 Units/Bag
MUR160RL	MUR160	Axial Lead	5000 Units/Tape & Reel

### MUR105, MUR110, MUR115, MUR120



### MUR130, MUR140, MUR160

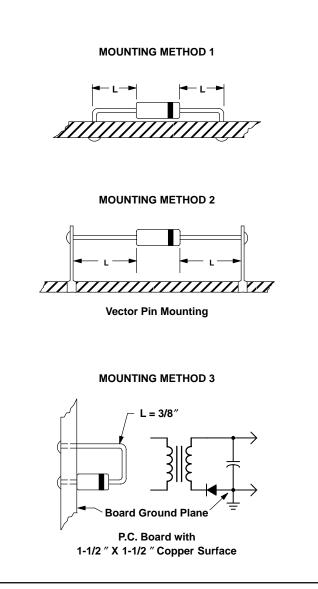


### NOTE 1. — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction to ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

#### TYPICAL VALUES FOR $\textbf{R}_{\theta \textbf{JA}}$ IN STILL AIR

Mounti	Mounting			Lead Length, L		
Metho	d	1/8	1/4	1/2	Units	
1		52	65	72	°C/W	
2	$R_{\thetaJA}$	67	80	87	°C/W	
3			50		°C/W	



MUR1100E is a Preferred Device

# SWITCHMODE™ Power Rectifiers

# Ultrafast "E" Series with High Reverse Energy Capability

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- 10 mjoules Avalanche Energy Guaranteed
- Excellent Protection Against Voltage Transients in Switching Inductive Load Circuits
- Ultrafast 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 1000 Volts

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: MUR180E, MUR1100E

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MUR180E MUR1100E	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	800 1000	V
Average Rectified Forward Current (Note 1.) (Square Wave Mounting Method #3 Per Note 3.)	I <sub>F(AV)</sub>	1.0 @ T <sub>A</sub> = 95°C	A
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	35	A
Operating Junction Temperature and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +175	°C

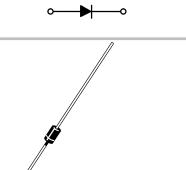
1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.



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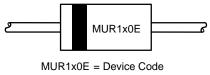
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ULTRAFAST RECTIFIERS 1.0 AMPERES 800-1000 VOLTS



AXIAL LEAD CASE 059-10 PLASTIC

#### MARKING DIAGRAM



x = 8 or 10

#### ORDERING INFORMATION

Device	Package	Shipping
MUR180E	Axial Lead	1000 Units/Bag
MUR180ERL	Axial Lead	5000/Tape & Reel
MUR1100E	Axial Lead	1000 Units/Bag
MUR1100ERL	Axial Lead	5000/Tape & Reel

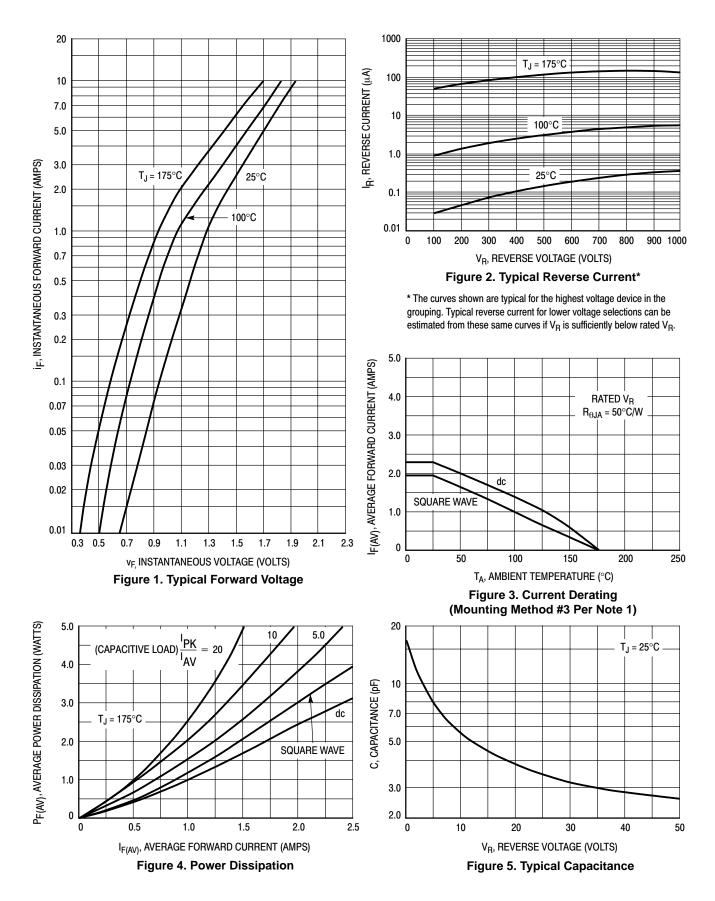
**Preferred** devices are recommended choices for future use and best overall value.

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Ambient	R <sub>0JA</sub>	See Note 3.	°C/W
ELECTRICAL CHARACTERISTICS			-
Maximum Instantaneous Forward Voltage (Note 2.) ( $i_F = 1.0 \text{ Amp}, T_J = 150^{\circ}\text{C}$ ) ( $i_F = 1.0 \text{ Amp}, T_J = 25^{\circ}\text{C}$ )	VF	1.50 1.75	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_J = 100^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	600 10	μΑ
Maximum Reverse Recovery Time ( $I_F = 1.0 \text{ Amp}, \text{ di/dt} = 50 \text{ Amp/}\mu\text{s}$ ) ( $I_F = 0.5 \text{ Amp}, i_R = 1.0 \text{ Amp}, I_{REC} = 0.25 \text{ Amp}$ )	t <sub>rr</sub>	100 75	ns
Maximum Forward Recovery Time $(I_F = 1.0 \text{ Amp}, \text{ di/dt} = 100 \text{ Amp/}\mu\text{s}, \text{ Recovery to } 1.0 \text{ V})$	t <sub>fr</sub>	75	ns
Controlled Avalanche Energy (See Test Circuit in Figure 6)	W <sub>AVAL</sub>	10	mJ

2. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

### **ELECTRICAL CHARACTERISTICS**



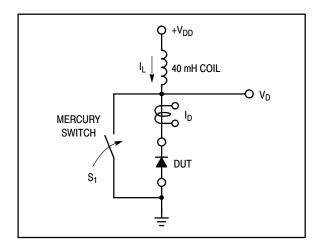


Figure 6. Test Circuit

The unclamped inductive switching circuit shown in Figure 6 was used to demonstrate the controlled avalanche capability of the new "E" series Ultrafast rectifiers. A mercury switch was used instead of an electronic switch to simulate a noisy environment when the switch was being opened.

When  $S_1$  is closed at  $t_0$  the current in the inductor  $I_L$  ramps up linearly; and energy is stored in the coil. At  $t_1$  the switch is opened and the voltage across the diode under test begins to rise rapidly, due to di/dt effects, when this induced voltage reaches the breakdown voltage of the diode, it is clamped at  $BV_{DUT}$  and the diode begins to conduct the full load current which now starts to decay linearly through the diode, and goes to zero at  $t_2$ .

By solving the loop equation at the point in time when  $S_1$  is opened; and calculating the energy that is transferred to the diode it can be shown that the total energy transferred is equal to the energy stored in the inductor plus a finite amount of energy from the V<sub>DD</sub> power supply while the diode is in breakdown (from  $t_1$  to  $t_2$ ) minus any losses due to finite

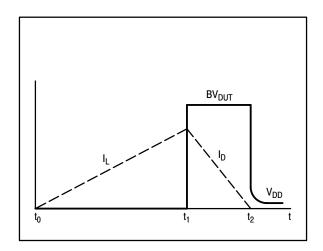
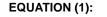


Figure 7. Current-Voltage Waveforms

component resistances. Assuming the component resistive elements are small Equation (1) approximates the total energy transferred to the diode. It can be seen from this equation that if the  $V_{DD}$  voltage is low compared to the breakdown voltage of the device, the amount of energy contributed by the supply during breakdown is small and the total energy can be assumed to be nearly equal to the energy stored in the coil during the time when S<sub>1</sub> was closed, Equation (2).

The oscilloscope picture in Figure 8, shows the information obtained for the MUR8100E (similar die construction as the MUR1100E Series) in this test circuit conducting a peak current of one ampere at a breakdown voltage of 1300 volts, and using Equation (2) the energy absorbed by the MUR8100E is approximately 20 mjoules.

Although it is not recommended to design for this condition, the new "E" series provides added protection against those unforeseen transient viruses that can produce unexplained random failures in unfriendly environments.



$$W_{AVAL} \approx \frac{1}{2} LI_{LPK}^{2} \left( \frac{BV_{DUT}}{BV_{DUT} - V_{DD}} \right)$$

**EQUATION (2):** 

$$W_{AVAL} \approx \frac{1}{2} LI_{LPK}^2$$

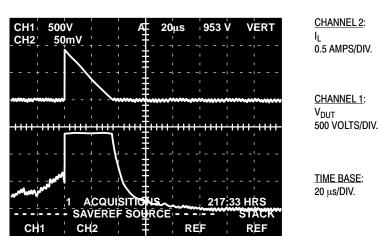
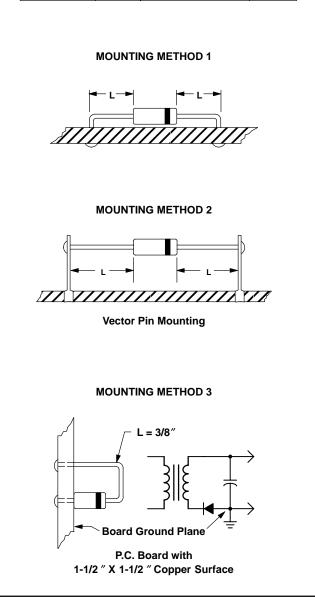


Figure 8. Current-Voltage Waveforms

### NOTE 3. — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction to ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

Mounti	Lead Length, L				
Method		1/8	1/4	1/2	Units
1		52	65	72	°C/W
2	$R_{\thetaJA}$	67	80	87	°C/W
3			50		°C/W



Preferred Device

# SWITCHMODE™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 25 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction

#### **Mechanical Characteristics**

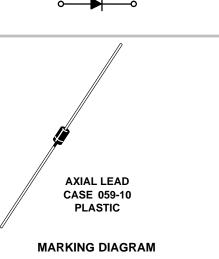
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: MUR220



### **ON Semiconductor®**

http://onsemi.com







MUR220 = Device Code

### ORDERING INFORMATION

Device	Package	Shipping
MUR220	Axial Lead	1000 Units/Bag
MUR220RL	Axial Lead	5000/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	Volts
Average Rectified Forward Current (Note 1.) (Square Wave Mounting Method #3 Per Note 3.)	I <sub>F(AV)</sub>	2.0 @ T <sub>A</sub> = 90°C	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	35	Amps
Operating Junction Temperature and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +175	°C

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

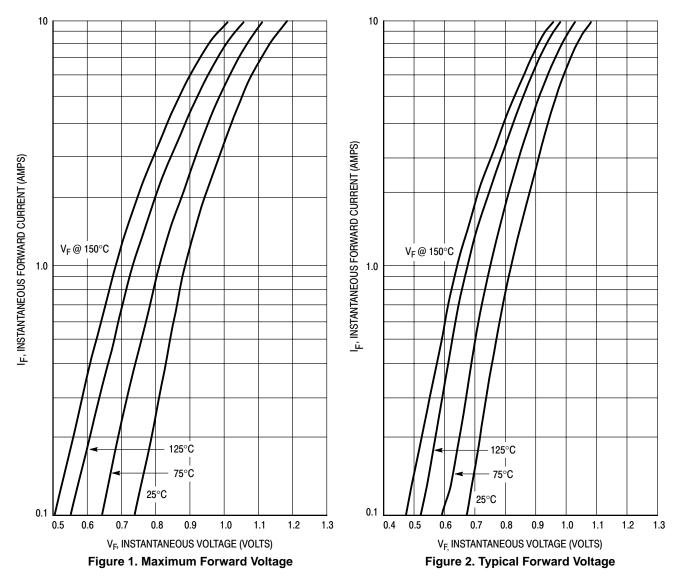
### THERMAL CHARACTERISTICS

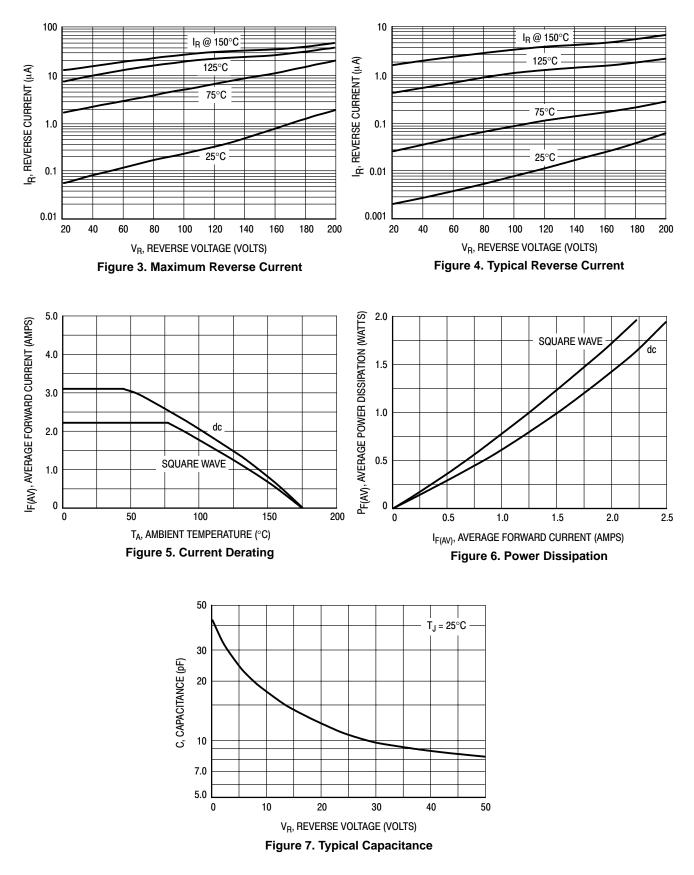
Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Ambient	$R_{\thetaJA}$	See Note 3.	°C/W

### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 2.) ( $I_F = 2.0 \text{ Amp}, T_J = 150^{\circ}\text{C}$ ) ( $I_F = 2.0 \text{ Amp}, T_J = 25^{\circ}\text{C}$ )	VF	0.75 0.95	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_J = 150^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	50 2.0	μΑ
Maximum Reverse Recovery Time $(I_F = 1.0 \text{ Amp, di/dt} = 50 \text{ Amp/}\mu s)$ $(I_F = 0.5 \text{ Amp, } I_R = 1.0 \text{ Amp, } I_{REC} = 0.25 \text{ A})$	t <sub>rr</sub>	35 25	ns
Maximum Forward Recovery Time $(I_F = 1.0 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, I_{REC} \text{ to } 1.0 \text{ V})$	t <sub>fr</sub>	25	ns

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



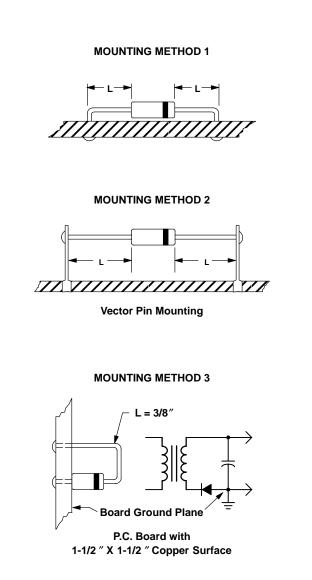


### NOTE 3. - AMBIENT MOUNTING DATA

Data shown for thermal resistance junction to ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

### TYPICAL VALUES FOR $\textbf{R}_{\theta \textbf{J} \textbf{A}}$ IN STILL AIR

Mounti	Mounting		Lead Length, L		
Metho	d	1/8	1/4	1/2	Units
1		52	65	72	°C/W
2	$R_{\thetaJA}$	67	80	87	°C/W
3			50		°C/W



Preferred Device

# SWITCHMODE™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction

#### **Mechanical Characteristics**

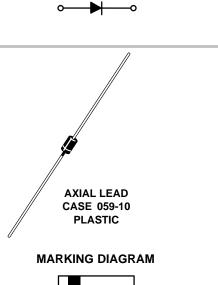
- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: MUR240



### **ON Semiconductor®**

http://onsemi.com





# MUR240 MUR240

### ORDERING INFORMATION

Device	Package Shipping	
MUR240	Axial Lead	1000 Units/Bag
MUR240RL	Axial Lead	5000/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	400 -	V
Average Rectified Forward Current (Note 1.) (Square Wave Mounting Method #3 Per Note 3.)	I <sub>F(AV)</sub>	2.0 @ T <sub>A</sub> = 85°C	A
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	35	A
Operating Junction Temperature and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +175	°C

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

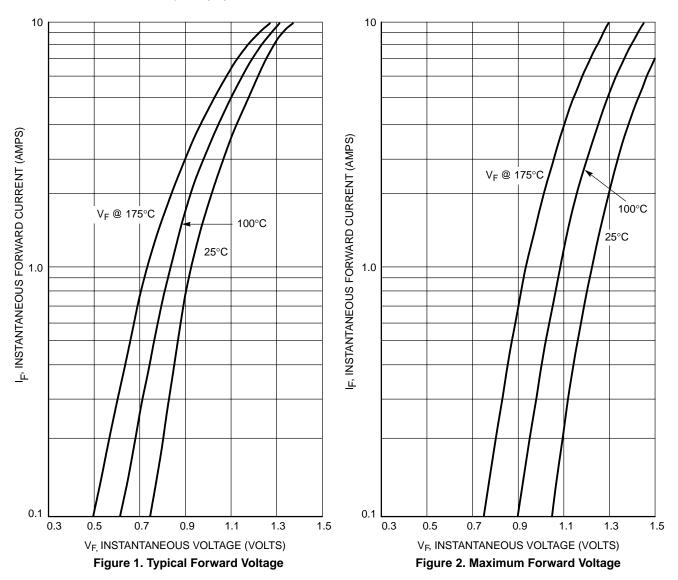
### THERMAL CHARACTERISTICS

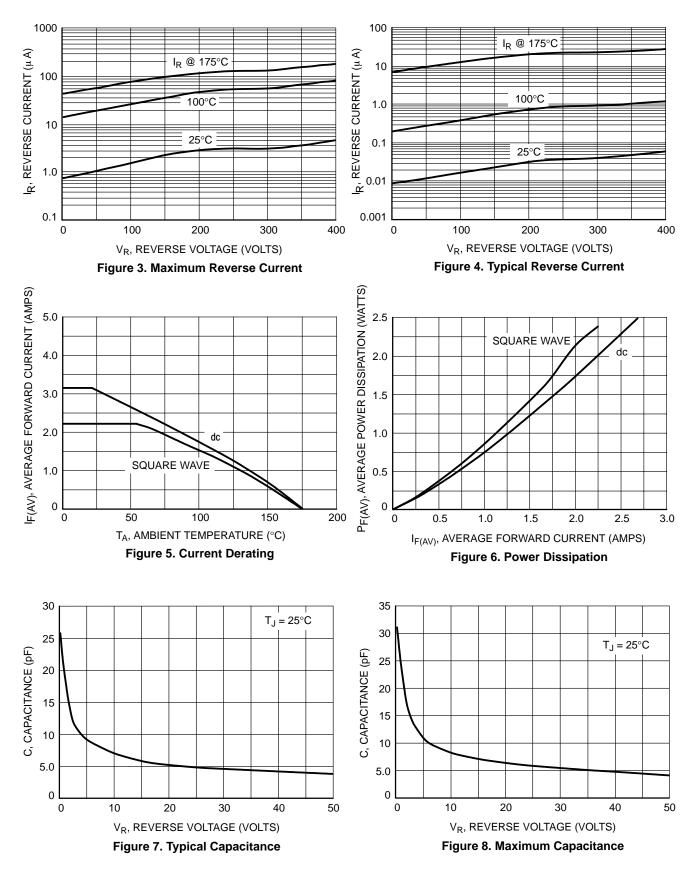
Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Ambient	$R_{\thetaJA}$	See Note 3.	°C/W

### **ELECTRICAL CHARACTERISTICS**

Maximum Instantaneous Forward Voltage (Note 2.) ( $I_F = 2.0 \text{ Amp}, T_J = 150^{\circ}\text{C}$ ) ( $I_F = 2.0 \text{ Amp}, T_J = 25^{\circ}\text{C}$ )	V <sub>F</sub>	1.05 1.30	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_J = 150^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	I <sub>R</sub>	150 5.0	μΑ
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amp/μs)	t <sub>rr</sub>	65	ns
Maximum Forward Recovery Time $(I_F = 1.0 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s})$	t <sub>rr</sub>	50	ns

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

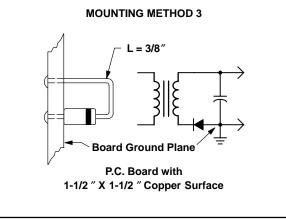




### NOTE 3. - AMBIENT MOUNTING DATA

Data shown for thermal resistance junction to ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

Mounting Lead Length, L						
Method	1/8 1/4 1/2			Units		
1	52	65	72	°C/W		
2 R <sub>0</sub> ,	<sub>JA</sub> 67	80	87	°C/W		
3		50		°C/W		
21111				V		



Vector Pin Mounting

http://onsemi.com 425

Preferred Device

# SWITCHMODE™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 50 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: MUR260



### **ON Semiconductor®**

http://onsemi.com





# MUR260 MUR260

### ORDERING INFORMATION

Device	Package	Shipping
MUR260	Axial Lead	1000 Units/Bag
MUR260RL	Axial Lead	5000/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600 -	Volts
Average Rectified Forward Current (Note 1.) (Square Wave Mounting Method #3 Per Note 3.)	I <sub>F(AV)</sub>	2.0 @ T <sub>A</sub> = 60°C	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	35	Amps
Operating Junction Temperature and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +175	°C

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

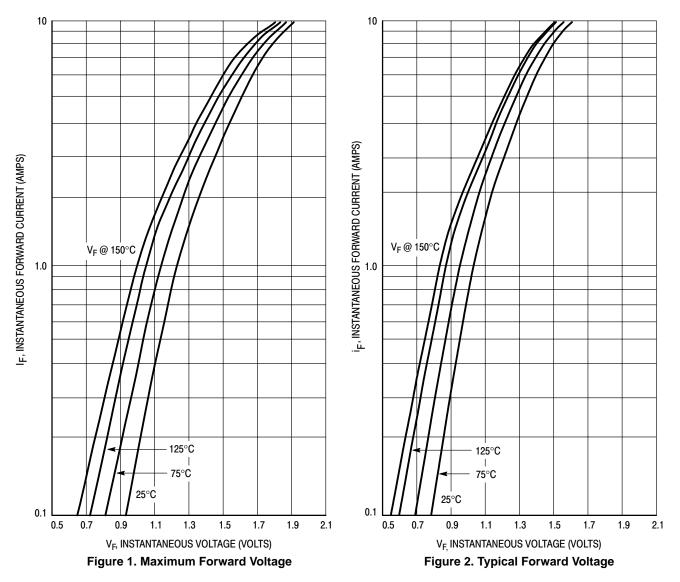
### THERMAL CHARACTERISTICS

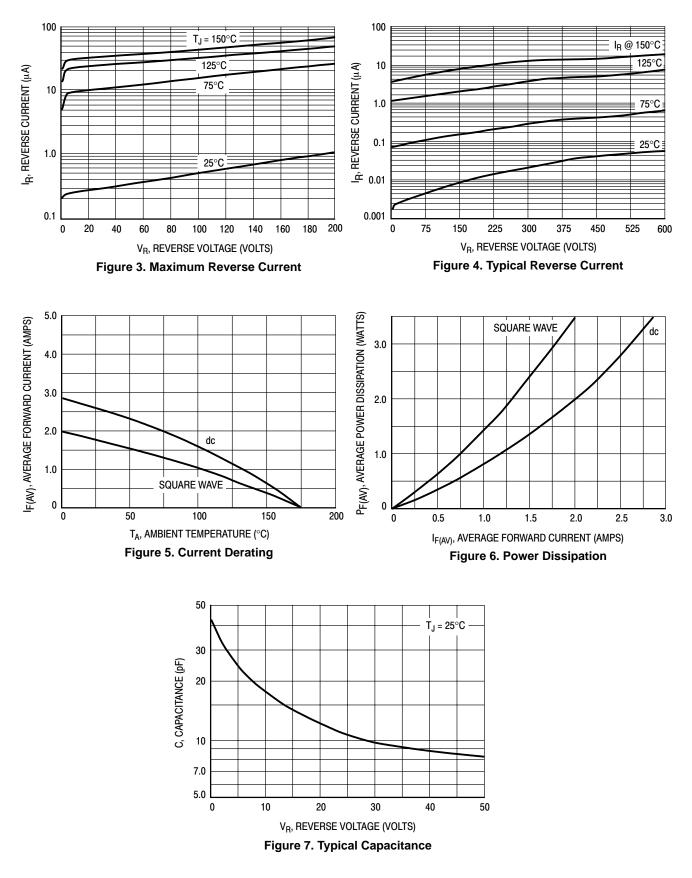
Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Ambient	$R_{\thetaJA}$	See Note 3.	°C/W

### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 2.) ( $I_F = 2.0 \text{ Amp}, T_J = 150^{\circ}\text{C}$ ) ( $I_F = 2.0 \text{ Amp}, T_J = 25^{\circ}\text{C}$ )	VF	1.15 1.35	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_J = 150^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	150 5.0	μΑ
	t <sub>rr</sub>	75 50	ns
Maximum Forward Recovery Time $(I_F = 1.0 \text{ A}, \text{ di/dt} = 100 \text{ A}/\mu \text{s}, I_{REC} \text{ to } 1.0 \text{ V})$	t <sub>fr</sub>	50	ns

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



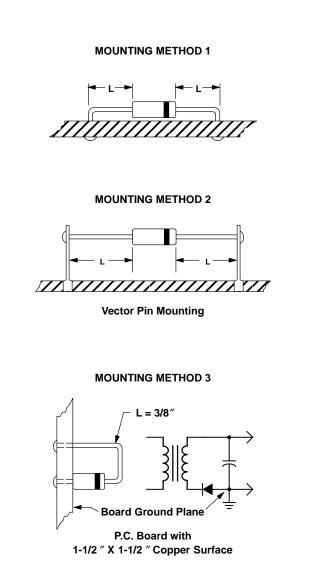


### NOTE 3. — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction to ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

### TYPICAL VALUES FOR $\textbf{R}_{\theta \textbf{J} \textbf{A}}$ IN STILL AIR

Mounti	Mounting		Lead Length, L		
Method		1/8	1/4	1/2	Units
1		52	65	72	°C/W
2	$R_{\theta JA}$	67	80	87	°C/W
3			50		°C/W



# **MUR2100E**

Preferred Device

# SWITCHMODE™ Power Rectifier

Ultrafast "E" Series with High Reverse Energy Capability

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- 20 mjoules Avalanche Energy Guaranteed
- Excellent Protection Against Voltage Transients in Switching Inductive Load Circuits
- Ultrafast 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction

### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 1000 per bag
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: MUR2100E

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	1000	Volts
Average Rectified Forward Current (Note 1.) (Square Wave Mounting Method #3 Per Note 3.)	I <sub>F(AV)</sub>	2.0 @ T <sub>A</sub> = 35°C	Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	35	Amps
Operating Junction Temperature and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +175	°C

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



### **ON Semiconductor®**

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MUR2100E = Device Code

### **ORDERING INFORMATION**

Device	Package	Shipping
MUR2100E	Axial Lead	1000 Units/Bag
MUR2100ERL	Axial Lead	5000/Tape & Reel

Preferred devices are recommended choices for future use and best overall value.

### **MUR2100E**

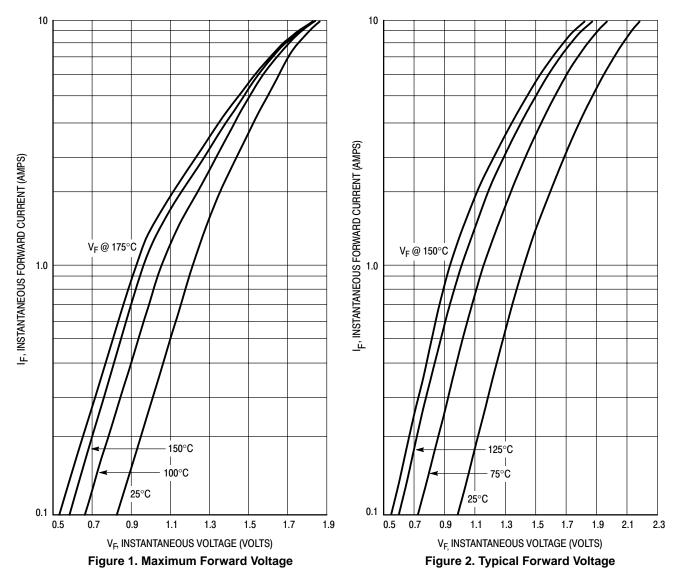
### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Ambient	$R_{\thetaJA}$	See Note 3.	°C/W

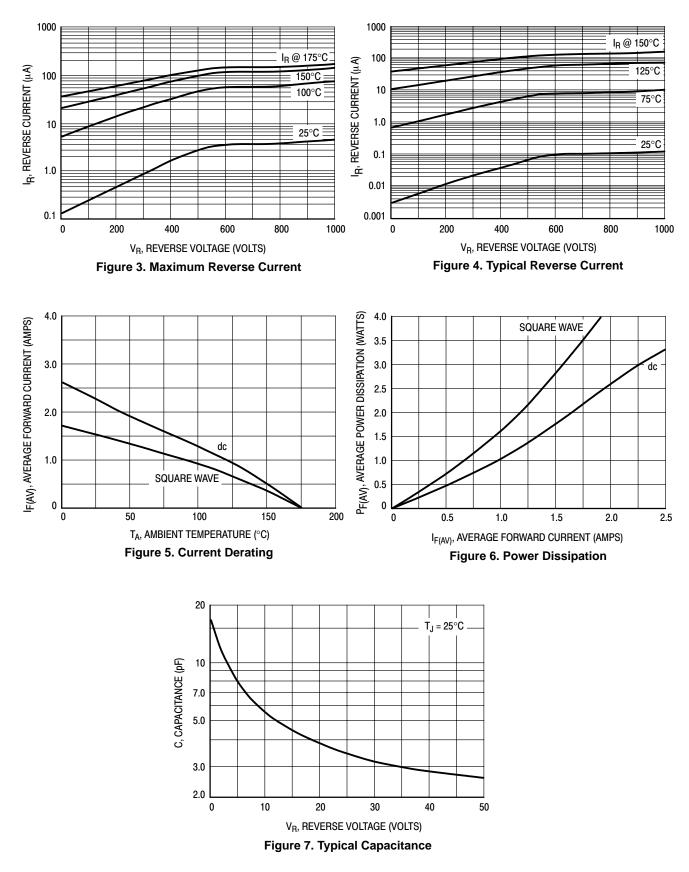
ELECTRICAL	CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 2.) ( $I_F = 2.0 \text{ Amp}, T_J = 150^{\circ}\text{C}$ ) ( $I_F = 2.0 \text{ Amp}, T_J = 25^{\circ}\text{C}$ )	VF	1.75 2.20	Volts
Maximum Instantaneous Reverse Current (Note 2.) (Rated dc Voltage, $T_J = 100^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	600 10	μΑ
Maximum Reverse Recovery Time $(I_F = 1.0 \text{ Amp, di/dt} = 50 \text{ Amp/}\mu\text{s})$ $(I_F = 0.5 \text{ Amp, } I_R = 1.0 \text{ Amp, } I_{REC} = 0.25 \text{ A})$	t <sub>rr</sub>	100 75	ns
Maximum Forward Recovery Time (I <sub>F</sub> = 1.0 A, di/dt = 100 A/µs, I <sub>REC</sub> to 1.0 V)	t <sub>fr</sub>	75	ns
Controlled Avalanche Energy (See Test Circuit in Figure 6)	W <sub>AVAL</sub>	10	mJ

2. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



## **MUR2100E**

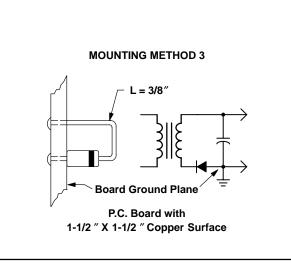


## **MUR2100E**

### NOTE 3. — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction to ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

Mour	nting	Lead Length, L			
Meth	nod	1/8	1/4	1/2	Units
1		52	65	72	°C/W
2	$R_{\theta JA}$	67	80	87	°C/W
3			50		°C/W
		NG MET			
277			<-L-		r



Vector Pin Mounting

http://onsemi.com 433

MUR420 and MUR460 are Preferred Devices

## Switchmode<sup>™</sup> Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 25, 50 and 75 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 Volts
- Mechanical Characteristics:
- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 5,000 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- Marking: MUR405, MUR410, MUR415, MUR420, MUR440, MUR460

### MAXIMUM RATINGS

Please See the Table on the Following Page



## **ON Semiconductor**<sup>™</sup>

http://onsemi.com

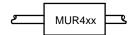
## ULTRAFAST RECTIFIERS 4.0 AMPERES 50-600 VOLTS





CASE 267-05 (DO-201AD) STYLE 1

#### MARKING DIAGRAM



MUR4xx = Device Code xx = 05, 10, 15, 20, 40, 60

#### **ORDERING INFORMATION**

Device	Package	Shipping
MUR405	Axial Lead	5000 Units/Bag
MUR405RL	Axial Lead	1500/Tape & Reel
MUR410	Axial Lead	5000 Units/Bag
MUR410RL	Axial Lead	1500/Tape & Reel
MUR415	Axial Lead	5000 Units/Bag
MUR415RL	Axial Lead	1500/Tape & Reel
MUR420	Axial Lead	5000 Units/Bag
MUR420RL	Axial Lead	1500/Tape & Reel
MUR440	Axial Lead	5000 Units/Bag
MUR440RL	Axial Lead	1500/Tape & Reel
MUR460	Axial Lead	5000 Units/Bag
MUR460RL	Axial Lead	1500/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

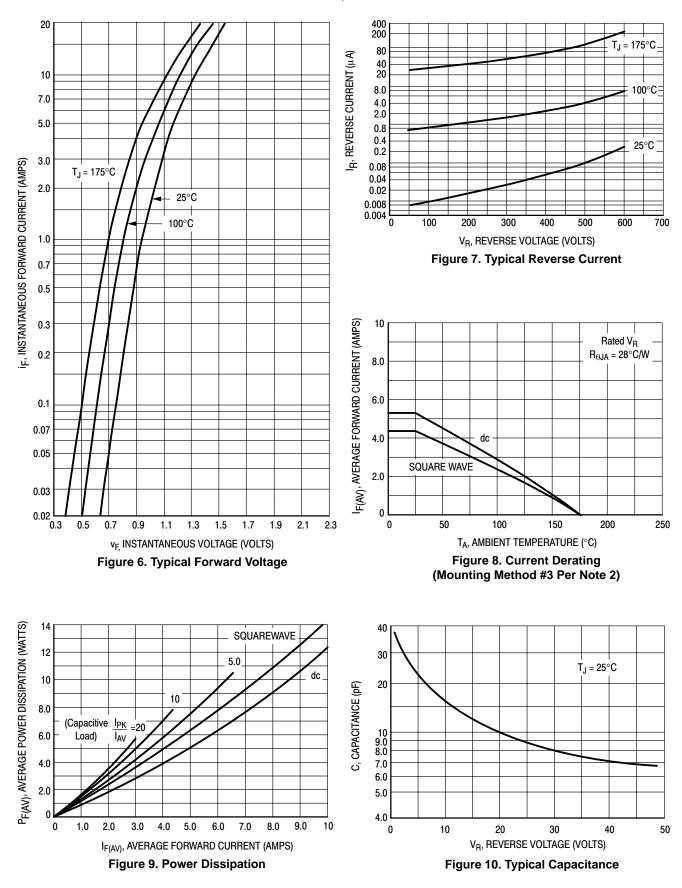
### MAXIMUM RATINGS

				М	JR			
Rating	Symbol	405	410	415	420	440	460	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	150	200	400	600	Volts
Average Rectified Forward Current (Square Wave) (Mounting Method #3 Per Note 2)	I <sub>F(AV)</sub>		4.0 @ T	<sub>A</sub> = 80°C			) @ 40°C	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, half wave, single phase, 60 Hz)	I <sub>FSM</sub>	125 70		0	Amps			
Operating Junction Temperature & Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>			-65 to	o +175	•		°C
THERMAL CHARACTERISTICS								
Maximum Thermal Resistance, Junction to Ambient	$R_{\theta JA}$			See N	lote 2			°C/W
ELECTRICAL CHARACTERISTICS								
$\label{eq:constant} \begin{array}{l} \mbox{Maximum Instantaneous Forward Voltage (Note 1)} \\ (i_F = 3.0 \mbox{ Amps, } T_J = 150^\circ\mbox{C}) \\ (i_F = 3.0 \mbox{ Amps, } T_J = 25^\circ\mbox{C}) \\ (i_F = 4.0 \mbox{ Amps, } T_J = 25^\circ\mbox{C}) \end{array}$	VF		0.8	710 375 390		1.	05 25 28	Volts
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 150^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	150 250 5.0 10			μΑ			
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amp/μs) (I <sub>F</sub> = 0.5 Amp, i <sub>R</sub> = 1.0 Amp, I <sub>REC</sub> = 0.25 Amp)	t <sub>rr</sub>			5 25		-	75 50	ns
Maximum Forward Recovery Time (I <sub>F</sub> = 1.0 A, di/dt = 100 A/μs, Recovery to 1.0 V)	t <sub>fr</sub>		2	25		5	50	ns

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

#### 100 80 40 20 T<sub>J</sub> = 175°C 70 I<sub>R</sub>, REVERSE CURRENT (µ A) 8.0 50 4.0 2.0 100°C 0.8 30 0.4 0.2 20 0.08 0.04 0.02 i<sub>F</sub>, INSTANTANEOUS FORWARD CURRENT (AMPS) 25°C 0.008 10 0.004 0.002 7.0 20 60 100 120 140 160 180 200 40 80 0 5.0 V<sub>R</sub>, REVERSE VOLTAGE (VOLTS) Figure 2. Typical Reverse Current 3.0 2.0 25°C I<sub>F(AV)</sub>, AVERAGE FORWARD CURRENT (AMPS) 10 T<sub>J</sub> = 175°C 100°C Rated V<sub>R</sub> 1.0 $R_{\theta JA}$ = 28°C/W 8.0 0.7 0.5 6.0 dc 0.3 4.0 SQUARE WAVE 0.2 2.0 0.1 0 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0 1.1 1.2 0 50 100 150 200 250 T<sub>A</sub>, AMBIENT TEMPERATURE (°C) v<sub>E</sub> INSTANTANEOUS VOLTAGE (VOLTS) **Figure 3. Current Derating** Figure 1. Typical Forward Voltage (Mounting Method #3 Per Note 2) 10 200 PF(AV), AVERAGE POWER DISSIPATION (WATTS) 9.0 (Capacitive IPK =20 5.0 10 8.0 $T_J=25^\circ C$ Load) I<sub>AV</sub> 100 90 80 7.0 C, CAPACITANCE (pF) 6.0 dc 70 5.0 60 4.0 50 SQUAREWAVE 3.0 40 2.0 30 1.0 0 20 1.0 2.0 3.0 4.0 5.0 6.0 7.0 8.0 0 50 10 20 30 40 0 IF(AV), AVERAGE FORWARD CURRENT (AMPS) V<sub>R</sub>, REVERSE VOLTAGE (VOLTS) Figure 4. Power Dissipation Figure 5. Typical Capacitance

### MUR405, MUR410, MUR415, MUR420



#### MUR440, MUR460

### NOTE 2 — AMBIENT MOUNTING DATA

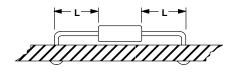
Data shown for thermal resistance junction-to-ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

#### TYPICAL VALUES FOR $\textbf{R}_{\theta \textbf{JA}}$ IN STILL AIR

Mounti	ng Lead Length, L (IN)			Mounting		
Metho	d	1/8	1/4	1/2	3/4	Units
1		50	51	53	55	°C/W
2	R <sub>0JA</sub>	58	59	61	63	°C/W
3			2	.8		°C/W

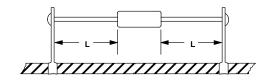
#### **MOUNTING METHOD 1**





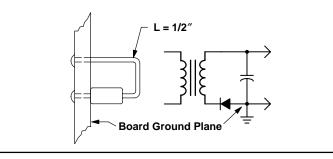
#### **MOUNTING METHOD 2**

Vector Push-In Terminals T-28



#### **MOUNTING METHOD 3**

P.C. Board with 1-1/2 " x 1-1/2 " Copper Surface



## SWITCHMODE™ Power Rectifiers

## Ultrafast "E" Series with High Reverse Energy Capability

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- 20 mJ Avalanche Energy Guaranteed
- Excellent Protection Against Voltage Transients in Switching Inductive Load Circuits
- Ultrafast 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 1000 Volts

#### Mechanical Characteristics:

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 5,000 per bag
- Available Tape and Reeled, 1500 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode indicated by Polarity Band
- Marking: MUR480E, MUR4100E

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MUR480E MUR4100E	V <sub>RRM</sub> V <sub>RWM</sub> VR	800 1000	V
Average Rectified Forward Current (Square Wave) (Mounting Method #3 Per Note 2)	I <sub>F(AV)</sub>	4.0 @ T <sub>A</sub> = 35°C	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	70	A
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C



## **ON Semiconductor®**

http://onsemi.com

ULTRAFAST RECTIFIER 4.0 AMPERES 800-1000 VOLTS





#### MARKING DIAGRAM



MUR4x0E = Device Codex = 8 or 10

#### ORDERING INFORMATION

Device	Package	Shipping
MUR480E	Axial Lead	5000 Units/Bag
MUR480ERL	Axial Lead	1500/Tape & Reel
MUR4100E	Axial Lead	5000 Units/Bag
MUR4100ERL	Axial Lead	1500/Tape & Reel

### THERMAL CHARACTERISTICS

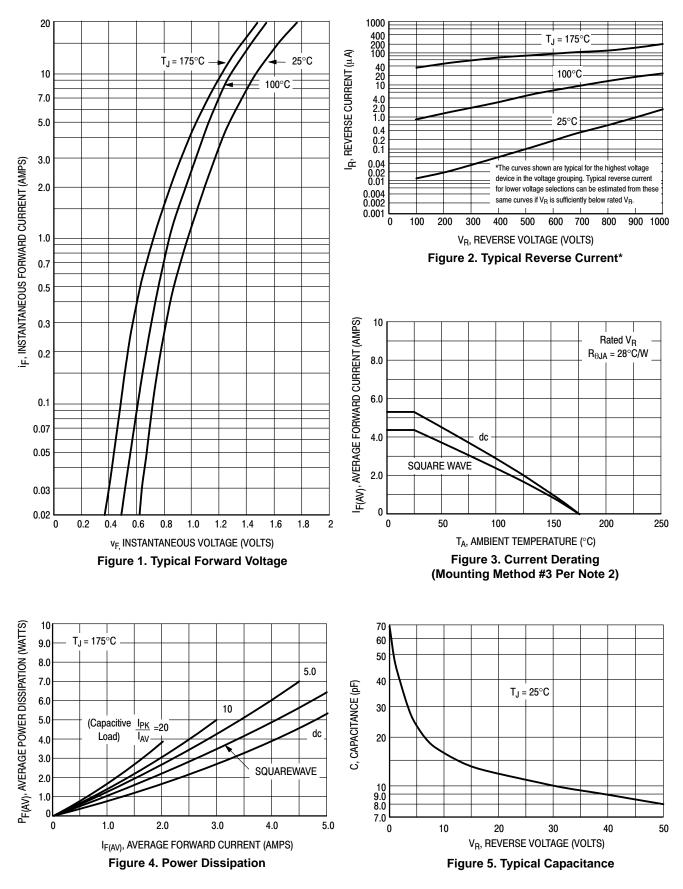
Rating	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Ambient	$R_{\thetaJA}$	See Note 2	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Max	Unit
	VF	1.53 1.75 1.85	Volts
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_J = 150^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	900 25	μΑ
	t <sub>rr</sub>	100 75	ns
Maximum Forward Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 100 Amp/µs, Recovery to 1.0 V)	t <sub>fr</sub>	75	ns
Controlled Avalanche Energy (See Test Circuit in Figure 6)	W <sub>AVAL</sub>	20	mJ

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

### MUR480E, MUR4100E



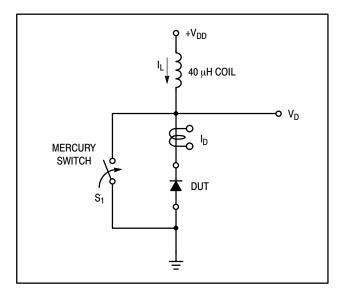


Figure 6. Test Circuit

The unclamped inductive switching circuit shown in Figure 6 was used to demonstrate the controlled avalanche capability of the new "E" series Ultrafast rectifiers. A mercury switch was used instead of an electronic switch to simulate a noisy environment when the switch was being opened.

When  $S_1$  is closed at  $t_0$  the current in the inductor  $I_L$  ramps up linearly; and energy is stored in the coil. At  $t_1$  the switch is opened and the voltage across the diode under test begins to rise rapidly, due to di/dt effects, when this induced voltage reaches the breakdown voltage of the diode, it is clamped at  $BV_{DUT}$  and the diode begins to conduct the full load current which now starts to decay linearly through the diode, and goes to zero at  $t_2$ .

By solving the loop equation at the point in time when  $S_1$  is opened; and calculating the energy that is transferred to the diode it can be shown that the total energy transferred is equal to the energy stored in the inductor plus a finite amount of energy from the V<sub>DD</sub> power supply while the diode is in breakdown (from  $t_1$  to  $t_2$ ) minus any losses due to finite

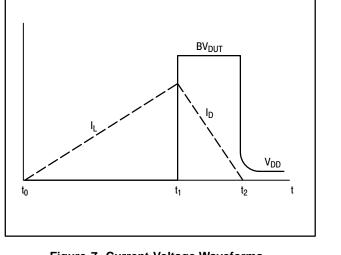


Figure 7. Current-Voltage Waveforms

component resistances. Assuming the component resistive elements are small Equation (1) approximates the total energy transferred to the diode. It can be seen from this equation that if the  $V_{DD}$  voltage is low compared to the breakdown voltage of the device, the amount of energy contributed by the supply during breakdown is small and the total energy can be assumed to be nearly equal to the energy stored in the coil during the time when S<sub>1</sub> was closed, Equation (2).

The oscilloscope picture in Figure 8, shows the information obtained for the MUR8100E (similar die construction as the MUR4100E Series) in this test circuit conducting a peak current of one ampere at a breakdown voltage of 1300 volts, and using Equation (2) the energy absorbed by the MUR8100E is approximately 20 mjoules.

Although it is not recommended to design for this condition, the new "E" series provides added protection against those unforeseen transient viruses that can produce unexplained random failures in unfriendly environments.

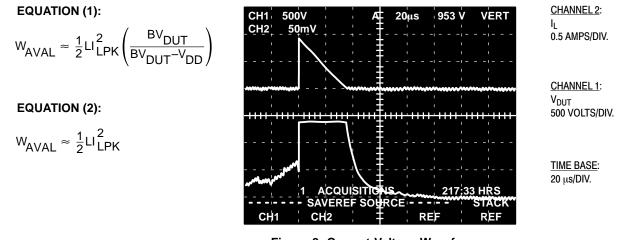


Figure 8. Current-Voltage Waveforms

### NOTE 2 - AMBIENT MOUNTING DATA

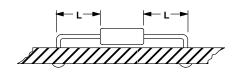
Data shown for thermal resistance junction-to-ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

## TYPICAL VALUES FOR $R_{\theta JA}$ IN STILL AIR

Moun	ting	Lead Length, L (IN)				
Meth	od	1/8	1/4	1/2	3/4	Units
1		50	51	53	55	°C/W
2	R <sub>0JA</sub>	58	59	61	63	°C/W
3	_		2	28		°C/W

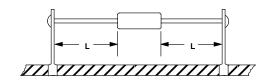
#### **MOUNTING METHOD 1**

P.C. Board Where Available Copper Surface area is small.



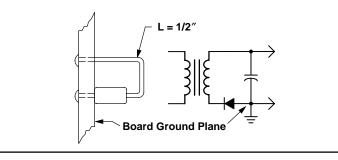
#### **MOUNTING METHOD 2**

Vector Push-In Terminals T-28



#### **MOUNTING METHOD 3**

P.C. Board with 1-1/2 " x 1-1/2 " Copper Surface



## MUR620CT

Preferred Device

## SWITCHMODE™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- **Mechanical Characteristics:**
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U620

## MAXIMUM RATINGS

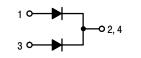
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	V
Average Rectified Forward Voltage (Rated $V_R$ , $T_C = 130^{\circ}C$ ) Per Diode Total Device	I <sub>F(AV)</sub>	3.0 6.0	A
Peak Repetitive Forward Current per Diode Leg (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 130^{\circ}C$ )	I <sub>FRM</sub>	6.0	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	75	A
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C



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ULTRAFAST RECTIFIER 6.0 AMPERES 200 VOLTS





CASE 221A PLASTIC

#### MARKING DIAGRAM



U620 = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MUR620CT	TO-220	50 Units/Rail

**Preferred** devices are recommended choices for future use and best overall value.

## MUR620CT

#### THERMAL CHARACTERISTICS (Per Diode Leg)

Rating	Symbol	Typical	Maximum	Unit
Thermal Resistance, Junction to Case	$R_{ extsf{ heta}JC}$	5.0-6.0	7.0	°C/W

ELECTRICAL CHARACTERISTICS (Per D	)iode Leg)
-----------------------------------	------------

Instantaneous Forward Voltage (Note 1.) ( $i_F = 3.0 \text{ Amps}, T_C = 150^{\circ}\text{C}$ ) ( $i_F = 3.0 \text{ Amps}, T_C = 25^{\circ}\text{C}$ )	۷F	0.80 0.94	0.895 0.975	Volts
Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 150^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	2.0-10 0.01-3.0	250 5.0	μΑ
Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/µs)	t <sub>rr</sub>	20-30	35	ns

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.

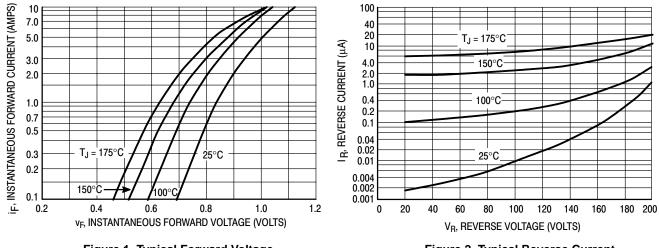


Figure 1. Typical Forward Voltage

Figure 2. Typical Reverse Current

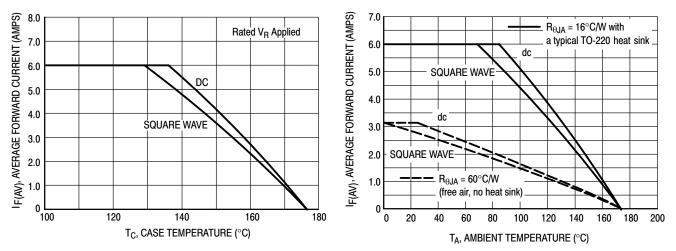


Figure 3. Total Device Current Derating, Case

Figure 4. Total Device Current Derating, Ambient

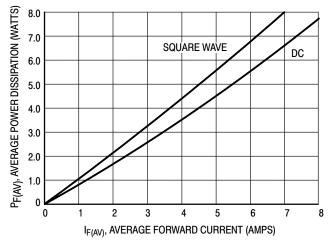


Figure 5. Power Dissipation

## MURH840CT

Preferred Device

## MEGAHERTZ™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 28 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 400 Volts
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures

### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: UH840

### MAXIMUM RATINGS

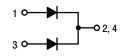
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	400	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 120^{\circ}C$ ) Per Leg Total Device	I <sub>F(AV)</sub>	4.0 8.0	A
Peak Repetitive Forward Current per Diode Leg (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 120^{\circ}C$ )	I <sub>FM</sub>	16	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	100	A
Controlled Avalanche Energy	W <sub>AVAL</sub>	20	mJ
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C

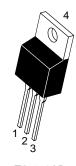


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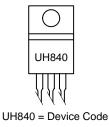
ULTRAFAST RECTIFIER 8.0 AMPERES 400 VOLTS





TO-220AB CASE 221A PLASTIC

#### MARKING DIAGRAM



### ORDERING INFORMATION

Device	Package	Shipping
MURH840CT	TO-220	50 Units/Rail

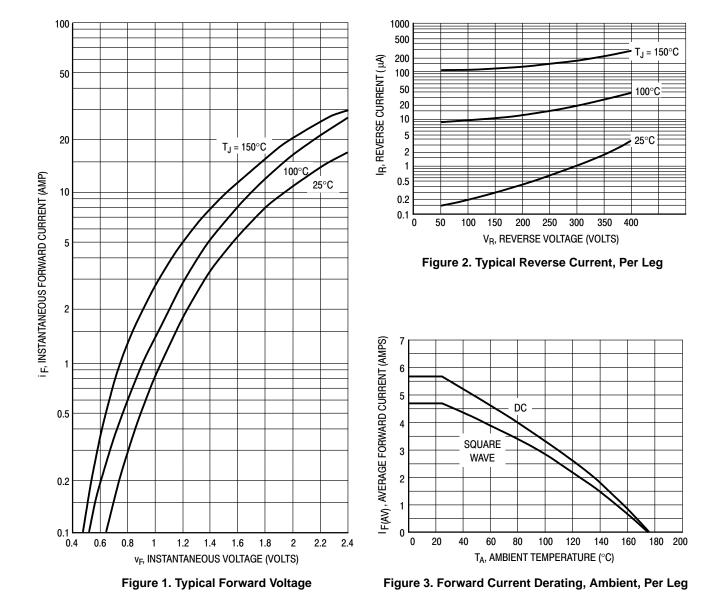
**Preferred** devices are recommended choices for future use and best overall value.

## MURH840CT

### THERMAL CHARACTERISTICS (Per Diode Leg)

Rating	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	R <sub>θJC</sub>	3.0	°C/W
ELECTRICAL CHARACTERISTICS (Per Diode Leg)			
Maximum Instantaneous Forward Voltage (Note 1.) ( $i_F = 4.0 \text{ Amps}, T_C = 150^{\circ}\text{C}$ ) ( $i_F = 4.0 \text{ Amps}, T_C = 25^{\circ}\text{C}$ )	VF	1.9 2.2	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 150^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	500 10	μΑ
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/μs)	t <sub>rr</sub>	28	ns

1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq$  2.0%.



## MURH840CT

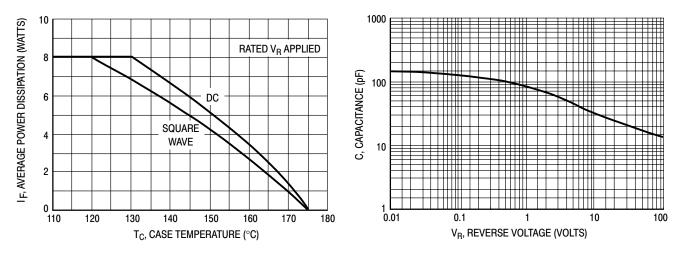


Figure 4. Current Derating, Case, Per Leg

Figure 5. Typical Capacitance, Per Leg

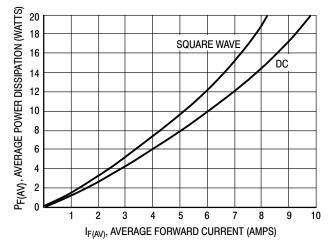


Figure 6. Forward Power Dissipation, Per Leg

## MURH860CT

Preferred Device

## MEGAHERTZ™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 Volts
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures

## **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: UH860

### MAXIMUM RATINGS (Per Leg)

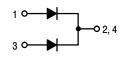
· •				
Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600	V	
Average Rectified Forward Current (Rated $V_R$ , $T_C = 120^{\circ}C$ ) Total Device	I <sub>F(AV)</sub>	4.0 8.0	A	
Peak Repetitive Forward Current (Rated $V_R$ , Square Wave, 20 kHz, $T_C = 120^{\circ}C$ )	I <sub>FM</sub>	16	A	
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	100	A	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C	

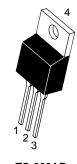


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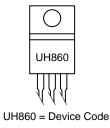
ULTRAFAST RECTIFIER 8.0 AMPERES 600 VOLTS





TO-220AB CASE 221A PLASTIC

### MARKING DIAGRAM



## ORDERING INFORMATION

Device	Package	Shipping
MURH860CT	TO-220	50 Units/Rail

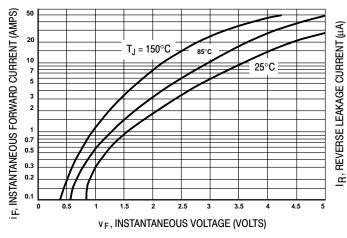
**Preferred** devices are recommended choices for future use and best overall value.

## MURH860CT

### THERMAL CHARACTERISTICS (Per Leg)

Rating	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	R <sub>θJC</sub>	3.0	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)			
Maximum Instantaneous Forward Voltage (Note 1.) ( $i_F = 4.0 \text{ Amps}, T_C = 150^{\circ}\text{C}$ ) ( $i_F = 4.0 \text{ Amps}, T_C = 25^{\circ}\text{C}$ )	VF	2.5 2.8	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 150^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	500 10	μΑ
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/μs)	t <sub>rr</sub>	35	ns

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%



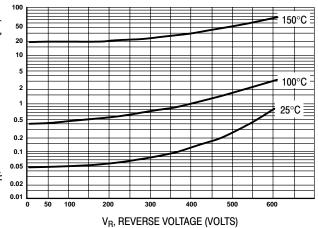


Figure 1. Typical Forward Voltage, Per Leg

Figure 2. Typical Reverse Leakage Current, Per Leg

RATED VOLTAGE APPLIED  $R_{\theta JC} = 3^{\circ}C/W$ 

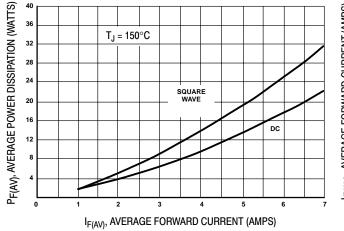


Figure 3. Typical Forward Dissipation, Per Leg

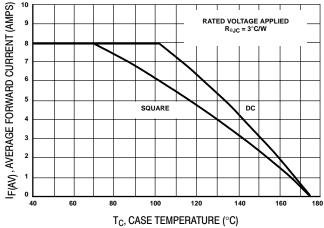
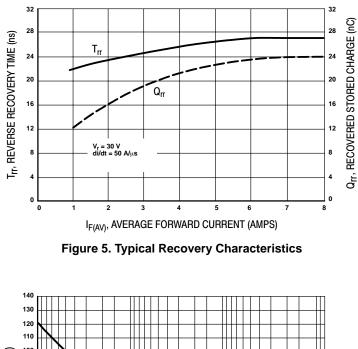


Figure 4. Typical Current Derating, Case, Per Leg

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## MURH860CT



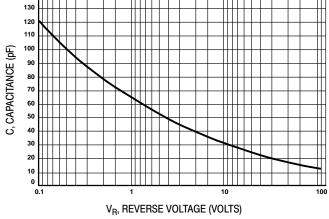


Figure 6. Typical Capacitance, Per Leg

## SWITCHMODE™ Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 and 60 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 Volts
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1610, U1615, U1620, U1640, U1660

#### MAXIMUM RATINGS

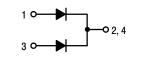
Please See the Table on the Following Page



## ON Semiconductor"

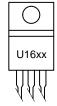
http://onsemi.com

ULTRAFAST RECTIFIERS 8.0 AMPERES 100-600 VOLTS





### MARKING DIAGRAM



TO-220AB CASE 221A PLASTIC

U16xx = Device Code xx = 10, 15, 20, 40 or 60

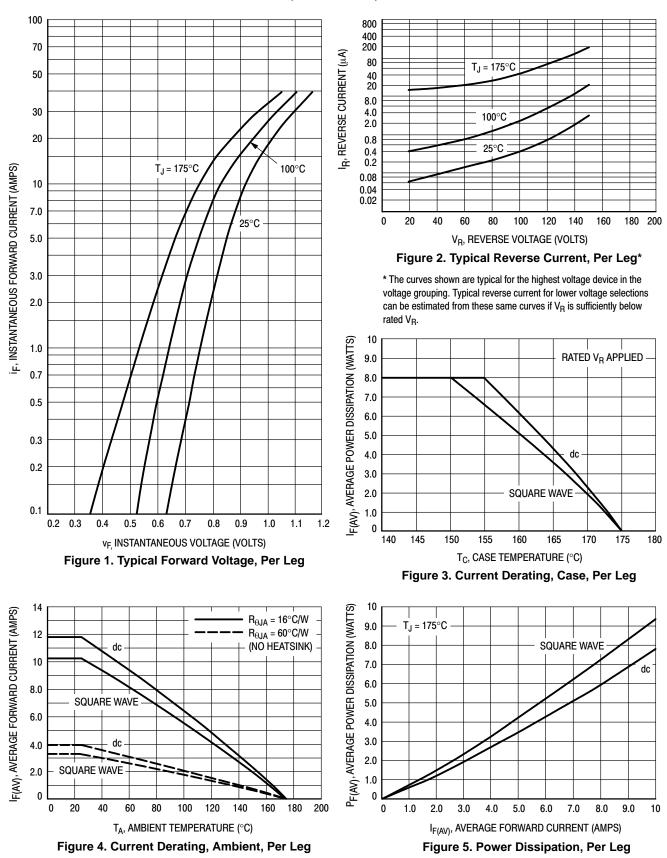
### ORDERING INFORMATION

Device	Package	Shipping
MUR1610CT	TO-220	50 Units/Rail
MUR1615CT	TO-220	50 Units/Rail
MUR1620CT	TO-220	50 Units/Rail
MUR1640CT	TO-220	50 Units/Rail
MUR1660CT	TO-220	50 Units/Rail

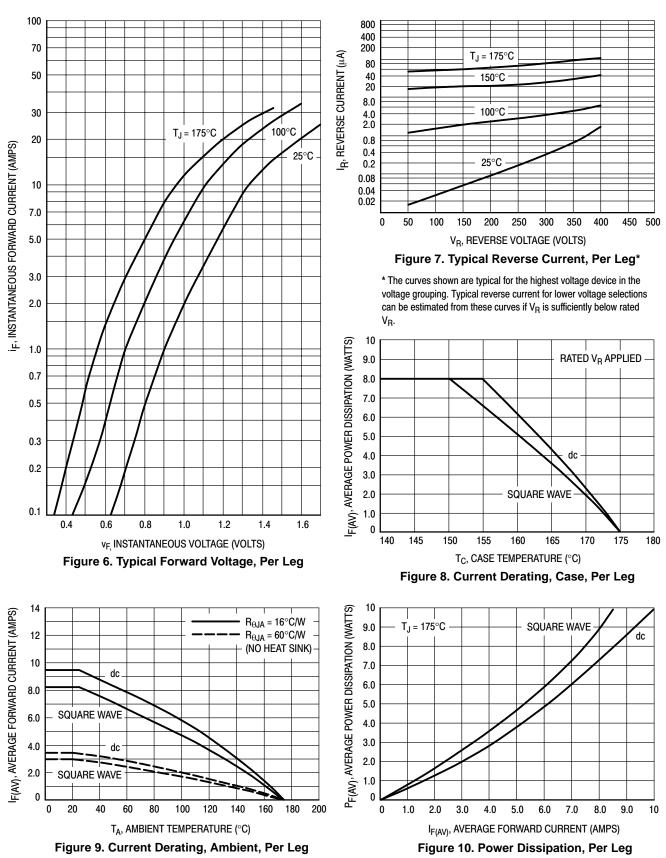
### MAXIMUM RATINGS

				MUR16			
Rating	Symbol	10CT	15CT	20CT	40CT	60CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	150	200	400	600	Volts
Average Rectified Forward CurrentPer LegTotal Device, (Rated $V_R$ ), $T_C = 150^{\circ}C$ Total Device	I <sub>F(AV)</sub>			8.0 16			Amps
Peak Rectified Forward CurrentPer Diode Leg(Rated $V_R$ , Square Wave, 20 kHz), $T_C = 150^{\circ}C$	I <sub>FM</sub>			16			Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>			100			Amps
Operating Junction Temperature and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +175			°C		
HERMAL CHARACTERISTICS (Per Diode Leg)							-
Maximum Thermal Resistance, Junction to Case	$R_{ extsf{ heta}JC}$		3.0		2	.0	°C/W
ELECTRICAL CHARACTERISTICS (Per Diode Leg)							
Maximum Instantaneous Forward Voltage (Note 1.) ( $i_F = 8.0 \text{ Amps}, T_C = 150^{\circ}\text{C}$ ) ( $i_F = 8.0 \text{ Amps}, T_C = 25^{\circ}\text{C}$ )	VF		0.895 0.975		1.00 1.30	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 150^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	250 500 5.0 10			μA		
Maximum Reverse Recovery Time ( $I_F = 1.0 \text{ Amp, di/dt} = 50 \text{ Amps/}\mu\text{s}$ ) ( $I_F = 0.5 \text{ Amp, }I_R = 1.0 \text{ Amp, }I_{REC} = 0.25 \text{ Amp}$ )	t <sub>rr</sub>		35 25		-	0 0	ns

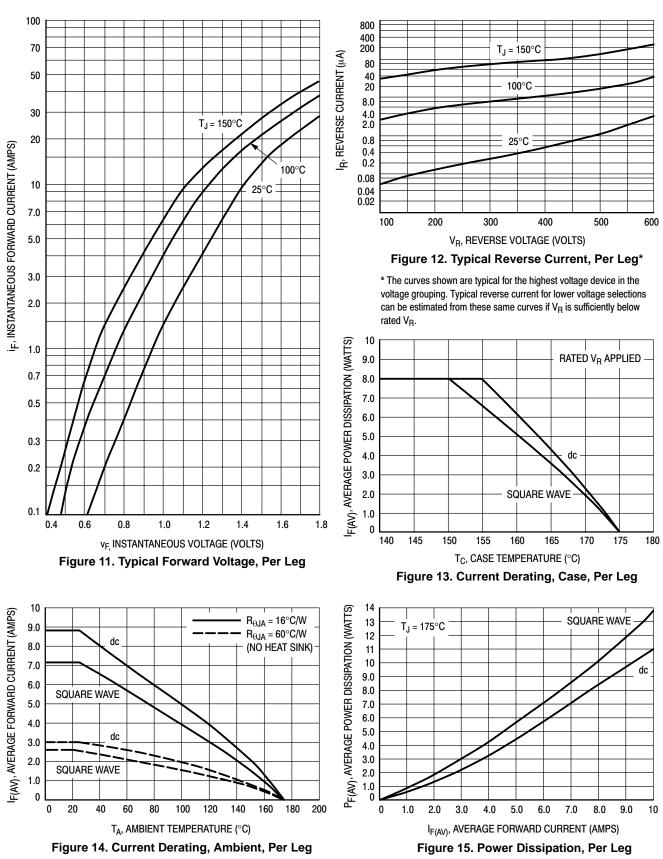
1. Pulse Test: Pulse Width = 300  $\mu s,$  Duty Cycle  $\leq 2.0\%$ 



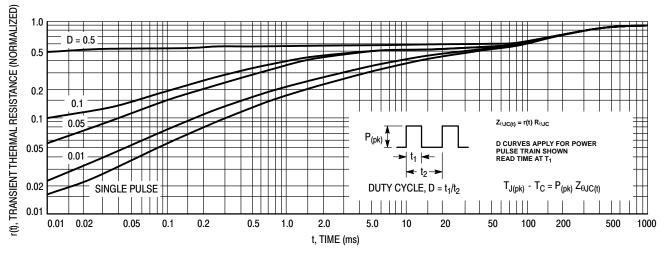
## MUR1610CT, MUR1615CT, MUR1620CT

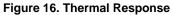


#### MUR1640CT



#### MUR1660CT





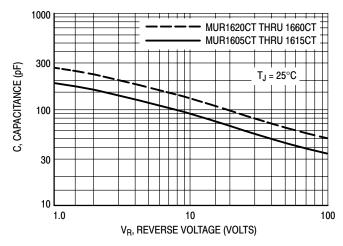


Figure 17. Typical Capacitance, Per Leg

## MUR1620CTR

Preferred Device

## SWITCHMODE™ Dual Ultrafast Power Rectifier

... designed for use in negative switching power supplies, inverters and as free wheeling diodes. Also, used in conjunction with common cathode dual Ultrafast Rectifiers, makes a single phase full-wave bridge. These state-of-the-art devices have the following features:

- Common Anode Dual Rectifier (8.0 A per Leg or 16 A per Package)
- Ultrafast 35 Nanosecond Reverse Recovery Times
- Exhibits Soft Recovery Characteristics
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- Complement to MUR1620CT Common Cathode Device
- Mechanical Characteristics:
- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1620R

### MAXIMUM RATINGS (Per Leg)

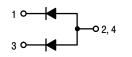
Rating	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	V	
Average Rectified Forward Voltage (Rated V <sub>R</sub> , T <sub>C</sub> = 160°C) Per Leg Per Total Device	I <sub>F(AV)</sub>	8.0 16	A	
$\begin{array}{l} \mbox{Peak Repetitive Surge Current} \\ (Rated V_R, Square Wave, \\ 20 \mbox{ kHz}, T_C = 140^{\circ} \mbox{C}) & \mbox{Per Diode} \end{array}$	I <sub>FM</sub>	16	A	
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	100	A	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C	



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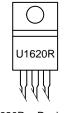
ULTRAFAST RECTIFIER 16 AMPERES 200 VOLTS





TO-220AB CASE 221A STYLE 7

### MARKING DIAGRAM



U1620R = Device Code

### ORDERING INFORMATION

Device	Package	Shipping
MUR1620CTR	TO-220	50 Units/Rail

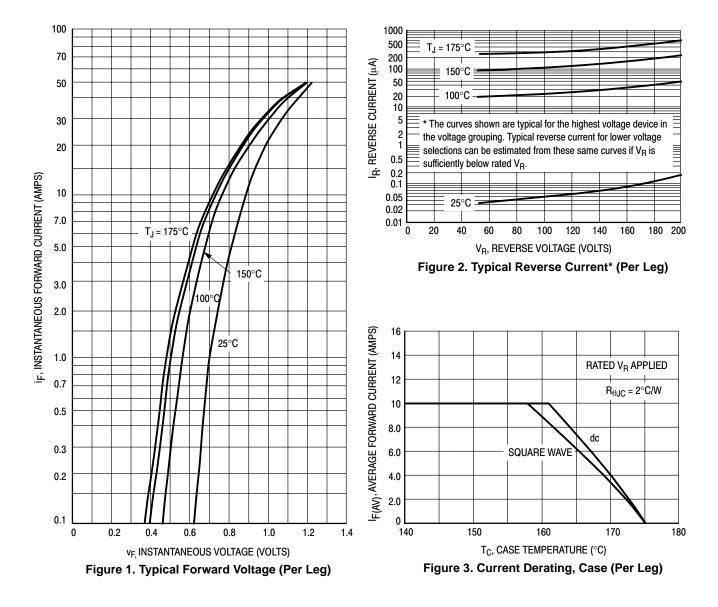
**Preferred** devices are recommended choices for future use and best overall value.

## MUR1620CTR

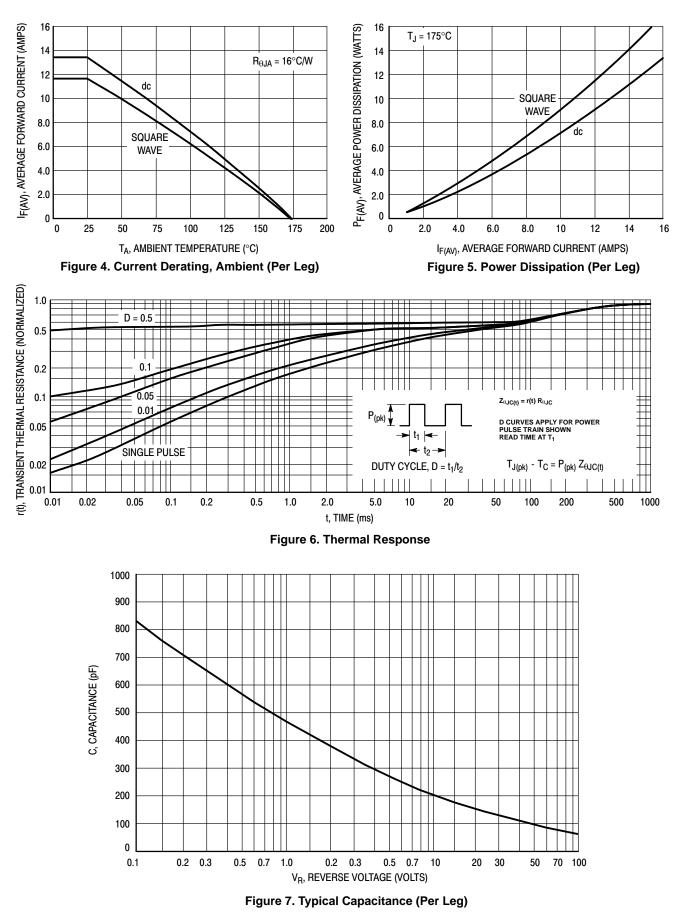
#### THERMAL CHARACTERISTICS (Per Leg)

Rating	Symbol	Value	Unit
Thermal Resistance — Junction to Case	$R_{\theta JC}$	2.0	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)			
Maximum Instantaneous Forward Voltage (Note 1.) ( $i_F = 8.0 \text{ Amps}, T_C = 25^{\circ}C$ ) ( $i_F = 8.0 \text{ Amps}, T_C = 150^{\circ}C$ )	VF	1.2 1.1	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 25^{\circ}C$ ) (Rated dc Voltage, $T_C = 150^{\circ}C$ )	i <sub>R</sub>	5.0 500	μΑ
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/μs) (I <sub>F</sub> = 0.5 Amp, di/dt = 100 Amps/μs)	t <sub>rr</sub>	85 35	ns

1. Pulse Test: Pulse Width = 5.0 ms, Duty Cycle  $\leq$  10%.



## MUR1620CTR



Preferred Devices

## SWITCHMODE™ Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 25, 50 and 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 600 Volts

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U805, U810, U815, U820, U840, U860

#### MAXIMUM RATINGS

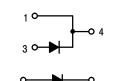
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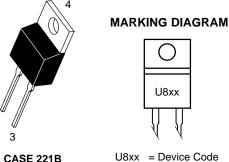


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ULTRAFAST RECTIFIERS 8.0 AMPERES 50-600 VOLTS





CASE 221B TO-220AC PLASTIC

U8xx = Device Code xx = 05, 10, 15, 20, 40 or 60

#### **ORDERING INFORMATION**

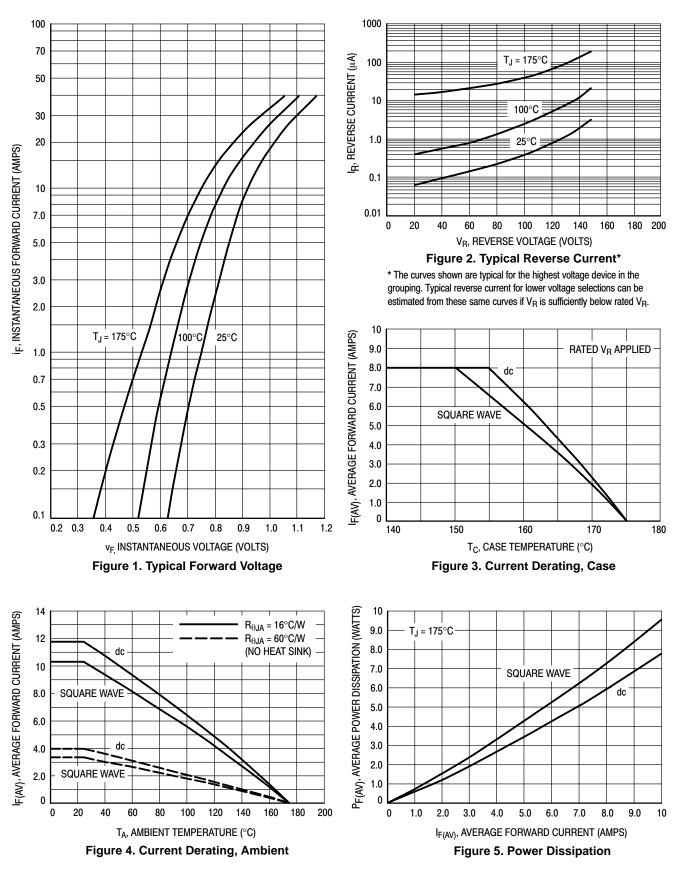
Device	Package Shipping	
MUR805	TO-220	50 Units/Rail
MUR810	TO-220	50 Units/Rail
MUR815	TO-220	50 Units/Rail
MUR820	TO-220	50 Units/Rail
MUR840	TO-220	50 Units/Rail
MUR860	TO-220	50 Units/Rail

**Preferred** devices are recommended choices for future use and best overall value.

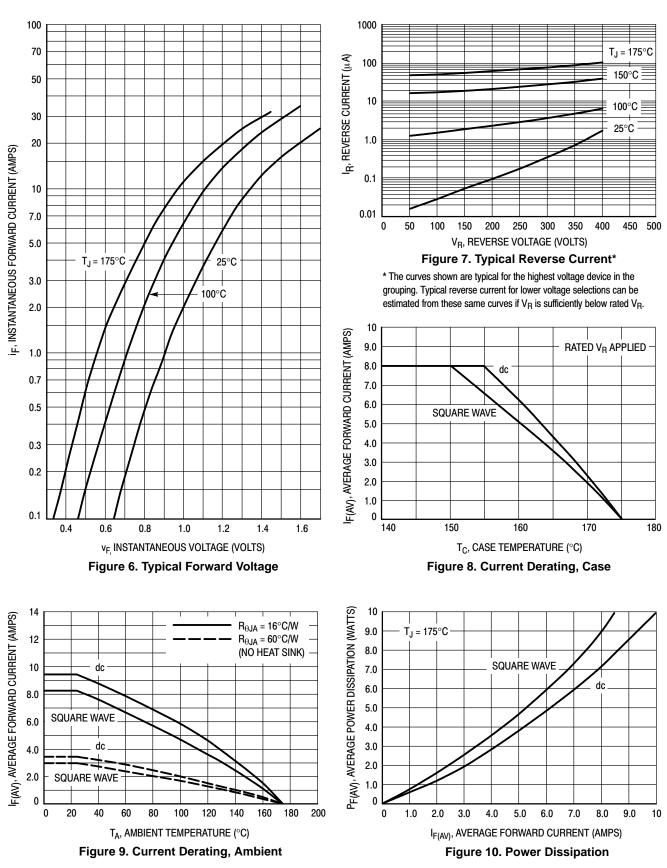
### MAXIMUM RATINGS

		MUR						
Rating	Symbol	805	810	815	820	840	860	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	150	200	400	600	Volts
Average Rectified Forward Current Total Device, (Rated V <sub>R</sub> ), T <sub>C</sub> = 150°C	I <sub>F(AV)</sub>	8.0					Amps	
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz), $T_C = 150^{\circ}C$	I <sub>FM</sub>	16				Amps		
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	100				Amps		
Operating Junction Temperature and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175				°C		
THERMAL CHARACTERISTICS								-
Maximum Thermal Resistance, Junction to Case	$R_{\thetaJC}$	3.0 2.0				°C/W		
ELECTRICAL CHARACTERISTICS								-
$\label{eq:maximum lnstantaneous Forward Voltage (Note 1.)} \\ (i_F = 8.0 \text{ Amps}, \text{ T}_{\text{C}} = 150^{\circ}\text{C}) \\ (i_F = 8.0 \text{ Amps}, \text{ T}_{\text{C}} = 25^{\circ}\text{C}) \\ \end{aligned}$	VF	0.895 0.975		1.00 1.30	1.20 1.50	Volts		
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_J = 150^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	İR	250 5.0			500 10		μA	
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/μs) (I <sub>F</sub> = 0.5 Amp, i <sub>R</sub> = 1.0 Amp, I <sub>REC</sub> = 0.25 Amp)	t <sub>rr</sub>				60 60	ns		

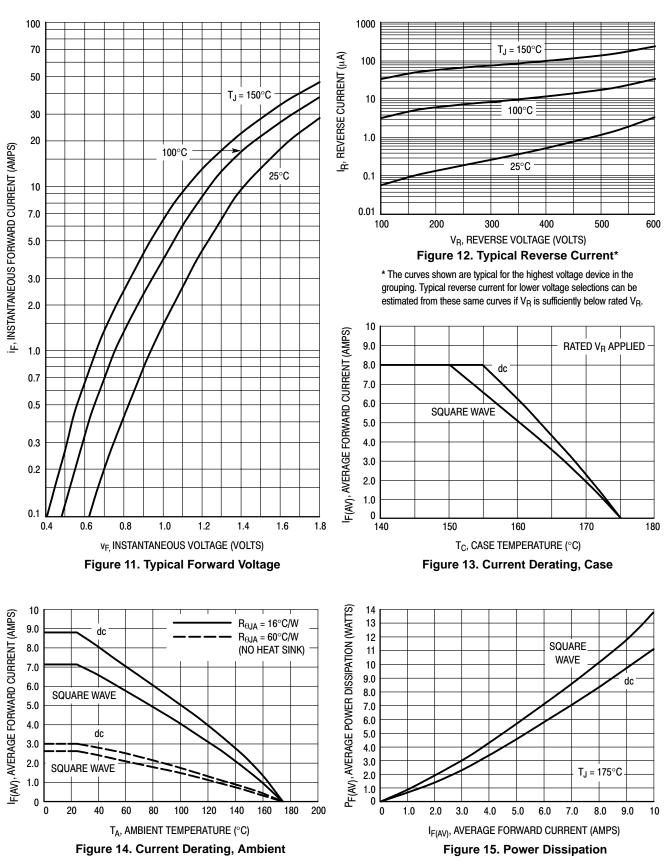
1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



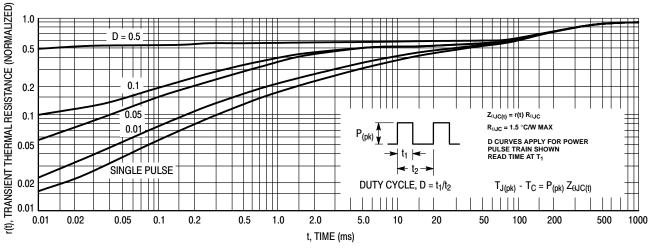
#### MUR805, MUR810, MUR815, MUR820



**MUR840** 



**MUR860** 





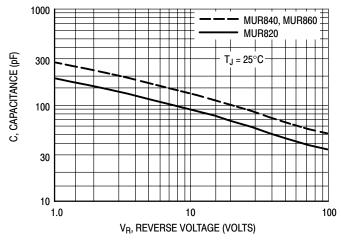


Figure 17. Typical Capacitance

Preferred Devices

# SWITCHMODE™ Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 and 60 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- High Voltage Capability to 600 Volts
- Low Forward Drop
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating Specified @ Both Case and Ambient Temperatures

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1510, U1515, U1520, U1540, U1560

### MAXIMUM RATINGS

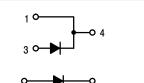
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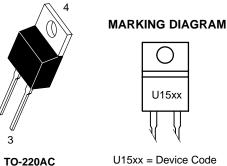


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ULTRAFAST RECTIFIERS 15 AMPERES 100-600 VOLTS





TO-220AC CASE 221B PLASTIC

U15xx = Device Code xx = 10, 15, 20, 40 or 60

### **ORDERING INFORMATION**

Device	Package	Shipping
MUR1510	TO-220	50 Units/Rail
MUR1515	TO-220	50 Units/Rail
MUR1520	TO-220	50 Units/Rail
MUR1540	TO-220	50 Units/Rail
MUR1560	TO-220	50 Units/Rail

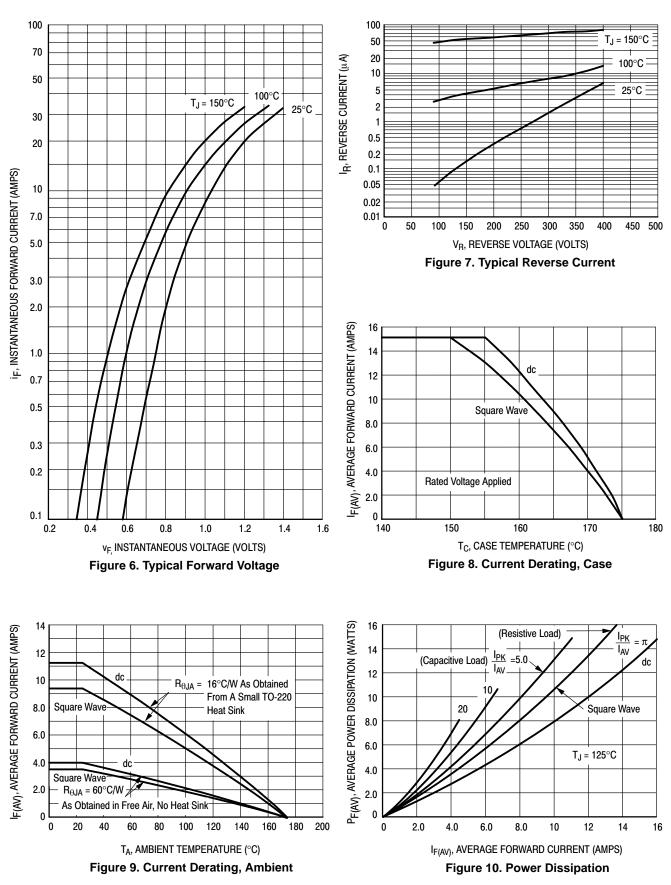
### MAXIMUM RATINGS

				MU	र		
Rating	Symbol	1510	1515	1520	1540	1560	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	100	150	200	400	600	Volts
Average Rectified Forward Current (Rated V <sub>R</sub> )	I <sub>F(AV)</sub>			5 = 150°C		15 @ T <sub>C</sub> = 145°C	Amps
Peak Rectified Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz)	I <sub>FRM</sub>		-	0 = 150°C		30 @ T <sub>C</sub> = 145°C	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	200			200 150		Amps
Operating Junction Temperature and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175				°C	
THERMAL CHARACTERISTICS	·						
Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	1.5				°C/W	
ELECTRICAL CHARACTERISTICS	·						
$\label{eq:maximum lnstantaneous Forward Voltage (Note 1.)} \\ (i_F = 15 \mbox{ Amps, } T_C = 150^\circ\mbox{C}) \\ (i_F = 15 \mbox{ Amps, } T_C = 25^\circ\mbox{C}) \\ \end{aligned}$	VF		0.85 1.05		1.12 1.25	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 150^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>		500 10		500 10	1000 10	μA
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/μs)	t <sub>rr</sub>		35			60	ns

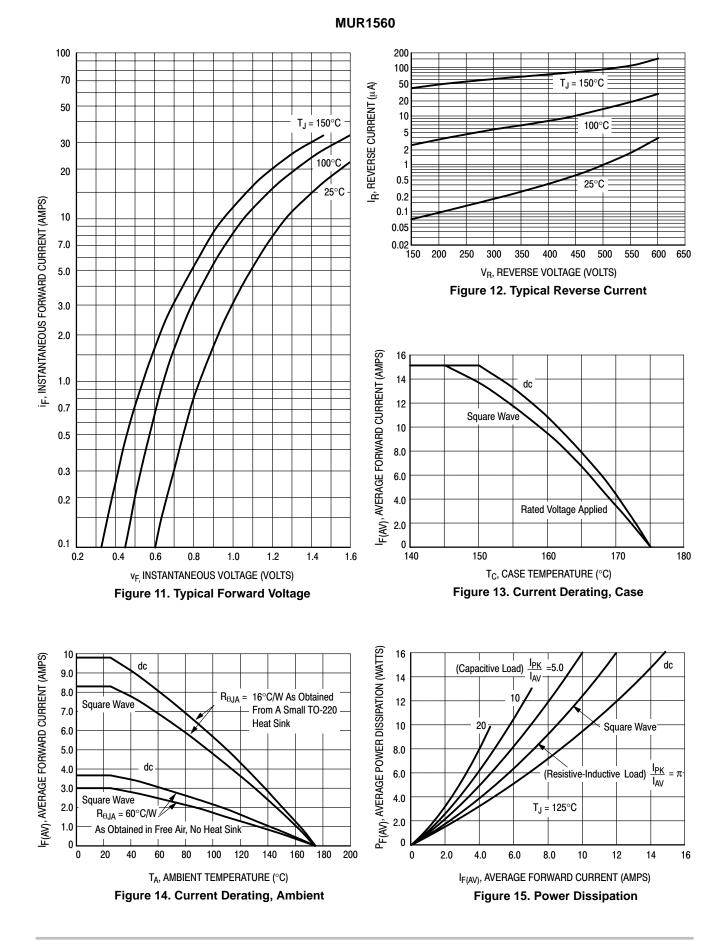
1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

#### 100 100 T<sub>J</sub> = 150°C T<sub>J</sub> = 150°C 50 100°C 70 20 I<sub>R</sub>, REVERSE CURRENT (µA) 100°C 25°C 10 50 5 2 30 1 0.5 20 25°C 0.2 0.1 i<sub>F</sub>, INSTANTANEOUS FORWARD CURRENT (AMPS) 0.05 10 0.02 7.0 0.01 20 60 0 40 80 100 120 140 160 180 200 5.0 V<sub>R</sub>, REVERSE VOLTAGE (VOLTS) Figure 2. Typical Reverse Current 3.0 2.0 I<sub>F(AV)</sub>, AVERAGE FORWARD CURRENT (AMPS) 16 14 1.0 dc 12 0.7 10 0.5 Square Wave 8.0 0.3 6.0 0.2 4.0 **Rated Voltage Applied** 2.0 0.1 0 0.4 0.6 0.8 1.0 1.2 1.4 1.6 140 150 160 170 180 0.2 T<sub>C</sub>, CASE TEMPERATURE (°C) v<sub>E</sub> INSTANTANEOUS VOLTAGE (VOLTS) Figure 3. Current Derating, Case **Figure 1. Typical Forward Voltage** IF(AV), AVERAGE FORWARD CURRENT (AMPS) 14 16 PF(AV), AVERAGE POWER DISSIPATION (WATTS) (Resistive Load) $\frac{I_{PK}}{I_{AV}} = \pi$ 14 12 dc I<sub>PK</sub> =5.0 (Capacitive Load) 12 10 $R_{\theta JA} = 16^{\circ}C/W$ As Obtained IAV dc From A Small TO-220 Square Wave 10 Heat Sink 8.0 10 8.0 20 6.0 6.0 Square Wave dc 4.0 4.0 Square Wave T<sub>J</sub> = 125°C $R_{\theta JA} = 60^{\circ}C/W$ 2.0 2.0 As Obtained in Free Air, No Heat Sink 0 0 120 160 180 0 20 40 60 80 100 140 200 2.0 4.0 6.0 8.0 10 12 14 16 0 T<sub>A</sub>, AMBIENT TEMPERATURE (°C) IF(AV), AVERAGE FORWARD CURRENT (AMPS) Figure 4. Current Derating, Ambient Figure 5. Power Dissipation

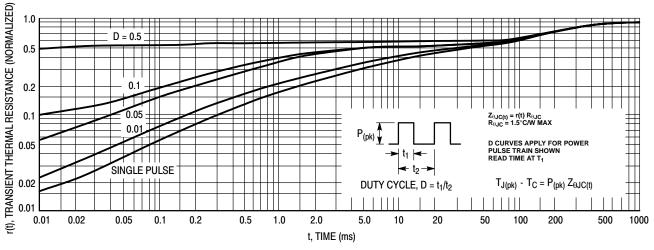
## MUR1510, MUR1515, MUR1520



MUR1540



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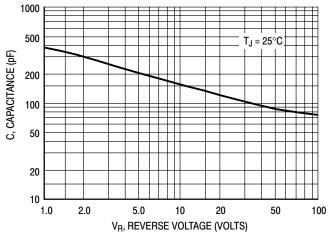


Figure 17. Typical Capacitance

# **MUR2020R**

Preferred Device

# SWITCHMODE™ Ultrafast Power Rectifier

... designed for use in negative switching power supplies, inverters and as free wheeling diode. Also, used in conjunction with a standard cathode dual Ultrafast Rectifier, makes a single phase full-wave bridge. These state-of-the-art devices have the following features:

- Reverse Polarity Rectifier
- Ultrafast 95 Nanosecond Reverse Recovery Times
- Exhibits Soft Recovery Characteristics
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Case Temperature
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"

### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U2020R

### MAXIMUM RATINGS (Per Leg)

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	Volts
Average Rectified Forward Voltage, (Rated $V_R$ ), $T_C$ = 125°C	I <sub>F(AV)</sub>	20	Amps
Peak Repetitive Forward Current (Rated V <sub>R</sub> ), T <sub>C</sub> = 125°C	I <sub>FRM</sub>	40	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	250	Amps
Operating Junction Temperature and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C

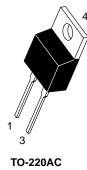


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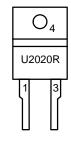
## ULTRAFAST RECTIFIER 20 AMPERES 200 VOLTS





CASE 221B PLASTIC

#### MARKING DIAGRAM



### ORDERING INFORMATION

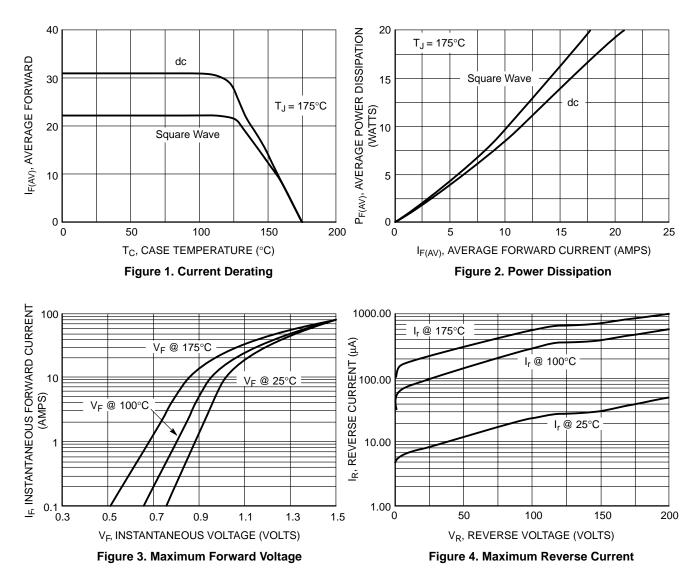
Device	Package	Shipping
MUR2020R	TO-220AC	50 Units/Rail

## **MUR2020R**

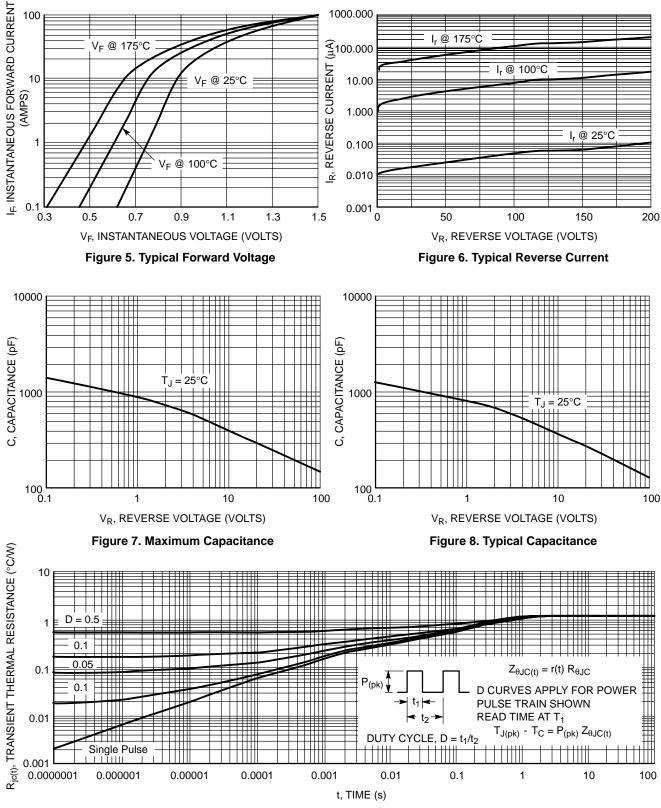
#### THERMAL CHARACTERISTICS (Per Leg)

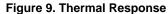
Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction to Case	R <sub>θJC</sub>	2.0	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)			
Maximum Instantaneous Forward Voltage (Note 1) ( $I_F = 20 \text{ Amps}, T_C = 25^{\circ}C$ ) ( $I_F = 20 \text{ Amps}, T_C = 150^{\circ}C$ )	V <sub>F</sub>	1.1 1.0	Volts
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_C = 25^{\circ}C$ ) (Rated dc Voltage, $T_C = 150^{\circ}C$ )	I <sub>R</sub>	50 1	μA mA
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/μs) (I <sub>F</sub> = 1.0 Amp, di/dt = 100 Amps/μs)	t <sub>rr</sub>	95 75	ns

1. Pulse Test: Pulse Width = 5.0 ms, Duty Cycle  $\leq$  10%.



# **MUR2020R**





MUR8100E is a Preferred Device

# SWITCHMODE™ Power Rectifiers

# Ultrafast "E" Series with High Reverse Energy Capability

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- 20 mjoules Avalanche Energy Guaranteed
- Excellent Protection Against Voltage Transients in Switching Inductive Load Circuits
- Ultrafast 75 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-220 Package
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- Reverse Voltage to 1000 Volts

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U880E, U8100E

#### MAXIMUM RATINGS

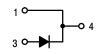
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage MUR880E MUR8100E	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	800 1000	V
Average Rectified Forward Current (Rated $V_R$ , $T_C = 150^{\circ}C$ ) Total Device	I <sub>F(AV)</sub>	8.0	A
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 150°C)	I <sub>FM</sub>	16	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	100	A
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C

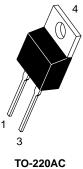


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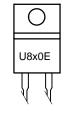
# ULTRAFAST RECTIFIERS 8.0 AMPERES 800-1000 VOLTS





CASE 221B PLASTIC

### MARKING DIAGRAM



U8x0E = Device Code x = 8 or 10

### ORDERING INFORMATION

Device	Package	Shipping
MUR8100E	TO-220	50 Units/Rail
MUR880E	TO-220	50 Units/Rail

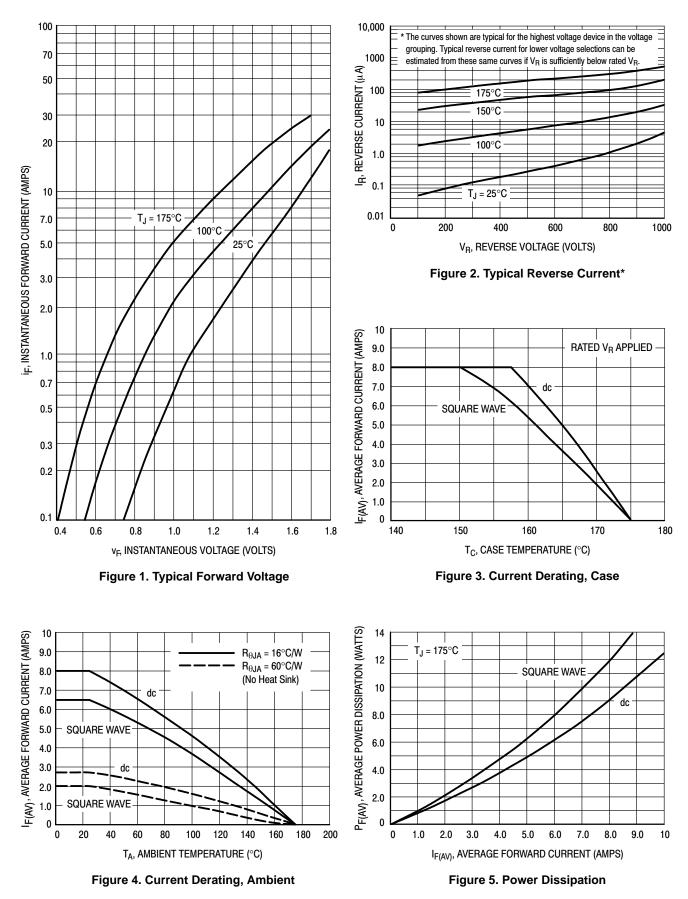
#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	$R_{\thetaJC}$	2.0	°C/W

## **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	MUR880E	MUR8100E	Unit
Maximum Instantaneous Forward Voltage (Note 1.) ( $i_F = 8.0 \text{ Amps}, T_C = 150^{\circ}\text{C}$ ) ( $i_F = 8.0 \text{ Amps}, T_C = 25^{\circ}\text{C}$ )	VF		.5 .8	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 100^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	-	00 25	μΑ
	t <sub>rr</sub>	-	00 '5	ns
Controlled Avalanche Energy (See Test Circuit in Figure 6)	W <sub>AVAL</sub>	2	0	mJ

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



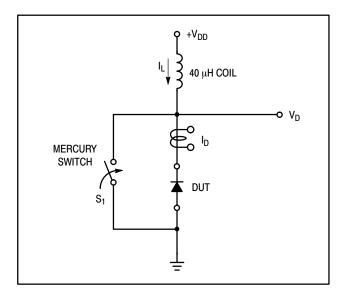


Figure 6. Test Circuit

The unclamped inductive switching circuit shown in Figure 6 was used to demonstrate the controlled avalanche capability of the new "E" series Ultrafast rectifiers. A mercury switch was used instead of an electronic switch to simulate a noisy environment when the switch was being opened.

When  $S_1$  is closed at  $t_0$  the current in the inductor  $I_L$  ramps up linearly; and energy is stored in the coil. At  $t_1$  the switch is opened and the voltage across the diode under test begins to rise rapidly, due to di/dt effects, when this induced voltage reaches the breakdown voltage of the diode, it is clamped at  $BV_{DUT}$  and the diode begins to conduct the full load current which now starts to decay linearly through the diode, and goes to zero at  $t_2$ .

By solving the loop equation at the point in time when  $S_1$  is opened; and calculating the energy that is transferred to the diode it can be shown that the total energy transferred is equal to the energy stored in the inductor plus a finite amount of energy from the V<sub>DD</sub> power supply while the diode is in

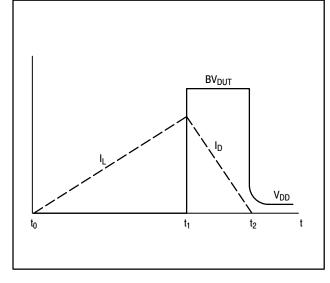


Figure 7. Current-Voltage Waveforms

breakdown (from  $t_1$  to  $t_2$ ) minus any losses due to finite component resistances. Assuming the component resistive elements are small Equation (1) approximates the total energy transferred to the diode. It can be seen from this equation that if the V<sub>DD</sub> voltage is low compared to the breakdown voltage of the device, the amount of energy contributed by the supply during breakdown is small and the total energy can be assumed to be nearly equal to the energy stored in the coil during the time when S<sub>1</sub> was closed, Equation (2).

The oscilloscope picture in Figure 8, shows the MUR8100E in this test circuit conducting a peak current of one ampere at a breakdown voltage of 1300 volts, and using Equation (2) the energy absorbed by the MUR8100E is approximately 20 mjoules.

Although it is not recommended to design for this condition, the new "E" series provides added protection against those unforeseen transient viruses that can produce unexplained random failures in unfriendly environments.



$$W_{AVAL} \approx \frac{1}{2} LI_{LPK}^{2} \left( \frac{BV_{DUT}}{BV_{DUT} - V_{DD}} \right)$$

**EQUATION (2):** 

$$W_{AVAL} \approx \frac{1}{2} LI_{LPK}^2$$

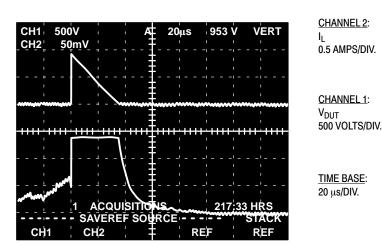
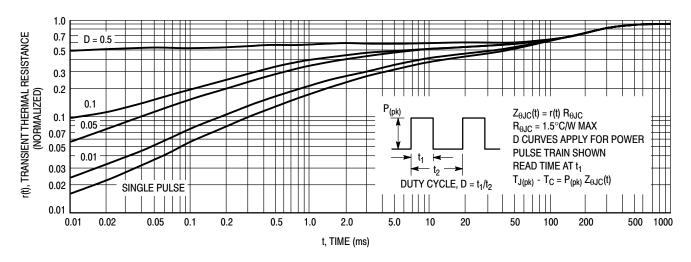


Figure 8. Current-Voltage Waveforms





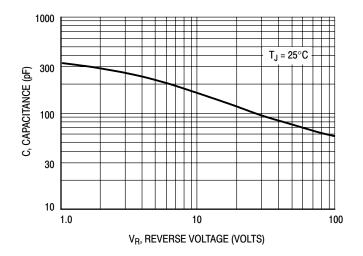


Figure 10. Typical Capacitance

# MURF1620CT

Preferred Device

# SWITCHMODE™ Power Rectifier

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Times
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369 (Note 1.)

## **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1620

### MAXIMUM RATINGS

Please See the Table on the Following Page

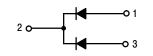
1. UL Recognized mounting method is per Figure 4



# **ON Semiconductor**<sup>™</sup>

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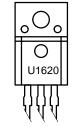
ULTRAFAST RECTIFIER 16 AMPERES 200 VOLTS





ISOLATED TO-220 CASE 221D STYLE 3

#### MARKING DIAGRAM



U1620 = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MURF1620CT	TO-220	50 Units/Rail

# MURF1620CT

#### MAXIMUM RATINGS (Per Leg)

Rating		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	Volts
Average Rectified Forward Current Total Device, (Rated V <sub>R</sub> ), T <sub>C</sub> = 150°C	Total Device	I <sub>F(AV)</sub>	8 16	Amps
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 150°C		I <sub>FM</sub>	16	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)		I <sub>FSM</sub>	100	Amps
Operating Junction and Storage Temperature		T <sub>J</sub> , T <sub>stg</sub>	- 65 to +150	°C
RMS Isolation Voltage (t = 1 second, R.H. $\leq$ 30%, T <sub>A</sub> = 25°C) (Note 3.) Per F	Per Figure 3 igure 4 (Note 2.) Per Figure 5	V <sub>iso1</sub> V <sub>iso2</sub> V <sub>iso3</sub>	4500 3500 1500	Volts

#### THERMAL CHARACTERISTICS (Per Leg)

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	4.2	°C/W
Lead Temperature for Soldering Purposes: 1/8" from the Case for 5 seconds	ΤL	260	°C

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 4.) ( $i_F = 8.0 \text{ Amp}, T_C = 150^{\circ}\text{C}$ ) ( $i_F = 8.0 \text{ Amp}, T_C = 25^{\circ}\text{C}$ )	VF	0.895 0.975	Volts
Maximum Instantaneous Reverse Current (Note 4.) (Rated dc Voltage, $T_C = 150^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	İR	250 5.0	μΑ
Maximum Reverse Recovery Time $(I_F = 1.0 \text{ Amp, di/dt} = 50 \text{ Amp/}\mu s)$ $(I_F = 0.5 \text{ Amp, } i_R = 1.0 \text{ Amp, } I_{REC} = 0.25 \text{ Amp})$	t <sub>rr</sub>	35 25	ns

2. UL Recognized mounting method is per Figure 4

3. Proper strike and creepage distance must be provided.

4. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

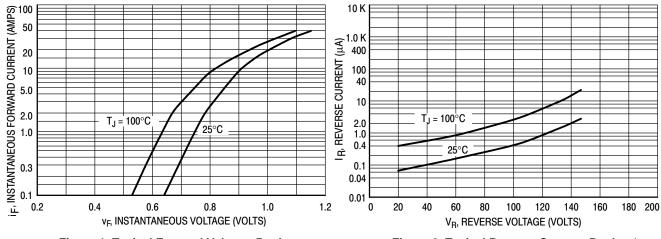


Figure 1. Typical Forward Voltage, Per Leg

Figure 2. Typical Reverse Current, Per Leg\*

## MURF1620CT

### **TEST CONDITIONS FOR ISOLATION TESTS\***

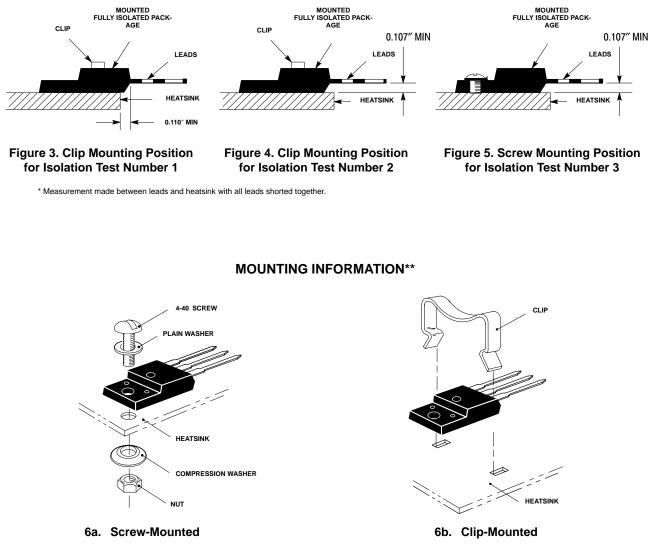


Figure 6. Typical Mounting Techniques

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of 20 in  $\cdot$  lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in  $\cdot$  lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, ON Semiconductor does not recommend exceeding 10 in  $\cdot$  lbs of mounting torque under any mounting conditions.

\*\*For more information about mounting power semiconductors see Application Note AN1040.

# MURF1660CT

Preferred Device

# SWITCHMODE™ Power Rectifier

Designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 60 Nanosecond Recovery Times
- 150°C Operating Junction Temperature
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating @ Both Case and Ambient Temperatures
- Electrically Isolated. No Isolation Hardware Required.
- UL Recognized File #E69369 (Note 1.)

## **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: U1660

### MAXIMUM RATINGS

Please See the Table on the Following Page

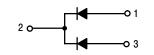
1. UL Recognized mounting method is per Figure 4



# **ON Semiconductor**<sup>™</sup>

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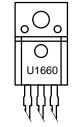
ULTRAFAST RECTIFIER 16 AMPERES 600 VOLTS





ISOLATED TO-220 CASE 221D STYLE 3

#### MARKING DIAGRAM



U1660 = Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MURF1660CT	TO-220	50 Units/Rail

# MURF1660CT

#### MAXIMUM RATINGS (Per Leg)

Rating		Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600	Volts
Average Rectified Forward Current Total Device, (Rated V <sub>R</sub> ), T <sub>C</sub> = 150°C	Per Diode Per Device	I <sub>F(AV)</sub>	8 16	Amps
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz), T <sub>C</sub> = 150°C		I <sub>FM</sub>	16	Amps
Non-repetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)		I <sub>FSM</sub>	100	Amps
Operating Junction and Storage Temperature		T <sub>J</sub> , T <sub>stg</sub>	- 65 to +150	°C
RMS Isolation Voltage (t = 1 second, R.H. $\leq$ 30%, T <sub>A</sub> = 25°C) (Note 3.) Per F	Per Figure 3 igure 4 (Note 2.) Per Figure 5	V <sub>iso1</sub> V <sub>iso2</sub> V <sub>iso3</sub>	4500 3500 1500	Volts

#### THERMAL CHARACTERISTICS (Per Leg)

Maximum Thermal Resistance, Junction to Case	$R_{\theta JC}$	3.0	°C/W
Lead Temperature for Soldering Purposes: 1/8" from Case for 5 Seconds	ΤL	260	°C

#### ELECTRICAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 4.) ( $i_F = 8.0 \text{ Amp}, T_C = 150^{\circ}\text{C}$ ) ( $i_F = 8.0 \text{ Amp}, T_C = 25^{\circ}\text{C}$ )	v <sub>F</sub>	1.20 1.50	Volts
Maximum Instantaneous Reverse Current (Note 4.) (Rated dc Voltage, $T_C = 150^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	İR	500 10	μΑ
Maximum Reverse Recovery Time $(I_F = 1.0 \text{ Amp, di/dt} = 50 \text{ Amp/}\mu\text{s})$ $(I_F = 0.5 \text{ Amp, i}_R = 1.0 \text{ Amp, I}_{REC} = 0.25 \text{ Amp})$	t <sub>rr</sub>	60 50	ns

2. UL Recognized mounting method is per Figure 4

3. Proper strike and creepage distance must be provided.

4. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

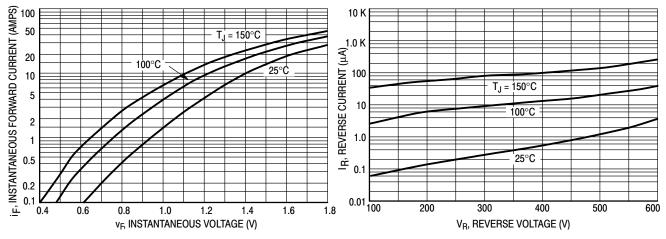


Figure 1. Typical Forward Voltage, Per Leg

Figure 2. Typical Reverse Current, Per Leg\*

## MURF1660CT

### **TEST CONDITIONS FOR ISOLATION TESTS\***

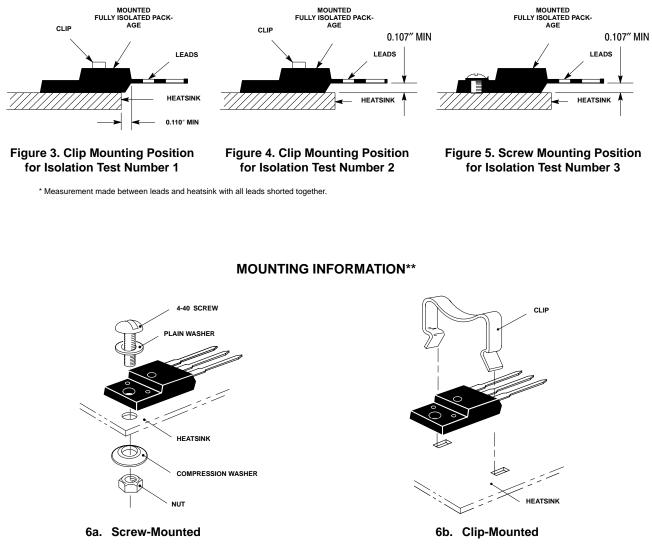


Figure 6. Typical Mounting Techniques

Laboratory tests on a limited number of samples indicate, when using the screw and compression washer mounting technique, a screw torque of 6 to 8 in · lbs is sufficient to provide maximum power dissipation capability. The compression washer helps to maintain a constant pressure on the package over time and during large temperature excursions.

Destructive laboratory tests show that using a hex head 4-40 screw, without washers, and applying a torque in excess of 20 in  $\cdot$  lbs will cause the plastic to crack around the mounting hole, resulting in a loss of isolation capability.

Additional tests on slotted 4-40 screws indicate that the screw slot fails between 15 to 20 in  $\cdot$  lbs without adversely affecting the package. However, in order to positively ensure the package integrity of the fully isolated device, ON Semiconductor does not recommend exceeding 10 in  $\cdot$  lbs of mounting torque under any mounting conditions.

\*\*For more information about mounting power semiconductors see Application Note AN1040.

# **MURHF860CT**

Preferred Device

# SWITCHMODE™ Power Rectifier

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 Nanosecond Recovery Times
- 150°C Operating Junction Temperature
- Electrically Isolated. No Isolation Hardware Required.
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction
- High Voltage Capability to 600 Volts
- Low Leakage Specified @ 150°C Case Temperature

### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.9 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 50 units per plastic tube
- Marking: UH860

### MAXIMUM RATINGS (Per Leg)

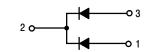
Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600	V
Average Rectified Forward Current (Rated $V_R$ , $T_C$ = 120°C) Total Device	I <sub>F(AV)</sub>	4.0 8.0	A
Peak Repetitive Forward Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 120°C)	I <sub>FM</sub>	16	A
Non-Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	100	A
Operating Junction and Storage Temperature Range	TJ, T <sub>stg</sub>	-65 to +150	°C



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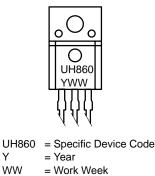
# ULTRAFAST RECTIFIER 8.0 AMPERES 600 VOLTS





ISOLATED TO-220 CASE 221D STYLE 4

### MARKING DIAGRAM



**ORDERING INFORMATION** 

Device	Package	Shipping
MURHF860CT	TO-220	50 Units/Rail

# MURHF860CT

## THERMAL CHARACTERISTICS (Per Leg)

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Case	R <sub>θJC</sub>	4.1	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)			
Maximum Instantaneous Forward Voltage (Note 1) ( $i_F = 4.0 \text{ Amps}, T_C = 150^{\circ}\text{C}$ ) ( $i_F = 4.0 \text{ Amps}, T_C = 25^{\circ}\text{C}$ )	VF	2.5 2.8	Volts
Maximum Instantaneous Reverse Current (Note 1) (Rated dc Voltage, $T_C = 150^{\circ}C$ ) (Rated dc Voltage, $T_C = 25^{\circ}C$ )	i <sub>R</sub>	500 10	μΑ
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/μs)	t <sub>rr</sub>	35	ns

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%

Preferred Devices

# SWITCHMODE™ Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 and 60 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- Popular TO-247 Package
- High Voltage Capability to 600 Volts
- Low Forward Drop
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating Specified @ Both Case and Ambient Temperatures
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction

### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: U3020, U3060

### MAXIMUM RATINGS

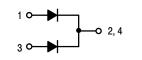
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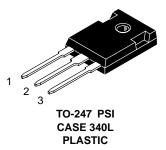


# ON Semiconductor<sup>™</sup>

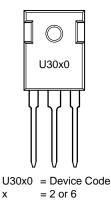
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ULTRAFAST RECTIFIERS 30 AMPERES 200-600 VOLTS





### MARKING DIAGRAM



#### **ORDERING INFORMATION**

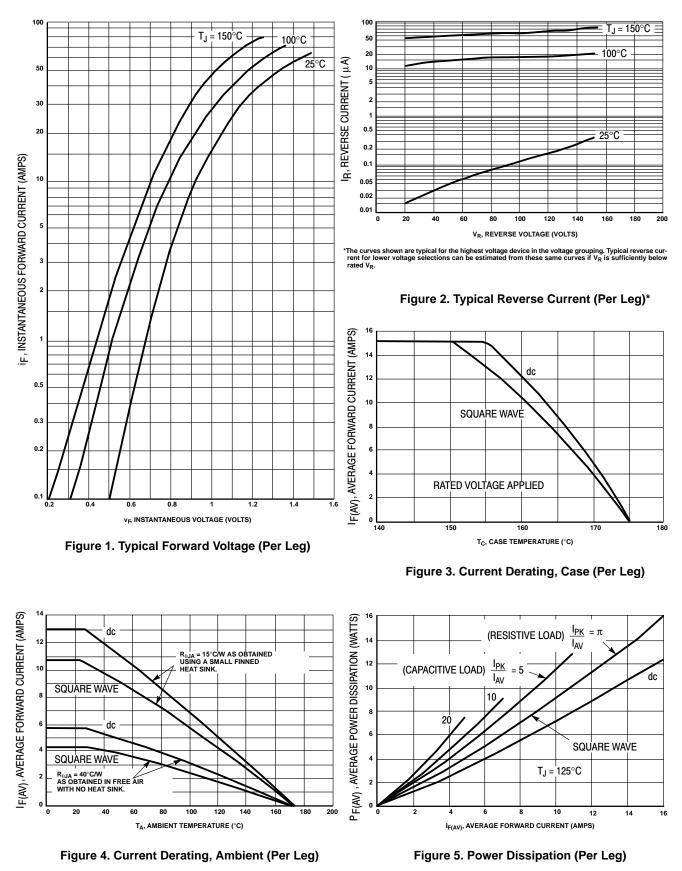
Device	Package	Shipping
MUR3020WT	TO-247	30 Units/Rail
MUR3060WT	TO-247	30 Units/Rail

### MAXIMUM RATINGS (Per Leg)

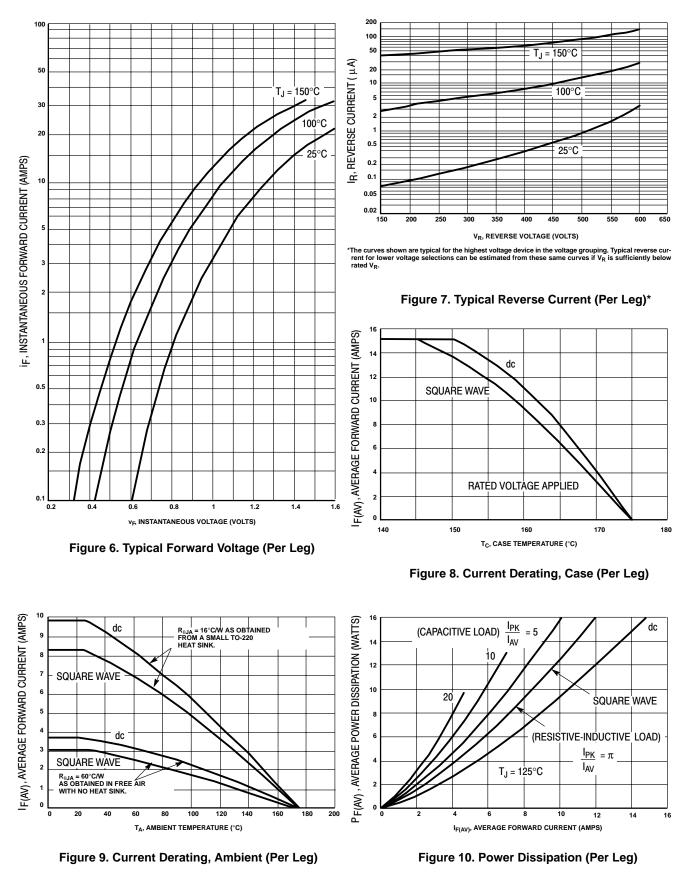
Rating	Symbol	MUR3020WT	MUR3060WT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	600	Volts
Average Rectified Forward Current @ 145°C Total Device	I <sub>F(AV)</sub>		5 30	Amps
Peak Repetitive Surge Current (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 145°C)	I <sub>FM</sub>	3	30	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	200	150	Amps
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>	- 65 t	o +175	°C
THERMAL CHARACTERISTICS (Per Leg)		·		
Maximum Thermal Resistance — Junction to Case — Junction to Ambient	R <sub>θJC</sub> R <sub>θJA</sub>		.5 40	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)		·		
Maximum Instantaneous Forward Voltage (Note 1.) ( $I_F = 15 \text{ Amp}, T_C = 150^{\circ}\text{C}$ ) ( $I_F = 15 \text{ Amp}, T_C = 25^{\circ}\text{C}$ )	VF	0.85 1.05	1.4 1.7	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated DC Voltage, $T_J = 150^{\circ}C$ ) (Rated DC Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	500 10	1000 10	μΑ
Maximum Reverse Recovery Time (i <sub>F</sub> = 1.0 A, di/dt = 50 Amps/μs)	t <sub>rr</sub>	35	60	ns

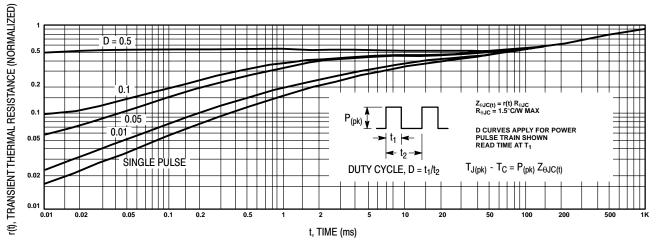
1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

### **MUR3020WT**



### **MUR3060WT**







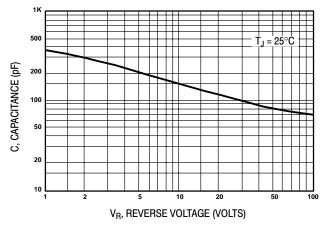


Figure 12. Typical Capacitance (Per Leg)

# SWITCHMODE<sup>™</sup> Power Rectifiers

... designed for use in switching power supplies, inverters and as free wheeling diodes, these state-of-the-art devices have the following features:

- Ultrafast 35 and 60 Nanosecond Recovery Time
- 175°C Operating Junction Temperature
- High Voltage Capability to 600 Volts
- Low Forward Drop
- Low Leakage Specified @ 150°C Case Temperature
- Current Derating Specified @ Both Case and Ambient Temperatures
- Epoxy Meets UL94, V<sub>O</sub> @ 1/8"
- High Temperature Glass Passivated Junction

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 4.3 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped 30 units per plastic tube
- Marking: U3020, U3040, U3060

#### MAXIMUM RATINGS

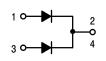
Please See the Table on the Following Page

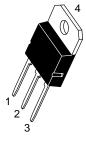


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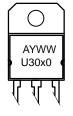
ULTRAFAST RECTIFIERS 30 AMPERES 200-600 VOLTS





TO-218AC CASE 340D STYLE 2

#### MARKING DIAGRAM



A = Assembly Location Y = Year WW = Work Week U30x0 = Device Code

= 2, 4 or 6

х

## ORDERING INFORMATION

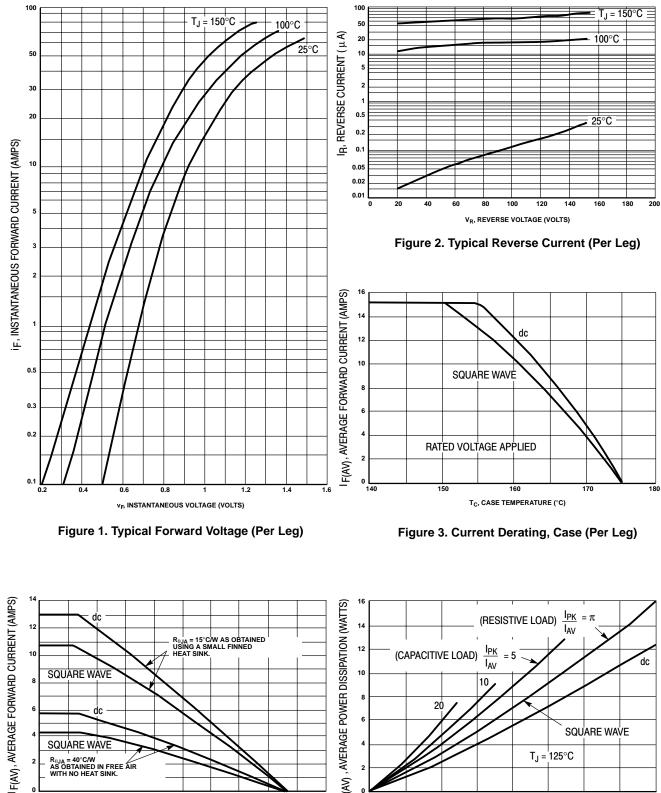
Device	Package	Shipping
MUR3020PT	SOT-93	30 Units/Rail
MUR3040PT	SOT-93	30 Units/Rail
MUR3060PT	SOT-93	30 Units/Rail

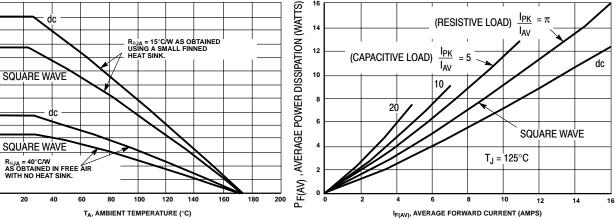
Rating	Symbol	MUR3020PT	MUR3040PT	MUR3060PT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	400	600	Volts
Average Rectified Forward Current (Rated V <sub>R</sub> ) Per Leg Per Device	I <sub>F(AV)</sub>		; = 150°C ; = 150°C	15 @ T <sub>C</sub> = 30 145°C	Amps
Peak Rectified Forward Current, Per Leg (Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>C</sub> = 150°C)	I <sub>FRM</sub>	-	80 = 150°C	30 @ T <sub>C</sub> =145°C	Amps
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz) Per Leg	I <sub>FSM</sub>	200	1	50	Amps
Operating Junction and Storage Temperature	T <sub>J</sub> , T <sub>stg</sub>		- 65 to +175		°C
THERMAL CHARACTERISTICS (Per Diode Leg)					
Maximum Thermal Resistance — Junction to Case — Junction to Ambient	R <sub>θJC</sub> R <sub>θJA</sub>		1.5 40		°C/W
ELECTRICAL CHARACTERISTICS (Per Diode Leg)					
Maximum Instantaneous Forward Voltage (Note 1.) ( $I_F = 15 \text{ Amp}, T_C = 150^{\circ}\text{C}$ ) ( $I_F = 15 \text{ Amp}, T_C = 25^{\circ}\text{C}$ )	V <sub>F</sub>	0.85 1.05	1.12 1.25	1.2 1.5	Volts
Maximum Instantaneous Reverse Current (Note 1.) (Rated DC Voltage, $T_J = 150^{\circ}C$ ) (Rated DC Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	-	00	1000 10	μA
Maximum Reverse Recovery Time (i <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/μs)	t <sub>rr</sub>	35	6	60	ns

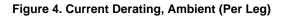
1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

MAXIMUM RATINGS (Per Leg)



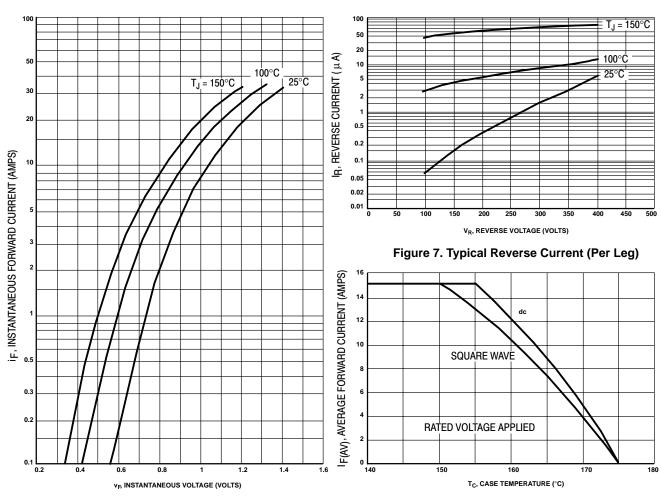






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Figure 5. Power Dissipation (Per Leg)



#### **MUR3040PT**



Figure 8. Current Derating, Case (Per Leg)

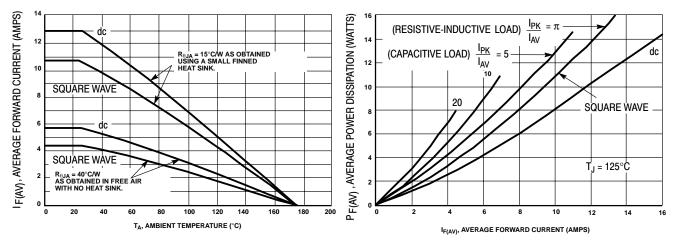
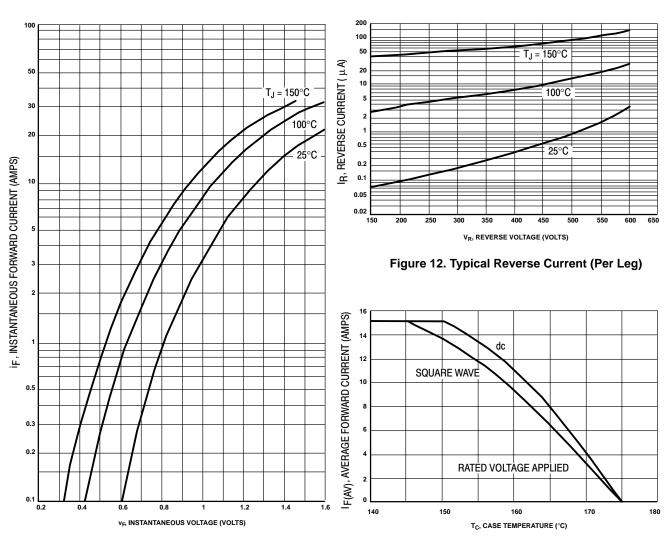


Figure 9. Current Derating, Ambient (Per Leg)

Figure 10. Power Dissipation (Per Leg)



**MUR3060PT** 

Figure 11. Typical Forward Voltage (Per Leg)

Figure 13. Current Derating, Case (Per Leg)

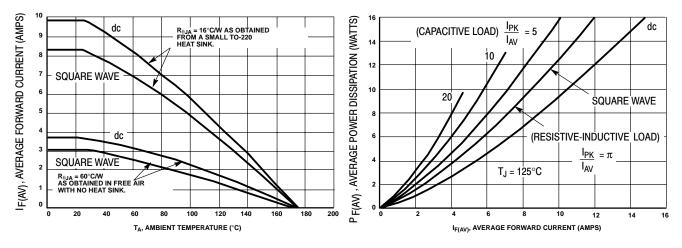
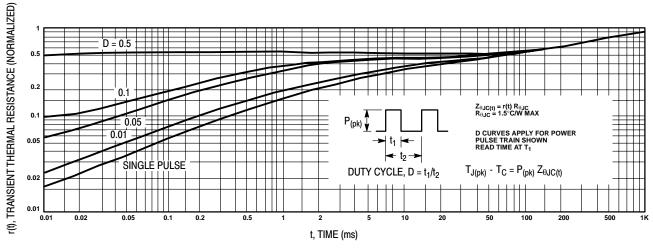
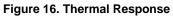


Figure 14. Current Derating, Ambient (Per Leg)







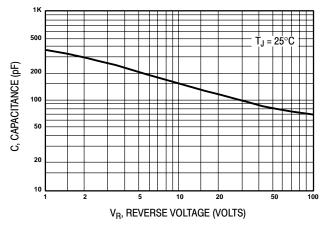


Figure 17. Typical Capacitance (Per Leg)

# MURP20020CT, MURP20040CT

Preferred Devices

# POWERTAP™ II Ultrafast SWITCHMODE™ Power Rectifiers

... designed for use in switching power supplies, inverters, and as free wheeling diodes. These state-of-the-art devices have the following features:

- Dual Diode Construction
- Low Leakage Current
- Low Forward Voltage
- 175°C Operating Junction Temperature
- Labor Saving POWERTAP Package

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded with metal heatsink base
- Weight: 80 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant
- Top Terminal Torque: 25-40 lb-in max
- Base Plate Torques: See procedure given in the Package Outline Section
- Shipped 25 units per foam
- Marking: UP20020, UP20040

#### MAXIMUM RATINGS

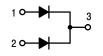
Please See the Table on the Following Page

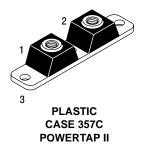


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ULTRAFAST RECTIFIERS 200 AMPERES 200-400 VOLTS





#### MARKING DIAGRAM



UP200x0 = Device Code x = 2 or 4 YY = Year WW = Work Week

#### **ORDERING INFORMATION**

Device	Package	Shipping
MURP20020CT	POWERTAP II	25 Units/Tray
MURP20040CT	POWERTAP II	25 Units/Tray

# MURP20020CT, MURP20040CT

### MAXIMUM RATINGS

Rating	Symbol	MURP20020CT	MURP20040CT	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	400	Volts
Average Rectified Forward Current (Rated V <sub>R</sub> )     Per Device       Per Leg	I <sub>F(AV)</sub>	200 (T <sub>C</sub> = 130°C) 100 (T <sub>C</sub> = 130°C)	200 (T <sub>C</sub> = 100°C) 100 (T <sub>C</sub> = 100°C)	Amps
Peak Repetitive Forward Current, Per Leg (Rated $V_R$ , Square Wave, 20 kHz), T <sub>C</sub> = 95°C	I <sub>FRM</sub>	200	200	Amps
Nonrepetitive Peak Surge Current Per Leg (Surge applied at rated load conditions halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	800	800	Amps
Operating Junction Temperature	TJ	- 55 to +175	- 55 to +175	°C
Storage Temperature	T <sub>stg</sub>	- 55 to +150	- 55 to +150	°C
THERMAL CHARACTERISTICS (Per Leg)				
Rating	Symbol	Мах		Unit
Thermal Resistance, Junction to Case	R <sub>θJC</sub>	0.45	0.45	°C/W
ELECTRICAL CHARACTERISTICS (Per Leg)				
Instantaneous Forward Voltage (Note 1.) ( $i_F = 100 \text{ Amps}, T_C = +25^{\circ}C$ ) ( $i_F = 200 \text{ Amps}, T_C = 25^{\circ}C$ ) ( $i_F = 100 \text{ Amps}, T_C = 125^{\circ}C$ )	v <sub>F</sub>	1.00 1.10 0.95	1.30 1.75 1.15	Volts
Instantaneous Reverse Current (Note 1.) (Rated dc Voltage, $T_C = 125$ °C) (Rated dc Voltage, $T_C = 25$ °C)	i <sub>R</sub>	1000 150	500 50	μΑ
Maximum Reverse Recovery Time (I <sub>F</sub> = 1.0 Amp, di/dt = 50 Amps/µs)	t <sub>rr</sub>	50	75	ns

1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.

# CHAPTER 5 Standard and Fast Recovery Data Sheets

## Surface Mount Standard Recovery Power Rectifier

## SMB Power Surface Mount Package

Features mesa epitaxial construction with glass passivation. Ideally suited for high frequency switching power supplies; free wheeling diodes and polarity protection diodes.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Stable, High Temperature, Glass Passivated Junction

#### Mechanical Characteristics:

- Case: Molded Epoxy
- Epoxy Meets UL94, VO at 1/8"
- Weight: 95 mg (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Maximum Temperature of 260°C / 10 Seconds for Soldering
- Available in 12 mm Tape, 2500 Units per 13 inch Reel, Add "T3" Suffix to Part Number
- Polarity: Notch and/or band in Plastic Body Indicates Cathode Lead
- Marking: RGG

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	400	V
Average Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>I</sub> = 118°C)	Ι <sub>Ο</sub>	1.5	A
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>I</sub> = 118°C)	I <sub>FRM</sub>	3.0	A
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	50	A
Storage/Operating Case Temperature Range	T <sub>stg</sub> , T <sub>C</sub>	-55 to 150	°C
Operating Junction Temperature Range	TJ	-55 to 150	°C



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#### STANDARD RECOVERY RECTIFIER 1.5 AMPERES 400 VOLTS



SMB CASE 403A PLASTIC

#### MARKING DIAGRAM



Y = Year WW = Work Week RGG = Device Code LL = Location Code

#### ORDERING INFORMATION

Device	Package	Shipping
MRS1504T3	SMB	2500/Tape & Reel

#### THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal Resistance - Junction-to-Lead (Note 2.)	R <sub>tjl</sub>	18	°C/W
Thermal Resistance - Junction-to-Ambient (on 1" sq. Cu. PCB pattern)	R <sub>tja</sub>	79	

#### ELECTRICAL CHARACTERISTICS

Maximum Instantaneous Forward Voltage (Note 1.), see Figure 2	VF	T <sub>J</sub> = 25°C	$T_J = 100^{\circ}C$	V
(I <sub>F</sub> = 1.5 A) (I <sub>F</sub> = 2.25 A)		1.04 1.10	0.96 1.02	
Maximum Instantaneous Reverse Current, see Figure 4	Ι <sub>R</sub>	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	μΑ
(V <sub>R</sub> = 400 V) (V <sub>R</sub> = 200 V)		1.0 0.5	340 180	

1. Pulse Test: Pulse Width  $\leq$  250 µs, Duty Cycle  $\leq$  2.0%.

2. Minimum pad size

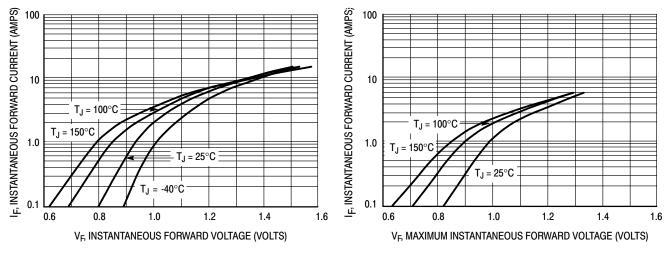


Figure 1. Typical Forward Voltage

Figure 2. Maximum Forward Voltage

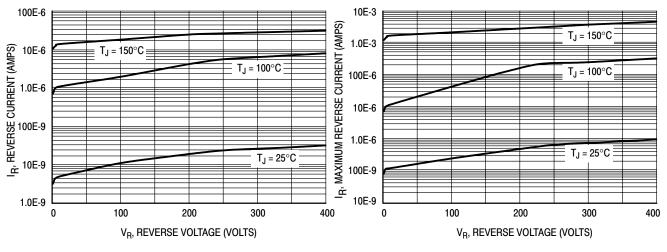




Figure 4. Maximum Reverse Current

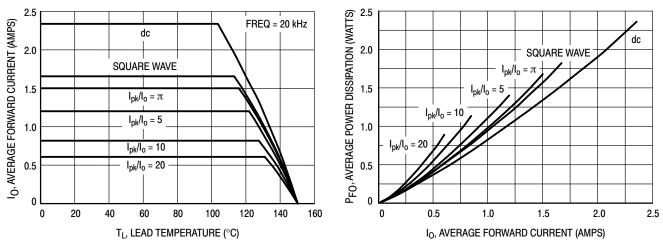
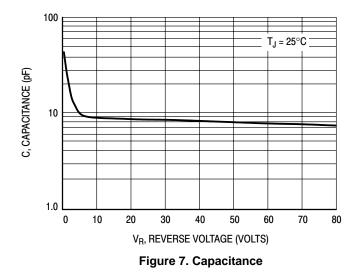
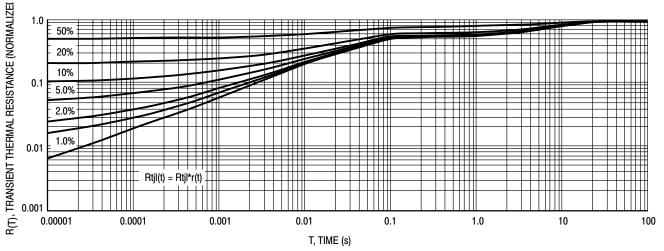




Figure 6. Forward Power Dissipation







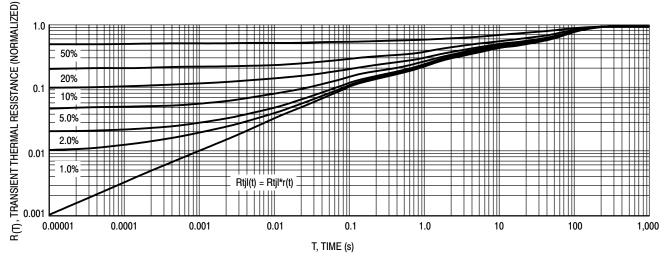


Figure 9. Thermal Response Junction to Ambient

# **MRA4003T3 Series**

## Surface Mount Standard Recovery Power Rectifier

## **SMA Power Surface Mount Package**

Features construction with glass passivation. Ideally suited for surface mounted Automotive application.

- Compact Package with J-Bend Leads Ideal for Automated Handling
- Stable, High Temperature, Glass Passivated Junction

#### **Mechanical Characteristics**

- Case: Molded Epoxy Epoxy meets UL94, VO at 1/8"
- Weight: 70 mg (Approximately)
- Finish: All External Surfaces are Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 260°C Max. for 10 seconds in Solder Bath
- Polarity: Notch and/or Band in Plastic Body Indicates Cathode Lead
- Available in 12 mm Tape, 5000 Units per 13 inch Reel, Add "T3" Suffix to Part Number
- Marking: MRA4003T3 R13
  - MRA4004T3 R14 MRA4005T3 — R15 MRA4006T3 — R16 MRA4007T3 — R17

#### MAXIMUM RATINGS

Please See the Table on the Following Page



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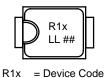
http://onsemi.com

#### STANDARD RECOVERY RECTIFIERS 1.0 AMPERES 300-1000 VOLTS



CASE 403B SMA PLASTIC

#### MARKING DIAGRAM



x = 3, 4, 5, 6 or 7

- LL = Location Code
- ## = Date Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
MRA4003T3	SMA	5000/Tape & Reel
MRA4004T3	SMA	5000/Tape & Reel
MRA4005T3	SMA	5000/Tape & Reel
MRA4006T3	SMA	5000/Tape & Reel
MRA4007T3	SMA	5000/Tape & Reel

### MRA4003T3 Series

#### MAXIMUM RATINGS

				Value			
Rating	Symbol	MRA4003T3	MRA4004T3	MRA4005T3	MRA4006T3	MRA4007T3	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	300	400	600	800	1000	Volts
Avg. Rectified Forward Current (At Rated V <sub>R</sub> , T <sub>L</sub> = 150°C)	Ι <sub>Ο</sub>	1					Amp
Peak Repetitive Forward Current (At Rated V <sub>R</sub> , Square Wave, 20 kHz, T <sub>L</sub> = 150°C)	I <sub>FRM</sub>	2				Amps	
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	30				Amps	
Storage/Operating Case Temperature	T <sub>stg</sub> , T <sub>C</sub>	-55 to 150				°C	
Operating Junction Temperature	TJ			-55 to 175			°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Lead (Note 1.)	$R_{\theta JL}$	16.2	°C/W
Thermal Resistance, Junction to Ambient (Note 2.)	$R_{\theta JA}$	88.3	

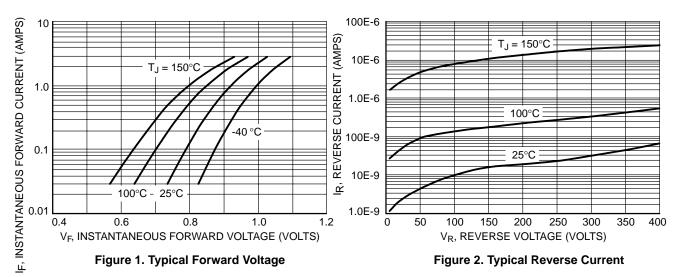
#### ELECTRICAL CHARACTERISTICS

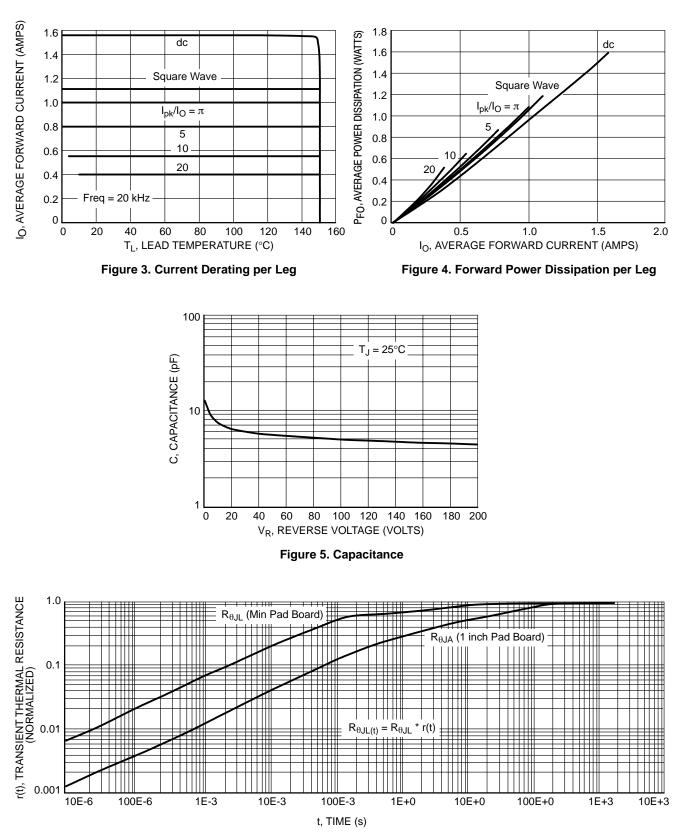
		Va	lue	
Characteristic	Symbol	T <sub>J</sub> = 25°C	T <sub>J</sub> = 100°C	Unit
Maximum Instantaneous Forward Voltage (Note 3.) (I <sub>F</sub> = 1 A) (I <sub>F</sub> = 2 A)	V <sub>F</sub>	1.1 1.18	1.04 1.12	Volts
Maximum Instantaneous Reverse Current (at rated DC voltage)	I <sub>R</sub>	10	50	μΑ

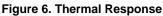
1. Minimum Pad Size

2. 1 inch Pad Size

3. Pulse Test: Pulse Width  $\leq 250~\mu s,$  Duty Cycle  $\leq 2\%.$ 







## 1N4001, 1N4002, 1N4003, 1N4004, 1N4005, 1N4006, 1N4007

1N4004 and 1N4007 are Preferred Devices

## **Axial Lead Standard Recovery Rectifiers**

This data sheet provides information on subminiature size, axial lead mounted rectifiers for general-purpose low-power applications.

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Available in Fan-Fold Packaging, 3000 per box, by adding a "FF" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N4001, 1N4002, 1N4003, 1N4004, 1N4005, 1N4006, 1N4007



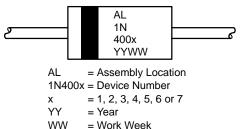
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## LEAD MOUNTED RECTIFIERS 50-1000 VOLTS DIFFUSED JUNCTION



#### MARKING DIAGRAM



#### MAXIMUM RATINGS

Rating	Symbol	1N4001	1N4002	1N4003	1N4004	1N4005	1N4006	1N4007	Unit
*Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	800	1000	Volts
*Non-Repetitive Peak Reverse Voltage (halfwave, single phase, 60 Hz)	V <sub>RSM</sub>	60	120	240	480	720	1000	1200	Volts
*RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	Volts
*Average Rectified Forward Current (single phase, resistive load, 60 Hz, T <sub>A</sub> = 75°C)	IO	1.0					Amp		
*Non-Repetitive Peak Surge Current (surge applied at rated load conditions)	I <sub>FSM</sub>	30 (for 1 cycle)				Amp			
Operating and Storage Junction Temperature Range	T <sub>J</sub> T <sub>stg</sub>	5				°C			

\*Indicates JEDEC Registered Data

#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 513 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

## 1N4001, 1N4002, 1N4003, 1N4004, 1N4005, 1N4006, 1N4007

#### ELECTRICAL CHARACTERISTICS\*

Rating	Symbol	Тур	Max	Unit
Maximum Instantaneous Forward Voltage Drop ( $i_F = 1.0 \text{ Amp}, T_J = 25^{\circ}\text{C}$ )	۷ <sub>F</sub>	0.93	1.1	Volts
Maximum Full-Cycle Average Forward Voltage Drop $(I_O = 1.0 \text{ Amp}, T_L = 75^{\circ}\text{C}, 1 \text{ inch leads})$	V <sub>F(AV)</sub>	-	0.8	Volts
Maximum Reverse Current (rated dc voltage) $(T_J = 25^{\circ}C)$ $(T_J = 100^{\circ}C)$	۱ <sub>R</sub>	0.05 1.0	10 50	μΑ
Maximum Full-Cycle Average Reverse Current $(I_O = 1.0 \text{ Amp}, T_L = 75^{\circ}C, 1 \text{ inch leads})$	I <sub>R(AV)</sub>	-	30	μΑ

\*Indicates JEDEC Registered Data

#### **ORDERING & SHIPPING INFORMATION**

Device	Package	Shipping
1N4001	Axial Lead	1000 Units/Bag
1N4001FF	Axial Lead	3000 Units/Box
1N4001RL	Axial Lead	5000/Tape & Reel
1N4002	Axial Lead	1000 Units/Bag
1N4002FF	Axial Lead	3000 Units/Box
1N4002RL	Axial Lead	5000/Tape & Reel
1N4003	Axial Lead	1000 Units/Bag
1N4003FF	Axial Lead	3000 Units/Box
1N4003RL	Axial Lead	5000/Tape & Reel
1N4004	Axial Lead	1000 Units/Bag
1N4004FF	Axial Lead	3000 Units/Box
1N4004RL	Axial Lead	5000/Tape & Reel
1N4005	Axial Lead	1000 Units/Bag
1N4005FF	Axial Lead	3000 Units/Box
1N4005RL	Axial Lead	5000/Tape & Reel
1N4006	Axial Lead	1000 Units/Bag
1N4006FF	Axial Lead	3000 Units/Box
1N4006RL	Axial Lead	5000/Tape & Reel
1N4007	Axial Lead	1000 Units/Bag
1N4007FF	Axial Lead	3000 Units/Box
1N4007RL	Axial Lead	5000/Tape & Reel

## 1N4933, 1N4934, 1N4935, 1N4936, 1N4937

1N4935 and 1N4937 are Preferred Devices

## **Axial-Lead Fast-Recovery Rectifiers**

Axial-lead, fast-recovery rectifiers are designed for special applications such as dc power supplies, inverters, converters, ultrasonic systems, choppers, low RF interference and free wheeling diodes. A complete line of fast recovery rectifiers having typical recovery time of 150 nanoseconds providing high efficiency at frequencies to 250 kHz.

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 0.4 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 1000 per bag.
- Available Tape and Reeled, 5000 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N4933, 1N4934, 1N4935, 1N4936, 1N4937

#### MAXIMUM RATINGS

Please See the Table on the Following Page



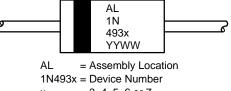
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FAST RECOVERY RECTIFIERS 1.0 AMPERE 50-600 VOLTS



#### MARKING DIAGRAM



x = 3, 4, 5, 6 or 7 YY = Year

#### WW = Work Week

#### **ORDERING INFORMATION**

Device	Package	Shipping
1N4933	Axial Lead	1000 Units/Bag
1N4933RL	Axial Lead	5000/Tape & Reel
1N4934	Axial Lead	1000 Units/Bag
1N4934RL	Axial Lead	5000/Tape & Reel
1N4935	Axial Lead	1000 Units/Bag
1N4935RL	Axial Lead	5000/Tape & Reel
1N4936	Axial Lead	1000 Units/Bag
1N4936RL	Axial Lead	5000/Tape & Reel
1N4937	Axial Lead	1000 Units/Bag
1N4937RL	Axial Lead	5000/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

## 1N4933, 1N4934, 1N4935, 1N4936, 1N4937

#### MAXIMUM RATINGS (Note 1.)

Rating	Symbol	1N4933	1N4934	1N4935	1N4936	1N4937	Unit
*Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	Volts
*Non-Repetitive Peak Reverse Voltage RMS Reverse Voltage	V <sub>RSM</sub> V <sub>R(RMS)</sub>	75 35	150 70	250 140	450 280	650 420	Volts
*Average Rectified Forward Current (Single phase, resistive load, $T_A = 75^{\circ}C$ ) (Note 2.)	Ι <sub>Ο</sub>	1.0					Amp
*Non-Repetitive Peak Surge Current (Surge applied at rated load conditions)	I <sub>FSM</sub>	30					Amps
Operating Junction Temperature Range Storage Temperature Range	T <sub>J</sub> T <sub>stg</sub>			65 to +150 65 to +150	-		°C

#### THERMAL CHARACTERISTICS

Characteristic		Max	Unit
Thermal Resistance, Junction to Ambient (Typical Printed Circuit Board Mounting)	$R_{\theta JC}$	65	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Characteristic		Min	Тур	Max	Unit
Instantaneous Forward Voltage ( $I_F = 3.14 \text{ Amp}, T_J = 125^{\circ}\text{C}$ )	۷F	-	1.0	1.2	Volts
Forward Voltage ( $I_F = 1.0 \text{ Amp}, T_A = 25^{\circ}\text{C}$ )	V <sub>F</sub>	-	1.0	1.1	Volts
*Reverse Current (Rated dc Voltage) $T_A = 25^{\circ}C$ $T_A = 100^{\circ}C$	۱ <sub>R</sub>	-	1.0 50	5.0 100	μA

#### **\*REVERSE RECOVERY CHARACTERISTICS**

Characteristic	Symbol	Min	Тур	Мах	Unit
Reverse Recovery Time ( $I_F = 1.0 \text{ Amp to } V_R = 30 \text{ Vdc}$ ) ( $I_{FM} = 15 \text{ Amp, di/dt} = 10 \text{ A/}\mu\text{s}$ )	t <sub>rr</sub>	-	150 175	200 300	ns
Reverse Recovery Current ( $I_F = 1.0 \text{ Amp to } V_R = 30 \text{ Vdc}$ )	I <sub>RM(REC)</sub>	-	1.0	2.0	Amp

Ratings at 25°C ambient temperature unless otherwise specified.
 Derate by 20% for capacitive loads.
 \*Indicates JEDEC Registered Data for 1N4933 Series.

# 1N5400 thru 1N5408

1N5404 and 1N5406 are Preferred Devices

## Axial-Lead Standard Recovery Rectifiers

Lead mounted standard recovery rectifiers are designed for use in power supplies and other applications having need of a device with the following features:

- High Current to Small Size
- High Surge Current Capability
- Low Forward Voltage Drop
- Void-Free Economical Plastic Package
- Available in Volume Quantities
- Plastic Meets UL 94V-0 for Flammability

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Polarity: Cathode Indicated by Polarity Band
- Marking: 1N5400, 1N5401, 1N5402, 1N5404, 1N5406, 1N5407, 1N5408

#### MAXIMUM RATINGS

Please See the Table on the Following Page



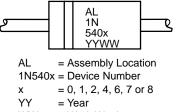
## **ON Semiconductor**<sup>™</sup>

http://onsemi.com

STANDARD RECOVERY RECTIFIERS 50-1000 VOLTS 3.0 AMPERES

AXIAL LEAD CASE 267-05 STYLE 1

#### MARKING DIAGRAM



WW = Work Week

#### **ORDERING INFORMATION**

Device	Package	Shipping
1N5400	Axial Lead	500 Units/Box
1N5400RL	Axial Lead	1200/Tape & Reel
1N5401	Axial Lead	500 Units/Box
1N5401RL	Axial Lead	1200/Tape & Reel
1N5402	Axial Lead	500 Units/Box
1N5402RL	Axial Lead	1200/Tape & Reel
1N5404	Axial Lead	500 Units/Box
1N5404RL	Axial Lead	1200/Tape & Reel
1N5406	Axial Lead	500 Units/Box
1N5406RL	Axial Lead	1200/Tape & Reel
1N5407	Axial Lead	500 Units/Box
1N5407RL	Axial Lead	1200/Tape & Reel
1N5408	Axial Lead	500 Units/Box
1N5408RL	Axial Lead	1200/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

### 1N5400 thru 1N5408

#### MAXIMUM RATINGS

Rating	Symbol	1N5400	1N5401	1N5402	1N5404	1N5406	1N5407	1N5408	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	800	1000	Volts
Non-repetitive Peak Reverse Voltage	V <sub>RSM</sub>	100	200	300	525	800	1000	1200	Volts
Average Rectified Forward Current (Single Phase Resistive Load, $1/2''$ Leads, $T_L = 105^{\circ}C$ )	IO	3.0							Amp
Non-repetitive Peak Surge Current (Surge Applied at Rated Load Conditions)	I <sub>FSM</sub>	200 (one cycle)							Amp
Operating and Storage Junction Temperature Range	T <sub>J</sub> T <sub>stg</sub>	- 65 to +170 - 65 to +175							°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Тур	Unit
Thermal Resistance, Junction to Ambient (PC Board Mount, 1/2" Leads)	$R_{\thetaJA}$	53	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Min	Тур	Max	Unit
Forward Voltage (I <sub>F</sub> = 3.0 Amp, $T_A = 25^{\circ}C$ )	٧ <sub>F</sub>	-	-	1.0	Volts
Reverse Current (Rated dc Voltage) $T_A = 25^{\circ}C$ $T_A = 150^{\circ}C$	I <sub>R</sub>	-	-	10 100	μΑ

Ratings at 25°C ambient temperature unless otherwise specified.

60 Hz resistive or inductive loads.

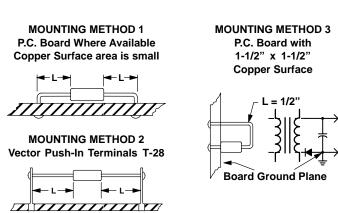
For capacitive load, derate current by 20%.

#### NOTE 1 — AMBIENT MOUNTING DATA

Data shown for thermal resistance junction-to-ambient ( $R_{\theta JA}$ ) for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

Mounting		Lead Length, L (IN)					
Method	1/8	1/4	1/2	3/4	R <sub>θJA</sub>		
1	50	51	53	55	°C/W		
2	58	59	61	63	°C/W		
3		°C/W					

TYPICAL VALUES FOR ROLA IN STILL AIR



### 1N5400 thru 1N5408

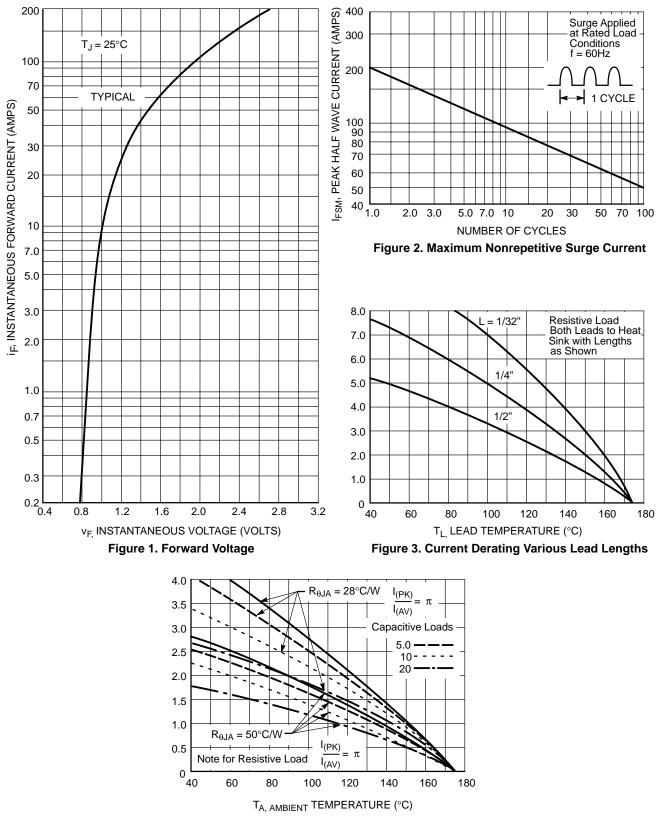


Figure 4. Current Derating PC Board Mounting

## MR850, MR851, MR852, MR854, MR856

MR852 and MR856 are Preferred Devices

## Axial Lead Fast Recovery Rectifiers

Axial lead mounted fast recovery power rectifiers are designed for special applications such as dc power supplies, inverters, converters, ultrasonic systems, choppers, low RF interference and free wheeling diodes. A complete line of fast recovery rectifiers having typical recovery time of 100 nanoseconds providing high efficiency at frequencies to 250 kHz.

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 1.1 gram (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead and Mounting Surface Temperature for Soldering Purposes: 220°C Max. for 10 Seconds, 1/16″ from case
- Shipped in plastic bags, 500 per box
- Available Tape and Reeled, 1200 per reel, by adding a "RL" suffix to the part number
- Polarity: Cathode Indicated by Polarity Band
- Marking: MR850, MR851, MR852, MR854, MR856

#### MAXIMUM RATINGS

Please See the Table on the Following Page



### **ON Semiconductor**<sup>™</sup>

http://onsemi.com

FAST RECOVERY POWER RECTIFIERS 3.0 AMPERES 50-600 VOLTS



CASE 267-05 STYLE 1

#### MARKING DIAGRAM



AL = Assembly Location MR85x = Device Number x = 0, 1, 2, 4 or 6YY = Year WW = Work Week

#### **ORDERING INFORMATION**

Device	Package	Shipping							
MR850	Axial Lead	500 Units/Box							
MR850RL	Axial Lead	1200/Tape & Reel							
MR851	Axial Lead	500 Units/Box							
MR851RL	Axial Lead	1200/Tape & Reel							
MR852	Axial Lead	500 Units/Box							
MR852RL	Axial Lead	1200/Tape & Reel							
MR854	Axial Lead	500 Units/Box							
MR854RL	Axial Lead	1200/Tape & Reel							
MR856	Axial Lead	500 Units/Box							
MR856RL	Axial Lead	1200/Tape & Reel							

**Preferred** devices are recommended choices for future use and best overall value.

## MR850, MR851, MR852, MR854, MR856

#### MAXIMUM RATINGS

Rating	Symbol	MR850	MR851	MR852	MR854	MR856	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	Volts
Non-Repetitive Peak Reverse Voltage	V <sub>RSM</sub>	75	150	250	450	650	Volts
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	Volts
Average Rectified Forward Current (Single phase resistive load, T <sub>A</sub> = 80°C)	Ι <sub>Ο</sub>			Amp			
Non-Repetitive Peak Surge Current (surge applied at rated load conditions)	I <sub>FSM</sub>		Amp				
Operating and Storage Junction Temperature Range	Т <sub>Ј</sub> , T <sub>stg</sub>			<ul> <li>65 to +125</li> <li>65 to +150</li> </ul>	-		°C

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient (Recommended Printed Circuit Board Mounting)	$R_{\theta J A}$	28	°C/W

#### ELECTRICAL CHARACTERISTICS

Characteristic		Symbol	Min	Тур	Max	Unit
Forward Voltage (I <sub>F</sub> = 3.0 Amp, T <sub>J</sub> = 25°C)		V <sub>F</sub>	-	1.04	1.25	Volts
$\begin{tabular}{ c c c c } \hline Reverse Current (rated dc voltage) $T_J = 25^\circ$ \\ \hline MR850$ \\ MR851$ \\ MR851$ \\ MR852$ \\ MR854$ \\ MR856$ \\ \hline \ MR856$ \\ \hline \ MR856$ \\ \hline \ MR856$ \\ \hline \ MR856$ \\ \hline \ MR856$ \\ \hline \ MR856$ \\ \hline \ MR856$ \\ \hline \hline \ MR856$ \\ \hline \hline \ MR856$ \\ \hline \hline \ MR856$ \\ \hline \hline \ MR856$ \\ \hline \hline \ MR856$ \\ \hline \hline \ \ MR856$ \\ \hline \hline \ \ \ MR856$ \\ \hline \hline \hline \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$		I <sub>R</sub>		2.0 - 60 - - 100	10 150 150 200 250 300	μΑ

#### **REVERSE RECOVERY CHARACTERISTICS**

Characteristic	Symbol	Min	Тур	Мах	Unit
Reverse Recovery Time ( $I_F = 1.0 \text{ Amp to } V_R = 30 \text{ Vdc}$ ) ( $I_F = 15 \text{ Amp, di/dt} = 10 \text{ A/}\mu\text{s}$ )	t <sub>rr</sub>	-	100 150	200 300	ns
Reverse Recovery Current ( $I_F = 1.0 \text{ Amp to } V_R = 30 \text{ Vdc}$ )	I <sub>RM(REC)</sub>	-	-	2.0	Amp

MR754 and MR760 are Preferred Devices

## **High Current Lead Mounted Rectifiers**

- Current Capacity Comparable to Chassis Mounted Rectifiers
- Very High Surge Capacity
- Insulated Case

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 2.5 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Lead is Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Polarity: Cathode Polarity Band
- Shipped 1000 units per plastic bag. Available Tape and Reeled, 800 units per reel by adding a "RL" suffix to the part number

#### MAXIMUM RATINGS

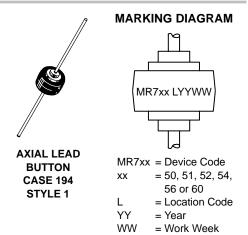
Please See the Table on the Following Page



## **ON Semiconductor**<sup>™</sup>

http://onsemi.com

### HIGH CURRENT LEAD MOUNTED SILICON RECTIFIERS 50 - 1000 VOLTS DIFFUSED JUNCTION



## ORDERING INFORMATION

Device	Package	Shipping
MR750	Axial Lead	1000 Units/Bag
MR750RL	Axial Lead	800/Tape & Reel
MR751	Axial Lead	1000 Units/Bag
MR751RL	Axial Lead	800/Tape & Reel
MR752	Axial Lead	1000 Units/Bag
MR752RL	Axial Lead	800/Tape & Reel
MR754	Axial Lead	1000 Units/Bag
MR754RL	Axial Lead	800/Tape & Reel
MR756	Axial Lead	1000 Units/Bag
MR756RL	Axial Lead	800/Tape & Reel
MR760	Axial Lead	1000 Units/Bag
MR760RL	Axial Lead	800/Tape & Reel

**Preferred** devices are recommended choices for future use and best overall value.

#### MAXIMUM RATINGS

Characteristic	Symbol	MR750	MR751	MR752	MR754	MR756	MR760	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	1000	Volts
Non-Repetitive Peak Reverse Voltage (Halfwave, single phase, 60 Hz peak)	V <sub>RSM</sub>	60	120	240	480	720	1200	Volts
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	700	Volts
Average Rectified Forward Current (Single phase, resistive load, 60 Hz) See Figures 5 and 6	Ι <sub>Ο</sub>	$22 (T_L = 60^{\circ}C, 1/8'' \text{ Lead Lengths})$ 6.0 (T <sub>A</sub> = 60°C, P.C. Board mounting)					Amps	
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions)	I <sub>FSM</sub>	◄ 400 (for 1 cycle) →					Amps	
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	۲		<u> </u>	o +175 —			°C

### ELECTRICAL CHARACTERISTICS

Characteristic and Conditions	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage Drop $(i_F = 100 \text{ Amps}, T_J = 25^{\circ}\text{C})$	VF	1.25	Volts
Maximum Forward Voltage Drop ( $I_F = 6.0 \text{ Amps}, T_A = 25^{\circ}C, 3/8'' \text{ leads}$ )	V <sub>F</sub>	0.90	Volts
Maximum Reverse Current $T_J = 25^{\circ}C$ (Rated dc Voltage) $T_J = 100^{\circ}C$	۱ <sub>R</sub>	25 1.0	μA mA

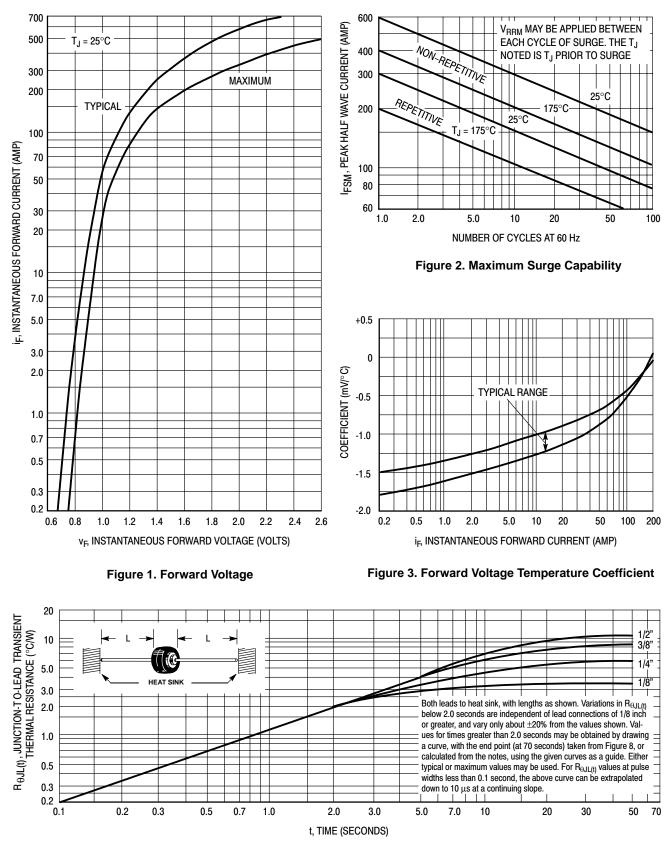
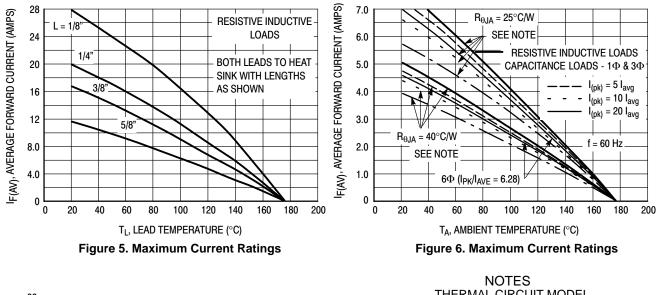
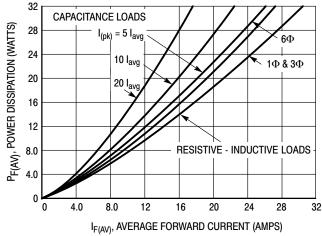


Figure 4. Typical Transient Thermal Resistance







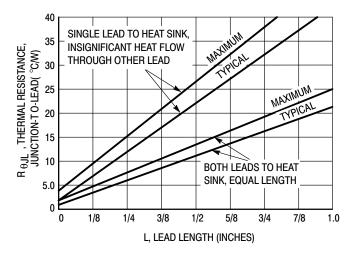
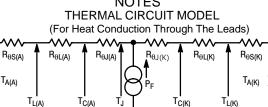


Figure 8. Steady State Thermal Resistance



Use of the above model permits junction to lead thermal resistance for any mounting configuration to be found. Lowest values occur when one side of the rectifier is brought as close as possible to the heat sink as shown below. Terms in the model signify T<sub>C</sub> = Case Temperature

T<sub>A</sub> = Ambient Temperature T<sub>L</sub> = Lead Temperature

 $T_J =$  Junction Temperature

 $\overline{R_{\theta S}}$  = Thermal Resistance, Heat Sink to Ambient

 $R_{\theta L}$  = Thermal Resistance, Lead to Heat Sink

 $R_{\theta,J}$  = Thermal Resistance, Junction to Case

 $P_F = Power Dissipation$ 

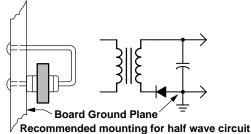
(Subscripts A and K refer to anode and cathode sides, respectively.) Values for thermal resistance components are:

 $R_{\theta L}$  = 40°C/W/in. Typically and 44°C/W/in Maximum.

 $R_{\theta,I} = 2^{\circ}C/W$  typically and  $4^{\circ}C/W$  Maximum.

Since  $R_{\theta J}$  is so low, measurements of the case temperature,  $T_C$ , will be approximately equal to junction temperature in practical lead mounted applications. When used as a 60 Hz rectifierm the slow thermal response holds T<sub>J</sub>(PK) close to T<sub>J</sub>(AVG). Therefore maximum lead temperature may be found from: T<sub>L</sub> = 175°-R<sub>0JL</sub> P<sub>F</sub>. P<sub>F</sub> may be found from Figure 7. The recommended method of mounting to a P.C. board is shown on the

sketch, where R<sub>0JA</sub> is approximately 25°C/W for a 1-1/2" x 1-1/2" copper surface area. Values of 40°C/W are typical for mounting to terminal strips or P.C. boards where available surface area is small.



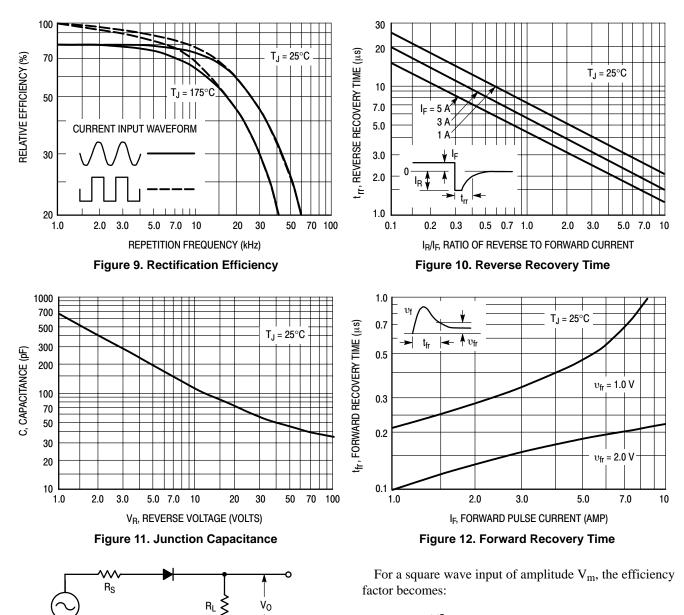


Figure 13. Single-Phase Half-Wave

Rectifier Circuit

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The rectification efficiency factor  $\sigma$  shown in Figure 9 was calculated using the formula:

$$\sigma = \frac{P_{(dc)}}{P_{(rms)}} = \frac{\frac{V_{2_0(dc)}}{R_L}}{\frac{V_{2_0(rms)}}{R_L}} \cdot 100\% = \frac{V_{2_0(dc)}}{V_{2_0(ac)}^2 + V_{2_0(dc)}^2} \cdot 100\%$$
(1)

For a sine wave input  $V_m \sin (wt)$  to the diode, assumed lossless, the maximum theoretical efficiency factor becomes:

$$\sigma_{\text{(sine)}} = \frac{\frac{V^2 m}{\pi^2 R_L}}{\frac{V^2 m}{4 R_1}} \cdot 100\% = \frac{4}{\pi^2} \cdot 100\% = 40.6\%$$
(2)

$$\sigma_{(\text{square})} = \frac{\frac{V^2 m}{^2 R_L}}{\frac{V^2 m}{R_L}} \cdot 100\% = 50\%$$
(3)

(A full wave circuit has twice these efficiencies)

As the frequency of the input signal is increased, the reverse recovery time of the diode (Figure 10) becomes significant, resulting in an increasing ac voltage component across  $R_L$  which is opposite in polarity to the forward current, thereby reducing the value of the efficiency factor  $\sigma$ , as shown on Figure 9.

It should be emphasized that Figure 9 shows waveform efficiency only; it does not provide a measure of diode losses. Data was obtained by measuring the ac component of  $V_o$  with a true rms ac voltmeter and the dc component with a dc voltmeter. The data was used in Equation 1 to obtain points for Figure 9.

MR2504 and MR2510 are Preferred Devices

## Medium-Current Silicon Rectifiers

. . . compact, highly efficient silicon rectifiers for medium-current applications requiring:

- High Current Surge 400 Amperes @  $T_J = 175^{\circ}C$
- Peak Performance @ Elevated Temperature 25 Amperes @  $T_C = 150^{\circ}C$
- Low Cost
- Compact, Molded Package For Optimum Efficiency in a Small Case Configuration

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 1.8 grams (approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminals are Readily Solderable
- Lead Temperature for Soldering Purposes: requires a custom temperature soldering profile
- Polarity: Cathode Polarity Band
- Shipped 5000 units per box

#### MAXIMUM RATINGS

Please See the Table on the Following Page



## ON Semiconductor\*\*

http://onsemi.com

#### MEDIUM-CURRENT SILICON RECTIFIERS 25 AMPERES 200-1000 VOLTS DIFFUSED JUNCTION



MICRODE BUTTON CASE 193

#### MARKING DIAGRAM



 $\begin{array}{rl} MR25xx = Device \ Code \\ xx &= 02, \ 04 \ or \ 10 \\ L &= Location \ Code \\ YY &= Year \end{array}$ 

WW = Work Week

#### **ORDERING INFORMATION**

Device	Package	Shipping
MR2502	Microde Button	5000 Units/Box
MR2504	Microde Button	5000 Units/Box
MR2510	Microde Button	5000 Units/Box

**Preferred** devices are recommended choices for future use and best overall value.

#### MAXIMUM RATINGS

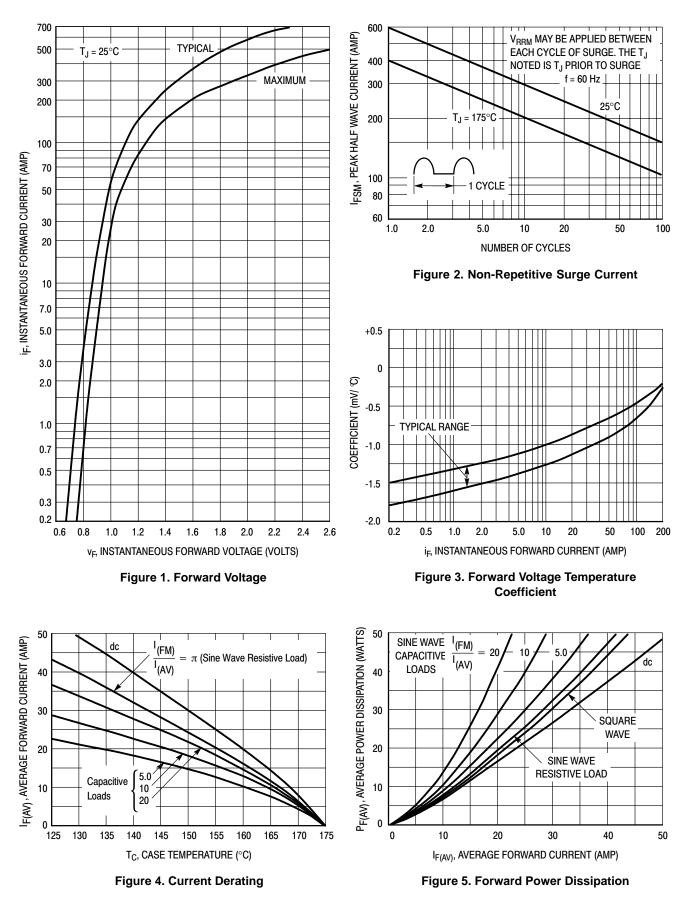
Characteristic	Symbol	MR2502	MR2504	MR2510	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	200	400	1000	Volts
Non-Repetitive Peak Reverse Voltage (Halfwave, single phase, 60 Hz peak)	V <sub>RSM</sub>	240	480	1200	Volts
Average Rectified Forward Current (Single phase, resistive load, 60 Hz, T <sub>C</sub> = 150°C)	Ι <sub>Ο</sub>	25			Amps
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	400 (for 1 cycle)			Amps
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +175			°C

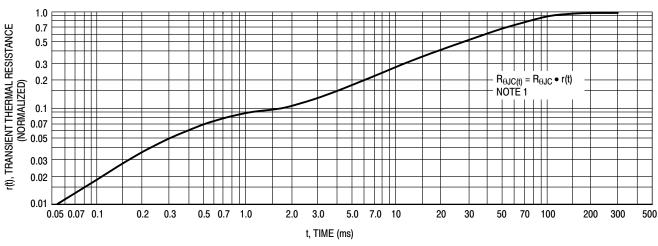
#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case (Single Side Cooled)	$R_{ extsf{ heta}JC}$	1.0	°C/W

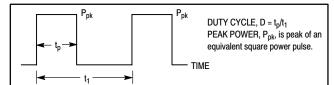
#### **ELECTRICAL CHARACTERISTICS**

Characteristics and Conditions	Symbol	Max	Unit
Maximum Instantaneous Forward Voltage (i <sub>F</sub> = 78.5 Amps, T <sub>C</sub> = 25°C)	۷F	1.18	Volts
Maximum Reverse Current (rated dc voltage) $T_C = 25^{\circ}C$ $T_C = 100^{\circ}C$	I <sub>R</sub>	100 500	μA









To determine maximum junction temperature of the diode in a given situation, the following procedure is recommended:

The temperature of the case should be measured using a thermocouple placed on the case at the temperature reference point (see the outline drawing on page 1). The thermal mass connected to the case is normally large enough so that it will not significantly respond to heat surges generated in the diode as a result of pulsed operation once steady-state conditions are achieved. Using the measured value of  $T_C$ , the junction temperature may be determined by:

#### $\mathsf{T}_\mathsf{J} = \mathsf{T}_\mathsf{C} + \Delta \, \mathsf{T}_\mathsf{J}_\mathsf{C}$

where  $\Delta\,T_{JC}$  is the increase in junction temperature above the case temperature, it may be determined by:

 $\begin{array}{l} \Delta \ T_{JC} = P_{pk} \cdot R_{\theta JC} \left[ D + (1 - D) \cdot r(t_1 + t_p) + r(t_p) - r(t_1) \right] \ \text{where} \\ r(t) = \text{normalized value of transient thermal resistance at time, } t, \\ \text{from Figure 6, i.e.:} \end{array}$ 

 $r~(t_1+t_p)$  = normalized value of transient thermal resistance at time  $t_1+t_p.$ 

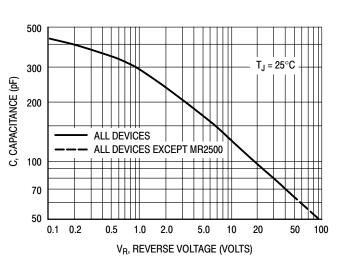
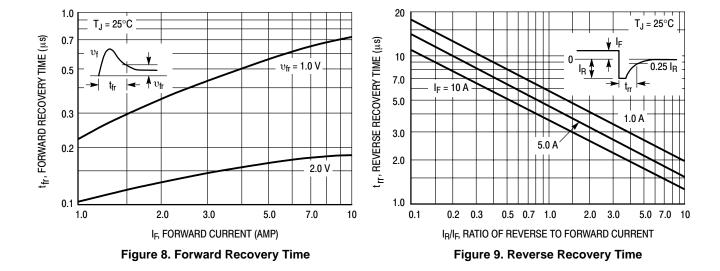


Figure 7. Capacitance



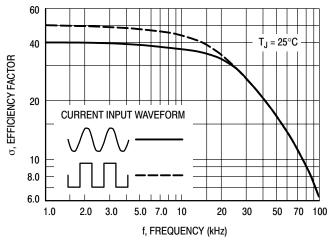


Figure 10. Rectification Waveform Efficiency

#### **RECTIFICATION EFFICIENCY NOTE**

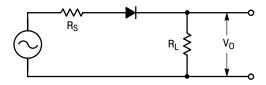


Figure 11. Single-Phase Half-Wave Rectifier Circuit

The rectification efficiency factor  $\sigma$  shown in Figure 10 was calculated using the formula:

$$\sigma = \frac{P_{(dc)}}{P_{(rms)}} = \frac{\frac{V_{20}^{2}(dc)}{R_{L}}}{\frac{V_{20}^{2}(rms)}{R_{L}}} \cdot 100\% = \frac{V_{20}^{2}(dc)}{V_{20}^{2}(ac) + V_{20}^{2}(dc)} \cdot 100\%$$
(1)

For a sine wave input  $V_m \sin(\omega t)$  to the diode, assume lossless, the maximum theoretical efficiency factor becomes:

$$\sigma_{\text{(sine)}} = \frac{\frac{V^2 m}{\pi^2 R_L}}{\frac{V^2 m}{4 R_L}} \cdot 100\% = \frac{4}{\pi^2} \cdot 100\% = 40.6\%$$
(2)

For a square wave input of amplitude  $V_m$ , the efficiency factor becomes:

$$\sigma_{\text{(square)}} = \frac{\frac{V^2 m}{^2 R_L}}{\frac{V^2 m}{R_L}} \cdot 100\% = 50\%$$
(3)

(A full wave circuit has twice these efficiencies)

As the frequency of the input signal is increased, the reverse recovery time of the diode (Figure 9) becomes significant, resulting in an increasing ac voltage component across  $R_L$  which is opposite in polarity to the forward current, thereby reducing the value of the efficiency factor  $\sigma$ , as shown on Figure 10.

It should be emphasized that Figure 10 shows waveform efficiency only; it does not provide a measure of diode losses. Data was obtained by measuring the ac component of  $V_O$  with a true rms ac voltmeter and the dc component with a dc voltmeter. The data was used in Equation 1 to obtain points for Figure 10.

#### ASSEMBLY AND SOLDERING INFORMATION

There are *two basic areas* of consideration for successful implementation of button rectifiers:

1. Mounting and Handling

2. Soldering

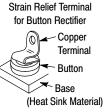
each should be carefully examined before attempting a finished assembly or mounting operation.

#### MOUNTING AND HANDLING

The button rectifier lends itself to a multitude of assembly arrangements but one key consideration must *always* be included:

# One Side of the Connections to the Button Must Be Flexible!

This stress relief to the button should also be chosen for maximum contact area to afford the best heat transfer but not at the expense of flexibility. For an annealed copper terminal a thickness of 0.015" is suggested.



The base heat sink may be of various materials whose shape and size are a function of the individual application and the heat transfer requirements.

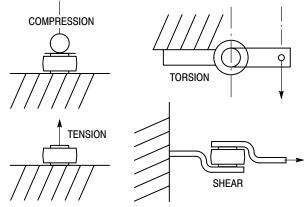
#### Common

Materials	Advantages and Disadvantages
Steel	Low Cost; relatively low heat conductivity
Copper	High Cost; high heat conductivity
Aluminum	Medium Cost; medium heat conductivity
	Relatively expensive to plate and not all
	platers can process aluminum.

Handling of the button during assembly must be relatively gentle to minimize sharp impact shocks and avoid nicking of the plastic. Improperly designed automatic handling equipment is the worst source of unnecessary shocks. Techniques for vacuum handling and spring loading should be investigated.

The mechanical stress limits for the button diode are as follows:

Compression	32 lbs.	142.3 Newton
Tension	32 lbs.	142.3 Newton
Torsion	6-inch lbs.	0.68 Newton-meters
Shear	55 lbs.	244.7 Newton



**MECHANICAL STRESS** 

Exceeding these recommended maximums can result in electrical degradation of the device.

#### SOLDERING

The button rectifier is basically a semiconductor chip bonded between two nickel- plated copper heat sinks with an encapsulating material of thermal- setting silicone. The exposed metal areas are also tin plated to enhance solderability.

In the soldering process it is important that the temperature not exceed 250°C if device damage is to be avoided. Various solder alloys can be used for this operation but two types are recommended for best results:

- 1. 95% Sn, 5% Sb; melting point 237°C
- 2. 96.5% tin, 3.5% silver; melting point 221°C
- 3. 63% tin, 37% lead; melting point 183°C

Solder is available as preforms or paste. The paste contains both the metal and flux and can be dispensed rapidly. The solder preform requires the application of a flux to assure good wetting of the solder. The type of flux used depends upon the degree of cleaning to be accomplished and is a function of the metals involved. These fluxes range from a mild rosin to a strong acid; e.g., Nickel plating oxides are best removed by an acid base flux while an activated rosin flux may be sufficient for tin plated parts.

Since the button is relatively light-weight, there is a tendency for it to float when the solder becomes liquid. To prevent bad joints and misalignment it is suggested that a weighting or spring loaded fixture be employed. It is also important that severe thermal shock (either heating or cooling) be avoided as it may lead to damage of the die or encapsulant of the part.

Button holding fixtures for use during soldering may be of various materials. Stainless steel has a longer use life while black anodized aluminum is less expensive and will limit heat reflection and enhance absorption. The assembly volume will influence the choice of materials. Fixture dimension tolerances for locating the button must allow for expansion during soldering as well as allowing for button clearance.

#### HEATING TECHNIQUES

The following four heating methods have their advantages and disadvantages depending on volume of buttons to be soldered.

- 1. **Belt Furnaces** readily handle large or small volumes and are adaptable to establishment of "on-line" assembly since a variable belt speed sets the run rate. Individual furnace zone controls make excellent temperature control possible.
- 2. **Flame Soldering** involves the directing of natural gas flame jets at the base of a heatsink as the heatsink is indexed to various loading- heating- cooling- unloading positions. This is the most economical labor method of soldering large volumes. Flame soldering offers good temperature control but requires sophisticated temperature monitoring systems such as infrared.

#### ASSEMBLY AND SOLDERING INFORMATION (continued)

- 3. **Ovens** are good for batch soldering and are production limited. There are handling problems because of slow cooling. Response time is load dependent, being a function of the watt rating of the oven and the mass of parts. Large ovens may not give an acceptable temperature gradient. Capital cost is low compared to belt furnaces and flame soldering.
- 4. **Hot Plates** are good for soldering small quantities of prototype devices. Temperature control is fair with overshoot common because of the exposed heating surface. Solder flow and positioning can be corrected during soldering since the assembly is exposed. Investment cost is very low.

Regardless of the heating method used, a soldering profile giving the time-temperature relationship of the particular method must be determined to assure proper soldering. Profiling must be performed on a scheduled basis to minimize poor soldering. The time-temperature relationship will change depending on the heating method used.

#### SOLDER PROCESS EVALUATION

Characteristics to look for when setting up the soldering process:

- **I Overtemperature** is indicated by any one or all three of the following observations.
  - 1. Remelting of the solder inside the button rectifier shows the temperature has exceeded 285°C and is noted by "islands" of shiny solder and solder dewetting when a unit is broken apart.
  - 2. Cracked die inside the button may be observed by a moving reverse oscilloscope trace when pressure is applied to the unit.
  - 3. Cracked plastic may be caused by thermal shock as well as overtemperature so cooling rate should also be checked.
- **II Cold soldering** gives a grainy appearance and solder build-up without a smooth continuous solder fillet. The temperature must be adjusted until the proper solder fillet is obtained within the maximum temperature limits.
- **III Incomplete solder fillets** result from insufficient solder or parts not making proper contact.
- **IV Tilted buttons** can cause a void in the solder between the heatsink and button rectifier which will result in poor heat transfer during operation. An eight degree tilt is a suggested maximum value.
- **V Plating problems** require a knowledge of plating operations for complete understanding of observed deficiencies.

- 1. Peeling or plating separation is generally seen when a button is broken away for solder inspection. If heatsink or terminal base metal is present the plating is poor and must be corrected.
- 2. Thin plating allows the solder to penetrate through to the base metal and can give a poor connection. A suggested minimum plating thickness is 300 microinches.
- 3. Contaminated soldering surfaces may out-gas and cause non-wetting resulting in voids in the solder connection. The exact cause is not always readily apparent and can be because of:
  - (a) improper plating
  - (b) mishandling of parts
  - (c) improper and/or excessive storage time

#### SOLDER PROCESS MONITORING

Continuous monitoring of the soldering process must be established to minimize potential problems. All parts used in the soldering operation should be sampled on a lot by lot basis by assembly of a controlled sample. Evaluate the control sample by break-apart tests to view the solder connections, by physical strength tests and by dimensional characteristics for part mating.

A shear test is a suggested way of testing the solder bond strength.

#### POST SOLDERING OPERATION CONSIDERATIONS

After soldering, the completed assembly must be unloaded, washed and inspected.

**Unloading** must be done carefully to avoid unnecessary stress. Assembly fixtures should be cooled to room temperature so solder profiles are not affected.

**Washing** is mandatory if an acid flux is used because of its ionic and corrosive nature. Wash the assemblies in agitated hot water and detergent for three to five minutes. After washing; rinse, blow off excessive water and bake 30 minutes at 150°C to remove trapped moisture.

**Inspection** should be both electrical and physical. Any rejects can be reworked as required.

#### SUMMARY

The Button Rectifier is an excellent building block for specialized applications. The prime example of its use is the output bridge of the automative alternator where millions are used each year. Although the material presented here is not all inclusive, primary considerations for use are presented. For further information, contact the nearest ON Semiconductor Sales Office or franchised distributor.

## Medium-Current Silicon Rectifier

## 250 Volts, 32 Amperes

Compact, highly efficient silicon rectifiers for medium-current applications requiring:

- High Current Surge 500 Amperes @  $T_J = 175^{\circ}C$
- Peak Performance @ Elevated Temperature 32 Amperes
- Low Cost
- Compact, Molded Package for Optimum Efficiency in a Small Case Configuration

#### **Mechanical Characteristics**

- Finish: All External Surfaces are Corrosion Resistant, and Contact Areas are Readily Solderable
- Polarity: Indicated by Cathode Band
- Weight: 1.8 Grams (Approximately)
- Maximum Temperature for Soldering Purposes: 260°C
- Marking: 3225

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
DC Blocking Voltage	V <sub>R</sub>	250	Volts
Non-Repetitive Peak Reverse Voltage (Halfwave, Single Phase, 60 Hz)	V <sub>RSM</sub>	310	Volts
Average Forward Current (Single Phase, Resistive Load, T <sub>C</sub> = 150°C)	Ι <sub>Ο</sub>	32	Amps
Non-Repetitive Peak Surge Current (Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	500	Amps
Operating Junction Temperature Range	TJ	-65 to +175	°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C

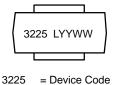


## **ON Semiconductor**<sup>™</sup>

http://onsemi.com

MICRODE BUTTON CASE 193

#### MARKING DIAGRAM



L = Location Code YY = Year

WW = Work Week

#### ORDERING INFORMATION

Device	Package	Shipping
TRA3225	Microde Button	5000 Units/Box

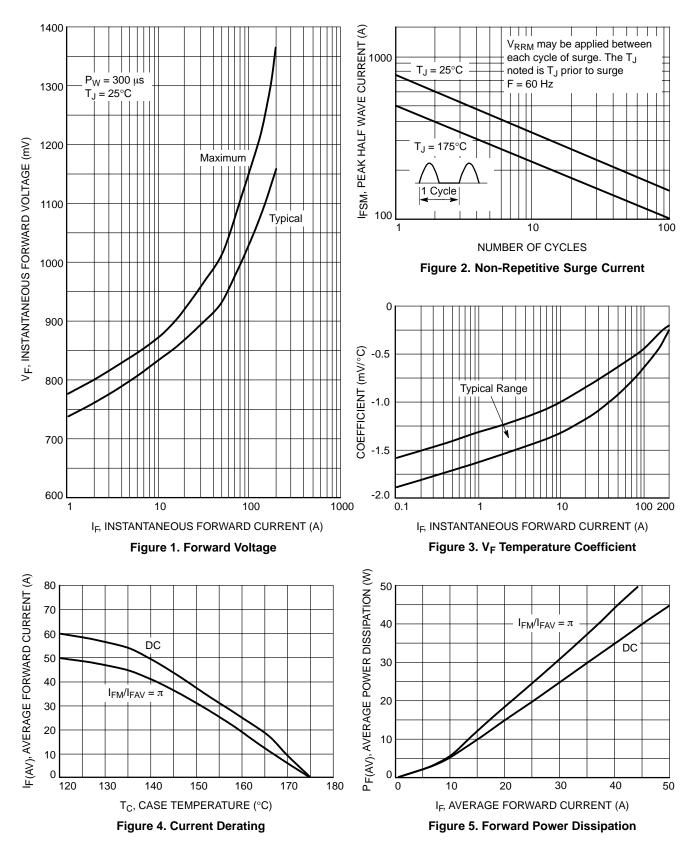
#### THERMAL CHARACTERISTICS

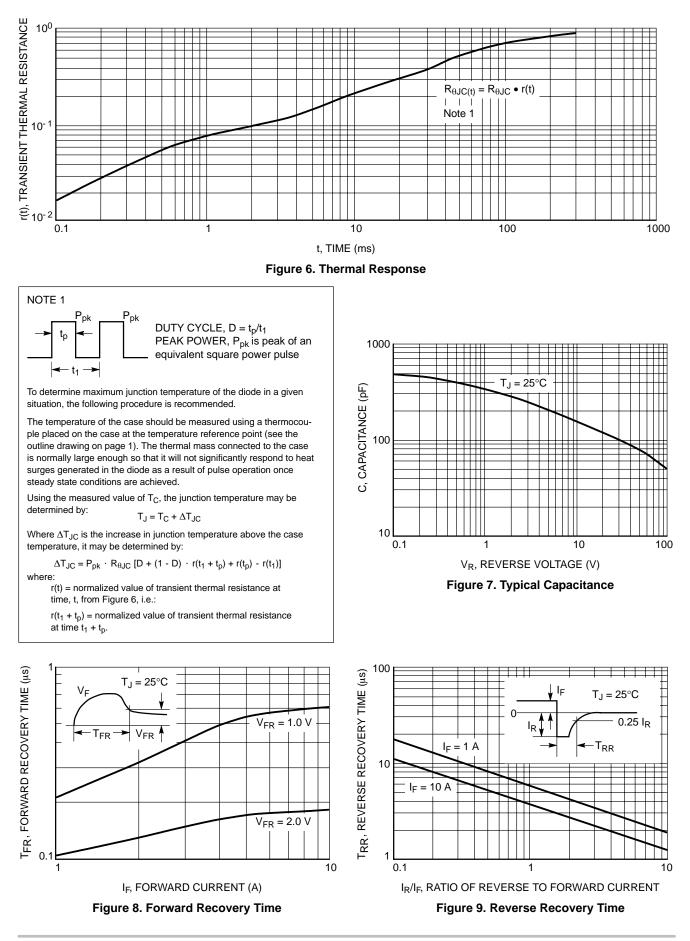
Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case		0.8	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Min	Max	Unit
Instantaneous Forward Voltage (Note 1.) ( $I_F = 100 \text{ Amps}, T_C = 25^{\circ}C$ )	V <sub>F</sub>	-	1.15	Volts
Reverse Current (Note 1.) $(V_R = 250 \text{ V}, T_C = 25^{\circ}\text{C})$ $(V_R = 250 \text{ V}, T_C = 100^{\circ}\text{C})$	I <sub>R</sub>		20 250	μΑ
Forward Voltage Temperature Coefficient (I <sub>F</sub> = 10 mA)		-2*	-2*	mV/°C

1. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2%. \*Typical





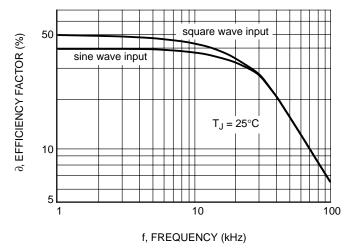


Figure 10. Rectification Waveform Efficiency

**RECTIFICATION EFFICIENCY NOTE** 

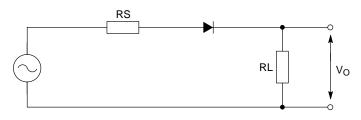


Figure 11. Single Phase Half-Wave Rectifier Circuit

The rectification efficiency factor  $\partial$  shown in Figure 10 was calculated using the formula:

$$\partial = \frac{P_{(dc)}}{P_{(rms)}} = \frac{\frac{V_{20}^{(dc)}}{R_{L}}}{\frac{V_{20}^{(rms)}}{R_{L}}} \cdot 100\% = \frac{V_{20}^{2}(dc)}{V_{20}^{2}(ac) + V_{20}^{2}(dc)} \cdot 100\%$$
(1)

For a sine wave input Vm sin(wt) to the diode, assume lossless, the maximum theoretical efficiency factor becomes:

$$\partial_{\text{(sine)}} = \frac{\frac{\sqrt{2}m}{\pi^2 R_L}}{\frac{\sqrt{2}m}{4R_L}} \cdot 100\% = \frac{4}{\pi^2} \cdot 100\% = 40.6\%$$
(2)

For a square wave input of amplitude Vm, the efficiency factor becomes:

$$\partial_{\text{(square)}} = \frac{\frac{V^2 m}{^2 R_L}}{\frac{V^2 m}{R_L}} \cdot 100\% = 50\%$$
(3)

(a full wave circuit has twice these efficiencies)

As the frequency of the input signal is increased, the reverse recovery time of the diode (Figure 9) becomes significant, resulting in an increase ac voltage component across RL which is opposite in polarity to the forward current, thereby reducing the value of the efficiency factor  $\partial$ , as shown on Figure 10.

It should be emphasized that Figure 10 shows waveform efficiency only; it does not provide a measure of diode losses. Data was obtained by measuring the ac component of  $V_O$  with a true rms ac voltmeter and the dc component with a dc voltmeter. The data was used in Equation 1 to obtain points for Figure 10.

#### Assembly and Soldering Information

There are two basic areas of consideration for successful implementation of button rectifiers:

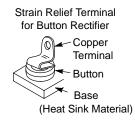
- 1. Mounting and Handling
- 2. Soldering

Each should be carefully examined before attempting a finished assembly or mounting operation.

#### **Mounting and Handling**

The button rectifier lends itself to a multitude of assembly arrangements, but one key consideration must *always* be included: One Side of the Connections to the Button Must be Flexible!

This stress relief to the button should also be chosen for maximum contact area to afford the best heat transfer - but not at the expense of flexibility. For an annealed copper terminal a thickness of 0.015'' is suggested.



The base heat sink may be of various materials whose shape and size are a function of the individual application and the heat transfer requirements.

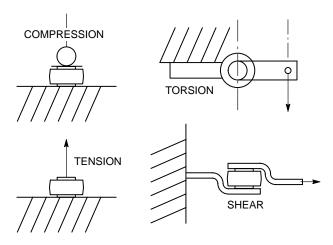
Common Materials	Advantages and Disadvantages		
Steel	Low Cost: relatively low heat conductivity		
Copper	High Cost: high heat conductivity		
Aluminum	Medium Cost: medium heat conductivity.		
	Relatively expensive to plate and not all		
	platers can process aluminum.		

Handling of the button during assembly must be relatively gentle to minimize sharp impact shocks and avoid nicking of the plastic. Improperly designed automatic handling equipment is the worst source of unnecessary shocks. Techniques for vacuum handling and spring loading should be investigated.

The mechanical stress limits for the button diode are as follows:

Compression	32 lbs.	142.3 Newton
Tension	32 lbs.	142.3 Newton
Torsion	6-inch lbs.	0.68 Newtons-meters
Shear	55 lbs.	244.7 Newton

#### **MECHANICAL STRESS**



Exceeding these recommended maximums can result in electrical degradation of the device.

#### Soldering

The button rectifier is basically a semiconductor chip bonded between two nickel-plated copper heat sinks with an encapsulating material of epoxy compound. The exposed metal areas are also tin plated to enhance solderability.

In the soldering process it is important that the temperature not exceed 260°C if device damage is to be avoided. Various solder alloys can be used for this operation but two types are recommended for best results:

- 1. 95% Sn, 5% Sb; melting point 237°C
- 2. 96.5% tin, 3.5% silver; melting point 221°C
- 3. 63% tin, 37% lead; melting point 183°C

Solder is available as preforms or paste. The paste contains both the metal and flux and can be dispensed rapidly. The solder preform requires the application of a flux to assure good wetting of the solder. The type of flux used depends upon the degree of cleaning to be accomplished and is a function of the metal involved. These fluxes range from a mild rosin to a strong acid; e.g., Nickel plating oxides are best removed by an acid base flux while an activated rosin flux may be sufficient for tin plated parts.

Since the button is relatively lightweight, there is a tendency for it to float when the solder becomes liquid. To prevent bad joints and misalignment, it is suggested that a weighting or spring loaded fixture be employed. It is also important that severe thermal shock (either heating or cooling) be avoided as it may lead to damage of the die or encapsulant of the part. Button holding fixtures for use during soldering may be of various materials. Stainless steel has a longer use life while black anodized aluminum is less expensive and will limit heat reflection and enhance absorption. The assembly volume will influence the choice of materials. Fixture dimension tolerances for locating the button must allow for expansion during soldering as well as allowing for button clearance.

#### **Heating Techniques**

The following four heating methods have their advantages and disadvantages depending on volume of buttons to be soldered.

- 1. **Belt furnaces** readily handle large or small volumes and are adaptable to establishment of "on-line" assembly since a variable belt speed sets the run rate. Individual furnace zone controls make excellent temperature control possible.
- 2. Flame Soldering involves the directing of natural gas flame jets at the base of a heatsink as the heatsink is indexed to various loading-heatingcooling-unloading positions. This is the most economical labor method of soldering large volumes. Flame soldering offers good temperature

control but requires sophisticated temperature monitoring systems such as infrared.

- 3. **Ovens** are good for batch soldering and are production limited. There are handling problems because of slow cooling. Response time is load dependent, being a function of the watt rating of the oven and the mass of parts. Large ovens may not give an acceptable temperature gradient. Capital cost is low compared to belt furnaces and flame soldering.
- 4. **Hot Plates** are good for soldering small quantities of prototype devices. Temperature control is fair with overshoot common because of the exposed heating surface. Solder flow and positioning can be corrected during soldering since the assembly is exposed. Investment cost is very low.

Regardless of the heating method used, a soldering profile giving the time-temperature relationship of the particular method must be determined to assure proper soldering. Profiling must be performed on a scheduled basis to minimize poor soldering. The time-temperature relationship will change depending on the heating method used.

# Medium-Current Silicon Rectifiers

# 250 Volts, 25 Amperes

Compact, highly efficient silicon rectifiers for medium-current applications requiring:

- High Current Surge 400 Amperes @  $T_J = 175^{\circ}C$
- Peak Performance @ Elevated Temperature 25 Amperes
- Low Cost
- Compact, Molded Package for Optimum Efficiency in a Small Case Configuration

#### **Mechanical Characteristics**

- Finish: All External Surfaces are Corrosion Resistant, and Contact Areas are Readily Solderable
- Polarity: Indicated by Cathode Band
- Weight: 1.8 Grams (Approximately)
- Maximum Temperature for Soldering Purposes: 260°C
- Marking: 2525 or MR3025

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
DC Blocking Voltage	V <sub>R</sub>	250	Volts
Non-Repetitive Peak Reverse Voltage (Halfwave, Single Phase, 60 Hz)	V <sub>RSM</sub>	310	Volts
Average Forward Current (Single Phase, Resistive Load, T <sub>C</sub> = 150°C)	Io	25	Amps
Non-Repetitive Peak Surge Current (Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	400	Amps
Operating Junction Temperature Range	TJ	-65 to +175	°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +175	°C

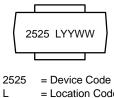


# **ON Semiconductor**<sup>™</sup>

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MICRODE BUTTON CASE 193

#### MARKING DIAGRAM



L = Location Code YY = Year WW = Work Week

#### MARKING DIAGRAM



### **ORDERING INFORMATION**

Device	Package	Shipping
TRA2525	Microde Button	5000 Units/Box
MR3025	Microde Button	5000 Units/Box

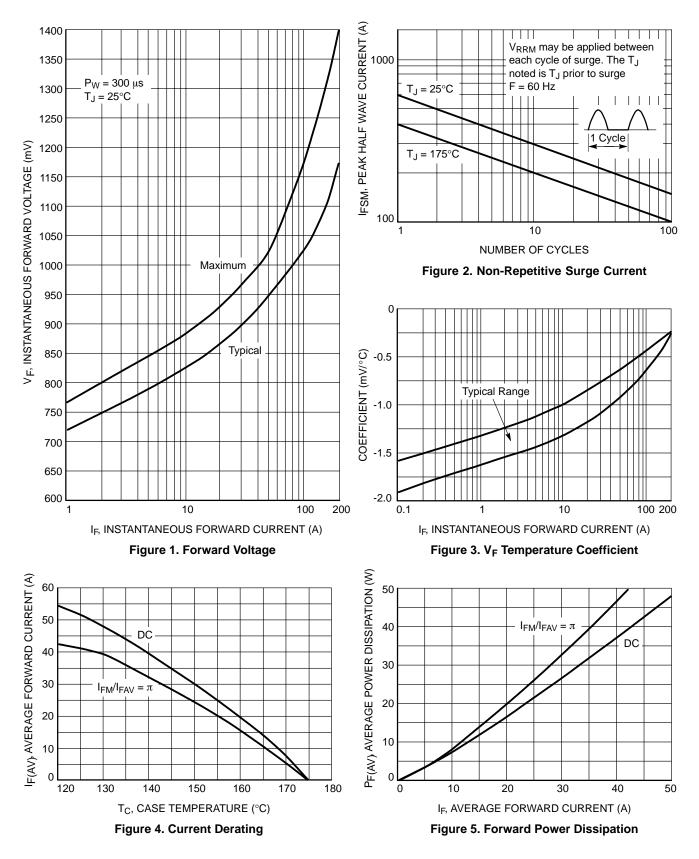
#### THERMAL CHARACTERISTICS

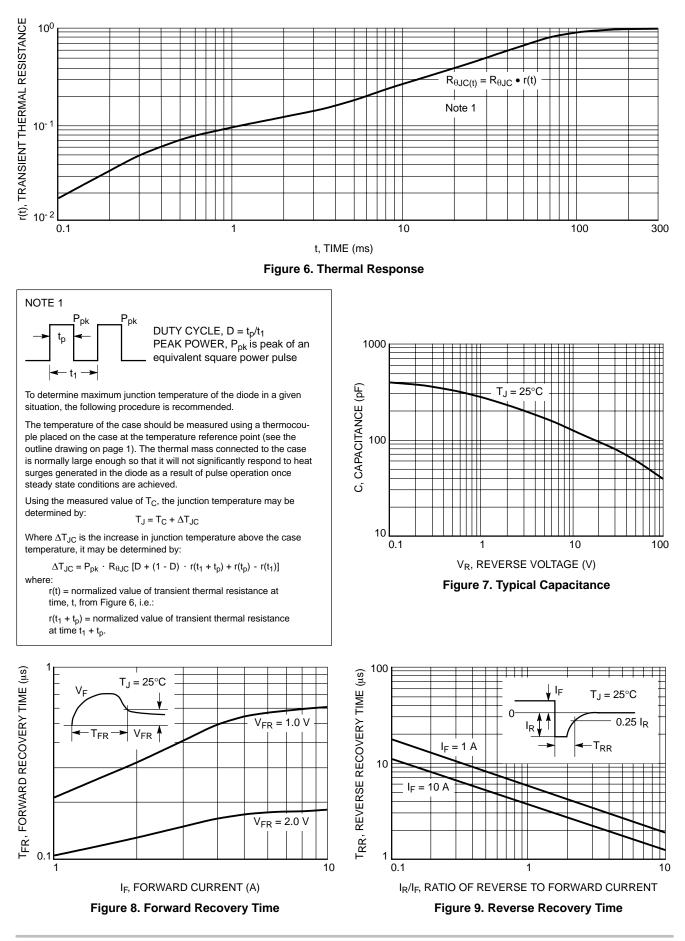
Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	$R_{\thetaJC}$	1.0	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Min	Max	Unit
Instantaneous Forward Voltage (Note 1.) ( $I_F = 100 \text{ Amps}, T_C = 25^{\circ}C$ )	V <sub>F</sub>	_	1.18	Volts
Reverse Current <sup>(1)</sup> (V <sub>R</sub> = 250 V, T <sub>C</sub> = 25°C) (V <sub>R</sub> = 250 V, T <sub>C</sub> = 100°C)	I <sub>R</sub>		10 250	μΑ
Forward Voltage Temperature Coefficient @ I <sub>F</sub> = 10 mA	V <sub>FTC</sub>	-2*	-2*	mV/°C

1. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2%. \*Typical





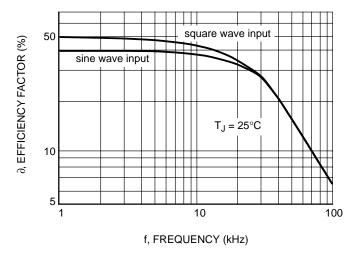


Figure 10. Rectification Waveform Efficiency

**RECTIFICATION EFFICIENCY NOTE** 

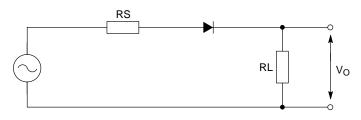


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For a sine wave input Vm sin(wt) to the diode, assume lossless, the maximum theoretical efficiency factor becomes:

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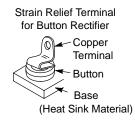
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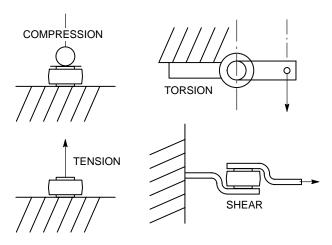
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- 2. Flame Soldering involves the directing of natural gas flame jets at the base of a heatsink as the heatsink is indexed to various loading-heating-cooling-unloading positions. This is the most economical labor method of soldering large volumes. Flame soldering offers good temperature

control but requires sophisticated temperature monitoring systems such as infrared.

- 3. **Ovens** are good for batch soldering and are production limited. There are handling problems because of slow cooling. Response time is load dependent, being a function of the watt rating of the oven and the mass of parts. Large ovens may not give an acceptable temperature gradient. Capital cost is low compared to belt furnaces and flame soldering.
- 4. Hot Plates are good for soldering small quantities of prototype devices. Temperature control is fair with overshoot common because of the exposed heating surface. Solder flow and positioning can be corrected during soldering since the assembly is exposed. Investment cost is very low.

Regardless of the heating method used, a soldering profile giving the time-temperature relationship of the particular method must be determined to assure proper soldering. Profiling must be performed on a scheduled basis to minimize poor soldering. The time-temperature relationship will change depending on the heating method used.

# Overvoltage Transient Suppressor

Designed for applications requiring a low voltage rectifier with reverse avalanche characteristics for use as reverse power transient suppressors. Developed to suppress transients in the automotive system, these devices operate in the forward mode as standard rectifiers or reverse mode as power avalanche rectifier and will protect electronic equipment from overvoltage conditions.

- High Power Capability
- Economical
- Increased Capacity by Parallel Operation

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 2.5 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Maximum Lead Temperature for Soldering Purposes: 350°C 3/8″ from Case for 10 Seconds at 5 lbs. Tension
- Polarity: Indicated by Diode Symbol or Cathode Band
- Marking: MR2520L

#### MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

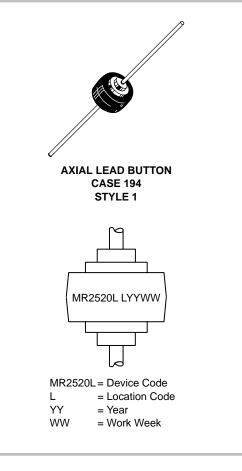
Rating	Symbol	Value	Unit	
DC Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	23	Volts	
$\begin{array}{l} \mbox{Repetitive Peak Reverse Surge Current} \\ \mbox{(Time Constant = 10 ms,} \\ \mbox{Duty Cycle} \leq 1\%, \ T_C = 25^{\circ}C) \end{array}$	I <sub>RSM</sub>	58	Amps	
Peak Reverse Power (Time Constant = 10 ms, Duty Cycle $\leq$ 1%, T <sub>C</sub> = 25°C)	P <sub>RSM</sub>	2500	Watts	
Average Rectified Forward Current (Single Phase, Resistive Load, 60 Hz, $T_C = 125^{\circ}C$ ) (See Figure 4)	Ι <sub>Ο</sub>	6.0	Amps	
Non-Repetitive Peak Surge Current Surge Supplied at Rated Load Conditions Halfwave, Single Phase	I <sub>FSM</sub>	400	Amps	
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C	



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### OVERVOLTAGE TRANSIENT SUPPRESSOR 24 - 32 VOLTS



#### ORDERING INFORMATION

Device	Package	Shipping
MR2520L	Axial Lead Button	1000/Box
MR2520LRL	Axial Lead Button	800/Reel

#### THERMAL CHARACTERISTICS

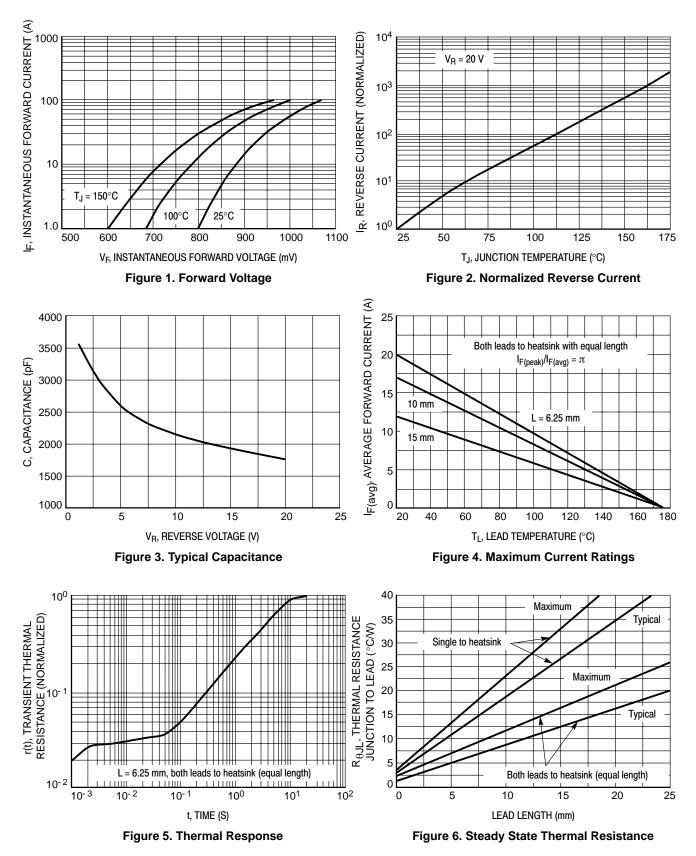
Characteristic	Lead Length	Symbol	Max	Unit
Thermal Resistance, Junction to Lead, Both Leads to Heat Sink with Equal Length	6.25 mm 10 mm 15 mm	R <sub>θJL</sub>	7.5 10 15	°C/W
Thermal Resistance Junction to Case	-	$R_{ extsf{ heta}JC}$	1.0	°C/W

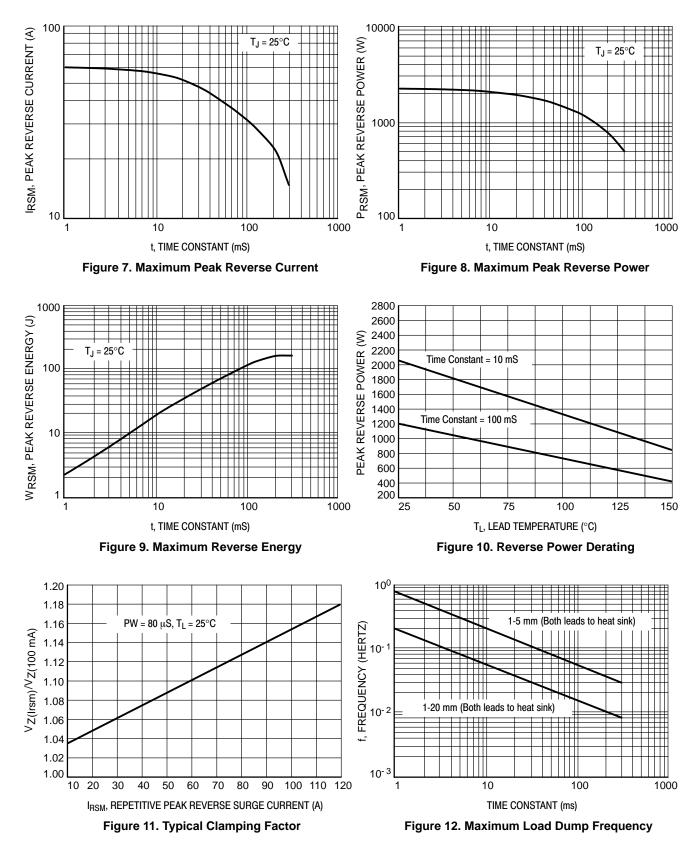
\*\*Typical

#### **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = $25^{\circ}C$ unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
Instantaneous Forward Voltage (Note 1) ( $I_F = 100 \text{ Amps}, T_C = 25^{\circ}C$ )	VF	-	1.25	Volts
Instantaneous Forward Voltage (Note 1) (I <sub>F</sub> = 6.0 Amps, T <sub>C</sub> = $25^{\circ}$ C)	VF	-	0.90	Volts
Reverse Current (V <sub>R</sub> = 20 Vdc, T <sub>C</sub> = 25°C)	I <sub>R</sub>	-	10	nAdc
Reverse Current (V <sub>R</sub> = 20 Vdc, T <sub>C</sub> = 25°C)	۱ <sub>R</sub>	-	300	nAdc
Breakdown Voltage (Note 1) ( $I_R = 100 \text{ mAdc}, T_C = 25^{\circ}C$ )	V <sub>(BR)</sub>	24	32	Volts
Breakdown Voltage (Note 1) ( $I_R = 90 \text{ Amp}, T_C = 150^{\circ}\text{C}, PW = 80 \mu\text{s}$ )	V <sub>(BR)</sub>	-	40	Volts
Dynamic Resistance (I <sub>R</sub> = 100 mA, T <sub>J</sub> = 25°C, f = 1.0 kHz)	R <sub>Z</sub>	-	5.0	Ω
Dynamic Resistance (I <sub>R</sub> = 40 mA, $T_J$ = 25°C)	R <sub>Z</sub>	-	0.15	Ω
Breakdown Voltage Temperature Coefficient	V <sub>(BR)TC</sub>	-	0.09*	%/°C
Forward Voltage Temperature Coefficient @ $I_F = 10 \text{ mA}$	V <sub>FTC</sub>	-	-2*	mV/°C

1. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2%. \*\*Typical





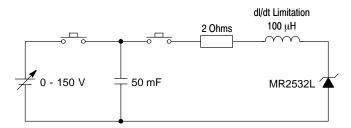


Figure 13. Load Dump Test Circuit

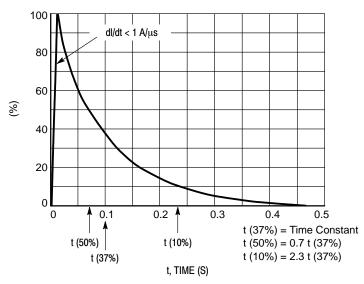


Figure 14. Load Dump Pulse Current

# **Overvoltage Transient Suppressors**

# **Medium Current**

Designed for applications requiring a low voltage rectifier with reverse avalanche characteristics for use as reverse power transient suppressors. Developed to suppress transients in the automotive system, these devices operate in the forward mode as standard rectifiers or reverse mode as power avalanche rectifier and will protect electronic equipment from overvoltage conditions.

- Avalanche Voltage 24 to 32 Volts
- High Power Capability
- Economical
- Increased Capacity by Parallel Operation

#### **Mechanical Characteristics**

- Case: Epoxy, Molded
- Weight: 2.5 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Maximum Lead Temperature for Soldering Purposes: 350°C 3/8" from Case for 10 Seconds at 5 lbs. Tension
- Polarity: Indicated by Diode Symbol or Cathode Band
- Marking: MR2535L

#### **MAXIMUM RATINGS** (T<sub>J</sub> = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
DC Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	20	Volts
$\begin{array}{l} \mbox{Repetitive Peak Reverse Surge Current} \\ \mbox{(Time Constant = 10 ms, Duty Cycle} \\ \le 1\%, \ T_C = 25^\circ C) \ (\mbox{See Note 1}) \end{array}$	I <sub>RSM</sub>	62	Amps
Average Rectified Forward Current (Single Phase, Resistive Load, 60 Hz, $T_C = 125^{\circ}C$ ) (See Figure 4)	Ι <sub>Ο</sub>	6.0	Amps
Non-Repetitive Peak Surge Current Surge Supplied at Rated Load Conditions Halfwave, Single Phase	I <sub>FSM</sub>	600	Amps
Operating and Storage Junction Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C



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#### ORDERING INFORMATION

Device	Package	Shipping
MR2535L	Axial Lead Button	1000/Box
MR2535LRL	Axial Lead Button	800/Reel

#### THERMAL CHARACTERISTICS

Characteristic	Lead Length	Symbol	Max	Unit
Thermal Resistance, Junction to Lead @ Both Leads to Heat Sink, Equal Length	1/4″ 3/8″ 1/2″	R <sub>θJL</sub>	7.5 10 13	°C/W
Thermal Resistance Junction to Case		$R_{ extsf{ heta}JC}$	0.8*	°C/W

**ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> =  $25^{\circ}$ C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
Instantaneous Forward Voltage (Note 1.) (i <sub>F</sub> = 100 Amps, $T_C = 25^{\circ}C$ )	VF	-	1.1	Volts
Reverse Current (V <sub>R</sub> = 20 Vdc, T <sub>C</sub> = 25°C)	I <sub>R</sub>	-	200	nAdc
Breakdown Voltage (Note 1.) ( $I_R$ = 100 mAdc, $T_C$ = 25°C)	V <sub>(BR)</sub>	24	32	Volts
Breakdown Voltage (Note 1.) (I <sub>R</sub> = 90 Amp, $T_C$ = 150°C, PW = 80 µs)	V <sub>(BR)</sub>	-	40	Volts
Breakdown Voltage Temperature Coefficient	V <sub>(BR)TC</sub>	-	0.096*	%/°C
Forward Voltage Temperature Coefficient @ I <sub>F</sub> = 10 mA	V <sub>FTC</sub>	-	2*	mV/°C

1. Pulse Test: Pulse Width  $\leq$  300 µs, Duty Cycle  $\leq$  2%.

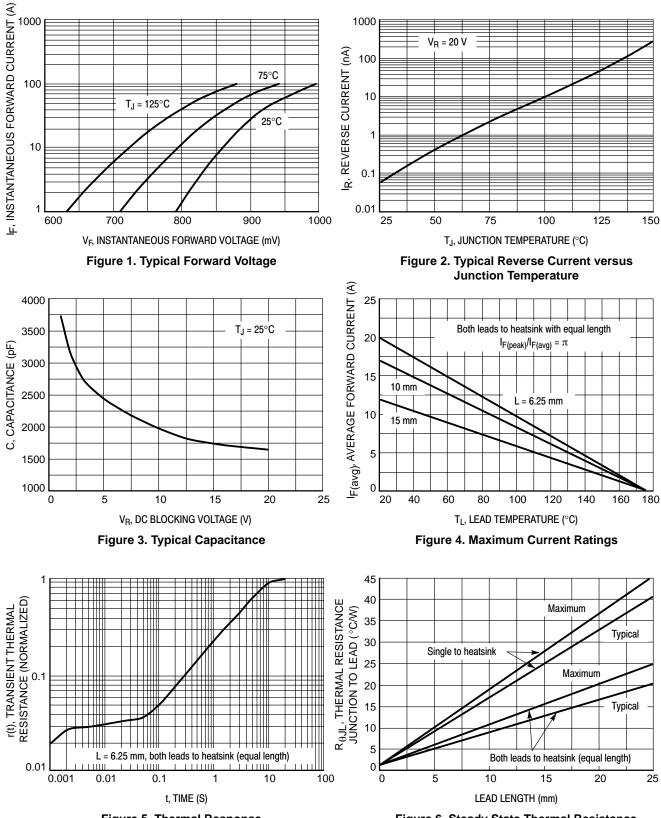
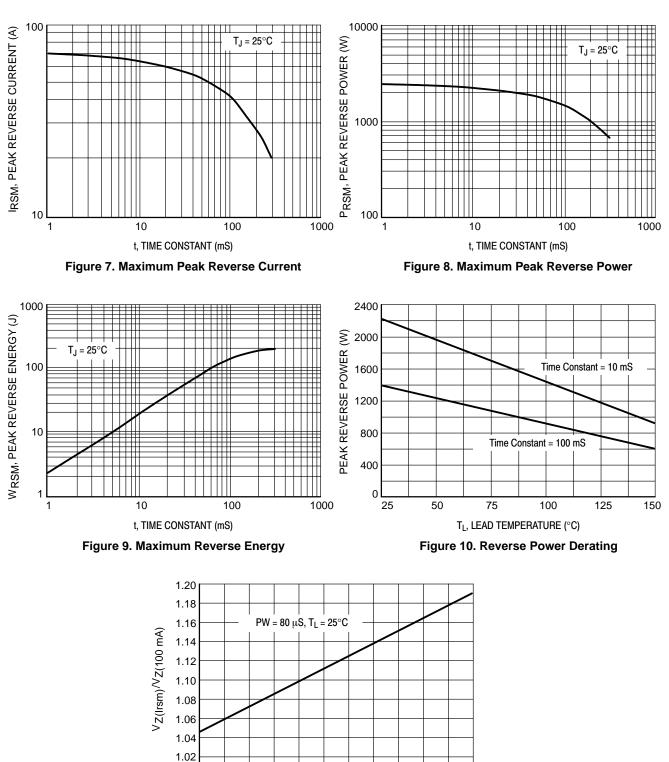


Figure 5. Thermal Response

Figure 6. Steady State Thermal Resistance



I<sub>RSM</sub>, REPETITIVE PEAK REVERSE SURGE CURRENT (A) Figure 11. Typical Clamping Factor

90

100 110

120

50 60 70 80

30 40

1.00

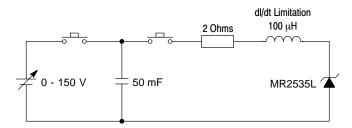


Figure 12. Load Dump Test Circuit

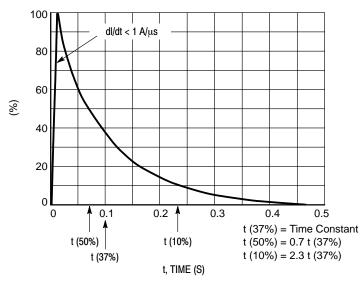


Figure 13. Load Dump Pulse Current

# **Overvoltage Transient Suppressor**

# 24 V-32 V

Designed for applications requiring a diode with reverse avalanche characteristics for use as reverse power transient suppressor. Developed to suppress transients in automotive system, this device operates in the forward mode as standard rectifier or reverse mode as power zener diode and will protect expensive modules such as ignition, injection, antiblocking system . . . from overvoltage conditions.

- High Power Capability
- Economical

#### **Mechanical Characteristics**

- Finish: All External Surfaces are Corrosion Resistant, and Contact Areas are Readily Solderable
- Polarity: Indicated by Cathode Band
- Weight: 1.8 Grams (Approximately)
- Maximum Temperature for Soldering Purposes: 260°C
- Marking: 2532

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
DC Blocking Voltage	V <sub>R</sub>	23	Volts
Average Forward Current (Single Phase, Resistive Load, $T_{C} = 150^{\circ}C$ )	Ι <sub>Ο</sub>	32	Amps
Peak Repetitive Reverse Surge Current (Time Constant = 10 ms, $T_C = 25^{\circ}C$ )	I <sub>RSM</sub>	80	Amps
Non-Repetitive Peak Surge Current (Halfwave, Single Phase, 60 Hz)	I <sub>FSM</sub>	500	Amps
Operating Junction Temperature Range	Τ <sub>J</sub>	-65 to +175	°C
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C



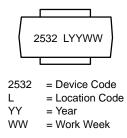
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http://onsemi.com



MICRODE BUTTON CASE 193

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

Device	Package	Shipping
TRA2532	Microde Button	5000 Units/Box

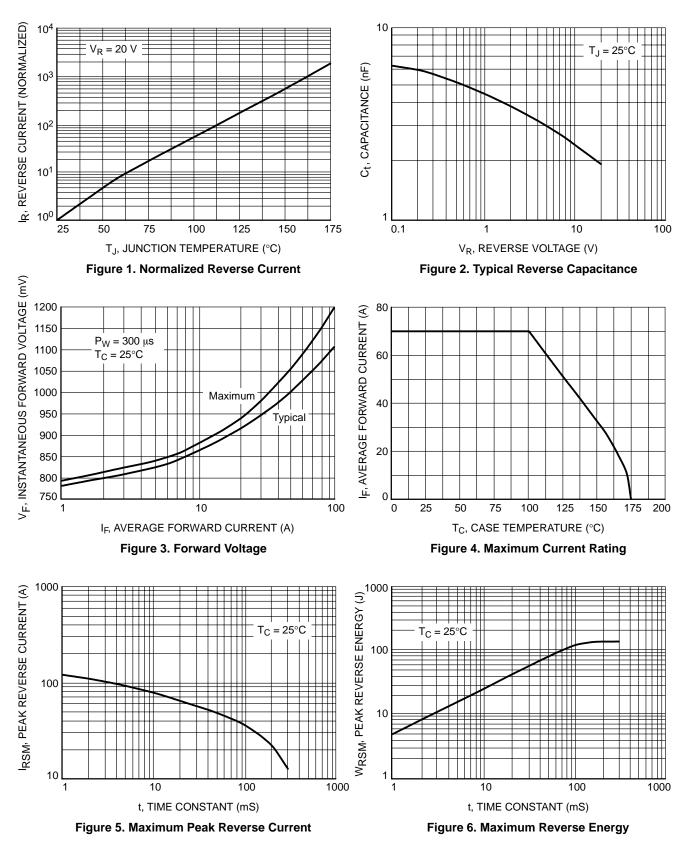
#### THERMAL CHARACTERISTICS

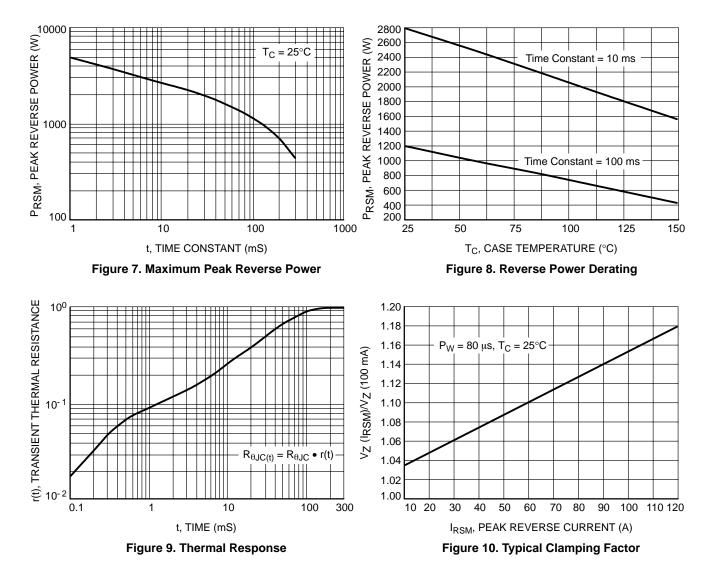
Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	$R_{\thetaJC}$	0.8	°C/W

#### **ELECTRICAL CHARACTERISTICS**

Characteristic	Symbol	Min	Max	Unit
Instantaneous Forward Voltage (Note 1.) ( $i_F = 100 \text{ Amps}, T_C = 25^{\circ}C$ )	VF	-	1.18	Volts
Reverse Current <sup>(1)</sup> (V <sub>R</sub> = 23 Vdc, T <sub>C</sub> = 25°C)	۱ <sub>R</sub>	-	10	μA
Breakdown Voltage <sup>(1)</sup> ( $I_Z = 100 \text{ mA}, T_C = 25^{\circ}C$ )	V <sub>(BR)</sub>	24	32	Volts
Breakdown Voltage ( $I_Z = 80 \text{ Amps}, T_C = 25^{\circ}C, P_W = 80 \mu\text{s}$ )	V <sub>(BR)</sub>	-	40	Volts
Breakdown Voltage Temperature Coefficient	V <sub>(BR)TC</sub>	0.096*	0.096*	%/°C
Forward Voltage Temperature Coefficient @ $I_F = 10 \text{ mA}$	V <sub>FTC</sub>	-2*	-2*	mV/°C

1. Pulse Test: Pulse Width  $\leq$  300  $\mu$ s, Duty Cycle  $\leq$  2%. \*Typical





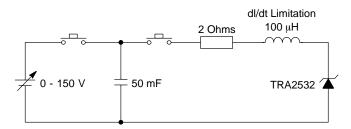


Figure 11. Load Dump Test Circuit

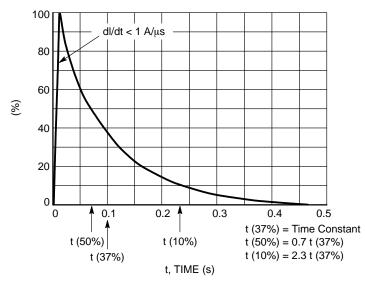


Figure 12. Load Dump Pulse Current

#### Assembly and Soldering Information

There are two basic areas of consideration for successful implementation of button rectifiers:

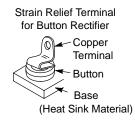
- 1. Mounting and Handling
- 2. Soldering

Each should be carefully examined before attempting a finished assembly or mounting operation.

#### **Mounting and Handling**

The button rectifier lends itself to a multitude of assembly arrangements, but one key consideration must *always* be included: One Side of the Connections to the Button Must be Flexible!

This stress relief to the button should also be chosen for maximum contact area to afford the best heat transfer - but not at the expense of flexibility. For an annealed copper terminal a thickness of 0.015'' is suggested.



The base heat sink may be of various materials whose shape and size are a function of the individual application and the heat transfer requirements.

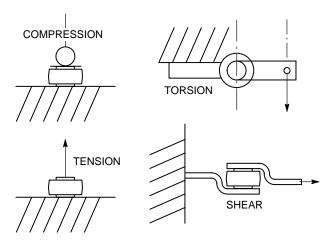
Common Materials	Advantages and Disadvantages
Steel	Low Cost: relatively low heat conductivity
Copper	High Cost: high heat conductivity
Aluminum	Medium Cost: medium heat conductivity.
	Relatively expensive to plate and not all
	platers can process aluminum.

Handling of the button during assembly must be relatively gentle to minimize sharp impact shocks and avoid nicking of the plastic. Improperly designed automatic handling equipment is the worst source of unnecessary shocks. Techniques for vacuum handling and spring loading should be investigated.

The mechanical stress limits for the button diode are as follows:

Compression	32 lbs.	142.3 Newton
Tension	32 lbs.	142.3 Newton
Torsion	6-inch lbs.	0.68 Newtons-meters
Shear	55 lbs.	244.7 Newton

#### **MECHANICAL STRESS**



Exceeding these recommended maximums can result in electrical degradation of the device.

#### Soldering

The button rectifier is basically a semiconductor chip bonded between two nickel-plated copper heat sinks with an encapsulating material of epoxy compound. The exposed metal areas are also tin plated to enhance solderability.

In the soldering process it is important that the temperature not exceed 260°C if device damage is to be avoided. Various solder alloys can be used for this operation but two types are recommended for best results:

- 1. 95% Sn, 5% Sb; melting point 237°C
- 2. 96.5% tin, 3.5% silver; melting point 221°C
- 3. 63% tin, 37% lead; melting point 183°C

Solder is available as preforms or paste. The paste contains both the metal and flux and can be dispensed rapidly. The solder preform requires the application of a flux to assure good wetting of the solder. The type of flux used depends upon the degree of cleaning to be accomplished and is a function of the metal involved. These fluxes range from a mild rosin to a strong acid; e.g., Nickel plating oxides are best removed by an acid base flux while an activated rosin flux may be sufficient for tin plated parts.

Since the button is relatively lightweight, there is a tendency for it to float when the solder becomes liquid. To prevent bad joints and misalignment, it is suggested that a weighting or spring loaded fixture be employed. It is also important that severe thermal shock (either heating or cooling) be avoided as it may lead to damage of the die or encapsulant of the part.

Button holding fixtures for use during soldering may be of various materials. Stainless steel has a longer use life while black anodized aluminum is less expensive and will limit heat reflection and enhance absorption. The assembly volume will influence the choice of materials. Fixture dimension tolerances for locating the button must allow for expansion during soldering as well as allowing for button clearance.

#### **Heating Techniques**

The following four heating methods have their advantages and disadvantages depending on volume of buttons to be soldered.

- 1. **Belt furnaces** readily handle large or small volumes and are adaptable to establishment of "on-line" assembly since a variable belt speed sets the run rate. Individual furnace zone controls make excellent temperature control possible.
- 2. Flame Soldering involves the directing of natural gas flame jets at the base of a heatsink as the heatsink is indexed to various loading-heatingcooling-unloading positions. This is the most economical labor method of soldering large volumes. Flame soldering offers good temperature control but requires sophisticated temperature monitoring systems such as infrared.

- 3. **Ovens** are good for batch soldering and are production limited. There are handling problems because of slow cooling. Response time is load dependent, being a function of the watt rating of the oven and the mass of parts. Large ovens may not give an acceptable temperature gradient. Capital cost is low compared to belt furnaces and flame soldering.
- 4. **Hot Plates** are good for soldering small quantities of prototype devices. Temperature control is fair with overshoot common because of the exposed heating surface. Solder flow and positioning can be corrected during soldering since the assembly is exposed. Investment cost is very low.

Regardless of the heating method used, a soldering profile giving the time-temperature relationship of the particular method must be determined to assure proper soldering. Profiling must be performed on a scheduled basis to minimize poor soldering. The time-temperature relationship will change depending on the heating method used.

# **Overvoltage Transient Suppressor**

...designed for applications requiring a diode with reverse avalanche characteristics for use as reverse power transient suppressor.

Developed to suppress transients in the automotive system, this device operates in reverse mode as power zener diode and will protect expensive modules such as ignition, injection and autoblocking systems from overvoltage conditions.

- High Power Capability
- Economical
- **Mechanical Characteristics**
- Finish: All External Surfaces are Corrosion Resistant
- Polarity: Cathode to Terminal
- Weight: 1.78 Grams (Approximately)
- Maximum Temperature for Soldering Purposes: 260°C for 10 s using a Belt Furnace
- Marking: MR2835S

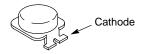
#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
DC Blocking Voltage	V <sub>R</sub>	23	Volts
Peak Repetitive Reverse Surge Current (Time Constant = 10 ms, T <sub>C</sub> = 25°C)	I <sub>RSM</sub>	62	Amps
Non-Repetitive Peak Surge Current (Halfwave, Single Phase, 50 Hz)	I <sub>FSM</sub>	400	Amps
Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C
Operating Junction Temperature Range	Τ <sub>J</sub>	-40 to +150	°C



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TOP CAN CASE 460

#### MARKING DIAGRAM



## = Lot Number MR2835S = Specific Device Code YY = Year WW = Work Week

#### ORDERING INFORMATION

Device	Package	Shipping
MR2835S	Top Can	500/Tape & Reel
MR2835SK	Top Can	500/Tape & Reel

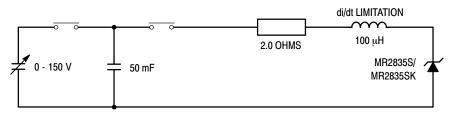
#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case	$R_{\thetaJC}$	1.0	°C/W

#### ELECTRICAL CHARACTERISTICS (T<sub>C</sub> = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
Instantaneous Forward Voltage (I <sub>F</sub> = 100 A) (Note 1)	V <sub>F</sub>	-	1.1	Volts
Reverse Current (V <sub>R</sub> = 20 V) (Note 1)	I <sub>R</sub>	-	5.0	μΑ
Breakdown Voltage (I <sub>Z</sub> = 100 mA) (Note 1)	V <sub>(BR)</sub>	24	32	Volts
Breakdown Voltage (I <sub>Z</sub> = 80 A, T <sub>C</sub> = 85°C, PW = 80 $\mu$ s)	V <sub>(BR)</sub>	-	40	Volts
Breakdown Voltage Temperature Coefficient	V <sub>(BR)TC</sub>	-	0.09	%/°C
Forward Voltage Temperature Coefficient (I <sub>F</sub> = 10 mA)	V <sub>FTC</sub>	-	-2.0*	mV/°C

1. Pulse Test: Pulse Width < 300  $\mu$ s, Duty Cycle < 2%. \*Typical

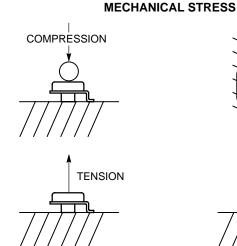


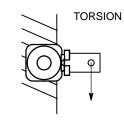


#### MOUNTING AND HANDLING

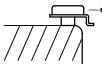
The mechanical stress limits for the Top Can diode are as follows:

Compression:	33.7 lbs	150 newtons
Tension:	33.7 lbs	150 newtons
Torsion:	6.3 inch lbs	0.7 newton meters
Shear:	56.2 lbs	250 newtons





SHEAR



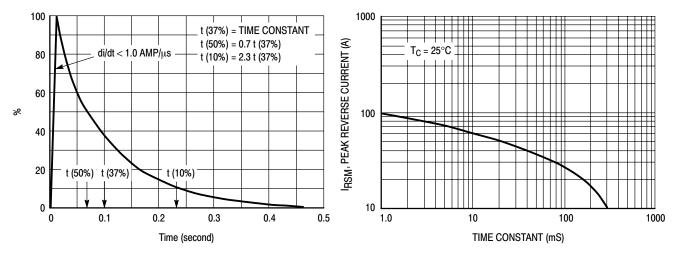




Figure 3. Maximum Peak Reverse Current

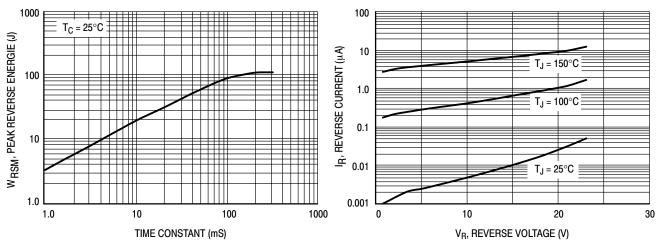


Figure 4. Maximum Reverse Energie

Figure 5. Typical Reverse Current

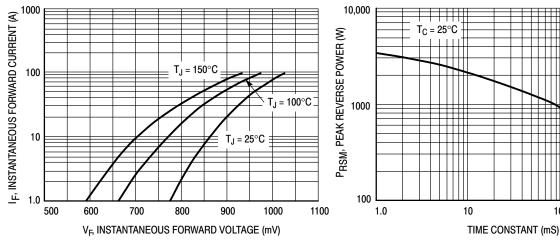


Figure 6. Typical Forward Voltage



100

1000

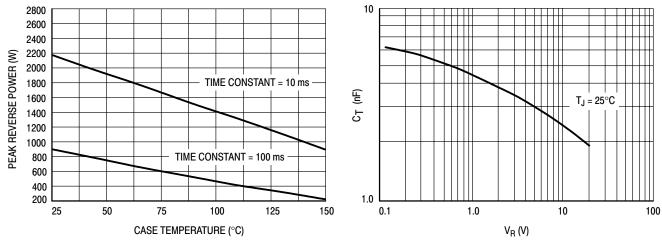
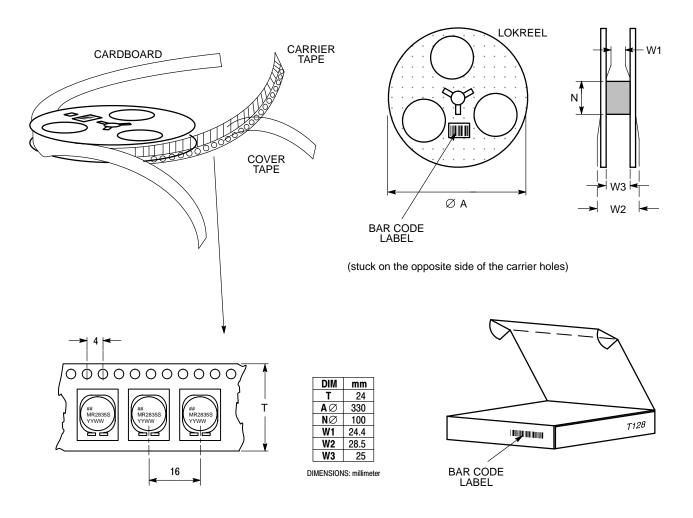


Figure 8. Reverse Power Derating

Figure 9. Typical Reverse Capacitance

Reel of 500 Units





# CHAPTER 6 AR598: Avalanche Capability of Today's Power Semiconductors

# Avalanche Capability of Today's Power Semiconductors



### ON Semiconductor<sup>™</sup>

http://onsemi.com

#### R Borras, P Aloisi, D Shumate\* ON Semiconductor, France, USA\* Paper published at the EPE Conference '93, Brighton 9/93.

# ARTICLE REPRINT

<u>Abstract.</u> Power semiconductors are used to switch high currents in fractions of a second and therefore belong inherently to a world of voltage spikes. To avoid unnecessary breakdown voltage guardbands, new generations of semiconductors are now avalanche rugged and characterized in avalanche energy.

This characterization is often far from application conditions and thus quite useless to the designer. It is easy to verify that an energy rating is not the best approach to a ruggedness quantification because of avalanche energy fluctuations with test conditions.

A physical and thermal analysis of the failure mechanisms leads to a new characterization method generating easy-to-use data for safe designs. The short-term avalanche capability will be discussed with an insight of the different technologies developed to meet these new ruggedness requirements.

Keywords. Avalanche, breakdown, unclamped inductive switching energy, safe operating areas.

#### INTRODUCTION

One obvious trend for new power electronic designs is to work at very high switching frequencies in order to reduce the volume and weight of all the capacitive and inductive elements. The consequence is that most applications today require switching very high currents in fractions of a microsecond and therefore generate L x dI/dt voltage spikes due to parasitic inductance. Unfortunately these undesirable voltage levels sometimes reach the breakdown voltage of power semiconductors that are not intended to be used in avalanche.

The necessity for avalanche rugged power semiconductors has clearly been perceived by many semiconductor manufacturers who have come up with avalanche-energy rated devices.

This paper will show the limits of an energy-based characterization model. It will concentrate on three different devices: Ultra Fast recovery Rectifiers, Schottky Barrier Rectifiers and MOSFETs. It will study their main failure mechanisms and show the technological improvements that guarantee an enhanced ruggedness.

This will lead to a new characterization that will help the designer choose correctly between overall cost and reliability.

#### LIMITS OF AN AVALANCHE ENERGY CHARACTERIZATION

Practically all the characterizations are based on the following Unclamped Inductive Switching (UIS) test circuit (Fig 1).

The energy is first stored in inductor L by turning on transistor Q for a period of time proportional to the peak current desired in the inductor. When Q is turned off, the inductor reverses its voltage and avalanches the Device Under Test until all its energy is transferred. The DUT can be a rectifier or a MOSFET (the gate should always be shorted to the source).

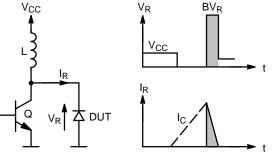


Figure 1. Standard UIS Characterization Circuit.

The standard characterization method consists in increasing the peak current in the inductor until the device fails. The energy that the device can sustain without failing becomes a figure of merit of the ruggedness to avalanche:

 $Waval = 1/2 L I_{peak}^2 BV_{(DUT)} / (BV_{(DUT)} - V_{CC})$ [1]

The main limit of this method is that the energy level that causes a failure in the DUT is not a constant but a function of L and  $V_{CC}$ . This results of the fact that the avalanche duration is function of the current decay slope  $(BV_{(DUT)}-V_{CC})/L$ :

# Table 1. Peak Current and Energy Causing Failures ina 1 A, 1000 V Ultra Fast Recovery Rectifier.

Inductor Value:	10 mH	50 mH	100 mH
Peak Current:	1.7 A	0.9 A	0.8 A
Energy:	14 mJ	20 mJ	32 mJ

Table 1 indicates that the failure is not caused by an energy (i.e. it is not independent of the avalanche duration) but rather by a current level that has to be derated versus time: the devices can sustain a low current for a long period of time (high energy) but at high avalanche currents they will fail after a few microseconds (low energy).

Therefore, unless the designer has a parasitic inductance of value L in his circuit, the standard characterization data will be useless, or worse, it might lead to an overestimate of the ruggedness of his application: because parasitic inductances are often an order of magnitude less than the test circuit inductance, the expected energy capability leads to excessive current levels.

The UIS test circuit is very easy to implement: the only important point is that the transistor has to have a breakdown voltage higher than the DUT. For low breakdown voltage devices, a MOSFET might be preferred to the bipolar transistor.

The advantages of using a MOSFET are multiple: it is a more rugged device, it is much easier to drive and its switching characteristics can be controlled by adding a resistor in series with the gate. It is mandatory to limit this switching speed to avoid having an avalanche energy measurement dependent on the gate drive (i.e. gate resistor and gate to source voltage values).

Anyhow, it is possible to generate very useful information with this UIS test circuit by varying the inductor value. It is also very important to present the data independently of the values of  $V_{CC}$  and L. One solution can be to plot the maximum peak current versus the avalanche duration (Fig 2):

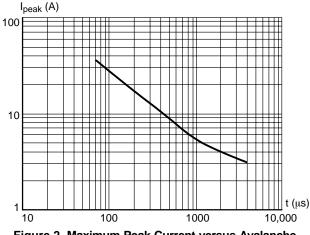


Figure 2. Maximum Peak Current versus Avalanche Duration for a 15 A, 60 V MOSFET in an UIS Test Circuit.

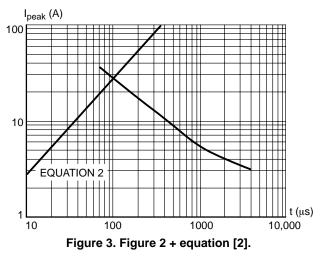
The advantage of this new graph is that the designer can easily calculate the safety margin of his application and he will not be mislead by an energy value that depends on too many different parameters. If he knows the value of the parasitic inductance in his circuit he will be able to determine its maximum peak current.

For instance, let us assume that the designer uses the 15 A, 60 V MOSFET characterized in Figure 2. This device sustains 500 mJ with an inductor of 75 mH according to equation [1]. Its typical breakdown voltage is 80 V.

If the supply voltage  $V_{DD}$  is 12 V and the parasitic inductance L is 250  $\mu$ H, then the avalanche duration and maximum peak current are related by

$$I_{peak} = t (BV_{DSS} - V_{DD}) / L$$
[2]

This relationship can be added to Figure 2 (see Fig 3):



Thus the maximum peak current that can flow through the parasitic inductance L is approximately 28 A instead of 58 A that would have resulted of using equation [1].

#### UNDERSTANDING THE FAILURE MECHANISMS

#### **Physical Approach**

The following microscope photographs show the failure locations for an Ultra Fast Recovery Rectifier (UFR), a Schottky Barrier Rectifier (SBR) and a MOSFET:

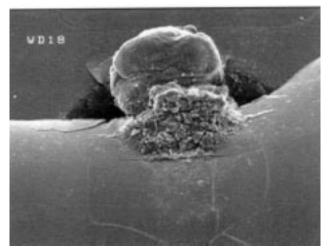


Figure 4. 4 A, 1000 V UFR Avalanche Failure.

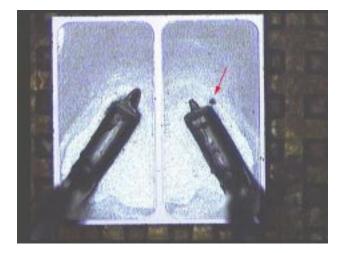


Figure 5. 25 A, 35 V SBR Avalanche Failure.

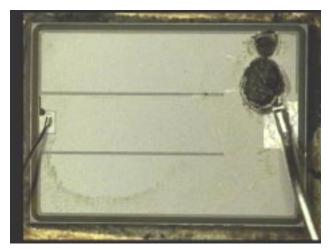


Figure 6. 20 A, 500 V MOSFET Avalanche Failure.

These photographs show that the failure is generally a punchthrough. The melt-through hole dimensions depend on the current level and avalanche duration.

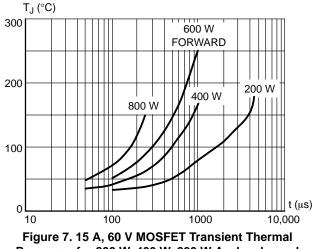
A close look at the electrical characteristics of failed rectifiers on a curve tracer show three levels of degradation: low stressed diodes have a normal forward characteristic but show an unusual leakage current before entering breakdown as if they had a high-value resistor in parallel: this resistance can be explained by a small punchthrough. For medium degradation levels, the value of this pseudo-resistance decreases and becomes visible in the forward characteristic of the diode. Finally, when the punchthrough reaches considerable dimensions, the device looks very similar to a low value resistor.

The failure does not always appear in the same region of the die. For instance, high voltage UFRs have their punch-through always located in a corner, MOSFETs often

fail in the corners or on the sides whereas SBRs have randomly located failures.

#### **Thermal Approach**

Transient thermal response graphs generated by a standard  $\Delta V_{DS}$  method show the junction temperature evolution for forward and avalanche constant current conduction in a MOSFET. These graphs (Fig 7) prove that the silicon efficiency during avalanche and forward currents are similar.



Response for 800 W, 400 W, 200 W Avalanche and 600 W Forward Conduction.

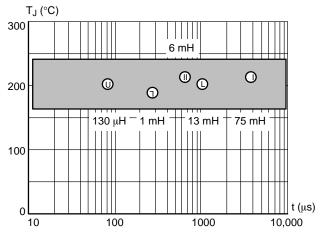
Figure 7 can be used to generate a transient thermal resistance graph by plotting the temperature divided by the power: the four graphs should then normally match. Some slight differences show that the transient thermal resistance increases with the current level: i.e. the 800 W curve (10 A constant avalanche current) has a higher transient thermal resistance than the 200 W (2.5 A). Therefore the thermal efficiency in a MOSFET is not perfectly homogeneous versus the avalanche current.

A similar analysis on an UFR or an SBR shows poor thermal efficiency in avalanche. This can be shown by comparing the temperature rise after 1 ms for forward and avalanche conduction pulses of same power (400 W):

MOSFET	$\Delta T_{direct}$ =160°C	$\Delta T_{avalanche} = 180^{\circ}C$	ratio=0.9
UFR	$\Delta T_{direct}$ =120°C	$\Delta T_{avalanche}$ =175°C	ratio=0.7
SBR	∆T <sub>direct</sub> =100°C	∆T <sub>avalanche</sub> =150°C	ratio=0.7

#### **Electrical Approach**

Considering the transient thermal responses of a device, it is possible to simulate the instantaneous junction temperature for any sort of power pulse. Conducting this simulation on the data generated by the UIS test it is possible to show that all the parts fail when they reach a "critical temperature" (Fig 8):





At these critical temperatures the intrinsic carrier concentration, ni, reaches levels close to those of the doping concentrations:

ni is proportional to  $T^{3/2} e^{-Eg/2kT}$  [3]

where T is the absolute temperature, Eg the energy bandgap and k is Boltzmann's constant.

At 200°C, ni exceeds 2  $10^{14}$  cm<sup>-3</sup> which corresponds to a 1000 V material epitaxy concentration level. This means that when the junction temperature reaches 300°C, the rectifier looks more like a resistor than a diode. A local thermal runaway then generates a hot spot and a punchthrough as can be seen in Figures 4, 5 and 6.

This failure analysis has shown that the failure mechanism is essentially thermal: the devices are heated by the  $BV_R x$  $I_R$  power dissipation. Unfortunately, this power does not remain constant because the UIS circuit generates a linear current decay and also the breakdown voltage varies with the current level and with the junction temperature.

In order to have a complete characterization of the device it is interesting to see how it reacts to a constant avalanche current and different ambient temperatures.

#### NEW CHARACTERIZATION METHOD PROPOSAL

During the prototype phase, it is easier for the designer to measure the avalanche current and duration than the circuit's parasitic inductance. Therefore, the characterization should be based on easy to measure parameters. The failure analysis proves that the main cause of degradation is the inability to handle an excessive power (avalanche current  $I_R$  multiplied by breakdown voltage  $BV_R$ ). A proper characterization should present the maximum power capability versus time.

As the avalanche voltage varies only slightly with the current level, the proposed method is based on avalanching

a device at a constant current and presenting the maximum current capability versus time:

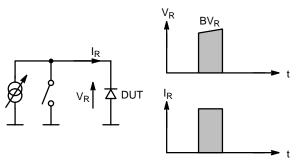


Figure 9. Constant Current Characterization Circuit.

Different test circuits similar to Figure 9 have been proposed by Gauen (1) and Pshaenich (2). Some unexpected failures in MOSFETs suggest that the DUT should always be referenced to ground. Unlike UFRs and SBRs, MOSFETs react differently whether they are tied to ground or floating around a fluctuating voltage. Many floating transistors fail at very low stress levels probably due to capacitive coupled currents that turn-on the internal parasitic transistor.

The test circuit shown in Figure 9 sets a constant avalanche current through the device until it fails, this duration can then be plotted for different current levels. This generates a graph similar to the UIS method, except that the current is constant instead of decreasing linearly.

This leads to the definition of a "Safe Avalanching Area" (Fig 10) that will guarantee a short-term reliability if the device is used within this clearly defined area.

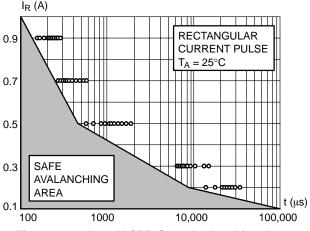


Figure 10. 1 A, 30 V SBR Save Avalanching Area.

This graph gives the maximum avalanche duration for any value of avalanche current.

The Safe Avalanching Area is generated by taking a safety margin from the failure points. Another approach would be to dynamically measure the temperature as in Figure 7 and generate an area defined by a maximum allowable junction temperature. As the failure mechanism is related to a peak junction temperature, it is necessary to give Safe Avalanching Areas for different ambient temperatures (Fig 11):

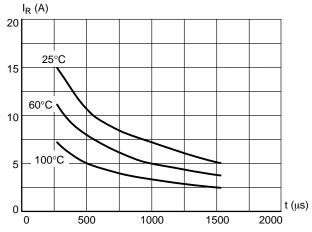


Figure 11. 25 A, 35 V SBR Safe Avalanching Areas for different ambient temperatures.

When the data in Figures 10 and 11 is plotted on log/log axes instead of lin/log or lin/lin, an interesting feature appears (Fig 12):

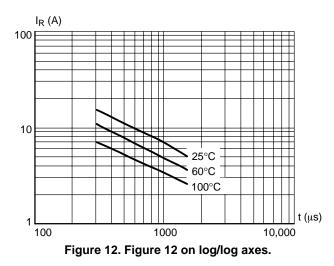


Figure 12 shows a linear relationship between current and time on a log/log plot. This means that:

so 
$$\frac{\log(I_R) = A \log(t) + B}{I_R = k T^A}$$
 [4]

where k is a constant function of the die size, the breakdown voltage and other parameters. Constant A can be extracted from Figure 12 and similar figures for UFRs and MOSFETs:

$$I_{R} = k T^{-0.55}$$
 [5]

Relation [5] is a consequence of heat propagation laws which explain that the temperature in a semiconductor rises proportionally to t  $^{0.5}$  (for a constant current pulse and as long as the temperature remains within the silicon die). This can be seen in any transient thermal resistance graph.

A standard thermal calculation shows that:

$$T_{J} = T_{A} + P_{D} \operatorname{Rth}_{JA}(t),$$

$$P_{D} = (T_{J} - T_{A}) / \operatorname{Rth}_{JA}(t)$$
[6]

where:

so

or

 $T_{J}$ ,  $T_{A}$  are the junction and ambient temperatures,

P<sub>D</sub> is the power dissipation,

 $Rth_{JA}(t)$  is the transient thermal resistance.

Given a constant power pulse and for values of t less than 1 ms, [6] is equivalent to:

$$I_{R} B_{VR} = (T_{J} - T_{A}) / (k t^{0.5})$$

$$I_{R} = k t^{-0.5}$$
[7]

This relation is similar to [5]. For avalanche durations of less than 500  $\mu$ s the heat propagates within the silicon only. For longer durations the heat reaches the solder and the package so the propagation characteristics are modified. The devices heat faster or slower and therefore the I<sub>R</sub>=f(t) slope changes. Empirical data shows that A in relation [4] remains within -0.5 to -0.6.

Relation [7] can also be expressed by:

$$I_R^2 t = k$$
 (k:constant) [7bis]

This rule of thumb works out much better than the, unfortunately too common,  $1/2 L I^2$  law.

For example, when applied to the example following Figure 2 (which is UIS and not Constant Current generated) to determine the maximum peak current in a 250  $\mu$ H inductor and by choosing for instance the 9 A, 500  $\mu$ s point, relation [7bis] can be written:

This gives a conservative value of 20 A instead of a real value of 28 A whereas the 1/2 L I<sup>2</sup> method generates a catastrophic 58 A value.

#### **TECHNOLOGY TRADEOFFS**

#### **Ultra Fast Recovery Rectifiers**

The UFR devices are based on a Mesa technology (Fig 13) with a Phosphorus doped (n-type) substrate. The heavily doped N+ substrate is followed by a lighter N- epitaxial layer. The P+ is diffused into the epitaxy to form the P-N junction. The passivation follows the perimeter of the die.

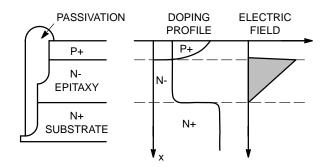


Figure 13. UFR Technology, Profile and Electric Field.

The epitaxy characteristics determine the major electrical parameters of the device. A designed experiment was conducted varying the epitaxy thickness and resistivity. The output responses were the forward voltage, the breakdown voltage, the leakage current and the avalanche capability. A wide range of epitaxy materials was chosen to determine the general trends for all the effects.

Although the results were predictable for the static parameters, the avalanche capability results were not.

A key issue is the electric field extension. If it terminates before the substrate the avalanche capability increases by increasing the epitaxy resistivity. If the field extends into the N+ region (reach-through) the avalanche capability is considerably reduced.

The avalanche capability is proportional to the die size and not to the perimeter. This confirms that the avalanche current is vertical and not only a surface or passivation related phenomenon.

The failures always occur in the corners where the electric field is most critical. These failures are essentially function of the thermal characteristics of the device when conducting avalanche currents. Therefore the avalanche capability decreases when the ambient temperature increases and the failures can normally be predicted by Safe Avalanching Areas such as Figure 12.

Some unexpected defects though can radically degrade the avalanche capability. Defects in the epi such as pipes cause premature failures but can often be screened by a leakage current test that eliminates soft breakdown devices. Defects in the passivation can generate parasitic oscillations during breakdown.

#### **Schottky Rectifiers**

Due to P-N junction guard rings, SBR devices are very similar to UFRs when conducting avalanche currents. These rectifiers have very low breakdown voltages and therefore very thin epitaxy layers. This probably explains that the avalanche-related failures occur anywhere on the die surface: the thin N- region is relatively more heterogeneous with respect to avalanche capability and thermal dissipation than a thick UFR epitaxy.

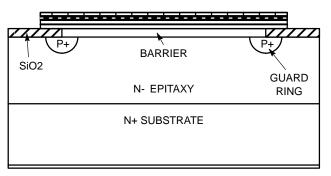


Figure 14. SBR Technology with P-N Guard Rings

#### MOSFETs

MOSFETs can also be compared to UFRs as long as the internal parasitic bipolar transistor (due to the P-tub) does not turn-on. The latest MOSFET generations reduce the Presistance to avoid biasing this NPN.

While analyzing different constant current test circuits, it appeared that devices used in a floating configuration can have very poor avalanche capabilities.

Due to their cellular technology, MOSFETs conduct very efficiently avalanche currents. They can sustain avalanche power levels close to those of forward conduction ratings.

#### CONCLUSION

The necessity of characterizing the avalanche capability of power semiconductors has been explained. An analysis of the standard UIS test circuit has shown the limits of a characterization based on energy ratings. Throughout a discussion of the main failure mechanisms, a new thermal approach has been proposed to help designers set safety levels in their designs. This paper sets new standards for characterizing avalanche ruggedness.

#### Acknowledgements

The authors would like to thank Jean-Michel REYNES, design engineer at ON Semiconductor Toulouse, for his help in understanding the failure mechanisms.

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# CHAPTER 7 Surface Mount Information

### INFORMATION FOR USING SURFACE MOUNT PACKAGES RECOMMENDED FOOTPRINTS FOR SURFACE MOUNTED APPLICATIONS

The power dissipation for a surface mount device is a function of the drain/collector pad size. These can vary from the minimum pad size for soldering to a pad size given for maximum power dissipation. Power dissipation for a surface mount device is determined by  $T_{J(max)}$ , the maximum rated junction temperature of the die,  $R_{\theta JA}$ , the thermal resistance from the device junction to ambient, and the operating temperature,  $T_A$ . Using the values provided on the data sheet,  $P_D$  can be calculated as follows:

Surface mount board layout is a critical portion of the total

design. The footprint for the semiconductor packages must

be the correct size to ensure proper solder connection

$$P_{D} = \frac{T_{J(max)} - T_{A}}{R_{\theta JA}}$$

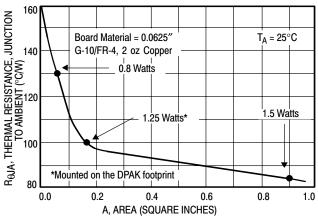
The values for the equation are found in the maximum ratings table on the data sheet. Substituting these values into the equation for an ambient temperature  $T_A$  of 25°C, one can calculate the power dissipation of the device. For example, for a SOT-223 device,  $P_D$  is calculated as follows.

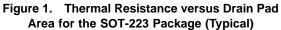
$$P_{D} = \frac{150^{\circ}C - 25^{\circ}C}{156^{\circ}C/W} = 800 \text{ milliwatts}$$

The 156°C/W for the SOT-223 package assumes the use of the recommended footprint on a glass epoxy printed circuit board to achieve a power dissipation of 800 milliwatts. There are other alternatives to achieving higher power dissipation from the surface mount packages. One is to increase the area of the drain/collector pad. By increasing the area of the drain/collector pad, the power dissipation can be increased. Although the power dissipation can almost be doubled with this method, area is taken up on the printed circuit board which can defeat the purpose of using surface mount technology. For example, a graph of  $R_{\theta JA}$  versus drain pad area is shown in Figures 1, 2 and 3.

Another alternative would be to use a ceramic substrate or an aluminum core board such as Thermal Clad<sup>™</sup>. Using a board material such as Thermal Clad, an aluminum core board, the power dissipation can be doubled using the same footprint. interface between the board and the package. With the correct pad geometry, the packages will self align when subjected to a solder reflow process.

### POWER DISSIPATION FOR A SURFACE MOUNT DEVICE





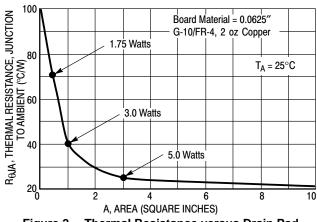


Figure 2. Thermal Resistance versus Drain Pad Area for the DPAK Package (Typical)

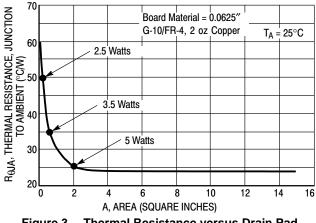
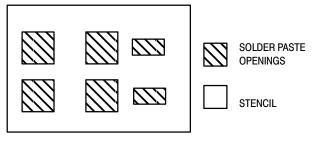


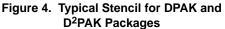
Figure 3. Thermal Resistance versus Drain Pad Area for the D<sup>2</sup>PAK Package (Typical)

### SOLDER STENCIL GUIDELINES

Prior to placing surface mount components onto a printed circuit board, solder paste must be applied to the pads. Solder stencils are used to screen the optimum amount. These stencils are typically 0.008 inches thick and may be made of brass or stainless steel. For packages such as the SC-59, SC-70/SOT-323, SOD-123, SOT-23, SOT-143, SOT-223, SO-8, SO-14, SO-16, and SMB/SMC diode packages, the stencil opening should be the same as the pad size or a 1:1 registration. This is not the case with the DPAK and D<sup>2</sup>PAK packages. If a 1:1 opening is used to screen solder onto the drain pad, misalignment and/or "tombstoning" may occur due to an excess of solder. For these two packages, the opening in the stencil for the paste should be approximately 50% of the tab area. The opening for the leads is still a 1:1 registration. Figure 4 shows a typical stencil for the DPAK and D<sup>2</sup>PAK packages. The

pattern of the opening in the stencil for the drain pad is not critical as long as it allows approximately 50% of the pad to be covered with paste.





### SOLDERING PRECAUTIONS

The melting temperature of solder is higher than the rated temperature of the device. When the entire device is heated to a high temperature, failure to complete soldering within a short time could result in device failure. Therefore, the following items should always be observed in order to minimize the thermal stress to which the devices are subjected.

- Always preheat the device.
- The delta temperature between the preheat and soldering should be 100°C or less.\*
- When preheating and soldering, the temperature of the leads and the case must not exceed the maximum temperature ratings as shown on the data sheet. When using infrared heating with the reflow soldering method, the difference should be a maximum of 10°C.
- The soldering temperature and time should not exceed 260°C for more than 10 seconds.
- When shifting from preheating to soldering, the maximum temperature gradient shall be 5°C or less.

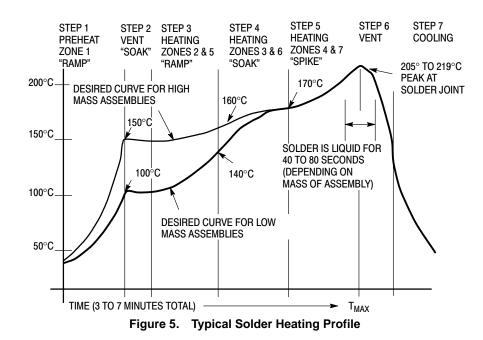
- After soldering has been completed, the device should be allowed to cool naturally for at least three minutes. Gradual cooling should be used since the use of forced cooling will increase the temperature gradient and will result in latent failure due to mechanical stress.
- Mechanical stress or shock should not be applied during cooling.

\* Soldering a device without preheating can cause excessive thermal shock and stress which can result in damage to the device.

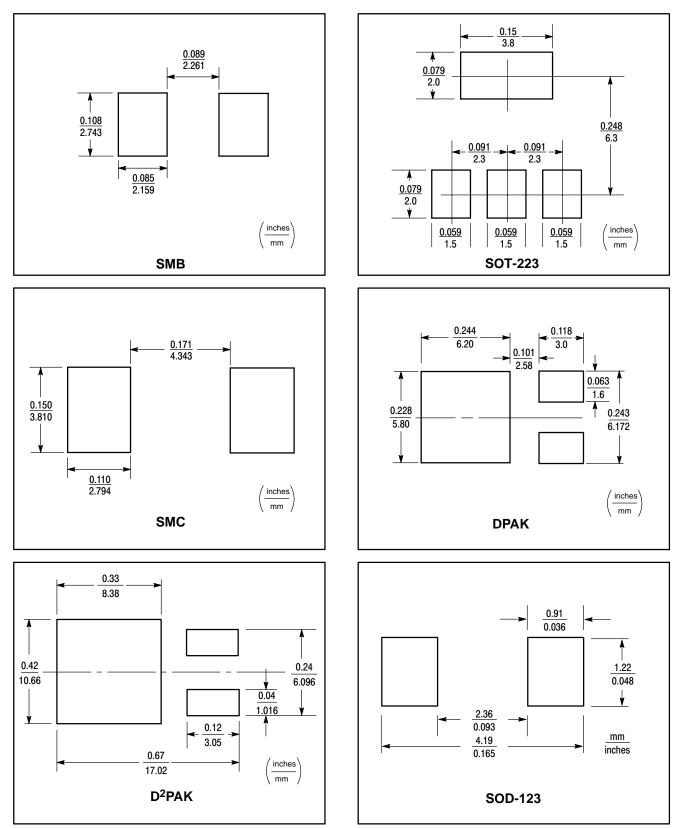
\* Due to shadowing and the inability to set the wave height to incorporate other surface mount components, the D<sup>2</sup>PAK is not recommended for wave soldering.

### **TYPICAL SOLDER HEATING PROFILE**

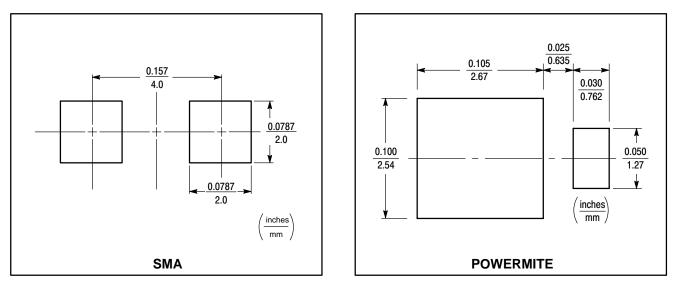
For any given circuit board, there will be a group of control settings that will give the desired heat pattern. The operator must set temperatures for several heating zones and a figure for belt speed. Taken together, these control settings make up a heating "profile" for that particular circuit board. On machines controlled by a computer, the computer remembers these profiles from one operating session to the next. Figure 5 shows a typical heating profile for use when soldering a surface mount device to a printed circuit board. This profile will vary among soldering systems, but it is a good starting point. Factors that can affect the profile include the type of soldering system in use, density and types of components on the board, type of solder used, and the type of board or substrate material being used. This profile shows temperature versus time. The line on the graph shows the actual temperature that might be experienced on the surface of a test board at or near a central solder joint. The two profiles are based on a high density and a low density board. The Vitronics SMD310 convection/infrared reflow soldering system was used to generate this profile. The type of solder used was 62/36/2 Tin Lead Silver with a melting point between 177-189 °C. When this type of furnace is used for solder reflow work, the circuit boards and solder joints tend to heat first. The components on the board are then heated by conduction. The circuit board, because it has a large surface area, absorbs the thermal energy more efficiently, then distributes this energy to the components. Because of this effect, the main body of a component may be up to 30 degrees cooler than the adjacent solder joints.



# **Footprints for Soldering**



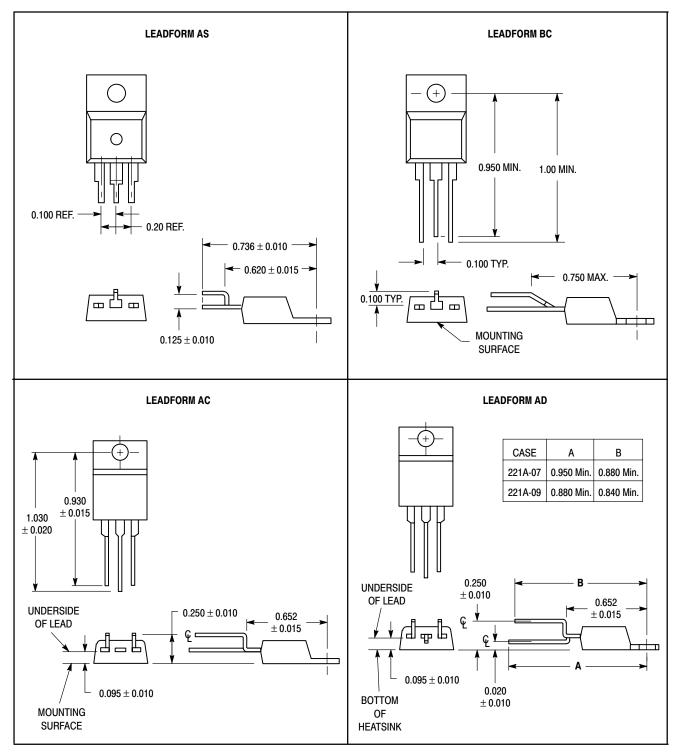
# **Footprints for Soldering**

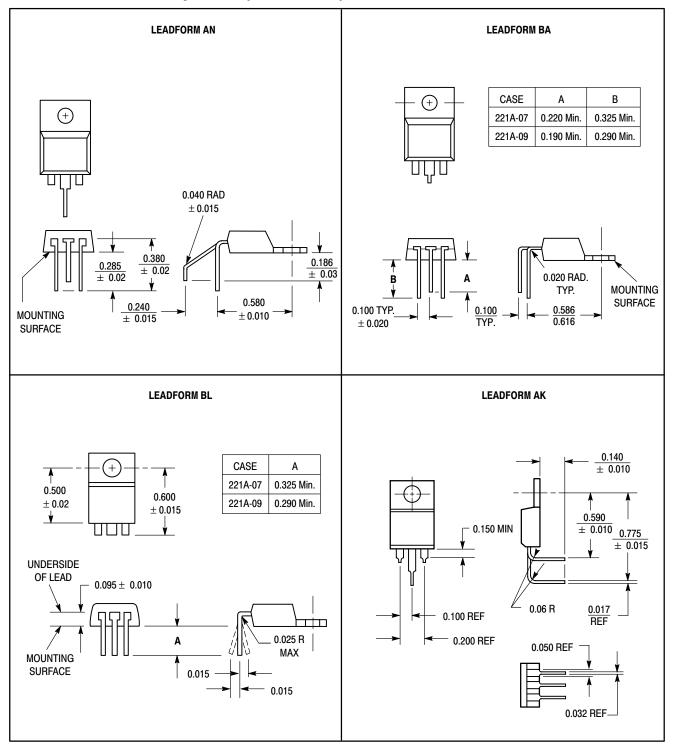


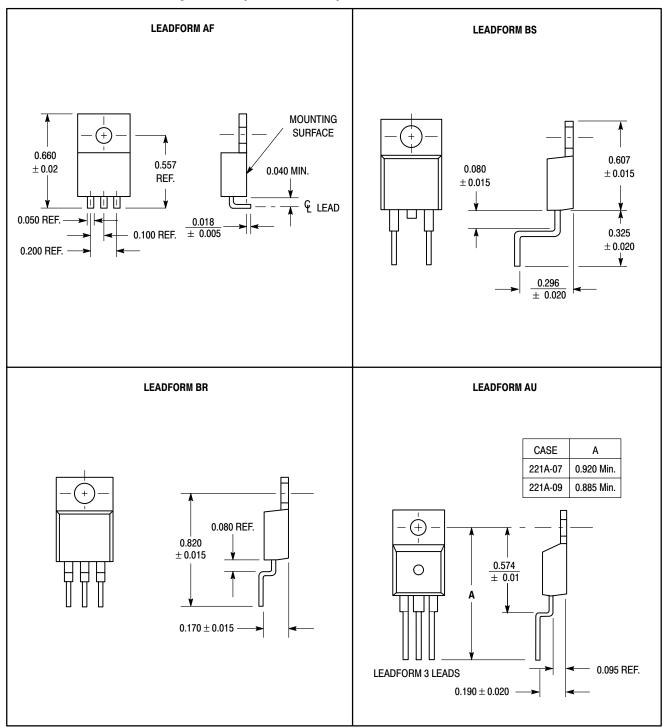
# CHAPTER 8 TO-220 Leadform Information

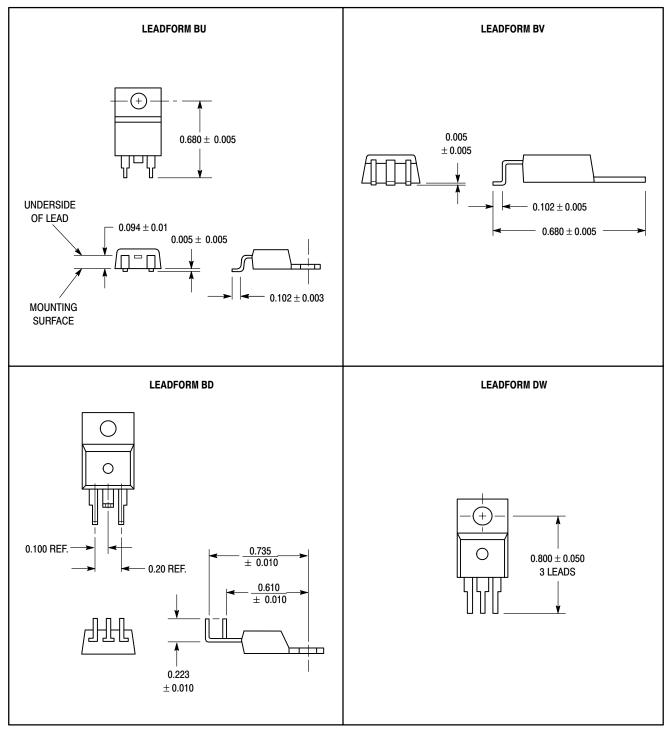
# Leadform Options — TO-220 (Case 221A)

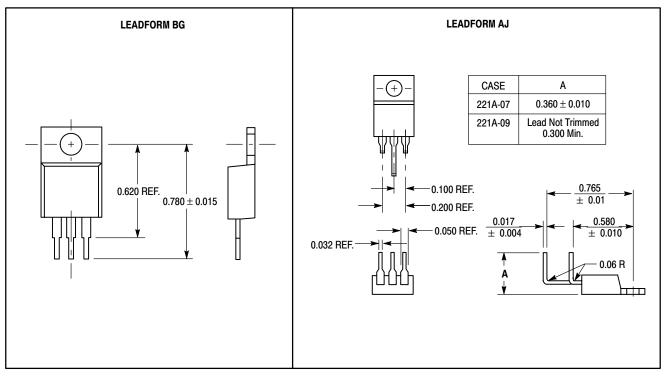
- Leadform options require assignment of a special part number before ordering.
- Contact your local ON Semiconductor representative for special part number and pricing.
- 10,000 piece minimum quantity orders are required.
- Leadform orders are non-cancellable after processing.
- Leadforms apply to both ON Semiconductor Case 221A-07 and 221A-09 except as noted.







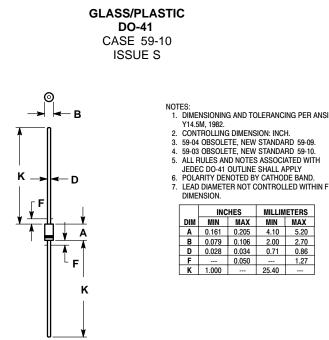




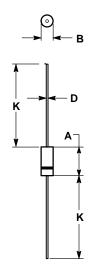
# CHAPTER 9 Package Outline Dimensions

## **Package Outline Dimensions**

For information on tape and reel packaging specifications, please download or order the ON Semiconductor Tape and Reel Packaging Specification Brochure (part number BRD8011/D). The PDF is available on the ON Semiconductor website at: http://www.onsemi.com/pub/Collateral/BRD8011-D.PDF.



**MINI MOSORB** CASE 59-09 **ISSUE S** 



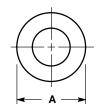
NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: INCH. 2.
- 59-04 OBSOLETE, NEW STANDARD 59-09.
   59-03 OBSOLETE, NEW STANDARD 59-10.
- 5. ALL RULES AND NOTES ASSOCIATED WITH JEDEC DO-41 OUTLINE SHALL APPLY.
- POLARITY DENOTED BY CATHODE BAND. LEAD DIAMETER NOT CONTROLLED WITHIN F 6. 7. DIMENSION.

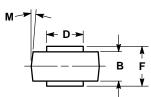
	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.228	0.299	5.80	7.60
В	0.102	0.142	2.60	3.60
D	0.028	0.034	0.71	0.86
Κ	1.000		25.44	

### PACKAGE OUTLINE DIMENSIONS (continued)

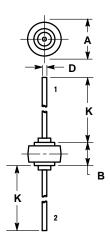
MICRODE BUTTON CASE 193-04 ISSUE J



	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	8.43	8.69	0.332	0.342
В	4.19	4.45	0.165	0.175
D	5.54	5.64	0.218	0.222
F	5.94	6.25	0.234	0.246
M	5°N	5°NOM		MOM



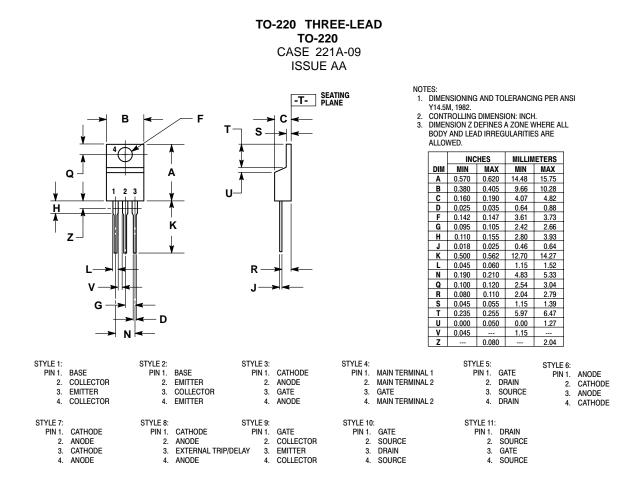
#### AXIAL LEAD BUTTON CASE 194-04 ISSUE F



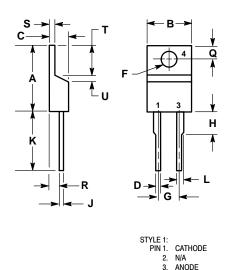
NOTES: 1. CATHODE SYMBOL ON PACKAGE.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	8.43	8.69	0.332	0.342
В	5.94	6.25	0.234	0.246
D	1.27	1.35	0.050	0.053
Κ	25.15	25.65	0.990	1.010

STYLE 1: PIN 1. CATHODE 2. ANODE



#### TO-220 TWO-LEAD CASE 221B-04 ISSUE D



NOTES: DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.595	0.620	15.11	15.75
В	0.380	0.405	9.65	10.29
С	0.160	0.190	4.06	4.82
D	0.025	0.035	0.64	0.89
F	0.142	0.147	3.61	3.73
G	0.190	0.210	4.83	5.33
Н	0.110	0.130	2.79	3.30
J	0.018	0.025	0.46	0.64
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.14	1.52
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.14	1.39
Т	0.235	0.255	5.97	6.48
U	0.000	0.050	0.00	1.27

STYLE 2: PIN 1. ANODE 2. N/A 3. CATHODE

ANODE 4.

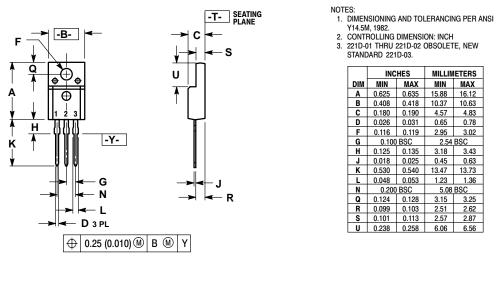
CATHODE

4.

### PACKAGE OUTLINE DIMENSIONS (continued)

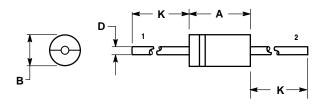
### **TO-220 FULLPACK TRANSISTOR** CASE 221D-03

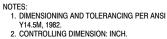
ISSUE G



STYLE 1: STYLE 2: STYLE	E 3: STYLE 4:	STYLE 5:	STYLE 6:
PIN 1. GATE PIN 1. BASE PI	N 1. ANODE PIN 1.	CATHODE PIN 1. CATHODE	PIN 1. MT 1
2. DRAIN 2. COLLECTOR	2. CATHODE 2.	ANODE 2. ANODE	2. MT 2
3. SOURCE 3. EMITTER	3. ANODE 3.	CATHODE 3. GATE	3. GATE

AXIAL LEAD CASE 267-05 **ISSUE G** 





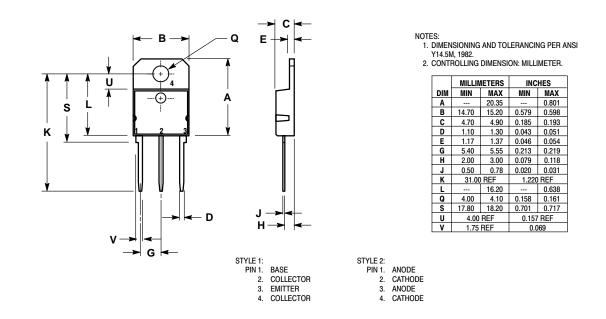
Γ		INCHES		MILLIN	IETERS
	DIM	MIN	MAX	MIN	MAX
	Α	0.287	0.374	7.30	9.50
	В	0.189	0.209	4.80	5.30
	D	0.047	0.051	1.20	1.30
	Κ	1.000		25.40	



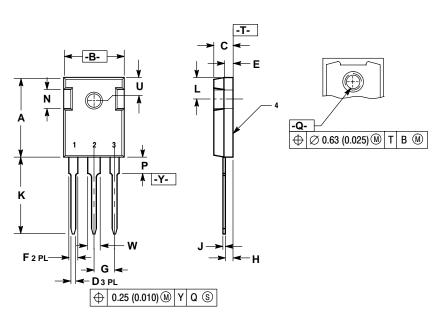
STYLE 2:

NO POLARITY

TO-218 THREE LEAD TO-218 CASE 340D-02 ISSUE B



TO-247 CASE 340L-02 ISSUE D



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M. 1982.

2. CONTROLLING DIMENSION: MILLIMETER.

	MILLIMETERS		INC	HES
DIM	MIN	MAX	MIN	MAX
Α	20.32	21.08	0.800	8.30
В	15.75	16.26	0.620	0.640
С	4.70	5.30	0.185	0.209
D	1.00	1.40	0.040	0.055
Ш	2.20	2.60	0.087	0.102
F	1.65	2.13	0.065	0.084
G	5.45	BSC	0.215 BSC	
Н	1.50	2.49	0.059	0.098
-	0.40	0.80	0.016	0.031
Κ	20.06	20.83	0.790	0.820
Г	5.40	6.20	0.212	0.244
Ν	4.32	5.49	0.170	0.216
Ρ		4.50		0.177
Ø	3.55	3.65	0.140	0.144
C	6.15	BSC	0.242	2 BSC
W	2.87	3.12	0.113	0.123

 STYLE 1:
 STYLE 2:
 STYLE 3:
 STYLE 4:

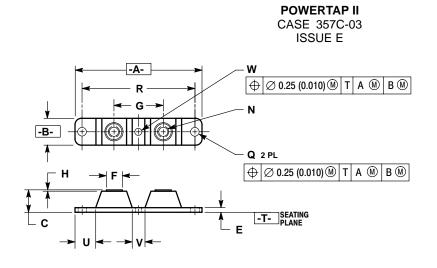
 PIN 1. GATE
 PIN 1. ANODE
 PIN 1. BASE
 PIN 1. GATE

 2. DRAIN
 2. CATHODE (S)
 2. COLLECTOR
 2. COLLECTOR

 3. SOURCE
 3. ANODE 2
 3. EMITTER
 3. EMITTER

 4. DRAIN
 4. CATHODES (S)
 4. COLLECTOR
 4. COLLECTOR

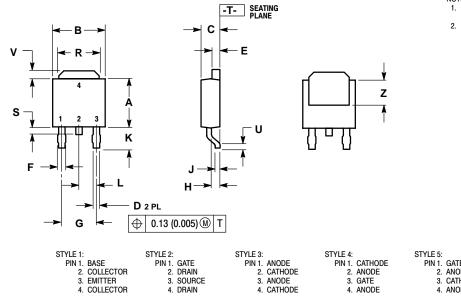
### PACKAGE OUTLINE DIMENSIONS (continued)



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. TERMINAL PENETRATION: 5.97 (0.235) MAXIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	3.450	3.635	87.63	92.33
В	0.700	0.810	17.78	20.57
С	0.615	0.640	15.63	16.26
Е	0.120	0.130	3.05	3.30
F	0.435	0.445	11.05	11.30
G	1.370	1.380	34.80	35.05
Н	0.007	0.030	0.18	0.76
Ν	1/4-20U	NC-2B	1/4-20UNC-2B	
Q	0.270	0.285	6.86	7.23
R	31.50	BSC	80.01	BSC
U	0.600	0.630	15.24	16.00
۷	0.330	0.375	8.39	9.52
W	0.170	0.190	4.32	4.82

DPAK CASE 369A-13 **ISSUE AA** 

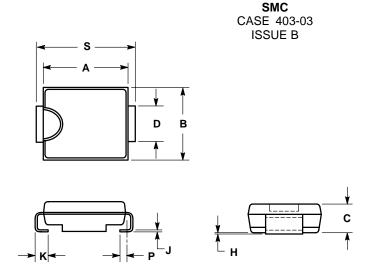


NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

	INCHES		MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.235	0.250	5.97	6.35
В	0.250	0.265	6.35	6.73
C	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.033	0.040	0.84	1.01
F	0.037	0.047	0.94	1.19
G	0.180 BSC		4.58 BSC	
Н	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.102	0.114	2.60	2.89
L	0.090	BSC	2.29 BSC	
R	0.175	0.215	4.45	5.46
S	0.020	0.050	0.51	1.27
U	0.020		0.51	
۷	0.030	0.050	0.77	1.27
Z	0.138		3.51	

STYLE 5:	STYLE 6:
PIN 1. GATE	PIN 1. MT1
2. ANODE	2. MT2
3. CATHODE	3. GATE
4. ANODE	4. MT2

### PACKAGE OUTLINE DIMENSIONS (continued)



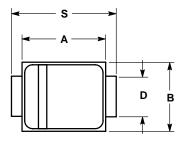
NOTES:		
<ol> <li>DIMENSI</li> </ol>	IONING AND TOLERANC	ING

G PER ANSI

DIMENSIONING AND TOLERANCING PER ANS Y14.5M, 1982.
 CONTROLLING DIMENSION: INCH.
 D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.260	0.280	6.60	7.11
В	0.220	0.240	5.59	6.10
С	0.075	0.095	1.90	2.41
D	0.115	0.121	2.92	3.07
н	0.0020	0.0060	0.051	0.152
J	0.006	0.012	0.15	0.30
Κ	0.030	0.050	0.76	1.27
Р	0.020 REF		0.51	REF
S	0.305	0.320	7.75	8.13

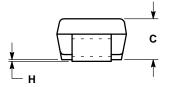
SMB D0-214AA CASE 403A-03 ISSUE D



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J

Р

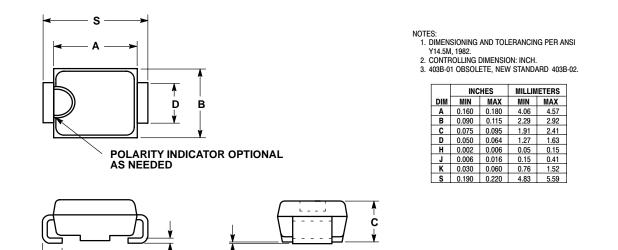


NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. D DIMENSION SHALL BE MEASURED WITHIN DIMENSION P.

	INC	HES	MILLIMETERS			
DIM	MIN	MAX	MIN	MAX		
Α	0.160	0.180	4.06	4.57		
В	0.130	0.150	3.30	3.81		
С	0.075	0.095	1.90	2.41		
D	0.077	0.083	1.96	2.11		
Н	0.0020	0.0060	0.051	0.152		
J	0.006	0.012	0.15	0.30		
Κ	0.030	0.050	0.76	1.27		
Р	0.020	) REF	0.51 REF			
S	0.205 0.220		5.21	5.59		

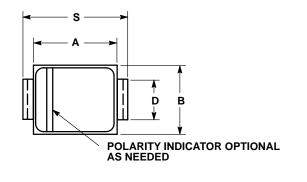
K

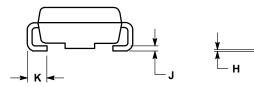
SMA CASE 403B-02 ISSUE C



SMA CASE 403D-02 **ISSUE A** 

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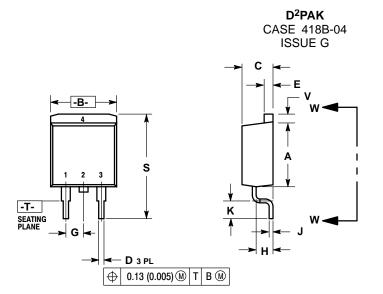
NOTES:

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VOLES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. 403D-01 DISOLETE, NEW STANDARD IS 403D-02.

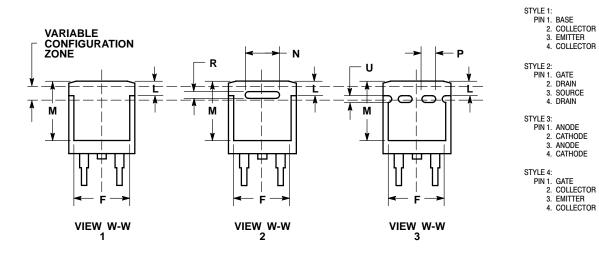
	INC	HES	MIL 1 10/	ETER		
DIM	MIN	MAX	MILLIMETERS			
DIN	IVIIN	IVIAA	MIN	MAX		
Α	0.160	0.180	4.06	4.57		
В	0.090	0.115	2.29	2.92		
С	0.075	0.095	1.91	2.41		
D	0.050	0.064	1.27	1.63		
н	0.002	0.006	0.05	0.15		
J	0.006	0.016	0.15	0.41		
K	0.030	0.060	0.76	1.52		
S	0.190	0.220	4.83	5.59		

http://onsemi.com 597

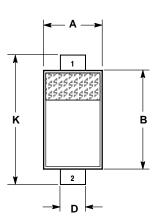


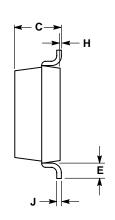
NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. 4188-01 THRU 4188-03 OBSOLETE, NEW STANDARD 4188-04.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	0.340	0.380	8.64	9.65	
В	0.380	0.405	9.65	10.29	
С	0.160	0.190	4.06	4.83	
D	0.020	0.035	0.51	0.89	
E	0.045	0.055	1.14	1.40	
F	0.310	0.350	7.87	8.89	
G	0.100	BSC	2.54 BSC		
н	0.080	0.110	2.03	2.79	
J	0.018	0.025	0.46	0.64	
K	0.090	0.110	2.29	2.79	
L	0.052	0.072	1.32	1.83	
М	0.280	0.320	7.11	8.13	
Ν	0.197	' REF	5.00	REF	
Ρ	0.079	REF	2.00	REF	
R	0.039	REF	0.99	REF	
S	0.575	0.625	14.60	15.88	
V	0.045	0.055	1.14	1.40	



SOD-123 CASE 425-04 ISSUE C



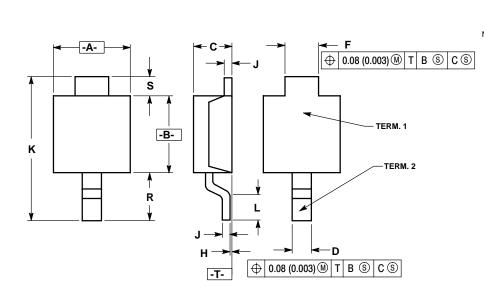




PIN 1. GATE 2. COLLECTOR 3. EMITTER 4. COLLECTOR

	INC	HES	MILLIMETERS			
DIM	MIN	MAX	MIN	MAX		
Α	0.055	0.071	1.40	1.80		
B 0.100		0.112	2.55	2.85		
C 0.037		0.053	0.95	1.35		
D	0.020	0.028	0.50	0.70		
Е	0.01		0.25			
Н	0.000	0.004	0.00	0.10		
L		0.006		0.15		
Κ	0.140	0.152	3.55	3.85		

STYLE 1: PIN 1. CATHODE 2. ANODE

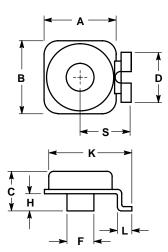


NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER. 3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.

	MILLIN	IETERS	INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	1.75	2.05	0.069	0.081		
В	1.75	2.18	0.069	0.086		
С	0.85	1.15	0.033	0.045		
D	0.40	0.69	0.016	0.027		
F	0.70	1.00	0.028	0.039		
Н	-0.05	+0.10	-0.002	+0.004		
J	0.10	0.25	0.004	0.010		
K	3.60	3.90	0.142	0.154		
L	0.50	0.80	0.020	0.031		
R	1.20	1.50	0.047	0.059		
S	0.50	REF	0.019 REF			

**TOP CAN BUTTON** CASE 460-02 **ISSUE A** 

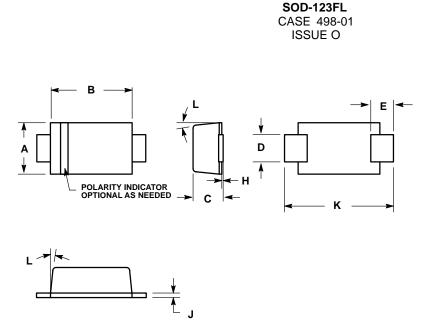
**PowerMIte** CASE 457-04 ISSUE D



NOTES:

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.

	MILLIN	IETERS	INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	9.1	9.5	0.358	0.374		
В	9.5	9.9	0.374	0.390		
С	5.2	5.6	0.205	0.220		
D	6.4	6.8	0.252	0.268		
F	3.4	3.8	0.134	0.149		
Н	2.0	2.4	0.079	0.095		
Κ	11.3	11.7	0.445	0.460		
Г	1.7	2.1	0.067	0.083		
s	6.5	6.9	0.256	0.272		



NOTES:

DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 CONTROLLING DIMENSION: MILLIMETER.
 DIMENSIONS A AND B DO NOT INCLUDE MOLD ELADIU.

FLASH. A. DIMENSIONS D AND J ARE TO BE MEASURED ON FLAT SECTION OF THE LEAD: BETWEEN 0.10 AND 0.25 MM FROM THE LEAD TIP.

	MILLIN	IETERS	INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	1.50	1.80	0.059	0.071		
В	2.50	2.90	0.098	0.114		
С	0.90	1.00	0.035	0.039		
D	0.70	1.10	0.028	0.043		
E	0.55	0.95	0.022	0.037		
н	0.00	0.10	0.000	0.004		
J	0.10	0.20	0.004	0.008		
K	3.40	3.80	0.134	0.150		
L	0 °	8 °	0 °	8 °		

For information on tape and reel packaging specifications, please download or order the ON Semiconductor Tape and Reel Packaging Specification Brochure (part number BRD8011/D). The PDF is available on the ON Semiconductor website at: http://www.onsemi.com/pub/Collateral/BRD8011-D.PDF.

# CHAPTER 10 Index and Cross Reference

### **Index and Cross Reference**

The following table represents an index and cross reference guide for all rectifier devices which are either manufactured directly by ON Semiconductor or for which ON Semiconductor manufactures a suitable equivalent. Where the ON Semiconductor part number differs from the industry part number, the ON Semiconductor device is a form, fit and function replacement for the industry type number - however, subtle differences in characteristics and/or specifications may exist. The part numbers listed in this Cross Reference are in computer sort.

	ON Semiconductor	ON Semiconductor			ON Semiconductor	ON Semiconductor	
Industry	Nearest	Similar		Industry	Nearest	Similar	
Part Number	Replacement	Replacement	Page	Part Number	Replacement	Replacement	Page
10BF10	MURS110T3		374	1N2069,A	1N4003		512
10BF20	MURS120T3		374	1N2070,A	1N4004		512
10BF40	MURS140T3		374	1N2071,A	1N4005		512
10BF60	MURS160T3		374	1N3611		1N4003	512
10BF80		MURS160T3	374	1N3611GP		1N4003	512
10BQ015		MBRS120T3	106	1N3612		1N4004	512
10BQ030	MBRS130T3		112	1N3612GP		1N4004	512
10BQ040	MBRS140T3		115	1N3613		1N4005	512
10BQ060		MBRS1100T3	122	1N3613GP		1N4005	512
10BQ100	MBRS1100T3		122	1N3614		1N4006	512
10CTF10		MUR840	462	1N3614GP		1N4006	512
10CTF20		MUR840	462	1N3957		1N4007	512
10CTF30		MUR840	462	1N3957GP		1N4007	512
10CTF40		MUR840	462	1N4001	1N4001		512
10DL1		1N4934	514	1N4001GP		1N4001	512
10DL2		1N4935	514	1N4002	1N4002		512
10MQ040N	MBRA140T3		89	1N4002GP		1N4002	512
10TQ030		MBR1035	265	1N4003	1N4003		512
10TQ035	MBR1035		265	1N4003GP		1N4003	512
10TQ040		MBR1045	265	1N4004	1N4004		512
10TQ045	MBR1045		265	1N4004GP		1N4004	512
11DQ03		1N5818	203	1N4005	1N4005		512
11DQ04		1N5819	203	1N4005GP		1N4005	512
11DQ05		MBR150	209	1N4006	1N4006		512
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FEP30DP		MUR3020WT	490		FR253		MR852	519
FEP30FP		MUR3060WT	490		FR254		MR856	519
FEP30GP		MUR3060WT	490		FR255		MR856	519
FEP30HP		MUR3060WT	490		FR301	MR852		519
FEP30JP		MUR3060WT	490		FR302	MR852		519
FEP6AT		MUR620CT	444		FR303	MR852		519
FEP6BT		MUR620CT	444		FR304	MR856		519
FEP6CT		MUR620CT	444		FR305	MR856		519
FEP6DT		MUR620CT	444		FRM3205CC	MUR3020PT		495
FEPB16AT		MURB1620CT	402		FRM3210CC	MUR3020PT		495
FEPB16BT		MURB1620CT	402		FRM3215CC	MUR3020PT		495
FEPB16CT		MURB1620CT	402		FRM3220CC	MUR3020PT		495
FEPB16DT		MURB1620CT	402		FRP1605CC	MUR1620CT		453
FES16AT		MUR1520	468		FRP1610CC	MUR1620CT		453
FES16BT		MUR1520	468		FRP1615CC	MUR1620CT		453
FES16CT		MUR1520	468		FRP1620CC	MUR1620CT		453
FES16DT		MUR1520	468		FRP805	MUR820		462
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FES16GT		MUR1540	468		FRP815	MUR820		462
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FES8BT		MUR820	462		FST1540	MBR1545CT		235
FES8CT		MUR820	462		FST1545	MBR1545CT		235
FES8DT		MUR820	462		FST20035		MBRP20045CT	318
FES8FT		MUR840	462		FST20040		MBRP20045CT	318
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FST2040	MBR2045CT		245	GI756		MR760	521
FST2045	MBR2045CT		245	GI758		MR760	521
FST2050	MBR2060CT		250	GI810		1N4933RL	514
FST30035		MBRP30045CT	321	GI811		1N4934RL	514
FST30040		MBRP30045CT	321	GI812		1N4935RL	514
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GER4007		1N4000 1N4007	512	GP08B		1N4002RL	512
GI1001		MUR120	408	GP08D		1N4003RL	512
GI1001 GI1002		MUR120	408	GP08G		1N4004RL	512
GI1002 GI1003		MUR120	408	GP08J		1N4004RL	512
GI1003		MUR120	408	GP10A		1N400311	512
GI1004 GI1101		MUR420	408	GP10A GP10B		1N4001 1N4002	512
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GI1301		MUR420 MUR420	434 434	GP10J GP10K		1N4005 1N4006	512
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GI1302 GI1303		MUR420 MUR420	434 434	GP15A		1N4007 1N4001RL	512
GI1303 GI1304		MUR420 MUR420	434 434	GP15A GP15B		1N4001RL 1N4002RL	512
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GI1401 GI1402			462 462			1N4003RL 1N4004RL	512
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	MUR820						
GI2401	MUR1620CT		453	GP15M		1N4007RL	512
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MBR6035PT		MBR6045PT	295	MBRS1100T3	MBRS1100T3		
MBR6040PT		MBR6045PT	295	MBRS130LT3	MBRS130LT3		1
MBR6045PT	MBR6045PT		295	MBRS140T3	MBRS140T3		1
MBR6045WT	MBR6045WT		306	MBRS320	MBRS320T3		1
MBR730	NDDTOF	MBR735	262	MBRS340	MBRS340T3		1
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MBR740		MBR745	262	MR2500	MR2504		5
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MBRB1545CT	MBRB1545CT		173	MR754	MR754		5
MBRB1550CT		MBRB1545CT	173	MR756	MR760		5
MBRB1635		MBRB1545CT	173	MR758	MR760		Ę
MBRB1645		MBRB1545CT	173	MR760	MR760		5
MBRB1650		MBRB1545CT	173	MR850	MR852		Ę
MBRB20100CT	MBRB20100CT		177	MR851	MR852		5
MBRB2035CT		MBRB2535CTL	184	MR852	MR852		Ę
MBRB2045CT		MBRB2545CT	187	MR854	MR856		5
MBRB2050CT		MBRB2545CT	187	MR856	MR856		5
MBRB2060CT	MBRB2060CT	MBRB204001	175	MUR10005CT	MURP20020CT		5
MBRB2080CT	WIDIND2000C1	MBRB20100CT	177	MUR100000CT	MURP20020CT		5
MBRB2090CT		MBRB20100CT	177	MUR10010CT	MURP20020CT		Ę
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		MDDD0000T		MUR110	MUR120		4
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MBRB3045CT		MBRB2545CT	187	MUR115	MUR120		4
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MBRD330	MBRD340		154	MUR130	MUR140		4
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MBRD620CT	MBRD640CT		158	MUR1510	MUR1520		4
MBRD630CT	MBRD640CT		158	MUR1515	MUR1520		4
MBRD640CT	MBRD640CT		158	MUR1520	MUR1520		4
MBRD650CT	MBRD660CT		158	MUR1530	MUR1540		4
MBRD660CT	MBRD660CT		158	MUR1540	MUR1540		4
MBRF20100CT	MBRF20100CT		281	MUR1550	MUR1560		4
MBRF2035CT		MBRF2545CT	287	MUR1560	MUR1560		4
MBRF2045CT		MBRF2545CT	287	MUR160	MUR160		4
MBRF2050CT		MBRF2545CT	287	MUR1605CT	MUR1620CT		4
MBRF2060CT		MBRF20100CT	281	MUR1605CTR	MUR1620CTR		4
MBRF2090CT		MBRF20100CT	281	MUR1610CT	MUR1620CT		4
MBRF2535CT	MBRF2545CT		287	MUR1610CTR	MUR1620CTR		4
MBRF2545CT	MBRF2545CT		287	MUR1615CT	MUR1620CT		4
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MUR1630CT	MUR1640CT		453	MURD605CT	MURD620CT		3
MUR1640CT	MUR1640CT		453	MURD610CT	MURD620CT		3
MUR1650CT	MUR1660CT		453	MURD615CT	MURD620CT		3
MUR1660CT	MUR1660CT		453	MURD620CT	MURD620CT		3
MUR170E	MUR1100E		413	MURH840CT	MURH840CT		4
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MUR20005CT	MURP20020CT		501	MURS120T3	MURS120T3		3
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MUR20030CT	MURP20040CT		501	MURS320T3	MURS320T3		3
MUR20040CT	MURP20040CT		501	MURS360T3	MURS360T3		3
MUR3005PT	MUR3020PT		495	P300A	1N5400RL		5
MUR3010PT	MUR3020PT		495	P300B	1N5401RL		5
MUR3015PT	MUR3020PT		495	P300D	1N5402RL		5
MUR3020PT	MUR3020PT		495	P300G	1N5404RL		5
MUR3020WT	MUR3020WT		490	P300J	1N5406RL		5
MUR3030PT	MUR3040PT		495	P300K	1N5407RL		5
MUR3040PT	MUR3040PT		495	P300M	1N5408RL		5
MUR3050PT	MUR3060PT		495	P600A		MR754	5
MUR3060PT	MUR3060PT		495	P600B		MR754	5
MUR3060WT	MUR3060WT		490	P600D		MR754	5
MUR405	MUR420		434	P600G		MR754	5
MUR410	MUR420		434	P600J		MR760	5
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MUR415	MUR420		434	PR1001	1N4933RL		5
MUR420	MUR420		434	PR1002	1N4934RL		5
MUR440	MUR460		434	PR1003	1N4935RL		5
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MUR460	MUR460		434	PR1005	1N4937RL		5
MUR470E	MUR4100E		439	PR1501		1N4933RL	5
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MUR490E	MUR4100E		439	PR1502		1N4934RL	5
MUR605CT	MUR620CT		444	PR1502S	1N4934RL		5
MUR610CT	MUR620CT		444	PR1503		1N4935RL	5
MUR615CT	MUR620CT		444	PR1503S	1N4935RL		5
MUR620CT	MUR620CT		444	PR1504		1N4936RL	5
MUR805	MUR820		462	PR1504S	1N4936RL		5
MUR810	MUR820		462	PR1505		1N4937RL	5
MUR8100E	MUR8100E		477	PR1505S	1N4937RL		5
MUR815	MUR820		462	PR2001		MR852	5
MUR820	MUR820		462	PR2002	1	MR852	5
MUR830	MUR840		462	PR2003	1	MR852	5
MUR840	MUR840		462	PR2004		MR854	5
MUR850	MUR860		462	PR2005	1	MR856	5
MUR860	MUR860		462	PR3001	MR852		5
MUR870E	MUR8100E		477	PR3002	MR852		5
MUR880E	MUR8100E		477	PR3003	MR852		5
MUR890E	MUR8100E		477	PR3004	MR854		5
MURB1610CT		MURB1620CT	402	PR3005	MR856		5
MURB1620CT	MURB1620CT		402	R710XPT	1	MUR3020WT	4
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RA251	MR2504		526	RGP30J		MR856	519
RA2510	MR2510		526	RGP80A	MUR820	Mil (000	462
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RGM30D		MUR3020PT	495	RS1DB	MURS120T3		374
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RGP10A		1N4933	514	RS1GB		MURS160T3	374
RGP10B		1N4934	514	RS1J	MRA4005T3		509
RGP10D		1N4935	514	RS1JB	MURS160T3		374
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RGP25G		MR856	519	RS3B		MURS320T3	387
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RS3J	MURS360T3		387	SB1045	MBR1045		265
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S2GA	MRA4004T3		509	SBG1640CT		MBRB1545CT	173
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S3JB	MURS160T3		374	SBL1050CT		MBR1545CT	235
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SRP100J	1N4937		514	STPS20L60CT	MBR2060CT		250
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SRP300B		MR852	519	STPS2L30A		MBRA130LT3	86
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